

CMOS 32-BIT SINGLE CHIP MICROCOMPUTER
E0C332L01 TECHNICAL MANUAL

E0C332L01 Technical Manual
E0C33 Block Technical Manual
SED1375 Block LCD Controller



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E0C332L01 Technical Manual

This manual describes the hardware specifications of the Seiko Epson original 32-bit microcomputer E0C332L01.

E0C332L01 Technical Manual

Describes the hardware specifications of the E0C332L01 except for details of the peripheral circuits.

E0C33 Block Technical Manual

Describes details of all the peripheral circuit blocks for the E0C33 Family microcomputers.

SED1375 Block LCD Controller

Describes the on-chip LCD controller block.

Refer to the "E0C33000 Core CPU Manual" for details of the E0C33000 32-bit RISC CPU .

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SED1375 BLOCK LCD CONTROLLER HARDWARE FUNCTIONAL SPECIFICATION

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SED1375 BLOCK LCD CONTROLLER PROGRAMMING NOTES AND EXAMPLES

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E0C332L01
Technical Manual

1 Outline

The E0C332L01 is a Seiko Epson original 32-bit microcomputer with a built-in LCD controller. It features high speed, low power and low-voltage operation and is most suitable for portable equipment that needs display function, such as information terminals, E-mail terminals, electronic dictionaries.

The E0C332L01 consists of the E0C33000 32-bit RISC type CPU as the core, a bus control unit, a DMA controller, an interrupt controller, timers, serial interface circuits, an A/D converter, ROM and RAM. The LCD controller unit is configured with the SEIKO EPSON SED1375 LCD controller and 40K bytes of SRAM display buffer (VRAM), and it allows driving of various LCD panels .

The E0C332L01 provides a DSP function, by using the internal MAC (multiplication and accumulation) operation function with the A/D converter, it makes it possible to design simply speech recognition and voice synthesis systems.

1.1 Features

Core CPU

Seiko Epson original 32-bit RISC CPU E0C33000 built-in

- Basic instruction set: 105 instructions (16-bit fixed size)
- Sixteen 32-bit general-purpose register
- 32-bit ALU and 8-bit shifter
- Multiplication/division instructions and MAC (multiplication and accumulation) instruction are available
- 20 ns of minimum instruction execution time at 50 MHz operation

Internal memory

ROM: 128K bytes

RAM: 8K bytes

VRAM: 40K bytes

Internal peripheral circuits

Oscillation circuit:	High-speed (OSC3) oscillation circuit 33 MHz max. Crystal/ceramic oscillator or external clock input
	Low-speed (OSC1) oscillation circuit 32.768 kHz typ. Crystal oscillator or external clock input
LCD controller:	SED1375 with 40KB VRAM 4 or 8-bit monochrome/color LCD interface Active matrix TFT/D-TFD interface 2, 4 or 16-level (1, 2 or 4 bit-per-pixel) gray-scale display 2, 4, 16 or 256-level (1, 2, 4 or 8 bit-per-pixel) color display Resolution examples: 640 × 480 dots with 1bpp color dipth 640 × 240 dots with 2bpp color dipth 320 × 240 dots with 4bpp color dipth 320 × 160 dots with 8bpp color dipth
Timers:	8-bit timer 4 channels 16-bit timer 6 channels Watchdog timer (16-bit timer 0's function) Clock timer 1 channel (with alarm function)
Serial interface:	2 channels (clock-synchronous system, asynchronous system and IrDA interface are selectable)
A/D converter:	10 bits × 8 channels
DMA controller:	High-speed DMA 4 channels Intelligent DMA 128 channels

1 OUTLINE

Interrupt controller:	Possible to invoke DMA	
	Input interrupt	10 types (programmable)
	DMA controller interrupt	5 types
	16-bit programmable timer interrupt	12 types
	8-bit programmable timer interrupt	4 types
	Serial interface interrupt	6 types
	A/D converter interrupt	1 type
	Clock timer interrupt	1 type
General-purpose input and output ports:	Shared with the I/O pins for internal peripheral circuits	
	Input port	13 bits
	I/O port	29 bits

External bus interface

BCU (bus control unit) built-in

- 24-bit address bus (internal 28-bit processing)
- 16-bit data bus
Data size is selectable from 8 bits and 16 bits in each area.
- Little-endian memory access; big-endian may be set in each area.
- Memory mapped I/O
- Chip enable and wait control circuits built-in
- DRAM direct interface function built-in
Supports fast page mode and EDO page mode.
Supports self-refresh and CAS-before RAS refresh.
- Supports burst ROM.

Operating conditions and power consumption

Operating voltage:	Core (VDD)	1.8 V to 3.6 V
	I/O (VDDE1)	1.8 V to 5.5 V
	LCD I/F (VDDE2)	1.8 V to 5.5 V
Operating clock frequency:	CPU	50 MHz max. (when core voltage = 3.3 V \pm 0.3 V) 40 MHz max. (when core voltage = 3.0 V \pm 0.3 V)
	LCD controller	25 MHz max. (when core voltage = 3.3 V \pm 0.3 V)
Operating temperature:		-40 to 85°C
Power consumption:	During SLEEP	4 μ W typ.
	During HALT	130 mW typ. (3.3 V, 50 MHz, LCD controller enabled)
		100 mW typ. (3.3 V, 50 MHz, LCD controller is in power-save mode)
		230 mW typ. (3.3 V, 50 MHz, LCD controller enabled)
During execution		

Note: • The values of power consumption during execution were measured when a test program that consisted of 55% load instructions, 23% arithmetic operation instructions, 1% mac instruction, 12% branch instructions and 9% ext instruction was being continuously executed.

- The LCD controller is configured with 640 \times 480 display resolution, 1 bpp mode and a 25 MHz operating clock.

Supply form

QFP18-176pin plastic package

1.2 Block Diagram

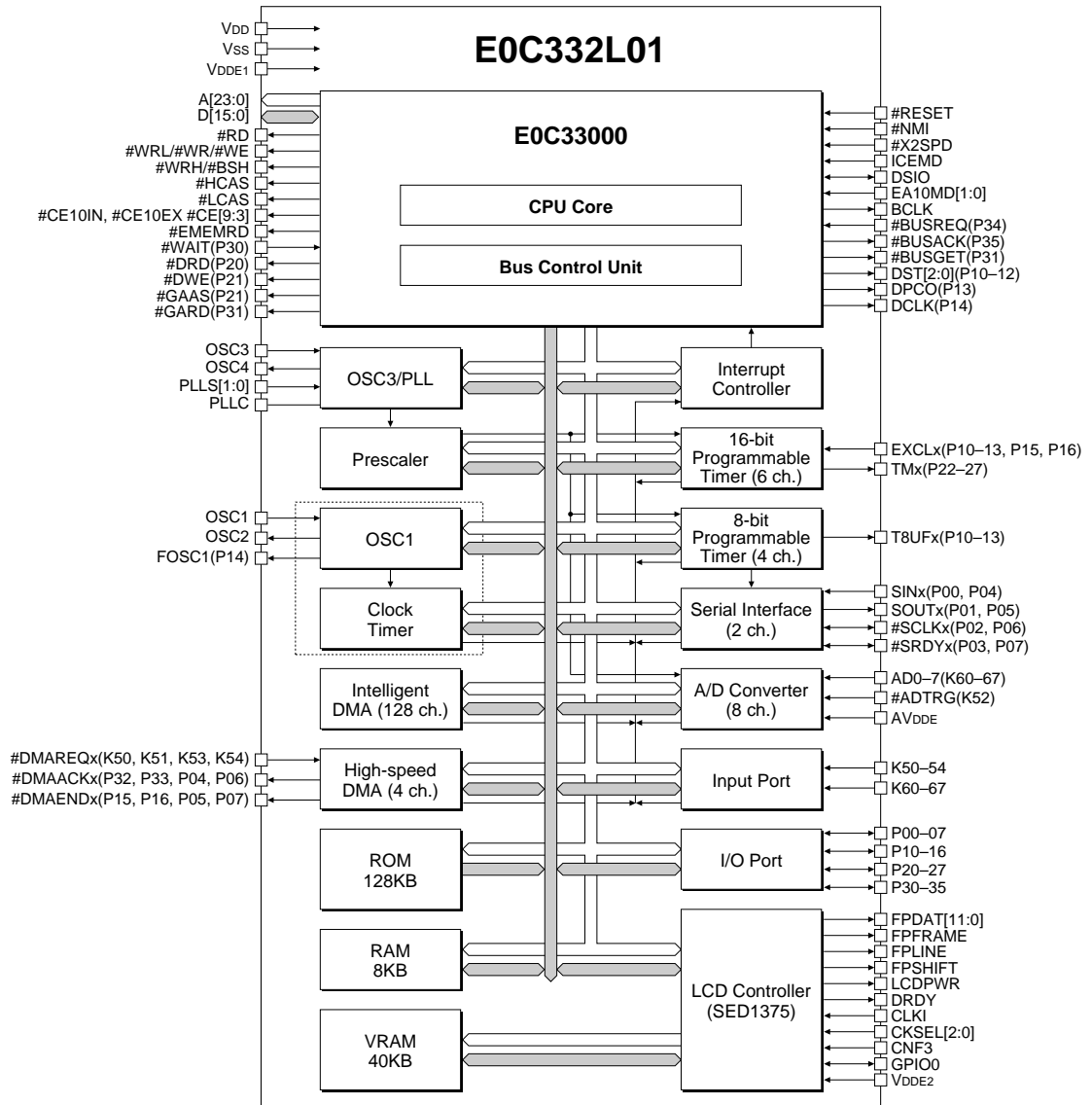
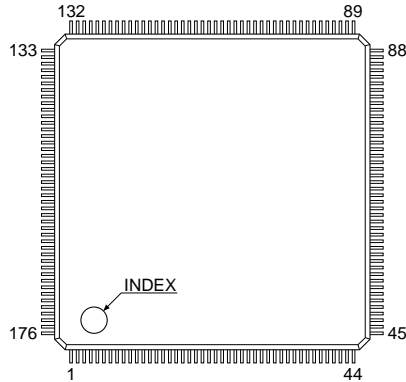


Figure 1.2.1 EOC332L01 Block Diagram

1.3 Pin Description

1.3.1 Pin Layout Diagram (plastic package)

QFP18-176pin



No.	Pin name	No.	Pin name	No.	Pin name	No.	Pin name
1	A23	45	D2	89	N.C.	133	P21/#DWE/#GAAS
2	A22	46	D1	90	Vss	134	P20/#DRD
3	A21	47	D0	91	GPIO0	135	P16/EXCL5/#DMAEND1
4	A20	48	Vss	92	FPDAT11/GPIO4/INVERSE	136	P15/EXCL4/#DMAEND0
5	VdDE1	49	BCLK	93	FPDAT10/GPIO3	137	VdDE1
6	A19	50	#MEMRD	94	FPDAT9/GPIO2	138	P14/FOSC1/DCLK
7	A18	51	#RD	95	VdDE2	139	P13/EXCL3/T8UF3/DPCO
8	A17	52	#WRL/#WR/#WE	96	FPDAT8/GPIO1	140	P12/EXCL2/T8UF2/DST2
9	A16	53	#WRH/#BSH	97	FPSHIFT	141	P11/EXCL1/T8UF1/DST1
10	A15	54	VdDE1	98	FPDAT7	142	P10/EXCL0/T8UF0/DST0
11	Vss	55	#CE10EX/#CE9&10EX	99	FPDAT6	143	Vss
12	A14	56	#CE10IN	100	FPDAT5	144	P07/#SRDY1/#DMAEND3
13	A13	57	#CE3	101	Vdd	145	P06/#SCLK1/DMAACK3
14	A12	58	Vss	102	FPDAT4	146	P05/SOUT1/#DMAEND2
15	A11	59	K67/AD7	103	FPDAT3	147	P04/SIN1/#DMAACK2
16	A10	60	K66/AD6	104	FPDAT2	148	Vdd
17	Vdd	61	K65/AD5	105	FPDAT1	149	OSC2
18	A9	62	AVdDE	106	Vss	150	OSC1
19	A8	63	K64/AD4	107	FPDAT0	151	Vss
20	A7	64	K63/AD3	108	FPLINE	152	P03/#SRDY0
21	A6	65	K62/AD2	109	FPPFRAME	153	P02/#SCLK0
22	A5	66	Vss	110	DRDY/MOD/FPSHIFT2	154	P01/SOUT0
23	Vss	67	K61/AD1	111	VdDE2	155	P00/SIN0
24	A4	68	K60/AD0	112	LCDPWR	156	CNF3
25	A3	69	K54/#DMAREQ3	113	N.C.	157	CKSEL2
26	A2	70	K53/#DMAREQ2	114	N.C.	158	CKSEL1
27	A1	71	K52/#ADTRG	115	N.C.	159	CKSEL0
28	A0/#BSL	72	Vdd	116	N.C.	160	VdDE1
29	VdDE1	73	K51/#DMAREQ1	117	N.C.	161	CLKI
30	D15	74	K50/#DMAREQ0	118	Vss	162	ICEMD
31	D14	75	#LCAS	119	P35/#BUSACK	163	Vss
32	D13	76	#HCAS	120	P34/#BUSREQ/#CE6	164	OSC4
33	D12	77	#CE9/#CE17/#CE17&18	121	P33/#DMAACK1	165	OSC3
34	D11	78	Vss	122	P32/#DMAACK0	166	EA10MD1
35	Vss	79	#CE8/#RAS1/#CE14/#RAS3	123	P31/#BUSGET/#GARD	167	EA10MD0
36	D10	80	#CE7/#RAS0/#CE13/#RAS2	124	P30/#WAIT/#CE4&5	168	#X2SPD
37	D9	81	#CE5/#CE15/#CE15&16	125	Vdd	169	Vdd
38	D8	82	#CE4/#CE11/#CE11&12	126	P27/TM5	170	PLLS1
39	D7	83	#CE6/#CE7&8	127	P26/TM4	171	PLLS0
40	D6	84	VdDE1	128	P25/TM3	172	#NMI
41	VDD	85	N.C.	129	P24/TM2	173	Vss
42	D5	86	N.C.	130	P23/TM1	174	PLL
43	D4	87	N.C.	131	Vss	175	#RESET
44	D3	88	N.C.	132	P22/TM0	176	DSIO

Figure 1.3.1 Pin Layout Diagram (QFP18-176pin)

1.3.2 Pin Functions

Table 1.3.1 List of Pins for Power Supply System

Pin name	Pin No.	I/O	Pull-up	Function
VDD	17,41,72, 101,125, 148,169	–	–	Power supply (+) for the internal logic
VSS	11,23,35,48, 58,66,78,90, 106,118, 131,143 151,163, 173	–	–	Power supply (-); GND
VDDE1	5,29,54,84, 137,160	–	–	Power supply (+) for the I/O block
VDDE2	95,111	–	–	Power supply (+) for the LCD interface
AVDDE	62	–	–	Analog system power supply (+); AVDDE = VDDE

Table 1.3.2 List of Pins for External Bus Interface Signals

Pin name	Pin No.	I/O	Pull-up	Function
A0 #BSL	28	O	–	A0: Address bus (A0) when SBUSST(D3/0x4812E) = "0" (default) #BSL: Bus strobe (low byte) signal when SBUSST(D3/0x4812E) = "1"
A[23:1]	1–4,6–10, 12–16, 18–22, 24–27	O	–	Address bus (A1 to A23)
D[15:0]	30–34, 36–40, 42–47	I/O	–	Data bus (D0 to D15)
#CE10EX	55	O	–	Area 10 chip enable for external memory * When CEFUNC[1:0] = "1x", this pin outputs #CE9+#CE10EX signal.
#CE10IN	56	O	–	Area 10 chip enable for internal ROM emulation memory
#CE9 #CE17	77	O	–	#CE9: Area 9 chip enable when CEFUNC[1:0](D[A:9])/0x48130) = "00" (default) #CE17: Area 17 chip enable when CEFUNC[1:0](D[A:9])/0x48130) = "01" * When CEFUNC[1:0] = "1x", this pin outputs #CE17+#CE18 signal.
#CE8 #RAS1 #CE14 #RAS3	79	O	–	#CE8: Area 8 chip enable when CEFUNC[1:0](D[A:9])/0x48130) = "00" and A8DRA(D8/0x48128) = "0" (default) #RAS1: Area 8 DRAM row strobe when CEFUNC[1:0](D[A:9])/0x48130) = "00" and A8DRA(D8/0x48128) = "1" #CE14: Area 14 chip enable when CEFUNC[1:0](D[A:9])/0x48130) = "01" or "1x" and A14DRA(D8/0x48122) = "0" #RAS3: Area 14 DRAM row strobe when CEFUNC[1:0](D[A:9])/0x48130) = "01" or "1x" and A14DRA(D8/0x48122) = "1"
#CE7 #RAS0 #CE13 #RAS2	80	O	–	#CE7: Area 7 chip enable when CEFUNC[1:0](D[A:9])/0x48130) = "00" and A7DRA(D7/0x48128) = "0" (default) #RAS0: Area 7 DRAM row strobe when CEFUNC[1:0](D[A:9])/0x48130) = "00" and A7DRA(D7/0x48128) = "1" #CE13: Area 13 chip enable when CEFUNC[1:0](D[A:9])/0x48130) = "01" or "1x" and A13DRA(D7/0x48122) = "0" #RAS2: Area 13 DRAM row strobe when CEFUNC[1:0](D[A:9])/0x48130) = "01" or "1x" and A13DRA(D7/0x48122) = "1"
#CE6	83	O	–	Area 6 chip enable * When CEFUNC[1:0] = "1x", this pin outputs #CE7+#CE8 signal.
#CE5 #CE15	81	O	–	#CE5: Area 5 chip enable when CEFUNC[1:0](D[A:9])/0x48130) = "00" (default) #CE15: Area 15 chip enable when CEFUNC[1:0](D[A:9])/0x48130) = "01" * When CEFUNC[1:0] = "1x", this pin outputs #CE15+#CE16 signal.
#CE4 #CE11	82	O	–	#CE4: Area 4 chip enable when CEFUNC[1:0](D[A:9])/0x48130) = "00" (default) #CE11: Area 11 chip enable when CEFUNC[1:0](D[A:9])/0x48130) = "01" * When CEFUNC[1:0] = "1x", this pin outputs #CE11+#CE12 signal.

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Pin name	Pin No.	I/O	Pull-up	Function
#CE3	57	O	–	Area 3 chip enable
#RD	51	O	–	Read signal
#EMEMRD	50	O	–	Read signal for internal ROM emulation memory
#WRL	52	O	–	#WRL: Write (low byte) signal when SBUSST(D3/0x4812E) = "0" (default)
#WR				#WR: Write signal when SBUSST(D3/0x4812E) = "1"
#WE				#WE: DRAM write signal (default)
#WRH	53	O	–	#WRH: Write (high byte) signal when SBUSST(D3/0x4812E) = "0" (default)
#BSH				#BSH: Bus strobe (high byte) signal when SBUSST(D3/0x4812E) = "1"
#HCAS	76	O	–	#HCAS: DRAM column address strobe (high byte) signal
#LCAS	75	O	–	#LCAS: DRAM column address strobe (low byte) signal
BCLK	49	O	–	Bus clock output
P34	120	I/O	–	P34: I/O port when CFP34(D4/0x402DC) = "0" (default)
#BUSREQ				#BUSREQ: Bus release request input when CFP34(D4/0x402DC) = "1"
#CE6				#CE6: Area 6 chip enable when CFP34(D4/0x402DC) = "1" and IOC34(D4/0x402DE) = "1"
P35	119	I/O	–	P35: I/O port when CFP35(D5/0x402DC) = "0" (default)
#BUSACK				#BUSACK: Bus acknowledge output when CFP35(D5/0x402DC) = "1"
P30	124	I/O	–	P30: I/O port when CFP30(D0/0x402DC) = "0" (default)
#WAIT				#WAIT: Wait cycle request input when CFP30(D0/0x402DC) = "1"
#CE4&5				#CE4&5: Areas 4&5 chip enable when CFP30(D0/0x402DC) = "1" and IOC30(D0/0x402DE) = "1"
P20	134	I/O	–	P20: I/O port when CFP20(D0/0x402D8) = "0" (default)
#DRD				#DRD: DRAM read signal output for successive RAS mode when CFP20(D0/0x402D8) = "1"
P21	133	I/O		P21: I/O port when CFP21(D1/0x402D8) = "0" and CFEX2(D2/0x402DF) = "0" (default)
#DWE				#DWE: DRAM write signal output for successive RAS mode when CFP21(D1/0x402D8) = "1" and CFEX2(D2/0x402DF) = "0"
#GAAS				#GAAS: Area address strobe output for GA when CFEX2(D2/0x402DF) = "1"
P31	123	I/O		P31: I/O port when CFP31(D1/0x402DC) = "0" and CFEX3(D3/0x402DF) = "0" (default)
#BUSGET				#BUSGET: Bus status monitor signal output for bus request when CFP31(D1/0x402DC) = "1" and CFEX3(D3/0x402DF) = "0"
#GARD				#GARD: Area read signal output for GA when CFEX3(D3/0x402DF) = "1"
EA10MD1	166	I	With pull-up	Area 10 boot mode selection
				EA10MD1 EA10MD0 Mode
				1 1 External ROM mode
EA10MD0	167	I	–	1 0 Internal ROM mode
				0 1 OTP mode
				0 0 Internal ROM emulation

Table 1.3.3 List of Pins for HSDMA Control Signals

Pin name	Pin No.	I/O	Pull-up	Function
K50	74	I	With pull-up	K50: Input port when CFK50(D0/0x402C0) = "0" (default)
#DMAREQ0				#DMAREQ0: HSDMA Ch. 0 request input when CFK50(D0/0x402C0) = "1"
K51	73	I	With pull-up	K51: Input port when CFK51(D1/0x402C0) = "0" (default)
#DMAREQ1				#DMAREQ1: HSDMA Ch. 1 request input when CFK51(D1/0x402C0) = "1"
K53	70	I	With pull-up	K53: Input port when CFK53(D3/0x402C0) = "0" (default)
#DMAREQ2				#DMAREQ2: HSDMA Ch. 2 request input when CFK53(D3/0x402C0) = "1"
K54	69	I	With pull-up	K54: Input port when CFK54(D4/0x402C0) = "0" (default)
#DMAREQ3				#DMAREQ3: HSDMA Ch. 3 request input when CFK54(D4/0x402C0) = "1"
P32	122	I/O	–	P32: I/O port when CFP32(D2/0x402DC) = "0" (default)
#DMAACK0				#DMAACK0: HSDMA Ch. 0 acknowledge output when CFP32(D2/0x402DC) = "1"
P33	121	I/O	–	P33: I/O port when CFP33(D3/0x402DC) = "0" (default)
#DMAACK1				#DMAACK1: HSDMA Ch. 1 acknowledge output when CFP33(D3/0x402DC) = "1"

Pin name	Pin No.	I/O	Pull-up	Function
P04 SIN1 #DMAACK2	147	I/O	–	P04: I/O port when CFP04(D4/0x402D0) = "0" and CFEX4(D4/0x402DF) = "0" (default) SIN1: Serial I/F Ch. 1 data input when CFP04(D4/0x402D0) = "1" and CFEX4(D4/0x402DF) = "0" #DMAACK2: HSDMA Ch. 2 acknowledge output when CFEX4(D4/0x402DF) = "1"
P06 #SCLK1 #DMAACK3	145	I/O	–	P06: I/O port when CFP06(D6/0x402D0) = "0" and CFEX6(D6/0x402DF) = "0" (default) #SCLK1: Serial I/F Ch. 1 clock input/output when CFP06(D6/0x402D0) = "1" and CFEX6(D6/0x402DF) = "0" #DMAACK3: HSDMA Ch. 3 acknowledge output when CFEX6(D6/0x402DF) = "1"
P15 EXCL4 #DMAEND0	136	I/O	–	P15: I/O port when CFP15(D5/0x402D4) = "0" (default) EXCL4: 16-bit timer 4 event counter input when CFP15(D5/0x402D4) = "1" and IOC15(D5/0x402D6) = "0" #DMAEND0: HSDMA Ch. 0 end-of-transfer signal output when CFP15(D5/0x402D4) = "1" and IOC15(D5/0x402D6) = "1"
P16 EXCL5 #DMAEND1	135	I/O	–	P16: I/O port when CFP16(D6/0x402D4) = "0" (default) EXCL5: 16-bit timer 5 event counter input when CFP16(D6/0x402D4) = "1" and IOC16(D6/0x402D6) = "0" #DMAEND1: HSDMA Ch. 1 end-of-transfer signal output when CFP16(D6/0x402D4) = "1" and IOC16(D6/0x402D6) = "1"
P05 SOUT1 #DMAEND2	146	I/O	–	P05: I/O port when CFP05(D5/0x402D0) = "0" and CFEX5(D5/0x402DF) = "0" (default) SOUT1: Serial I/F Ch. 1 data output when CFP05(D5/0x402D0) = "1" and CFEX5(D5/0x402DF) = "0" #DMAEND2: HSDMA Ch. 2 end-of-transfer signal output when CFEX5(D5/0x402DF) = "1"
P07 #SRDY1 #DMAEND3	144	I/O	–	P07: I/O port when CFP07(D7/0x402D0) = "0" and CFEX7(D7/0x402DF) = "0" (default) #SRDY1: Serial I/F Ch. 1 ready signal output when CFP07(D7/0x402D0) = "1" and CFEX5(D5/0x402DF) = "0" #DMAEND3: HSDMA Ch. 3 end-of-transfer signal output when CFEX7(D7/0x402DF) = "1"

Table 1.3.4 List of Pins for Internal Peripheral Circuits

Pin name	Pin No.	I/O	Pull-up	Function
K52 #ADTRG	71	I	With pull-up	K52: Input port when CFK52(D2/0x402C0) = "0" (default) #ADTRG: A/D converter trigger input when CFK52(D2/0x402C0) = "1"
K60 AD0	68	I	–	K60: Input port when CFK60(D0/0x402C3) = "0" (default) AD0: A/D converter Ch. 0 input when CFK60(D0/0x402C3) = "1"
K61 AD1	67	I	–	K61: Input port when CFK61(D1/0x402C3) = "0" (default) AD1: A/D converter Ch. 1 input when CFK61(D1/0x402C3) = "1"
K62 AD2	65	I	–	K62: Input port when CFK62(D2/0x402C3) = "0" (default) AD2: A/D converter Ch. 2 input when CFK62(D2/0x402C3) = "1"
K63 AD3	64	I	–	K63: Input port when CFK63(D3/0x402C3) = "0" (default) AD3: A/D converter Ch. 3 input when CFK63(D3/0x402C3) = "1"
K64 AD4	63	I	–	K64: Input port when CFK64(D4/0x402C3) = "0" (default) AD4: A/D converter Ch. 4 input when CFK64(D4/0x402C3) = "1"
K65 AD5	61	I	–	K65: Input port when CFK65(D5/0x402C3) = "0" (default) AD5: A/D converter Ch. 5 input when CFK65(D5/0x402C3) = "1"
K66 AD6	60	I	–	K66: Input port when CFK66(D6/0x402C3) = "0" (default) AD6: A/D converter Ch. 6 input when CFK66(D6/0x402C3) = "1"
K67 AD7	59	I	–	K67: Input port when CFK67(D7/0x402C3) = "0" (default) AD7: A/D converter Ch. 7 input when CFK67(D7/0x402C3) = "1"
P00 SIN0	155	I/O	–	P00: I/O port when CFP00(D0/0x402D0) = "0" (default) SIN0: Serial I/F Ch. 0 data input when CFP00(D0/0x402D0) = "1"
P01 SOUT0	154	I/O	–	P01: I/O port when CFP01(D1/0x402D0) = "0" (default) SOUT0: Serial I/F Ch. 0 data output when CFP01(D1/0x402D0) = "1"
P02 #SCLK0	153	I/O	–	P02: I/O port when CFP02(D2/0x402D0) = "0" (default) #SCLK0: Serial I/F Ch. 0 clock input/output when CFP02(D2/0x402D0) = "1"
P03 #SRDY0	152	I/O	–	P03: I/O port when CFP03(D3/0x402D0) = "0" (default) #SRDY0: Serial I/F Ch. 0 ready signal output when CFP03(D3/0x402D0) = "1"

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Pin name	Pin No.	I/O	Pull-up	Function
P04 SIN1 #DMAACK2	147	I/O	–	P04: I/O port when CFP04(D4/0x402D0) = "0" and CFEX4(D4/0x402DF) = "0" (default) SIN1: Serial I/F Ch. 1 data input when CFP04(D4/0x402D0) = "1" and CFEX4(D4/0x402DF) = "0" #DMAACK2: HSDMA Ch. 2 acknowledge output when CFEX4(D4/0x402DF) = "1"
P05 SOUT1 #DMAEND2	146	I/O	–	P05: I/O port when CFP05(D5/0x402D0) = "0" and CFEX5(D5/0x402DF) = "0" (default) SOUT1: Serial I/F Ch. 1 data output when CFP05(D5/0x402D0) = "1" and CFEX5(D5/0x402DF) = "0" #DMAEND2: HSDMA Ch. 2 end-of-transfer signal output when CFEX5(D5/0x402DF) = "1"
P06 #SCLK1 #DMAACK3	145	I/O	–	P06: I/O port when CFP06(D6/0x402D0) = "0" and CFEX6(D6/0x402DF) = "0" (default) #SCLK1: Serial I/F Ch. 1 clock input/output when CFP06(D6/0x402D0) = "1" and CFEX6(D6/0x402DF) = "0" #DMAACK3: HSDMA Ch. 3 acknowledge output when CFEX6(D6/0x402DF) = "1"
P07 #SRDY1 #DMAEND3	144	I/O	–	P07: I/O port when CFP07(D7/0x402D0) = "0" and CFEX7(D7/0x402DF) = "0" (default) #SRDY1: Serial I/F Ch. 1 ready signal output when CFP07(D7/0x402D0) = "1" and CFEX5(D5/0x402DF) = "0" #DMAEND3: HSDMA Ch. 3 end-of-transfer signal output when CFEX7(D7/0x402DF) = "1"
P10 EXCL0 T8UF0 DST0	142	I/O	–	P10: I/O port when CFP10(D0/0x402D4) = "0" and CFEX1(D1/0x402DF) = "0" EXCL0: 16-bit timer 0 event counter input when CFP10(D0/0x402D4) = "1", IOC10(D0/0x402D6) = "0" and CFEX1(D1/0x402DF) = "0" T8UF0: 8-bit timer 0 output when CFP10(D0/0x402D4) = "1", IOC10(D0/0x402D6) = "1" and CFEX1(D1/0x402DF) = "0" DST0: DST0 signal output when CFEX1(D1/0x402DF) = "1" (default)
P11 EXCL1 T8UF1 DST1	141	I/O	–	P11: I/O port when CFP11(D1/0x402D4) = "0" and CFEX1(D1/0x402DF) = "0" EXCL1: 16-bit timer 1 event counter input when CFP11(D1/0x402D4) = "1", IOC11(D1/0x402D6) = "0" and CFEX1(D1/0x402DF) = "0" T8UF1: 8-bit timer 1 output when CFP11(D1/0x402D4) = "1", IOC11(D1/0x402D6) = "1" and CFEX1(D1/0x402DF) = "0" DST1: DST1 signal output when CFEX1(D1/0x402DF) = "1" (default)
P12 EXCL2 T8UF2 DST2	140	I/O	–	P12: I/O port when CFP12(D2/0x402D4) = "0" and CFEX0(D0/0x402DF) = "0" EXCL2: 16-bit timer 2 event counter input when CFP12(D2/0x402D4) = "1", IOC12(D2/0x402D6) = "0" and CFEX0(D0/0x402DF) = "0" T8UF2: 8-bit timer 2 output when CFP12(D2/0x402D4) = "1", IOC12(D2/0x402D6) = "1" and CFEX0(D0/0x402DF) = "0" DST2: DST2 signal output when CFEX0(D0/0x402DF) = "1" (default)
P13 EXCL3 T8UF3 DPCO	139	I/O	–	P13: I/O port when CFP13(D3/0x402D4) = "0" and CFEX1(D1/0x402DF) = "0" EXCL3: 16-bit timer 3 event counter input when CFP13(D3/0x402D4) = "1", IOC13(D3/0x402D6) = "0" and CFEX1(D1/0x402DF) = "0" T8UF3: 8-bit timer 3 output when CFP13(D3/0x402D4) = "1", IOC13(D3/0x402D6) = "1" and CFEX1(D1/0x402DF) = "0" DPCO: DPCO signal output when CFEX1(D1/0x402DF) = "1" (default)
P14 FOSC1 DCLK	138	I/O	–	P14: I/O port when CFP14(D4/0x402D4) = "0" and CFEX0(D0/0x402DF) = "0" FOSC1: OSC1 clock output when CFP14(D4/0x402D4) = "1" and CFEX0(D0/0x402DF) = "0" DCLK: DCLK signal output when CFEX0(D0/0x402DF) = "1" (default)
P15 EXCL4 #DMAEND0	136	I/O	–	P15: I/O port when CFP15(D5/0x402D4) = "0" (default) EXCL4: 16-bit timer 4 event counter input when CFP15(D5/0x402D4) = "1" and IOC15(D5/0x402D6) = "0" #DMAEND0: HSDMA Ch. 0 end-of-transfer signal output when CFP15(D5/0x402D4) = "1" and IOC15(D5/0x402D6) = "1"
P16 EXCL5 #DMAEND1	135	I/O	–	P16: I/O port when CFP16(D6/0x402D4) = "0" (default) EXCL5: 16-bit timer 5 event counter input when CFP16(D6/0x402D4) = "1" and IOC16(D6/0x402D6) = "0" #DMAEND1: HSDMA Ch. 1 end-of-transfer signal output when CFP16(D6/0x402D4) = "1" and IOC16(D6/0x402D6) = "1"

Pin name	Pin No.	I/O	Pull-up	Function
P22 TM0	132	I/O	–	P22: I/O port when CFP22(D2/0x402D8) = "0" (default) TM0: 16-bit timer 0 output when CFP22(D2/0x402D8) = "1"
P23 TM1	130	I/O	–	P23: I/O port when CFP23(D3/0x402D8) = "0" (default) TM1: 16-bit timer 1 output when CFP23(D3/0x402D8) = "1"
P24 TM2	129	I/O	–	P24: I/O port when CFP24(D4/0x402D8) = "0" (default) TM2: 16-bit timer 2 output when CFP24(D4/0x402D8) = "1"
P25 TM3	128	I/O	–	P25: I/O port when CFP25(D5/0x402D8) = "0" (default) TM3: 16-bit timer 3 output when CFP25(D5/0x402D8) = "1"
P26 TM4	127	I/O	–	P26: I/O port when CFP26(D6/0x402D8) = "0" (default) TM4: 16-bit timer 4 output when CFP26(D6/0x402D8) = "1"
P27 TM5	126	I/O	–	P27: I/O port when CFP27(D7/0x402D8) = "0" (default) TM5: 16-bit timer 5 output when CFP27(D7/0x402D8) = "1"

Table 1.3.5 List of Pins for LCD Controller (SED1375)

Pin name	Pin No.	I/O	Pull-up	Function																																				
FPDAT11 GPIO4 INVERSE	92	I/O	–	FPDAT11: Panel data bit 11 for TFT/MD-TFD panels GPIO4: General-purpose I/O pin (default) INVERSE: Inverse video select pin																																				
FPDAT10 GPIO3	93	I/O	–	FPDAT10: Panel data bit 10 for TFT/MD-TFD panels GPIO3: General-purpose I/O pin (default)																																				
FPDAT9 GPIO2	94	I/O	–	FPDAT9: Panel data bit 9 for TFT/MD-TFD panels GPIO2: General-purpose I/O pin (default)																																				
FPDAT8 GPIO1	96	I/O	–	FPDAT8: Panel data bit 8 for TFT/MD-TFD panels GPIO1: General-purpose I/O pin (default)																																				
FPDAT[7:0]	98–100, 102–105, 107	O	–	Panel data bits [7:0]																																				
FPFRAME	109	O	–	Frame pulse																																				
FPLINE	108	O	–	Line pulse																																				
FPSHIFT	97	O	–	Shift clock																																				
LCDPWR	112	O	–	Active high LCD power control																																				
DRDY MOD FPSHIFT2	110	O	–	DRDY: TFT/MD-TFD display enable MOD: LCD backplane bias (default) FPSHIFT2: Second shift clock for color passive panel (8-bit single format 1)																																				
CLKI	161	I	–	External clock input																																				
CKSEL[2:0]	157–159	I	–	Clock source selection <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th>CKSEL2</th> <th>CKSEL1</th> <th>CKSEL0</th> <th>Clock source</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>1</td> <td>1</td> <td>reserved</td> </tr> <tr> <td>1</td> <td>1</td> <td>0</td> <td>1375 disable mode</td> </tr> <tr> <td>1</td> <td>0</td> <td>1</td> <td>External input clock from the CLKI pin</td> </tr> <tr> <td>1</td> <td>0</td> <td>0</td> <td>OSC3 oscillation clock x 1/4</td> </tr> <tr> <td>0</td> <td>1</td> <td>1</td> <td>OSC3 oscillation clock x 1/3</td> </tr> <tr> <td>0</td> <td>1</td> <td>0</td> <td>OSC3 oscillation clock x 1/2</td> </tr> <tr> <td>0</td> <td>0</td> <td>1</td> <td>OSC3 oscillation clock</td> </tr> <tr> <td>0</td> <td>0</td> <td>0</td> <td>PLL output clock</td> </tr> </tbody> </table>	CKSEL2	CKSEL1	CKSEL0	Clock source	1	1	1	reserved	1	1	0	1375 disable mode	1	0	1	External input clock from the CLKI pin	1	0	0	OSC3 oscillation clock x 1/4	0	1	1	OSC3 oscillation clock x 1/3	0	1	0	OSC3 oscillation clock x 1/2	0	0	1	OSC3 oscillation clock	0	0	0	PLL output clock
CKSEL2	CKSEL1	CKSEL0	Clock source																																					
1	1	1	reserved																																					
1	1	0	1375 disable mode																																					
1	0	1	External input clock from the CLKI pin																																					
1	0	0	OSC3 oscillation clock x 1/4																																					
0	1	1	OSC3 oscillation clock x 1/3																																					
0	1	0	OSC3 oscillation clock x 1/2																																					
0	0	1	OSC3 oscillation clock																																					
0	0	0	PLL output clock																																					
CNF3	156	I	–	Access method (endian) selection 1: Big endian, 0: Little endian																																				
GPIO0	91	I/O	–	General-purpose I/O pin																																				

- *1 The SED1375 CNF[2:0] pins are not available in the E0C332L01 and have been replaced with the CKSEL[2:0] pins. Refer to "SED1375 Hardware Functional Specification" for details of the LCD interface pins.
- *2 Note that some pins in Table 1.3.5 use different I/O interface level (power source) from other LCD controller pins.
 CLKI, CKSEL[2:0], CNF3 pins (signals): VDDE1 (power voltage for I/O interface)
 Other pins (signals): VDDE2 (power voltage for LCD interface)

Table 1.3.6 List of Pins for Clock Generator

Pin name	Pin No.	I/O	Pull-up	Function				
OSC1	150	I	–	Low-speed (OSC1) oscillation input (32 kHz crystal oscillator or external clock input)				
OSC2	149	O	–	Low-speed (OSC1) oscillation output				
OSC3	165	I	–	High-speed (OSC3) oscillation input (crystal/ceramic oscillator or external clock input)				
OSC4	164	O	–	High-speed (OSC3) oscillation output				
PLLS[1:0]	170,171	I	–	PLL set-up pins				
				PLLS1	PLLS0	f_{in} (f_{osc3})	f_{out} (f_{PSCIN})	
				1	1	10–30MHz	20–60MHz	*1
						10–25MHz	20–50MHz	*2
				0	1	10–15MHz	40–60MHz	*1
		10–12.5MHz	40–50MHz	*2				
		0	0	PLL is not used	L			
				*1: ROM-less model with 3.3 V \pm 0.3 V operating voltage				
				*2: ROM built-in model, or 3.0 V \pm 0.3 V operating voltage				
PLL_C	174	I/O	–	Capacitor connecting pin for PLL				

Table 1.3.7 List of Other Pins

Pin name	Pin No.	I/O	Pull-up/down	Function
ICEMD	162	I	With pull-down	High-impedance control input pin When this pin is set to High, all the output pins go into high-impedance state. This makes it possible to disable the E0C33 chip on the board.
DSIO	176	I/O	With pull-up	Serial I/O pin for debugging This pin is used to communicate with the debugging tool ICD33.
#X2SPD	168	I	–	Clock doubling mode set-up pin 1: CPU clock = bus clock x 1, 0: CPU clock = bus clock x 2
#NMI	172	I	With pull-up	NMI request input pin
#RESET	175	I	With pull-up	Initial reset input pin

Note: "#" in the pin names indicates that the signal is low active.

2 Power Supply

This chapter explains the operating voltage of the E0C332L01.

2.1 Power Supply Pins

The E0C332L01 has the power supply pins shown in Table 2.1.1.

Table 2.1.1 Power Supply Pins

Pin name	Pin No.	Function
VDD	17,41,72,101,125,148,169	Power supply (+) for the internal logic
VSS	11,23,35,48,58,66,78,90,106, 118,131,143,151,163,173	Power supply (-); GND
VDDE1	5,29,54,84,137,160	Power supply (+) for the I/O block
VDDE2	95,111	Power supply (+) for the LCD interface
AVDDE	62	Analog system power supply (+); AVDDE = VDDE

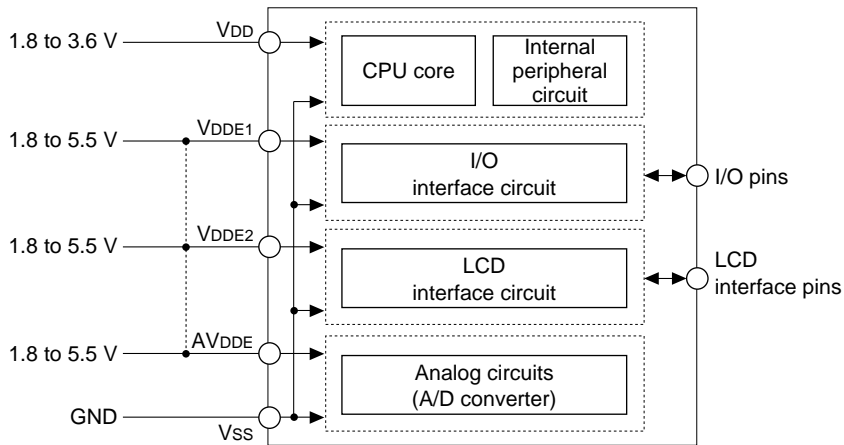


Figure 2.1.1 Power Supply System

2.2 Operating Voltage (V_{DD} , V_{SS})

The core CPU and internal peripheral circuits operate with a voltage supplied between the V_{DD} and V_{SS} pins. The following operating voltage can be used:

$$V_{DD} = 1.8 \text{ V to } 3.6 \text{ V} \quad (V_{SS} = \text{GND})$$

Note: The E0C332L01 has 7 V_{DD} pins and 15 V_{SS} pins. Be sure to supply the operating voltage to all the pins. Do not open any of them.

The operating clock frequency range (OSC3) is 5 MHz to 50 MHz with this voltage.

2.3 Power Supply for I/O Interface (V_{DDE1})

The V_{DDE1} voltage is used for interfacing with external I/O signals. For the I/O interface of the E0C332L01, the V_{DDE1} voltage is used as high level and the V_{SS} voltage as low level.

Normally, supply the same voltage level as V_{DD} . It can be supplied separately from V_{DD} for 5 V interface. The V_{SS} pin is used for the ground common with V_{DD} and V_{DDE2} .

The following voltage is enabled for V_{DDE1} :

$$V_{DDE1} = 1.8 \text{ V to } 5.5 \text{ V (} V_{SS} = \text{GND)}$$

- Notes:**
- The E0C332L01 has 6 V_{DDE1} pins. Be sure to supply a voltage to all the pins. Do not open any of them.
 - When $V_{DDE1} = 5 \text{ V}$, the data bus inputs CMOS-interface-level signals, not TTL level.
 - When an external clock is input to the OSC1 or OSC3 pin, the clock signal level must be V_{DD} .
 - The interface voltage level of the DSIO, P10, P11, P12, P13 and P14 pins is V_{DD} .

2.4 Power Supply for LCD Interface (V_{DDE2})

The V_{DDE2} voltage is used for interfacing with LCD control signals. It can be supplied separately from V_{DD} and V_{DDE1} . The V_{SS} pin is used for the ground common with V_{DD} and V_{DDE1} .

The LCD controller pins/signals (pin No. 91 to 112) shown in Table 1.3.5, "List of Pins for LCD Controller (SED1375)", except for the CLKI, CKSEL[2:0] and CNF3 pins use the V_{DDE2} voltage as their I/O interface level. Note that the CLKI, CKSEL[2:0] and CNF3 pins use V_{DDE1} (power voltage for I/O interface).

The following voltage is enabled for V_{DDE2} :

$$V_{DDE2} = 1.8 \text{ V to } 5.5 \text{ V (} V_{SS} = \text{GND)}$$

- Note:** The E0C332L01 has 2 V_{DDE2} pins. Be sure to supply a voltage to all the pins. Do not open any of them.

2.5 Power Supply for Analog Circuits (AV_{DDE})

The analog power supply pin (AV_{DDE}) is provided separately from the V_{DD} and $V_{DDE1/2}$ pins in order that the digital circuits do not affect the analog circuit (A/D converter). The AV_{DDE} pin is used to supply an analog power voltage and the V_{SS} pin is used as the analog ground.

Supply the same voltage level as the V_{DDE1} to the AV_{DDE} pin.

$$AV_{DDE} = V_{DDE1}, V_{SS} = \text{GND}$$

- Note:** Be sure to supply V_{DDE1} to the AV_{DDE} pin even if the analog circuit is not used.

Noise on the analog power lines decrease the A/D converting precision, so use a stabilized power supply and make the board pattern with consideration given to that.

3 Internal Memory

This chapter explains the internal memory configuration.

Figure 3.1 shows the E0C332L01 memory map.

Area	Address	
Areas 18–11	0xFFFFFFFF	External Memory
	0x1000000	
Area 10	0x0FFFFFFF	External Memory
	0x0C20000	Internal ROM (128KB)
	0x0C1FFFFF	
	0x0C00000	
Areas 9–7	0x0BFFFFFF	External Memory
	0x0400000	
Area 6	0x03FFFFFF	(Mirror of VRAM and LCD control registers)
	0x03A0000	LCD control registers
	0x039FFFFF	
	0x039FFE0	
	0x039FFDF	(Reserved)
	0x038A000	
	0x0389FFF	VRAM (40KB)
	0x0380000	
	0x037FFFF	(Reserved)
	0X0300000	
Areas 5–4	0x02FFFFFF	External Memory
	0x0100000	
Area 3	0x00FFFFFF	(Reserved)
	0x0080000	For middleware use
Area 2	0x007FFFF	(Reserved)
	0x0060000	For CPU, debug mode
Area 1	0x005FFFF	(Mirror of internal I/O)
	0x0050000	
	0x004FFFF	Internal I/O
	0x0040000	
	0x003FFFF	(Mirror of internal I/O)
Area 0	0x0030000	
	0x0002FFF	(Mirror of internal RAM)
	0x0002000	
	0x0001FFF	Internal RAM (8KB)
0x0000000		

Figure 3.1 Memory Map

Area 2 is used in debug mode only and it cannot be accessed in user mode (normal program execution status).

Area 6 is configured as an external area at initial reset. To access the LCD control registers and VRAM in the SED1375 block, the "Area 6 internal/external access control" bit in the access control register (0x48132) must be set as "internal access" (A6IO/D9 = 1).

3.1 ROM and Boot Address

The E0C332L01 has a built-in 128KB ROM. The ROM is allocated to Area 10, address 0x0C00000 to address 0x0C1FFFF. The boot address is fixed at 0x0C00000 (beginning of the ROM) in the E0C332L01.

The built-in ROM can be used when the EA10MD[1:0] pins are set to "10" (internal ROM boot mode) and is read in 1 cycle.

For setting up Area 10, refer to the "BCU (Bus Controller Unit)" section in the "E0C33 Block Technical Manual".

3.2 RAM

The E0C332L01 has a built-in 8KB RAM. The RAM is allocated to Area 0, address 0x0000000 to address 0x0001FFF.

The internal RAM is a 32-bit sized device and data can be read/written in 1 cycle regardless of data size (byte, half-word or word).

3.3 VRAM

The E0C332L01 has a built-in 40KB VRAM. The VRAM is allocated to Area 6, address 0x0380000 to address 0x0389FFF and is accessed via the built-in LCD controller (SED1375).

When the LCD controller is disabled by setting the CKSEL[2:0] pins to "110", the VRAM is disconnected from the LCD controller but remains connected to the E0C332L01 bus. This allows use of the VRAM as a general-purpose RAM (device size: 16 bits).

When using the VRAM as a general-purpose RAM, set the number of wait cycles for accessing as follows:

- (1) When the core voltage is $3.3\text{ V} \pm 0.3\text{ V}$ and the bus clock frequency is lower than 20 MHz: No wait
- (2) When the core voltage is $3.3\text{ V} \pm 0.3\text{ V}$ and the bus clock frequency is 20 MHz or higher: 1 wait
- (3) When the core voltage is $3.0\text{ V} \pm 0.3\text{ V}$: 1 wait (bus clock frequency: 33 MHz max.)
- (4) When the core voltage is $2.0\text{ V} \pm 0.2\text{ V}$: 1 wait (bus clock frequency: 20 MHz max.)

The number of wait cycles can be set using the "Area 6 wait control" bit (A6WT[2:0]/D[A:8]) in Areas 6–4 setup register (0x4812A).

4 Peripheral Circuits

This chapter lists the built-in peripheral circuits and the I/O memory map. For details of the circuits, refer to the "E0C33 Block Technical Manual" and the "SED1375 Hardware Functional Specification".

4.1 List of Peripheral Circuits

The E0C332L01 consists of the C33 ASIC Macro Blocks: C33 Core Block, C33 Peripheral Block, C33 DMA Block and C33 Analog Block. It also contains the SED1375 LCD Controller Block.

C33 Core Block

CPU	E0C33000 32-bit RISC type CPU
BCU (Bus Control Unit)	24-bit external address bus and 16-bit data bus All the BCU functions can be used.
ITC (Interrupt Controller)	39 types of interrupts are available.
CLG (Clock Generator)	OSC3 oscillation circuit (33 MHz Max.), PLL and OSC1 oscillation circuit (32.768 kHz Typ.) built-in
DBG (Debug Unit)	Functional block for debugging with the ICD33 (In-Circuit Debugger for E0C33 Family)

C33 Peripheral Block

Prescaler	Programmable clock generator for peripheral circuits
8-bit programmable timer	4 channels with clock output function
16-bit programmable timer	6 channels with event counter, clock output and watchdog timer functions
Serial interface	2 channels (asynchronous mode, clock synchronous mode and IrDA are selectable.)
Input and I/O ports	13 bits of input ports and 29 bits of I/O ports (used for peripheral I/O)
Clock timer	1 channel with alarm function

C33 DMA Block

HSDMA (High-Speed DMA)	4 channels
IDMA (Intelligent DMA)	128 channels

C33 Analog Block

A/D converter	10-bit A/D converter with 8 input channels
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SED1375 Block

LCD controller	40KB VRAM built-in 4 or 8-bit monochrome/color LCD interface Active matrix TFT/D-TFD interface 2, 4 or 16-level (1, 2 or 4 bit-per-pixel) gray-scale display 2, 4, 16 or 256-level (1, 2, 4 or 8 bit-per-pixel) color display Resolution examples: 640 × 480 dots with 1bpp color dipth 640 × 240 dots with 2bpp color dipth 320 × 240 dots with 4bpp color dipth 320 × 160 dots with 8bpp color dipth
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4.2 I/O Memory Map

Table 4.2.1 I/O Memory Map

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
8-bit timer clock select register	0040146 (B)	D7-4	–	reserved	–	–	–	0 when being read.			
		D3	P8TPCK3	8-bit timer 3 clock selection	1 0/1	0	Divided clk.	0	R/W	0: selected by	
		D2	P8TPCK2	8-bit timer 2 clock selection	1 0/1	0	Divided clk.	0	R/W	Prescaler clock select	
		D1	P8TPCK1	8-bit timer 1 clock selection	1 0/1	0	Divided clk.	0	R/W	register (0x40181)	
		D0	P8TPCK0	8-bit timer 0 clock selection	1 0/1	0	Divided clk.	0	R/W		
16-bit timer 0 clock control register	0040147 (B)	D7-4	–	reserved	–	–	–	–	0 when being read.		
		D3	P16TON0	16-bit timer 0 clock control	1 On	0 Off	0	R/W			
		D2	P16TS02	16-bit timer 0	P16TS0[2:0]		Division ratio		0	R/W	0: selected by
		D1	P16TS01	clock division ratio selection	1 1 1	0/4096		0		Prescaler clock select	
		D0	P16TS00		1 1 0	0/1024		0		register (0x40181)	
					1 0 1	0/256					
					1 0 0	0/64				16-bit timer 0 can be	
					0 1 1	0/16				used as a watchdog	
					0 1 0	0/4				timer.	
			0 0 1	0/2							
			0 0 0	0/1							
16-bit timer 1 clock control register	0040148 (B)	D7-4	–	reserved	–	–	–	–	0 when being read.		
		D3	P16TON1	16-bit timer 1 clock control	1 On	0 Off	0	R/W			
		D2	P16TS12	16-bit timer 1	P16TS1[2:0]		Division ratio		0	R/W	0: selected by
		D1	P16TS11	clock division ratio selection	1 1 1	0/4096		0		Prescaler clock select	
		D0	P16TS10		1 1 0	0/1024		0		register (0x40181)	
					1 0 1	0/256					
					1 0 0	0/64					
					0 1 1	0/16					
					0 1 0	0/4					
			0 0 1	0/2							
			0 0 0	0/1							
16-bit timer 2 clock control register	0040149 (B)	D7-4	–	reserved	–	–	–	–	0 when being read.		
		D3	P16TON2	16-bit timer 2 clock control	1 On	0 Off	0	R/W			
		D2	P16TS22	16-bit timer 2	P16TS2[2:0]		Division ratio		0	R/W	0: selected by
		D1	P16TS21	clock division ratio selection	1 1 1	0/4096		0		Prescaler clock select	
		D0	P16TS20		1 1 0	0/1024		0		register (0x40181)	
					1 0 1	0/256					
					1 0 0	0/64					
					0 1 1	0/16					
					0 1 0	0/4					
			0 0 1	0/2							
			0 0 0	0/1							
16-bit timer 3 clock control register	004014A (B)	D7-4	–	reserved	–	–	–	–	0 when being read.		
		D3	P16TON3	16-bit timer 3 clock control	1 On	0 Off	0	R/W			
		D2	P16TS32	16-bit timer 3	P16TS3[2:0]		Division ratio		0	R/W	0: selected by
		D1	P16TS31	clock division ratio selection	1 1 1	0/4096		0		Prescaler clock select	
		D0	P16TS30		1 1 0	0/1024		0		register (0x40181)	
					1 0 1	0/256					
					1 0 0	0/64					
					0 1 1	0/16					
					0 1 0	0/4					
			0 0 1	0/2							
			0 0 0	0/1							
16-bit timer 4 clock control register	004014B (B)	D7-4	–	reserved	–	–	–	–	0 when being read.		
		D3	P16TON4	16-bit timer 4 clock control	1 On	0 Off	0	R/W			
		D2	P16TS42	16-bit timer 4	P16TS4[2:0]		Division ratio		0	R/W	0: selected by
		D1	P16TS41	clock division ratio selection	1 1 1	0/4096		0		Prescaler clock select	
		D0	P16TS40		1 1 0	0/1024		0		register (0x40181)	
					1 0 1	0/256					
					1 0 0	0/64					
					0 1 1	0/16					
					0 1 0	0/4					
			0 0 1	0/2							
			0 0 0	0/1							

(B) in [Address] indicates an 8-bit register and (HW) indicates a 16-bit register.

The meaning of the symbols described in [Init.] are listed below:

0, 1: Initial values that are set at initial reset.

(However, the registers for the bus and input/output ports are not initialized at hot start.)

X: Not initialized at initial reset.

–: Not set in the circuit.

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
16-bit timer 5 clock control register	004014C (B)	D7-4	–	reserved	–	–	–	0 when being read.		
		D3	P16TON5	16-bit timer 5 clock control	1 On	0 Off	0	R/W		
		D2	P16TS52	16-bit timer 5	P16TS5[2:0]		Division ratio	0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D1	P16TS51	clock division ratio selection	1	1	1	θ/4096	0	
		D0	P16TS50		1	1	0	θ/1024	0	
					1	0	1	θ/256		
					1	0	0	θ/64		
					0	1	1	θ/16		
		0	1		0	θ/4				
		0	0	1	θ/2					
		0	0	0	θ/1					
8-bit timer 0/1 clock control register	004014D (B)	D7	P8TON1	8-bit timer 1 clock control	1 On	0 Off	0	R/W		
		D6	P8TS12	8-bit timer 1	P8TS1[2:0]		Division ratio	0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D5	P8TS11	clock division ratio selection	1	1	1	θ/4096	0	
		D4	P8TS10		1	1	0	θ/2048	0	
					1	0	1	θ/1024		
					1	0	0	θ/512		
					0	1	1	θ/256		
					0	1	0	θ/128		
					0	0	1	θ/64		
					0	0	0	θ/32		
		D3	P8TON0	8-bit timer 0 clock control	1 On	0 Off	0	R/W		
		D2	P8TS02	8-bit timer 0	P8TS0[2:0]		Division ratio	0	R/W	θ: selected by Prescaler clock select register (0x40181)
D1	P8TS01	clock division ratio selection	1	1	1	θ/256	0			
D0	P8TS00		1	1	0	θ/128	0			
			1	0	1	θ/64				
			1	0	0	θ/32				
			0	1	1	θ/16				
			0	1	0	θ/8				
			0	0	1	θ/4				
			0	0	0	θ/2				
8-bit timer 2/3 clock control register	004014E (B)	D7	P8TON3	8-bit timer 3 clock control	1 On	0 Off	0	R/W		
		D6	P8TS32	8-bit timer 3	P8TS3[2:0]		Division ratio	0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D5	P8TS31	clock division ratio selection	1	1	1	θ/256	0	
		D4	P8TS30		1	1	0	θ/128	0	
					1	0	1	θ/64		
					1	0	0	θ/32		
					0	1	1	θ/16		
					0	1	0	θ/8		
					0	0	1	θ/4		
					0	0	0	θ/2		
		D3	P8TON2	8-bit timer 2 clock control	1 On	0 Off	0	R/W		
		D2	P8TS22	8-bit timer 2	P8TS2[2:0]		Division ratio	0	R/W	θ: selected by Prescaler clock select register (0x40181)
D1	P8TS21	clock division ratio selection	1	1	1	θ/4096	0			
D0	P8TS20		1	1	0	θ/2048	0			
			1	0	1	θ/64				
			1	0	0	θ/32				
			0	1	1	θ/16				
			0	1	0	θ/8				
			0	0	1	θ/4				
			0	0	0	θ/2				
A/D clock control register	004014F (B)	D7-4	–	reserved	–	–	–	0 when being read.		
		D3	PSONAD	A/D converter clock control	1 On	0 Off	0	R/W		
		D2	PSAD2	A/D converter clock division ratio	P8TS0[2:0]		Division ratio	0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D1	PSAD1	selection	1	1	1	θ/256	0	
		D0	PSAD0		1	1	0	θ/128	0	
					1	0	1	θ/64		
					1	0	0	θ/32		
					0	1	1	θ/16		
		0	1		0	θ/8				
		0	0	1	θ/4					
		0	0	0	θ/2					

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Clock timer Run/Stop register	0040151 (B)	D7-2	–	reserved	–	–	–	0 when being read.	
		D1	TCRST	Clock timer reset	1 Reset	0 Invalid	X W	0 when being read.	
		D0	TCRUN	Clock timer Run/Stop control	1 Run	0 Stop	X R/W		
Clock timer interrupt control register	0040152 (B)	D7	TCISE2	Clock timer interrupt factor selection	TCISE[2:0]	Interrupt factor	X	R/W	
		D6	TCISE1		1 1 1	None	X		
		D5	TCISE0		1 1 0	Day	X		
					1 0 1	Hour			
					1 0 0	Minute			
					0 1 1	1 Hz			
					0 1 0	2 Hz			
				0 0 1	8 Hz				
				0 0 0	32 Hz				
			D4	TCASE2	Clock timer alarm factor selection	TCASE[2:0]	Alarm factor	X	R/W
D3	TCASE1	1 X X	Day	X					
D2	TCASE0	X 1 X	Hour	X					
		X X 1	Minute						
		0 0 0	None						
	D1	TCIF	Interrupt factor generation flag	1 Generated	0 Not generated	X	R/W	Reset by writing 1.	
	D0	TCAF	Alarm factor generation flag	1 Generated	0 Not generated	X	R/W	Reset by writing 1.	
Clock timer divider register	0040153 (B)	D7	TCDF7	Clock timer data 1 Hz	1 High	0 Low	X R		
		D6	TCDF6	Clock timer data 2 Hz	1 High	0 Low	X R		
		D5	TCDF5	Clock timer data 4 Hz	1 High	0 Low	X R		
		D4	TCDF4	Clock timer data 8 Hz	1 High	0 Low	X R		
		D3	TCDF3	Clock timer data 16 Hz	1 High	0 Low	X R		
		D2	TCDF2	Clock timer data 32 Hz	1 High	0 Low	X R		
		D1	TCDF1	Clock timer data 64 Hz	1 High	0 Low	X R		
		D0	TCDF0	Clock timer data 128 Hz	1 High	0 Low	X R		
Clock timer second register	0040154 (B)	D7-6	–	reserved	–	–	–	0 when being read.	
		D5	TCMD5	Clock timer second counter data TCMD5 = MSB TCMD0 = LSB	0 to 59 seconds		X	R	
		D4	TCMD4		X				
		D3	TCMD3		X				
		D2	TCMD2		X				
		D1	TCMD1		X				
		D0	TCMD0		X				
Clock timer minute register	0040155 (B)	D7-6	–	reserved	–	–	–	0 when being read.	
		D5	TCHD5	Clock timer minute counter data TCHD5 = MSB TCHD0 = LSB	0 to 59 minutes		X	R/W	
		D4	TCHD4		X				
		D3	TCHD3		X				
		D2	TCHD2		X				
		D1	TCHD1		X				
		D0	TCHD0		X				
Clock timer hour register	0040156 (B)	D7-5	–	reserved	–	–	–	0 when being read.	
		D4	TCDD4	Clock timer hour counter data TCDD4 = MSB TCDD0 = LSB	0 to 23 hours		X	R/W	
		D3	TCDD3		X				
		D2	TCDD2		X				
		D1	TCDD1		X				
		D0	TCDD0		X				
Clock timer day (low-order) register	0040157 (B)	D7	TCND7	Clock timer day counter data (low-order 8 bits) TCND0 = LSB	0 to 65535 days (low-order 8 bits)		X	R/W	
		D6	TCND6		X				
		D5	TCND5		X				
		D4	TCND4		X				
		D3	TCND3		X				
		D2	TCND2		X				
		D1	TCND1		X				
		D0	TCND0		X				
Clock timer day (high-order) register	0040158 (B)	D7	TCND15	Clock timer day counter data (high-order 8 bits) TCND15 = MSB	0 to 65535 days (high-order 8 bits)		X	R/W	
		D6	TCND14		X				
		D5	TCND13		X				
		D4	TCND12		X				
		D3	TCND11		X				
		D2	TCND10		X				
		D1	TCND9		X				
		D0	TCND8		X				
Clock timer minute comparison register	0040159 (B)	D7-6	–	reserved	–	–	–	0 when being read.	
		D5	TCCH5	Clock timer minute comparison data (Note) Can be set within 0–63.	0 to 59 minutes		X	R/W	
		D4	TCCH4		X				
		D3	TCCH3		X				
		D2	TCCH2		X				
		D1	TCCH1		X				
		D0	TCCH0		X				

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
Clock timer hour comparison register	004015A (B)	D7-5	–	reserved	–	–	–	0 when being read.
		D4	TCCD4	Clock timer hour comparison data	0 to 23 hours	X	R/W	
		D3	TCCD3	TCCD4 = MSB	(Note) Can be set within 0–31.	X		
		D2	TCCD2	TCCD0 = LSB		X		
		D1	TCCD1			X		
		D0	TCCD0			X		
Clock timer day comparison register	004015B (B)	D7-5	–	reserved	–	–	–	0 when being read.
		D4	TCCN4	Clock timer day comparison data	0 to 31 days	X	R/W	Compared with TCND[4:0].
		D3	TCCN3	TCCN4 = MSB		X		
		D2	TCCN2	TCCN0 = LSB		X		
		D1	TCCN1			X		
		D0	TCCN0			X		

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
8-bit timer 0 control register	0040160 (B)	D7-3	–	reserved	–	–	–	0 when being read.	
		D2	PTOUT0	8-bit timer 0 clock output control	1 On	0 Off	0	R/W	
		D1	PSET0	8-bit timer 0 preset	1 Preset	0 Invalid	–	W	0 when being read.
		D0	PTRUN0	8-bit timer 0 Run/Stop control	1 Run	0 Stop	0	R/W	
8-bit timer 0 reload data register	0040161 (B)	D7	RLD07	8-bit timer 0 reload data RLD07 = MSB RLD00 = LSB	0 to 255		X	R/W	
		D6	RLD06		X				
		D5	RLD05		X				
		D4	RLD04		X				
		D3	RLD03		X				
		D2	RLD02		X				
		D1	RLD01		X				
		D0	RLD00		X				
8-bit timer 0 counter data register	0040162 (B)	D7	PTD07	8-bit timer 0 counter data PTD07 = MSB PTD00 = LSB	0 to 255		X	R	
		D6	PTD06		X				
		D5	PTD05		X				
		D4	PTD04		X				
		D3	PTD03		X				
		D2	PTD02		X				
		D1	PTD01		X				
		D0	PTD00		X				
8-bit timer 1 control register	0040164 (B)	D7-3	–	reserved	–	–	–	0 when being read.	
		D2	PTOUT1	8-bit timer 1 clock output control	1 On	0 Off	0	R/W	
		D1	PSET1	8-bit timer 1 preset	1 Preset	0 Invalid	–	W	0 when being read.
		D0	PTRUN1	8-bit timer 1 Run/Stop control	1 Run	0 Stop	0	R/W	
8-bit timer 1 reload data register	0040165 (B)	D7	RLD17	8-bit timer 1 reload data RLD17 = MSB RLD10 = LSB	0 to 255		X	R/W	
		D6	RLD16		X				
		D5	RLD15		X				
		D4	RLD14		X				
		D3	RLD13		X				
		D2	RLD12		X				
		D1	RLD11		X				
		D0	RLD10		X				
8-bit timer 1 counter data register	0040166 (B)	D7	PTD17	8-bit timer 1 counter data PTD17 = MSB PTD10 = LSB	0 to 255		X	R	
		D6	PTD16		X				
		D5	PTD15		X				
		D4	PTD14		X				
		D3	PTD13		X				
		D2	PTD12		X				
		D1	PTD11		X				
		D0	PTD10		X				
8-bit timer 2 control register	0040168 (B)	D7-3	–	reserved	–	–	–	0 when being read.	
		D2	PTOUT2	8-bit timer 2 clock output control	1 On	0 Off	0	R/W	
		D1	PSET2	8-bit timer 2 preset	1 Preset	0 Invalid	–	W	0 when being read.
		D0	PTRUN2	8-bit timer 2 Run/Stop control	1 Run	0 Stop	0	R/W	
8-bit timer 2 reload data register	0040169 (B)	D7	RLD27	8-bit timer 2 reload data RLD27 = MSB RLD20 = LSB	0 to 255		X	R/W	
		D6	RLD26		X				
		D5	RLD25		X				
		D4	RLD24		X				
		D3	RLD23		X				
		D2	RLD22		X				
		D1	RLD21		X				
		D0	RLD20		X				
8-bit timer 2 counter data register	004016A (B)	D7	PTD27	8-bit timer 2 counter data PTD27 = MSB PTD20 = LSB	0 to 255		X	R	
		D6	PTD26		X				
		D5	PTD25		X				
		D4	PTD24		X				
		D3	PTD23		X				
		D2	PTD22		X				
		D1	PTD21		X				
		D0	PTD20		X				

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
8-bit timer 3 control register	004016C (B)	D7-3	–	reserved	–	–	–	0 when being read.	
		D2	PTOUT3	8-bit timer 3 clock output control	1 On	0 Off	0	R/W	
		D1	PSET3	8-bit timer 3 preset	1 Preset	0 Invalid	–	W	0 when being read.
		D0	PTRUN3	8-bit timer 3 Run/Stop control	1 Run	0 Stop	0	R/W	
8-bit timer 3 reload data register	004016D (B)	D7	RLD37	8-bit timer 3 reload data RLD37 = MSB RLD30 = LSB	0 to 255		X	R/W	
		D6	RLD36				X		
		D5	RLD35				X		
		D4	RLD34				X		
		D3	RLD33				X		
		D2	RLD32				X		
		D1	RLD31				X		
		D0	RLD30				X		
8-bit timer 3 counter data register	004016E (B)	D7	PTD37	8-bit timer 3 counter data PTD37 = MSB PTD30 = LSB	0 to 255		X	R	
		D6	PTD36				X		
		D5	PTD35				X		
		D4	PTD34				X		
		D3	PTD33				X		
		D2	PTD32				X		
		D1	PTD31				X		
		D0	PTD30				X		

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Watchdog timer write-protect register	0040170 (B)	D7	WRWD	EWD write protection	1	Write enabled	0	Write-protect	0	R/W	
		D6-0	–	–	–	–	–	–	–	–	0 when being read.
Watchdog timer enable register	0040171 (B)	D7-2	–	–	–	–	–	–	–	–	0 when being read.
		D1	EWD	Watchdog timer enable	1	NMI enabled	0	NMI disabled	0	R/W	
		D0	–	–	–	–	–	–	–	–	0 when being read.

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Power control register	0040180 (B)	D7	CLKDT1	System clock division ratio selection	CLKDT[1:0]	Division ratio	0	R/W			
		D6	CLKDT0				1			1	1/8
							1			0	1/4
							0			1	1/2
							0			0	1/1
		D5	PSCON	Prescaler On/Off control	1	On	0	Off		1	R/W
		D4-3	-	reserved		-	0	-	Writing 1 not allowed.		
		D2	CLKCHG	CPU operating clock switch	1	OSC3	0	OSC1	1	R/W	
		D1	SOSC3	High-speed (OSC3) oscillation On/Off	1	On	0	Off	1	R/W	
		D0	SOSC1	Low-speed (OSC1) oscillation On/Off	1	On	0	Off	1	R/W	
Prescaler clock select register	0040181 (B)	D7-1	-	reserved		-		0	-		
		D0	PSCDT0	Prescaler clock selection	1	OSC1	0	OSC3/PLL	0	R/W	
Clock option register	0040190 (B)	D7-4	-	-		-		-	-	0 when being read.	
		D3	HLT2OP	HALT clock option	1	On	0	Off	0	R/W	
		D2	8T1ON	OSC3-stabilize waiting function	1	Off	0	On	1	R/W	
		D1	-	reserved		-			0	-	Do not write 1.
		D0	PF1ON	OSC1 external output control	1	On	0	Off	0	R/W	
Power control protect register	004019E (B)	D7	CLGP7	Power control register protect flag	Writing 10010110 (0x96) removes the write protection of the power control register (0x40180). Writing another value set the write protection.	0	R/W				
		D6	CLGP6			0					
		D5	CLGP5			0					
		D4	CLGP4			0					
		D3	CLGP3			0					
		D2	CLGP2			0					
		D1	CLGP1			0					
		D0	CLGP0			0					

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Serial I/F Ch.0 transmit data register	00401E0 (B)	D7	TXD07	Serial I/F Ch.0 transmit data TXD07(06) = MSB TXD00 = LSB	0x0 to 0xFF(0x7F)		X	R/W	7-bit asynchronous mode does not use TXD07.		
		D6	TXD06				X				
		D5	TXD05				X				
		D4	TXD04				X				
		D3	TXD03				X				
		D2	TXD02				X				
		D1	TXD01				X				
		D0	TXD00				X				
Serial I/F Ch.0 receive data register	00401E1 (B)	D7	RXD07	Serial I/F Ch.0 receive data RXD07(06) = MSB RXD00 = LSB	0x0 to 0xFF(0x7F)		X	R	7-bit asynchronous mode does not use RXD07 (fixed at 0).		
		D6	RXD06				X				
		D5	RXD05				X				
		D4	RXD04				X				
		D3	RXD03				X				
		D2	RXD02				X				
		D1	RXD01				X				
		D0	RXD00				X				
Serial I/F Ch.0 status register	00401E2 (B)	D7-6	–	–	–		–	–	0 when being read.		
		D5	TEND0	Ch.0 transmit-completion flag	1	Transmitting	0	End	0	R	
		D4	FER0	Ch.0 flaming error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D3	PER0	Ch.0 parity error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D2	OER0	Ch.0 overrun error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE0	Ch.0 transmit data buffer empty	1	Empty	0	Buffer full	1	R	
		D0	RDBF0	Ch.0 receive data buffer full	1	Buffer full	0	Empty	0	R	
		Serial I/F Ch.0 control register	00401E3 (B)	D7	TXEN0	Ch.0 transmit enable	1	Enabled	0	Disabled	0
D6	RXEN0			Ch.0 receive enable	1	Enabled	0	Disabled	0	R/W	
D5	EPR0			Ch.0 parity enable	1	With parity	0	No parity	X	R/W	Valid only in asynchronous mode.
D4	PMD0			Ch.0 parity mode selection	1	Odd	0	Even	X	R/W	
D3	STPB0			Ch.0 stop bit selection	1	2 bits	0	1 bit	X	R/W	
D2	SSCK0			Ch.0 input clock selection	1	#SCLK0	0	Internal clock	X	R/W	
D1	SMD01			Ch.0 transfer mode selection	SMD0[1:0]		Transfer mode		X	R/W	
D0	SMD00				1	1	8-bit asynchronous	X			
		1	0		7-bit asynchronous						
		0	1		Clock sync. Slave						
0	0	Clock sync. Master									
Serial I/F Ch.0 IrDA register	00401E4 (B)	D7-5	–	–	–		–	–	0 when being read.		
		D4	DIVMD0	Ch.0 async. clock division ratio	1	1/8	0	1/16	X	R/W	
		D3	IRTL0	Ch.0 IrDA I/F output logic inversion	1	Inverted	0	Direct	X	R/W	Valid only in asynchronous mode.
		D2	IRRL0	Ch.0 IrDA I/F input logic inversion	1	Inverted	0	Direct	X	R/W	
		D1	IRMD01	Ch.0 interface mode selection	IRMD0[1:0]		I/F mode		X	R/W	
		D0	IRMD00		1	1	reserved				
					1	0	IrDA 1.0				
					0	1	reserved				
0	0	General I/F									

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Serial I/F Ch.1 transmit data register	00401E5 (B)	D7	TXD17	Serial I/F Ch.1 transmit data TXD17(16) = MSB TXD10 = LSB	0x0 to 0xFF(0x7F)		X	R/W	7-bit asynchronous mode does not use TXD17.		
		D6	TXD16				X				
		D5	TXD15				X				
		D4	TXD14				X				
		D3	TXD13				X				
		D2	TXD12				X				
		D1	TXD11				X				
		D0	TXD10				X				
Serial I/F Ch.1 receive data register	00401E6 (B)	D7	RXD17	Serial I/F Ch.1 receive data RXD17(16) = MSB RXD10 = LSB	0x0 to 0xFF(0x7F)		X	R	7-bit asynchronous mode does not use RXD17 (fixed at 0).		
		D6	RXD16				X				
		D5	RXD15				X				
		D4	RXD14				X				
		D3	RXD13				X				
		D2	RXD12				X				
		D1	RXD11				X				
		D0	RXD10				X				
Serial I/F Ch.1 status register	00401E7 (B)	D7-6	-	-	-		-	-	0 when being read.		
		D5	TEND1	Ch.1 transmit-completion flag	1	Transmitting	0	End	0	R	
		D4	FER1	Ch.1 framing error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D3	PER1	Ch.1 parity error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D2	OER1	Ch.1 overrun error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE1	Ch.1 transmit data buffer empty	1	Empty	0	Buffer full	1	R	
		D0	RDBF1	Ch.1 receive data buffer full	1	Buffer full	0	Empty	0	R	
		Serial I/F Ch.1 control register	00401E8 (B)	D7	TXEN1	Ch.1 transmit enable	1	Enabled	0	Disabled	0
D6	RXEN1			Ch.1 receive enable	1	Enabled	0	Disabled	0	R/W	
D5	EPR1			Ch.1 parity enable	1	With parity	0	No parity	X	R/W	Valid only in asynchronous mode.
D4	PMD1			Ch.1 parity mode selection	1	Odd	0	Even	X	R/W	
D3	STPB1			Ch.1 stop bit selection	1	2 bits	0	1 bit	X	R/W	
D2	SSCK1			Ch.1 input clock selection	1	#SCLK1	0	Internal clock	X	R/W	
D1	SMD11			Ch.1 transfer mode selection	SMD1[1:0]		Transfer mode		X	R/W	
D0	SMD10				1	1	8-bit asynchronous	X			
		1	0		7-bit asynchronous						
		0	1		Clock sync. Slave						
		0	0	Clock sync. Master							
Serial I/F Ch.1 IrDA register	00401E9 (B)	D7-5	-	-	-		-	-	0 when being read.		
		D4	DIVMD1	Ch.1 async. clock division ratio	1	1/8	0	1/16	X	R/W	
		D3	IRTL1	Ch.1 IrDA I/F output logic inversion	1	Inverted	0	Direct	X	R/W	Valid only in asynchronous mode.
		D2	IRRL1	Ch.1 IrDA I/F input logic inversion	1	Inverted	0	Direct	X	R/W	
		D1	IRMD11	Ch.1 interface mode selection	IRMD1[1:0]		I/F mode		X	R/W	
		D0	IRMD10		1	1	reserved	X			
1	0				IrDA 1.0						
		0	1	reserved							
		0	0	General I/F							

4 PERIPHERAL CIRCUITS

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
A/D conversion result (low-order) register	0040240 (B)	D7	ADD7	A/D converted data (low-order 8 bits) ADD0 = LSB	0x0 to 0x3FF (low-order 8 bits)		0	R			
		D6	ADD6				0				
		D5	ADD5				0				
		D4	ADD4				0				
		D3	ADD3				0				
		D2	ADD2				0				
		D1	ADD1				0				
		D0	ADD0				0				
A/D conversion result (high-order) register	0040241 (B)	D7-2	–	–	–		–	–	0 when being read.		
		D1	ADD9	A/D converted data (high-order 2 bits) ADD9 = MSB	0x0 to 0x3FF (high-order 2 bits)		0	R			
		D0	ADD8				0				
A/D trigger register	0040242 (B)	D7-6	–	–	–		–	–	0 when being read.		
		D5	MS	A/D conversion mode selection	1	Continuous	0	Normal	0	R/W	
		D4 D3	TS1 TS0	A/D conversion trigger selection	TS[1:0]		Trigger		0	R/W	
					1	1	#ADTRG pin				
					1	0	8-bit timer 0				
					0	1	16-bit timer 0				
		D2 D1 D0	CH2 CH1 CH0	A/D conversion channel status	CH[2:0]		Channel		0	R	
					1	1	1	AD7			
					1	1	0	AD6			
					1	0	1	AD5			
1	0				0	AD4					
0	1				1	AD3					
0	1	0	AD2								
0	0	1	AD1								
0	0	0	AD0								
A/D channel register	0040243 (B)	D7-6	–	–	–		–	–	0 when being read.		
		D5 D4 D3	CE2 CE1 CE0	A/D converter end channel selection	CE[2:0]		End channel		0	R/W	
					1	1	1	AD7			
					1	1	0	AD6			
					1	0	1	AD5			
					1	0	0	AD4			
					0	1	1	AD3			
		0	1	0	AD2						
		0	0	1	AD1						
		0	0	0	AD0						
D2 D1 D0	CS2 CS1 CS0	A/D converter start channel selection	CS[2:0]		Start channel		0	R/W			
			1	1	1	AD7					
			1	1	0	AD6					
			1	0	1	AD5					
			1	0	0	AD4					
			0	1	1	AD3					
0	1	0	AD2								
0	0	1	AD1								
0	0	0	AD0								
A/D enable register	0040244 (B)	D7-4	–	–	–		–	–	0 when being read.		
		D3	ADF	Conversion-complete flag	1	Completed	0	Run/Standby	0	R	Reset when ADD is read.
		D2	ADE	A/D enable	1	Enabled	0	Disabled	0	R/W	
		D1	ADST	A/D conversion control/status	1	Start/Run	0	Stop	0	R/W	
		D0	OWE	Overwrite error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
A/D sampling register	0040245 (B)	D7-2	–	–	–		–	–	0 when being read.		
		D1 D0	ST1 ST0	Input signal sampling time setup	ST[1:0]		Sampling time		1	R/W	Use with 9 clocks.
					1	1	9 clocks				
					1	0	7 clocks				
					0	1	5 clocks				
0	0	3 clocks									

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Port input 0/1 interrupt priority register	0040260 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PP1L2	Port input 1 interrupt level	0 to 7	X	R/W		
		D5	PP1L1						
		D4	PP1L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PP0L2	Port input 0 interrupt level	0 to 7	X	R/W		
D1	PP0L1								
D0	PP0L0								
Port input 2/3 interrupt priority register	0040261 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PP3L2	Port input 3 interrupt level	0 to 7	X	R/W		
		D5	PP3L1						
		D4	PP3L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PP2L2	Port input 2 interrupt level	0 to 7	X	R/W		
D1	PP2L1								
D0	PP2L0								
Key input interrupt priority register	0040262 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PK1L2	Key input 1 interrupt level	0 to 7	X	R/W		
		D5	PK1L1						
		D4	PK1L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PK0L2	Key input 0 interrupt level	0 to 7	X	R/W		
D1	PK0L1								
D0	PK0L0								
High-speed DMA Ch.0/1 interrupt priority register	0040263 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PHSD1L2	High-speed DMA Ch.1 interrupt level	0 to 7	X	R/W		
		D5	PHSD1L1						
		D4	PHSD1L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PHSD0L2	High-speed DMA Ch.0 interrupt level	0 to 7	X	R/W		
D1	PHSD0L1								
D0	PHSD0L0								
High-speed DMA Ch.2/3 interrupt priority register	0040264 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PHSD3L2	High-speed DMA Ch.3 interrupt level	0 to 7	X	R/W		
		D5	PHSD3L1						
		D4	PHSD3L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PHSD2L2	High-speed DMA Ch.2 interrupt level	0 to 7	X	R/W		
D1	PHSD2L1								
D0	PHSD2L0								
IDMA interrupt priority register	0040265 (B)	D7–3	–	reserved	–	–	–	0 when being read.	
		D2	PDM2	IDMA interrupt level	0 to 7	X	R/W		
		D1	PDM1						
		D0	PDM0						
16-bit timer 0/1 interrupt priority register	0040266 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T12	16-bit timer 1 interrupt level	0 to 7	X	R/W		
		D5	P16T11						
		D4	P16T10						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	P16T02	16-bit timer 0 interrupt level	0 to 7	X	R/W		
D1	P16T01								
D0	P16T00								
16-bit timer 2/3 interrupt priority register	0040267 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T32	16-bit timer 3 interrupt level	0 to 7	X	R/W		
		D5	P16T31						
		D4	P16T30						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	P16T22	16-bit timer 2 interrupt level	0 to 7	X	R/W		
D1	P16T21								
D0	P16T20								
16-bit timer 4/5 interrupt priority register	0040268 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T52	16-bit timer 5 interrupt level	0 to 7	X	R/W		
		D5	P16T51						
		D4	P16T50						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	P16T42	16-bit timer 4 interrupt level	0 to 7	X	R/W		
D1	P16T41								
D0	P16T40								

4 PERIPHERAL CIRCUITS

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
8-bit timer, serial I/F Ch.0 interrupt priority register	0040269 (B)	D7	–	reserved	–	–	–	0 when being read.
		D6	PSIO02	Serial interface Ch.0 interrupt level	0 to 7	X	R/W	
		D5	PSIO01					
		D4	PSIO00					
		D3	–	reserved	–	–	–	0 when being read.
		D2	P8TM2	8-bit timer 0–3 interrupt level	0 to 7	X	R/W	
D1	P8TM1							
D0	P8TM0							
Serial I/F Ch.1, A/D interrupt priority register	004026A (B)	D7	–	reserved	–	–	–	0 when being read.
		D6	PAD2	A/D converter interrupt level	0 to 7	X	R/W	
		D5	PAD1					
		D4	PAD0					
		D3	–	reserved	–	–	–	0 when being read.
		D2	PSIO12	Serial interface Ch.1 interrupt level	0 to 7	X	R/W	
D1	PSIO11							
D0	PSIO10							
Clock timer interrupt priority register	004026B (B)	D7–3	–	reserved	–	–	–	Writing 1 not allowed.
		D2	PCTM2	Clock timer interrupt level	0 to 7	X	R/W	
		D1	PCTM1					
		D0	PCTM0					
Port input 4/5 interrupt priority register	004026C (B)	D7	–	reserved	–	–	–	0 when being read.
		D6	PP5L2	Port input 5 interrupt level	0 to 7	X	R/W	
		D5	PP5L1					
		D4	PP5L0					
		D3	–	reserved	–	–	–	0 when being read.
		D2	PP4L2	Port input 4 interrupt level	0 to 7	X	R/W	
D1	PP4L1							
D0	PP4L0							
Port input 6/7 interrupt priority register	004026D (B)	D7	–	reserved	–	–	–	0 when being read.
		D6	PP7L2	Port input 7 interrupt level	0 to 7	X	R/W	
		D5	PP7L1					
		D4	PP7L0					
		D3	–	reserved	–	–	–	0 when being read.
		D2	PP6L2	Port input 6 interrupt level	0 to 7	X	R/W	
D1	PP6L1							
D0	PP6L0							

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks	
Key input, port input 0–3 interrupt enable register	0040270 (B)	D7–6	–	reserved		–	–	–	0 when being read.	
		D5	EK1	Key input 1	1	Enabled	0	Disabled	0	R/W
		D4	EK0	Key input 0					0	R/W
		D3	EP3	Port input 3					0	R/W
		D2	EP2	Port input 2					0	R/W
		D1	EP1	Port input 1					0	R/W
		D0	EP0	Port input 0					0	R/W
DMA interrupt enable register	0040271 (B)	D7–5	–	reserved		–	–	–	0 when being read.	
		D4	EIDMA	IDMA	1	Enabled	0	Disabled	0	R/W
		D3	EHDM3	High-speed DMA Ch.3					0	R/W
		D2	EHDM2	High-speed DMA Ch.2					0	R/W
		D1	EHDM1	High-speed DMA Ch.1					0	R/W
		D0	EHDM0	High-speed DMA Ch.0					0	R/W
16-bit timer 0/1 interrupt enable register	0040272 (B)	D7	E16TC1	16-bit timer 1 comparison A	1	Enabled	0	Disabled	0	R/W
		D6	E16TU1	16-bit timer 1 comparison B					0	R/W
		D5–4	–	reserved		–	–	–	–	0 when being read.
		D3	E16TC0	16-bit timer 0 comparison A	1	Enabled	0	Disabled	0	R/W
		D2	E16TU0	16-bit timer 0 comparison B					0	R/W
		D1–0	–	reserved		–	–	–	–	0 when being read.
16-bit timer 2/3 interrupt enable register	0040273 (B)	D7	E16TC3	16-bit timer 3 comparison A	1	Enabled	0	Disabled	0	R/W
		D6	E16TU3	16-bit timer 3 comparison B					0	R/W
		D5–4	–	reserved		–	–	–	–	0 when being read.
		D3	E16TC2	16-bit timer 2 comparison A	1	Enabled	0	Disabled	0	R/W
		D2	E16TU2	16-bit timer 2 comparison B					0	R/W
		D1–0	–	reserved		–	–	–	–	0 when being read.
16-bit timer 4/5 interrupt enable register	0040274 (B)	D7	E16TC5	16-bit timer 5 comparison A	1	Enabled	0	Disabled	0	R/W
		D6	E16TU5	16-bit timer 5 comparison B					0	R/W
		D5–4	–	reserved		–	–	–	–	0 when being read.
		D3	E16TC4	16-bit timer 4 comparison A	1	Enabled	0	Disabled	0	R/W
		D2	E16TU4	16-bit timer 4 comparison B					0	R/W
		D1–0	–	reserved		–	–	–	–	0 when being read.
8-bit timer interrupt enable register	0040275 (B)	D7–4	–	reserved		–	–	–	0 when being read.	
		D3	E8TU3	8-bit timer 3 underflow	1	Enabled	0	Disabled	0	R/W
		D2	E8TU2	8-bit timer 2 underflow					0	R/W
		D1	E8TU1	8-bit timer 1 underflow					0	R/W
		D0	E8TU0	8-bit timer 0 underflow					0	R/W
Serial I/F interrupt enable register	0040276 (B)	D7–6	–	reserved		–	–	–	0 when being read.	
		D5	ESTX1	SIF Ch.1 transmit buffer empty	1	Enabled	0	Disabled	0	R/W
		D4	ESRX1	SIF Ch.1 receive buffer full					0	R/W
		D3	ESERR1	SIF Ch.1 receive error					0	R/W
		D2	ESTX0	SIF Ch.0 transmit buffer empty					0	R/W
		D1	ESRX0	SIF Ch.0 receive buffer full					0	R/W
		D0	ESERR0	SIF Ch.0 receive error					0	R/W
Port input 4–7, clock timer, A/D interrupt enable register	0040277 (B)	D7–6	–	reserved		–	–	–	0 when being read.	
		D5	EP7	Port input 7	1	Enabled	0	Disabled	0	R/W
		D4	EP6	Port input 6					0	R/W
		D3	EP5	Port input 5					0	R/W
		D2	EP4	Port input 4					0	R/W
		D1	ECTM	Clock timer					0	R/W
		D0	EADE	A/D converter					0	R/W

4 PERIPHERAL CIRCUITS

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks						
Key input, port input 0–3 interrupt factor flag register	0040280 (B)	D7–6	–	reserved	1	Factor is generated	0	No factor is generated	–	–	0 when being read.				
		D5	FK1	Key input 1					X	R/W					
		D4	FK0	Key input 0					X	R/W					
		D3	FP3	Port input 3					X	R/W					
		D2	FP2	Port input 2					X	R/W					
		D1	FP1	Port input 1					X	R/W					
		D0	FP0	Port input 0					X	R/W					
DMA interrupt factor flag register	0040281 (B)	D7–5	–	reserved	1	Factor is generated	0	No factor is generated	–	–	0 when being read.				
		D4	FIDMA	IDMA					X	R/W					
		D3	FHDM3	High-speed DMA Ch.3					X	R/W					
		D2	FHDM2	High-speed DMA Ch.2					X	R/W					
		D1	FHDM1	High-speed DMA Ch.1					X	R/W					
		D0	FHDM0	High-speed DMA Ch.0					X	R/W					
16-bit timer 0/1 interrupt factor flag register	0040282 (B)	D7	F16TC1	16-bit timer 1 comparison A	1	Factor is generated	0	No factor is generated	X	R/W	0 when being read.				
		D6	F16TU1	16-bit timer 1 comparison B					X	R/W					
		D5–4	–	reserved					–	–					
		D3	F16TC0	16-bit timer 0 comparison A					1	Factor is generated		0	No factor is generated	X	R/W
		D2	F16TU0	16-bit timer 0 comparison B					X	R/W					
		D1–0	–	reserved					–	–		–	–	–	–
16-bit timer 2/3 interrupt factor flag register	0040283 (B)	D7	F16TC3	16-bit timer 3 comparison A	1	Factor is generated	0	No factor is generated	X	R/W	0 when being read.				
		D6	F16TU3	16-bit timer 3 comparison B					X	R/W					
		D5–4	–	reserved					–	–					
		D3	F16TC2	16-bit timer 2 comparison A					1	Factor is generated		0	No factor is generated	X	R/W
		D2	F16TU2	16-bit timer 2 comparison B					X	R/W					
		D1–0	–	reserved					–	–		–	–	–	–
16-bit timer 4/5 interrupt factor flag register	0040284 (B)	D7	F16TC5	16-bit timer 5 comparison A	1	Factor is generated	0	No factor is generated	X	R/W	0 when being read.				
		D6	F16TU5	16-bit timer 5 comparison B					X	R/W					
		D5–4	–	reserved					–	–					
		D3	F16TC4	16-bit timer 4 comparison A					1	Factor is generated		0	No factor is generated	X	R/W
		D2	F16TU4	16-bit timer 4 comparison B					X	R/W					
		D1–0	–	reserved					–	–		–	–	–	–
8-bit timer interrupt factor flag register	0040285 (B)	D7–4	–	reserved	1	Factor is generated	0	No factor is generated	–	–	0 when being read.				
		D3	F8TU3	8-bit timer 3 underflow					X	R/W					
		D2	F8TU2	8-bit timer 2 underflow					X	R/W					
		D1	F8TU1	8-bit timer 1 underflow					X	R/W					
		D0	F8TU0	8-bit timer 0 underflow					X	R/W					
Serial I/F interrupt factor flag register	0040286 (B)	D7–6	–	reserved	1	Factor is generated	0	No factor is generated	–	–	0 when being read.				
		D5	FSTX1	SIF Ch.1 transmit buffer empty					X	R/W					
		D4	FSRX1	SIF Ch.1 receive buffer full					X	R/W					
		D3	FSERR1	SIF Ch.1 receive error					X	R/W					
		D2	FSTX0	SIF Ch.0 transmit buffer empty					X	R/W					
		D1	FSRX0	SIF Ch.0 receive buffer full					X	R/W					
		D0	FSERR0	SIF Ch.0 receive error					X	R/W					
Port input 4–7, clock timer, A/D interrupt factor flag register	0040287 (B)	D7–6	–	reserved	1	Factor is generated	0	No factor is generated	–	–	0 when being read.				
		D5	FP7	Port input 7					X	R/W					
		D4	FP6	Port input 6					X	R/W					
		D3	FP5	Port input 5					X	R/W					
		D2	FP4	Port input 4					X	R/W					
		D1	FCTM	Clock timer					X	R/W					
		D0	FADE	A/D converter					X	R/W					

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA request register	0040290 (B)	D7	R16TC0	16-bit timer 0 comparison A	1	IDMA request	0	Interrupt request	0	R/W	
		D6	R16TU0	16-bit timer 0 comparison B					0	R/W	
		D5	RHDM1	High-speed DMA Ch.1					0	R/W	
		D4	RHDM0	High-speed DMA Ch.0					0	R/W	
		D3	RP3	Port input 3					0	R/W	
		D2	RP2	Port input 2					0	R/W	
		D1	RP1	Port input 1					0	R/W	
		D0	RP0	Port input 0					0	R/W	
16-bit timer 1–4 IDMA request register	0040291 (B)	D7	R16TC4	16-bit timer 4 comparison A	1	IDMA request	0	Interrupt request	0	R/W	
		D6	R16TU4	16-bit timer 4 comparison B					0	R/W	
		D5	R16TC3	16-bit timer 3 comparison A					0	R/W	
		D4	R16TU3	16-bit timer 3 comparison B					0	R/W	
		D3	R16TC2	16-bit timer 2 comparison A					0	R/W	
		D2	R16TU2	16-bit timer 2 comparison B					0	R/W	
		D1	R16TC1	16-bit timer 1 comparison A					0	R/W	
		D0	R16TU1	16-bit timer 1 comparison B					0	R/W	
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register	0040292 (B)	D7	RSTX0	SIF Ch.0 transmit buffer empty	1	IDMA request	0	Interrupt request	0	R/W	
		D6	RSRX0	SIF Ch.0 receive buffer full					0	R/W	
		D5	R8TU3	8-bit timer 3 underflow					0	R/W	
		D4	R8TU2	8-bit timer 2 underflow					0	R/W	
		D3	R8TU1	8-bit timer 1 underflow					0	R/W	
		D2	R8TU0	8-bit timer 0 underflow					0	R/W	
		D1	R16TC5	16-bit timer 5 comparison A					0	R/W	
		D0	R16TU5	16-bit timer 5 comparison B					0	R/W	
Serial I/F Ch.1, A/D, port input 4–7 IDMA request register	0040293 (B)	D7	RP7	Port input 7	1	IDMA request	0	Interrupt request	0	R/W	
		D6	RP6	Port input 6					0	R/W	
		D5	RP5	Port input 5					0	R/W	
		D4	RP4	Port input 4					0	R/W	
		D3	–	reserved	–	–	0 when being read.				
		D2	RADE	A/D converter	1	IDMA request	0	Interrupt request	0	R/W	
		D1	RSTX1	SIF Ch.1 transmit buffer empty					0	R/W	
		D0	RSRX1	SIF Ch.1 receive buffer full					0	R/W	
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA enable register	0040294 (B)	D7	DE16TC0	16-bit timer 0 comparison A	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D6	DE16TU0	16-bit timer 0 comparison B					0	R/W	
		D5	DEHDM1	High-speed DMA Ch.1					0	R/W	
		D4	DEHDM0	High-speed DMA Ch.0					0	R/W	
		D3	DEP3	Port input 3					0	R/W	
		D2	DEP2	Port input 2					0	R/W	
		D1	DEP1	Port input 1					0	R/W	
		D0	DEP0	Port input 0					0	R/W	
16-bit timer 1–4 IDMA enable register	0040295 (B)	D7	DE16TC4	16-bit timer 4 comparison A	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D6	DE16TU4	16-bit timer 4 comparison B					0	R/W	
		D5	DE16TC3	16-bit timer 3 comparison A					0	R/W	
		D4	DE16TU3	16-bit timer 3 comparison B					0	R/W	
		D3	DE16TC2	16-bit timer 2 comparison A					0	R/W	
		D2	DE16TU2	16-bit timer 2 comparison B					0	R/W	
		D1	DE16TC1	16-bit timer 1 comparison A					0	R/W	
		D0	DE16TU1	16-bit timer 1 comparison B					0	R/W	
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register	0040296 (B)	D7	DESTX0	SIF Ch.0 transmit buffer empty	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D6	DESRX0	SIF Ch.0 receive buffer full					0	R/W	
		D5	DE8TU3	8-bit timer 3 underflow					0	R/W	
		D4	DE8TU2	8-bit timer 2 underflow					0	R/W	
		D3	DE8TU1	8-bit timer 1 underflow					0	R/W	
		D2	DE8TU0	8-bit timer 0 underflow					0	R/W	
		D1	DE16TC5	16-bit timer 5 comparison A					0	R/W	
		D0	DE16TU5	16-bit timer 5 comparison B					0	R/W	
Serial I/F Ch.1, A/D, port input 4–7 IDMA enable register	0040297 (B)	D7	DEP7	Port input 7	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D6	DEP6	Port input 6					0	R/W	
		D5	DEP5	Port input 5					0	R/W	
		D4	DEP4	Port input 4					0	R/W	
		D3	–	reserved	–	–	0 when being read.				
		D2	DEADE	A/D converter	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D1	DESTX1	SIF Ch.1 transmit buffer empty					0	R/W	
		D0	DESRX1	SIF Ch.1 receive buffer full					0	R/W	

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
High-speed DMA Ch.0/1 trigger set-up register	0040298 (B)	D7	HSD1S3	High-speed DMA Ch.1 trigger set-up	0	Software trigger	0	R/W		
		D6	HSD1S2		1	K51 input (falling edge)	0			
D5	HSD1S1	2	K51 input (rising edge)		0					
D4	HSD1S0	3	Port 1 input		0					
					4	Port 5 input				
					5	8-bit timer Ch.1 underflow				
					6	16-bit timer Ch.1 compare B				
					7	16-bit timer Ch.1 compare A				
					8	16-bit timer Ch.5 compare B				
					9	16-bit timer Ch.5 compare A				
					A	SI/F Ch.1 Rx buffer full				
					B	SI/F Ch.1 Tx buffer empty				
					C	A/D conversion completion				
High-speed DMA Ch.2/3 trigger set-up register	0040299 (B)	D3	HSD0S3	High-speed DMA Ch.0 trigger set-up	0	Software trigger	0	R/W		
		D2	HSD0S2		1	K50 input (falling edge)	0			
D1	HSD0S1	2	K50 input (rising edge)		0					
D0	HSD0S0	3	Port 0 input		0					
					4	Port 4 input				
					5	8-bit timer Ch.0 underflow				
					6	16-bit timer Ch.0 compare B				
					7	16-bit timer Ch.0 compare A				
					8	16-bit timer Ch.4 compare B				
					9	16-bit timer Ch.4 compare A				
					A	SI/F Ch.0 Rx buffer full				
					B	SI/F Ch.0 Tx buffer empty				
					C	A/D conversion completion				
High-speed DMA Ch.2/3 trigger set-up register	0040299 (B)	D7	HSD3S3	High-speed DMA Ch.3 trigger set-up	0	Software trigger	0	R/W		
		D6	HSD3S2		1	K54 input (falling edge)	0			
D5	HSD3S1	2	K54 input (rising edge)		0					
D4	HSD3S0	3	Port 3 input		0					
					4	Port 7 input				
					5	8-bit timer Ch.3 underflow				
					6	16-bit timer Ch.3 compare B				
					7	16-bit timer Ch.3 compare A				
					8	16-bit timer Ch.5 compare B				
					9	16-bit timer Ch.5 compare A				
					A	SI/F Ch.1 Rx buffer full				
					B	SI/F Ch.1 Tx buffer empty				
					C	A/D conversion completion				
High-speed DMA software trigger register	004029A (B)	D7-4	–	reserved	–	–	–	–	0 when being read.	
		D3	HST3	HSDMA Ch.3 software trigger	1	Trigger	0	Invalid		0
		D2	HST2	HSDMA Ch.2 software trigger				0	W	
		D1	HST1	HSDMA Ch.1 software trigger				0	W	
		D0	HST0	HSDMA Ch.0 software trigger				0	W	
Flag set/reset method select register	004029F (B)	D7-3	–	reserved	–	–	–	–		
		D2	DENONLY	IDMA enable register set method selection	1	Set only	0	RD/WR	1	R/W
		D1	IDMAONLY	IDMA request register set method selection	1	Set only	0	RD/WR	1	R/W
		D0	RSTONLY	Interrupt factor flag reset method selection	1	Reset only	0	RD/WR	1	R/W

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks		
K5 function select register	00402C0 (B)	D7-5	–	reserved	–		–	–	0 when being read.		
		D4	CFK54	K54 function selection	1	#DMAREQ3	0	K54		0	R/W
		D3	CFK53	K53 function selection	1	#DMAREQ2	0	K53		0	R/W
		D2	CFK52	K52 function selection	1	#ADTRG	0	K52		0	R/W
		D1	CFK51	K51 function selection	1	#DMAREQ1	0	K51		0	R/W
		D0	CFK50	K50 function selection	1	#DMAREQ0	0	K50		0	R/W
K5 input port data register	00402C1 (B)	D7-5	–	reserved	–		–	–	0 when being read.		
		D4	K54D	K54 input port data	1	High	0	Low		–	R
		D3	K53D	K53 input port data						–	R
		D2	K52D	K52 input port data						–	R
		D1	K51D	K51 input port data						–	R
		D0	K50D	K50 input port data						–	R
K6 function select register	00402C3 (B)	D7	CFK67	K67 function selection					1	AD7	0
		D6	CFK66	K66 function selection	1	AD6	0	K66	0	R/W	
		D5	CFK65	K65 function selection	1	AD5	0	K65	0	R/W	
		D4	CFK64	K64 function selection	1	AD4	0	K64	0	R/W	
		D3	CFK63	K63 function selection	1	AD3	0	K63	0	R/W	
		D2	CFK62	K62 function selection	1	AD2	0	K62	0	R/W	
		D1	CFK61	K61 function selection	1	AD1	0	K61	0	R/W	
		D0	CFK60	K60 function selection	1	AD0	0	K60	0	R/W	
K6 input port data register	00402C4 (B)	D7	K67D	K67 input port data	1	High	0	Low	–	R	
		D6	K66D	K66 input port data					–	R	
		D5	K65D	K65 input port data					–	R	
		D4	K64D	K64 input port data					–	R	
		D3	K63D	K63 input port data					–	R	
		D2	K62D	K62 input port data					–	R	
		D1	K61D	K61 input port data					–	R	
		D0	K60D	K60 input port data					–	R	

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Register name	Address	Bit	Name	Function	Setting				Init.	R/W	Remarks
Port input interrupt select register 1	00402C6 (B)	D7	SPT31	FPT3 interrupt input port selection	11	10	01	00	0	R/W	
		D6	SPT30		P23	P03	K53	K63	0		
		D5	SPT21	FPT2 interrupt input port selection	11	10	01	00	0	R/W	
		D4	SPT20		P22	P02	K52	K62	0		
		D3	SPT11	FPT1 interrupt input port selection	11	10	01	00	0	R/W	
		D2	SPT10		P21	P01	K51	K61	0		
		D1	SPT01	FPT0 interrupt input port selection	11	10	01	00	0	R/W	
		D0	SPT00		P20	P00	K50	K60	0		
Port input interrupt select register 2	00402C7 (B)	D7	SPT71	FPT7 interrupt input port selection	11	10	01	00	0	R/W	
		D6	SPT70		P27	P07	P33	K67	0		
		D5	SPT61	FPT6 interrupt input port selection	11	10	01	00	0	R/W	
		D4	SPT60		P26	P06	P32	K66	0		
		D3	SPT51	FPT5 interrupt input port selection	11	10	01	00	0	R/W	
		D2	SPT50		P25	P05	P31	K65	0		
		D1	SPT41	FPT4 interrupt input port selection	11	10	01	00	0	R/W	
		D0	SPT40		P24	P04	K54	K64	0		
Port input interrupt input polarity select register	00402C8 (B)	D7	SPPT7	FPT7 input polarity selection	1	High level or Rising edge	0	Low level or Falling edge	1	R/W	
		D6	SPPT6	FPT6 input polarity selection					1		
		D5	SPPT5	FPT5 input polarity selection					1		
		D4	SPPT4	FPT4 input polarity selection					1		
		D3	SPPT3	FPT3 input polarity selection					1		
		D2	SPPT2	FPT2 input polarity selection					1		
		D1	SPPT1	FPT1 input polarity selection					1		
		D0	SPPT0	FPT0 input polarity selection					1		
Port input interrupt edge/level select register	00402C9 (B)	D7	SEPT7	FPT7 edge/level selection	1	Edge	0	Level	1	R/W	
		D6	SEPT6	FPT6 edge/level selection					1		
		D5	SEPT5	FPT5 edge/level selection					1		
		D4	SEPT4	FPT4 edge/level selection					1		
		D3	SEPT3	FPT3 edge/level selection					1		
		D2	SEPT2	FPT2 edge/level selection					1		
		D1	SEPT1	FPT1 edge/level selection					1		
		D0	SEPT0	FPT0 edge/level selection					1		
Key input interrupt select register	00402CA (B)	D7-4	-	reserved	-				-	-	0 when being read.
		D3	SPPK11	FPK11 interrupt input port selection	11	10	01	00	0	R/W	
		D2	SPPK10		P2[7:4]	P0[7:4]	K6[7:4]	K6[3:0]	0		
		D1	SPPK01	FPK01 interrupt input port selection	11	10	01	00	0	R/W	
		D0	SPPK00		P2[4:0]	P0[4:0]	K6[4:0]	K5[4:0]	0		
Key input interrupt (FPK0) input comparison register	00402CC (B)	D7-5	-	reserved	-				-	-	
		D4	SCP04	FPK04 input comparison	1	High	0	Low	0	R/W	
		D3	SCP03	FPK03 input comparison					0		
		D2	SCP02	FPK02 input comparison					0		
		D1	SCP01	FPK01 input comparison					0		
		D0	SCP00	FPK00 input comparison					0		
Key input interrupt (FPK1) input comparison register	00402CD (B)	D7-4	-	reserved					-		
		D3	SCP13	FPK13 input comparison	1	High	0	Low	0	R/W	
		D2	SCP12	FPK12 input comparison					0		
		D1	SCP11	FPK11 input comparison					0		
		D0	SCP10	FPK10 input comparison					0		
Key input interrupt (FPK0) input mask register	00402CE (B)	D7-5	-	reserved					-		
		D4	SMP04	FPK04 input mask	1	Interrupt enabled	0	Interrupt disabled	0	R/W	
		D3	SMP03	FPK03 input mask					0		
		D2	SMP02	FPK02 input mask					0		
		D1	SMP01	FPK01 input mask					0		
		D0	SMP00	FPK00 input mask					0		
Key input interrupt (FPK1) input mask register	00402CF (B)	D7-4	-	reserved					-		
		D3	SMP13	FPK13 input mask	1	Interrupt enabled	0	Interrupt disabled	0	R/W	
		D2	SMP12	FPK12 input mask					0		
		D1	SMP11	FPK11 input mask					0		
		D0	SMP10	FPK10 input mask					0		

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
P0 function select register	00402D0 (B)	D7	CFP07	P07 function selection	1 #SRDY1	0 P07	0	R/W	Extended functions (0x402DF)
		D6	CFP06	P06 function selection	1 #SCLK1	0 P06	0	R/W	
		D5	CFP05	P05 function selection	1 SOUT1	0 P05	0	R/W	
		D4	CFP04	P04 function selection	1 SIN1	0 P04	0	R/W	
		D3	CFP03	P03 function selection	1 #SRDY0	0 P03	0	R/W	
		D2	CFP02	P02 function selection	1 #SCLK0	0 P02	0	R/W	
		D1	CFP01	P01 function selection	1 SOUT0	0 P01	0	R/W	
		D0	CFP00	P00 function selection	1 SIN0	0 P00	0	R/W	
P0 I/O port data register	00402D1 (B)	D7	P07D	P07 I/O port data	1 High	0 Low	0	R/W	
		D6	P06D	P06 I/O port data			0	R/W	
		D5	P05D	P05 I/O port data			0	R/W	
		D4	P04D	P04 I/O port data			0	R/W	
		D3	P03D	P03 I/O port data			0	R/W	
		D2	P02D	P02 I/O port data			0	R/W	
		D1	P01D	P01 I/O port data			0	R/W	
		D0	P00D	P00 I/O port data			0	R/W	
P0 I/O control register	00402D2 (B)	D7	IOC07	P07 I/O control	1 Output	0 Input	0	R/W	
		D6	IOC06	P06 I/O control			0	R/W	
		D5	IOC05	P05 I/O control			0	R/W	
		D4	IOC04	P04 I/O control			0	R/W	
		D3	IOC03	P03 I/O control			0	R/W	
		D2	IOC02	P02 I/O control			0	R/W	
		D1	IOC01	P01 I/O control			0	R/W	
		D0	IOC00	P00 I/O control			0	R/W	
P1 function select register	00402D4 (B)	D7	–	reserved	–		–	–	0 when being read.
		D6	CFP16	P16 function selection	1 EXCL5 #DMAEND1	0 P16	0	R/W	Extended functions (0x402DF)
		D5	CFP15	P15 function selection	1 EXCL4 #DMAEND0	0 P15	0	R/W	
		D4	CFP14	P14 function selection	1 FOSC1	0 P14	0	R/W	
		D3	CFP13	P13 function selection	1 EXCL3 T8UF3	0 P13	0	R/W	
		D2	CFP12	P12 function selection	1 EXCL2 T8UF2	0 P12	0	R/W	
		D1	CFP11	P11 function selection	1 EXCL1 T8UF1	0 P11	0	R/W	
		D0	CFP10	P10 function selection	1 EXCL0 T8UF0	0 P10	0	R/W	
P1 I/O port data register	00402D5 (B)	D7	–	reserved	–		–	–	
		D6	P16D	P16 I/O port data	1 High	0 Low	0	R/W	
		D5	P15D	P15 I/O port data			0	R/W	
		D4	P14D	P14 I/O port data			0	R/W	
		D3	P13D	P13 I/O port data			0	R/W	
		D2	P12D	P12 I/O port data			0	R/W	
		D1	P11D	P11 I/O port data			0	R/W	
		D0	P10D	P10 I/O port data			0	R/W	
P1 I/O control register	00402D6 (B)	D7	–	reserved			–		
		D6	IOC16	P16 I/O control	1 Output	0 Input	0	R/W	
		D5	IOC15	P15 I/O control			0	R/W	
		D4	IOC14	P14 I/O control			0	R/W	
		D3	IOC13	P13 I/O control			0	R/W	
		D2	IOC12	P12 I/O control			0	R/W	
		D1	IOC11	P11 I/O control			0	R/W	
		D0	IOC10	P10 I/O control			0	R/W	
P2 function select register	00402D8 (B)	D7	CFP27	P27 function selection			1 TM5	0 P27	
		D6	CFP26	P26 function selection	1 TM4	0 P26	0	R/W	
		D5	CFP25	P25 function selection	1 TM3	0 P25	0	R/W	
		D4	CFP24	P24 function selection	1 TM2	0 P24	0	R/W	
		D3	CFP23	P23 function selection	1 TM1	0 P23	0	R/W	
		D2	CFP22	P22 function selection	1 TM0	0 P22	0	R/W	
		D1	CFP21	P21 function selection	1 #DWE	0 P21	0	R/W	
		D0	CFP20	P20 function selection	1 #DRD	0 P20	0	R/W	
P2 I/O port data register	00402D9 (B)	D7	P27D	P27 I/O port data	1 High	0 Low	0	R/W	
		D6	P26D	P26 I/O port data			0	R/W	
		D5	P25D	P25 I/O port data			0	R/W	
		D4	P24D	P24 I/O port data			0	R/W	
		D3	P23D	P23 I/O port data			0	R/W	
		D2	P22D	P22 I/O port data			0	R/W	
		D1	P21D	P21 I/O port data			0	R/W	
		D0	P20D	P20 I/O port data			0	R/W	

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Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks			
P2 I/O control register	00402DA (B)	D7	IOC27	P27 I/O control	1	Output	0	Input	0	R/W		
		D6	IOC26	P26 I/O control					0	R/W		
		D5	IOC25	P25 I/O control					0	R/W		
		D4	IOC24	P24 I/O control					0	R/W		
		D3	IOC23	P23 I/O control					0	R/W		
		D2	IOC22	P22 I/O control					0	R/W		
		D1	IOC21	P21 I/O control					0	R/W		
		D0	IOC20	P20 I/O control					0	R/W		
P3 function select register	00402DC (B)	D7-6	–	reserved	–	–	–	–	0 when being read.			
		D5	CFP35	P35 function selection	1	#BUSACK	0	P35	0	R/W		
		D4	CFP34	P34 function selection	1	#BUSREQ #CE6	0	P34	0	R/W		
		D3	CFP33	P33 function selection	1	#DMAACK1	0	P33	0	R/W		
		D2	CFP32	P32 function selection	1	#DMAACK0	0	P32	0	R/W		
		D1	CFP31	P31 function selection	1	#BUSGET	0	P31	0	R/W		Ext. func.(0x402DF)
		D0	CFP30	P30 function selection	1	#WAIT #CE4/#CE5	0	P30	0	R/W		
P3 I/O port data register	00402DD (B)	D7-6	–	reserved	–	–	–	–	0 when being read.			
		D5	P35D	P35 I/O port data	1	High	0	Low	0	R/W		
		D4	P34D	P34 I/O port data					0	R/W		
		D3	P33D	P33 I/O port data					0	R/W		
		D2	P32D	P32 I/O port data					0	R/W		
		D1	P31D	P31 I/O port data					0	R/W		
		D0	P30D	P30 I/O port data					0	R/W		
P3 I/O control register	00402DE (B)	D7-6	–	reserved					–	–		–
		D5	IOC35	P35 I/O control	1	Output	0	Input	0	R/W		
		D4	IOC34	P34 I/O control					0	R/W		
		D3	IOC33	P33 I/O control					0	R/W		
		D2	IOC32	P32 I/O control					0	R/W		
		D1	IOC31	P31 I/O control					0	R/W		
		D0	IOC30	P30 I/O control					0	R/W		
Port function extension register	00402DF (B)	D7	CFEX7	P07 port extended function					1	#DMAEND3		0
		D6	CFEX6	P06 port extended function	1	#DMAACK3	0	P06, etc.	0	R/W		
		D5	CFEX5	P05 port extended function	1	#DMAEND2	0	P05, etc.	0	R/W		
		D4	CFEX4	P04 port extended function	1	#DMAACK2	0	P04, etc.	0	R/W		
		D3	CFEX3	P31 port extended function	1	#GARD	0	P31, etc.	0	R/W		
		D2	CFEX2	P21 port extended function	1	#GAAS	0	P21, etc.	0	R/W		
		D1	CFEX1	P10, P11, P13 port extended function	1	DST0 DST1 DPC0	0	P10, etc. P11, etc. P13, etc.	1	R/W		
		D0	CFEX0	P12, P14 port extended function	1	DST2 DCLK	0	P12, etc. P14, etc.	1	R/W		

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks							
Areas 18–15 set-up register	0048120 (HW)	DF	–	reserved	–	–	–	0 when being read.							
		DE	A18SZ	Areas 18–17 device size selection	1 8 bits 0 16 bits	0	R/W								
		DD	A18DF1	Areas 18–17	A18DF[1:0] Number of cycles	1 1 3.5 1 0 2.5 0 1 1.5 0 0 0.5	1	R/W							
		DC	A18DF0	output disable delay time											
		DB	–	reserved						–	–	–	0 when being read.		
		DA	A18WT2	Areas 18–17 wait control						A18WT[2:0] Wait cycles	1	R/W			
		D9	A18WT1			1 1 1 7 1 1 0 6 1 0 1 5 1 0 0 4 0 1 1 3 0 1 0 2 0 0 1 1 0 0 0 0	1	R/W							
		D8	A18WT0												
		D7	–							reserved	–	–	–	0 when being read.	
		D6	A16SZ							Areas 16–15 device size selection	1 8 bits 0 16 bits	0	R/W		
		D5	A16DF1							Areas 16–15	A16DF[1:0] Number of cycles	1 1 3.5 1 0 2.5 0 1 1.5 0 0 0.5	1	R/W	
		D4	A16DF0							output disable delay time					
		D3	–							reserved					
		D2	A16WT2	Areas 16–15 wait control	A16WT[2:0] Wait cycles	1	R/W								
D1	A16WT1			1 1 1 7 1 1 0 6 1 0 1 5 1 0 0 4 0 1 1 3 0 1 0 2 0 0 1 1 0 0 0 0	1	R/W									
D0	A16WT0														
D0	A16WT0														
Areas 14–13 set-up register	0048122 (HW)	DF–9	–	reserved	–	–	–	0 when being read.							
		D8	A14DRA	Area 14 DRAM selection	1 Used 0 Not used	0	R/W								
		D7	A13DRA	Area 13 DRAM selection	1 Used 0 Not used	0	R/W								
		D6	A14SZ	Areas 14–13 device size selection	1 8 bits 0 16 bits	0	R/W								
		D5	A14DF1	Areas 14–13	A14DF[1:0] Number of cycles	1 1 3.5 1 0 2.5 0 1 1.5 0 0 0.5	1	R/W							
		D4	A14DF0	output disable delay time											
		D3	–	reserved						–	–	–	0 when being read.		
		D2	A14WT2	Areas 14–13 wait control						A14WT[2:0] Wait cycles	1	R/W			
D1	A14WT1			1 1 1 7 1 1 0 6 1 0 1 5 1 0 0 4 0 1 1 3 0 1 0 2 0 0 1 1 0 0 0 0	1	R/W									
D0	A14WT0														
D0	A14WT0														
Areas 12–11 set-up register	0048124 (HW)	DF–7	–	reserved	–	–	–	0 when being read.							
		D6	A12SZ	Areas 12–11 device size selection	1 8 bits 0 16 bits	0	R/W								
		D5	A12DF1	Areas 12–11	A18DF[1:0] Number of cycles	1 1 3.5 1 0 2.5 0 1 1.5 0 0 0.5	1	R/W							
		D4	A12DF0	output disable delay time											
		D3	–	reserved						–	–	–	0 when being read.		
		D2	A12WT2	Areas 12–11 wait control						A18WT[2:0] Wait cycles	1	R/W			
		D1	A12WT1			1 1 1 7 1 1 0 6 1 0 1 5 1 0 0 4 0 1 1 3 0 1 0 2 0 0 1 1 0 0 0 0	1	R/W							
D0	A12WT0														

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
Areas 10–9 set-up register	0048126 (HW)	DF	–	reserved	–	–	–	0 when being read.		
		DE	A10IR2	Area 10 internal ROM wait control	A10IR[2:0]	ROM size	1	R/W		
		DD	A10IR1	Area 10 internal ROM size	1 1 1	2MB	1			
		DC	A10IR0	selection	1 1 0	1MB	1			
					1 0 1	512KB				
					1 0 0	256KB				
					0 1 1	128KB				
					0 1 0	64KB				
					0 0 1	32KB				
					0 0 0	16KB				
		DB	–	reserved	–	–	–	–	0 when being read.	
		DA	A10BW1	Areas 10–9	A10BW[1:0]	Wait cycles	0	R/W		
		D9	A10BW0	burst ROM	1 1	3	0			
				burst read cycle wait control	1 0	2				
					0 1	1				
					0 0	0				
		D8	A10DRA	Area 10 burst ROM selection	1	Used	0	Not used	0	R/W
		D7	A9DRA	Area 9 burst ROM selection	1	Used	0	Not used	0	R/W
		D6	A10SZ	Areas 10–9 device size selection	1	8 bits	0	16 bits	0	R/W
		D5	A10DF1	Areas 10–9	A10DF[1:0]	Number of cycles	1	R/W		
D4	A10DF0	output disable delay time	1 1	3.5	1					
			1 0	2.5						
			0 1	1.5						
			0 0	0.5						
D3	–	reserved	–	–	–	–	0 when being read.			
D2	A10WT2	Areas 10–9 wait control	A10WT[2:0]	Wait cycles	1	R/W				
D1	A10WT1		1 1 1	7	1					
D0	A10WT0		1 1 0	6	1					
			1 0 1	5						
			1 0 0	4						
			0 1 1	3						
			0 1 0	2						
			0 0 1	1						
			0 0 0	0						
Areas 8–7 set-up register	0048128 (HW)	DF–9	–	reserved	–	–	–	0 when being read.		
		D8	A8DRA	Area 8 DRAM selection	1	Used	0	Not used	0	R/W
		D7	A7DRA	Area 7 DRAM selection	1	Used	0	Not used	0	R/W
		D6	A8SZ	Areas 8–7 device size selection	1	8 bits	0	16 bits	0	R/W
		D5	A8DF1	Areas 8–7	A8DF[1:0]	Number of cycles	1	R/W		
		D4	A8DF0	output disable delay time	1 1	3.5	1			
					1 0	2.5				
					0 1	1.5				
					0 0	0.5				
		D3	–	reserved	–	–	–	–	0 when being read.	
		D2	A8WT2	Areas 8–7 wait control	A8WT[2:0]	Wait cycles	1	R/W		
		D1	A8WT1		1 1 1	7	1			
D0	A8WT0		1 1 0	6	1					
			1 0 1	5						
			1 0 0	4						
			0 1 1	3						
			0 1 0	2						
			0 0 1	1						
			0 0 0	0						

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Areas 6–4 set-up register	004812A (HW)	DF–E	–	reserved	–	–	–	0 when being read.			
		DD	A6DF1	Area 6	A6DF[1:0]	Number of cycles	1	R/W			
		DC	A6DF0	output disable delay time	1	1	3.5	1			
					1	0	2.5				
					0	1	1.5				
					0	0	0.5				
		DB	–	reserved	–	–	–	–	0 when being read.		
		DA	A6WT2	Area 6 wait control	A6WT[2:0]	Wait cycles	1	R/W			
		D9	A6WT1		1	1	1	7		1	
		D8	A6WT0		1	1	0	6		1	
					1	0	1	5			
					1	0	0	4			
					0	1	1	3			
					0	1	0	2			
		0	0	1	1						
		0	0	0	0						
D7	–	reserved	–	–	–	–	0 when being read.				
D6	A5SZ	Areas 5–4 device size selection	1	8 bits	0	16 bits	0	R/W			
D5	A5DF1	Areas 5–4 output disable delay time	A5DF[1:0]	Number of cycles	1	R/W					
D4	A5DF0		1	1	3.5	1					
			1	0	2.5						
			0	1	1.5						
		0	0	0.5							
D3	–	reserved	–	–	–	–	0 when being read.				
D2	A5WT2	Areas 5–4 wait control	A5WT[2:0]	Wait cycles	1	R/W					
D1	A5WT1		1	1	1	7		1			
D0	A5WT0		1	1	0	6		1			
			1	0	1	5					
			1	0	0	4					
			0	1	1	3					
		0	1	0	2						
		0	0	1	1						
		0	0	0	0						
TTBR write protect register	004812D (B)	D7	TBRP7	TTBR register write protect	Writing 01011001(0x59) removes the TTBR (0x48134) write protection. Writing other data sets the write protection.	0	W	Undefined in read.			
		D6	TBRP6			0					
		D5	TBRP5			0					
		D4	TBRP4			0					
		D3	TBRP3			0					
		D2	TBRP2			0					
		D1	TBRP1			0					
		D0	TBRP0			0					
Bus control register	004812E (HW)	DF	RBCLK	BCLK output control	1	Fixed at H	0	Enabled	0	R/W	
		DE	–	reserved	–	–	–	–	0	–	Writing 1 not allowed.
		DD	RBST8	Burst ROM burst mode selection	1	8-successive	0	4-successive	0	R/W	
		DC	REDO	DRAM page mode selection	1	EDO	0	Fast page	0	R/W	
		DB	RCA1	Column address size selection	RCA[1:0]	Size	0	R/W			
		DA	RCA0		1	1	11	0			
					1	0	10				
					0	1	9				
				0	0	8					
		D9	RPC2	Refresh enable	1	Enabled	0	Disabled	0	R/W	
		D8	RPC1	Refresh method selection	1	Self-refresh	0	CBR-refresh	0	R/W	
		D7	RPC0	Refresh RPC delay setup	1	2.0	0	1.0	0	R/W	
		D6	RRA1	Refresh RAS pulse width selection	RRA[1:0]	Number of cycles	0	R/W			
		D5	RRA0		1	1	5	0			
					1	0	4				
					0	1	3				
		0	0	2							
D4	–	reserved	–	–	–	–	0	–	Writing 1 not allowed.		
D3	SBUSST	External interface method selection	1	#BSL	0	A0	0	R/W			
D2	SEMAS	External bus master setup	1	Existing	0	Nonexistent	0	R/W			
D1	SEPD	External power-down control	1	Enabled	0	Disabled	0	R/W			
D0	SWAITE	#WAIT enable	1	Enabled	0	Disabled	0	R/W			

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks				
DRAM timing set-up register	0048130 (HW)	DF-C	-	reserved	-	-	-	0 when being read.				
		DB	A3EEN	Area 3 emulation	1 Internal ROM 0 Emulation	1	R/W					
		DA	CEFUNC1	#CE pin function selection	CFFUNC[1:0] #CE output	0	0	R/W				
		D9	CEFUNC0							1 x #CE7/8..#CE17/18		
										0 1 #CE6..#CE17		
						0 0 #CE4..#CE10						
		D8	CRAS	Successive RAS mode setup	1 Successive 0 Normal	0	R/W					
		D7	RPRC1	DRAM RAS precharge cycles selection	RPRC[1:0] Number of cycles	0	0	R/W				
		D6	RPRC0							1 1 4		
										1 0 3		
										0 1 2		
						0 0 1						
		D5	-	reserved	-	-	-	0 when being read.				
		D4	CASC1	DRAM CAS cycles selection	CASC[1:0] Number of cycles	0	0	R/W				
D3	CASC0	1 1 4										
		1 0 3										
		0 1 2										
				0 0 1								
D2	-	reserved	-	-	-	0 when being read.						
D1	RASC1	DRAM RAS cycles selection	RASC[1:0] Number of cycles	0	0	R/W						
D0	RASC0							1 1 4				
								1 0 3				
								0 1 2				
				0 0 1								
Access control register	0048132 (HW)	DF	A18IO	Area 18, 17 internal/external access	1 Internal access	0 External access	0	R/W				
		DE	A16IO	Area 16, 15 internal/external access			0	R/W				
		DD	A14IO	Area 14, 13 internal/external access			0	R/W				
		DC	A12IO	Area 12, 11 internal/external access			0	R/W				
		DB	-	reserved	-	-	0	-	0 when being read.			
		DA	A8IO	Area 8, 7 internal/external access	1 Internal access	0 External access	0	R/W				
		D9	A6IO	Area 6 internal/external access			0	R/W				
		D8	A5IO	Area 5, 4 internal/external access			0	R/W				
		D7	A18EC	Area 18, 17 endian control	1 Big endian	0 Little endian	0	R/W				
		D6	A16EC	Area 16, 15 endian control			0	R/W				
		D5	A14EC	Area 14, 13 endian control			0	R/W				
		D4	A12EC	Area 12, 11 endian control			0	R/W				
		D3	A10EC	Area 10, 9 endian control			0	R/W				
		D2	A8EC	Area 8, 7 endian control			0	R/W				
		D1	A6EC	Area 6 endian control			0	R/W				
		D0	A5EC	Area 5, 4 endian control			0	R/W				
TTBR low-order register	0048134 (HW)	DF	TTBR15	Trap table base address [15:10]						0	R/W	
		DE	TTBR14							0		
		DD	TTBR13		0							
		DC	TTBR12		0							
		DB	TTBR11		0							
		DA	TTBR10		0							
		D9	TTBR09	Trap table base address [9:0]	Fixed at 0			0	R	0 when being read. Writing 1 not allowed.		
		D8	TTBR08					0				
		D7	TTBR07					0				
		D6	TTBR06					0				
		D5	TTBR05					0				
		D4	TTBR04					0				
		D3	TTBR03					0				
		D2	TTBR02					0				
		D1	TTBR01					0				
		D0	TTBR00					0				
TTBR high-order register	0048136 (HW)	DF	TTBR33	Trap table base address [31:28]	Fixed at 0		0	R	0 when being read. Writing 1 not allowed.			
		DE	TTBR32				0					
		DD	TTBR31				0					
		DC	TTBR30				0					
		DB	TTBR2B	Trap table base address [27:16]	The initial value is set according to the BTA3 pin status. BTA3 = "1": 0x008 BTA3 = "0": 0x0C0			←	R/W			
		DA	TTBR2A									
		D9	TTBR29									
		D8	TTBR28									
		D7	TTBR27									
		D6	TTBR26									
		D5	TTBR25									
		D4	TTBR24									
		D3	TTBR23									
		D2	TTBR22									
D1	TTBR21											
D0	TTBR20											

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks			
G/A read signal control register	0048138 (HW)	DF	A18AS	Area 18, 17 address strobe signal	1	Enabled	0	Disabled	0	R/W		
		DE	A16AS	Area 16, 15 address strobe signal					0	R/W		
		DD	A14AS	Area 14, 13 address strobe signal					0	R/W		
		DC	A12AS	Area 12, 11 address strobe signal					0	R/W		
		DB	–	reserved					0	–		0 when being read.
		DA	A8AS	Area 8, 7 address strobe signal	1	Enabled	0	Disabled	0	R/W		
		D9	A6AS	Area 6 address strobe signal					0	R/W		
		D8	A5AS	Area 5, 4 address strobe signal					0	R/W		
		D7	A18RD	Area 18, 17 read signal	1	Enabled	0	Disabled	0	R/W		
		D6	A16RD	Area 16, 15 read signal					0	R/W		
		D5	A14RD	Area 14, 13 read signal					0	R/W		
		D4	A12RD	Area 12, 11 read signal					0	R/W		
		D3	–	reserved					0	–		0 when being read.
		D2	A8RD	Area 8, 7 read signal	1	Enabled	0	Disabled	0	R/W		
		D1	A6RD	Area 6 read signal					0	R/W		
		D0	A5RD	Area 5, 4 read signal					0	R/W		
BCLK select register	004813A (B)	D7–4	–	reserved				–	0	–	0 when being read.	
		D3	A1X1MD	Area 1 access-speed	1	2 cycles	0	4 cycles	0	R/W	x2 speed mode only	
		D2	–	reserved					–	0	–	0 when being read.
		D1	BCLKSEL1	BCLK output clock selection	BCLKSEL[1:0]		BCLK		0	R/W		
		D0	BCLKSEL0		1	1	PLL_CLK	0				
			1	0	OSC3_CLK							
			0	1	BCU_CLK							
			0	0	CPU_CLK							

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
16-bit timer 0 comparison register A	0048180 (HW)	DF	CR0A15	16-bit timer 0 comparison data A CR0A15 = MSB CR0A0 = LSB	0 to 65535	X	R/W				
		DE	CR0A14								
		DD	CR0A13								
		DC	CR0A12								
		DB	CR0A11								
		DA	CR0A10								
		D9	CR0A9								
		D8	CR0A8								
		D7	CR0A7								
		D6	CR0A6								
		D5	CR0A5								
		D4	CR0A4								
		D3	CR0A3								
		D2	CR0A2								
		D1	CR0A1								
		D0	CR0A0								
16-bit timer 0 comparison register B	0048182 (HW)	DF	CR0B15	16-bit timer 0 comparison data B CR0B15 = MSB CR0B0 = LSB	0 to 65535	X	R/W				
		DE	CR0B14								
		DD	CR0B13								
		DC	CR0B12								
		DB	CR0B11								
		DA	CR0B10								
		D9	CR0B9								
		D8	CR0B8								
		D7	CR0B7								
		D6	CR0B6								
		D5	CR0B5								
		D4	CR0B4								
		D3	CR0B3								
		D2	CR0B2								
		D1	CR0B1								
		D0	CR0B0								
16-bit timer 0 counter data register	0048184 (HW)	DF	TC015	16-bit timer 0 counter data TC015 = MSB TC00 = LSB	0 to 65535	X	R				
		DE	TC014								
		DD	TC013								
		DC	TC012								
		DB	TC011								
		DA	TC010								
		D9	TC09								
		D8	TC08								
		D7	TC07								
		D6	TC06								
		D5	TC05								
		D4	TC04								
		D3	TC03								
		D2	TC02								
		D1	TC01								
		D0	TC00								
16-bit timer 0 control register	0048186 (B)	D7	–	reserved	–	0	–	0 when being read.			
		D6	SELFM0	16-bit timer 0 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB0	16-bit timer 0 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV0	16-bit timer 0 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL0	16-bit timer 0 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM0	16-bit timer 0 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET0	16-bit timer 0 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN0	16-bit timer 0 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
16-bit timer 1 comparison register A	0048188 (HW)	DF	CR1A15	16-bit timer 1 comparison data A CR1A15 = MSB CR1A0 = LSB	0 to 65535	X	R/W		
		DE	CR1A14						
		DD	CR1A13						
		DC	CR1A12						
		DB	CR1A11						
		DA	CR1A10						
		D9	CR1A9						
		D8	CR1A8						
		D7	CR1A7						
		D6	CR1A6						
		D5	CR1A5						
		D4	CR1A4						
		D3	CR1A3						
		D2	CR1A2						
		D1	CR1A1						
		D0	CR1A0						
16-bit timer 1 comparison register B	004818A (HW)	DF	CR1B15	16-bit timer 1 comparison data B CR1B15 = MSB CR1B0 = LSB	0 to 65535	X	R/W		
		DE	CR1B14						
		DD	CR1B13						
		DC	CR1B12						
		DB	CR1B11						
		DA	CR1B10						
		D9	CR1B9						
		D8	CR1B8						
		D7	CR1B7						
		D6	CR1B6						
		D5	CR1B5						
		D4	CR1B4						
		D3	CR1B3						
		D2	CR1B2						
		D1	CR1B1						
		D0	CR1B0						
16-bit timer 1 counter data register	004818C (HW)	DF	TC115	16-bit timer 1 counter data TC115 = MSB TC10 = LSB	0 to 65535	X	R		
		DE	TC114						
		DD	TC113						
		DC	TC112						
		DB	TC111						
		DA	TC110						
		D9	TC19						
		D8	TC18						
		D7	TC17						
		D6	TC16						
		D5	TC15						
		D4	TC14						
		D3	TC13						
		D2	TC12						
		D1	TC11						
		D0	TC10						
16-bit timer 1 control register	004818E (B)	D7	–	reserved	–	0	–	0 when being read.	
		D6	SELF1	16-bit timer 1 fine mode selection	1 Fine mode	0 Normal	0	R/W	
		D5	SELCRB1	16-bit timer 1 comparison buffer	1 Enabled	0 Disabled	0	R/W	
		D4	OUTINV1	16-bit timer 1 output inversion	1 Invert	0 Normal	0	R/W	
		D3	CKSL1	16-bit timer 1 input clock selection	1 External clock	0 Internal clock	0	R/W	
		D2	PTM1	16-bit timer 1 clock output control	1 On	0 Off	0	R/W	
		D1	PRESET1	16-bit timer 1 reset	1 Reset	0 Invalid	0	W	0 when being read.
		D0	PRUN1	16-bit timer 1 Run/Stop control	1 Run	0 Stop	0	R/W	

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
16-bit timer 2 comparison register A	0048190 (HW)	DF	CR2A15	16-bit timer 2 comparison data A CR2A15 = MSB CR2A0 = LSB	0 to 65535	X	R/W		
		DE	CR2A14						
		DD	CR2A13						
		DC	CR2A12						
		DB	CR2A11						
		DA	CR2A10						
		D9	CR2A9						
		D8	CR2A8						
		D7	CR2A7						
		D6	CR2A6						
		D5	CR2A5						
		D4	CR2A4						
		D3	CR2A3						
		D2	CR2A2						
		D1	CR2A1						
		D0	CR2A0						
16-bit timer 2 comparison register B	0048192 (HW)	DF	CR2B15	16-bit timer 2 comparison data B CR2B15 = MSB CR2B0 = LSB	0 to 65535	X	R/W		
		DE	CR2B14						
		DD	CR2B13						
		DC	CR2B12						
		DB	CR2B11						
		DA	CR2B10						
		D9	CR2B9						
		D8	CR2B8						
		D7	CR2B7						
		D6	CR2B6						
		D5	CR2B5						
		D4	CR2B4						
		D3	CR2B3						
		D2	CR2B2						
		D1	CR2B1						
		D0	CR2B0						
16-bit timer 2 counter data register	0048194 (HW)	DF	TC215	16-bit timer 2 counter data TC215 = MSB TC20 = LSB	0 to 65535	X	R		
		DE	TC214						
		DD	TC213						
		DC	TC212						
		DB	TC211						
		DA	TC210						
		D9	TC29						
		D8	TC28						
		D7	TC27						
		D6	TC26						
		D5	TC25						
		D4	TC24						
		D3	TC23						
		D2	TC22						
		D1	TC21						
		D0	TC20						
16-bit timer 2 control register	0048196 (B)	D7	–	reserved	–	0	–	0 when being read.	
		D6	SELFM2	16-bit timer 2 fine mode selection	1 Fine mode	0 Normal	0	R/W	
		D5	SELCRB2	16-bit timer 2 comparison buffer	1 Enabled	0 Disabled	0	R/W	
		D4	OUTINV2	16-bit timer 2 output inversion	1 Invert	0 Normal	0	R/W	
		D3	CKSL2	16-bit timer 2 input clock selection	1 External clock	0 Internal clock	0	R/W	
		D2	PTM2	16-bit timer 2 clock output control	1 On	0 Off	0	R/W	
		D1	PRESET2	16-bit timer 2 reset	1 Reset	0 Invalid	0	W	0 when being read.
		D0	PRUN2	16-bit timer 2 Run/Stop control	1 Run	0 Stop	0	R/W	

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
16-bit timer 3 comparison register A	0048198 (HW)	DF	CR3A15	16-bit timer 3 comparison data A CR3A15 = MSB CR3A0 = LSB	0 to 65535	X	R/W				
		DE	CR3A14								
		DD	CR3A13								
		DC	CR3A12								
		DB	CR3A11								
		DA	CR3A10								
		D9	CR3A9								
		D8	CR3A8								
		D7	CR3A7								
		D6	CR3A6								
		D5	CR3A5								
		D4	CR3A4								
		D3	CR3A3								
		D2	CR3A2								
		D1	CR3A1								
		D0	CR3A0								
16-bit timer 3 comparison register B	004819A (HW)	DF	CR3B15	16-bit timer 3 comparison data B CR3B15 = MSB CR3B0 = LSB	0 to 65535	X	R/W				
		DE	CR3B14								
		DD	CR3B13								
		DC	CR3B12								
		DB	CR3B11								
		DA	CR3B10								
		D9	CR3B9								
		D8	CR3B8								
		D7	CR3B7								
		D6	CR3B6								
		D5	CR3B5								
		D4	CR3B4								
		D3	CR3B3								
		D2	CR3B2								
		D1	CR3B1								
		D0	CR3B0								
16-bit timer 3 counter data register	004819C (HW)	DF	TC315	16-bit timer 3 counter data TC315 = MSB TC30 = LSB	0 to 65535	X	R				
		DE	TC314								
		DD	TC313								
		DC	TC312								
		DB	TC311								
		DA	TC310								
		D9	TC39								
		D8	TC38								
		D7	TC37								
		D6	TC36								
		D5	TC35								
		D4	TC34								
		D3	TC33								
		D2	TC32								
		D1	TC31								
		D0	TC30								
16-bit timer 3 control register	004819E (B)	D7	–	reserved	–		0	–	0 when being read.		
		D6	SELF3	16-bit timer 3 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SEL3B3	16-bit timer 3 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV3	16-bit timer 3 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL3	16-bit timer 3 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM3	16-bit timer 3 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET3	16-bit timer 3 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN3	16-bit timer 3 Run/Stop control	1	Run	0	Stop	0	R/W	

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
16-bit timer 4 comparison register A	00481A0 (HW)	DF	CR4A15	16-bit timer 4 comparison data A CR4A15 = MSB CR4A0 = LSB	0 to 65535		X	R/W			
		DE	CR4A14								
		DD	CR4A13								
		DC	CR4A12								
		DB	CR4A11								
		DA	CR4A10								
		D9	CR4A9								
		D8	CR4A8								
		D7	CR4A7								
		D6	CR4A6								
		D5	CR4A5								
		D4	CR4A4								
		D3	CR4A3								
		D2	CR4A2								
		D1	CR4A1								
		D0	CR4A0								
16-bit timer 4 comparison register B	00481A2 (HW)	DF	CR4B15	16-bit timer 4 comparison data B CR4B15 = MSB CR4B0 = LSB	0 to 65535		X	R/W			
		DE	CR4B14								
		DD	CR4B13								
		DC	CR4B12								
		DB	CR4B11								
		DA	CR4B10								
		D9	CR4B9								
		D8	CR4B8								
		D7	CR4B7								
		D6	CR4B6								
		D5	CR4B5								
		D4	CR4B4								
		D3	CR4B3								
		D2	CR4B2								
		D1	CR4B1								
		D0	CR4B0								
16-bit timer 4 counter data register	00481A4 (HW)	DF	TC415	16-bit timer 4 counter data TC415 = MSB TC40 = LSB	0 to 65535		X	R			
		DE	TC414								
		DD	TC413								
		DC	TC412								
		DB	TC411								
		DA	TC410								
		D9	TC49								
		D8	TC48								
		D7	TC47								
		D6	TC46								
		D5	TC45								
		D4	TC44								
		D3	TC43								
		D2	TC42								
		D1	TC41								
		D0	TC40								
16-bit timer 4 control register	00481A6 (B)	D7	–	reserved	–		0	–	0 when being read.		
		D6	SELFM4	16-bit timer 4 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB4	16-bit timer 4 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV4	16-bit timer 4 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL4	16-bit timer 4 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM4	16-bit timer 4 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET4	16-bit timer 4 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN4	16-bit timer 4 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
16-bit timer 5 comparison register A	00481A8 (HW)	DF	CR5A15	16-bit timer 5 comparison data A CR5A15 = MSB CR5A0 = LSB	0 to 65535	X	R/W				
		DE	CR5A14								
		DD	CR5A13								
		DC	CR5A12								
		DB	CR5A11								
		DA	CR5A10								
		D9	CR5A9								
		D8	CR5A8								
		D7	CR5A7								
		D6	CR5A6								
		D5	CR5A5								
		D4	CR5A4								
		D3	CR5A3								
		D2	CR5A2								
		D1	CR5A1								
		D0	CR5A0								
16-bit timer 5 comparison register B	00481AA (HW)	DF	CR5B15	16-bit timer 5 comparison data B CR5B15 = MSB CR5B0 = LSB	0 to 65535	X	R/W				
		DE	CR5B14								
		DD	CR5B13								
		DC	CR5B12								
		DB	CR5B11								
		DA	CR5B10								
		D9	CR5B9								
		D8	CR5B8								
		D7	CR5B7								
		D6	CR5B6								
		D5	CR5B5								
		D4	CR5B4								
		D3	CR5B3								
		D2	CR5B2								
		D1	CR5B1								
		D0	CR5B0								
16-bit timer 5 counter data register	00481AC (HW)	DF	TC515	16-bit timer 5 counter data TC515 = MSB TC50 = LSB	0 to 65535	X	R				
		DE	TC514								
		DD	TC513								
		DC	TC512								
		DB	TC511								
		DA	TC510								
		D9	TC59								
		D8	TC58								
		D7	TC57								
		D6	TC56								
		D5	TC55								
		D4	TC54								
		D3	TC53								
		D2	TC52								
		D1	TC51								
		D0	TC50								
16-bit timer 5 control register	00481AE (B)	D7	–	reserved	–		0	–	0 when being read.		
		D6	SELF5	16-bit timer 5 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB5	16-bit timer 5 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV5	16-bit timer 5 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL5	16-bit timer 5 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM5	16-bit timer 5 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET5	16-bit timer 5 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN5	16-bit timer 5 Run/Stop control	1	Run	0	Stop	0	R/W	

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
IDMA base address low-order register	0048200 (HW)	DF	DBASEL15	IDMA base address		0	R/W	
		DE	DBASEL14	low-order 16 bits		0		
		DD	DBASEL13	(Initial value: 0x0C003A0)		0		
		DC	DBASEL12			0		
		DB	DBASEL11			0		
		DA	DBASEL10			0		
		D9	DBASEL9			1		
		D8	DBASEL8			1		
		D7	DBASEL7			1		
		D6	DBASEL6			0		
		D5	DBASEL5			1		
		D4	DBASEL4			0		
		D3	DBASEL3			0		
		D2	DBASEL2			0		
		D1	DBASEL1			0		
		D0	DBASEL0			0		
		IDMA base address high-order register	0048202 (HW)	DF-C	-	reserved		
DB	DBASEH11			IDMA base address		0	R/W	
DA	DBASEH10			high-order 12 bits		0		
D9	DBASEH9			(Initial value: 0x0C003A0)		0		
D8	DBASEH8					0		
D7	DBASEH7					1		
D6	DBASEH6					1		
D5	DBASEH5					0		
D4	DBASEH4					0		
D3	DBASEH3					0		
D2	DBASEH2					0		
D1	DBASEH1					0		
D0	DBASEH0					0		
IDMA start register	0048204 (B)	D7	DSTART	IDMA start	1 IDMA start 0 Stop	0		
		D6-0	DCHN	IDMA channel number	0 to 127	0	R/W	
IDMA enable register	0048205 (B)	D7-1	-	reserved	-	-	-	
		D0	IDMAEN	IDMA enable	1 Enabled 0 Disabled	0	R/W	

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks							
High-speed DMA Ch.0 transfer counter register	0048220 (HW)	DF	TC0_L7	Ch.0 transfer counter[7:0] (block transfer mode)			X	R/W							
		DE	TC0_L6												
		DD	TC0_L5												
		DC	TC0_L4												
		DB	TC0_L3				Ch.0 transfer counter[15:8] (single/successive transfer mode)								
		DA	TC0_L2												
		D9	TC0_L1												
		D8	TC0_L0												
		D7	BLKLEN07	Ch.0 block length (block transfer mode)				X	R/W						
		D6	BLKLEN06												
		D5	BLKLEN05												
		D4	BLKLEN04					Ch.0 transfer counter[7:0] (single/successive transfer mode)							
		D3	BLKLEN03												
		D2	BLKLEN02												
D1	BLKLEN01														
D0	BLKLEN00														
High-speed DMA Ch.0 control register	0048222 (HW)	DF	DUALM0	Ch.0 address mode selection	1	Dual addr	0	Single addr	0	R/W					
		DE	D0DIR	D) Invalid											
				S) Ch.0 transfer direction control	1	Memory WR	0	Memory RD	0	R/W					
		DD-8	-	reserved								Undefined in read.			
		D7	TC0_H7	Ch.0 transfer counter[15:8] (block transfer mode)						X	R/W				
		D6	TC0_H6												
		D5	TC0_H5												
		D4	TC0_H4							Ch.0 transfer counter[23:16] (single/successive transfer mode)					
		D3	TC0_H3												
		D2	TC0_H2												
		D1	TC0_H1												
D0	TC0_H0														
High-speed DMA Ch.0 low-order source address set-up register	0048224 (HW)	DF	S0ADRL15	D) Ch.0 source address[15:0] S) Ch.0 memory address[15:0]					X	R/W					
		DE	S0ADRL14												
		DD	S0ADRL13												
		DC	S0ADRL12												
		DB	S0ADRL11												
		DA	S0ADRL10												
		D9	S0ADRL9												
		A8	S0ADRL8												
		D7	S0ADRL7												
		D6	S0ADRL6												
		D5	S0ADRL5												
		D4	S0ADRL4												
		D3	S0ADRL3												
		D2	S0ADRL2												
D1	S0ADRL1														
D0	S0ADRL0														
High-speed DMA Ch.0 high-order source address set-up register	0048226 (HW)	DF	DINTEN0	Ch.0 interrupt enable	1	Enabled	0	Disabled	0	R/W					
		DE	DATSIZE0	Ch.0 transfer data size	1	Half word	0	Byte	0	R/W					
		DD	S0IN1	D) Ch.0 source address control S) Ch.0 memory address control							0	R/W			
		DC	S0IN0												
													1	1	Inc.(no init)
													1	0	Inc.(init)
						0	1	Dec.(no init)							
						0	0	Fixed							
		D7	S0ADRH11	D) Ch.0 source address[27:16] S) Ch.0 memory address[27:16]							X	R/W			
		DA	S0ADRH10												
		D9	S0ADRH9												
		A8	S0ADRH8												
		D7	S0ADRH7												
		D6	S0ADRH6												
D5	S0ADRH5														
D4	S0ADRH4														
D3	S0ADRH3														
D2	S0ADRH2														
D1	S0ADRH1														
D0	S0ADRH0														

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
High-speed DMA Ch.0 low-order destination address set-up register Note: D) Dual address mode S) Single address mode	0048228 (HW)	DF	D0ADRL15	D) Ch.0 destination address[15:0] S) Invalid				R/W	X	
		DE	D0ADRL14						X	
		DD	D0ADRL13						X	
		DC	D0ADRL12						X	
		DB	D0ADRL11						X	
		DA	D0ADRL10						X	
		D9	D0ADRL9						X	
		A8	D0ADRL8						X	
		D7	D0ADRL7						X	
		D6	D0ADRL6						X	
		D5	D0ADRL5						X	
		D4	D0ADRL4						X	
		D3	D0ADRL3						X	
		D2	D0ADRL2						X	
		D1	D0ADRL1						X	
		D0	D0ADRL0						X	
High-speed DMA Ch.0 high-order destination address set-up register Note: D) Dual address mode S) Single address mode	004822A (HW)	DF	D0MOD1	Ch.0 transfer mode	D0MOD[1:0]	Mode	0	R/W		
		DE	D0MOD0							1 1
							1 0	Block		
							0 1	Successive		
							0 0	Single		
		DD	D0IN1	D) Ch.0 destination address control	D0IN[1:0]	Inc/dec	0	R/W		
		DC	D0IN0							1 1
							1 0	Inc.(init)		
							0 1	Dec.(no init)		
							0 0	Fixed		
		DB	D0ADRH11	D) Ch.0 destination address[27:16] S) Invalid					R/W	X
		DA	D0ADRH10							X
D9	D0ADRH9	X								
A8	D0ADRH8	X								
D7	D0ADRH7	X								
D6	D0ADRH6	X								
D5	D0ADRH5	X								
D4	D0ADRH4	X								
D3	D0ADRH3	X								
D2	D0ADRH2	X								
D1	D0ADRH1	X								
D0	D0ADRH0	X								
High-speed DMA Ch.0 enable register	004822C (HW)	DF-1	–	reserved	–	–	–	Undefined in read.		
		D0	HS0_EN	Ch.0 enable	1 Enable	0 Disable	0	R/W		
High-speed DMA Ch.0 trigger flag register	004822E (HW)	DF-1	–	reserved	–	–	–	Undefined in read.		
		D0	HS0_TF	Ch.0 trigger flag clear (writing)	1 Clear	0 No operation	0	R/W		
				Ch.0 trigger flag status (reading)	1 Set	0 Cleared				

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks											
High-speed DMA Ch.1 transfer counter register	0048230 (HW)	DF	TC1_L7	Ch.1 transfer counter[7:0] (block transfer mode)			X	R/W											
		DE	TC1_L6																
		DD	TC1_L5																
		DC	TC1_L4																
		DB	TC1_L3																
		DA	TC1_L2																
		D9	TC1_L1																
		D8	TC1_L0																
		D7	BLKLEN17				Ch.1 block length (block transfer mode)						X	R/W					
		D6	BLKLEN16																
	D5	BLKLEN15																	
	D4	BLKLEN14	Ch.1 transfer counter[7:0] (single/successive transfer mode)																
	D3	BLKLEN13																	
	D2	BLKLEN12																	
	D1	BLKLEN11																	
	D0	BLKLEN10																	
High-speed DMA Ch.1 control register	0048232 (HW)	DF	DUALM1	Ch.1 address mode selection	1	Dual addr	0	Single addr	0	R/W									
		DE	D1DIR	D) Invalid															
				S) Ch.1 transfer direction control	1	Memory WR	0	Memory RD	0	R/W									
		DD-8	-	reserved								Undefined in read.							
		D7	TC1_H7	Ch.1 transfer counter[15:8] (block transfer mode)						R/W									
		D6	TC1_H6																
		D5	TC1_H5																
		D4	TC1_H4									Ch.1 transfer counter[23:16] (single/successive transfer mode)							
		D3	TC1_H3																
		D2	TC1_H2																
		D1	TC1_H1																
D0	TC1_H0																		
High-speed DMA Ch.1 low-order source address set-up register	0048234 (HW)	DF	S1ADRL15										D) Ch.1 source address[15:0] S) Ch.1 memory address[15:0]					R/W	
		DE	S1ADRL14																
		DD	S1ADRL13																
		DC	S1ADRL12																
		DB	S1ADRL11																
		DA	S1ADRL10																
		D9	S1ADRL9																
		A8	S1ADRL8																
		D7	S1ADRL7																
		D6	S1ADRL6																
		D5	S1ADRL5																
		D4	S1ADRL4																
		D3	S1ADRL3																
		D2	S1ADRL2																
		D1	S1ADRL1																
		D0	S1ADRL0																
High-speed DMA Ch.1 high-order source address set-up register	0048236 (HW)	DF	DINTEN1	Ch.1 interrupt enable	1	Enabled	0	Disabled	0	R/W									
		DE	DATSIZE1	Ch.1 transfer data size	1	Half word	0	Byte	0	R/W									
		DD	S1IN1	D) Ch.1 source address control S) Ch.1 memory address control							R/W								
		DC	S1IN0																
													1	1	Inc.(no init)				
													1	0	Inc.(init)				
				0	1	Dec.(no init)													
				0	0	Fixed													
		D7	S1ADRH11	D) Ch.1 source address[27:16] S) Ch.1 memory address[27:16]						R/W									
		DA	S1ADRH10																
		D9	S1ADRH9																
		A8	S1ADRH8																
		D7	S1ADRH7																
		D6	S1ADRH6																
		D5	S1ADRH5																
		D4	S1ADRH4																
D3	S1ADRH3																		
D2	S1ADRH2																		
D1	S1ADRH1																		
D0	S1ADRH0																		

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks												
High-speed DMA Ch.1 low-order destination address set-up register Note: D) Dual address mode S) Single address mode	0048238 (HW)	DF	D1ADRL15	D) Ch.1 destination address[15:0] S) Invalid				R/W	X											
		DE	D1ADRL14						X											
		DD	D1ADRL13						X											
		DC	D1ADRL12						X											
		DB	D1ADRL11						X											
		DA	D1ADRL10						X											
		D9	D1ADRL9						X											
		A8	D1ADRL8						X											
		D7	D1ADRL7						X											
		D6	D1ADRL6						X											
		D5	D1ADRL5						X											
		D4	D1ADRL4						X											
		D3	D1ADRL3						X											
		D2	D1ADRL2						X											
		D1	D1ADRL1						X											
D0	D1ADRL0	X																		
High-speed DMA Ch.1 high-order destination address set-up register Note: D) Dual address mode S) Single address mode	004823A (HW)	DF	D1MOD1	Ch.1 transfer mode		D1MOD[1:0]	Mode	0	R/W											
		DE	D1MOD0								1 1	Invalid	0							
											1 0	Block								
											0 1	Successive								
											0 0	Single								
			DD								D1IN1	D) Ch.1 destination address control S) Invalid		D1IN[1:0]	Inc/dec	0	R/W			
			DC								D1IN0								1 1	Inc.(no init)
																			1 0	Inc.(init)
																			0 1	Dec.(no init)
																			0 0	Fixed
			DB								D1ADRH11	D) Ch.1 destination address[27:16] S) Invalid					R/W			
			DA								D1ADRH10								X	
			D9								D1ADRH9								X	
			A8								D1ADRH8								X	
	D7	D1ADRH7	X																	
	D6	D1ADRH6	X																	
	D5	D1ADRH5	X																	
	D4	D1ADRH4	X																	
	D3	D1ADRH3	X																	
	D2	D1ADRH2	X																	
	D1	D1ADRH1	X																	
	D0	D1ADRH0	X																	
High-speed DMA Ch.1 enable register	004823C (HW)	DF-1	-	reserved		-	-	-	Undefined in read.											
		D0	HS1_EN	Ch.1 enable	1 Enable	0 Disable	0	R/W												
High-speed DMA Ch.1 trigger flag register	004823E (HW)	DF-1	-	reserved		-	-	-	Undefined in read.											
		D0	HS1_TF	Ch.1 trigger flag clear (writing)	1 Clear	0 No operation	0	R/W												
				Ch.1 trigger flag status (reading)	1 Set	0 Cleared														

Register name	Address	Bit	Name	Function	Setting			Init.	R/W	Remarks							
High-speed DMA Ch.2 transfer counter register	0048240 (HW)	DF	TC2_L7	Ch.2 transfer counter[7:0] (block transfer mode)				X	R/W								
		DE	TC2_L6														
		DD	TC2_L5														
		DC	TC2_L4														
		DB	TC2_L3														
		DA	TC2_L2														
		D9	TC2_L1														
		D8	TC2_L0														
		D7	BLKLEN27								Ch.2 block length (block transfer mode)				X	R/W	
		D6	BLKLEN26														
	D5	BLKLEN25															
	D4	BLKLEN24	Ch.2 transfer counter[7:0] (single/successive transfer mode)				X										
	D3	BLKLEN23															
	D2	BLKLEN22															
	D1	BLKLEN21															
	D0	BLKLEN20															
High-speed DMA Ch.2 control register	0048242 (HW)	DF	DUALM2	Ch.2 address mode selection	1	Dual addr	0	Single addr	0	R/W							
		DE	D2DIR	D) Invalid													
				S) Ch.2 transfer direction control	1	Memory WR	0	Memory RD	0	R/W							
		DD-8	-	reserved							Undefined in read.						
	Note: D) Dual address mode S) Single address mode		D7	TC2_H7	Ch.2 transfer counter[15:8] (block transfer mode)				X	R/W							
		D6	TC2_H6														
		D5	TC2_H5														
		D4	TC2_H4	Ch.2 transfer counter[23:16] (single/successive transfer mode)											X		
		D3	TC2_H3														
		D2	TC2_H2														
		D1	TC2_H1														
		D0	TC2_H0														
High-speed DMA Ch.2 low-order source address set-up register		0048244 (HW)	DF	S2ADRL15								D) Ch.2 source address[15:0] S) Ch.2 memory address[15:0]				X	R/W
	DE		S2ADRL14														
	DD		S2ADRL13														
	DC		S2ADRL12														
	DB		S2ADRL11														
	DA		S2ADRL10														
	D9		S2ADRL9														
	A8		S2ADRL8														
	D7		S2ADRL7														
	D6		S2ADRL6														
	D5		S2ADRL5														
	D4		S2ADRL4														
	D3		S2ADRL3														
	D2		S2ADRL2														
	D1		S2ADRL1														
D0	S2ADRL0																
High-speed DMA Ch.2 high-order source address set-up register	0048246 (HW)	DF	DINTEN2	Ch.2 interrupt enable	1	Enabled	0	Disabled	0	R/W							
		DE	DATSIZE2	Ch.2 transfer data size	1	Half word	0	Byte	0	R/W							
		DD	S2IN1	D) Ch.2 source address control	S2IN[1:0]		Inc/dec		0	R/W							
		DC	S2IN0	S) Ch.2 memory address control	1	1	Inc.(no init)		0								
					1	0	Inc.(init)										
					0	1	Dec.(no init)										
					0	0	Fixed										
		Note: D) Dual address mode S) Single address mode		DB	S2ADRH11	D) Ch.2 source address[27:16] S) Ch.2 memory address[27:16]				X	R/W						
			DA	S2ADRH10													
			D9	S2ADRH9													
			A8	S2ADRH8													
			D7	S2ADRH7													
			D6	S2ADRH6													
			D5	S2ADRH5													
			D4	S2ADRH4													
D3	S2ADRH3																
D2	S2ADRH2																
D1	S2ADRH1																
D0	S2ADRH0																

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
High-speed DMA Ch.2 low-order destination address set-up register Note: D) Dual address mode S) Single address mode	0048248 (HW)	DF	D2ADRL15	D) Ch.2 destination address[15:0] S) Invalid			X	R/W		
		DE	D2ADRL14							
		DD	D2ADRL13							
		DC	D2ADRL12							
		DB	D2ADRL11							
		DA	D2ADRL10							
		D9	D2ADRL9							
		A8	D2ADRL8							
		D7	D2ADRL7							
		D6	D2ADRL6							
		D5	D2ADRL5							
		D4	D2ADRL4							
		D3	D2ADRL3							
		D2	D2ADRL2							
		D1	D2ADRL1							
		D0	D2ADRL0							
		High-speed DMA Ch.2 high-order destination address set-up register Note: D) Dual address mode S) Single address mode	004824A (HW)				DF			D2MOD1
DE	D2MOD0			1 1	Invalid	0				
				1 0	Block		0 1	Successive		
				0 1	Single	0 0			Single	
				0 0	Single		0	R/W		
DD	D2IN1			D) Ch.2 destination address control S) Invalid	D2IN[1:0]	Inc/dec			0	R/W
DC	D2IN0						1 1	Inc.(no init)		
				1 0	Inc.(init)	0 1	Dec.(no init)			
				0 1	Dec.(no init)			0 0	Fixed	
				0 0	Fixed	X	R/W			
DB	D2ADRH11			D) Ch.2 destination address[27:16] S) Invalid						
DA	D2ADRH10									
D9	D2ADRH9									
A8	D2ADRH8									
D7	D2ADRH7									
D6	D2ADRH6									
D5	D2ADRH5									
D4	D2ADRH4									
D3	D2ADRH3									
D2	D2ADRH2									
D1	D2ADRH1									
D0	D2ADRH0									
High-speed DMA Ch.2 enable register	004824C (HW)	DF-1	-	reserved	-	-	-	Undefined in read.		
		D0	HS2_EN	Ch.2 enable	1 Enable	0 Disable	0	R/W		
High-speed DMA Ch.2 trigger flag register	004824E (HW)	DF-1	-	reserved	-	-	-	Undefined in read.		
		D0	HS2_TF	Ch.2 trigger flag clear (writing)	1 Clear	0 No operation	0	R/W		
				Ch.2 trigger flag status (reading)	1 Set	0 Cleared				

Register name	Address	Bit	Name	Function	Setting			Init.	R/W	Remarks							
High-speed DMA Ch.3 transfer counter register	0048250 (HW)	DF	TC3_L7	Ch.3 transfer counter[7:0] (block transfer mode)				X	R/W								
		DE	TC3_L6														
		DD	TC3_L5														
		DC	TC3_L4														
		DB	TC3_L3														
		DA	TC3_L2														
		D9	TC3_L1														
		D8	TC3_L0														
		D7	BLKLEN37								Ch.3 block length (block transfer mode)				X	R/W	
		D6	BLKLEN36														
	D5	BLKLEN35															
	D4	BLKLEN34	Ch.3 transfer counter[7:0] (single/successive transfer mode)				X										
	D3	BLKLEN33															
	D2	BLKLEN32															
	D1	BLKLEN31															
	D0	BLKLEN30															
High-speed DMA Ch.3 control register	0048252 (HW)	DF	DUALM3	Ch.3 address mode selection	1	Dual addr	0	Single addr	0	R/W							
		DE	D3DIR	D) Invalid													
				S) Ch.3 transfer direction control	1	Memory WR	0	Memory RD	0	R/W							
		DD-8	-	reserved							Undefined in read.						
		D7	TC3_H7	Ch.3 transfer counter[15:8] (block transfer mode)					X	R/W							
		D6	TC3_H6														
		D5	TC3_H5														
		D4	TC3_H4														
		D3	TC3_H3									Ch.3 transfer counter[23:16] (single/successive transfer mode)				X	
		D2	TC3_H2														
D1	TC3_H1																
D0	TC3_H0																
High-speed DMA Ch.3 low-order source address set-up register	0048254 (HW)	DF	S3ADRL15	D) Ch.3 source address[15:0] S) Ch.3 memory address[15:0]				X	R/W								
		DE	S3ADRL14														
		DD	S3ADRL13														
		DC	S3ADRL12														
		DB	S3ADRL11														
		DA	S3ADRL10														
		D9	S3ADRL9														
		A8	S3ADRL8														
		D7	S3ADRL7														
		D6	S3ADRL6														
		D5	S3ADRL5														
		D4	S3ADRL4														
		D3	S3ADRL3														
		D2	S3ADRL2														
		D1	S3ADRL1														
		D0	S3ADRL0														
High-speed DMA Ch.3 high-order source address set-up register	0048256 (HW)	DF	DINTEN3	Ch.3 interrupt enable	1	Enabled	0	Disabled	0	R/W							
		DE	DATSIZE3	Ch.3 transfer data size	1	Half word	0	Byte	0	R/W							
		DD	S3IN1	D) Ch.3 source address control S) Ch.3 memory address control		1	1	Inc.(no init)	0	R/W							
		DC	S3IN0														
												1	0	Inc.(init)			
												0	1	Dec.(no init)			
				0	0	Fixed											
		Note: D) Dual address mode S) Single address mode		DB	S3ADRH11	D) Ch.3 source address[27:16] S) Ch.3 memory address[27:16]				X	R/W						
				DA	S3ADRH10												
				D9	S3ADRH9												
A8	S3ADRH8																
D7	S3ADRH7																
D6	S3ADRH6																
D5	S3ADRH5																
D4	S3ADRH4																
D3	S3ADRH3																
D2	S3ADRH2																
D1	S3ADRH1																
D0	S3ADRH0																

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
High-speed DMA Ch.3 low-order destination address set-up register Note: D) Dual address mode S) Single address mode	0048258 (HW)	DF	D3ADRL15	D) Ch.3 destination address[15:0] S) Invalid				R/W	X		
		DE	D3ADRL14						X		
		DD	D3ADRL13						X		
		DC	D3ADRL12						X		
		DB	D3ADRL11						X		
		DA	D3ADRL10						X		
		D9	D3ADRL9						X		
		A8	D3ADRL8						X		
		D7	D3ADRL7						X		
		D6	D3ADRL6						X		
		D5	D3ADRL5						X		
		D4	D3ADRL4						X		
		D3	D3ADRL3						X		
		D2	D3ADRL2						X		
		D1	D3ADRL1						X		
D0	D3ADRL0	X									
High-speed DMA Ch.3 high-order destination address set-up register Note: D) Dual address mode S) Single address mode	004825A (HW)	DF	D3MOD1	Ch.3 transfer mode	D3MOD[1:0]	Mode	0	R/W			
		DE	D3MOD0							1 1 Invalid	
							1 0 Block				
							0 1 Successive				
							0 0 Single				
				DD	D3IN1	D) Ch.3 destination address control S) Invalid	D3IN[1:0]	Inc/dec	0	R/W	
				DC	D3IN0						
								1 0 Inc.(init)			
								0 1 Dec.(no init)			
								0 0 Fixed			
				DB	D3ADRH11	D) Ch.3 destination address[27:16] S) Invalid				R/W	
				DA	D3ADRH10						
		D9	D3ADRH9	X							
		A8	D3ADRH8	X							
		D7	D3ADRH7	X							
		D6	D3ADRH6	X							
		D5	D3ADRH5	X							
		D4	D3ADRH4	X							
		D3	D3ADRH3	X							
		D2	D3ADRH2	X							
		D1	D3ADRH1	X							
		D0	D3ADRH0	X							
High-speed DMA Ch.3 enable register	004825C (HW)	DF-1	-	reserved	-	-	-	-	Undefined in read.		
		D0	HS3_EN	Ch.3 enable	1 Enable	0 Disable	0	R/W			
High-speed DMA Ch.3 trigger flag register	004825E (HW)	DF-1	-	reserved	-	-	-	-	Undefined in read.		
		D0	HS3_TF	Ch.3 trigger flag clear (writing)	1 Clear	0 No operation	0	R/W			
				Ch.3 trigger flag status (reading)	1 Set	0 Cleared					

Register name	Address	Bit	Name	Setting	Init.	R/W	Remarks			
SED1375 REG[00h] Revision code register	039FFE0 (B)	D7	Product Code Bit 5	SED1375 = "001001"		0	R			
		D6	Product Code Bit 4			0				
		D5	Product Code Bit 3			1				
		D4	Product Code Bit 2			0				
		D3	Product Code Bit 1			0				
		D2	Product Code Bit 0			1				
		D1	Revision Code Bit 1			0	R			
D0	Revision Code Bit 0			Revision = "01"	0	1				
SED1375 REG[01h] Mode register 0	039FFE1 (B)	D7	TFT/STN	1	TFT/D-TFD	0	STN	0	R/W	
		D6	Dual/Single	1	Dual	0	Single	0	R/W	
		D5	Color/Mono	1	Color	0	Mono	0	R/W	
		D4	FP Line Polarity	1	Active high	0	Active low	0	R/W	
		D3	FP Flame Polarity	1	Active high	0	Active low	0	R/W	
		D2	Mask FPSHIFT	1	Masked	0	Not masked	0	R/W	
		D1	Data Width Bit 1			See SED1375 Hardware		0	R/W	
D0	Data Width Bit 0			Functional Specification		0				
SED1375 REG[02h] Mode register 1	039FFE2 (B)	D7	Bit-Per-Pixel Bit 1	Bit[1:0]		0	R/W			
				D6	Bit-Per-Pixel Bit 0				8 bpp	
									4 bpp	
									2 bpp	
									1 bpp	
		D5	High Performance	1	MCIk=PCIk	0	MCIk=PCIk/x	0	R/W	
		D4	Input Clock Divide (Clk / 2)	1	Clk/1	0	Clk/2	0	R/W	
		D3	Display Blank	1	Displayed	0	Blanked	0	R/W	
		D2	Frame Repeat	1	Repeated	0	Not repeated	0	R/W	
D1	Hardware Video Invert Enable	1	Inverted	0	GPIO4	0	R/W			
D0	Software Video Invert	1	Inverted	0	Normal	0	R/W			
SED1375 REG[03h] Mode register 2	039FFE3 (B)	D7-4	n/a	-		0	R/W			
		D3	LCDPWR Override	1	Inactive	0	Controlled	0	R/W	
		D2	Hardware Power Save Enable	1	Enabled	0	GPIO0	0	R/W	
		D1	Software Power Save Bit 1	Bit[1:0]		0	R/W			
				Mode						
		D0	Software Power Save Bit 0	1	1	Normal operation		0		
		1	0	reserved						
		0	1	reserved						
		0	0	Power save mode						
SED1375 REG[04h] Horizontal panel size register	039FFE4 (B)	D7	n/a	-		0	R/W			
		D6	Horizontal Panel Size Bit 6	Value =		0	R/W			
		D5	Horizontal Panel Size Bit 5	(Horizontal panel resolution/8)		0				
		D4	Horizontal Panel Size Bit 4	- 1		0				
		D3	Horizontal Panel Size Bit 3			0				
		D2	Horizontal Panel Size Bit 2			0				
		D1	Horizontal Panel Size Bit 1			0				
		D0	Horizontal Panel Size Bit 0			0				
SED1375 REG[05h] Vertical panel size register (LSB)	039FFE5 (B)	D7	Vertical Panel Size Bit 7	Value =		0	R/W			
		D6	Vertical Panel Size Bit 6	Vertical panel resolution - 1		0				
		D5	Vertical Panel Size Bit 5			0				
		D4	Vertical Panel Size Bit 4			0				
		D3	Vertical Panel Size Bit 3			0				
		D2	Vertical Panel Size Bit 2			0				
		D1	Vertical Panel Size Bit 1			0				
		D0	Vertical Panel Size Bit 0			0				
SED1375 REG[06h] Vertical panel size register (MSB)	039FFE6 (B)	D7-2	n/a	-		0	R/W			
		D1	Vertical Panel Size Bit 9	Value =		0	R/W			
		D0	Vertical Panel Size Bit 8	Vertical panel resolution - 1		0				
SED1375 REG[07h] FPLINE start position	039FFE7 (B)	D7-5	n/a	-		0	R/W			
		D4	FPLINE Start Position Bit 4	FPLINE start position (pixels)		0	R/W			
		D3	FPLINE Start Position Bit 3	= (REG[07h] + 2) x 8		0				
		D2	FPLINE Start Position Bit 2			0				
		D1	FPLINE Start Position Bit 1			0				
		D0	FPLINE Start Position Bit 0			0				
SED1375 REG[08h] Horizontal non-display period	039FFE8 (B)	D7-5	n/a	-		0	R/W			
		D4	Horizontal Non-Display Period Bit 4	Horizontal non-display period		0	R/W			
		D3	Horizontal Non-Display Period Bit 3	(pixels) = (REG[08h] + 4) x 8		0				
		D2	Horizontal Non-Display Period Bit 2			0				
		D1	Horizontal Non-Display Period Bit 1			0				
		D0	Horizontal Non-Display Period Bit 0			0				

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Register name	Address	Bit	Name	Setting	Init.	R/W	Remarks
SED1375 REG[09h] FPFRAME start position	039FFE9 (B)	D7-6	n/a	–	0	R/W	
		D5	FPFRAME Start Position Bit 5	FPFRAME start position (lines) = REG[09h]	0	R/W	
		D4	FPFRAME Start Position Bit 4		0		
		D3	FPFRAME Start Position Bit 3		0		
		D2	FPFRAME Start Position Bit 2		0		
		D1	FPFRAME Start Position Bit 1		0		
		D0	FPFRAME Start Position Bit 0		0		
SED1375 REG[0Ah] Vertical non-display period	039FFEA (B)	D7	Vertical Non-Display Status		1 Non-display 0 Display	0	R
		D6	n/a	–	0	R/W	
		D5	Vertical Non-Display Period Bit 5	Vertical non-display period (lines) = REG[0Ah] bits [5:0]	0	R/W	
		D4	Vertical Non-Display Period Bit 4		0		
		D3	Vertical Non-Display Period Bit 3		0		
		D2	Vertical Non-Display Period Bit 2		0		
		D1	Vertical Non-Display Period Bit 1		0		
D0	Vertical Non-Display Period Bit 0	0					
SED1375 REG[0Bh] MOD rate register	039FFEB (B)	D7-6	n/a	–	0	R/W	
		D5	MOD Rate Bit 5		0	R/W	
		D4	MOD Rate Bit 4		0		
		D3	MOD Rate Bit 3		0		
		D2	MOD Rate Bit 2		0		
		D1	MOD Rate Bit 1		0		
		D0	MOD Rate Bit 0		0		
SED1375 REG[0Ch] Screen 1 start address register (LSB)	039FFEC (B)	D7	Screen 1 Start Address Bit 7			0	R/W
		D6	Screen 1 Start Address Bit 6	0			
		D5	Screen 1 Start Address Bit 5	0			
		D4	Screen 1 Start Address Bit 4	0			
		D3	Screen 1 Start Address Bit 3	0			
		D2	Screen 1 Start Address Bit 2	0			
		D1	Screen 1 Start Address Bit 1	0			
D0	Screen 1 Start Address Bit 0	0					
SED1375 REG[0Dh] Screen 1 start address register (MSB)	039FFED (B)	D7	Screen 1 Start Address Bit 15		0	R/W	
		D6	Screen 1 Start Address Bit 14		0		
		D5	Screen 1 Start Address Bit 13		0		
		D4	Screen 1 Start Address Bit 12		0		
		D3	Screen 1 Start Address Bit 11		0		
		D2	Screen 1 Start Address Bit 10		0		
		D1	Screen 1 Start Address Bit 9		0		
D0	Screen 1 Start Address Bit 8	0					
SED1375 REG[0Eh] Screen 2 start address register (LSB)	039FFEE (B)	D7	Screen 2 Start Address Bit 7		0	R/W	
		D6	Screen 2 Start Address Bit 6		0		
		D5	Screen 2 Start Address Bit 5		0		
		D4	Screen 2 Start Address Bit 4		0		
		D3	Screen 2 Start Address Bit 3		0		
		D2	Screen 2 Start Address Bit 2		0		
		D1	Screen 2 Start Address Bit 1		0		
D0	Screen 2 Start Address Bit 0	0					
SED1375 REG[0Fh] Screen 2 start address register (MSB)	039FFEF (B)	D7	Screen 2 Start Address Bit 15		0	R/W	
		D6	Screen 2 Start Address Bit 14		0		
		D5	Screen 2 Start Address Bit 13		0		
		D4	Screen 2 Start Address Bit 12		0		
		D3	Screen 2 Start Address Bit 11		0		
		D2	Screen 2 Start Address Bit 10		0		
		D1	Screen 2 Start Address Bit 9		0		
D0	Screen 2 Start Address Bit 8	0					
SED1375 REG[10h] Screen 1 start address overflow register	039FFF0 (B)	D7-1	n/a	–	0	R/W	
		D0	Screen 1 Start Address Bit 16 (for Portrait mode only)		0	R/W	
SED1375 REG[11h] Memory address offset register	039FFF1 (B)	D7	Memory Address Offset Bit 7		0	R/W	
		D6	Memory Address Offset Bit 6		0		
		D5	Memory Address Offset Bit 5		0		
		D4	Memory Address Offset Bit 4		0		
		D3	Memory Address Offset Bit 3		0		
		D2	Memory Address Offset Bit 2		0		
		D1	Memory Address Offset Bit 1		0		
D0	Memory Address Offset Bit 0	0					

Register name	Address	Bit	Name	Setting	Init.	R/W	Remarks		
SED1375 REG[12h] Screen 1 vertical size register (LSB)	039FFF2 (B)	D7	Screen 1 Vertical Size Bit 7		0	R/W			
		D6	Screen 1 Vertical Size Bit 6		0				
		D5	Screen 1 Vertical Size Bit 5		0				
		D4	Screen 1 Vertical Size Bit 4		0				
		D3	Screen 1 Vertical Size Bit 3		0				
		D2	Screen 1 Vertical Size Bit 2		0				
		D1	Screen 1 Vertical Size Bit 1		0				
		D0	Screen 1 Vertical Size Bit 0		0				
SED1375 REG[13h] Screen 1 vertical size register (MSB)	039FFF3 (B)	D7–2	n/a		0	R/W			
		D1	Screen 1 Vertical Size Bit 9		0	R/W			
		D0	Screen 1 Vertical Size Bit 8		0				
SED1375 REG[15h] Look-up table address register	039FFF5 (B)	D7	LUT Address Bit 7		0	R/W			
		D6	LUT Address Bit 6		0				
		D5	LUT Address Bit 5		0				
		D4	LUT Address Bit 4		0				
		D3	LUT Address Bit 3		0				
		D2	LUT Address Bit 2		0				
		D1	LUT Address Bit 1		0				
		D0	LUT Address Bit 0		0				
SED1375 REG[17h] Look-up table data register	039FFF7 (B)	D7	LUT Data Bit 3		0	R/W			
		D6	LUT Data Bit 2		0				
		D5	LUT Data Bit 1		0				
		D4	LUT Data Bit 0		0				
		D3–0	n/a		–	0	R/W		
SED1375 REG[18h] GPIO configuration control register	039FFF8 (B)	D7–5	n/a		–	0	R/W		
		D4	GPIO4 Pin IO Configuration	1	Output	0	Input	0	R/W
		D3	GPIO3 Pin IO Configuration	1	Output	0	Input	0	R/W
		D2	GPIO2 Pin IO Configuration	1	Output	0	Input	0	R/W
		D1	GPIO1 Pin IO Configuration	1	Output	0	Input	0	R/W
		D0	GPIO0 Pin IO Configuration	1	Output	0	Input	0	R/W
SED1375 REG[19h] GPIO status/control register	039FFF9 (B)	D7–5	n/a		–	0	R/W		
		D4	GPIO4 Pin IO Status	1	1	0	0	0	R/W
		D3	GPIO3 Pin IO Status	1	1	0	0	0	R/W
		D2	GPIO2 Pin IO Status	1	1	0	0	0	R/W
		D1	GPIO1 Pin IO Status	1	1	0	0	0	R/W
		D0	GPIO0 Pin IO Status	1	1	0	0	0	R/W
SED1375 REG[1Ah] Scratch pad register	039FFFA (B)	D7	Scratch Bit 7	1	1	0	0	0	R/W
		D6	Scratch Bit 6			0	0	0	R/W
		D5	Scratch Bit 5			0	0	0	R/W
		D4	Scratch Bit 4			0	0	0	R/W
		D3	Scratch Bit 3			0	0	0	R/W
		D2	Scratch Bit 2			0	0	0	R/W
		D1	Scratch Bit 1			0	0	0	R/W
		D0	Scratch Bit 0			0	0	0	R/W
SED1375 REG[1Bh] Portrait mode register	039FFFB (B)	D7	Portrait Mode Enable	1	Portrait	0	Landscape	0	R/W
		D6	Portrait Mode Select	1	Alternate	0	Default	0	R/W
		D5–3	n/a			–	0	R/W	
		D2	reserved			Fix at 0	0	R/W	
		D1	Portrait Mode Pixel Clock Select Bit 1			See SED1375 Hardware	0	R/W	
D0	Portrait Mode Pixel Clock Select Bit 0			Functional Specification	0	R/W			
SED1375 REG[1Ch] Line byte count register for portrait mode	039FFFC (B)	D7	Line Byte Count Bit 7		0	R/W			
		D6	Line Byte Count Bit 6		0				
		D5	Line Byte Count Bit 5		0				
		D4	Line Byte Count Bit 4		0				
		D3	Line Byte Count Bit 3		0				
		D2	Line Byte Count Bit 2		0				
		D1	Line Byte Count Bit 1		0				
		D0	Line Byte Count Bit 0		0				

4.3 SED1375 LCD Controller Block

The E0C332L01 contains the SED1375 LCD controller block.

This section describes the contents differ from the original SED1375 chip, and notes on usage.

For the SED1375 registers and control method, refer to "SED1375 Hardware Functional Specification".

Address mapping

The SED1375 block is allocated to Area 6.

SED1375 registers: 0x39FFE0 to 0x39FFFF

VRAM (40KB): 0x380000 to 0x389FFF

The base address of the registers and display buffer described in "SED1375 Hardware Functional Specification" is 0x380000.

SED1375 host interface

The SED1375 block in the E0C332L01 has no host bus interface pins and the CNF[2:0] pins that are used to select an interface type, since the interface configuration is fixed in the IC.

Clock input

The SED1375 chip can use only one source clock input to CLKI pin, while the E0C332L01 allows selection of the clock source including the internal clock. Use the CKSEL[2:0] pins for this selection.

Table 4.3.1 Selecting Clock

CKSEL2	CKSEL1	CKSEL0	Source clock for SED1375
0	0	0	PLL output clock
0	0	1	OSC3 oscillation clock
0	1	0	OSC3 oscillation clock $\times 1/2$
0	1	1	OSC3 oscillation clock $\times 1/3$
1	0	0	OSC3 oscillation clock $\times 1/4$
1	0	1	External clock input to the CLKI pin
1	1	0	SED1375 disable mode
1	1	1	reserved

When an internal clock (OSC3 oscillation clock or PLL output clock) is selected as the SED1375 source clock or when SED1375 disable mode is selected, the CLKI pin must be fixed at high or low level.

Setting bus condition

The SED1375 registers and VRAM are accessed via the BCU in the C33 core block. The SED1375 block is interfaced with the BCU by the bus cycle control using the #WAIT signal (output from the SED1375 block). Therefore, set up the BCU registers as follows:

- 1) Areas 6–4 set-up register (0x4812A)
 - Area 6 output disable delay time = 0.5 cycles (A6DF[1:0]/D[D:C] = 0b00)
 - Area 6 wait control = 1 wait cycle (A6WT[2:0]/D[A:8] = 0b001)
- 2) Bus control register (0x4812E)
 - External interface method selection = A0 (SBUSST/D3 = 0)
 - Enable #WAIT signal input. (SWAITE/D0 = 1)
- 3) Access control register (0x48132)
 - Area 6 internal access (A6IO/D9 = 1)
- 4) BCLK select register (0x4813A)
 - Select BCU_CLK or a 33 MHz or less (if PLL_CLK, OSC3_CLK or CPU_CLK is selected). (BCLKSEL[1:0]/D[1:0])

SED1375 disable mode

When the SED1375 is disabled by setting the CKSEL[2:0] pins to "110", the VRAM is disconnected from the SED1375 but remains connected to the E0C332L01 bus. This allows use of the VRAM as a general-purpose RAM.

The SED1375 enters Power Save Mode by this setting.

When using the VRAM as a general-purpose RAM, set the number of wait cycles for accessing as follows:

- 1) When the core voltage is $3.3\text{ V} \pm 0.3\text{ V}$ and the bus clock frequency is lower than 20 MHz: No wait
- 2) When the core voltage is $3.3\text{ V} \pm 0.3\text{ V}$ and the bus clock frequency is 20 MHz or higher: 1 wait
- 3) When the core voltage is $3.0\text{ V} \pm 0.3\text{ V}$: 1 wait (bus clock frequency: 33 MHz max.)
- 4) When the core voltage is $2.0\text{ V} \pm 0.2\text{ V}$: 1 wait (bus clock frequency: 20 MHz max.)

The number of wait cycles can be set using the "Area 6 wait control" bit (A6WT[2:0]/D[A:8]) in Areas 6–4 setup register (0x4812A).

Note when using the OSC3 clock

When an internal clock (PLL output or OSC3 clock) is selected as the SED1375 operating clock, be sure to perform the following procedure before stopping the OSC3 oscillation.

- 1) Set the SED1375 block in the Software Power Save Mode.
- 2) Wait for 128 frame cycles or more before stopping the OSC3 oscillation.

Even if the external clock (CLKI pin) is selected as the SED1375 operating clock, the same procedure is necessary before stopping the external clock.

5 Power-Down Control

This chapter describes the controls used to reduce power consumption of the device.

Points on power saving

The current consumption of the device varies greatly with the CPU's operation mode, the system clocks used, and the peripheral circuits operated.

Current consumption	low←-----→high					
CPU/BCU	SLEEP	HALT2	Operating	HALT2	HALT(basic)	Operating
System clock	—	OSC1	OSC1	OSC3	OSC3	OSC3
OSC3 oscillation circuit	OFF	OFF	OFF	ON	ON	ON
Prescaler/peripheral circuit	STOP					RUN
LCD controller	Power save mode					Normal operation mode

To reduce power consumption of the device, it is important that as many unnecessary circuits as possible be turned off. In particular, peripheral circuits operating at a fast-clock rate consume a large amount of current, so design the program so that these circuits are turned off whenever unnecessary.

Power-saving in standby modes

When CPU processing is unnecessary, such as when waiting for an interrupt from key entries or peripheral circuits, place the device in standby mode to reduce current consumption.

Standby mode	Method to enter the mode	Circuits/functions stopped
Basic HALT mode	Execute the halt instruction after setting HLT2OP (D3)/Clock option register (0x40190) to "0". When the #BUSREQ signal is asserted from an external bus master while SEPD (D1)/Bus control register (0x4812E) = "1".	CPU only
HALT2 mode	Execute the halt instruction after setting HLT2OP to "1".	CPU, BCU, bus clock, and DMA
SLEEP mode	Execute the slp instruction.	CPU, BCU, bus clock, DMA, high-speed (OSC3) oscillation circuit, prescaler, and peripheral circuits that use the prescaler output clocks

HLT2OP (D3)/Clock option register (0x40190) that is used to select a HALT mode is set to "0" (basic HALT mode) at initial reset.

- Notes:**
- In systems in which DRAM is connected directly to the device, the refresh function is turned off during HALT2 and SLEEP modes.
 - The standby mode is cleared by interrupt generation (except for the basic HALT mode, which is set using an external bus master). Therefore, before entering standby mode, set the related registers to allow an interrupt to be used to clear the standby mode to be generated.

The low-speed (OSC1) oscillation circuit and clock timer continue operating even during SLEEP mode. If they are unnecessary, these circuits can also be turned off.

Function	Control bit	"1"	"0"	Default
Low-speed (OSC1) oscillation ON/OFF control	SOSC1(D0)/ Power control register(0x40180)	ON	OFF	ON

Switching over the system clocks

Normally, the system is clocked by the high-speed (OSC3) oscillation clock. If high-speed operation is unnecessary, switch the system clock to the low-speed (OSC1) oscillation clock and turn off the high-speed (OSC3) oscillation circuit. This helps to reduce current consumption. However, if DRAM is connected directly to the device, note that the refresh function is also turned off.

Even during operation using the high-speed (OSC3) oscillation clock, power reduction can also be achieved through the use of a system clock derived from the OSC3 clock by dividing it (1/1, 1/2, 1/4, or 1/8).

Function	Control bit	"1"	"0"	Default
System clock switch over	CLKCHG(D2)/ Power control register(0x40180)	OSC3	OSC1	OSC3
High-speed (OSC3) oscillation ON/OFF control	SOSC3(D1)/ Power control register(0x40180)	ON	OFF	ON
System clock division ratio selection	CLKDT(D[7:6])/ Power control register(0x40180)	"11" = 1/8 "10" = 1/4 "01" = 1/2 "00" = 1/1		1/1

Turning off the prescaler and peripheral circuits

Current consumption can be reduced by turning off the peripheral circuits operating at high speed as much as possible. The circuits listed below are operated using a clock generated by the prescaler:

- 16-bit programmable timers 0 to 5 (watchdog timer)
- 8-bit programmable timers 0 to 3 (DRAM refresh, serial interface)
- A/D converter

If none of these circuits need to be used, turn off the prescaler. If some of these circuits need to be used, turn off all other unnecessary circuits and stop clock supply from the prescaler to those circuits.

Function	Control bit	"1"	"0"	Default
Prescaler ON/OFF	PSCON(D5)/Power control register(0x40180)	ON	OFF	ON
16-bit timer 0 clock control	P16TON0(D3)/16-bit timer 0 clock control register(0x40147)	ON	OFF	OFF
16-bit timer 0 Run/Stop	PRUN0(D0)/16-bit timer 0 control register(0x48186)	RUN	STOP	STOP
16-bit timer 1 clock control	P16TON1(D3)/16-bit timer 1 clock control register(0x40148)	ON	OFF	OFF
16-bit timer 1 Run/Stop	PRUN1(D0)/16-bit timer 1 control register(0x4818E)	RUN	STOP	STOP
16-bit timer 2 clock control	P16TON2(D3)/16-bit timer 2 clock control register(0x40149)	ON	OFF	OFF
16-bit timer 2 Run/Stop	PRUN2(D0)/16-bit timer 2 control register(0x48196)	RUN	STOP	STOP
16-bit timer 3 clock control	P16TON3(D3)/16-bit timer 3 clock control register(0x4014A)	ON	OFF	OFF
16-bit timer 3 Run/Stop	PRUN3(D0)/16-bit timer 3 control register(0x4819E)	RUN	STOP	STOP
16-bit timer 4 clock control	P16TON4(D3)/16-bit timer 4 clock control register(0x4014B)	ON	OFF	OFF
16-bit timer 4 Run/Stop	PRUN4(D0)/16-bit timer 4 control register(0x481A6)	RUN	STOP	STOP
16-bit timer 5 clock control	P16TON5(D3)/16-bit timer 5 clock control register(0x4014C)	ON	OFF	OFF
16-bit timer 5 Run/Stop	PRUN5(D0)/16-bit timer 5 control register(0x481AE)	RUN	STOP	STOP
8-bit timer 0 clock control	P8TON0(D3)/8-bit timer 0/1 clock control register(0x4014D)	ON	OFF	OFF
8-bit timer 0 Run/Stop	Ptrun0(D0)/8-bit timer 0 control register(0x40160)	RUN	STOP	STOP
8-bit timer 1 clock control	P8TON1(D7)/8-bit timer 0/1 clock control register(0x4014D)	ON	OFF	OFF
8-bit timer 1 Run/Stop	Ptrun1(D0)/8-bit timer 1 control register(0x40164)	RUN	STOP	STOP
8-bit timer 2 clock control	P8TON2(D3)/8-bit timer 2/3 clock control register(0x4014E)	ON	OFF	OFF
8-bit timer 2 Run/Stop	Ptrun2(D0)/8-bit timer 2 control register(0x40168)	RUN	STOP	STOP
8-bit timer 3 clock control	P8TON3(D7)/8-bit timer 2/3 clock control register(0x4014E)	ON	OFF	OFF
8-bit timer 3 Run/Stop	Ptrun3(D0)/8-bit timer 3 control register(0x4016C)	RUN	STOP	STOP
A/D converter clock control	PSONAD(D3)/A/D clock control register(0x4014F)	ON	OFF	OFF
A/D conversion enable	ADE(D2)/A/D enable register(0x40244)	RUN	STOP	STOP

The same clock source must be used for the prescaler operating clock and the CPU operating clock. Therefore, when operating the CPU in low-speed with the OSC1 clock, the prescaler input clock must be switched according to the CPU operating clock. In this case, in order to prevent a malfunction in the peripheral circuit, the prescaler should be turned off before switching the CPU operating clock. After the CPU operating clock has been switched, switch the prescaler operating clock and then turn the prescaler on.

Function	Control bit	"1"	"0"	Default
Prescaler operating clock switch over	PSCDT0 (D0)/Prescaler clock select register(0x40181)	OSC1	OSC3/ PLL	OSC3/ PLL

Power-down control of the LCD controller

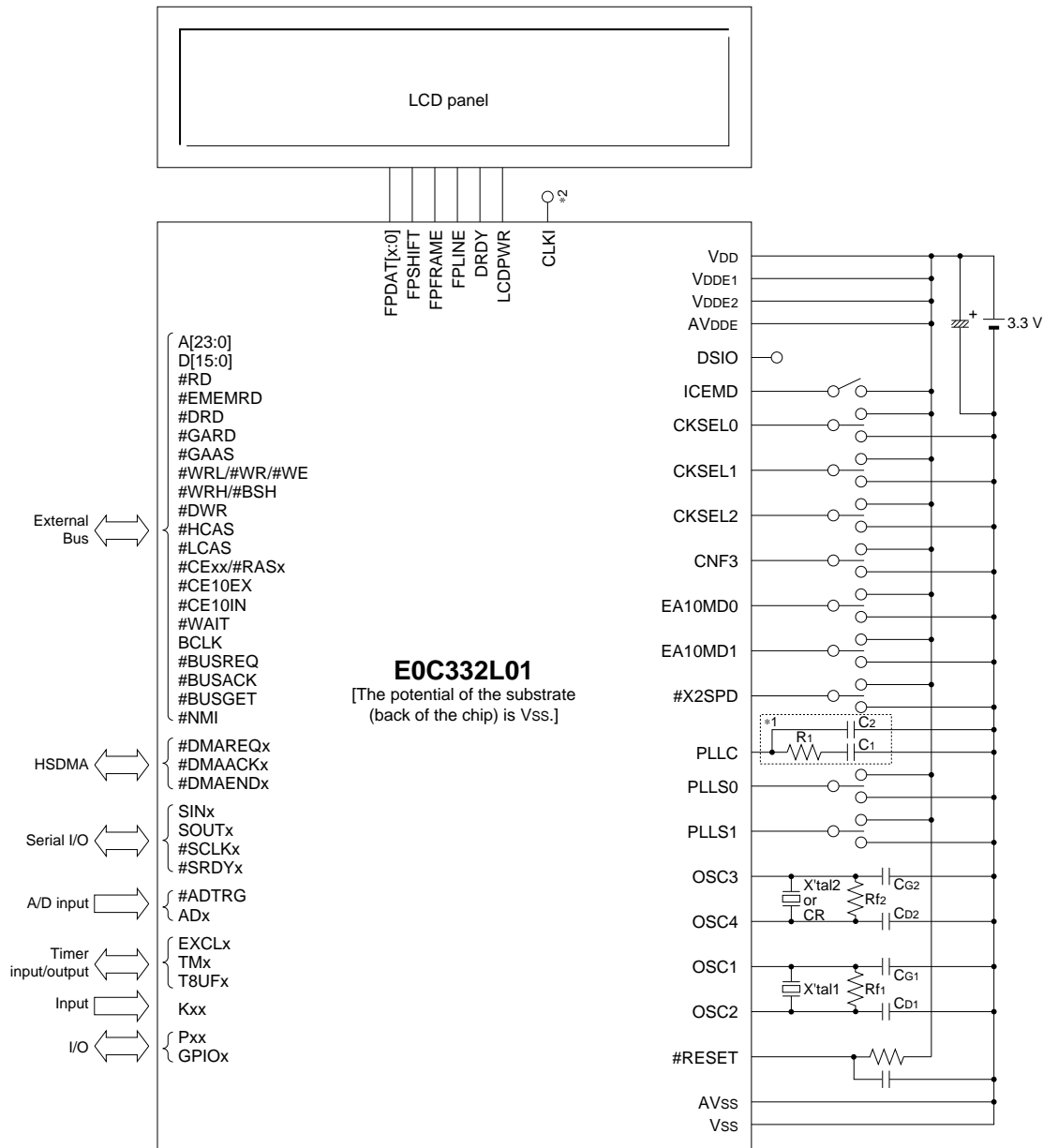
The SED1375 provides the power save mode on its own. Since the software power save mode can be controlled by software, set the mode when turning the LCD display off.

Function	Control bit	"11"	"00"	Default
Software power save mode	REG[03h](0x39FFE3)•D[1:0]	Normal operation	Software power save mode	Software power save mode

Note: The software power save mode switches the LCD panel power control signal (LCDPWR) to the inactive state. This may cause damage of the LCD panel if the clock supply to the SED1375 is stopped at the same time.

Therefore, do not stop the clock supply for 128 frame cycles or more after setting the SED1375 to software power save mode.

6 Basic External Wiring Diagram



X'tal1	Crystal oscillator	32.768 kHz
CG1	Gate capacitor	10 pF
CD1	Drain capacitor	10 pF
Rf1	Feedback resistor	10 MΩ
X'tal2	Crystal oscillator	33 MHz (Max.)
CR	Ceramic oscillator	33 MHz (Max.)
CG2	Gate capacitor	10 pF
CD2	Drain capacitor	10 pF
Rf2	Feedback resistor	1 MΩ
R1	Resistor	4.7 kΩ
C1	Capacitor	100 pF
C2	Capacitor	5 pF

*1: When the PLL is not used, leave the PLLC pin open.
 *2: When a source clock other than CLKI pin input is selected for the SED1375, the CLKI pin must be fixed at high or low level.

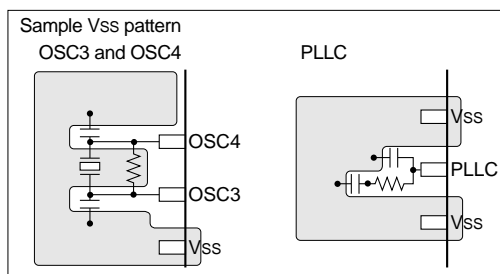
Note: The above table is simply an example, and is not guaranteed to work.

7 Precautions on Mounting

The following shows the precautions when designing the board and mounting the IC.

Oscillation Circuit

- Oscillation characteristics change depending on conditions (board pattern, components used, etc.). In particular, when a ceramic oscillator or crystal oscillator is used, use the oscillator manufacturer's recommended values for constants such as capacitance and resistance.
- Disturbances of the oscillation clock due to noise may cause a malfunction. Consider the following points to prevent this:
 - Components which are connected to the OSC3 (OSC1), OSC4 (OSC2) and PLLC pins, such as oscillators, resistors and capacitors, should be connected in the shortest line.
 - As shown in the figure below, make a VSS pattern as large as possible at circumscription of the OSC3 (OSC1) and OSC4 (OSC2) pins and the components connected to these pins. The same applies to the PLLC pin.
Furthermore, do not use this VSS pattern to connect other components than the oscillation system.



- When supplying an external clock to the OSC3 (OSC1) pin, the clock source should be connected to the OSC3 (OSC1) pin in the shortest line.
Furthermore, do not connect anything else to the OSC4 (OSC2) pin.
- In order to prevent unstable operation of the oscillation circuit due to current leak between OSC3 (OSC1) and VDD, please keep enough distance between OSC3 (OSC1) and VDD or other signals on the board pattern.

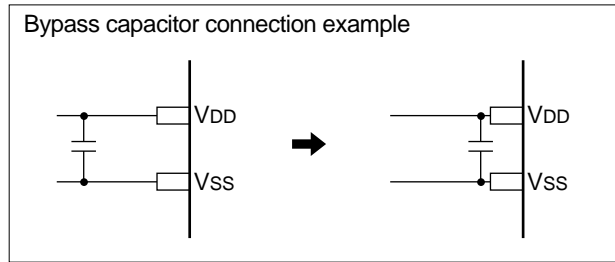
Reset Circuit

- The power-on reset signal which is input to the #RESET pin changes depending on conditions (power rise time, components used, board pattern, etc.). Decide the time constant of the capacitor and resistor after enough tests have been completed with the application product.
- In order to prevent any occurrences of unnecessary resetting caused by noise during operating, components such as capacitors and resistors should be connected to the #RESET pin in the shortest line.

Power Supply Circuit

- Sudden power supply variation due to noise may cause malfunction. Consider the following points to prevent this:
 - The power supply should be connected to the VDD, VDDE1, VDDE2, VSS and AVDDE pins with patterns as short and large as possible.
In particular, the power supply for AVDDE affects A/D conversion precision.

- (2) When connecting between the VDD and VSS pins with a bypass capacitor, the pins should be connected as short as possible.

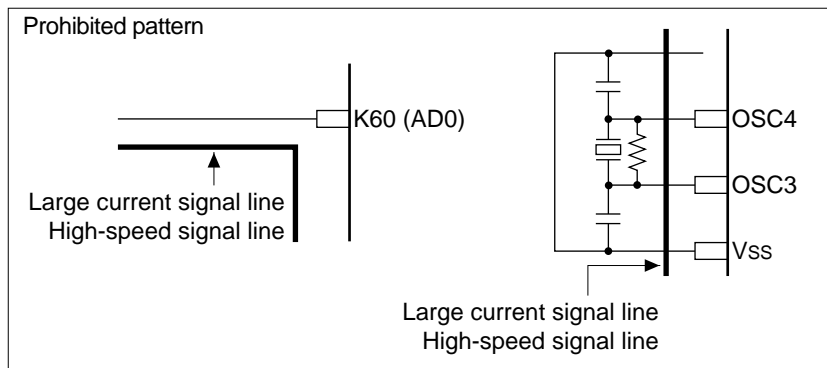


A/D Converter

- When the A/D converter is not used, the power supply pin AVDDE for the analog system should be connected to VDDE1.

Arrangement of Signal Lines

- In order to prevent generation of electromagnetic induction noise caused by mutual inductance, do not arrange a large current signal line near the circuits that are sensitive to noise such as the oscillation unit and analog input unit.
- When a signal line is parallel with a high-speed line in long distance or intersects a high-speed line, noise may be generated by mutual interference between the signals and it may cause a malfunction. Do not arrange a high-speed signal line especially near circuits that are sensitive to noise such as the oscillation unit and analog input unit.



8 Electrical Characteristics

8.1 Absolute Maximum Rating

(V _{SS} =0V)					
Item	Symbol	Condition	Rated value	Unit	*
Supply voltage	V _{DD}		-0.3 to +4.0	V	
I/O power voltage	V _{DDE1}		-0.3 to +7.0	V	
LCD interface power voltage	V _{DDE2}		-0.3 to +7.0	V	
Input voltage	V _I		-0.3 to V _{DDE} +0.5	V	
High-level output current	I _{OH}	1 pin	-10	mA	
		Total of all pins	-40	mA	
Low-level output current	I _{OL}	1 pin	10	mA	
		Total of all pins	40	mA	
Analog power voltage	AV _{DDE}		-0.3 to +7.0	V	
Analog input voltage	AV _{IN}		-0.3 to AV _{DDE} +0.3	V	
Storage temperature	T _{STG}		-65 to +150	°C	

8.2 Recommended Operating Conditions

1) 3.3 V/5.0 V dual power source

(V_{SS}=0V)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Supply voltage (high voltage)	V _{DDE1}		4.50	5.00	5.50	V	1
	V _{DDE2}		4.50	5.00	5.50	V	1
Supply voltage (low voltage)	V _{DD}		2.70	–	3.60	V	
Input voltage	H _{VI}		V _{SS}	–	V _{DDE}	V	
	L _{VI}		V _{SS}	–	V _{DD}	V	
CPU operating clock frequency	f _{CPU}		–	–	50	MHz	
Low-speed oscillation frequency	f _{OSC1}		–	32.768	–	kHz	
LCD controller operating clock frequency	f _{LCDC}		–	–	25	MHz	
Operating temperature	T _a		-40	25	85	°C	
Input rise time (normal input)	t _{ri}		–	–	50	ns	
Input fall time (normal input)	t _{fi}		–	–	50	ns	
Input rise time (schmitt input)	t _{ri}		–	–	5	ms	
Input fall time (schmitt input)	t _{fi}		–	–	5	ms	

* note 1) A low-voltage power source (3.3 V) can also be used for either V_{DDE1} or V_{DDE2}.

2) 3.3 V single power source

(V_{DDE1}=V_{DDE2}=V_{DD}, V_{SS}=0V)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Supply voltage	V _{DD}		2.70	–	3.60	V	
Input voltage	V _I		V _{SS}	–	V _{DD}	V	
CPU operating clock frequency	f _{CPU}		–	–	50	MHz	
Low-speed oscillation frequency	f _{OSC1}		–	32.768	–	kHz	
LCD controller operating clock frequency	f _{LCDC}		–	–	25	MHz	
Operating temperature	T _a		-40	25	85	°C	
Input rise time (normal input)	t _{ri}		–	–	50	ns	
Input fall time (normal input)	t _{fi}		–	–	50	ns	
Input rise time (schmitt input)	t _{ri}		–	–	5	ms	
Input fall time (schmitt input)	t _{fi}		–	–	5	ms	

3) 2.0 V single power source

(V_{DDE1}=V_{DDE2}=V_{DD}, V_{SS}=0V)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Supply voltage	V _{DD}		1.80	2.00	2.20	V	
Input voltage	V _I		V _{SS}	–	V _{DD}	V	
CPU operating clock frequency	f _{CPU}		–	–	20	MHz	
Low-speed oscillation frequency	f _{OSC1}		–	32.768	–	kHz	
LCD controller operating clock frequency	f _{LCDC}		–	–	10	MHz	
Operating temperature	T _a		-40	25	85	°C	
Input rise time (normal input)	t _{ri}		–	–	100	ns	
Input fall time (normal input)	t _{fi}		–	–	100	ns	
Input rise time (schmitt input)	t _{ri}		–	–	10	ms	
Input fall time (schmitt input)	t _{fi}		–	–	10	ms	

8.3 DC Characteristics

1) 3.3 V/5.0 V dual power source

(Unless otherwise specified: $V_{DDE}=5V\pm 0.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^\circ C$ to $+85^\circ C$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Input leakage current	I _{LI}		-1	-	1	μA	
Off-state leakage current	I _{oZ}		-1	-	1	μA	
High-level output voltage	V _{OH}	I _{oH} =-3mA (Type1), I _{oH} =-12mA (Type3), V _{DDE} =Min.	V _{DDE} -0.4	-	-	V	
Low-level output voltage	V _{OL}	I _{oL} =3mA (Type1), I _{oL} =12mA (Type3), V _{DDE} =Min.	-	-	0.4	V	
High-level input voltage	V _{IH}	CMOS level, V _{DDE} =Max.	3.5	-	-	V	
Low-level input voltage	V _{IL}	CMOS level, V _{DDE} =Min.	-	-	1.0	V	
Positive trigger input voltage	V _{T+}	CMOS schmitt	2.0	-	4.0	V	
Negative trigger input voltage	V _{T-}	CMOS schmitt	0.8	-	3.1	V	
Hysteresis voltage	V _H	CMOS schmitt	0.3	-	-	V	
Pull-up resistor	R _{PU}	V _I =0V	60	120	288	kΩ	
Pull-down resistor	R _{PD}	V _I =V _{DDE} (#ICEMD)	30	60	144	kΩ	
Input pin capacitance	C _I	f=1MHz, V _{DDE} =0V	-	-	10	pF	
Output pin capacitance	C _O	f=1MHz, V _{DDE} =0V	-	-	10	pF	
I/O pin capacitance	C _{IO}	f=1MHz, V _{DDE} =0V	-	-	10	pF	

2) 3.3 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^\circ C$ to $+85^\circ C$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Input leakage current	I _{LI}		-1	-	1	μA	
Off-state leakage current	I _{oZ}		-1	-	1	μA	
High-level output voltage	V _{OH}	I _{oH} =-2mA (Type1), I _{oH} =-6mA (Type2), I _{oH} =-12mA (Type3), V _{DD} =Min.	V _{DD} -0.4	-	-	V	
Low-level output voltage	V _{OL}	I _{oL} =2mA (Type1), I _{oL} =6mA (Type2), I _{oL} =12mA (Type3), V _{DD} =Min.	-	-	0.4	V	
High-level input voltage	V _{IH}	CMOS level, V _{DD} =Max.	2.4	-	-	V	
Low-level input voltage	V _{IL}	CMOS level, V _{DD} =Min.	-	-	0.4	V	
Positive trigger input voltage	V _{T+}	LVTTL schmitt	1.1	-	2.4	V	
Negative trigger input voltage	V _{T-}	LVTTL schmitt	0.6	-	1.8	V	
Hysteresis voltage	V _H	LVTTL schmitt	0.1	-	-	V	
Pull-up resistor	R _{PU}	V _I =0V	80	200	480	kΩ	
		Other than DSIO	40	100	240	kΩ	
Pull-down resistor	R _{PD}	V _I =V _{DD} (#ICEMD)	40	100	240	kΩ	
Input pin capacitance	C _I	f=1MHz, V _{DD} =0V	-	-	10	pF	
Output pin capacitance	C _O	f=1MHz, V _{DD} =0V	-	-	10	pF	
I/O pin capacitance	C _{IO}	f=1MHz, V _{DD} =0V	-	-	10	pF	

Note: See Appendix B for pin characteristics.

3) 2.0 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*	
Input leakage current	I _{LI}		-1	-	1	μA		
Off-state leakage current	I _{OZ}		-1	-	1	μA		
High-level output voltage	V _{OH}	I _{OH} =-0.6mA (Type1), I _{OH} =-2mA (Type2), I _{OH} =-4mA (Type3), V _{DD} =Min.	V _{DD} -0.2	-	-	V		
Low-level output voltage	V _{OL}	I _{OL} =0.6mA (Type1), I _{OL} =2mA (Type2), I _{OL} =4mA (Type3), V _{DD} =Min.	-	-	0.2	V		
High-level input voltage	V _{IH}	CMOS level, V _{DD} =Max.	1.6	-	-	V		
Low-level input voltage	V _{IL}	CMOS level, V _{DD} =Min.	-	-	0.3	V		
Positive trigger input voltage	V _{T+}	CMOS schmitt	0.4	-	1.6	V		
Negative trigger input voltage	V _{T-}	CMOS schmitt	0.3	-	1.4	V		
Hysteresis voltage	V _H	CMOS schmitt	0	-	-	V		
Pull-up resistor	R _{PU}	V _I =0V	Other than DSIO	120	480	1200	kΩ	
			DSIO	60	240	600	kΩ	
Pull-down resistor	R _{PD}	V _I =V _{DD} (#ICEMD)	60	240	600	kΩ		
Input pin capacitance	C _I	f=1MHz, V _{DD} =0V	-	-	10	pF		
Output pin capacitance	C _O	f=1MHz, V _{DD} =0V	-	-	10	pF		
I/O pin capacitance	C _{IO}	f=1MHz, V _{DD} =0V	-	-	10	pF		

Note: See Appendix B for pin characteristics.

8.4 Current Consumption

1) 3.3 V power source

(Unless otherwise specified: $V_{DDE}=2.7V$ to $5.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*	
Operating current	IDD1	When CPU is operating	20MHz	–	25	35	mA	1
			33MHz	–	45	60		
			50MHz	–	60	75		
	IDD2	HALT mode	20MHz	–	13	16	mA	2
			33MHz	–	23	30		
			50MHz	–	30	45		
	IDD3	HALT2 mode	20MHz	–	3	5	mA	3
			33MHz	–	5	7		
			50MHz	–	7	9		
IDD4	SLEEP mode		–	1	30	μA	4	
Clock timer operating current	IDDC	When clock timer only is operating OSC1 oscillation: 32kHz	–	7	–	μA	5	

2) 2.0 V power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Operating current	IDD1	When CPU is operating, 20MHz	–	12	17	mA	1
	IDD2	HALT mode, 20MHz	–	7	10	mA	2
	IDD3	HALT2 mode, 20MHz	–	1.5	2.0	mA	3
	IDD4	SLEEP mode	–	1	30	μA	4
Clock timer operating current	IDDC	When clock timer only is operating OSC1 oscillation: 32kHz	–	1.5	–	μA	5

3) Analog power current

(Unless otherwise specified: $V_{DD}=2.0V\pm 0.2V$, $V_{DDE}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
A/D converter operating current	AIDD1	$V_{DD}=3.6V$, $V_{DDE}=AV_{DD}=5.0V\pm 0.5V$	–	800	1400	μA	6
		$V_{DD}=V_{DDE}=AV_{DD}=2.7V$ to $3.6V$	–	500	800		

4) LCD controller operating current

(Unless otherwise specified: $V_{DDE}=2.7V$ to $5.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
LCD controller operating current	LIDD1	Display resolution = 640×480 , 1bpp CLK = 25MHz	–	8.5	14	mA	7
	LIDD2	Display resolution = 320×240 , 1bpp CLK = 6.8MHz	–	2.2	3.5	mA	7
	LIDD3	Display resolution = 320×240 , 4bpp CLK = 6.8MHz	–	2.7	4.0	mA	7

Current consumption measurement condition: $V_{IH}=V_{DD}$, $V_{IL}=0V$, output pins are open, V_{DDE1}/V_{DDE2} current is not included

* note)	No.	OSC3	OSC1	CPU	Clock timer	Other peripheral circuits *2
	1	On	Off	Normal operation *1	Stop	Stop
	2	On	Off	HALT mode	Stop	Stop
	3	On	Off	HALT2 mode	Stop	Stop
	4	Off	Off	SLEEP mode	Stop	Stop
	5	Off	On	HALT mode	Run	Stop
	6	On	Off	HALT mode	Stop	A/D converter only operated, conversion clock frequency=2MHz

* note 7) This table shows the operating current values of the LCD controller block only. They may vary according to the display settings and the LCD controller input clock frequency.

*1: The values of current consumption while the CPU is operating were measured when a test program that consists of 55% load instructions, 23% arithmetic operation instructions, 1% mac instruction, 12% branch instructions and 9% ext instruction is being executed in the built-in ROM continuously.

*2: The LCD controller is included.

8.5 A/D Converter Characteristics

1) 3.3 V/5.0 V dual power source

(Unless otherwise specified: $V_{DDE}=AV_{DD}=4.5V$ to $5.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$, $ST[1:0]=11$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Resolution	–		–	10	–	bit	
Conversion time	–		5	–	–	μs	1
Zero scale error	E _{ZS}		0	2	4	LSB	
Full scale error	E _{FS}		-2	–	2	LSB	
Integral linearity error	E _L		-3	–	3	LSB	
Differential linearity error	E _D		-3	–	3	LSB	
Permissible signal source impedance	–		–	–	5	$k\Omega$	
Analog input capacitance	–		–	–	45	pF	

* note 1) Indicates the minimum value when A/D clock = 4MHz (maximum clock frequency in 5V system).

2) 3.3 V single power source

(Unless otherwise specified: $V_{DDE}=AV_{DD}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$, $ST[1:0]=11$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Resolution	–		–	10	–	bit	
Conversion time	–		10	–	–	μs	1
Zero scale error	E _{ZS}		0	2	4	LSB	
Full scale error	E _{FS}		-2	–	2	LSB	
Integral linearity error	E _L		-3	–	3	LSB	
Differential linearity error	E _D		-3	–	3	LSB	
Permissible signal source impedance	–		–	–	5	$k\Omega$	
Analog input capacitance	–		–	–	45	pF	

* note 1) Indicates the minimum value when A/D clock = 2MHz (maximum clock frequency in 3V system).

Note: • Be sure to use as $V_{DDE} = AV_{DD}$.

• The A/D converter cannot be used when the E0C332L01 is used with a 2V power source.

A/D conversion error

$V[000]_h$ = Ideal voltage at zero-scale point (=0.5LSB)

$V'[000]_h$ = Actual voltage at zero-scale point

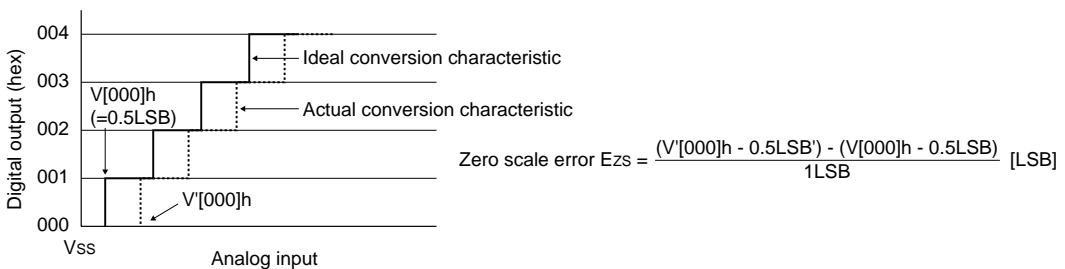
$V[3FF]_h$ = Ideal voltage at full-scale point (=1022.5LSB)

$V'[3FF]_h$ = Actual voltage at full-scale point

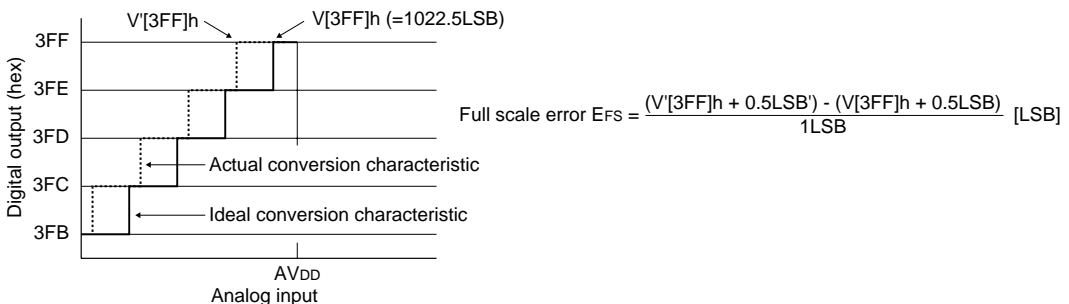
$$1LSB = \frac{AV_{DD} - V_{SS}}{2^{10} - 1}$$

$$1LSB' = \frac{V'[3FF]_h - V'[000]_h}{2^{10} - 2}$$

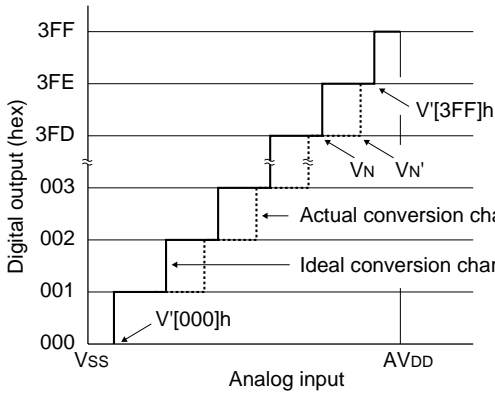
■ Zero scale error



■ Full scale error

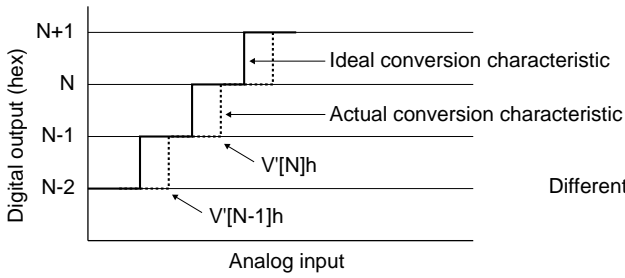


■ Integral linearity error



$$\text{Integral linearity error } E_L = \frac{V_N' - V_N}{1\text{LSB}'} \text{ [LSB]}$$

■ Differential linearity error



$$\text{Differential linearity error } E_D = \frac{V'[N]h - V'[N-1]h}{1\text{LSB}'} - 1 \text{ [LSB]}$$

8.6 AC Characteristics

8.6.1 Symbol Description

tcyc: Bus-clock cycle time

- In x1 mode, tcyc = 50 ns (20 MHz) when the CPU is operated with a 20-MHz clock
tcyc = 30 ns (33 MHz) when the CPU is operated with a 33-MHz clock
- In x2 mode, tcyc = 50 ns (20 MHz) when the CPU is operated with a 40-MHz clock
tcyc = 40 ns (25 MHz) when the CPU is operated with a 50-MHz clock
tcyc = 33 ns (30 MHz) when the CPU is operated with a 60-MHz clock

WC: Number of wait cycles

Up to 7 cycles can be set for the number of cycles using the BCU control register. Furthermore, it can be extended to a desired number of cycles by setting the #WAIT pin from outside of the IC.

The minimum number of read cycles with no wait (0) inserted is 1 cycle.

The minimum number of write cycles with no wait cycle (0) inserted is 2 cycles. It does not change even if 1-wait cycle is set. The write cycle is actually extended when 2 or more wait cycles are set.

When inserting wait cycles by controlling the #WAIT pin from outside of the IC, pay attention to the timing of the #WAIT signal sampling. Read cycles are terminated at the cycle in which the #WAIT signal is negated. Write cycles are terminated at the following cycle after the #WAIT signal is negated.

C1, C2, C3, Cn: Cycle number

C1 indicates the first cycle when the BCU transfers data from/to an external memory or another device. Similarly, C2 and Cn indicate the second cycle and nth cycle, respectively.

Cw: Wait cycle

Indicates that the cycle is wait cycle inserted.

8.6.2 AC Characteristics Measurement Condition

Signal detection level: Input signal High level $V_{IH} = V_{DDE} - 0.4 V$
Low level $V_{IL} = 0.4 V$

Output signal High level $V_{OH} = 1/2 V_{DDE}$
Low level $V_{OL} = 1/2 V_{DDE}$

The following applies when OSC3 is external clock input:

Input signal High level $V_{IH} = 1/2 V_{DD}$
Low level $V_{IL} = 1/2 V_{DD}$

Input signal waveform: Rise time (10% \rightarrow 90% V_{DD}) 5 ns
Fall time (90% \rightarrow 10% V_{DD}) 5 ns

Output load capacitance: $C_L = 50 pF$

8.6.3 C33 Block AC Characteristic Tables

External clock input characteristics

(Note) These AC characteristics apply to input signals from outside the IC.

The OSC3 input clock must be within VDD to VSS voltage range.

1) 3.3 V/5.0 V dual power source

(Unless otherwise specified: VDDE=5.0V±0.5V, VDD=2.7V to 3.6V, VSS=0V, Ta=-40°C to +85°C)

Item	Symbol	Min.	Max.	Unit	*
High-speed clock cycle time	tC3	30		ns	
OSC3 clock input duty	tC3ED	45	55	%	
OSC3 clock input rise time	tIF		5	ns	
OSC3 clock input fall time	tIR		5	ns	
BCLK high-level output delay time	tCD1		35	ns	
BCLK low-level output delay time	tCD2		35	ns	
Minimum reset pulse width	tRST	6·tCYC		ns	

2) 3.3 V single power source

(Unless otherwise specified: VDDE=VDD=2.7V to 3.6V, VSS=0V, Ta=-40°C to +85°C)

Item	Symbol	Min.	Max.	Unit	*
High-speed clock cycle time	tC3	30		ns	
OSC3 clock input duty	tC3ED	45	55	%	
OSC3 clock input rise time	tIF		5	ns	
OSC3 clock input fall time	tIR		5	ns	
BCLK high-level output delay time	tCD1		35	ns	
BCLK low-level output delay time	tCD2		35	ns	
Minimum reset pulse width	tRST	6·tCYC		ns	

3) 2.0 V single power source

(Unless otherwise specified: VDDE=VDD=2.0V±0.2V, VSS=0V, Ta=-40°C to +85°C)

Item	Symbol	Min.	Max.	Unit	*
High-speed clock cycle time	tC3	50		ns	
OSC3 clock input duty	tC3ED	45	55	%	
OSC3 clock input rise time	tIF		5	ns	
OSC3 clock input fall time	tIR		5	ns	
BCLK high-level output delay time	tCD1		60	ns	
BCLK low-level output delay time	tCD2		60	ns	
Minimum reset pulse width	tRST	6·tCYC		ns	

BCLK clock output characteristics

(Note) These AC characteristic values are applied only when the high-speed oscillation circuit is used.

1) 3.3 V/5.0 V dual power source

(Unless otherwise specified: VDDE=5.0V±0.5V, VDD=2.7V to 3.6V, VSS=0V, Ta=-40°C to +85°C)

Item	Symbol	Min.	Max.	Unit	*
BCLK clock output duty	tCBD	40	60	%	

2) 3.3 V single power source

(Unless otherwise specified: VDDE=VDD=2.7V to 3.6V, VSS=0V, Ta=-40°C to +85°C)

Item	Symbol	Min.	Max.	Unit	*
BCLK clock output duty	tCBD	40	60	%	

3) 2.0 V single power source

(Unless otherwise specified: VDDE=VDD=2.0V±0.2V, VSS=0V, Ta=-40°C to +85°C)

Item	Symbol	Min.	Max.	Unit	*
BCLK clock output duty	tCBD	40	60	%	

Common characteristics

1) 3.3 V/5.0 V dual power source

(Unless otherwise specified: $V_{DDE}=5.0V\pm 0.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Address delay time	t _{AD}	–	8	ns	1
#CE _x delay time (1)	t _{CE1}	–	8	ns	
#CE _x delay time (2)	t _{CE2}	–	8	ns	
Wait setup time	t _{WTS}	15	–	ns	
Wait hold time	t _{WTH}	0	–	ns	
Read signal delay time (1)	t _{RDD1}		8	ns	2
Read data setup time	t _{RDS}	12		ns	
Read data hold time	t _{RDH}	0		ns	
Write signal delay time (1)	t _{WRD1}		8	ns	3
Write data delay time (1)	t _{WDD1}		10	ns	
Write data delay time (2)	t _{WDD2}	0	10	ns	
Write data hold time	t _{WDH}	0		ns	

2) 3.3 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Address delay time	t _{AD}	–	10	ns	1
#CE _x delay time (1)	t _{CE1}	–	10	ns	
#CE _x delay time (2)	t _{CE2}	–	10	ns	
Wait setup time	t _{WTS}	15	–	ns	
Wait hold time	t _{WTH}	0	–	ns	
Read signal delay time (1)	t _{RDD1}		10	ns	2
Read data setup time	t _{RDS}	15		ns	
Read data hold time	t _{RDH}	0		ns	
Write signal delay time (1)	t _{WRD1}		10	ns	3
Write data delay time (1)	t _{WDD1}		10	ns	
Write data delay time (2)	t _{WDD2}	0	10	ns	
Write data hold time	t _{WDH}	0		ns	

3) 2.0 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Address delay time	t _{AD}	–	20	ns	1
#CE _x delay time (1)	t _{CE1}	–	20	ns	
#CE _x delay time (2)	t _{CE2}	–	20	ns	
Wait setup time	t _{WTS}	40	–	ns	
Wait hold time	t _{WTH}	0	–	ns	
Read signal delay time (1)	t _{RDD1}		20	ns	2
Read data setup time	t _{RDS}	40		ns	
Read data hold time	t _{RDH}	0		ns	
Write signal delay time (1)	t _{WRD1}		20	ns	3
Write data delay time (1)	t _{WDD1}		20	ns	
Write data delay time (2)	t _{WDD2}	0	20	ns	
Write data hold time	t _{WDH}	0		ns	

- * note 1) This applies to the #BSH and #BSL timings.
 2) This applies to the #GAAS and #GARD timings.
 3) This applies to the #GAAS timing.

SRAM read cycle

1) 3.3 V/5.0 V dual power source

(Unless otherwise specified: $V_{DDE}=5.0V\pm 0.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Read signal delay time (2)	t _{RDD2}		8	ns	
Read signal pulse width	t _{RDW}	t _{cyC} (0.5+WC)-8		ns	
Read address access time (1)	t _{ACC1}		t _{cyC} (1+WC)-20	ns	
Chip enable access time (1)	t _{CEAC1}		t _{cyC} (1+WC)-20	ns	
Read signal access time (1)	t _{RDAC1}		t _{cyC} (0.5+WC)-20	ns	

2) 3.3 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Read signal delay time (2)	t _{RDD2}		10	ns	
Read signal pulse width	t _{RDW}	t _{cyC} (0.5+WC)-10		ns	
Read address access time (1)	t _{ACC1}		t _{cyC} (1+WC)-25	ns	
Chip enable access time (1)	t _{CEAC1}		t _{cyC} (1+WC)-25	ns	
Read signal access time (1)	t _{RDAC1}		t _{cyC} (0.5+WC)-25	ns	

3) 2.0 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Read signal delay time (2)	t _{RDD2}		10	ns	
Read signal pulse width	t _{RDW}	t _{cyC} (0.5+WC)-10		ns	
Read address access time (1)	t _{ACC1}		t _{cyC} (1+WC)-60	ns	
Chip enable access time (1)	t _{CEAC1}		t _{cyC} (1+WC)-60	ns	
Read signal access time (1)	t _{RDAC1}		t _{cyC} (0.5+WC)-60	ns	

SRAM write cycle

1) 3.3 V/5.0 V dual power source

(Unless otherwise specified: $V_{DDE}=5.0V\pm 0.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Write signal delay time (2)	t _{WRD2}		8	ns	
Write signal pulse width	t _{WRW}	t _{cyC} (1+WC)-10		ns	

2) 3.3 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Write signal delay time (2)	t _{WRD2}		10	ns	
Write signal pulse width	t _{WRW}	t _{cyC} (1+WC)-10		ns	

3) 2.0 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Write signal delay time (2)	t _{WRD2}		20	ns	
Write signal pulse width	t _{WRW}	t _{cyC} (1+WC)-20		ns	

DRAM access cycle common characteristics

1) 3.3 V/5.0 V dual power source

(Unless otherwise specified: $V_{DDE}=5.0V\pm 0.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
#RAS signal delay time (1)	t _{RASD1}		10	ns	
#RAS signal delay time (2)	t _{RASD2}		10	ns	
#RAS signal pulse width	t _{RASW}	t _{CYC} (2+WC)-10		ns	
#CAS signal delay time (1)	t _{CASD1}		10	ns	
#CAS signal delay time (2)	t _{CASD2}		10	ns	
#CAS signal pulse width	t _{CASW}	t _{CYC} (0.5+WC)-5		ns	
Read signal delay time (3)	t _{RDD3}		10	ns	
Read signal pulse width (2)	t _{RDW2}	t _{CYC} (2+WC)-10		ns	
Write signal delay time (3)	t _{WRD3}		10	ns	
Write signal pulse width (2)	t _{WRW2}	t _{CYC} (2+WC)-10		ns	

2) 3.3 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
#RAS signal delay time (1)	t _{RASD1}		10	ns	
#RAS signal delay time (2)	t _{RASD2}		10	ns	
#RAS signal pulse width	t _{RASW}	t _{CYC} (2+WC)-10		ns	
#CAS signal delay time (1)	t _{CASD1}		10	ns	
#CAS signal delay time (2)	t _{CASD2}		10	ns	
#CAS signal pulse width	t _{CASW}	t _{CYC} (0.5+WC)-10		ns	
Read signal delay time (3)	t _{RDD3}		10	ns	
Read signal pulse width (2)	t _{RDW2}	t _{CYC} (2+WC)-10		ns	
Write signal delay time (3)	t _{WRD3}		10	ns	
Write signal pulse width (2)	t _{WRW2}	t _{CYC} (2+WC)-10		ns	

3) 2.0 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
#RAS signal delay time (1)	t _{RASD1}		20	ns	
#RAS signal delay time (2)	t _{RASD2}		20	ns	
#RAS signal pulse width	t _{RASW}	t _{CYC} (2+WC)-20		ns	
#CAS signal delay time (1)	t _{CASD1}		20	ns	
#CAS signal delay time (2)	t _{CASD2}		20	ns	
#CAS signal pulse width	t _{CASW}	t _{CYC} (0.5+WC)-20		ns	
Read signal delay time (3)	t _{RDD3}		20	ns	
Read signal pulse width (2)	t _{RDW2}	t _{CYC} (2+WC)-20		ns	
Write signal delay time (3)	t _{WRD3}		20	ns	
Write signal pulse width (2)	t _{WRW2}	t _{CYC} (2+WC)-20		ns	

DRAM random access cycle and DRAM fast-page cycle**1) 3.3 V/5.0 V dual power source**(Unless otherwise specified: $V_{DDE}=5.0V\pm 0.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Column address access time	t_{ACCF}		$t_{CYC}(1+WC)-25$	ns	
#RAS access time	t_{RACF}		$t_{CYC}(1.5+WC)-25$	ns	
#CAS access time	t_{CACF}		$t_{CYC}(0.5+WC)-25$	ns	

2) 3.3 V single power source(Unless otherwise specified: $V_{DDE}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Column address access time	t_{ACCF}		$t_{CYC}(1+WC)-25$	ns	
#RAS access time	t_{RACF}		$t_{CYC}(1.5+WC)-25$	ns	
#CAS access time	t_{CACF}		$t_{CYC}(0.5+WC)-25$	ns	

3) 2.0 V single power source(Unless otherwise specified: $V_{DDE}=V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Column address access time	t_{ACCF}		$t_{CYC}(1+WC)-60$	ns	
#RAS access time	t_{RACF}		$t_{CYC}(1.5+WC)-60$	ns	
#CAS access time	t_{CACF}		$t_{CYC}(0.5+WC)-60$	ns	

EDO DRAM random access cycle and EDO DRAM page cycle**1) 3.3 V/5.0 V dual power source**(Unless otherwise specified: $V_{DDE}=5.0V\pm 0.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Column address access time	t_{ACCE}		$t_{CYC}(1.5+WC)-25$	ns	
#RAS access time	t_{RACE}		$t_{CYC}(2+WC)-25$	ns	
#CAS access time	t_{CACE}		$t_{CYC}(1+WC)-15$	ns	
Read data setup time	t_{RDS2}	20		ns	

2) 3.3 V single power source(Unless otherwise specified: $V_{DDE}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Column address access time	t_{ACCE}		$t_{CYC}(1.5+WC)-25$	ns	
#RAS access time	t_{RACE}		$t_{CYC}(2+WC)-25$	ns	
#CAS access time	t_{CACE}		$t_{CYC}(1+WC)-20$	ns	
Read data setup time	t_{RDS2}	20		ns	

3) 2.0 V single power source(Unless otherwise specified: $V_{DDE}=V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Column address access time	t_{ACCE}		$t_{CYC}(1.5+WC)-60$	ns	
#RAS access time	t_{RACE}		$t_{CYC}(2+WC)-60$	ns	
#CAS access time	t_{CACE}		$t_{CYC}(1+WC)-60$	ns	
Read data setup time	t_{RDS2}	20		ns	

Burst ROM read cycle**1) 3.3 V/5.0 V dual power source**(Unless otherwise specified: $V_{DDE}=5.0V\pm 0.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Read address access time (2)	t _{ACC2}		t _{cyc} (1+WC)-20	ns	
Chip enable access time (2)	t _{CEAC2}		t _{cyc} (1+WC)-20	ns	
Read signal access time (2)	t _{RDAC2}		t _{cyc} (0.5+WC)-20	ns	
Burst address access time	t _{ACCB}		t _{cyc} (1+WC)-20	ns	

2) 3.3 V single power source(Unless otherwise specified: $V_{DDE}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Read address access time (2)	t _{ACC2}		t _{cyc} (1+WC)-25	ns	
Chip enable access time (2)	t _{CEAC2}		t _{cyc} (1+WC)-25	ns	
Read signal access time (2)	t _{RDAC2}		t _{cyc} (0.5+WC)-25	ns	
Burst address access time	t _{ACCB}		t _{cyc} (1+WC)-25	ns	

3) 2.0 V single power source(Unless otherwise specified: $V_{DDE}=V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Read address access time (2)	t _{ACC2}		t _{cyc} (1+WC)-60	ns	
Chip enable access time (2)	t _{CEAC2}		t _{cyc} (1+WC)-60	ns	
Read signal access time (2)	t _{RDAC2}		t _{cyc} (0.5+WC)-60	ns	
Burst address access time	t _{ACCB}		t _{cyc} (1+WC)-60	ns	

External bus master and NMI**1) 3.3 V/5.0 V dual power source**(Unless otherwise specified: $V_{DDE}=5.0V\pm 0.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
#BUSREQ signal setup time	t _{BRQS}	15		ns	
#BUSREQ signal hold time	t _{BRQH}	0		ns	
#BUSACK signal output delay time	t _{BAKD}		10	ns	
High-impedance → output delay time	t _{Z2E}		10	ns	
Output → high-impedance delay time	t _{B2Z}		10	ns	
#NMI pulse width	t _{NMIW}	30		ns	

2) 3.3 V single power source(Unless otherwise specified: $V_{DDE}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
#BUSREQ signal setup time	t _{BRQS}	15		ns	
#BUSREQ signal hold time	t _{BRQH}	0		ns	
#BUSACK signal output delay time	t _{BAKD}		10	ns	
High-impedance → output delay time	t _{Z2E}		10	ns	
Output → high-impedance delay time	t _{B2Z}		10	ns	
#NMI pulse width	t _{NMIW}	30		ns	

3) 2.0 V single power source(Unless otherwise specified: $V_{DDE}=V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
#BUSREQ signal setup time	t _{BRQS}	40		ns	
#BUSREQ signal hold time	t _{BRQH}	0		ns	
#BUSACK signal output delay time	t _{BAKD}		20	ns	
High-impedance → output delay time	t _{Z2E}		20	ns	
Output → high-impedance delay time	t _{B2Z}		20	ns	
#NMI pulse width	t _{NMIW}	90		ns	

Input, Output and I/O port

1) 3.3 V/5.0 V dual power source

(Unless otherwise specified: $V_{DDE}=5.0V\pm 0.5V$, $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Input data setup time	tINPS	20		ns	
Input data hold time	tINPH	10		ns	
Output data delay time	tOUTD		20	ns	
K-port interrupt	SLEEP, HALT2 mode	tkINW	30	ns	
input pulse width	Others		$2 \times t_{CYC}$	ns	

2) 3.3 V single power source

(Unless otherwise specified: $V_{DDE}=V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Input data setup time	tINPS	20		ns	
Input data hold time	tINPH	10		ns	
Output data delay time	tOUTD		20	ns	
K-port interrupt	SLEEP, HALT2 mode	tkINW	30	ns	
input pulse width	Others		$2 \times t_{CYC}$	ns	

3) 2.0 V single power source

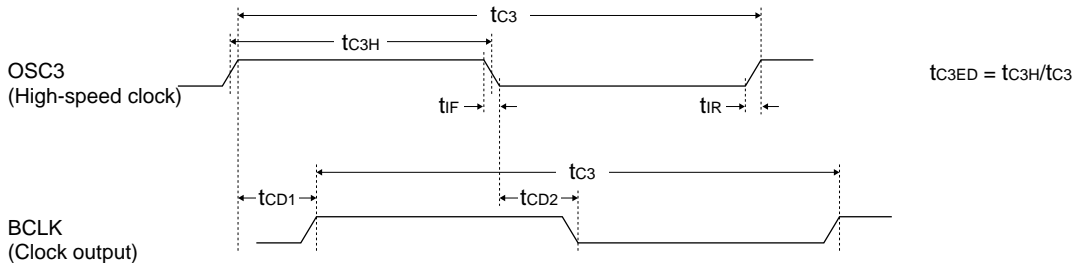
(Unless otherwise specified: $V_{DDE}=V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Min.	Max.	Unit	*
Input data setup time	tINPS	40		ns	
Input data hold time	tINPH	20		ns	
Output data delay time	tOUTD		30	ns	
K-port interrupt	SLEEP, HALT2 mode	tkINW	90	ns	
input pulse width	Others		$2 \times t_{CYC}$	ns	

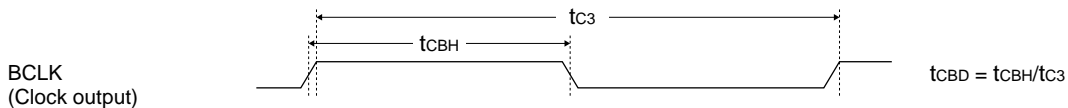
8.6.4 C33 Block AC Characteristic Timing Charts

Clock

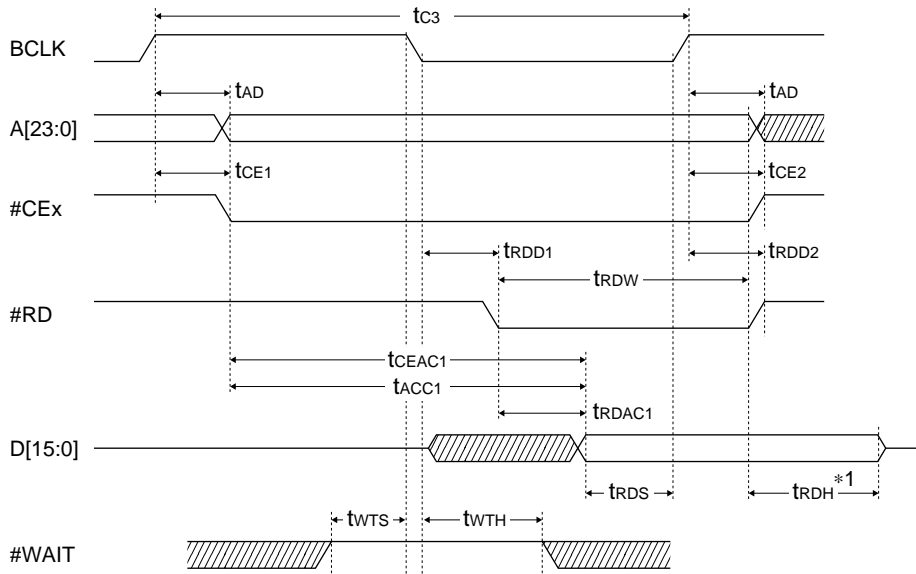
(1) When an external clock is input (in x1 speed mode):



(2) When the high-speed oscillation circuit is used for the operating clock:

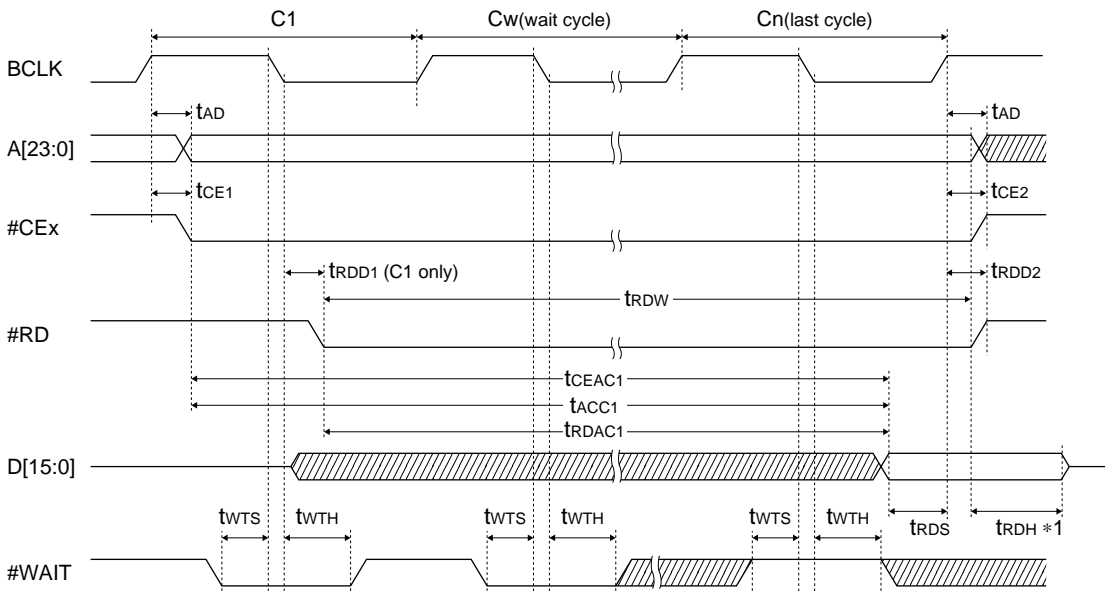


SRAM read cycle (basic cycle: 1 cycle)



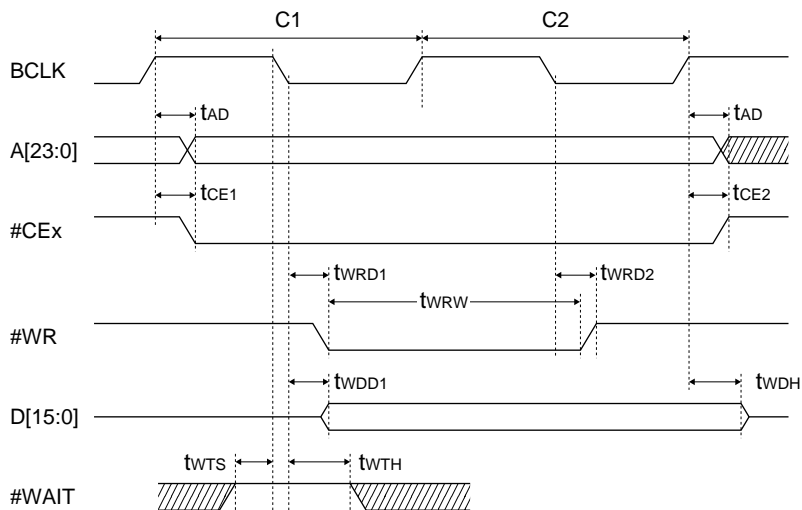
*1 trDH is measured with respect to the first signal change (negation) from among the #RD, #CEx and A[23:0] signals.

SRAM read cycle (when a wait cycle is inserted)

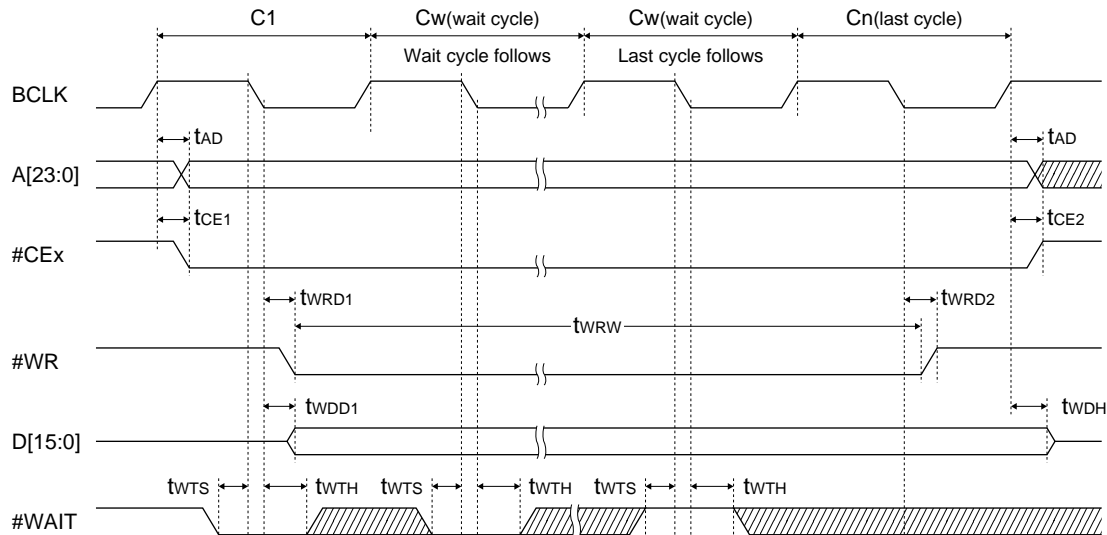


*1 trDH is measured with respect to the first signal change (negation) from among the #RD, #CEx and A[23:0] signals.

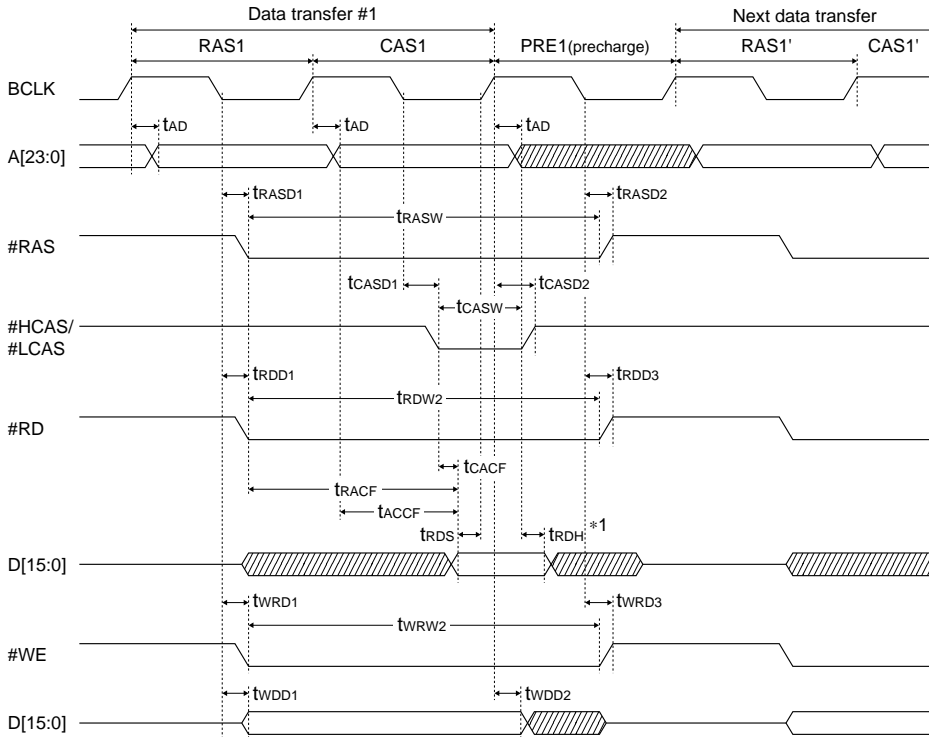
SRAM write cycle (basic cycle: 2 cycles)



SRAM write cycle (when wait cycles are inserted)

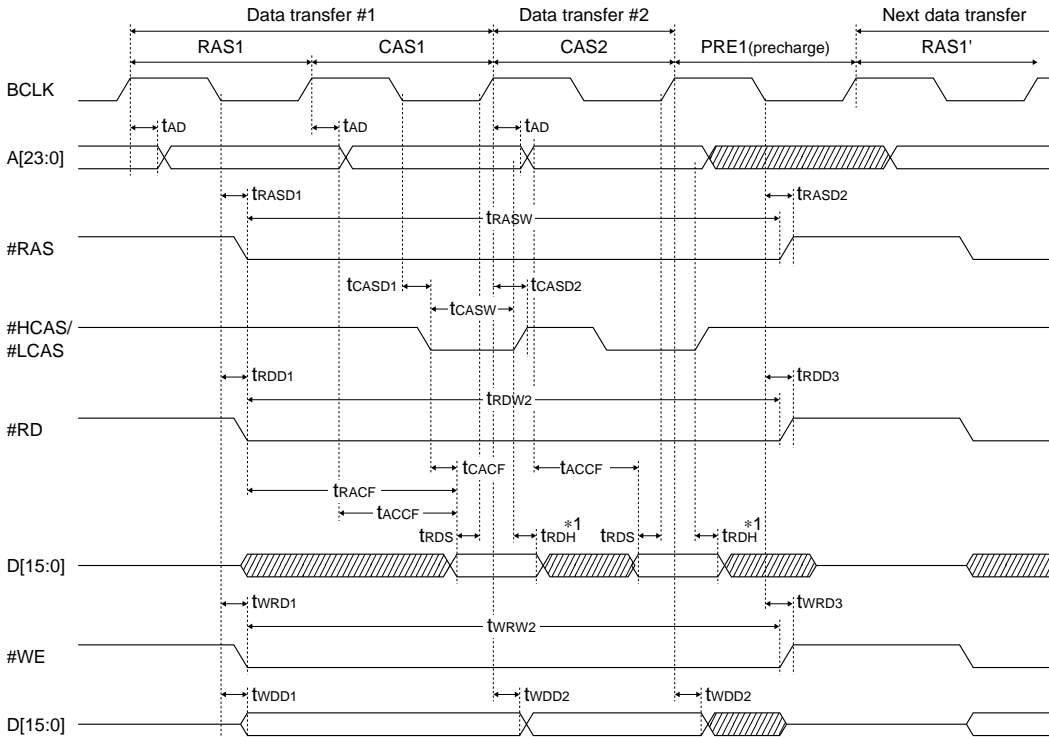


DRAM random access cycle (basic cycle)



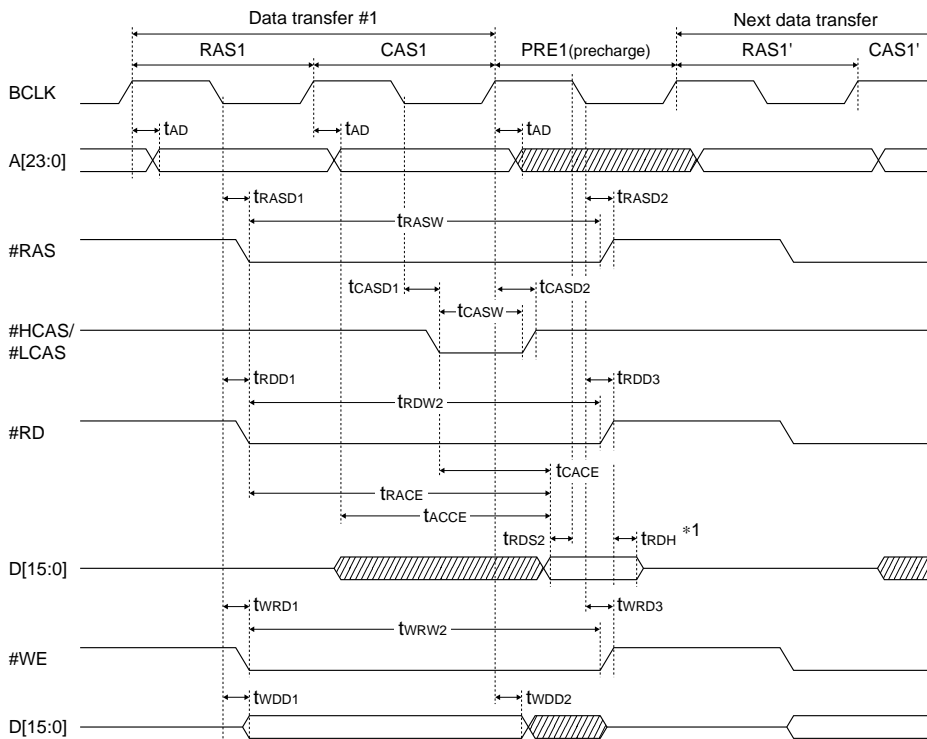
*1 t_{RDH} is measured with respect to the first signal change (negation) of either the #RD or the A[23:0] signals.

DRAM fast-page access cycle



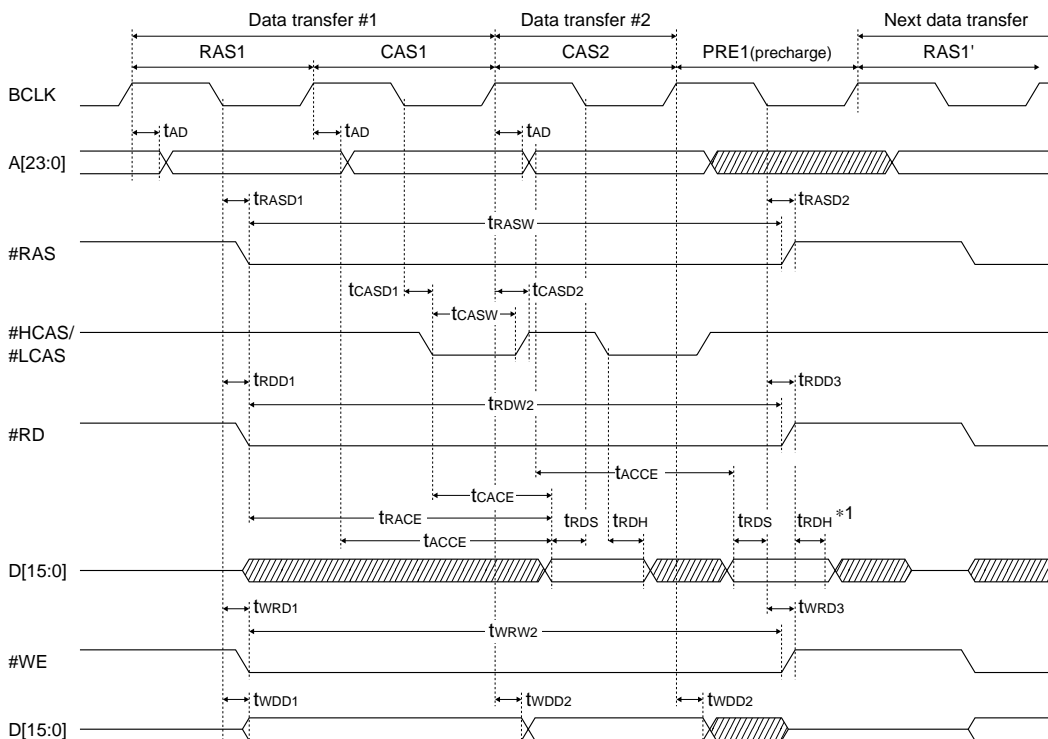
*1 t_{RDH} is measured with respect to the first signal change (negation) of either the #RD or the A[23:0] signals.

EDO DRAM random access cycle (basic cycle)



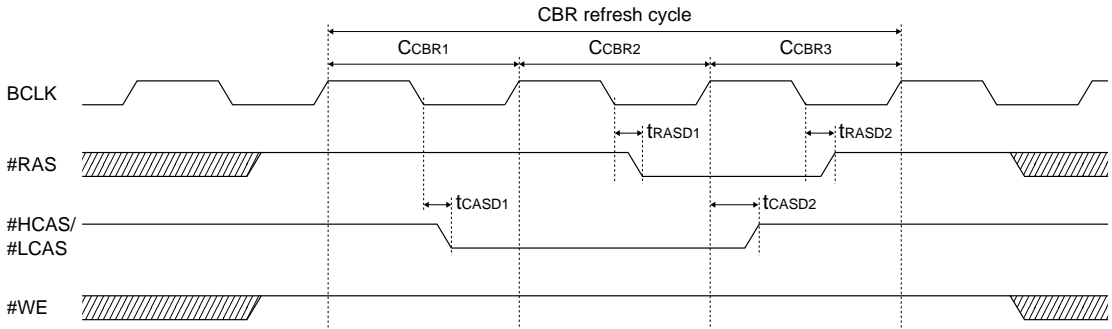
*1 t_{RDH} is measured with respect to the first signal change (negation) of either the #RD or the #RASx signals.

EDO DRAM page access cycle

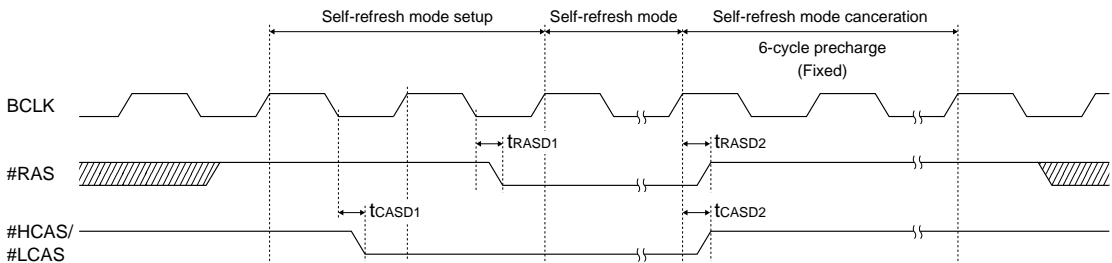


*1 t_{RDH} is measured with respect to the first signal change from among the #RD (negation), #RASx (negation) and #CAS (rise) signals.

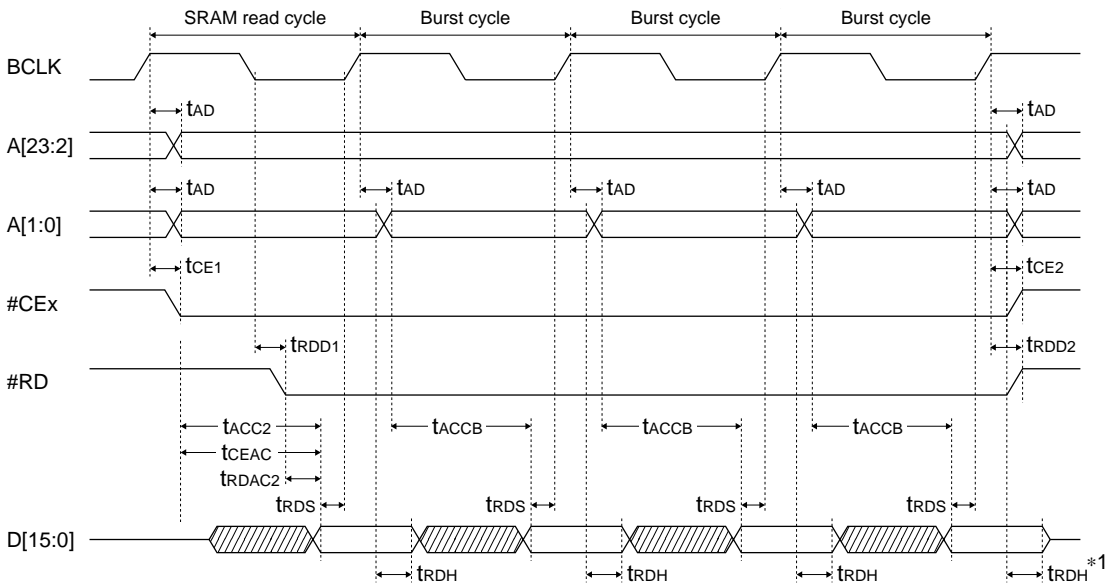
DRAM CAS-before-RAS refresh cycle



DRAM self-refresh cycle

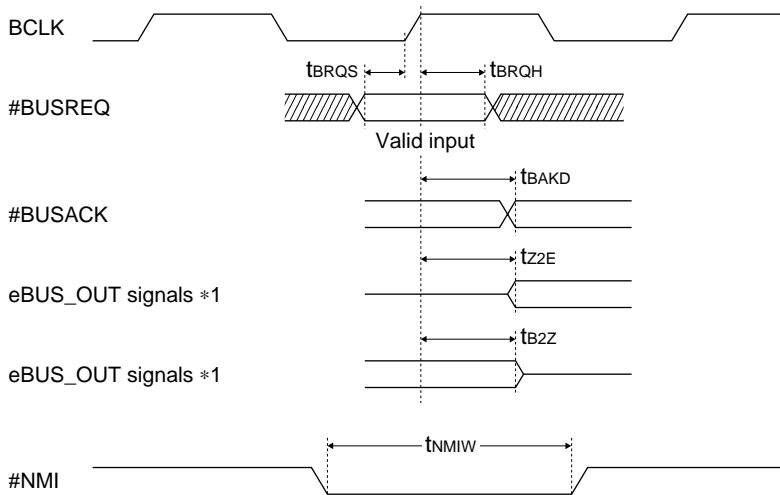


Burst ROM read cycle



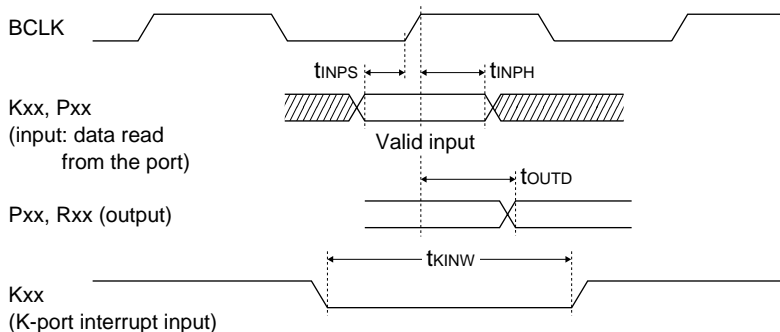
*1 t_{RDH} is measured with respect to the first signal change (negation) from among the #RD, #CEx and A[23:0] signals.

#BUSREQ, #BUSACK and #NMI timing



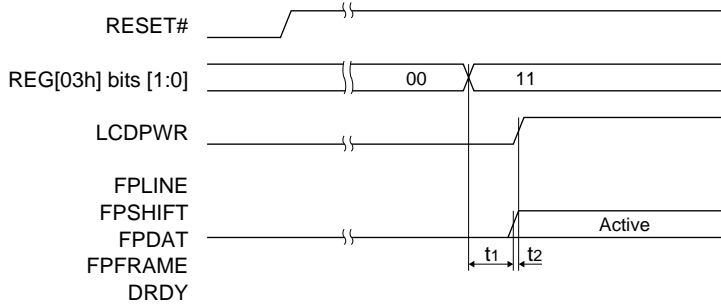
*1 eBUS_OUT indicates the following pins:
 A[23:0], #RD, #WRL, #WRH, #HCAS, #LCAS, #CE[17:4], D[15:0]

Input, output and I/O port timing



8.6.5 LCD Interface AC Characteristics

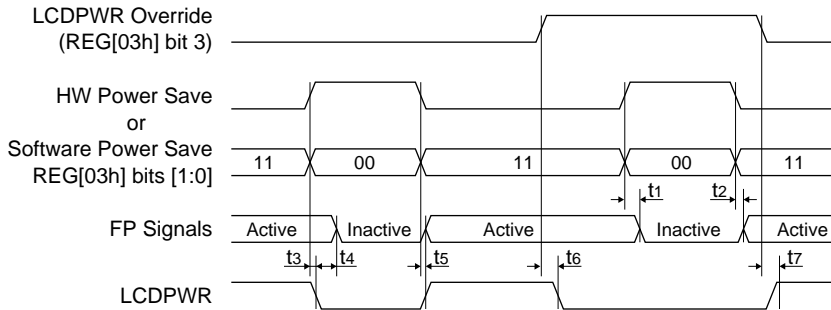
Power on/reset timing



Symbol	Parameter	Min.	Typ.	Max.	Unit
t1	REG[03h] to FPLINE, FPF, FPSHIFT, FPDAT, DRDY active			T _{FPFRAME}	ns
t2	FPLINE, FPF, FPSHIFT, FPDAT, DRDY active to LCDPWR		0		Frame

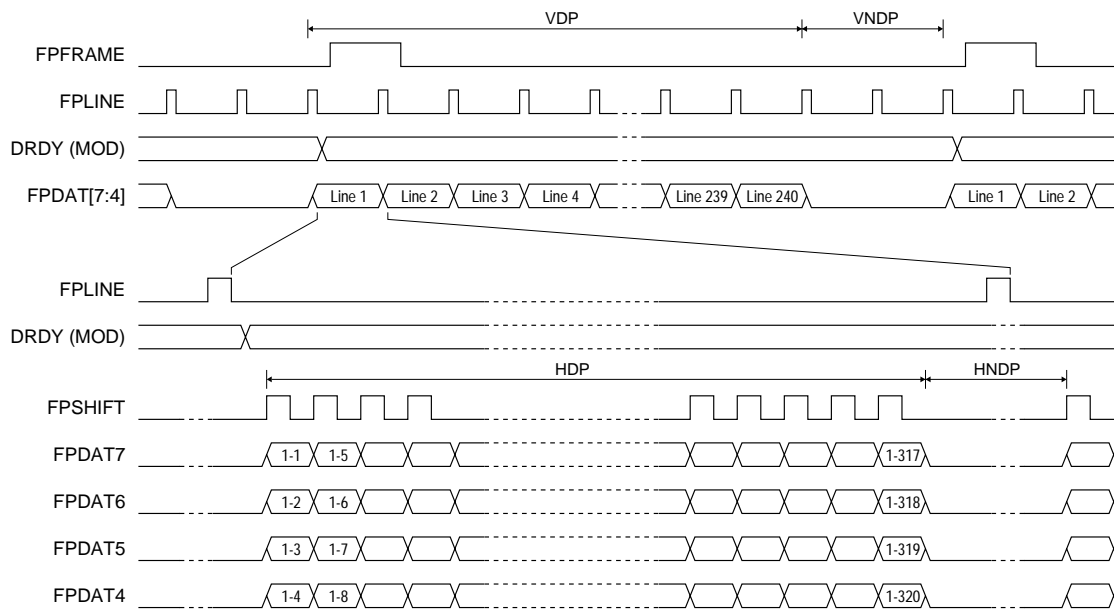
Note: Where T_{FPFRAME} is the period of FPF and T_{PCLK} is the period of the pixel clock.

Power down/up timing



Symbol	Parameter	Min.	Typ.	Max.	Unit
t1	HW Power Save active to FPLINE, FPF, FPSHIFT, FPDAT, DRDY inactive - LCDPWR Override = 1			1	Frame
t2	HW Power Save inactive to FPLINE, FPF, FPSHIFT, FPDAT, DRDY active - LCDPWR Override = 1			1	Frame
t3	HW Power Save active to FPLINE, FPF, FPSHIFT, FPDAT, DRDY inactive - LCDPWR Override = 0			1	Frame
t4	LCDPWR low to FPLINE, FPF, FPSHIFT, FPDAT, DRDY inactive - LCDPWR Override = 0		127		Frame
t5	HW Power Save inactive to FPLINE, FPF, FPSHIFT, FPDAT, DRDY, LCDPWR active - LCDPWR Override = 0		0		Frame
t6	LCDPWR Override active (1) to LCDPWR inactive			1	Frame
t7	LCDPWR Override inactive (1) to LCDPWR active			1	Frame

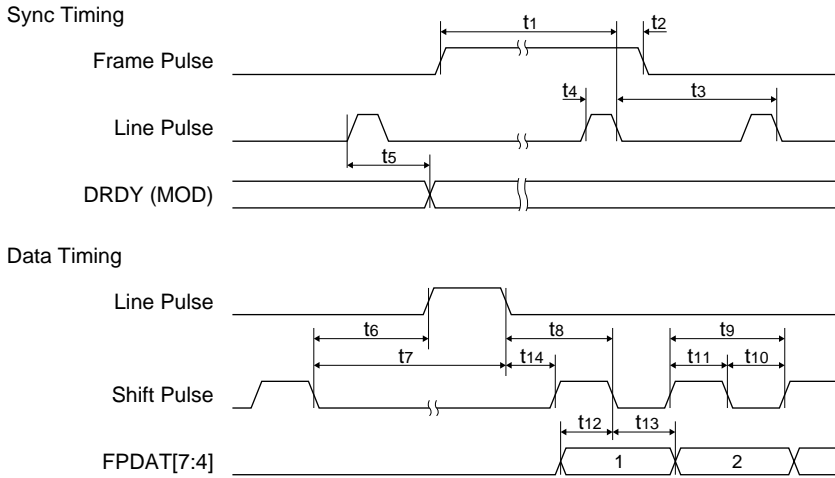
4-bit single monochrome panel timing



* Diagram drawn with 2 FPLINE vertical blank period
 Example timing for a 320 × 240 panel
 For this timing diagram Mask FPSHIFT, REG[01h] bit 3, is set to 1

- VDP = Vertical Display Period = (REG[06h] bits [1:0], REG[05h] bits [7:0]) + 1 Lines
- VNDP = Vertical Non-Display Period = REG[0Ah] bits [5:0] Lines
- HDP = Horizontal Display Period = ((REG[04h] bits [6:0]) + 1) × 8Ts
- HNDP = Horizontal Non-Display Period = (REG[08h] + 4) × 8Ts

8 ELECTRICAL CHARACTERISTICS



Note: For this timing diagram Mask FPSHIFT, REG[01h] bit 3, is set to 1

4-bit Single Monochrome Panel AC Timing

Symbol	Parameter	Min.	Typ.	Max.	Unit
t ₁	Frame Pulse setup to Line Pulse falling edge	note 2			(note 1)
t ₂	Frame Pulse hold from Line Pulse falling edge	9			Ts
t ₃	Line Pulse period	note 3			
t ₄	Line Pulse pulse width	9			Ts
t ₅	MOD delay from Line Pulse rising edge	1			Ts
t ₆	Shift Pulse falling edge to Line Pulse rising edge	note 4			
t ₇	Shift Pulse falling edge to Line Pulse falling edge	note 5			
t ₈	Line Pulse falling edge to Shift Pulse falling edge	t ₁₄ +2			Ts
t ₉	Shift Pulse period	4			Ts
t ₁₀	Shift Pulse pulse width low	2			Ts
t ₁₁	Shift Pulse pulse width high	2			Ts
t ₁₂	FPDAT[7:4] setup to Shift Pulse falling edge	2			Ts
t ₁₃	FPDAT[7:4] hold from Shift Pulse falling edge	2			Ts
t ₁₄	Line Pulse falling edge to Shift Pulse rising edge	23			Ts

note) 1. Ts = pixel clock period

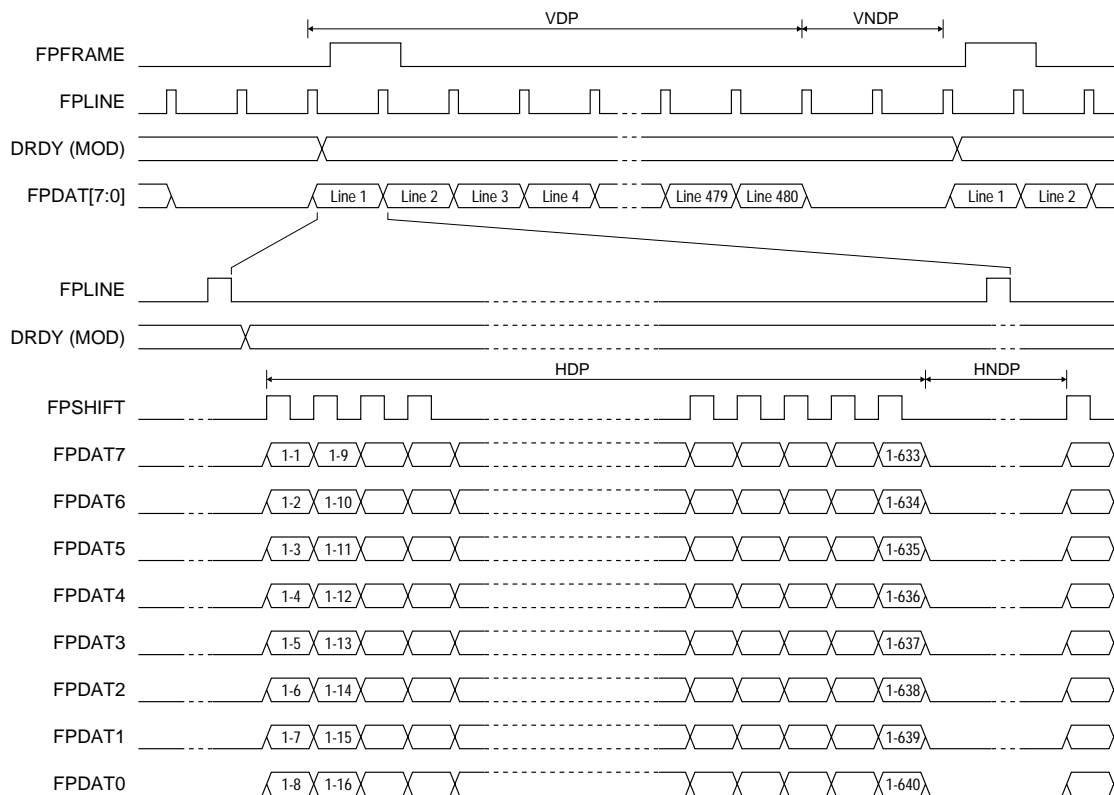
2. t_{1min} = t_{3min} - 9Ts

3. t_{3min} = [((REG[04h] bits [6:0]) + 1) × 8 + ((REG[08h] bits [4:0]) + 4) × 8]Ts

4. t_{6min} = [(REG[08h] bits [4:0]) × 8 + 2]Ts

5. t_{7min} = [(REG[08h] bits [4:0]) × 8 + 11]Ts

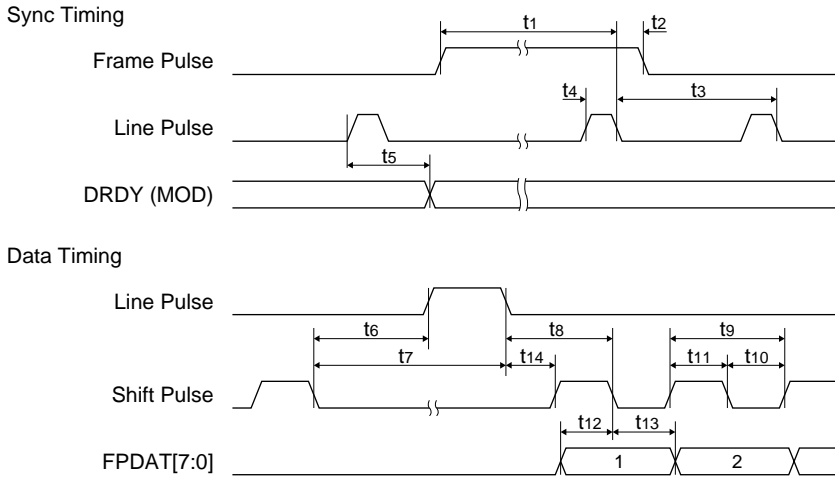
8-bit single monochrome panel timing



* Diagram drawn with 2 FPLINE vertical blank period
 Example timing for a 640 × 480 panel
 For this timing diagram Mask FPSHIFT, REG[01h] bit 3, is set to 1

- VDP = Vertical Display Period = (REG[06h] bits [1:0], REG[05h] bits [7:0]) + 1 Lines
- VNDP = Vertical Non-Display Period = REG[0Ah] bits [5:0] Lines
- HDP = Horizontal Display Period = ((REG[04h] bits [6:0]) + 1) × 8Ts
- HNDP = Horizontal Non-Display Period = (REG[08h] + 4) × 8Ts

8 ELECTRICAL CHARACTERISTICS



Note: For this timing diagram Mask FPSHIFT, REG[01h] bit 3, is set to 1

8-bit Single Monochrome Panel AC Timing

Symbol	Parameter	Min.	Typ.	Max.	Unit
t ₁	Frame Pulse setup to Line Pulse falling edge	note 2			(note 1)
t ₂	Frame Pulse hold from Line Pulse falling edge	9			Ts
t ₃	Line Pulse period	note 3			
t ₄	Line Pulse pulse width	9			Ts
t ₅	MOD delay from Line Pulse rising edge	1			Ts
t ₆	Shift Pulse falling edge to Line Pulse rising edge	note 4			
t ₇	Shift Pulse falling edge to Line Pulse falling edge	note 5			
t ₈	Line Pulse falling edge to Shift Pulse falling edge	t ₁₄ +4			Ts
t ₉	Shift Pulse period	8			Ts
t ₁₀	Shift Pulse pulse width low	4			Ts
t ₁₁	Shift Pulse pulse width high	4			Ts
t ₁₂	FPDAT[7:0] setup to Shift Pulse falling edge	4			Ts
t ₁₃	FPDAT[7:0] hold from Shift Pulse falling edge	4			Ts
t ₁₄	Line Pulse falling edge to Shift Pulse rising edge	23			Ts

note) 1. Ts = pixel clock period

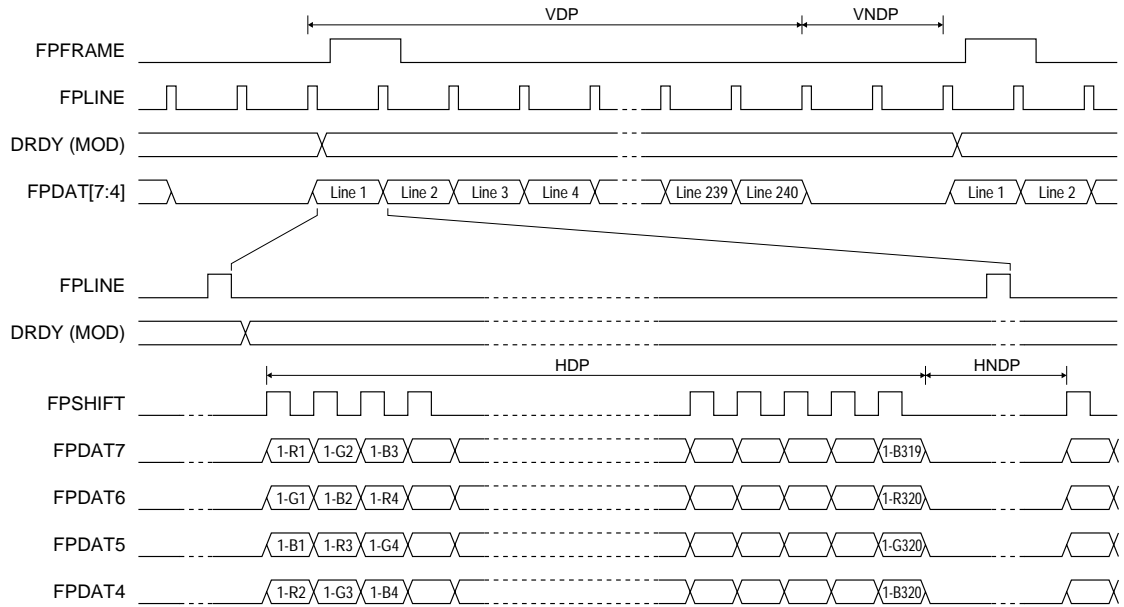
2. t_{1min} = t_{3min} - 9Ts

3. t_{3min} = [((REG[04h] bits [6:0]) + 1) × 8 + ((REG[08h] bits [4:0]) + 4) × 8]Ts

4. t_{6min} = [(REG[08h] bits [4:0]) × 8 + 4]Ts

5. t_{7min} = [(REG[08h] bits [4:0]) × 8 + 13]Ts

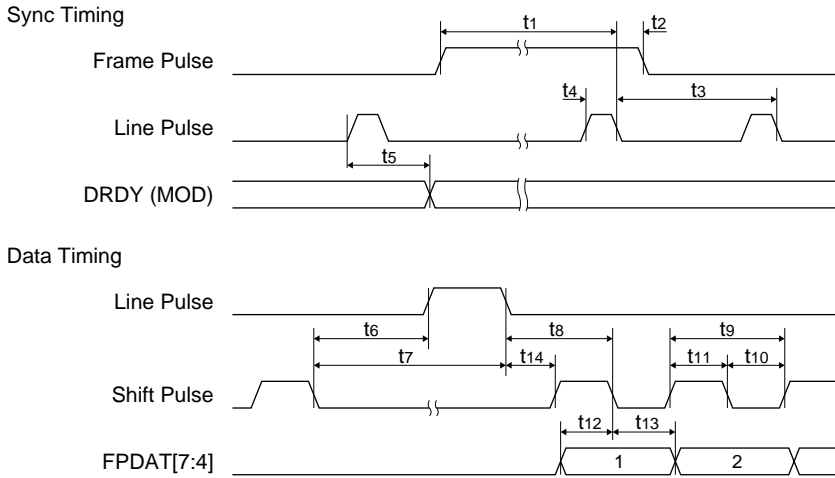
4-bit single color panel timing



* Diagram drawn with 2 FPLINE vertical blank period
 Example timing for a 320 × 240 panel

VDP = Vertical Display Period = (REG[06h] bits [1:0], REG[05h] bits [7:0]) + 1 Lines
 VNDP = Vertical Non-Display Period = REG[0Ah] bits [5:0] Lines
 HDP = Horizontal Display Period = ((REG[04h] bits [6:0]) + 1) × 8Ts
 HNDP = Horizontal Non-Display Period = (REG[08h] + 4) × 8Ts

8 ELECTRICAL CHARACTERISTICS



4-bit Single Color Panel AC Timing

Symbol	Parameter	Min.	Typ.	Max.	Unit
t ₁	Frame Pulse setup to Line Pulse falling edge	note 2			(note 1)
t ₂	Frame Pulse hold from Line Pulse falling edge	9			T _s
t ₃	Line Pulse period	note 3			
t ₄	Line Pulse pulse width	9			T _s
t ₅	MOD delay from Line Pulse rising edge	1			T _s
t ₆	Shift Pulse falling edge to Line Pulse rising edge	note 4			
t ₇	Shift Pulse falling edge to Line Pulse falling edge	note 5			
t ₈	Line Pulse falling edge to Shift Pulse falling edge	t ₁₄ +0.5			T _s
t ₉	Shift Pulse period	1			T _s
t ₁₀	Shift Pulse pulse width low	0.5			T _s
t ₁₁	Shift Pulse pulse width high	0.5			T _s
t ₁₂	FPDAT[7:4] setup to Shift Pulse falling edge	0.5			T _s
t ₁₃	FPDAT[7:4] hold from Shift Pulse falling edge	0.5			T _s
t ₁₄	Line Pulse falling edge to Shift Pulse rising edge	23			T _s

note) 1. T_s = pixel clock period

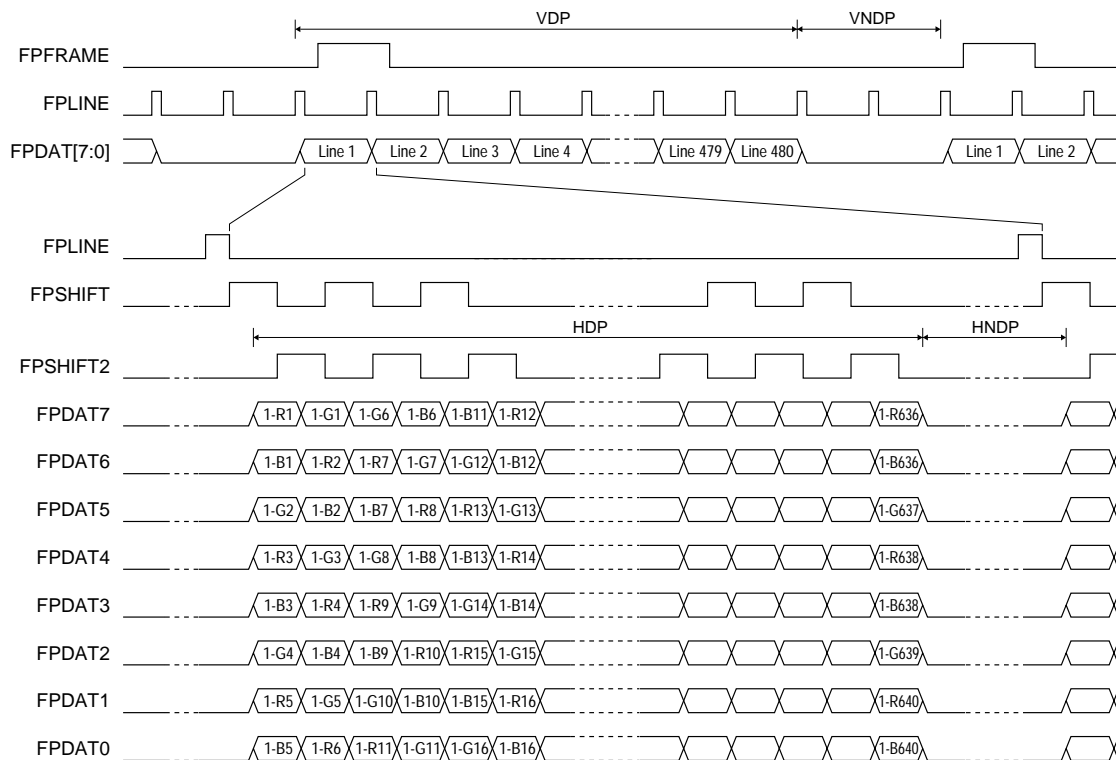
2. t_{1min} = t_{3min} - 9T_s

3. t_{3min} = (((REG[04h] bits [6:0]) + 1) × 8 + ((REG[08h] bits [4:0]) + 4) × 8)T_s

4. t_{6min} = [(REG[08h] bits [4:0]) × 8 + 0.5]T_s

5. t_{7min} = [(REG[08h] bits [4:0]) × 8 + 9.5]T_s

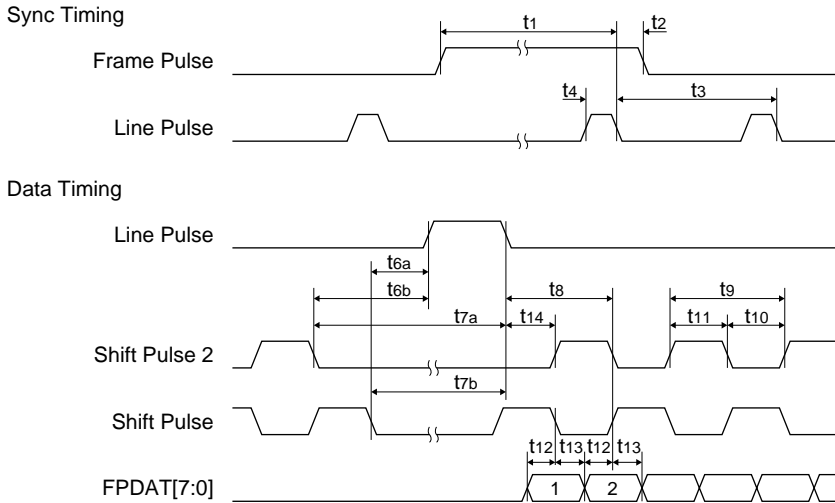
8-bit single color panel timing (Format 1)



* Diagram drawn with 2 FPLINE vertical blank period
 Example timing for a 640 × 480 panel

- VDP = Vertical Display Period = (REG[06h] bits [1:0], REG[05h] bits [7:0]) + 1 Lines
- VNDP = Vertical Non-Display Period = REG[0Ah] bits [5:0] Lines
- HDP = Horizontal Display Period = ((REG[04h] bits [6:0]) + 1) × 8Ts
- HNDP = Horizontal Non-Display Period = (REG[08h] + 4) × 8Ts

8 ELECTRICAL CHARACTERISTICS



8-bit Single Color Panel AC Timing (Format 1)

Symbol	Parameter	Min.	Typ.	Max.	Unit
t_1	Frame Pulse setup to Line Pulse falling edge	note 2			(note 1)
t_2	Frame Pulse hold from Line Pulse falling edge	9			Ts
t_3	Line Pulse period	note 3			
t_4	Line Pulse pulse width	9			Ts
t_{6a}	Shift Pulse falling edge to Line Pulse rising edge	note 4			
t_{6b}	Shift Pulse 2 falling edge to Line Pulse rising edge	note 5			
t_{7a}	Shift Pulse 2 falling edge to Line Pulse falling edge	note 6			
t_{7b}	Shift Pulse falling edge to Line Pulse falling edge	note 7			
t_8	Line Pulse falling edge to Shift Pulse rising, Shift Pulse 2 falling edge	$t_{14}+2$			Ts
t_9	Shift Pulse 2, Shift Pulse period	4			Ts
t_{10}	Shift Pulse 2, Shift Pulse pulse width low	2			Ts
t_{11}	Shift Pulse 2, Shift Pulse pulse width high	2			Ts
t_{12}	FPDAT[7:0] setup to Shift Pulse 2, Shift Pulse falling edge	1			Ts
t_{13}	FPDAT[7:0] hold from Shift Pulse 2, Shift Pulse falling edge	1			Ts
t_{14}	Line Pulse falling edge to Shift Pulse rising edge	23			Ts

note) 1. Ts = pixel clock period

2. $t_{1min} = t_{3min} - 9Ts$

3. $t_{3min} = [(((REG[04h] \text{ bits } [6:0]) + 1) \times 8 + ((REG[08h] \text{ bits } [4:0]) + 4) \times 8)Ts]$

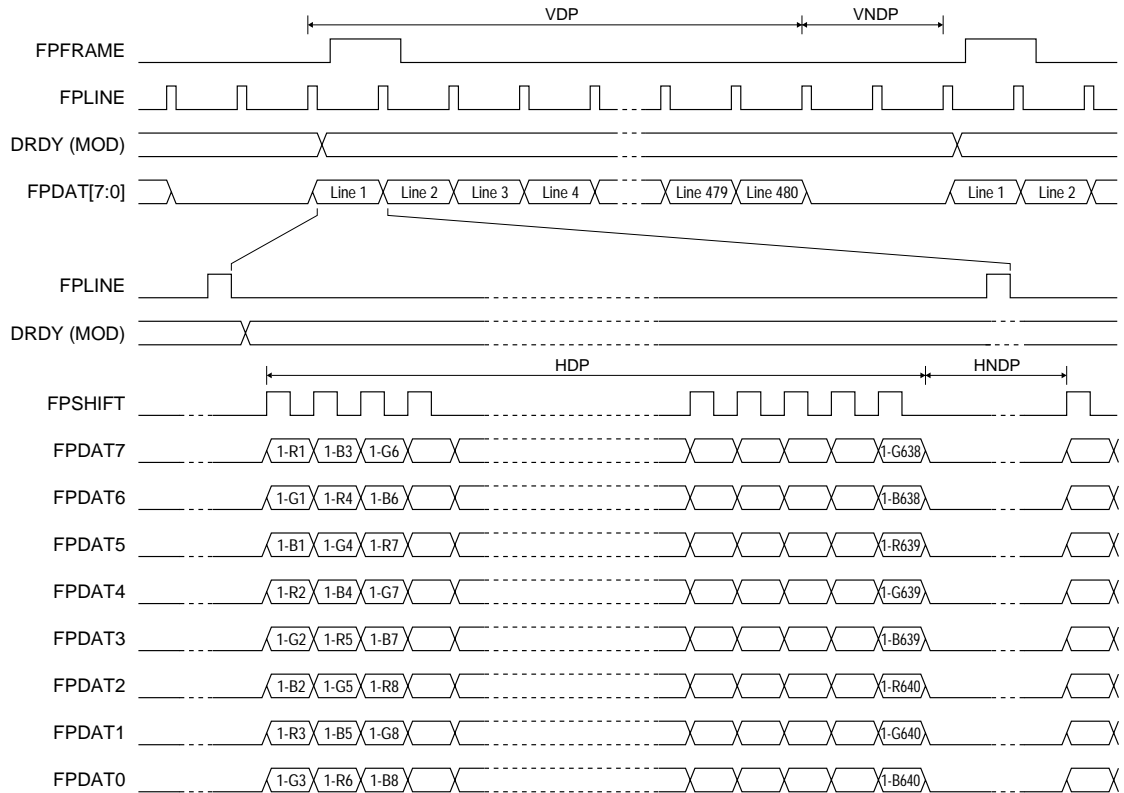
4. $t_{6amin} = [((REG[08h] \text{ bits } [4:0]) \times 8 + t_{13} - t_{10})Ts]$

5. $t_{6bmin} = [(REG[08h] \text{ bits } [4:0]) \times 8 + t_{13}]Ts$

6. $t_{7amin} = [(REG[08h] \text{ bits } [4:0]) \times 8 + 11]Ts$

7. $t_{7bmin} = [((REG[08h] \text{ bits } [4:0]) \times 8 + 11) - t_{10}]Ts$

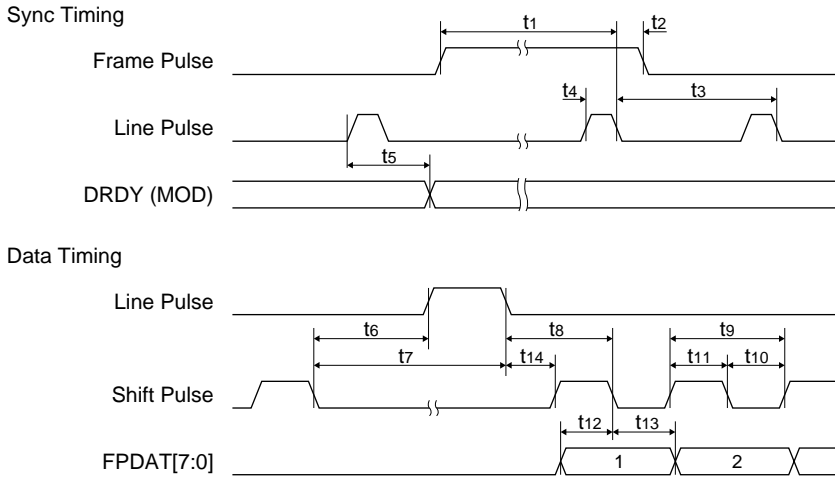
8-bit single color panel timing (Format 2)



* Diagram drawn with 2 FPLINE vertical blank period
 Example timing for a 640 × 480 panel

VDP = Vertical Display Period = (REG[06h] bits [1:0], REG[05h] bits [7:0]) + 1 Lines
 VNDP = Vertical Non-Display Period = REG[0Ah] bits [5:0] Lines
 HDP = Horizontal Display Period = ((REG[04h] bits [6:0]) + 1) × 8Ts
 HNDP = Horizontal Non-Display Period = (REG[08h] + 4) × 8Ts

8 ELECTRICAL CHARACTERISTICS



8-bit Single Color Panel AC Timing (Format 2)

Symbol	Parameter	Min.	Typ.	Max.	Unit
t ₁	Frame Pulse setup to Line Pulse falling edge	note 2			(note 1)
t ₂	Frame Pulse hold from Line Pulse falling edge	9			T _s
t ₃	Line Pulse period	note 3			
t ₄	Line Pulse pulse width	9			T _s
t ₅	MOD delay from Line Pulse rising edge	1			T _s
t ₆	Shift Pulse falling edge to Line Pulse rising edge	note 4			
t ₇	Shift Pulse falling edge to Line Pulse falling edge	note 5			
t ₈	Line Pulse falling edge to Shift Pulse falling edge	t ₁₄ +2			T _s
t ₉	Shift Pulse period	2			T _s
t ₁₀	Shift Pulse pulse width low	1			T _s
t ₁₁	Shift Pulse pulse width high	1			T _s
t ₁₂	FPDAT[7:0] setup to Shift Pulse falling edge	1			T _s
t ₁₃	FPDAT[7:0] hold from Shift Pulse falling edge	1			T _s
t ₁₄	Line Pulse falling edge to Shift Pulse rising edge	23			T _s

note) 1. T_s = pixel clock period

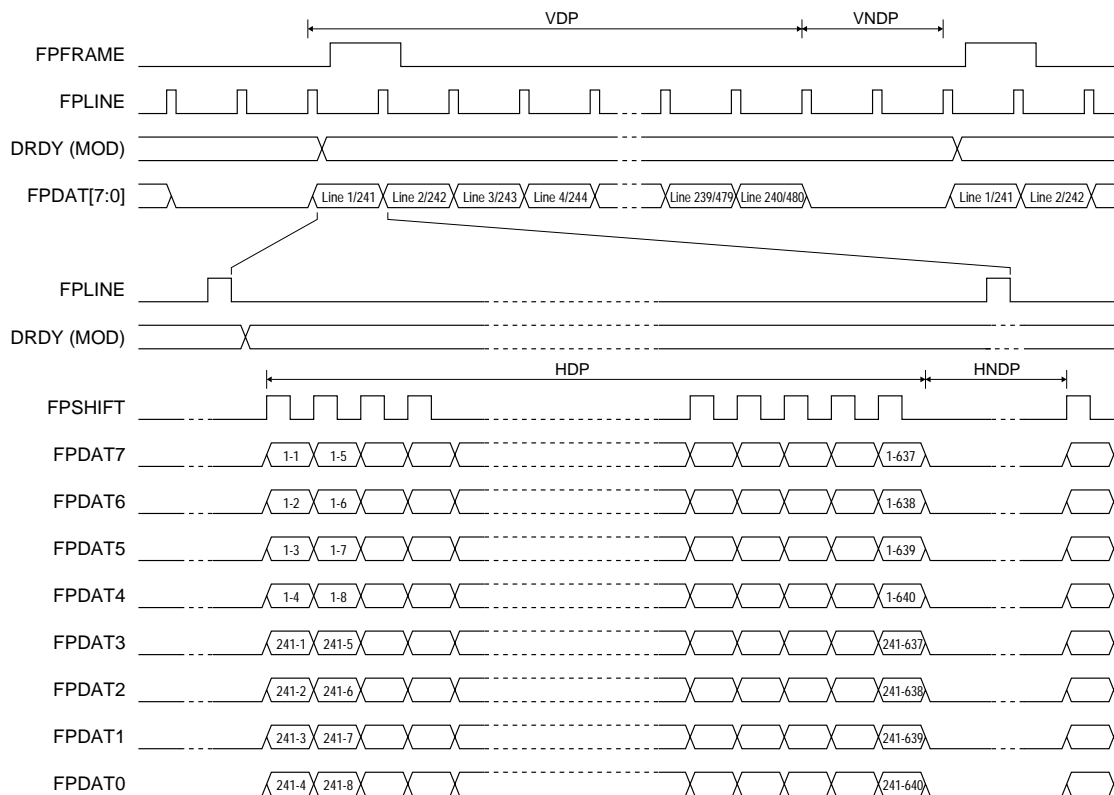
2. t_{1min} = t_{3min} - 9T_s

3. t_{3min} = (((REG[04h] bits [6:0]) + 1) × 8 + ((REG[08h] bits [4:0]) + 4) × 8)T_s

4. t_{6min} = [(REG[08h] bits [4:0]) × 8 + 1]T_s

5. t_{7min} = [(REG[08h] bits [4:0]) × 8 + 10]T_s

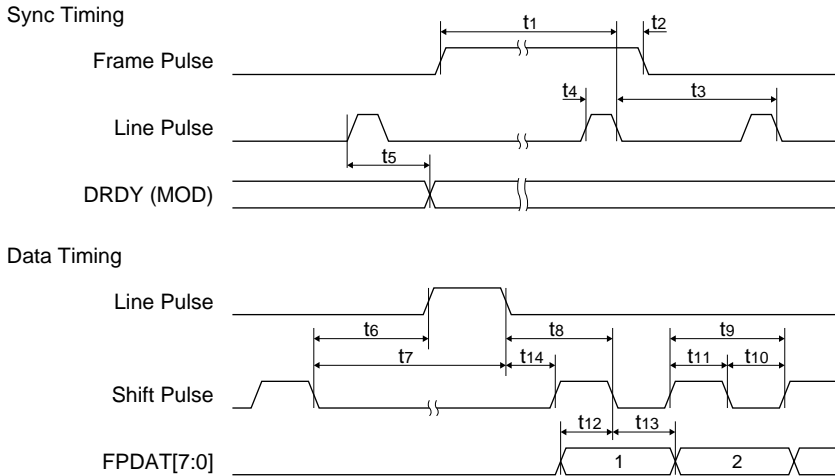
8-bit dual monochrome panel timing



* Diagram drawn with 2 FPLINE vertical blank period
 Example timing for a 640 × 480 panel

- VDP = Vertical Display Period = (REG[06h] bits [1:0], REG[05h] bits [7:0]) + 1 Lines
- VNDP = Vertical Non-Display Period = REG[0Ah] bits [5:0] Lines
- HDP = Horizontal Display Period = ((REG[04h] bits [6:0]) + 1) × 8Ts
- HNDP = Horizontal Non-Display Period = (REG[08h] + 4) × 8Ts

8 ELECTRICAL CHARACTERISTICS



Note: For this timing diagram Mask FPSHIFT, REG[01h] bit 3, is set to 1

8-bit Dual Monochrome Panel AC Timing

Symbol	Parameter	Min.	Typ.	Max.	Unit
t_1	Frame Pulse setup to Line Pulse falling edge	note 2			(note 1)
t_2	Frame Pulse hold from Line Pulse falling edge	9			Ts
t_3	Line Pulse period	note 3			
t_4	Line Pulse pulse width	9			Ts
t_5	MOD delay from Line Pulse rising edge	1			Ts
t_6	Shift Pulse falling edge to Line Pulse rising edge	note 4			
t_7	Shift Pulse falling edge to Line Pulse falling edge	note 5			
t_8	Line Pulse falling edge to Shift Pulse falling edge	$t_{14}+4$			Ts
t_9	Shift Pulse period	8			Ts
t_{10}	Shift Pulse pulse width low	4			Ts
t_{11}	Shift Pulse pulse width high	4			Ts
t_{12}	FPDAT[7:0] setup to Shift Pulse falling edge	4			Ts
t_{13}	FPDAT[7:0] hold from Shift Pulse falling edge	4			Ts
t_{14}	Line Pulse falling edge to Shift Pulse rising edge	39			Ts

note) 1. Ts = pixel clock period

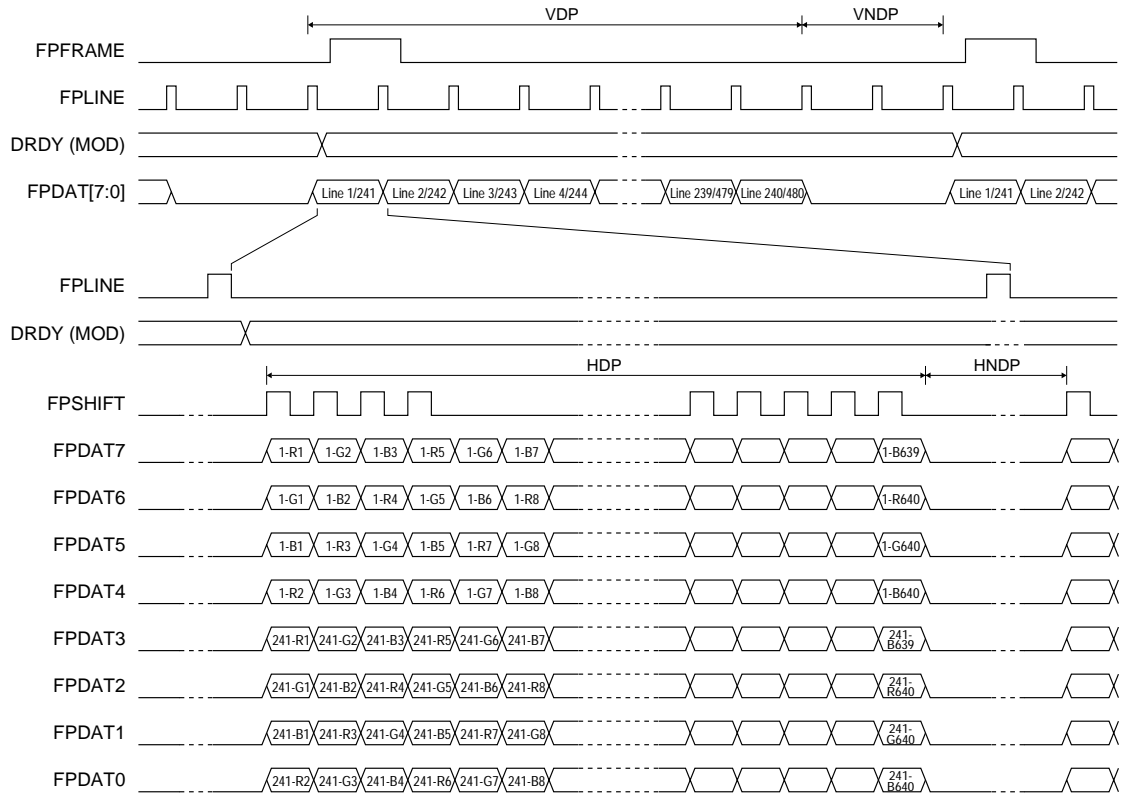
2. $t_{1\min} = t_{3\min} - 9Ts$

3. $t_{3\min} = [(((REG[04h] \text{ bits } [6:0]) + 1) \times 8 + ((REG[08h] \text{ bits } [4:0]) + 4) \times 8) \times 2]Ts$

4. $t_{6\min} = [(((REG[08h] \text{ bits } [4:0]) \times 2) \times 8 + 20)Ts$

5. $t_{7\min} = [(((REG[08h] \text{ bits } [4:0]) \times 2) \times 8 + 29)Ts$

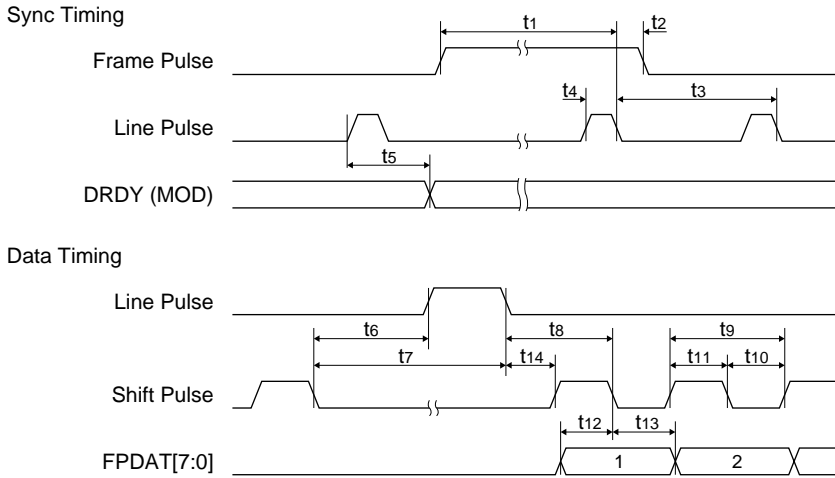
8-bit dual color panel timing



* Diagram drawn with 2 FPLINE vertical blank period
 Example timing for a 640 × 480 panel

VDP = Vertical Display Period = (REG[06h] bits [1:0], REG[05h] bits [7:0]) + 1 Lines
 VNDP = Vertical Non-Display Period = REG[0Ah] bits [5:0] Lines
 HDP = Horizontal Display Period = ((REG[04h] bits [6:0]) + 1) × 8Ts
 HNDP = Horizontal Non-Display Period = (REG[08h] + 4) × 8Ts

8 ELECTRICAL CHARACTERISTICS



8-bit Dual Color Panel AC Timing

Symbol	Parameter	Min.	Typ.	Max.	Unit
t ₁	Frame Pulse setup to Line Pulse falling edge	note 2			(note 1)
t ₂	Frame Pulse hold from Line Pulse falling edge	9			Ts
t ₃	Line Pulse period	note 3			
t ₄	Line Pulse pulse width	9			Ts
t ₅	MOD delay from Line Pulse rising edge	1			Ts
t ₆	Shift Pulse falling edge to Line Pulse rising edge	note 4			
t ₇	Shift Pulse falling edge to Line Pulse falling edge	note 5			
t ₈	Line Pulse falling edge to Shift Pulse falling edge	t ₁₄ +1			Ts
t ₉	Shift Pulse period	2			Ts
t ₁₀	Shift Pulse pulse width low	1			Ts
t ₁₁	Shift Pulse pulse width high	1			Ts
t ₁₂	FPDAT[7:0] setup to Shift Pulse falling edge	1			Ts
t ₁₃	FPDAT[7:0] hold from Shift Pulse falling edge	1			Ts
t ₁₄	Line Pulse falling edge to Shift Pulse rising edge	39			Ts

note) 1. Ts = pixel clock period

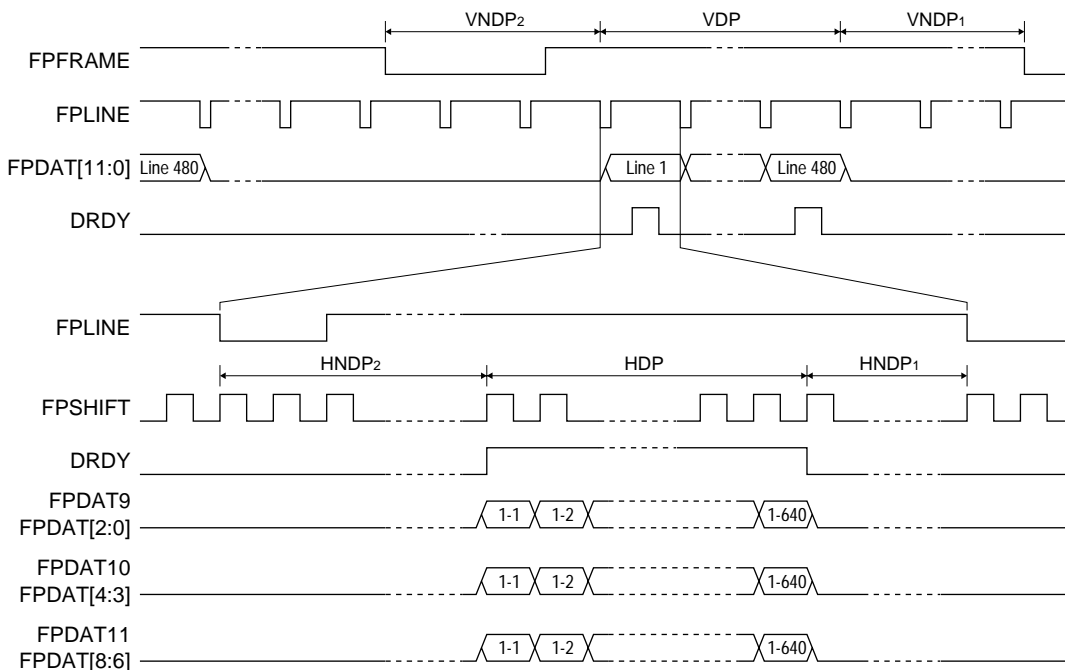
2. t_{1min} = t_{3min} - 9Ts

3. t_{3min} = [(((REG[04h] bits [6:0]) + 1) × 8 + ((REG[08h] bits [4:0]) + 4) × 8) × 2]Ts

4. t_{6min} = [(((REG[08h] bits [4:0]) × 2) × 8 + 17]Ts

5. t_{7min} = [(((REG[08h] bits [4:0]) × 2) × 8 + 26]Ts

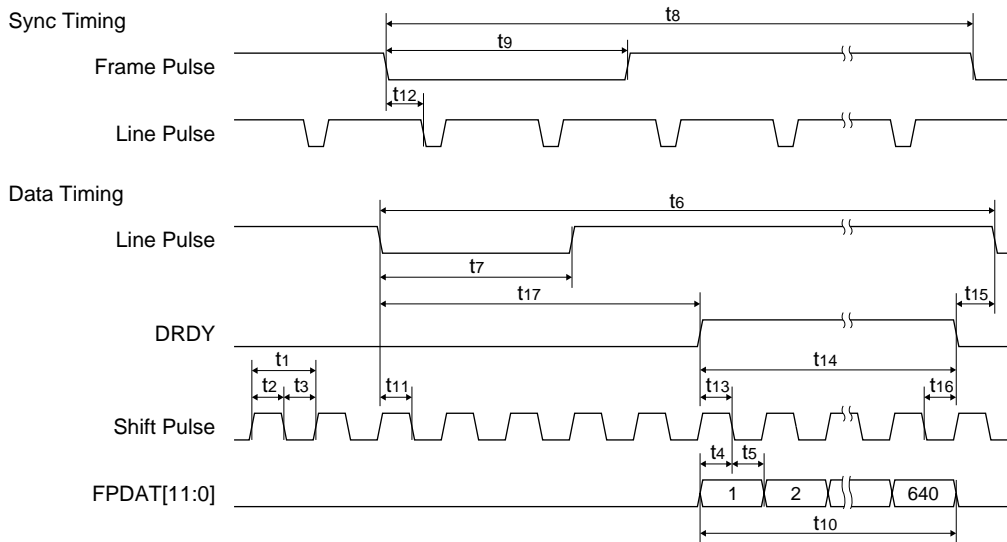
12-bit TFT/D-TFD panel timing



* DRDY is used to indicate the first pixel
 Example timing for a 12-bit 640 × 480 panel

- VDP = Vertical Display Period = (REG[06h] bits [1:0], REG[05h] bits [7:0]) + 1 Lines
- VNDP = Vertical Non-Display Period = VNDP1 + VNDP2 = REG[0Ah] bits [5:0] Lines
- VNDP1 = Vertical Non-Display Period 1 = REG[09h] bits [5:0] Lines
- VNDP2 = Vertical Non-Display Period 2 = (REG[0Ah] bits [5:0]) - (REG[09h] bits [5:0]) Lines
- HDP = Horizontal Display Period = ((REG[04h] bits [6:0]) + 1) × 8Ts
- HNDP = Horizontal Non-Display Period = HNDP1 + HNDP2 = (REG[08h] + 4) × 8Ts
- HNDP1 = Horizontal Non-Display Period 1 = ((REG[07h] bits [4:0]) × 8) + 16Ts
- HNDP2 = Horizontal Non-Display Period 2 = (((REG[08h] bits [4:0]) - (REG[07h] bits [4:0])) × 8) + 16Ts

8 ELECTRICAL CHARACTERISTICS



Note: DRDY is used to indicate the first pixel

TFT/D-TFD Panel AC Timing

Symbol	Parameter	Min.	Typ.	Max.	Unit
t_1	Shift Pulse period	1			(note 1)
t_2	Shift Pulse pulse width high	0.5			Ts
t_3	Shift Pulse pulse width low	0.5			Ts
t_4	Data setup to Shift Pulse falling edge	0.5			Ts
t_5	Data hold from Shift Pulse falling edge	0.5			Ts
t_6	Line Pulse cycle time	note 2			
t_7	Line Pulse pulse width low	9			Ts
t_8	Frame Pulse cycle time	note 3			
t_9	Frame Pulse pulse width low	$2t_6$			Ts
t_{10}	Horizontal display period	note 4			
t_{11}	Line Pulse setup to Shift Pulse falling edge	0.5			Ts
t_{12}	Frame Pulse falling edge to Line Pulse falling edge phase difference	$t_6 - 18Ts$			
t_{13}	DRDY to Shift Pulse falling edge setup time	0.5			Ts
t_{14}	DRDY pulse width	note 5			
t_{15}	DRDY falling edge to Line Pulse falling edge	note 6			
t_{16}	DRDY hold from Shift Pulse falling edge	0.5			Ts
t_{17}	Line Pulse falling edge to DRDY active	note 7		250	Ts

note) 1. Ts = pixel clock period

2. $t_{6min} = [((REG[04h] \text{ bits } [6:0]) + 1) \times 8 + ((REG[08h] \text{ bits } [4:0]) + 4) \times 8]Ts$

3. $t_{8min} = [((REG[06h] \text{ bits } [1:0], REG[05h] \text{ bits } [7:0]) + 1) + (REG[0Ah] \text{ bits } [6:0])]Lines$

4. $t_{10min} = [((REG[04h] \text{ bits } [6:0]) + 1) \times 8]Ts$

5. $t_{14min} = [((REG[04h] \text{ bits } [6:0]) + 1) \times 8]Ts$

6. $t_{15min} = [(REG[07h] \text{ bits } [4:0]) \times 8 + 16]Ts$

7. $t_{17min} = [(REG[08h] \text{ bits } [4:0]) - (REG[07h] \text{ bits } [4:0]) \times 8 + 16]Ts$

8.7 Oscillation Characteristics

Oscillation characteristics change depending on conditions (board pattern, components used, etc.). Use the following characteristics as reference values. In particular, when a ceramic or crystal oscillator is used, use the oscillator manufacturer recommended values for constants such as capacitance and resistance.

OSC1 crystal oscillation

(Unless otherwise specified: crystal=C-002RX#1 32.768kHz, Rf1=20MΩ, CG1=CD1=15pF#2)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Operating temperature	Ta	VDD=2.7V to 3.6V	-40		85	°C	
		VDD=1.9V to 2.2V	-40		85	°C	
		VDD=1.8V to 2.2V	0		70	°C	

#1 C-002RX: Crystal resonator made by Seiko Epson

#2 "CG1=CD1=15pF" includes board capacitance.

(Unless otherwise specified: VDD=3.3V, VSS=0V, crystal=C-002RX#1 32.768kHz, Rf1=20MΩ, CG1=CD1=15pF#2, Ta=25°C)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Oscillation start time	tSTA1				3	sec	
External gate/drain capacitance	CG1, CD1	CG1=CD1, including board capacitance	5		25	pF	
Frequency/IC deviation	Δf/ΔIC		-10		10	ppm	
Frequency/power voltage deviation	Δf/ΔV		-10		10	ppm/V	
Frequency adjustment range	Δf/ΔCG	CG=5 to 25pF	50			ppm	

#1 C-002RX: Crystal resonator made by Seiko Epson

#2 "CG1=CD1=15pF" includes board capacitance.

(Unless otherwise specified: VDD=2.0V, VSS=0V, crystal=C-002RX#1 32.768kHz, Rf1=20MΩ, CG1=CD1=15pF#2, Ta=25°C)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Oscillation start time	tSTA1				20	sec	
External gate/drain capacitance	CG1, CD1	CG1=CD1, including board capacitance	5		25	pF	
Frequency/IC deviation	Δf/ΔIC		-10		10	ppm	
Frequency/power voltage deviation	Δf/ΔV		-10		10	ppm/V	
Frequency adjustment range	Δf/ΔCG	CG=5 to 25pF	50			ppm	

#1 C-002RX: Crystal resonator made by Seiko Epson

#2 "CG1=CD1=15pF" includes board capacitance.

OSC3 crystal oscillation

Note: A "crystal resonator that uses a fundamental" should be used for the OSC3 crystal oscillation circuit.

(Unless otherwise specified: VDD=3.3V, VSS=0V, crystal=MA-306#1 33.8688MHz, Rf2=1MΩ, CG1=CD1=15pF#2, Ta=25°C)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Oscillation start time	tSTA3	VDD=3.3V			10	ms	
		VDD=2.0V			25	ms	

#1 MA-306: Crystal resonator made by Seiko Epson

#2 "CG1=CD1=15pF" includes board capacitance.

OSC3 ceramic oscillation

(Unless otherwise specified: $V_{SS}=0V$, $T_a=25^{\circ}C$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Oscillation start time	t_{STA3}	10MHz ceramic oscillator			10	ms	1
		16MHz ceramic oscillator			10	ms	2
		20MHz ceramic oscillator			10	ms	3
		25MHz ceramic oscillator			5	ms	4
		33MHz ceramic oscillator			5	ms	5

* note)	No.	Ceramic oscillator	Recommended constants			Power voltage range (V)	Remarks (Manufacturer)
			C_{G2} (pF)	C_{D2} (pF)	R_{f2} (M Ω)		
	1	CST10.0MTW	30	30	1	1.8 to 2.2	(Murata Mfg. corporation) *1
	2	CST16.00MXW0C1	5	5	1	1.8 to 2.2	(Murata Mfg. corporation)
	3	CST20.00MXW0H1	5	5	1	1.8 to 2.2	(Murata Mfg. corporation)
	4	CST25.00MXW0H1	5	5	1	2.7 to 3.6	(Murata Mfg. corporation)
	5	CST33.00MXZ040	Open	Open	1	2.7 to 3.6	(Murata Mfg. corporation)

*1 This oscillator has a tendency to rise to the frequency of 0.3%.

8.8 PLL Characteristics

Setting the PLLS0 and PLLS1 pins (recommended operating condition)

 $V_{DD}=2.7V$ to $3.6V$

PLLS1	PLLS0	Mode	Fin (OSC3 clock)	Fout
1	1	x2	10 to 25MHz	20 to 50MHz
0	1	x4	10 to 12.5MHz	40 to 50MHz
0	0	PLL not used	–	–

 $V_{DD}=2.0V\pm 0.2V$

PLLS1	PLLS0	Mode	Fin (OSC3 clock)	Fout
1	1	x2	10MHz	20MHz
0	0	PLL not used	–	–

PLL characteristics

(Unless otherwise specified: $V_{DD}=2.7V$ to $3.6V$, $V_{SS}=0V$, crystal oscillator=SG-8002#1, $R_1=4.7k\Omega$, $C_1=100pF$, $C_2=5pF$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Jitter (peak jitter)	t_{pj}		-1		1	ns	
Lockup time	t_{pll}				1	ms	

#1 SG-8002: Crystal oscillator made by Seiko Epson

(Unless otherwise specified: $V_{DD}=2.0V\pm 0.2V$, $V_{SS}=0V$, crystal oscillator=SG-8002#1, $R_1=4.7k\Omega$, $C_1=100pF$, $C_2=5pF$, $T_a=-40^{\circ}C$ to $+85^{\circ}C$)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	*
Jitter (peak jitter)	t_{pj}		-2		2	ns	
Lockup time	t_{pll}				2	ms	

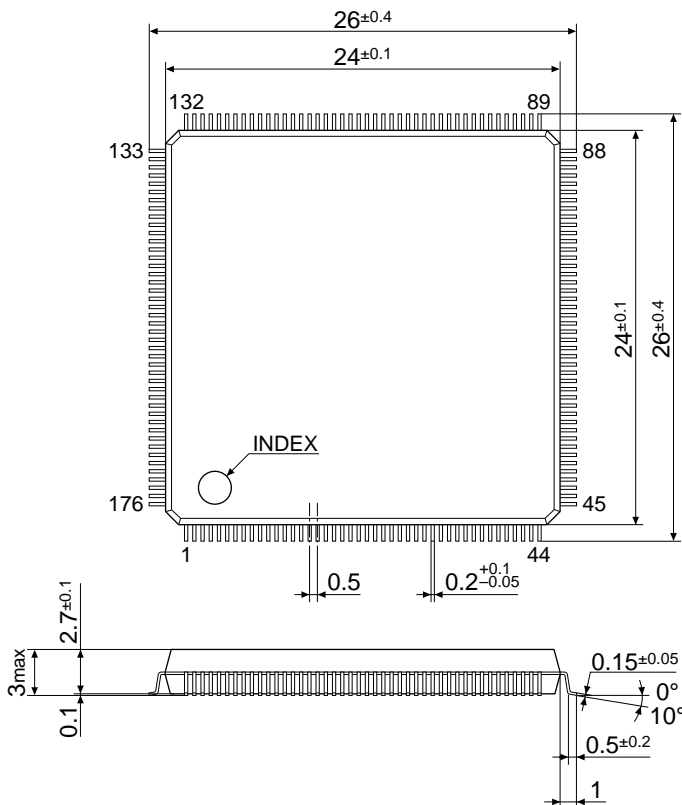
#1 SG-8002: Crystal oscillator made by Seiko Epson

9 Package

9.1 Plastic Package

QFP18-176pin

(Unit: mm)



Limit of power consumption

The chip temperature of an LSI rises according to power consumption. The chip temperature can be calculated from environment temperature (T_a), thermal resistance (θ) and power consumption (P_D).

$$\text{Chip temperature } (T_j) = T_a + (P_D \times \theta) \text{ (}^\circ\text{C)}$$

As a guide, normally keep the chip temperature (T_j) lower than 85°C .

The thermal resistance of the QFP18-176pin package is as follows:

$$\text{Thermal resistance } (^\circ\text{C/W}) = 105 \text{ to } 115^\circ\text{C (75 to } 85^\circ\text{C for Cu lead frame)}$$

This thermal resistance is a value under the condition that the measured device is hanging in the air and has no air-cooling. Thermal resistance greatly varies according to the mounting condition on the board and air-cooling condition.

Appendix A <Reference> External Device Interface Timings

This section shows setup examples for setting timing conditions of the external system interface as a reference material used when configuring a system with external devices.

Pay attention to the following precautions when using this material.

- The described AC characteristic values of external devices are standard values. They may differ from those of the devices actually used, so the actual setup values (number of cycles) should be determined by referring the manual or specification of the device to be used.
- It is necessary to set the timing values allowing ample margin according to the load capacitance of the bus and signal lines, number of devices to be connected, operating temperature range, I/O levels and other conditions. The number of cycles described in this section is an example and the conditions are not considered.
- The values described in "Time" column of the tables are simply calculated by multiplying the number of cycles by the cycle time. Conditions such as the output delay time of the device, delay due to wiring and load capacitance, and input setup time are not considered.
- The described contents are reference data and cannot be guaranteed to work.

A.1 DRAM (70ns)

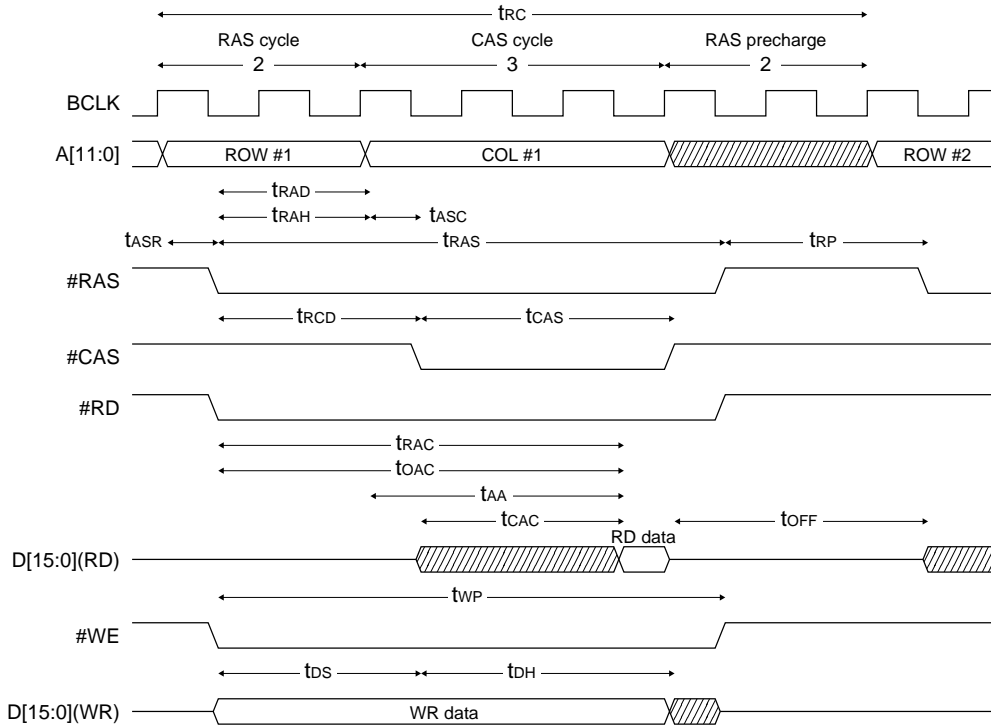
DRAM interface setup examples – 70ns

Operating frequency	RAS precharge cycle	RAS cycle	CAS cycle	Refresh RAS pulse width	Refresh RPC delay
20MHz	2	1	2	2	1
25MHz	2	1	2	2	1
33MHz	2	2	3	3	1

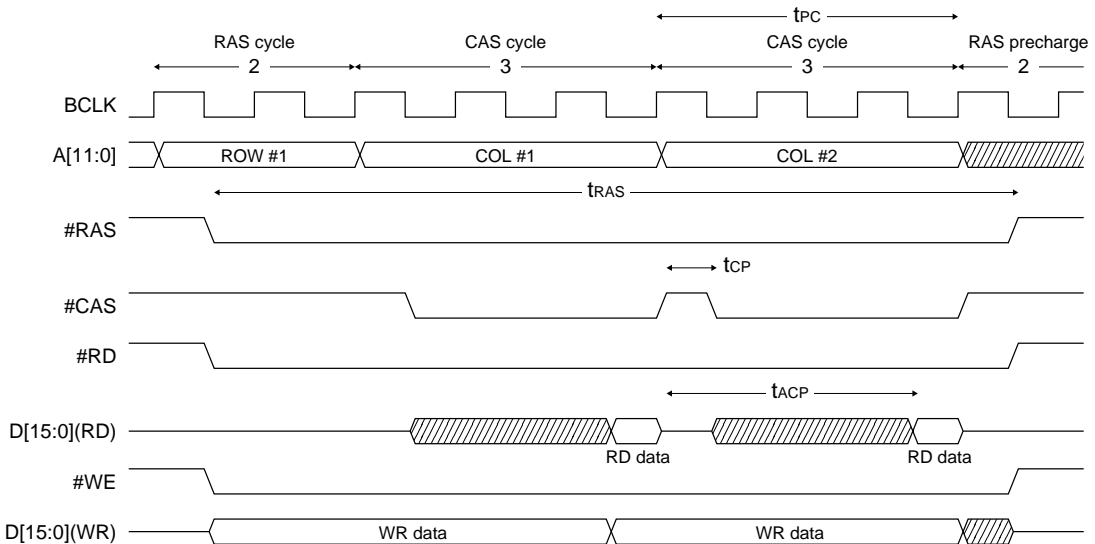
DRAM interface timing – 70ns

DRAM interface		Unit: ns		33MHz		25MHz		20MHz	
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
<Common parameters>									
Random read/random write cycle time	t _{RC}	130	–	7	210	5	200	5	250
#RAS precharge time	t _{RP}	50	–	2	60	2	80	2	100
#RAS pulse width	t _{RAS}	70	10000	5	150	3	120	3	150
#CAS pulse width	t _{CAS}	20	10000	2.5	75	1.5	60	1.5	75
Row address setup time	t _{ASR}	0	–	0.5	15	0.5	20	0.5	25
Row address hold time	t _{RAH}	10	–	1.5	45	0.5	20	0.5	25
Column address setup time	t _{ASC}	0	–	0.5	15	0.5	20	0.5	25
#RAS→#CAS delay time	t _{RCD}	20	–	2.0	60	1.0	40	1.0	50
#RAS→column address delay time	t _{RAD}	15	–	1.5	45	0.5	20	0.5	25
<Read-cycle parameters>									
#RAS access time	t _{RAC}	–	70	4.5	135	2.5	100	2.5	125
#CAS access time	t _{CAC}	–	20	2.5	75	1.5	60	1.5	75
Address access time	t _{AA}	–	35	3.0	90	2.0	80	2.0	100
#OE access time	t _{OAC}	–	20	4.5	135	2.5	100	2.5	125
Output buffer turn-off time	t _{OFF}	0	20	2	60	2	80	2	100
<Write-cycle parameters>									
Data input hold time	t _{DH}	15	–	2.5	75	1.5	60	1.5	75
<Fast-page mode>									
Fast-page mode cycle time	t _{PC}	45	–	3.0	90	2.0	80	2.0	100
Fast-page mode #CAS precharge time	t _{CP}	10	–	0.5	15	0.5	20	0.5	25
Access time after #CAS precharge	t _{ACP}	–	40	3.0	90	2.0	80	2.0	100
<Refresh cycle>									
#CAS setup time	t _{CSR}	10	–	1.0	30	1.0	40	1.0	50
#CAS hold time	t _{CHR}	10	–	2.5	75	1.5	60	1.5	75
#RAS precharge→#CAS hold time	t _{PPC}	10	–	1.0	30	1.0	40	1.0	50
#RAS pulse width (only in refresh cycle)	t _{RAS}	70	10000	3.0	90	2.0	80	2.0	100

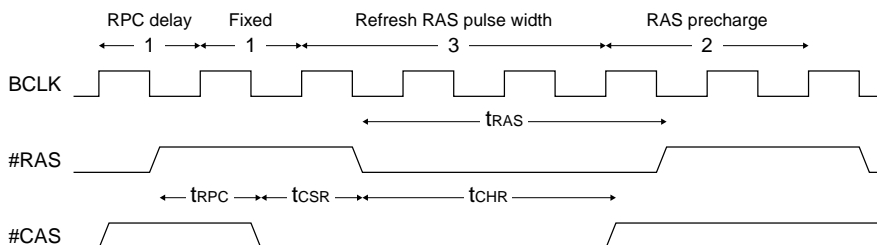
DRAM: 70ns, CPU: 33MHz, random read/write cycle



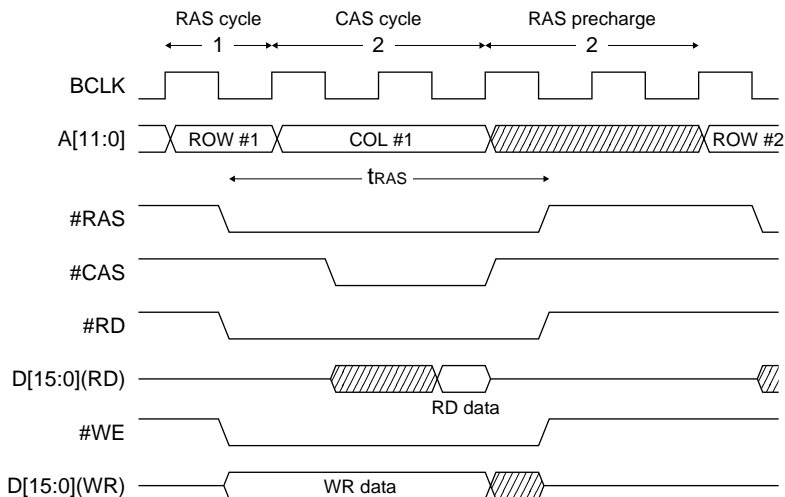
DRAM: 70ns, CPU: 33MHz, page-mode read/write cycle



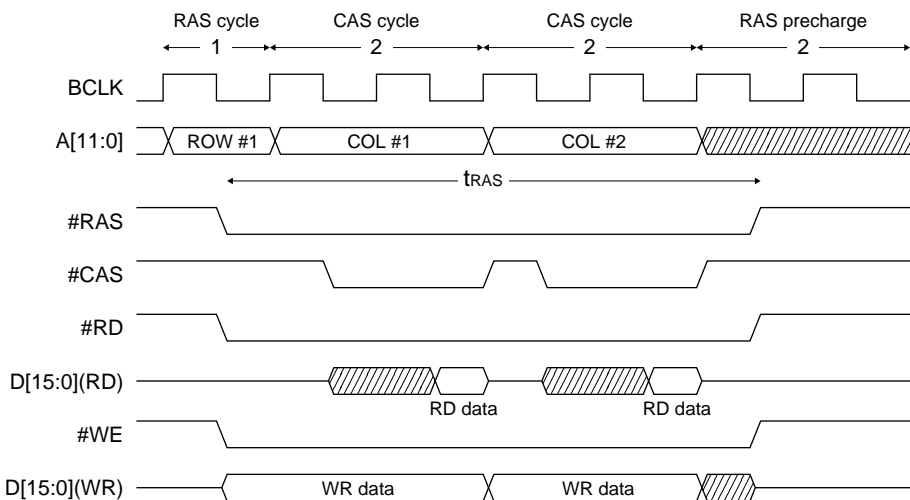
DRAM: 70ns, CPU: 33MHz, CAS-before-RAS refresh cycle



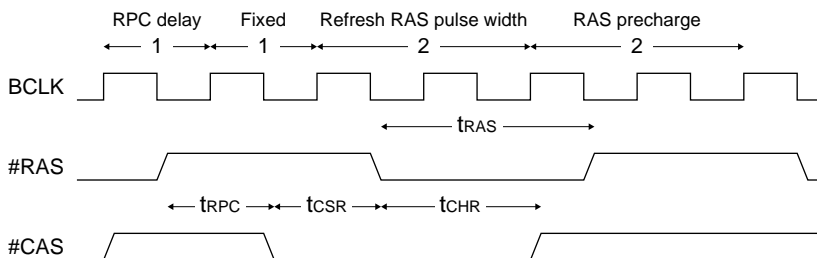
DRAM: 70ns, CPU: 25/20MHz, random read/write cycle



DRAM: 70ns, CPU: 25/20MHz, page-mode read/write cycle



DRAM: 70ns, CPU: 25/20MHz, CAS-before-RAS refresh cycle



A.2 DRAM (60ns)

DRAM interface setup examples – 60ns

Operating frequency	RAS precharge cycle	RAS cycle	CAS cycle	Refresh RAS pulse width	Refresh RPC delay
20MHz	1	1	2	2	1
25MHz	2	1	2	2	1
33MHz	2	2	2	3	1

DRAM interface timing – 60ns

DRAM interface Parameter	Unit: ns			33MHz		25MHz		20MHz	
	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time

<Common parameters>

Random read/random write cycle time	t _{RC}	110	–	6	180	5	200	4	200
#RAS precharge time	t _{RP}	40	–	2	60	2	80	1	50
#RAS pulse width	t _{RAS}	60	10000	4	120	3	120	3	150
#CAS pulse width	t _{CAS}	15	10000	1.5	45	1.5	60	1.5	75
Row address setup time	t _{ASR}	0	–	0.5	15	0.5	20	0.5	25
Row address hold time	t _{RAH}	10	–	1.5	45	0.5	20	0.5	25
Column address setup time	t _{ASC}	0	–	0.5	15	0.5	20	0.5	25
#RAS→#CAS delay time	t _{RCD}	20	–	2.0	60	1.0	40	1.0	50
#RAS→column address delay time	t _{RAD}	15	–	1.5	45	0.5	20	0.5	25

<Read-cycle parameters>

#RAS access time	t _{RAC}	–	60	3.5	105	2.5	100	2.5	125
#CAS access time	t _{CAC}	–	15	1.5	45	1.5	60	1.5	75
Address access time	t _{AA}	–	30	2.0	60	2.0	80	2.0	100
#OE access time	t _{OAC}	–	15	3.5	105	2.5	100	2.5	125
Output buffer turn-off time	t _{OFF}	0	15	2	60	2	80	1	50

<Write-cycle parameters>

Data input hold time	t _{DH}	10	–	1.5	45	1.5	60	1.5	75
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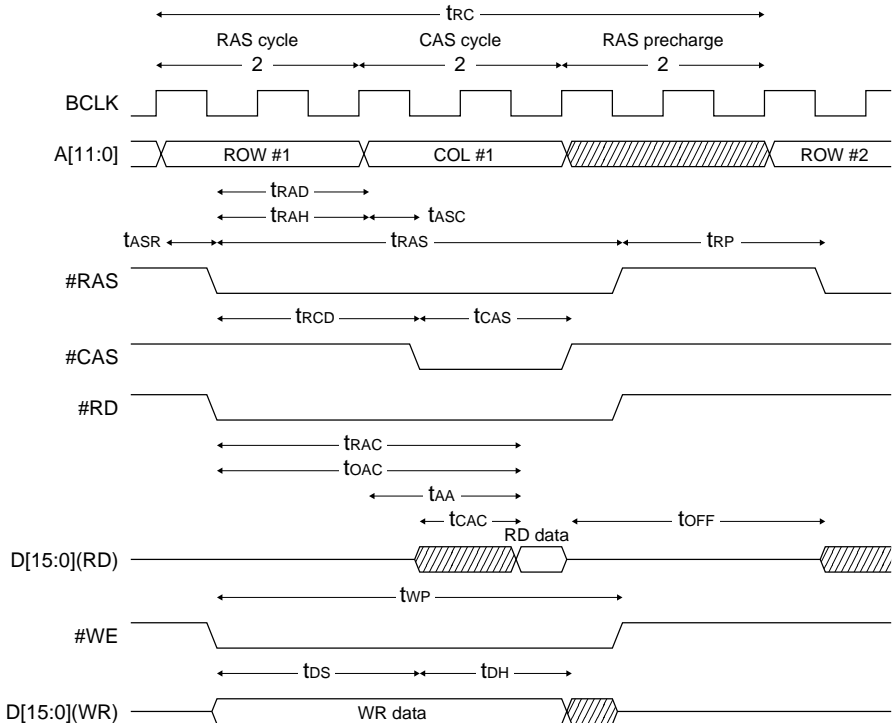
<Fast-page mode>

Fast-page mode cycle time	t _{PC}	40	–	2.0	60	2.0	80	2.0	100
Fast-page mode #CAS precharge time	t _{CP}	10	–	0.5	15	0.5	20	0.5	25
Access time after #CAS precharge	t _{ACP}	–	35	2.0	60	2.0	80	2.0	100

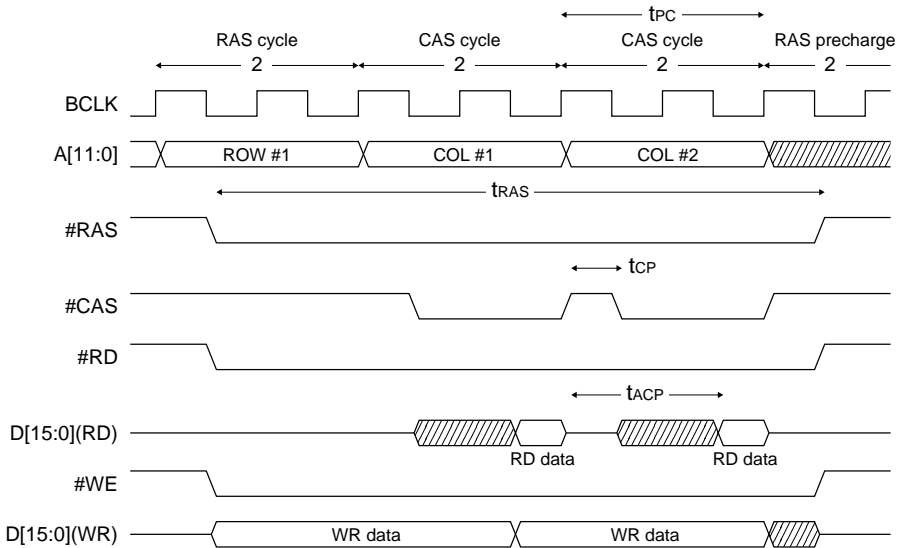
<Refresh cycle>

#CAS setup time	t _{CSR}	10	–	1.0	30	1.0	40	1.0	50
#CAS hold time	t _{CHR}	10	–	2.5	75	1.5	60	1.5	75
#RAS precharge→#CAS hold time	t _{PPC}	10	–	1.0	30	1.0	40	1.0	50
#RAS pulse width (only in refresh cycle)	t _{TRAS}	60	10000	3.0	90	2.0	80	2.0	100

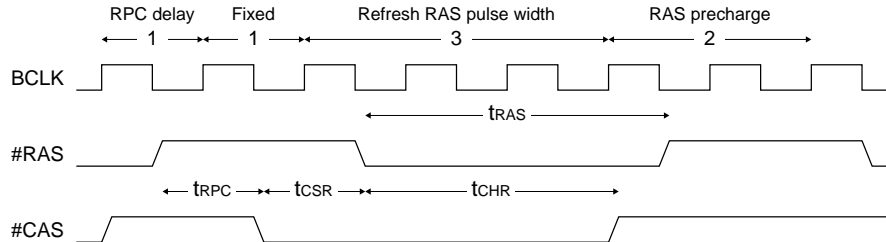
DRAM: 60ns, CPU: 33MHz, random read/write cycle



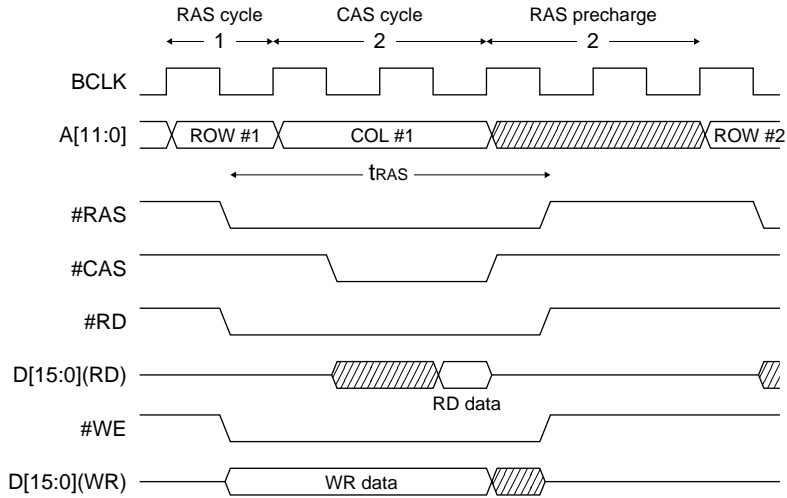
DRAM: 60ns, CPU: 33MHz, page-mode read/write cycle



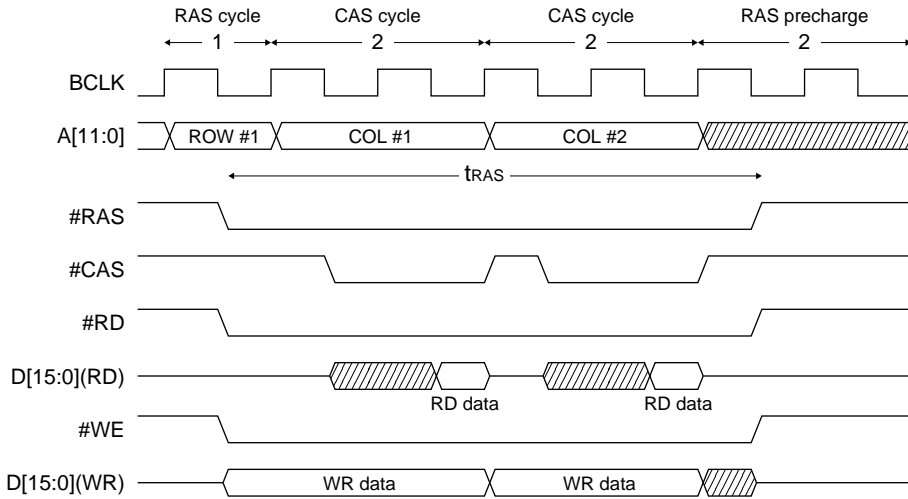
DRAM: 60ns, CPU: 33MHz, CAS-before-RAS refresh cycle



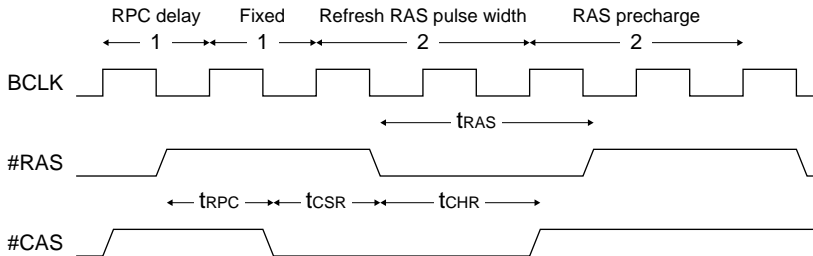
DRAM: 60ns, CPU: 25MHz, random read/write cycle



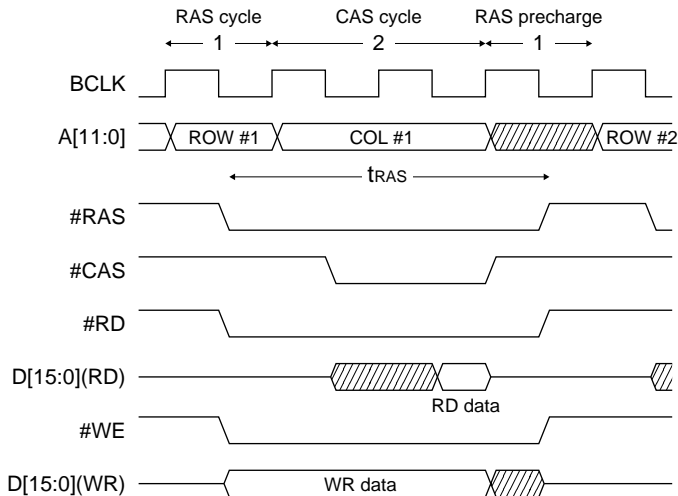
DRAM: 60ns, CPU: 25MHz, page-mode read/write cycle



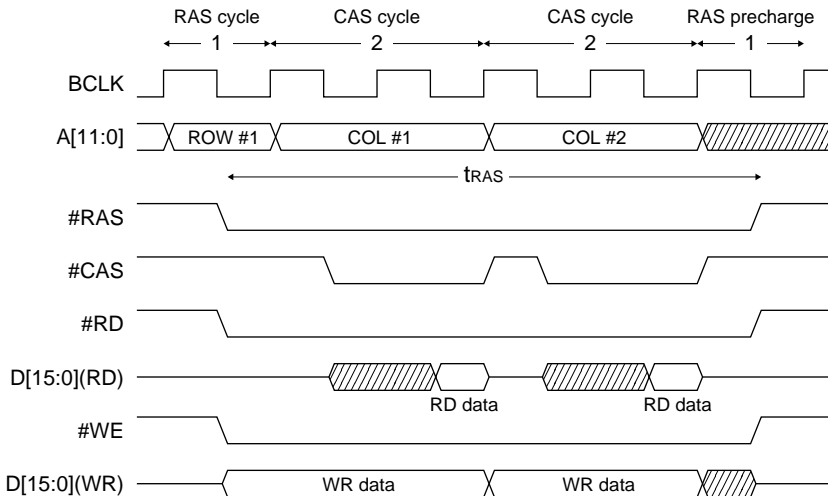
DRAM: 60ns, CPU: 25MHz, CAS-before-RAS refresh cycle



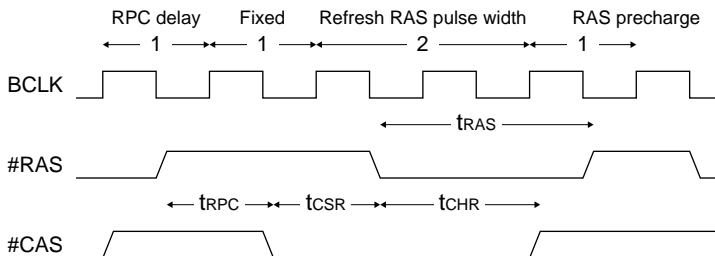
DRAM: 60ns, CPU: 20MHz, random read/write cycle



DRAM: 60ns, CPU: 20MHz, page-mode read/write cycle



DRAM: 60ns, CPU: 20MHz, CAS-before-RAS refresh cycle



A.3 ROM and Burst ROM

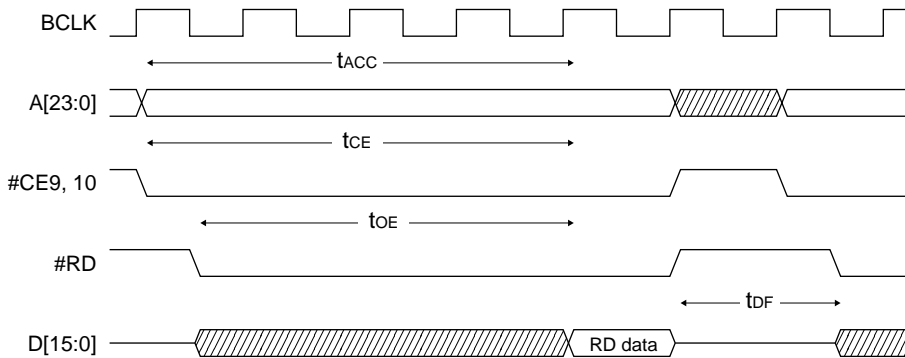
Burst ROM and mask ROM interface setup examples

Operating frequency	Normal read cycle		Burst read cycle		Output disable delay cycle
	Wait cycle	Read cycle	Wait cycle	Read cycle	
20MHz	2	3	1	2	1.5
25MHz	3	4	1	2	1.5
33MHz	4	5	2	3	1.5

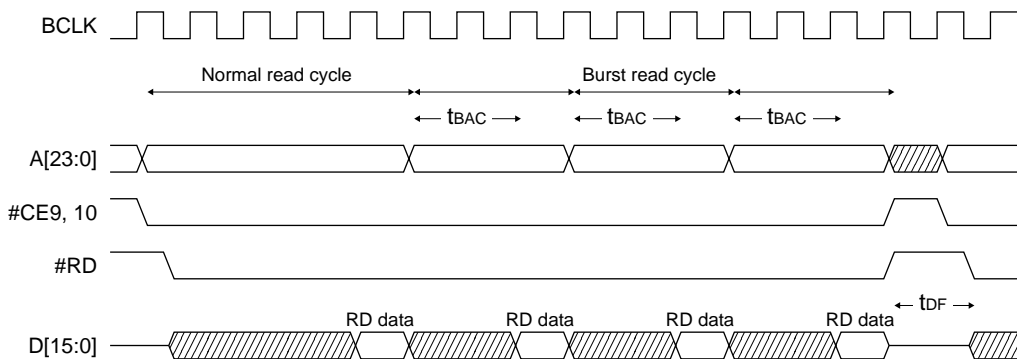
Burst ROM and mask ROM interface timing

Burst ROM and mask ROM interface				33MHz		25MHz		20MHz	
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
Access time	t _{ACC}	-	100	5	150	4	160	3	150
#CE output delay time	t _{CE}	-	100	5	150	4	160	3	150
#OE output delay time	t _{OE}	-	50	4.5	135	3.5	140	2.5	125
Burst access time	t _{BAC}	-	50	3	90	2	80	2	100
Output disable delay time	t _{DF}	0	40	1.5	45	1.5	60	1.5	75

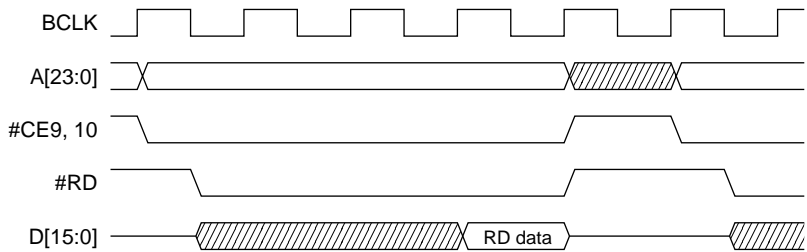
ROM: 100ns, CPU: 33MHz, normal read



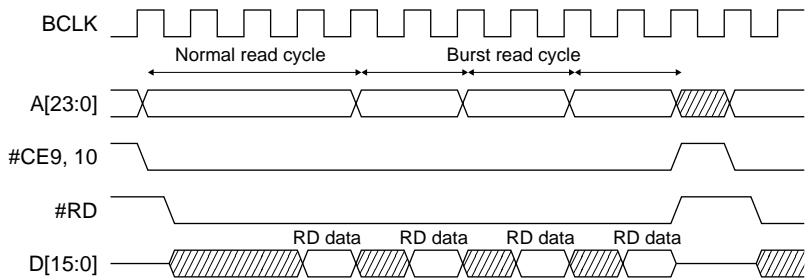
ROM: 100ns, CPU: 33MHz, burst read



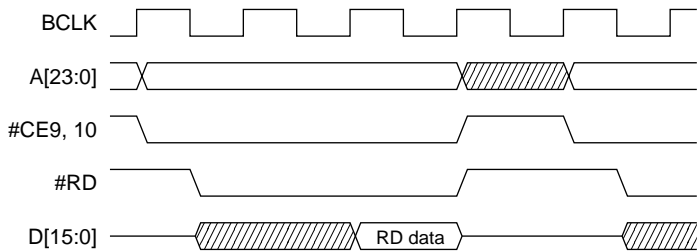
ROM: 100ns, CPU: 25MHz, normal read



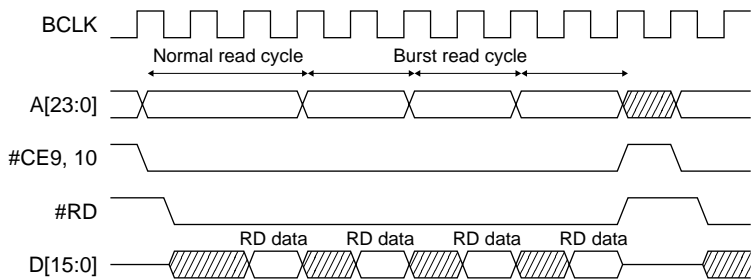
ROM: 100ns, CPU: 25MHz, burst read



ROM: 100ns, CPU: 20MHz, normal read



ROM: 100ns, CPU: 20MHz, burst read



A.4 SRAM (55ns)

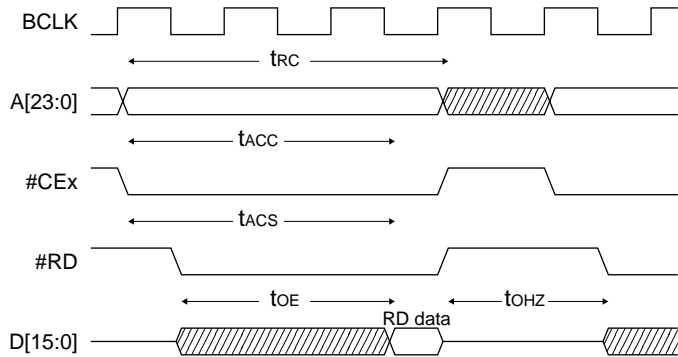
SRAM interface setup examples – 55ns

Operating frequency	Read cycle		Write cycle	Output disable delay time
	Wait cycle	Read cycle		
20MHz	1	2	2	1.5
25MHz	2	3	3	1.5
33MHz	2	3	3	1.5

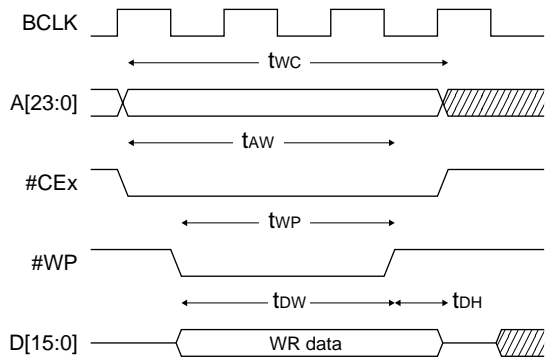
SRAM interface timing – 55ns

SRAM interface				33MHz		25MHz		20MHz	
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
<Read cycle>									
Read cycle time	t _{RC}	55	–	3	90	3	120	2	100
Address access time	t _{ACC}	–	55	3	90	3	120	2	100
#CE access time	t _{ACS}	–	55	3	90	3	120	2	100
#OE access time	t _{OE}	–	30	2.5	75	2.5	100	1.5	75
Output disable delay time	t _{OHZ}	0	30	1.5	45	1.5	60	1.5	75
<Write cycle>									
Write cycle time	t _{WC}	55	–	3	90	3	120	2	100
Address enable time	t _{AW}	50	–	2.5	75	2.5	100	1.5	75
Write pulse width	t _{WP}	45	–	2	60	2	80	1	50
Input data setup time	t _{DW}	30	–	2	60	2	80	1	50
Input data hold time	t _{DH}	0	–	0.5	15	0.5	20	0.5	25

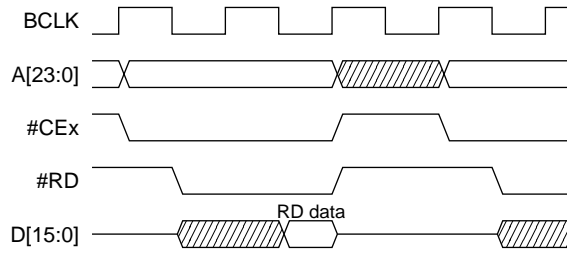
SRAM: 55ns, CPU: 33/25MHz, read cycle



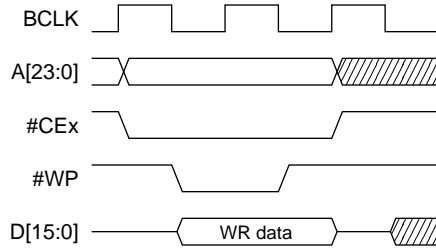
SRAM: 55ns, CPU: 33/25MHz, write cycle



SRAM: 55ns, CPU: 20MHz, read cycle



SRAM: 55ns, CPU: 20MHz, write cycle



A.5 SRAM (70ns)

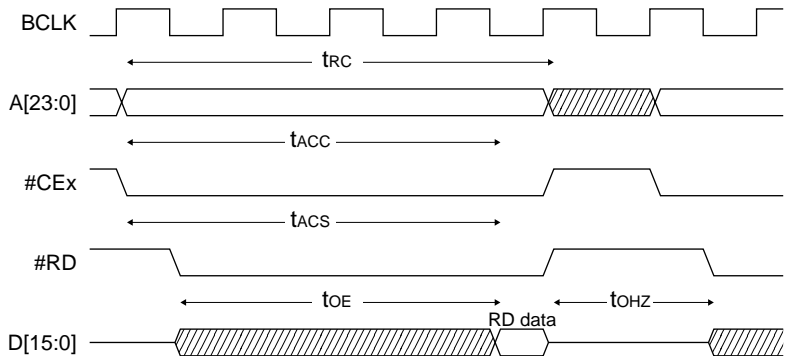
SRAM interface setup examples – 70ns

Operating frequency	Read cycle		Write cycle	Output disable delay time
	Wait cycle	Read cycle		
20MHz	2	3	3	1.5
25MHz	2	3	3	1.5
33MHz	3	4	4	1.5

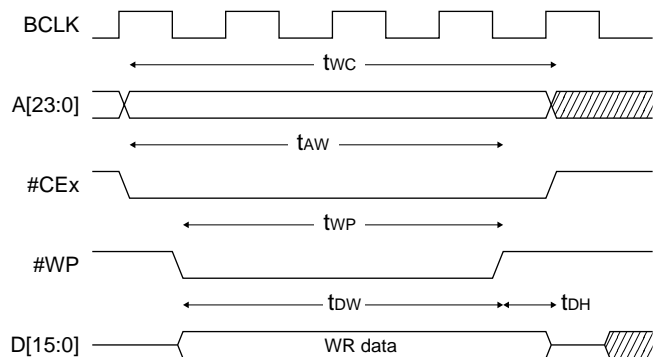
SRAM interface timing – 70ns

SRAM interface				33MHz		25MHz		20MHz	
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
<Read cycle>									
Read cycle time	t _{RC}	70	–	4	120	3	120	3	150
Address access time	t _{ACC}	–	70	4	120	3	120	3	150
#CE access time	t _{ACS}	–	70	4	120	3	120	3	150
#OE access time	t _{OE}	–	40	3.5	105	2.5	100	2.5	125
Output disable delay time	t _{OHZ}	0	30	1.5	45	1.5	60	1.5	75
<Write cycle>									
Write cycle time	t _{WC}	70	–	4	120	3	120	3	150
Address enable time	t _{AW}	60	–	3.5	105	2.5	100	2.5	125
Write pulse width	t _{WP}	55	–	3	90	2	80	2	100
Input data setup time	t _{DW}	30	–	3	90	2	80	2	100
Input data hold time	t _{DH}	0	–	0.5	15	0.5	20	0.5	25

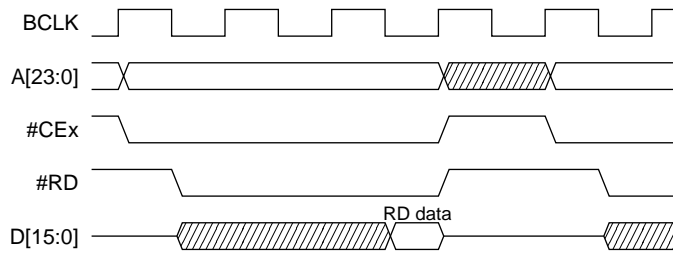
SRAM: 70ns, CPU: 33MHz, read cycle



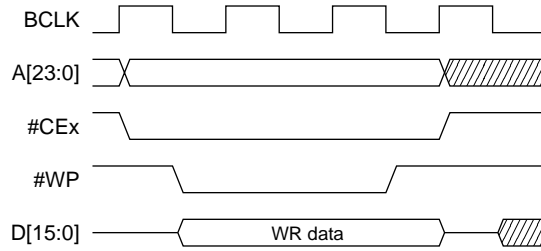
SRAM: 70ns, CPU: 33MHz, write cycle



SRAM: 70ns, CPU: 25/20MHz, read cycle



SRAM: 70ns, CPU: 25/20MHz, write cycle



A.6 8255A

8255A interface setup examples

Operating frequency	Read cycle		Write cycle	Output disable delay time
	Wait cycle	Read cycle		
20MHz	9 *1	10	10	3.5
25MHz	11	12	12	3.5
33MHz	14	15	15	3.5 *2

8255A interface timing

SRAM interface				33MHz		25MHz		20MHz	
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
<Read cycle>									
Read cycle time	t _{RC}	300	–	15	450	12	480	10	500
Address access time	t _{ACC}	–	250	15	450	12	480	10	500
#CE access time	t _{ACS}	–	250	15	450	12	480	10	500
#OE access time	t _{OE}	–	250	14.5	435	11.5	460	9.5	475
Output disable delay time	t _{OHZ}	10	150	3.5	105	3.5	140	3.5	175
<Write cycle>									
Write cycle time	t _{WC}	430	–	15	450	12	480	10	500
Address enable time	t _{AW}	400	–	14.5	435	11.5	460	9.5	475
Write pulse width	t _{WP}	400	–	14	420	11	440	9	450
Input data setup time	t _{DW}	100	–	14	420	11	440	9	450
Input data hold time	t _{DH}	30	–	0.5	15	0.5	20	0.5	25

*1 The E0C332L01 enables up to 7 cycles of wait-cycle insertion. If a number of wait cycles more than 7 cycles needs to be inserted, input the #WAIT signal from external hardware. Note that the interface must be set for SRAM type devices to insert wait cycles using the #WAIT pin. (Refer to "BCU (Bus Control Unit)" in the "E0C33 Block Technical Manual", for more information.)

*2 This setting cannot satisfy the 150 ns of output-disable delay time specification required for the 8255A. When implementing such a low-speed device in the system, the external bus must be separated by inserting a 3-state bus buffer at the output side (when viewed from the CPU) of the external system bus.

*3 If the data hold time that can be set is sufficient for the device, secure it by connecting a bus repeater to the external data bus D[15:0] or by inserting a latch at the output side of the external system interface.

Appendix B Pin Characteristics

Pin No.	Signal name	I/O cell name	Characteristic		Pull-up /down	Power supply	Remarks
			Input	Output			
1	A23	XHBC1T	note 1	Type1		V _{DDE1}	
2	A22	XHBC1T	note 1	Type1		V _{DDE1}	
3	A21	XHBC1T	note 1	Type1		V _{DDE1}	
4	A20	XHBC1T	note 1	Type1		V _{DDE1}	
5	V _{DDE1}	XHVDD					
6	A19	XHBC1T	note 1	Type1		V _{DDE1}	
7	A18	XHBC1T	note 1	Type1		V _{DDE1}	
8	A17	XHBC1T	note 1	Type1		V _{DDE1}	
9	A16	XHBC1T	note 1	Type1		V _{DDE1}	
10	A15	XHBC1T	note 1	Type1		V _{DDE1}	
11	V _{SS}	XVSS					
12	A14	XHBC1T	note 1	Type1		V _{DDE1}	
13	A13	XHBC1T	note 1	Type1		V _{DDE1}	
14	A12	XHBC1T	note 1	Type1		V _{DDE1}	
15	A11	XHBC1T	note 1	Type1		V _{DDE1}	
16	A10	XHBC1T	note 1	Type1		V _{DDE1}	
17	V _{DD}	XLVDD					
18	A9	XHBC1T	note 1	Type1		V _{DDE1}	
19	A8	XHBC1T	note 1	Type1		V _{DDE1}	
20	A7	XHBC1T	note 1	Type1		V _{DDE1}	
21	A6	XHBC1T	note 1	Type1		V _{DDE1}	
22	A5	XHBC1T	note 1	Type1		V _{DDE1}	
23	V _{SS}	XVSS					
24	A4	XHBC1T	note 1	Type1		V _{DDE1}	
25	A3	XHBC1T	note 1	Type1		V _{DDE1}	
26	A2	XHBC1T	note 1	Type1		V _{DDE1}	
27	A1	XHBC1T	note 1	Type1		V _{DDE1}	
28	A0/#BSL	XHBC1T	note 1	Type1		V _{DDE1}	
29	V _{DDE1}	XHVDD					
30	D15	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
31	D14	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
32	D13	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
33	D12	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
34	D11	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
35	V _{SS}	XVSS					
36	D10	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
37	D9	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
38	D8	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
39	D7	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
40	D6	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
41	V _{DD}	XLVDD					
42	D5	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
43	D4	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
44	D3	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
45	D2	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
46	D1	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
47	D0	XHBC1T	CMOS/LVTTL	Type1		V _{DDE1}	
48	V _{SS}	XVSS					
49	BCLK	XHTB1T		Type1		V _{DDE1}	
50	#EMEMRD	XHTB1T		Type1		V _{DDE1}	

APPENDIX B PIN CHARACTERISTICS

Pin No.	Signal name	I/O cell name	Characteristic		Pull-up /down	Power supply	Remarks
			Input	Output			
51	#RD	XHBC1T	note 1	Type1		V _{DDE1}	
52	#WRL/#WR/#WE	XHBC1T	note 1	Type1		V _{DDE1}	
53	#WRH/#BSH	XHBC1T	note 1	Type1		V _{DDE1}	
54	V _{DDE1}	XHVDD					
55	#CE10EX/#CE9&10EX	XHBC1T	note 1	Type1		V _{DDE1}	
56	#CE10IN	XHTB1T		Type1		V _{DDE1}	
57	#CE3	XHTB1T		Type1		V _{DDE1}	
58	V _{SS}	XVSS					
59	K67/AD7	XHIBCLIN	CMOS/LVTTL			AV _{DDE}	note 2
60	K66/AD6	XHIBCLIN	CMOS/LVTTL			AV _{DDE}	note 2
61	K65/AD5	XHIBCLIN	CMOS/LVTTL			AV _{DDE}	note 2
62	AV _{DDE}	XHVDD					
63	K64/AD4	XHIBCLIN	CMOS/LVTTL			AV _{DDE}	note 2
64	K63/AD3	XHIBCLIN	CMOS/LVTTL			AV _{DDE}	note 2
65	K62/AD2	XHIBCLIN	CMOS/LVTTL			AV _{DDE}	note 2
66	V _{SS}	XVSS					
67	K61/AD1	XHIBCLIN	CMOS/LVTTL			AV _{DDE}	note 2
68	K60/AD0	XHIBCLIN	CMOS/LVTTL			AV _{DDE}	note 2
69	K54/#DMAREQ3	XHIBHP2	CMOS/LVTTL SCHMITT		Pull-up	V _{DDE1}	
70	K53/#DMAREQ2	XHIBHP2	CMOS/LVTTL SCHMITT		Pull-up	V _{DDE1}	
71	K52/#ADTRG	XHIBHP2	CMOS/LVTTL SCHMITT		Pull-up	V _{DDE1}	
72	V _{DD}	XLVDD					
73	K51/#DMAREQ1	XHIBHP2	CMOS/LVTTL SCHMITT		Pull-up	V _{DDE1}	
74	K50/#DMAREQ0	XHIBHP2	CMOS/LVTTL SCHMITT		Pull-up	V _{DDE1}	
75	#LCAS	XHTB1T		Type1		V _{DDE1}	
76	#HCAS	XHTB1T		Type1		V _{DDE1}	
77	#CE9/#CE17/#CE17&18	XHBC1T	note 1	Type1		V _{DDE1}	
78	V _{SS}	XVSS					
79	#CE8/#RAS1/#CE14/#RAS3	XHBC1T	note 1	Type1		V _{DDE1}	
80	#CE7/#RAS0/#CE13/#RAS2	XHBC1T	note 1	Type1		V _{DDE1}	
81	#CE5/#CE15/#CE15&16	XHBC1T	note 1	Type1		V _{DDE1}	
82	#CE4/#CE11/#CE11&12	XHBC1T	note 1	Type1		V _{DDE1}	
83	#CE6/#CE7&8	XHBC1T	note 1	Type1		V _{DDE1}	
84	V _{DDE1}	XHVDD					
90	V _{SS}	XVSS					
91	GPIO0	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE2}	
92	FPDAT11/GPIO4/INVERSE	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
93	FPDAT10/GPIO3	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
94	FPDAT9/GPIO2	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
95	V _{DDE2}	XHVDD					
96	FPDAT8/GPIO1	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
97	FPSHIFT	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
98	FPDAT7	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
99	FPDAT6	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
100	FPDAT5	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
101	V _{DD}	XLVDD					
102	FPDAT4	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
103	FPDAT3	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
104	FPDAT2	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
105	FPDAT1	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
106	V _{SS}	XVSS					
107	FPDAT0	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
108	FPLINE	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
109	FPPFRAME	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	
110	DRDY/MOD/FPSHIFT2	XHBC3BT	CMOS/LVTTL	Type3		V _{DDE2}	

Pin No.	Signal name	I/O cell name	Characteristic		Pull-up /down	Power supply	Remarks
			Input	Output			
111	V _{DDE2}	XHVDD					
112	LCDPWR	XHTB1T		Type1		V _{DDE2}	
118	V _{SS}	XVSS					
119	P35/#BUSACK	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
120	P34/#BUSREQ/#CE6	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
121	P33/#DMAACK1	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
122	P32/#DMAACK0	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
123	P31/#BUSGET/#GARD	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
124	P30/#WAIT/#CE4&5	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
125	V _{DD}	XLVDD					
126	P27/TM5	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
127	P26/TM4	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
128	P25/TM3	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
129	P24/TM2	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
130	P23/TM1	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
131	V _{SS}	XVSS					
132	P22/TM0	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
133	P21/#DWE/#GAAS	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
134	P20/#DRD	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
135	P16/EXCL5/#DMAEND1	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
136	P15/EXCL4/#DMAEND0	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
137	V _{DDE1}	XHVDD					
138	P14/FOSC1/DCLK	XLBH2T	CMOS/LVTTL SCHMITT	Type2		V _{DD}	note 3
139	P13/EXCL3/T8UF3/DPCO	XLBH2T	CMOS/LVTTL SCHMITT	Type2		V _{DD}	note 3
140	P12/EXCL2/T8UF2/DST2	XLBH2T	CMOS/LVTTL SCHMITT	Type2		V _{DD}	note 3
141	P11/EXCL1/T8UF1/DST1	XLBH2T	CMOS/LVTTL SCHMITT	Type2		V _{DD}	note 3
142	P10/EXCL0/T8UF0/DST0	XLBH2T	CMOS/LVTTL SCHMITT	Type2		V _{DD}	note 3
143	V _{SS}	XVSS					
144	P07/#SRDY1/#DMAEND3	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
145	P06/#SCLK1/#DMAACK3	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
146	P05/SOUT1/#DMAEND2	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
147	P04/SIN1/#DMAACK2	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
148	V _{DD}	XLVDD					
149	OSC2	XLLOT				V _{DD}	
150	OSC1	XLLIN				V _{DD}	note 3
151	V _{SS}	XVSS					
152	P03/#SRDY0	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
153	P02/#SCLK0	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
154	P01/SOUT0	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
155	P00/SIN0	XHBH1T	CMOS/LVTTL SCHMITT	Type1		V _{DDE1}	
156	CNF3	XHIBC	CMOS/LVTTL			V _{DDE1}	
157	CKSEL2	XHIBC	CMOS/LVTTL			V _{DDE1}	
158	CKSEL1	XHIBC	CMOS/LVTTL			V _{DDE1}	
159	CKSEL0	XHIBC	CMOS/LVTTL			V _{DDE1}	
160	V _{DDE1}	XHVDD					
161	CLKI	XHIBC	CMOS/LVTTL			V _{DDE1}	
162	ICEMD	XITST1			Pull-down		Test pin
163	V _{SS}	XVSS					
164	OSC4	XLLOT				V _{DD}	
165	OSC3	XLLIN				V _{DD}	note 3
166	EA10MD1	XHIBCP2	CMOS/LVTTL		Pull-up	V _{DDE1}	
167	EA10MD0	XHIBC	CMOS/LVTTL			V _{DDE1}	
168	#X2SPD	XHIBC	CMOS/LVTTL			V _{DDE1}	
169	V _{DD}	XLVDD					

APPENDIX B PIN CHARACTERISTICS

Pin No.	Signal name	I/O cell name	Characteristic		Pull-up /down	Power supply	Remarks
			Input	Output			
170	PLLS1	XHIBC	CMOS/LVTTL			V _{DDE1}	
171	PLLS0	XHIBC	CMOS/LVTTL			V _{DDE1}	
172	#NMI	XHIBHP2	CMOS/LVTTL SCHMITT		Pull-up	V _{DDE1}	
173	V _{SS}	XVSS					
174	PLL _C	XLLIN					
175	#RESET	XHIBHP2	CMOS/LVTTL SCHMITT		Pull-up	V _{DDE1}	
176	DSIO	XLBH2P2T	CMOS/LVTTL SCHMITT	Type2	Pull-up	V _{DD}	note 3

note 1) This pin is set as an input pin during device testing. Normally it is an output pin.

note 2) The voltage applied to this pin must be $0V \leq V_{IN} \leq AV_{DDE}$.

note 3) The voltage applied to this pin must be $0V \leq V_{IN} \leq V_{DD}$.

The following table lists output current characteristics.

Output current (I_{OL}/I_{OH})

	5.0 V	3.3 V	2.0 V
Type1	3 mA	2 mA	0.6 mA
Type2	–	6 mA	2 mA
Type3	12 mA	12 mA	4 mA

E0C33 Block Technical Manual

E0C33 Block Technical Manual

I OUTLINE

I-1 INTRODUCTION

The C33 ASIC Macro is a library of macro cells including SEIKO EPSON original 32-bit CPU core E0C33000 and its various peripheral circuits. It is integrated on the SSL50000, SEIKO EPSON's 0.35 μm embedded ASIC Family. Since it shares common process technology, SRAM/ROM/Flash ASIC memory macro can also be integrated on the same chip. Thus SEIKO EPSON provides complete ASIC-microcomputer design environment. The C33 CPU architecture is RISC type. So the CPU core size is small but the instruction set is very strong to achieve small compiled-code size.

The C33 ASIC Macro has the following features:

- Small CPU core: 25K gates
- Fast and high performance: DC to 60 MHz operation
- Strong instruction set: 16-bit fixed length, 105 basic instructions
- Execution cycle: Major instructions are executed in 1 cycle per instruction
- MAC function: 16 bits \times 16 bits + 64 bits, 2 clock per MAC (25 MOPS in 50 MHz)
- Registers: 32 bits \times 16 general registers and 32 bits \times 5 special registers
- Memory space: 256M bytes (28 bits) linear space, code-data-IO shared type
- External bus I/F: 15 configurable memory areas
Direct connection to external memory
- Interrupts: Reset, NMI, up to 128 external interrupts, 4 software interrupts, 2 exceptions
- Reset, boot: Cold reset, hot reset
- Power down mode: Sleep, Halt
- Others: Little endian (partial big endian can be configured)
Harvard architecture (fetch, load/store parallel execution)
- User logic interface: Programmable wait state (up to 7 cycles)
#WAIT pin hand shake is possible.
Large memory space for the user logic (up to 16M bytes)
BCU configuration registers allow internal use of the external areas (Areas 4 to 18).
Many interrupt requests from the user logic are acceptable.

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I-2 BLOCK DIAGRAM

The C33 Macro Library consists of five major blocks: C33 Core Block, C33 Peripheral Block, C33 Analog Block, C33 DMA Block and C33 Internal Memory Block.

Figure I-2.1 shows the configuration of the C33 macro blocks.

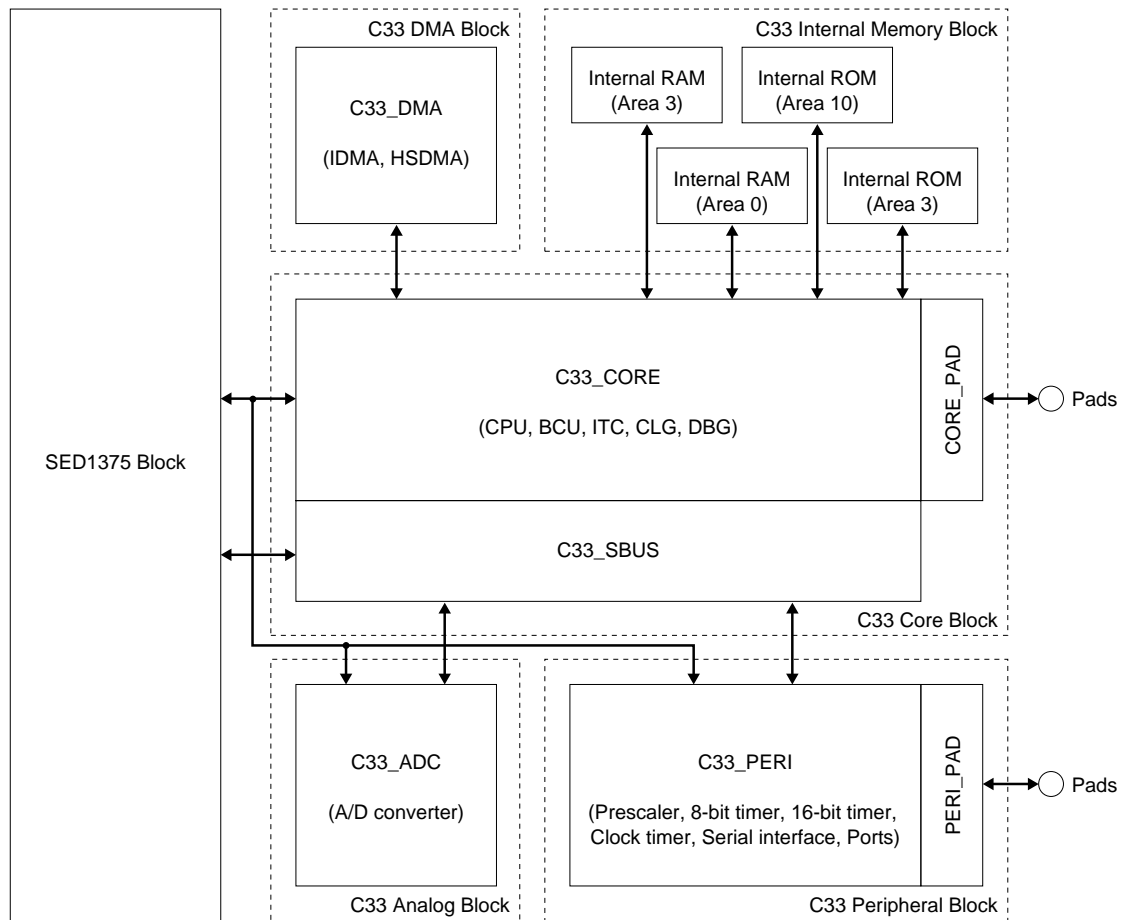


Figure I-2.1 Block Configuration

C33 Core Block

The C33 Core Block consists of a functional block C33_CORE including CPU, BCU (Bus Control Unit), ITC (Interrupt Controller), CLG (Clock Generator) and DBG (Debug Unit), an I/O pad block for external interface, and an SBUS (Internal Silicon Integration Bus) for interfacing with on-chip Peripheral Macro Cells.

The C33 Core Block employs the E0C33000 32-bit RISC type CPU as the core CPU.

C33 Peripheral Block

The C33 Peripheral Block consists of a prescaler, four channels of 8-bit programmable timer, six channels of 16-bit programmable timer including watchdog timer function, two channels of serial interface, input and I/O ports, and a clock timer.

C33 Analog Block

The analog block consists of an A/D converter with eight input channels.

C33 DMA Block

The DMA block is configured with two types of DMA controllers: HSDMA (High-Speed DMA) that has on-chip registers for controlling DMA command information and IDMA (Intelligent DMA) that uses a memory area for storing DMA command information.

C33 Memory Block

For the internal memory space (Areas 0, 3 and 10), SRAM, Flash or mask ROM are provided. The memory size can be decided according to the system.

User Block

The user can design custom blocks using the SSL50000 Series ASIC libraries.

For details of the blocks, refer to the respective section in this manual.

I-3 LIST OF PINS

List of External I/O Pins

The following lists the external I/O pins of the C33 Core Block and Peripheral Block. Note that some pins are listed in two or more tables.

Table I-3.1 List of Pins for External Bus Interface Signals

Pin name	I/O	Pull-up	Function
A0	O	–	A0: Address bus (A0) when SBUSST(D3/0x4812E) = "0" (default)
#BSL			#BSL: Bus strobe (low byte) signal when SBUSST(D3/0x4812E) = "1"
A[23:1]	O	–	Address bus (A1 to A23)
D[15:0]	I/O	–	Data bus (D0 to D15)
#CE10EX	O	–	Area 10 chip enable for external memory * When CEFUNC[1:0] = "1x", this pin outputs #CE9+#CE10EX signal.
#CE10IN	O	–	Area 10 chip enable for internal ROM emulation memory
#CE9	O	–	#CE9: Area 9 chip enable when CEFUNC[1:0](D[A:9])/0x48130 = "00" (default)
#CE17			#CE17: Area 17 chip enable when CEFUNC[1:0](D[A:9])/0x48130 = "01" * When CEFUNC[1:0] = "1x", this pin outputs #CE17+#CE18 signal.
#CE8	O	–	#CE8: Area 8 chip enable when CEFUNC[1:0](D[A:9])/0x48130 = "00"
#RAS1			and A8DRA(D8/0x48128) = "0" (default)
#CE14			#RAS1: Area 8 DRAM row strobe when CEFUNC[1:0](D[A:9])/0x48130 = "00"
#RAS3			and A8DRA(D8/0x48128) = "1"
			#CE14: Area 14 chip enable when CEFUNC[1:0](D[A:9])/0x48130 = "01" or "1x"
			and A14DRA(D8/0x48122) = "0"
			#RAS3: Area 14 DRAM row strobe when CEFUNC[1:0](D[A:9])/0x48130 = "01" or "1x"
			and A14DRA(D8/0x48122) = "1"
#CE7	O	–	#CE7: Area 7 chip enable when CEFUNC[1:0](D[A:9])/0x48130 = "00" and
#RAS0			A7DRA(D7/0x48128) = "0" (default)
#CE13			#RAS0: Area 7 DRAM row strobe when CEFUNC[1:0](D[A:9])/0x48130 = "00"
#RAS2			and A7DRA(D7/0x48128) = "1"
			#CE13: Area 13 chip enable when CEFUNC[1:0](D[A:9])/0x48130 = "01" or "1x"
			and A13DRA(D7/0x48122) = "0"
			#RAS2: Area 13 DRAM row strobe when CEFUNC[1:0](D[A:9])/0x48130 = "01" or "1x"
			and A13DRA(D7/0x48122) = "1"
#CE6	O	–	Area 6 chip enable * When CEFUNC[1:0] = "1x", this pin outputs #CE7+#CE8 signal.
#CE5	O	–	#CE5: Area 5 chip enable when CEFUNC[1:0](D[A:9])/0x48130 = "00" (default)
#CE15			#CE15: Area 15 chip enable when CEFUNC[1:0](D[A:9])/0x48130 = "01" * When CEFUNC[1:0] = "1x", this pin outputs #CE15+#CE16 signal.
#CE4	O	–	#CE4: Area 4 chip enable when CEFUNC[1:0](D[A:9])/0x48130 = "00" (default)
#CE11			#CE11: Area 11 chip enable when CEFUNC[1:0](D[A:9])/0x48130 = "01" * When CEFUNC[1:0] = "1x", this pin outputs #CE11+#CE12 signal.
#CE3	O	–	Area 3 chip enable
#RD	O	–	Read signal
#EMEMRD	O	–	Read signal for internal ROM emulation memory
#WRL	O	–	#WRL: Write (low byte) signal when SBUSST(D3/0x4812E) = "0" (default)
#WR			#WR: Write signal when SBUSST(D3/0x4812E) = "1"
#WE			#WE: DRAM write signal (default)
#WRH	O	–	#WRH: Write (high byte) signal when SBUSST(D3/0x4812E) = "0" (default)
#BSH			#BSH: Bus strobe (high byte) signal when SBUSST(D3/0x4812E) = "1"
#HCAS	O	–	#HCAS: DRAM column address strobe (high byte) signal
#LCAS	O	–	#LCAS: DRAM column address strobe (low byte) signal
BCLK	O	–	Bus clock output
P34	I	–	P34: I/O port when CFP34(D4/0x402DC) = "0" (default)
#BUSREQ			#BUSREQ: Bus release request input when CFP34(D4/0x402DC) = "1" and IOC34(D4/0x402DE) = "0"
#CE6			#CE6: Area 6 chip enable when CFP34(D4/0x402DC) = "1" and IOC34(D4/0x402DE) = "1"

I OUTLINE: LIST OF PINS

Pin name	I/O	Pull-up	Function
P35 #BUSACK	I/O	–	P35: I/O port when CFP35(D5/0x402DC) = "0" (default) #BUSACK: Bus acknowledge output when CFP35(D5/0x402DC) = "1"
P30 #WAIT #CE4&5	I/O	–	P30: I/O port when CFP30(D0/0x402DC) = "0" (default) #WAIT: Wait cycle request input when CFP30(D0/0x402DC) = "1" and IOC30(D0/0x402DE) = "0" #CE4&5: Areas 4&5 chip enable when CFP30(D0/0x402DC) = "1" and IOC30(D0/0x402DE) = "1"
P20 #DRD	I/O	–	P20: I/O port when CFP20(D0/0x402D8) = "0" (default) #DRD: DRAM read signal output for successive RAS mode when CFP20(D0/0x402D8) = "1"
P21 #DWE #GAAS	I/O		P21: I/O port when CFP21(D1/0x402D8) = "0" and CFEX2(D2/0x402DF) = "0" (default) #DWE: DRAM write signal output for successive RAS mode when CFP21(D1/0x402D8) = "1" and CFEX2(D2/0x402DF) = "0" #GAAS: Area address strobe output for GA when CFEX2(D2/0x402DF) = "1"
P31 #BUSGET #GARD	I/O		P31: I/O port when CFP31(D1/0x402DC) = "0" and CFEX3(D3/0x402DF) = "0" (default) #BUSGET: Bus status monitor signal output for bus request when CFP31(D1/0x402DC) = "1" and CFEX3(D3/0x402DF) = "0" #GARD: Area read signal output for GA when CFEX3(D3/0x402DF) = "1"
EA10MD1	I	With pull-up	Area 10 boot mode selection EA10MD1 EA10MD0 Mode 1 1 External ROM mode 1 0 Internal ROM mode 0 1 OTP mode 0 0 Internal ROM emulation
EA10MD0	I	–	
EA3MD	I	With pull-up	Area 3 mode selection 1: Internal ROM mode, 0: Emulation mode

Table I-3.2 List of Pins for HSDMA Control Signals

Pin name	I/O	Pull-up	Function
K50 #DMAREQ0	I	With pull-up	K50: Input port when CFK50(D0/0x402C0) = "0" (default) #DMAREQ0: HSDMA Ch. 0 request input when CFK50(D0/0x402C0) = "1"
K51 #DMAREQ1	I	With pull-up	K51: Input port when CFK51(D1/0x402C0) = "0" (default) #DMAREQ1: HSDMA Ch. 1 request input when CFK51(D1/0x402C0) = "1"
K53 #DMAREQ2	I	With pull-up	K53: Input port when CFK53(D3/0x402C0) = "0" (default) #DMAREQ2: HSDMA Ch. 2 request input when CFK53(D3/0x402C0) = "1"
K54 #DMAREQ3	I	With pull-up	K54: Input port when CFK54(D4/0x402C0) = "0" (default) #DMAREQ3: HSDMA Ch. 3 request input when CFK54(D4/0x402C0) = "1"
P32 #DMAACK0	I/O	–	P32: I/O port when CFP32(D2/0x402DC) = "0" (default) #DMAACK0: HSDMA Ch. 0 acknowledge output when CFP32(D2/0x402DC) = "1"
P33 #DMAACK1	I/O	–	P33: I/O port when CFP33(D3/0x402DC) = "0" (default) #DMAACK1: HSDMA Ch. 1 acknowledge output when CFP33(D3/0x402DC) = "1"
P04 SIN1 #DMAACK2	I/O	–	P04: I/O port when CFP04(D4/0x402D0) = "0" and CFEX4(D4/0x402DF) = "0" (default) SIN1: Serial I/F Ch. 1 data input when CFP04(D4/0x402D0) = "1" and CFEX4(D4/0x402DF) = "0" #DMAACK2: HSDMA Ch. 2 acknowledge output when CFEX4(D4/0x402DF) = "1"
P06 #SCLK1 #DMAACK3	I/O	–	P06: I/O port when CFP06(D6/0x402D0) = "0" and CFEX6(D6/0x402DF) = "0" (default) #SCLK1: Serial I/F Ch. 1 clock input/output when CFP06(D6/0x402D0) = "1" and CFEX6(D6/0x402DF) = "0" #DMAACK3: HSDMA Ch. 3 acknowledge output when CFEX6(D6/0x402DF) = "1"
P15 EXCL4 #DMAEND0	I/O	–	P15: I/O port when CFP15(D5/0x402D4) = "0" (default) EXCL4: 16-bit timer 4 event counter input when CFP15(D5/0x402D4) = "1" and IOC15(D5/0x402D6) = "0" #DMAEND0: HSDMA Ch. 0 end-of-transfer signal output when CFP15(D5/0x402D4) = "1" and IOC15(D5/0x402D6) = "1"
P16 EXCL5 #DMAEND1	I/O	–	P16: I/O port when CFP16(D6/0x402D4) = "0" (default) EXCL5: 16-bit timer 5 event counter input when CFP16(D6/0x402D4) = "1" and IOC16(D6/0x402D6) = "0" #DMAEND1: HSDMA Ch. 1 end-of-transfer signal output when CFP16(D6/0x402D4) = "1" and IOC16(D6/0x402D6) = "1"

Pin name	I/O	Pull-up	Function
P05 SOUT1 #DMAEND2	I/O	–	P05: I/O port when CFP05(D5/0x402D0) = "0" and CFEX5(D5/0x402DF) = "0" (default) SOUT1: Serial I/F Ch. 1 data output when CFP05(D5/0x402D0) = "1" and CFEX5(D5/0x402DF) = "0" #DMAEND2: HSDMA Ch. 2 end-of-transfer signal output when CFEX5(D5/0x402DF) = "1"
P07 #SRDY1 #DMAEND3	I/O	–	P07: I/O port when CFP07(D7/0x402D0) = "0" and CFEX7(D7/0x402DF) = "0" (default) #SRDY1: Serial I/F Ch. 1 ready signal output when CFP07(D7/0x402D0) = "1" and CFEX5(D5/0x402DF) = "0" #DMAEND3: HSDMA Ch. 3 end-of-transfer signal output when CFEX7(D7/0x402DF) = "1"

Table I-3.3 List of Pins for Internal Peripheral Circuits

Pin name	I/O	Pull-up	Function
K50 #DMAREQ0	I	With pull-up	K50: Input port when CFK50(D0/0x402C0) = "0" (default) #DMAREQ0: HSDMA Ch. 0 request input when CFK50(D0/0x402C0) = "1"
K51 #DMAREQ1	I	With pull-up	K51: Input port when CFK51(D1/0x402C0) = "0" (default) #DMAREQ1: HSDMA Ch. 1 request input when CFK51(D1/0x402C0) = "1"
K52 #ADTRG	I	With pull-up	K52: Input port when CFK52(D2/0x402C0) = "0" (default) #ADTRG: A/D converter trigger input when CFK52(D2/0x402C0) = "1"
K53 #DMAREQ2	I	With pull-up	K53: Input port when CFK53(D3/0x402C0) = "0" (default) #DMAREQ2: HSDMA Ch. 2 request input when CFK53(D3/0x402C0) = "1"
K54 #DMAREQ3	I	With pull-up	K54: Input port when CFK54(D4/0x402C0) = "0" (default) #DMAREQ3: HSDMA Ch. 3 request input when CFK54(D4/0x402C0) = "1"
K60 AD0	I	–	K60: Input port when CFK60(D0/0x402C3) = "0" (default) AD0: A/D converter Ch. 0 input when CFK60(D0/0x402C3) = "1"
K61 AD1	I	–	K61: Input port when CFK61(D1/0x402C3) = "0" (default) AD1: A/D converter Ch. 1 input when CFK61(D1/0x402C3) = "1"
K62 AD2	I	–	K62: Input port when CFK62(D2/0x402C3) = "0" (default) AD2: A/D converter Ch. 2 input when CFK62(D2/0x402C3) = "1"
K63 AD3	I	–	K63: Input port when CFK63(D3/0x402C3) = "0" (default) AD3: A/D converter Ch. 3 input when CFK63(D3/0x402C3) = "1"
K64 AD4	I	–	K64: Input port when CFK64(D4/0x402C3) = "0" (default) AD4: A/D converter Ch. 4 input when CFK64(D4/0x402C3) = "1"
K65 AD5	I	–	K65: Input port when CFK65(D5/0x402C3) = "0" (default) AD5: A/D converter Ch. 5 input when CFK65(D5/0x402C3) = "1"
K66 AD6	I	–	K66: Input port when CFK66(D6/0x402C3) = "0" (default) AD6: A/D converter Ch. 6 input when CFK66(D6/0x402C3) = "1"
K67 AD7	I	–	K67: Input port when CFK67(D7/0x402C3) = "0" (default) AD7: A/D converter Ch. 7 input when CFK67(D7/0x402C3) = "1"
P00 SIN0	I/O	–	P00: I/O port when CFP00(D0/0x402D0) = "0" (default) SIN0: Serial I/F Ch. 0 data input when CFP00(D0/0x402D0) = "1"
P01 SOUT0	I/O	–	P01: I/O port when CFP01(D1/0x402D0) = "0" (default) SOUT0: Serial I/F Ch. 0 data output when CFP01(D1/0x402D0) = "1"
P02 #SCLK0	I/O	–	P02: I/O port when CFP02(D2/0x402D0) = "0" (default) #SCLK0: Serial I/F Ch. 0 clock input/output when CFP02(D2/0x402D0) = "1"
P03 #SRDY0	I/O	–	P03: I/O port when CFP03(D3/0x402D0) = "0" (default) #SRDY0: Serial I/F Ch. 0 ready signal output when CFP03(D3/0x402D0) = "1"
P04 SIN1 #DMAACK2	I/O	–	P04: I/O port when CFP04(D4/0x402D0) = "0" and CFEX4(D4/0x402DF) = "0" (default) SIN1: Serial I/F Ch. 1 data input when CFP04(D4/0x402D0) = "1" and CFEX4(D4/0x402DF) = "0" #DMAACK2: HSDMA Ch. 2 acknowledge output when CFEX4(D4/0x402DF) = "1"
P05 SOUT1 #DMAEND2	I/O	–	P05: I/O port when CFP05(D5/0x402D0) = "0" and CFEX5(D5/0x402DF) = "0" (default) SOUT1: Serial I/F Ch. 1 data output when CFP05(D5/0x402D0) = "1" and CFEX5(D5/0x402DF) = "0" #DMAEND2: HSDMA Ch. 2 end-of-transfer signal output when CFEX5(D5/0x402DF) = "1"

I OUTLINE: LIST OF PINS

Pin name	I/O	Pull-up	Function
P06 #SCLK1 #DMAACK3	I/O	–	P06: I/O port when CFP06(D6/0x402D0) = "0" and CFEX6(D6/0x402DF) = "0" (default) #SCLK1: Serial I/F Ch. 1 clock input/output when CFP06(D6/0x402D0) = "1" and CFEX6(D6/0x402DF) = "0" #DMAACK3: HSDMA Ch. 3 acknowledge output when CFEX6(D6/0x402DF) = "1"
P07 #SRDY1 #DMAEND3	I/O	–	P07: I/O port when CFP07(D7/0x402D0) = "0" and CFEX7(D7/0x402DF) = "0" (default) #SRDY1: Serial I/F Ch. 1 ready signal output when CFP07(D7/0x402D0) = "1" and CFEX5(D5/0x402DF) = "0" #DMAEND3: HSDMA Ch. 3 end-of-transfer signal output when CFEX7(D7/0x402DF) = "1"
P10 EXCL0 T8UF0 DST0	I/O	–	P10: I/O port when CFP10(D0/0x402D4) = "0" and CFEX1(D1/0x402DF) = "0" EXCL0: 16-bit timer 0 event counter input when CFP10(D0/0x402D4) = "1", IOC10(D0/0x402D6) = "0" and CFEX1(D1/0x402DF) = "0" T8UF0: 8-bit timer 0 output when CFP10(D0/0x402D4) = "1", IOC10(D0/0x402D6) = "1" and CFEX1(D1/0x402DF) = "0" DST0: DST0 signal output when CFEX1(D1/0x402DF) = "1" (default)
P11 EXCL1 T8UF1 DST1	I/O	–	P11: I/O port when CFP11(D1/0x402D4) = "0" and CFEX1(D1/0x402DF) = "0" EXCL1: 16-bit timer 1 event counter input when CFP11(D1/0x402D4) = "1", IOC11(D1/0x402D6) = "0" and CFEX1(D1/0x402DF) = "0" T8UF1: 8-bit timer 1 output when CFP11(D1/0x402D4) = "1", IOC11(D1/0x402D6) = "1" and CFEX1(D1/0x402DF) = "0" DST1: DST1 signal output when CFEX1(D1/0x402DF) = "1" (default)
P12 EXCL2 T8UF2 DST2	I/O	–	P12: I/O port when CFP12(D2/0x402D4) = "0" and CFEX0(D0/0x402DF) = "0" EXCL2: 16-bit timer 2 event counter input when CFP12(D2/0x402D4) = "1", IOC12(D2/0x402D6) = "0" and CFEX0(D0/0x402DF) = "0" T8UF2: 8-bit timer 2 output when CFP12(D2/0x402D4) = "1", IOC12(D2/0x402D6) = "1" and CFEX0(D0/0x402DF) = "0" DST2: DST2 signal output when CFEX0(D0/0x402DF) = "1" (default)
P13 EXCL3 T8UF3 DPCO	I/O	–	P13: I/O port when CFP13(D3/0x402D4) = "0" and CFEX1(D1/0x402DF) = "0" EXCL3: 16-bit timer 3 event counter input when CFP13(D3/0x402D4) = "1", IOC13(D3/0x402D6) = "0" and CFEX1(D1/0x402DF) = "0" T8UF3: 8-bit timer 3 output when CFP13(D3/0x402D4) = "1", IOC13(D3/0x402D6) = "1" and CFEX1(D1/0x402DF) = "0" DPCO: DPCO signal output when CFEX1(D1/0x402DF) = "1" (default)
P14 FOSC1 DCLK	I/O	–	P14: I/O port when CFP14(D4/0x402D4) = "0" and CFEX0(D0/0x402DF) = "0" FOSC1: OSC1 clock output when CFP14(D4/0x402D4) = "1" and CFEX0(D0/0x402DF) = "0" DCLK: DCLK signal output when CFEX0(D0/0x402DF) = "1" (default)
P15 EXCL4 #DMAEND0	I/O	–	P15: I/O port when CFP15(D5/0x402D4) = "0" (default) EXCL4: 16-bit timer 4 event counter input when CFP15(D5/0x402D4) = "1" and IOC15(D5/0x402D6) = "0" #DMAEND0: HSDMA Ch. 0 end-of-transfer signal output when CFP15(D5/0x402D4) = "1" and IOC15(D5/0x402D6) = "1"
P16 EXCL5 #DMAEND1	I/O	–	P16: I/O port when CFP16(D6/0x402D4) = "0" (default) EXCL5: 16-bit timer 5 event counter input when CFP16(D6/0x402D4) = "1" and IOC16(D6/0x402D6) = "0" #DMAEND1: HSDMA Ch. 1 end-of-transfer signal output when CFP16(D6/0x402D4) = "1" and IOC16(D6/0x402D6) = "1"
P20 #DRD	I/O	–	P20: I/O port when CFP20(D0/0x402D8) = "0" (default) #DRD: DRAM read signal output for successive RAS mode when CFP20(D0/0x402D8) = "1"
P21 #DWE #GAAS	I/O		P21: I/O port when CFP21(D1/0x402D8) = "0" and CFEX2(D2/0x402DF) = "0" (default) #DWE: DRAM write signal output for successive RAS mode when CFP21(D1/0x402D8) = "1" and CFEX2(D2/0x402DF) = "0" #GAAS: Area address strobe output for GA when CFEX2(D2/0x402DF) = "1"
P22 TM0	I/O	–	P22: I/O port when CFP22(D2/0x402D8) = "0" (default) TM0: 16-bit timer 0 output when CFP22(D2/0x402D8) = "1"
P23 TM1	I/O	–	P23: I/O port when CFP23(D3/0x402D8) = "0" (default) TM1: 16-bit timer 1 output when CFP23(D3/0x402D8) = "1"
P24 TM2	I/O	–	P24: I/O port when CFP24(D4/0x402D8) = "0" (default) TM2: 16-bit timer 2 output when CFP24(D4/0x402D8) = "1"

Pin name	I/O	Pull-up	Function
P25 TM3	I/O	–	P25: I/O port when CFP25(D5/0x402D8) = "0" (default) TM3: 16-bit timer 3 output when CFP25(D5/0x402D8) = "1"
P26 TM4	I/O	–	P26: I/O port when CFP26(D6/0x402D8) = "0" (default) TM4: 16-bit timer 4 output when CFP26(D6/0x402D8) = "1"
P27 TM5	I/O	–	P27: I/O port when CFP27(D7/0x402D8) = "0" (default) TM5: 16-bit timer 5 output when CFP27(D7/0x402D8) = "1"
P31 #BUSGET #GARD	I/O		P31: I/O port when CFP31(D1/0x402DC) = "0" and CFEX3(D3/0x402DF) = "0" (default) #BUSGET: Bus status monitor signal output for bus request when CFP31(D1/0x402DC) = "1" and CFEX3(D3/0x402DF) = "0" #GARD: Area read signal output for GA when CFEX3(D3/0x402DF) = "1"
P32 #DMAACK0	I/O	–	P32: I/O port when CFP32(D2/0x402DC) = "0" (default) #DMAACK0: HSDMA Ch. 0 acknowledge output when CFP32(D2/0x402DC) = "1"
P33 #DMAACK1	I/O	–	P33: I/O port when CFP33(D3/0x402DC) = "0" (default) #DMAACK1: HSDMA Ch. 1 acknowledge output when CFP33(D3/0x402DC) = "1"
P34 #BUSREQ #CE6	I	–	P34: I/O port when CFP34(D4/0x402DC) = "0" (default) #BUSREQ: Bus release request input when CFP34(D4/0x402DC) = "1" and IOC34(D4/0x402DE) = "0" #CE6: Area 6 chip enable when CFP34(D4/0x402DC) = "1" and IOC34(D4/0x402DE) = "1"
P35 #BUSACK	I/O	–	P35: I/O port when CFP35(D5/0x402DC) = "0" (default) #BUSACK: Bus acknowledge output when CFP35(D5/0x402DC) = "1"

Table I-3.4 List of Pins for Clock Generator and Oscillation Circuits

Pin name	I/O	Pull-up	Function																										
OSC1	I	–	Low-speed (OSC1) oscillation input (32 kHz crystal oscillator or external clock input)																										
OSC2	O	–	Low-speed (OSC1) oscillation output																										
OSC3	I	–	High-speed (OSC3) oscillation input (crystal/ceramic oscillator or external clock input)																										
OSC4	O	–	High-speed (OSC3) oscillation output																										
PLLS[1:0]	I	–	PLL set-up pins <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th>PLLS1</th> <th>PLLS0</th> <th>fin (fosc3)</th> <th>fout (fpSCIN)</th> <th></th> </tr> </thead> <tbody> <tr> <td rowspan="2">1</td> <td rowspan="2">1</td> <td>10–30MHz</td> <td>20–60MHz</td> <td>*1</td> </tr> <tr> <td>10–25MHz</td> <td>20–50MHz</td> <td>*2</td> </tr> <tr> <td rowspan="2">0</td> <td rowspan="2">1</td> <td>10–15MHz</td> <td>40–60MHz</td> <td>*1</td> </tr> <tr> <td>10–12.5MHz</td> <td>40–50MHz</td> <td>*2</td> </tr> <tr> <td>0</td> <td>0</td> <td colspan="2">PLL is not used</td> <td>L</td> </tr> </tbody> </table> <p>*1: ROM-less model with 3.3 V ± 0.3 V operating voltage *2: ROM built-in model, or 3.0 V ± 0.3 V operating voltage</p>	PLLS1	PLLS0	fin (fosc3)	fout (fpSCIN)		1	1	10–30MHz	20–60MHz	*1	10–25MHz	20–50MHz	*2	0	1	10–15MHz	40–60MHz	*1	10–12.5MHz	40–50MHz	*2	0	0	PLL is not used		L
PLLS1	PLLS0	fin (fosc3)	fout (fpSCIN)																										
1	1	10–30MHz	20–60MHz	*1																									
		10–25MHz	20–50MHz	*2																									
0	1	10–15MHz	40–60MHz	*1																									
		10–12.5MHz	40–50MHz	*2																									
0	0	PLL is not used		L																									
PLLC	–	–	Capacitor connecting pin for PLL																										

Table I-3.5 List of Other Pins

Pin name	I/O	Pull-up/down	Function
ICEMD	I	With pull-down	High-impedance control input pin When this pin is set to High, all the output pins go into high-impedance state. This makes it possible to disable the E0C33 chip on the board.
DSIO	I/O	With pull-up	Serial I/O pin for debugging This pin is used to communicate with the debugging tool ICD33.
#X2SPD	I	–	Clock doubling mode set-up pin 1: CPU clock = bus clock x 1, 0: CPU clock = bus clock x 2
#NMI	I	With pull-up	NMI request input pin
#RESET	I	With pull-up	Initial reset input pin

Note: "#" in the pin names indicates that the signal is low active.

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E0C33 Block Technical Manual

II CORE BLOCK

II-1 INTRODUCTION

The core block consists of a functional block C33_CORE including CPU, BCU (Bus Control Unit), ITC (Interrupt Controller), CLG (Clock Generator) and DBG (Debug Unit), an I/O pad block for external interface, and an SBUS (Internal Silicon Integration Bus) for interfacing with on-chip Peripheral Macro Cells.

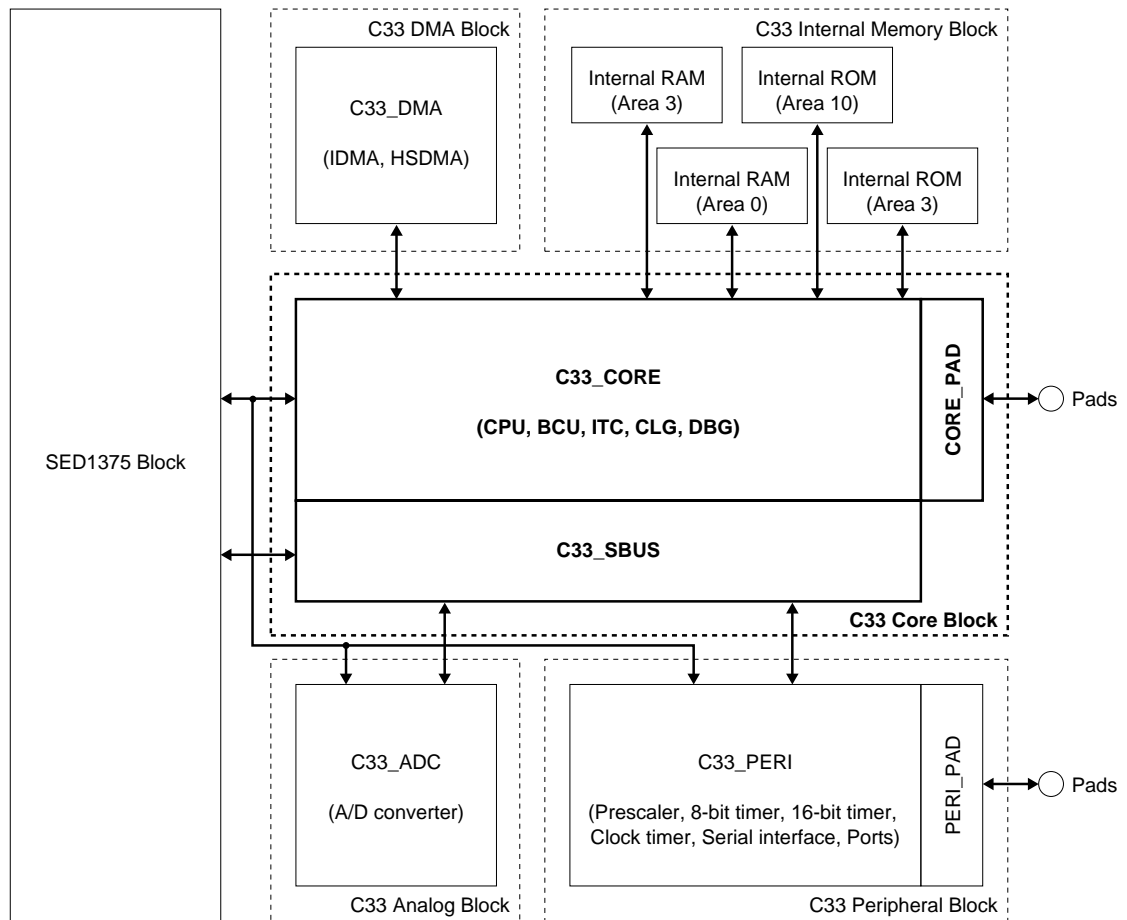


Figure II-1.1 Core Block

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II-2 CPU AND OPERATING MODE

CPU

The C33 Core Block employs the E0C33000 32-bit RISC type CPU as the core CPU. Since it has a built-in multiplier, all instructions (105 instructions) in the E0C33000 instruction set including the MAC (multiplication and accumulation) instruction and the multiplication/division instructions are available.

All the internal registers of the E0C33000 can be used. The CPU registers and CPU address bus can handle 28-bit addresses. However, the core block has a 24-bit external address bus (A[0:23]), so the low-order 24 bits of address data can only be delivered to the external address bus and the internal address bus which is connected to the User Logic Block.

Refer to the "E0C33000 Core CPU Manual" for details of the E0C33000.

Standby Mode

The CPU supports three standby modes: two HALT modes and a SLEEP mode.

By setting the CPU in the standby mode, power consumption can greatly be reduced.

HALT Mode

When the CPU executes the halt instruction, it suspends the program execution and enters the HALT mode.

The CPU supports two types of HALT modes (basic HALT mode and HALT2 mode) and either can be selected using the HLT2OP (D3) / Clock option register (0x40190).

The CPU stops operating in basic HALT mode, so the amount of current consumption can be reduced. The internal peripheral circuits including the oscillation circuit keep operating in basic HALT mode.

HALT2 mode stops the external bus control functions including DMA and the bus clock as well as the CPU similar to basic HALT mode. Consequently, HALT2 mode realizes more power saving than the basic HALT mode.

The HALT mode is canceled by an initial reset or an interrupt including NMI. This mode is useful for saving power when waiting for an external input or completion of the peripheral circuit operations that do not need to execute the CPU.

The CPU transits to program execution status through trap processing when the HALT mode is canceled by an interrupt and executes the interrupt processing routine. The trap processing of the CPU saves the address of the instruction that follows the executed halt instruction into the stack. Therefore, when the interrupt processing routine is terminated by the reti instruction, the program flow returns to the instruction that follows the halt instruction.

Note that the HALT mode cannot be canceled with an interrupt factor except for reset and NMI if the PSR is set into interrupt disabled status.

SLEEP Mode

When the CPU executes the slp instruction, it suspends the program execution and enters SLEEP mode.

In SLEEP mode, the CPU and the internal peripheral circuits including the high-speed (OSC3) oscillation circuit stop operating. Thus SLEEP mode can greatly reduce current consumption in comparison to HALT mode.

Moreover, the low-speed (OSC1) oscillation circuit and clock timer do not stop operating. The clock function keeps operating in SLEEP mode.

SLEEP mode is canceled by an initial reset or an interrupt (NMI, clock timer interrupt, external interrupt such as a key entry). Note that other interrupts by the internal peripheral circuits that use the OSC3 clock cannot be used for canceling SLEEP mode.

The CPU transits to program execution status through trap processing when the SLEEP mode is canceled by an interrupt and executes the interrupt processing routine. The trap processing of the CPU saves the address of the instruction that follows the executed slp instruction into the stack. Therefore, when the interrupt processing routine is terminated by the reti instruction, the program flow returns to the instruction that follows the slp instruction.

Note that SLEEP mode cannot be canceled with an interrupt factor except for reset and NMI if the PSR is set into interrupt disabled status.

Notes on Standby Mode

Interrupts

The standby mode can be canceled by an interrupt. Therefore, it is necessary to enable the interrupt to be used for canceling the standby mode before setting the CPU in the standby mode. It is also necessary to set the IE (interrupt enable) and IL (interrupt level) bits in the PSR to a condition that can accept the interrupt. Otherwise, the standby mode cannot be canceled even when an interrupt occurs. Refer to "ITC (Interrupt Controller)", for interrupt settings.

Oscillation circuit

The high-speed (OSC3) oscillation circuit stops in SLEEP mode and restarts oscillating when SLEEP mode is canceled. If the CPU had operated with the OSC3 clock before entering SLEEP mode, the CPU restarts operating with the OSC3 clock immediately after canceling SLEEP mode. However, the OSC3 oscillation needs appropriate stabilization time (10 ms max. under the standard condition in 3.3 V). To restart the CPU after the oscillation stabilizes, a programmable interval can be inserted between cancellation of SLEEP mode and starting the CPU operation. Refer to "CLG (Clock Generator)", for details.

The oscillation start time of the high-speed (OSC3) oscillation circuit varies according to the components to be used, board pattern and operating environment. The interval must be set to allow enough margin.

BCU

When the CPU enters the standby mode, the BCU (bus control unit) stops after the current bus cycle has completed. All the chip enable signals are negated.

In basic HALT mode, the BCLK (bus clock) signal is output and DRAM refresh cycles are generated. DMA also operates.

In HALT2 or SLEEP mode, the BCLK signal stops, therefore DRAM refresh cycles cannot be generated and DMA stops.

Additional

The contents of the CPU registers and input/output port status are retained in the standby mode. Almost all control and data registers of the internal peripheral circuits are also retained, note, however, some registers may be changed at the transition to SLEEP mode. Refer to the section of each peripheral circuit for other precautions.

Test Mode

The C33 Core Block has the ICEMD pin for testing the chip. When this pin is set to High, the IC enters the following state:

- All output pins go into high-impedance state except for the clock output pins (OSC2: H, OSC4 H, PLLC: L).
- Clock inputs are disabled. OSC1, OSC3 and PLL stop operating. OSC2: H, OSC4 H, PLLC: L
- All the pull-up and pull-down resistors enter an inactive state.

Leave this pin open or connect to VSS for normal operation. The ICEMD pin has a built-in pull-down resistor.

Debug Mode

The C33 Core Block supports the debug mode.

The debug mode is a CPU function, and realizes single step operation and break functions in the chip itself. Refer to the "E0C33000 Core CPU Manual" for details of the debug mode and the functions.

Area 2 in the memory map can only be accessed in the debug mode.

In the debug mode, the OSC3 clock is used as the CPU operating clock. Therefore, do not stop the high-speed (OSC3) oscillation circuit when using the debugging functions. Furthermore, only the C33 Core Block operates in the debug mode and other internal peripheral circuits stop operating.

Trap Table

Table 2.1 shows the trap table in the C33 Core. Refer to the "E0C33000 Core CPU Manual" for details of exceptions and Section II-5 in this manual, "ITC (Interrupt Controller)", for interrupts.

Table II-2.1 Trap Table

HEX No.	Vector number (Hex address)	Exception/interrupt name	Exception/interrupt factor	IDMA Ch.	Priority
0	0(Base)	Reset	Low input to the reset pin	–	High ↑
	1–3	reserved	–	–	
4	4(Base+10)	Zero division	Division instruction	–	
5	5	reserved	–	–	
6	6(Base+18)	Address error exception	Memory access instruction	–	
7	0x0 or 0x60000	Debugging exception	brk instruction, etc.	–	
8	8(Base+1C)	NMI	Low input to the NMI pin	–	
	9–11	reserved	–	–	
C	12(Base+30)	Software exception 0	int instruction	–	
D	13(Base+34)	Software exception 1	int instruction	–	
E	14(Base+38)	Software exception 2	int instruction	–	
F	15(Base+3C)	Software exception 3	int instruction	–	
10	16(Base+40)	Port input interrupt 0	Edge (rising or falling) or level (High or Low)	1	
11	17(Base+44)	Port input interrupt 1	Edge (rising or falling) or level (High or Low)	2	
12	18(Base+48)	Port input interrupt 2	Edge (rising or falling) or level (High or Low)	3	
13	19(Base+4C)	Port input interrupt 3	Edge (rising or falling) or level (High or Low)	4	
14	20(Base+50)	Key input interrupt 0	Rising or falling edge	–	
15	21(Base+54)	Key input interrupt 1	Rising or falling edge	–	
16	22(Base+58)	High-speed DMA Ch.0	High-speed DMA Ch.0, end of transfer	5	
17	23(Base+5C)	High-speed DMA Ch.1	High-speed DMA Ch.1, end of transfer	6	
18	24(Base+60)	High-speed DMA Ch.2	High-speed DMA Ch.2, end of transfer	–	
19	25(Base+64)	High-speed DMA Ch.3	High-speed DMA Ch.3, end of transfer	–	
1A	26(Base+68)	IDMA	Intelligent DMA, end of transfer	–	
	27–29	reserved	–	–	
1E	30(Base+78)	16-bit programmable timer 0	Timer 0 comparison B	7	
1F	31(Base+7C)		Timer 0 comparison A	8	
	32–33	reserved	–	–	
22	34(Base+88)	16-bit programmable timer 1	Timer 1 comparison B	9	
23	35(Base+8C)		Timer 1 comparison A	10	
	36–37	reserved	–	–	
26	38(Base+98)	16-bit programmable timer 2	Timer 2 comparison B	11	
27	39(Base+9C)		Timer 2 comparison A	12	
	40–41	reserved	–	–	
2A	42(Base+A8)	16-bit programmable timer 3	Timer 3 comparison B	13	
2B	43(Base+AC)		Timer 3 comparison A	14	
	44–45	reserved	–	–	
2E	46(Base+B8)	16-bit programmable timer 4	Timer 4 comparison B	15	
2F	47(Base+BC)		Timer 4 comparison A	16	
	48–49	reserved	–	–	
32	50(Base+C8)	16-bit programmable timer 5	Timer 5 comparison B	17	
33	51(Base+CC)		Timer 5 comparison A	18	
34	52(Base+D0)	8-bit programmable timer	Timer 0 underflow	19	
35	53(Base+D4)		Timer 1 underflow	20	
36	54(Base+D8)		Timer 2 underflow	21	
37	55(Base+DC)		Timer 3 underflow	22	
38	56(Base+E0)		Serial interface Ch.0	Receive error	–
39	57(Base+E4)	Receive buffer full		23	
3A	58(Base+E8)	Transmit buffer empty		24	
	59	reserved	–	–	
3C	60(Base+F0)	Serial interface Ch.1	Receive error	–	
3D	61(Base+F4)		Receive buffer full	25	
3E	62(Base+F8)		Transmit buffer empty	26	
	63	reserved	–	–	
40	64(Base+100)	A/D converter	A/D converter, end of conversion	27	
41	65(Base+104)	Clock timer	Falling edge of 32 Hz, 8 Hz, 2 Hz or 1 Hz signal 1-minute, 1-hour or specified time count up	–	
	66–67	reserved	–	–	
44	68(Base+110)	Port input interrupt 4	Edge (rising or falling) or level (High or Low)	28	
45	69(Base+114)	Port input interrupt 5	Edge (rising or falling) or level (High or Low)	29	
46	70(Base+118)	Port input interrupt 6	Edge (rising or falling) or level (High or Low)	30	
47	71(Base+11C)	Port input interrupt 7	Edge (rising or falling) or level (High or Low)	31	

* Base = Set value in the TTBR register (0x48134 to 0x48137); 0xC00000 by default.

II-3 INITIAL RESET

Pins for Initial Reset

Table II-3.1 shows the pins used for initial reset.

Table II-3.1 Pins for Initial Reset

Pin name	I/O	Function
#RESET	I	Initial reset input pin (Low active) Low: Resets the CPU.
#MNI	I	NMI request input pin This pin is also used for selecting a reset method. High: Cold start Low: Hot start

The chip is reset when the #RESET pin goes low and starts operating at the rising edge of the reset signal. The CPU and internal peripheral circuits are initialized while the #RESET pin is low.

Cold Start and Hot Start

The CPU supports two initial reset methods: cold start and hot start. The #MNI pin is used with the #RESET pin to set this condition.

The differences between cold start and hot start are shown in Table II-3.2.

Table II-3.2 Differences between Cold Start and Hot Start

Setup contents	Cold start	Hot start
Reset condition	#RESET = low & #MNI = high	#RESET = low & #MNI = low
CPU: PC	The vector at the boot address is loaded to the PC.	
CPU: PSR	All the PSR bits are reset to 0.	
CPU: Other registers	Undefined	
CPU: Operating clock	The CPU operates with the OSC3 clock.	
External bus status (0x48120–0x4813F)	Initialized	Status is retained.
Oscillation circuit	Both the OSC1 and OSC3 circuits start oscillating.	
I/O pin status (0x402C0–0x402DF)	Initialized	Status is retained.
Other peripheral circuit	Initialized or undefined	

Since cold start initializes all the internal peripheral circuits as well as the CPU, it is useful as a power-on reset. Hot start initializes the CPU and peripheral circuits, but does not reset the bus control unit and the input, output and I/O port status. It is useful as a reset that maintains the external memory, external I/O and the port status.

The #NMI pin that specifies the reset method should be set following the timing chart shown in Figure II-3.1.

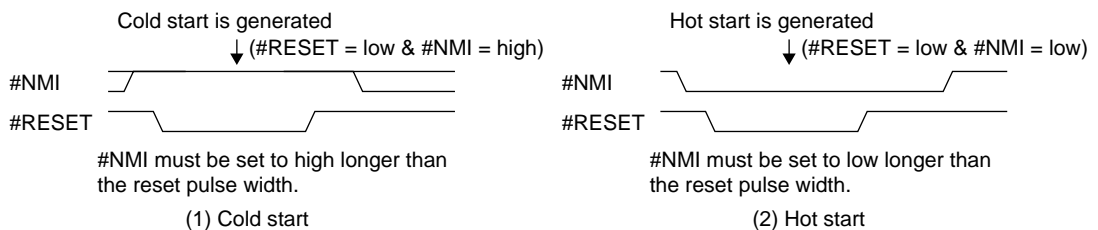


Figure II-3.1 Setup of pad_rset_x and #MNI Pins

Power-on Reset

Be sure to reset (cold start) the chip after turning on the power to start operating.

Since the #RESET pin is directly connected to an input gate, a power-on reset circuit should be configured outside the chip.

An initial reset (#RESET = low) turns the high-speed (OSC3) oscillation circuit on. The CPU starts operating with the OSC3 clock at the rising edge of the reset signal. The high-speed (OSC3) oscillation circuit takes time (10 ms max. under the standard condition in 3.3 V) for the oscillation to stabilize, therefore initial reset must be released after an appropriate oscillation-stabilization time has passed in order to start up the CPU without fault. The initial reset pulse width must be exceeded the oscillation-stabilization time.

Figure II-3.2 shows a power-on reset timing chart.

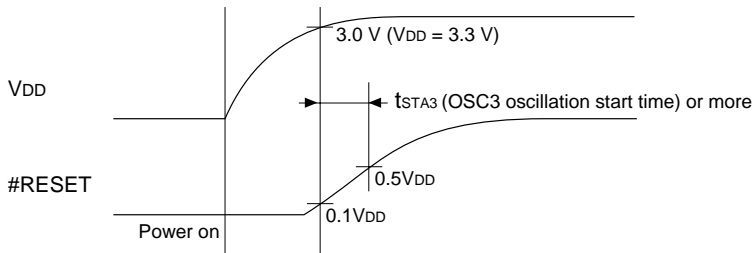


Figure II-3.2 Power-on Reset Timing

Maintain the #RESET pin at $0.1 \cdot V_{DD}$ or less (low level) after turning the power on until the supply voltage rises at least to the oscillation start voltage (3.0 V). Furthermore, maintain the #RESET pin at $0.5 \cdot V_{DD}$ or less until the high-speed (OSC3) oscillation circuit stabilizes oscillating.

Note: The OSC3 oscillation start time varies due to the elements used, board pattern and operating environment, therefore allow enough margin for the reset-release time. Refer to "Oscillation Characteristics", in which an example of oscillation start time is provided.

Reset Pulse

A low pulse can be input to the #RESET pin for resetting the chip being operated.

The minimum reset pulse width is provided in "AC Characteristics". Be sure to input a pulse that has a pulse width longer than the minimum value.

To reset the chip when the high-speed (OSC3) oscillation circuit is in off status, the pulse width must be extended until the oscillation stabilizes similarly to the power-on reset. Be aware that a short reset pulse may cause an operation error.

Boot Address

When the core CPU is initially reset, it reads the reset vector (program start address) from the boot address (0x0C00000) and loads the vector to the PC (program counter). Then the CPU starts executing the program from the address when the #RESET pin goes high.

The trap table in which trap vectors for interrupts and other trap factors are written also begins from the boot address by the default setting. (Refer to the "E0C33000 Core CPU Manual" for details of the trap table.)

The trap table base address can also be changed to a 1KB boundary address using the TTBR register (0x48134 to 0x48137).

Notes Related to Initial Reset

Core CPU

Since the all registers except for the PC and PSR are indeterminate at initial reset, they should be initialized by a program. In particular, the SP (stack pointer) must be initialized before accessing the stack area. NMI requests are disabled until any value is written to the SP. The initialization is necessary when the CPU is cold-started.

Internal RAM

The contents of the internal RAM are indeterminate at initial reset. Initialize the area to be used if necessary.

High-speed (OSC3) oscillation circuit

An initial reset activates the high-speed (OSC3) oscillation circuit and the CPU starts operating with the OSC3 clock after the initial reset is released. In order to prevent a malfunction of the CPU due to an unstabilized clock, the #RESET pin must be maintained at low until the OSC3 oscillation stabilizes when performing a power-on reset or resetting while the high-speed (OSC3) oscillation circuit is stopped.

Low-speed (OSC1) oscillation circuit

A power-on reset or an initial reset when the low-speed (OSC1) oscillation circuit is off starts the OSC1 oscillation. The low-speed (OSC1) oscillation circuit takes a longer stabilization time (3 sec max. under the standard condition) than the high-speed (OSC3) oscillation circuit. In order to prevent a malfunction due to an unstabilized clock, do not use the OSC1 clock until the stabilization time has passed.

BCU (Bus Control Unit)

Cold-start initializes the control registers for the BCU (bus control unit). Therefore, it is necessary to set up all the bus conditions.

Hot-start retains the previous bus conditions before an initial reset.

Input/output ports and input/output pins

Cold start initializes the control and data registers for the input and I/O ports.

Hot start retains the contents of the control registers and input/output pin status before an initial reset.

However, when the pins are used for the internal peripheral circuits, it is necessary to set up the control registers of the peripheral circuit because they are initialized by an initial reset.

Other internal peripheral circuits

The control and data registers of peripheral circuits other than those listed above are initialized with the predefined values or become indeterminate regardless of the reset method (cold start or hot start). Therefore, it is necessary to set up the peripheral circuit conditions.

Refer to the I/O maps or explanation of each peripheral circuit section for initial settings of the peripheral circuits.

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II-4 BCU (Bus Control Unit)

The BCU (Bus Control Unit) provides an interface for external devices and on-chip user logic block. The types and sizes of memory and peripheral I/O devices can be set for each area of the memory map and can be controlled directly by the BCU. This unit also supports a direct interface for DRAM and burst ROM. This chapter describes how to control the external and internal system interface, and how it operates.

Note: The control registers of the external system interface shown in this chapter are mapped to the internal 16-bit I/O area. Therefore, the addresses of these control registers are indicated by half-word (16-bit) addresses unless otherwise specified. Note that the control registers can be accessed in bytes, half-words, or words.

Pin Assignment for External System Interface

I/O Pin List

External I/O pins

Table II-4.1 lists the pins used for the external system interface.

Table II-4.1 I/O Pin List

Pin name	I/O	Function
A[0]#/BSL	O	Address bus (A0) / Bus strobe (Low-byte)
A[23:1]	O	Address bus (A1–A23)
D[15:0]	I/O	Data bus (D0–D15)
#CE10EX	O	Area 10 external memory chip enable
#CE10IN	O	Area 10 chip enable for internal ROM emulation mode
#CE9/#CE17	O	Area 9/17 chip enable
#CE8/#RAS1/#CE14/#RAS3	O	Area 8/14 chip enable / DRAM Row strobe
#CE7/#RAS0/#CE13/#RAS2	O	Area 7/13 chip enable / DRAM Row strobe
#CE6	O	Area 6 chip enable
#CE5/#CE15	O	Area 5/15 chip enable
#CE4/#CE11	O	Area 4/11 chip enable
#CE3	O	Area 3 chip enable for ROM emulation mode
#RD	O	Read signal
#EMEMRD	O	Read signal for area 3/10 emulation mode
#WRL/#WR/#WE	O	Write (Low-byte) / Write / DRAM write
#WRH/#BSH	O	Write (High-byte) / Bus strobe (High-byte)
#HCAS	O	DRAM column address strobe (High-byte)
#LCAS	O	DRAM column address strobe (Low-byte)
BCLK	O	Bus clock output
#BUSREQ/#CE6/P34	I/O	Bus release request / Area 6 chip enable / I/O port
#BUSACK/P35	O	Bus request acknowledge / I/O port
#WAIT/#CE4&5/P30	I/O	Wait cycle request / Areas 4&5 chip enable / I/O port
#DRD/P20	O	DRAM read signal / I/O port
#DWE/P21	O	DRAM write (Low-byte) / I/O port
#X2SPD	I	CPU - BCLK clock ratio 1: CPU clock = Bus clock, 0: CPU clock = Bus clock x 2
EA10MD[1:0]	I	Area 10 boot mode selection 11: External ROM, 10: Internal ROM, 01: OTP, 00: Internal ROM emulation
EA3MD	I	Area 3 mode selection 1: Internal ROM mode, 0: Emulation mode

User interface signals

Table II-4.2 List of User Interface Signals

Signal name	I/O	Function
Internal_addr0	O	<ul style="list-style-type: none"> Address bus (a0) when SBUSST(D3/0x4812E) = "0" (default) Bus strobe (low byte) signal (#BSL) when SBUSST(D3/0x4812E) = "1"
Internal_addr[23:1]	O	Address bus (a1 to a23)
Internal_dout[15:0]	O	Output data bus (dout0 to dout15) This data bus is used when the CPU writes data to the on-chip user logic.
Internal_din[15:0]	I	Input data bus (din0 to din15) This data bus is used when the CPU reads data from the on-chip user logic.
Internal_ce4_x Internal_ce5_x Internal_ce6_x	O	Areas 6–4 chip enable signals These signals go low when the CPU accesses the user logic circuits that are mapped to Areas 6–4.
Internal_rd_x	O	Read signal This signal goes low when the CPU reads data from the user logic.
Internal_wrl_x	O	<ul style="list-style-type: none"> Write (low byte) signal (#WRL) when SBUSST(D3/0x4812E) = "0" (default) Write signal (#WR) when SBUSST(D3/0x4812E) = "1" This signal goes low when the CPU write 8 low-order bit data to the user logic.
Internal_wrh_x	O	<ul style="list-style-type: none"> Write (high byte) signal (#WRH) when SBUSST(D3/0x4812E) = "0" (default) Bus strobe (high byte) signal (#BSH) when SBUSST(D3/0x4812E) = "1" This signal goes low when the CPU write 8 high-order bit data to the user logic.
Internal_osc3_clk	O	High-speed (OSC3) oscillation clock output This can be used as a source clock for the user logic.
Internal_pll_clk	O	PLL output clock This can be used as a source clock for the user logic.
Internal_wait_x	I	Wait cycle request input The user logic can request to insert wait cycles by setting this signal to low.
Internal_irrd_x	O	Instruction fetch indicator signal This signal goes low when the CPU is in an instruction fetch cycle.
Internal_k60-k67	I	Input signals These signals are connected to the input ports K60–K67. The user logic can request HSDMA, IDMA and interrupts using these signals. The user logic can also be used as input ports with these signals.

The internal bus signals are available when an internal access area is set using the BCU register.

The bus conditions can be programmed using the BCU registers similar to the external bus.

Combination of System Bus Control Signals

The bus control signal pins that have two or more functions have their functionality determined when an interface method is selected by a program. The BCU contains an ordinary external system interface (two interface method are supported) and a DRAM interface.

Table II-4.3 Interface Selection

Interface type	Interface method	Control bit
External system interface	A0 system (default)	SBUSST(D3/0x4812E) = "0"
	#BSL system	SBUSST(D3/0x4812E) = "1"
DRAM interface	2CAS system (fixed)	None

SBUSST is initialized to "0" at cold start.

When the IC is hot-started, these bits retain their status before the chip was reset.

Table II-4.4 shows combinations of control signals classified by each interface method.

Table II-4.4 Combinations of Bus Control Signals

External system interface		DRAM interface
A0 system	#BSL system	2CAS system
A0	#BSL (little endian) / #BSH (big endian) *1	–
#WRL	#WR	#WE
#WRH	#BSL (little endian) / #BSH (big endian) *1	–
–	–	#HCAS
–	–	#LCAS
#CE _x	#CE _x	#RAS _x *2

*1 In the #BSL system, the A0 and #WRH pin functions change according to the endian selected (little endian or big endian).

*2 When using DRAM, the #CE output pins in areas 7–8 (areas 13–14) function as the #RAS1–2 (#RAS3–4) pins.

Memory Area

Memory Map

Figure II-4.1 shows the memory map supported by the BCU.

Area	Address		Area	Address	
Area 9	0x0BFFFFFF	External memory (4MB)	Area 18	0xFFFFFFFF	External memory (16MB)
SRAM type			SRAM type	0xD000000	
Burst ROM type			8 or 16 bits	0xCFFFFFF	
8 or 16 bits	0x0800000		0xC000000		
Area 8	0x07FFFFFF	External memory (2MB)	Area 17	0xBFFFFFF	External memory (16MB)
SRAM type			SRAM type	0x9000000	
DRAM type			8 or 16 bits	0x8FFFFFF	
8 or 16 bits	0x0600000		0x8000000		
Area 7	0x05FFFFFF	External memory (2MB)	Area 16	0x7FFFFFF	External memory (16MB)
SRAM type			SRAM type	0x7000000	
DRAM type			8 or 16 bits	0x6FFFFFF	
8 or 16 bits	0x0400000		0x6000000		
Area 6	0x03FFFFFF	External I/O (16-bit device)	Area 15	0x5FFFFFF	External memory (16MB)
SRAM type			SRAM type	0x5000000	
	0x0380000		8 or 16 bits	0x4FFFFFF	
	0x037FFFF	External I/O (8-bit device)	0x4000000		
	0x0300000				
Area 5	0x02FFFFFF	External memory (1MB)	Area 14	0x3FFFFFF	External memory (16MB)
SRAM type			SRAM type		
8 or 16 bits			DRAM type		
	0x0200000		8 or 16 bits	0x3000000	
Area 4	0x01FFFFFF	External memory (1MB)	Area 13	0x2FFFFFF	External memory (16MB)
SRAM type			SRAM type		
8 or 16 bits			DRAM type		
	0x0100000		8 or 16 bits	0x2000000	
Area 3	0x00FFFFFF	(Reserved) For middleware use	Area 12	0x1FFFFFF	External memory (8MB)
16 bits			SRAM type		
Fixed at 1 cycle			8 or 16 bits		
	0x0080000		0x1800000		
Area 2	0x007FFFF	(Reserved) For CPU core or debug mode	Area 11	0x17FFFF	External memory (8MB)
16 bits			SRAM type		
Fixed at 3 cycles			8 or 16 bits		
	0x0060000		0x1000000		
Area 1	0x005FFFF	(Mirror of internal I/O)	Area 10	0x0FFFFFF	External memory (4MB)
8, 16 bits			SRAM type		
2 or 4 cycles			Burst ROM type		
	0x004FFFF		8 or 16 bits	0x0C00000	
	0x0040000	Internal I/O			
	0x003FFFF	(Mirror of internal I/O)			
	0x0030000				
Area 0	0x002FFFF	Internal RAM			
32 bits					
Fixed at 1 cycle					
	0x0000000				

Figure II-4.1 Memory Map

Basically, Areas 0 to 3 are internal memory areas and Areas 4 to 18 are external memory areas.

Area 0 is normally used for a built-in RAM. The built-in memory is mapped from the beginning of the area.

Area 1 is reserved for the I/O memory of the on-chip functional blocks. Address 0x0040000 to address 0x004FFFF are used as the control registers and address 0x0050000 to 0x005FFFF are used as the mirror area.

Area 2 is used in debug mode only and it cannot be accessed in user mode (normal program execution status).

Area 3 is reserved for E0C33 middlewares.

Area 4 to 18 can also be configured as internal memory areas using the control register and they can be used for user logic circuits.

External Memory Map and Chip Enable

The BCU has a 24-bit external address bus (A[23:0]) and a 16-bit external data bus (D[15:0]), allowing an address space of up to 16MB to be accessed with one chip enable signal. By default, the address space is divided into 11 areas (areas 0 to 10) for management purposes. Of these, areas 4 to 10 are open to an external system, each provided with an independent chip-enable pin (#CE[10:4]).

The C33 Core Block is limited to 24 available pins for the address bus and 7 pins for the #CE output due to its package structure. However, the #CE[4:10] output pins can be switched to the high-order area chip enable output pins as shown in Table II-4.5 using software. CEFUNC[1:0] (D[A:9]) / DRAM timing set-up register (0x48130) is used for this switching.

Table II-4.5 Switching of #CE Output

Pin	CEFUNC = "00"	CEFUNC = "01"	CEFUNC = "1x"
#CE4	#CE4	#CE11	#CE11+#CE12
#CE5	#CE5	#CE15	#CE15+#CE16
#CE6	#CE6	#CE6	#CE7+#CE8
#CE7/#RAS0	#CE7/#RAS0	#CE13/#RAS2	#CE13/#RAS2
#CE8/#RAS1	#CE8/#RAS1	#CE14/#RAS3	#CE14/#RAS3
#CE9	#CE9	#CE17	#CE17+#CE18
#CE10EX	#CE10EX	#CE10EX	#CE9+#CE10EX

(Default: CEFUNC = "00")

The high-order areas that are made available for use by writing "01" to CEFUNC can be larger in size than the default low-order areas. For example, when using DRAM in default settings, the available space is 4MB in areas 7 and 8. However, if areas 13 and 14 are used, up to 32MB of DRAM can be used. The same applies to the other areas.

Furthermore, when CEFUNC is set to "10" or "11", five chip enable signals are expanded into two area size.

Although the C33 Core Block has only 24 address output pins, it features 28-bit internal address processing.

Figure II-4.2 shows a memory map for an external system.

Area	Address	Area	Address
Area 10 (#CE10)	0x0FFFFFFF	Area 17 (#CE17)	0xBFFFFFFF
SRAM type		SRAM type	0x90000000
Burst ROM type		8 or 16 bits	0x8FFFFFFF
8 or 16 bits	0x0C000000		0x80000000
Area 9 (#CE9)	0x0BFFFFFFF	Area 15 (#CE15)	0x5FFFFFFF
SRAM type		SRAM type	0x50000000
Burst ROM type		8 or 16 bits	0x4FFFFFFF
8 or 16 bits	0x08000000		0x40000000
Area 8 (#CE8/#RAS1)	0x07FFFFFFF	Area 14 (#CE14/#RAS3)	0x3FFFFFFF
SRAM type		SRAM type	
DRAM type		DRAM type	
8 or 16 bits	0x06000000	8 or 16 bits	0x30000000
Area 7 (#CE7/#RAS0)	0x05FFFFFFF	Area 13 (#CE13/#RAS2)	0x2FFFFFFF
SRAM type		SRAM type	
DRAM type		DRAM type	
8 or 16 bits	0x04000000	8 or 16 bits	0x20000000
Area 6 (#CE6)	0x03FFFFFFF	Area 11 (#CE11)	0x17FFFFFFF
SRAM type	0x03800000	SRAM type	
	0x037FFFFF	8 or 16 bits	
	0x03000000		0x10000000
Area 5 (#CE5)	0x02FFFFFFF	Area 10 (#CE10)	0x0FFFFFFF
SRAM type		SRAM type	
8 or 16 bits		Burst ROM type	
	0x02000000	8 or 16 bits	0x0C000000
Area 4 (#CE4)	0x01FFFFFFF	Area 6 (#CE6)	0x03FFFFFFF
SRAM type		SRAM type	0x03800000
8 or 16 bits			0x037FFFFF
	0x01000000		0x03000000

CEFUNC = "00"

CEFUNC = "01"

II CORE BLOCK: BCU (Bus Control Unit)

Area	Address	
Area 17+18 (#CE17+18)	0xFFFFFFFF	(Mirror of External memory 7')
SRAM type	0xD000000	
8 or 16 bits	0xCFFFFFFF	External memory 7' (16MB)
	0xC000000	
	0xBFFFFFFF	(Mirror of External memory 7)
	0x9000000	
	0x8FFFFFFF	External memory 7 (16MB)
	0x8000000	
Areas 15–16 (#CE15+16)	0x7FFFFFFF	(Mirror of External memory 6')
SRAM type	0x7000000	
8 or 16 bits	0x6FFFFFFF	External memory 6' (16MB)
	0x6000000	
	0x5FFFFFFF	(Mirror of External memory 6)
	0x5000000	
	0x4FFFFFFF	External memory 6 (16MB)
	0x4000000	
Area 14 (#CE14/#RAS3)	0x3FFFFFFF	
SRAM type		
DRAM type		External memory 5 (16MB)
8 or 16 bits	0x3000000	
Area 13 (#CE13/#RAS2)	0x2FFFFFFF	
SRAM type		
DRAM type		External memory 4 (16MB)
8 or 16 bits	0x2000000	
Areas 11–12 (#CE11+12)	0x1FFFFFFF	
SRAM type		
8 or 16 bits	0x1000000	External memory 3 (16MB)
Areas 9–10 (#CE9+10EX)	0x0FFFFFFF	
SRAM type		
Burst ROM type		External memory 2 (8MB)
8 or 16 bits	0x0800000	
Areas 7–8 (#CE7+8)	0x07FFFFFFF	
SRAM type		
8 or 16 bits	0x0400000	External memory 1 (4MB)

CEFUNC = "10" or "11"

Figure II-4.2 External System Memory Map

Furthermore, the #CE4+#CE5 and #CE6 signals can be output from the P30 and P34 terminals, respectively.

This function expands the accessible area when CEFUNC is set to "01", "10" or "11".

To output the #CE4+#CE5 signal from the P30 terminal:

CFP30 (D0)/P3 function select register (0x402DC) = "1"

IOC30 (D0)/P3 I/O control register (0x402DE) = "1"

To output the #CE6 signal from the P34 terminal:

CFP34 (D4)/P3 function select register (0x402DC) = "1"

IOC34 (D4)/P3 I/O control register (0x402DE) = "1"

The P30 and P34 terminals are set for the general I/O ports at initial reset.

The P30 and P34 terminals are shared with the #WAIT input and the #BUSREQ input, respectively. Therefore, when using the #WAIT and #BUSREQ signals, there terminal cannot be used for #CE4+#CE5 and #CE6 outputs.

Using Internal Memory on External Memory Area

The BCU allows using of an internal memory in the external memory areas.

The AxxIO bit in the access control register (0x48132) is used to select either internal access or external access. When "1" is written, the internal device will be accessed and when "0" is written, the external device is accessed (external access by default). The bit names and the corresponding areas are as follows:

A18IO (DF): Areas 17 and 18
 A16IO (DE): Areas 15 and 16
 A14IO (DD): Areas 13 and 14
 A12IO (DC): Areas 11 and 12
 A8IO (DA): Areas 7 and 8
 A6IO (D9): Area 6
 A5IO (D8): Areas 4 and 5

Exclusive Signals for Areas

Areas can be accessed using the exclusive signals (address strobe and read signals) as well as the common control signals.

To use these exclusive signals, they should be configured using G/A read signal control register (0x48138).

The AxxAS bit is used to enable/disable the address strobe signal, and the AxxRD bit is used to enable/disable the read signal. When "1" is written to the bit, the exclusive signal for the corresponding area(s) is enabled and when "0" is written, it is disabled (disabled by default). The bit names and the corresponding areas are as follows:

A18AS (DF), A18RD (D7): Areas 17 and 18
 A16AS (DE), A16RD (D6): Areas 15 and 16
 A14AS (DD), A14RD (D5): Areas 13 and 14
 A12AS (DC), A12RD (D4): Areas 11 and 12
 A8AS (DA), A8RD (D2): Areas 7 and 8
 A6AS (D9), A6RD (D1): Area 6
 A5AS (D8), A5RD (D0): Areas 4 and 5

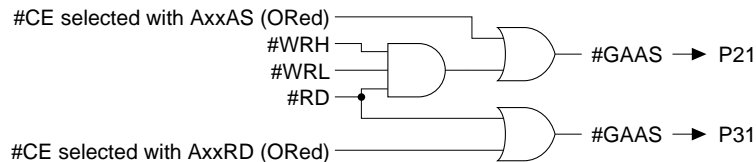


Figure II-4.3 #GAAS and #GARD Signals

The address strobe signal and the read signal are output from the P21 pin and P31 pin, respectively. Therefore, when using these signals, the pin(s) must be configured for exclusive signal output using the port function select register and port function extension register.

To output the exclusive address strobe signal #GAAS:

CFEX2 (D2)/Port function extension register (0x402DF) = "1"

To output the exclusive address strobe signal #GARD:

CFEX3 (D3)/Port function extension register (0x402DF) = "1"

These signals are common used to all the above areas, so when two or more areas are selected to output the exclusive signal, OR condition is applied.

Area 10

Area 10 is an external memory area that includes the boot address (0xC00000). This area supports four boot mode and a high-speed internal ROM can also be mapped.

Area 10 boot mode

The boot mode can be configured using the external pins EA10MD[1:0].

Table II-4.6 Area 10 Boot Mode Selection

EA10MD[1:0] pins	Area 10 boot mode
00	Internal ROM emulation mode
01	OTP and internal ROM emulation mode
10	Internal ROM boot mode
11	External ROM boot mode

Internal ROM boot mode

The CPU boots by the internal ROM mapped to area 10. The internal ROM size should be selected from among eight types (min. 16KB, max. 2MB) using the A10IR[2:0] (D[E:C])/Areas 10–9 set-up register (0x48126). This ROM begins with address 0xC00000 and can be read in one cycle the same as that of area 3. For the remained area within area 10, the external memory will be accessed if it is available.

Internal ROM emulation mode

The CPU boots by the external memory that emulates an internal ROM. This mode accesses the ROM emulation area set by the A10IR[2:0] (D[E:C])/Areas 10–9 set-up register (0x48126) using the same condition as internal ROM boot mode. The emulation memory is accessed using the #CE10IN chip enable signal.

* Internal ROM emulation mode can only be used for debugging, and cannot be used in mass production.

OTP and internal ROM emulation mode

In this mode, channel 0 of IDMA starts up for transferring the program codes in the Flash memory to the high-speed SRAM immediately after an initial reset is released. Then the system boots by the SRAM. After that, this mode functions the same as internal ROM emulation mode.

Since the Flash memory and SRAM are mapped to the same address range, the Flash memory is accessed using the #CE10EX chip enable signal and the SRAM is accessed using the #CE10IN chip enable signal.

External ROM boot mode

The CPU boots by the external ROM (ROM, Flash, SRAM, etc.). This mode uses the bus condition set by the BCU registers for area 10.

Setting the internal ROM size

When a boot mode other than external ROM boot mode is used, the internal ROM or emulation memory size should be set using A10IR[2:0] (D[E:C])/Areas 10–9 set-up register (0x48126).

Table II-4.7 Area 10 Internal ROM Size

A10IR2	A10IR1	A10IR0	ROM size
0	0	0	16KB
0	0	1	32KB
0	1	0	64KB
0	1	1	128KB
1	0	0	256KB
1	0	1	512KB
1	1	0	1MB
1	1	1	2MB (default)

Area 10 memory map

Figure II-4.4 shows the memory map of area 10.

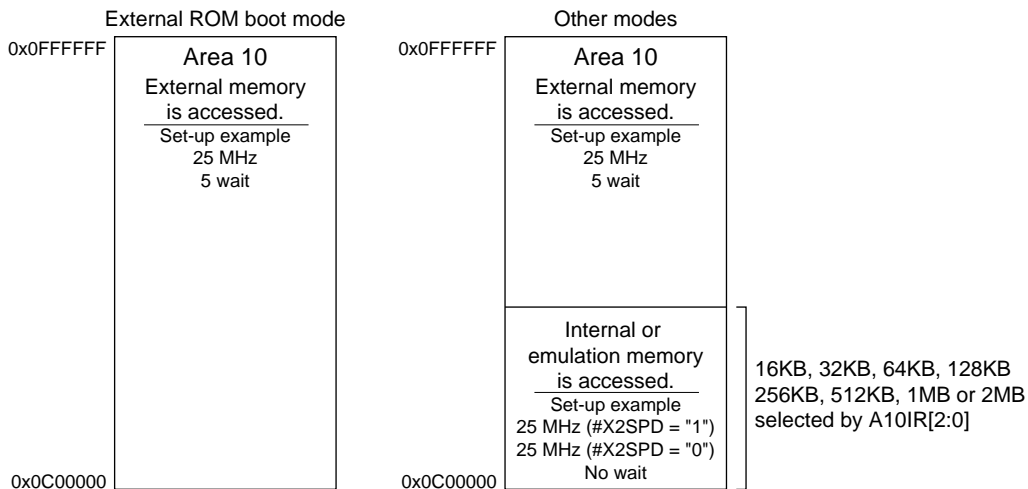


Figure II-4.4 Area 10 Memory Map

Area 3

Area 3 is an internal memory area and reserved for E0C33 middlewares.

This area can be configured with an internal ROM or an external emulation memory. The EA3MD pin is used for this selection.

Table II-4.8 Area 3 Mode Selection

EA3MD pin	Area 3 mode
0	Emulation mode
1	Internal ROM mode

System Configuration in Emulation Mode

Figure II-4.5 shows a development environment example using the emulation mode.

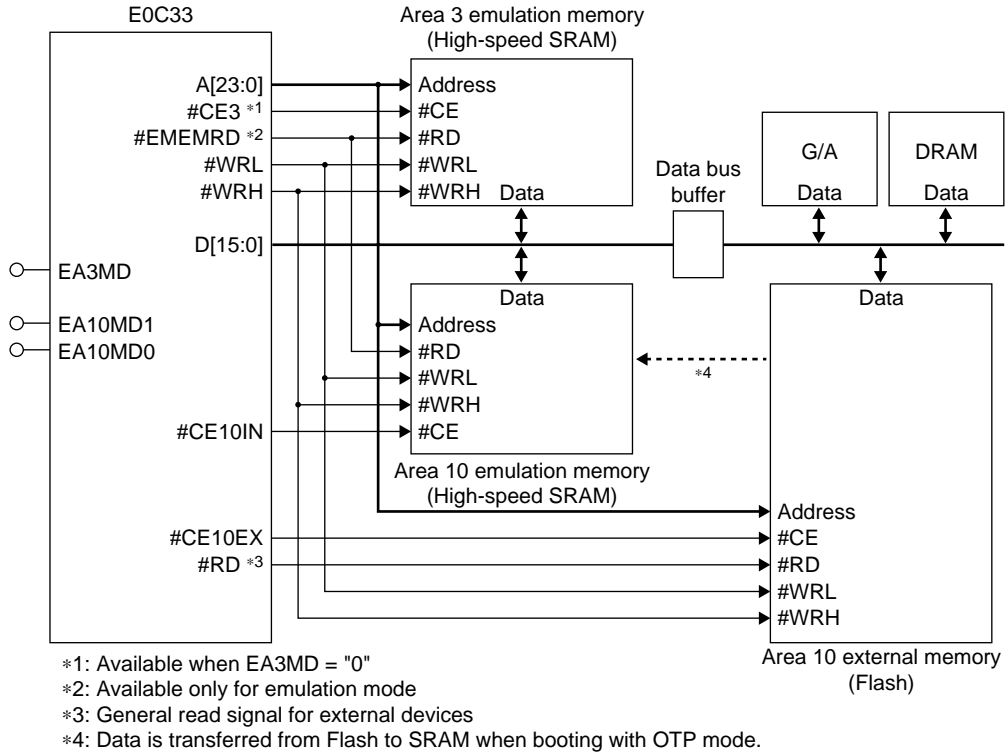


Figure II-4.5 Development Environment Example

The emulation memory is accessed without wait state as shown in Figure II-4.6.

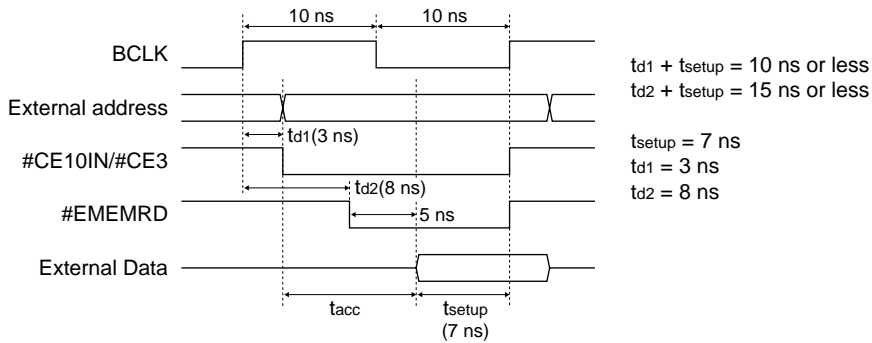


Figure II-4.6 Read Timing in Emulation Mode

In the emulation mode, the exclusive read signal #EMEMRD is used.

Setting External Bus Conditions

The type, size, and wait conditions of a device connected to the external bus can be individually set for each area using the control register (0x48120 to 0x48130). The following explains the available setup conditions individually for each area. For details on how to set the DRAM interface conditions, refer to "DRAM Direct Interface".

The control register used to set bus conditions is initialized at cold start. Therefore, please set up these registers again using software according to the external device configuration and specifications.

When the IC is hot-started, the setup contents and pins retain their previous status before a reset.

Setting Device Type and Size

Table II-4.9 shows the types of devices that can be connected directly to each area.

Table II-4.9 Device Type

Area	SRAM type	DRAM type	Burst ROM type	Control bit
18–15	●	X	X	None
14	●	●	X	A14DRA(D8)/Areas 14–13 set-up register(0x48122)
13	●	●	X	A13DRA(D7)/Areas 14–13 set-up register(0x48122)
12,11	●	X	X	None
10	●	X	●	A10DRA(D8)/Areas 10–9 set-up register(0x48126)
9	●	X	●	A9DRA(D7)/Areas 10–9 set-up register(0x48126)
8	●	●	X	A8DRA(D8)/Areas 8–7 set-up register(0x48128)
7	●	●	X	A7DRA(D7)/Areas 8–7 set-up register(0x48128)
6–4	●	X	X	None

●: Can be connected X: Cannot be connected

When connecting burst ROM or DRAM, write "1" to each corresponding control bit. These control bits are reset to "0" (SRAM type) at cold start.

The device size can be set to 8 or 16 bits once every two areas except for area 6. Area 6 alone has its first half (0x300000–0x37FFFF) fixed to an 8-bit device and the second half (0x380000–0x3FFFFFF) fixed to a 16-bit device.

Table II-4.10 Device Size Control Bits

Area	Control bit
18, 17	A18SZ(DE)/Areas 18–15 set-up register(0x48120)
16, 15	A16SZ(D6)/Areas 18–15 set-up register(0x48120)
14, 13	A14SZ(D6)/Areas 14–13 set-up register(0x48122)
12, 11	A12SZ(D6)/Areas 12–11 set-up register(0x48124)
10, 9	A10SZ(D6)/Areas 10–9 set-up register(0x48126)
8, 7	A8SZ(D6)/Areas 8–7 set-up register(0x48128)
5, 4	A5SZ(D6)/Areas 6–4 set-up register(0x4812A)

At cold start, each area by default is set to 16 bits.

When using an 8-bit device, write "1" to the control bit.

Note: The BCU supports 16-bit burst ROM. Therefore, when connecting burst ROM to area 10 or area 9, do not set the device size to 8 bits (A10SZ = "1").

For differences in bus operation due to the device size and access data size, refer to "Bus Operation of External Memory".

Setting SRAM Timing Conditions

The areas set for the SRAM allow wait cycles and output disable delay time to be set.

Number of wait cycles: 0 to 7 (incremented in units of one cycle)

Output disable delay time: 0.5, 1.5, 2.5, 3.5 cycles

This selection can be made once every two areas except for area 6.

Table II-4.11 Timing Condition Setting Bits (for SRAM type)

Area	Number of wait cycles	Output disable delay time	Control register
18, 17	A18WT[2:0](D[A:8])	A18DF[1:0](D[D:C])	Areas 18–15 set-up register(0x48120)
16, 15	A16WT[2:0](D[2:0])	A16DF[1:0](D5:4)	Areas 18–15 set-up register(0x48120)
14, 13	A14WT[2:0](D[2:0])	A14DF[1:0](D5:4)	Areas 14–13 set-up register(0x48122)
12, 11	A12WT[2:0](D[2:0])	A12DF[1:0](D5:4)	Areas 12–11 set-up register(0x48124)
10, 9	A10WT[2:0](D[2:0])	A10DF[1:0](D5:4)	Areas 10–9 set-up register(0x48126)
8, 7	A8WT[2:0](D[2:0])	A8DF[1:0](D5:4)	Areas 8–7 set-up register(0x48128)
6	A6WT[2:0](D[A:8])	A6DF[1:0](D[D:C])	Areas 6–4 set-up register(0x4812A)
5, 4	A5WT[2:0](D[2:0])	A5DF[1:0](D[5:4])	Areas 6–4 set-up register(0x4812A)

At cold start, the number of wait cycles is set to 7 and the output disable delay time is set to 3.5 cycles. Reset up these parameters as necessary using software according to specifications of the connected device.

At hot start, these parameters retain their previous settings before a reset.

Wait cycles

When the number of wait cycles is set for an area using the control bit, the BCU extends the bus cycle for a duration equivalent to the wait cycles set when it accesses the area. Set the desired wait cycles according to the bus clock frequency and the external device's access time. Separately from the wait cycles set here, a wait request from an external device can also be accepted using the #WAIT pin. Since the settings of wait cycles using software are made once every two areas, use this external wait request function if you want the wait cycles to be controlled individually in each area or if you need 7 or more wait cycles. The #WAIT pin is shared with the P30 I/O port. For an external wait request to be accepted, write "1" to CFP30 (D0) / P3 function select register (0x402DC [Byte]) and write "1" (default = "0") to SWAIT (D0) / Bus control register (0x4812E) to enable the #WAIT pin.

For timing charts for bus cycles and when wait cycles are inserted, refer to "Bus Cycles in External System Interface".

If the number of wait cycles is set to 0 and no external wait is requested, the basic read cycle (read in byte or half-word) for the SRAM external device consists of one cycle. If wait cycles are set, because these cycles are added, the bus read cycle consists of [number of wait cycles + 1] (providing that there is no external wait).

On the other hand, the basic write cycle consists of at least two cycles. This does not change regardless of whether zero or one wait cycle is set. If the number of wait cycles set is 2 or more, the bus cycle is actually extended. In this case, the bus write cycle consists of [number of wait cycles + 1], as in the case of read cycles (providing that there is no external wait).

Output disable delay time

In cases when a device having a long output disable time is connected, if a read cycle for that device is followed by the next access, contention for the data bus may occur. (Due to the fact the read device's data bus is not placed in the high-impedance state.) The output disable delay time is provided to prevent such data bus contention. This is accomplished by inserting a specified number of cycles between a read cycle and the next bus operation.

Check the specifications of the device to be connected before setting the output disable delay time.

By default, the output disable delay time is inserted only in the following cases:

- when a read cycle from the external device that has had an output disable delay time set is followed by a write cycle performed by the CPU; and
- when a read cycle from the external device that has had an output disable delay time set is followed by a read cycle for a different area (including the internal device).

Conversely, no output disable delay time is inserted in the following conditions:

- immediately after a write cycle, and
- during a successive read from the same external device.

Setting Timing Conditions of Burst ROM

Wait cycles

If burst ROM is selected for area 10 or 9, the wait cycles to be inserted in the burst read cycle can be selected in a range from 0 to 3 cycles. A10BW[1:0] (D[A:9]) / Areas 10–9 set-up register (0x48126) is used for this selection. This selection is applied simultaneously to areas 10 and 9, so wait cycles can not be chosen individually for each area. The wait cycles set at cold start is 0.

Even for a burst read, the SRAM settings of wait cycles in the first bus operation are valid. (Refer to A10WT[2:0] in the foregoing section.)

The wait cycles set by A10BW[1:0] are inserted into the burst cycles after the first bus operation.

In addition, when burst ROM is selected, no wait cycles can be inserted into the read cycle via the #WAIT pin.

For writing to an area that has had burst ROM selected, an SRAM write cycle is executed. In this case, both the SRAM settings of wait cycles and those input via the #WAIT pin are valid.

Burst mode

The burst mode can be selected between an eight-consecutive-burst and a four-consecutive-burst mode.

RBST8 (DD) / Bus control register (0x4812E) is used for this selection. The eight-consecutive-burst mode is selected by writing "1" to RBST8 and the four-consecutive-burst mode is selected by setting the bit to "0". At cold start, the four-consecutive-burst mode is set by default.

Bus Operation

Data Arrangement in Memory

The E0C33 Family of devices handle data in bytes (8 bits), half-words (16 bits), and words (32 bits). When accessing data in memory, it is necessary to specify a boundary address that conforms to the data size involved. Specification of an invalid address causes an address error exception. For instructions (e.g., stack manipulation or branch instructions) that rewrite the SP (stack pointer) or PC (program counter), the specified addresses are forcibly modified to appropriate boundary addresses. Therefore, no address error exception occurs in this type of instruction. For details about the address error exception, refer to the "E0C33000 Core CPU Manual".

Table II-4.12 shows the data arrangement in memory, classified by data type.

Table II-4.12 Data Arrangement in Memory

Data type	Arranged location
Byte data	Byte boundary address (all addresses)
Half-word data	Half-word boundary address (A[0]="0")
Word data	Word boundary address (A[1:0]="00")

The half-word and word data in memory area accessed in little-endian format by default. It can be changed to big-endian format using AxxEC (D[7:0])/Access control register (0x48132). When "1" is written to AxxEC, the corresponding area is accessed in big-endian method. The bit names and the corresponding areas are as follows:

A18EC (D7): Areas 17 and 18

A16EC (D6): Areas 15 and 16

A14EC (D5): Areas 13 and 14

A12EC (D4): Areas 11 and 12

A10EC (D3): Areas 9 and 10 ... Fixed at "0" (little-endian) for booting.

A8EC (D2): Areas 7 and 8

A6EC (D1): Area 6

A5EC (D0): Areas 4 and 5

To increase memory efficiency, try to locate the same type of data at continuous locations on exact boundary addresses in order to minimize invalid areas.

Bus Operation of External Memory

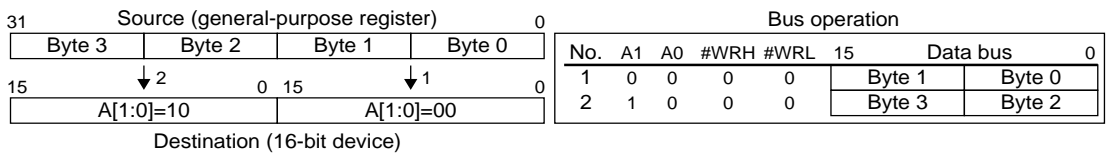
The external data bus is 16-bits wide. For this reason, more than one bus operation occurs depending on the device size and the data size of the instruction executed, as shown in Table II-4.13.

Table II-4.13 Number of Bus Operation Cycles

Data size to be accessed	Device size	Number of bus operation cycles	Remarks
32 bits	16 bits	2	
16 bits	16 bits	1	
8 bits	16 bits	1	In little-endian method, the low-order byte is accessed when the LSB of the address (A[0]) is "0" or the #BSL signal is L. The high-order byte is accessed when the LSB of the address (A[0]) is "1" or the #BSH signal is H. In big-endian method, the high-order byte is accessed when the LSB of the address (A[0]) is "0" or the #BSL signal is L. The low-order byte is accessed when the LSB of the address (A[0]) is "1" or the #BSH signal is H.
32 bits	8 bits	4	In little-endian method, the 8-bit device must be connected to the low-order 8 bits of the data bus. In big-endian method, the 8-bit device must be connected to the high-order 8 bits of the data bus.
16 bits	8 bits	2	In little-endian method, the 8-bit device must be connected to the low-order 8 bits of the data bus. In big-endian method, the 8-bit device must be connected to the high-order 8 bits of the data bus.
8 bits	8 bits	1	In little-endian method, the 8-bit device must be connected to the low-order 8 bits of the data bus. In big-endian method, the 8-bit device must be connected to the high-order 8 bits of the data bus.

The following diagram shows sample bus operations where the A0 system is used.

Little-endian



Big-endian

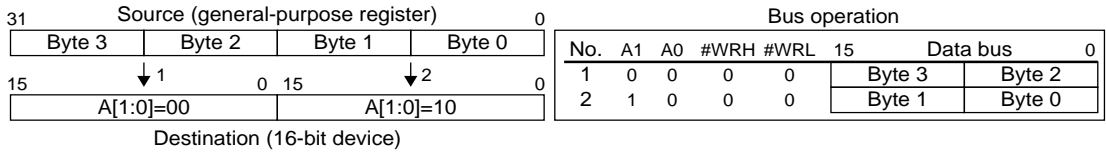
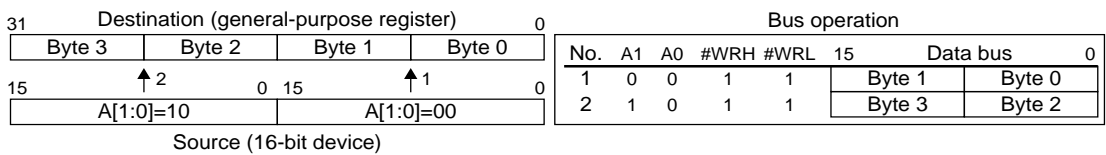


Figure II-4.7 Word Data Writing to a 16-bit Device

Little-endian



Big-endian

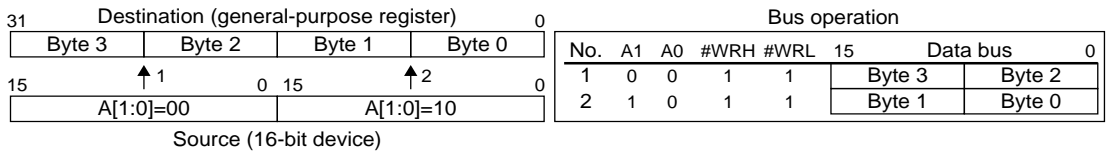
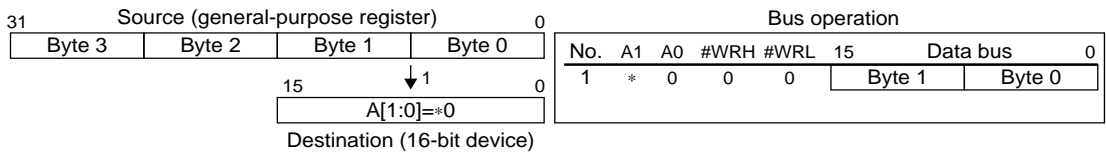


Figure II-4.8 Word Data Reading from a 16-bit Device

Little-endian



Big-endian

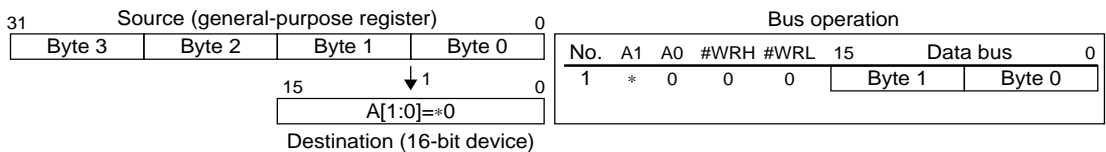
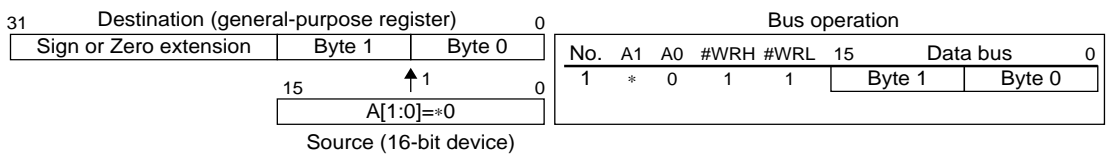


Figure II-4.9 Half-word Data Writing to a 16-bit Device

Little-endian



Big-endian

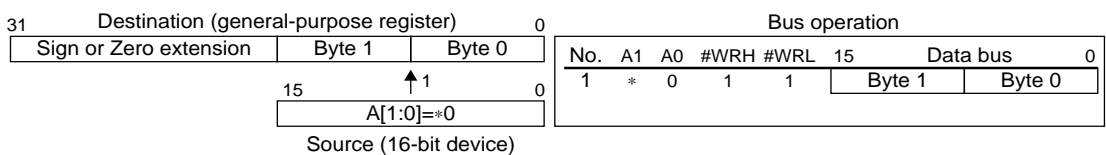
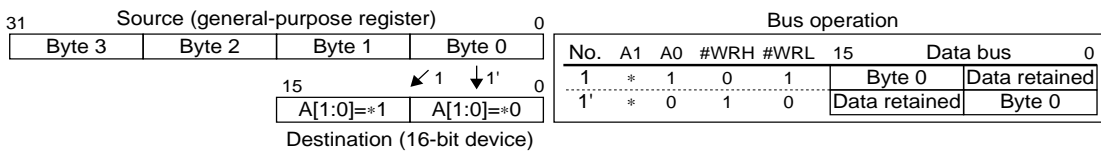


Figure II-4.10 Half-word Data Reading from a 16-bit Device

II CORE BLOCK: BCU (Bus Control Unit)

Little-endian



Big-endian

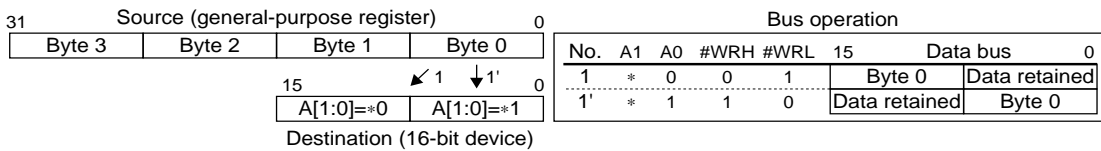
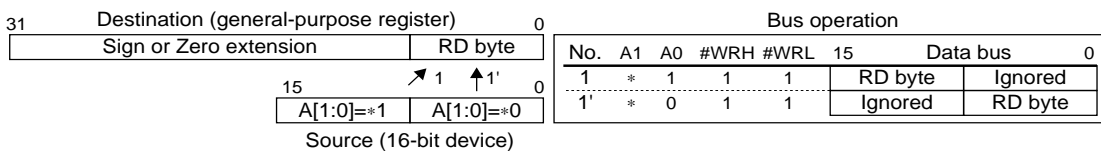


Figure II-4.11 Byte Data Writing to a 16-bit Device

Little-endian



Big-endian

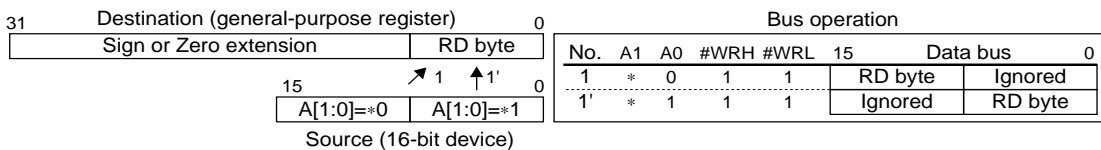
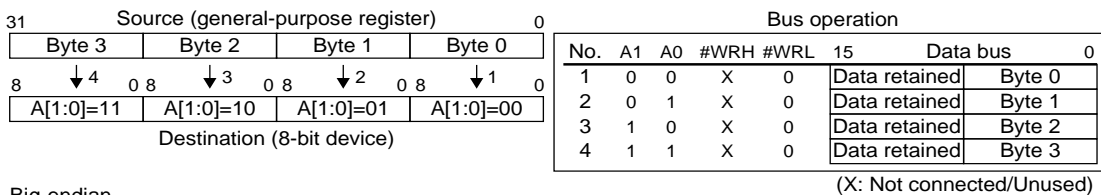


Figure II-4.12 Byte Data Reading from a 16-bit Device

Little-endian



(X: Not connected/Unused)

Big-endian

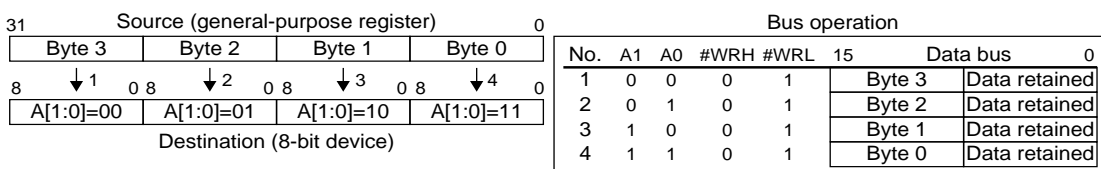
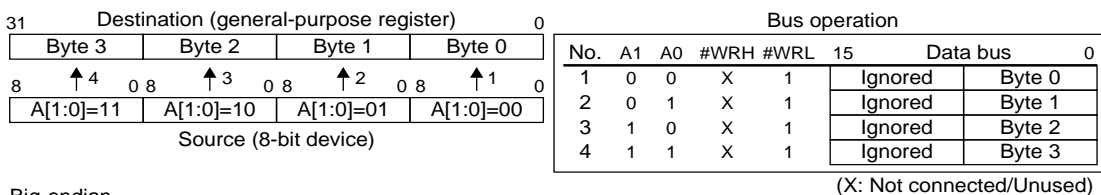


Figure II-4.13 Word Data Writing to an 8-bit Device

Little-endian



(X: Not connected/Unused)

Big-endian

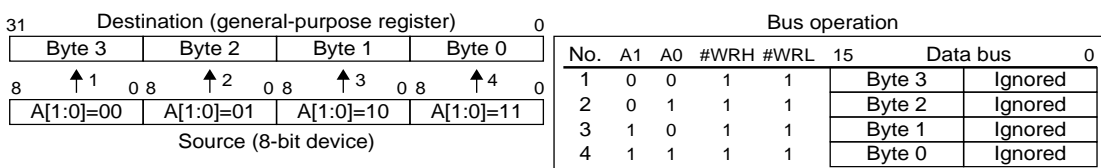
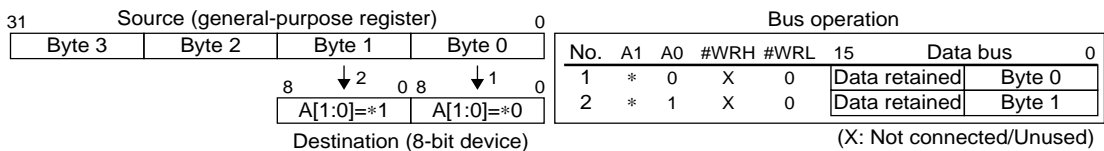


Figure II-4.14 Word Data Reading from an 8-bit Device

Little-endian



Big-endian

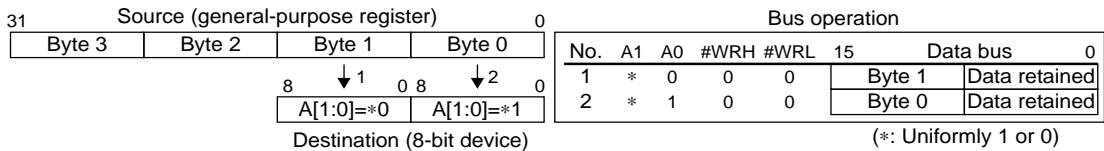
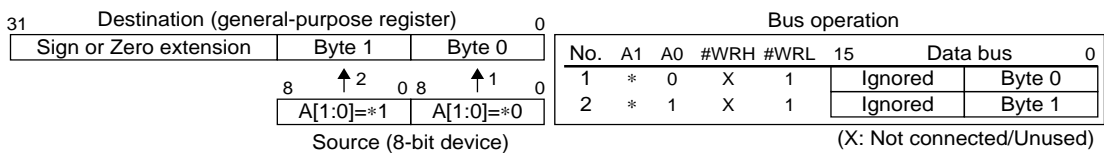


Figure II-4.15 Half-word Data Writing to an 8-bit Device

Little-endian



Big-endian

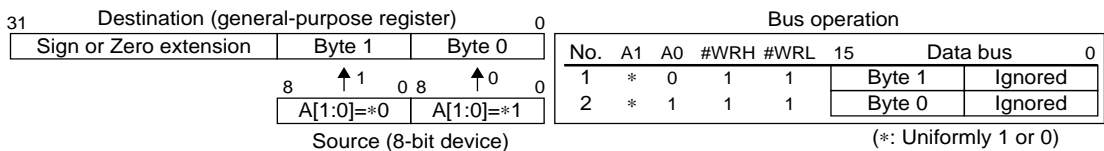
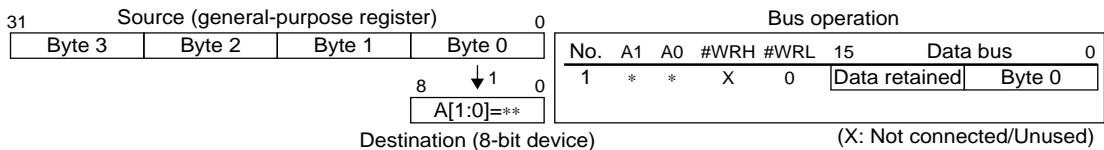


Figure II-4.16 Half-word Data Reading from an 8-bit Device

Little-endian



Big-endian

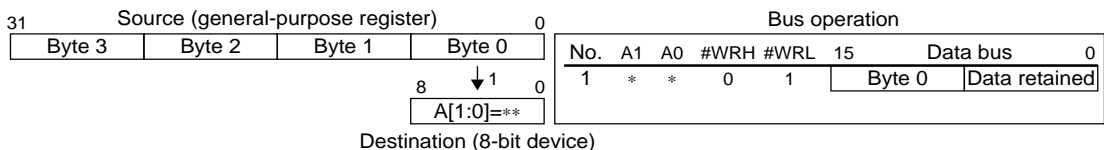
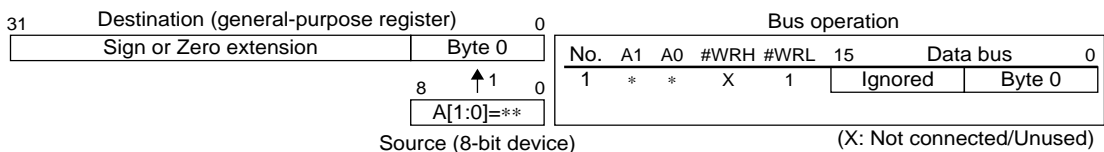


Figure II-4.17 Byte Data Writing to an 8-bit Device

Little-endian



Big-endian

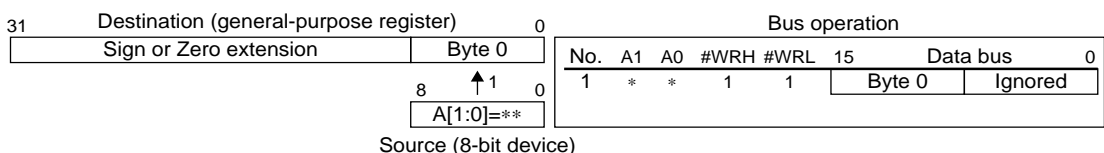


Figure II-4.18 Byte Data Reading from an 8-bit Device

Bus Clock

The bus clock is generated by the BCU using the CPU system clock output from the clock generator. Figure II-4.19 shows the clock system.

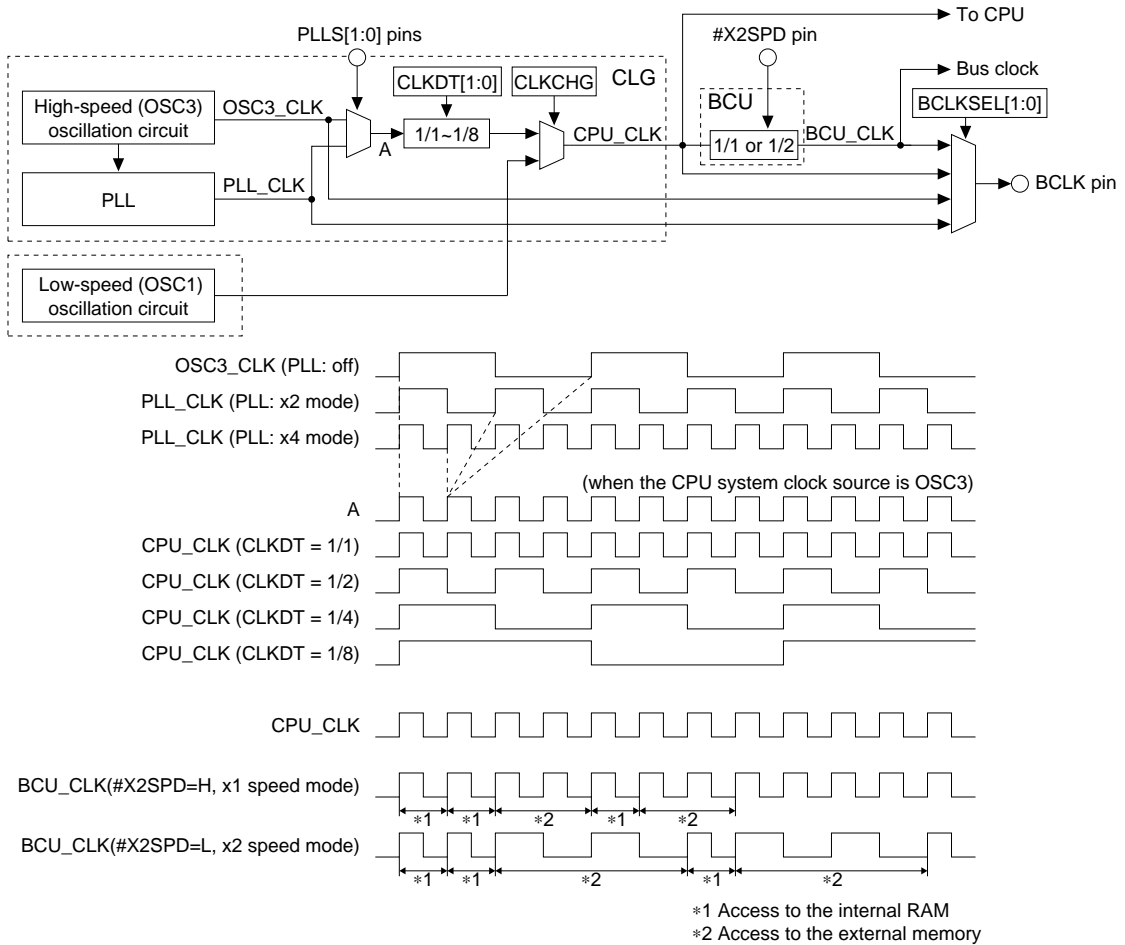


Figure II-4.19 Clock System

Since the bus clock is generated from the CPU system clock (CPU_CLK), the following settings affect the bus clock:

1. Selection of an oscillation circuit (OSC3 or OSC1)
2. PLL configuration (OSC3_CLK x 1, x2 or x4)
3. CPU clock division ratio for power saving

Items 2 and 3 apply when the high-speed (OSC3) oscillation circuit is selected as the CPU clock source. For details about the settings of the system clock, refer to "CLG (Clock Generator)".

Bus clock operation during standby is as follows:

- Basic HALT mode: the BCU and bus clock continue operating. DRAM can be refreshed.
- HALT2 mode: the BCU and bus clock are stopped.
- SLEEP mode: the BCU and bus clock are stopped.

Bus Speed Mode

The CPU - bus clock ratio can be set using the #X2SPD pin as follows:

When #X2SPD = High, x1 speed mode (CPU - bus clock ratio is 1 : 1) is set. The bus clock and the CPU system clock will be the same.

When #X2SPD = Low, x2 speed mode (CPU - bus clock ratio is 2 : 1) is set. In x2 speed mode, the bus clock will be dynamically varied according to the memory to be accessed.

- When an external memory area is accessed, the bus clock frequency becomes half of the CPU system clock.
- When the internal RAM/ROM area is accessed, the bus clock frequency becomes equal to the CPU system clock.

In x1 speed mode, area 1 (internal I/O area) is accessed in 4 cycles of the CPU system clock, while in x2 speed mode, the number of access cycles can be selected using A1X1MD (D3) / BCLK select register (0x4813A).

When A1X1MD = "1", area 1 is accessed in 2 cycles of the CPU system clock.

When A1X1MD = "0", area 1 is accessed in 4 cycles of the CPU system clock. (default)

Bus Clock Output

The bus clock is also output from the BCLK pin to an external device. The BCLK output clock can be selected from among four types using BCLKSEL[1:0] (D[1:0]) / BCLK select register (0x4813A).

Table II-4.14 Selection of BCLK Output Clock

BCLKSEL1	BCLKSEL0	Output clock
1	1	PLL_CLK (PLL output clock)
1	0	OSC3_CLK (OSC3 oscillation clock)
0	1	BCU_CLK (BCU operating clock)
0	0	CPU_CLK (CPU operating clock)

Bus Cycles in External System Interface

The following shows a sample SRAM connection the basic bus cycles.

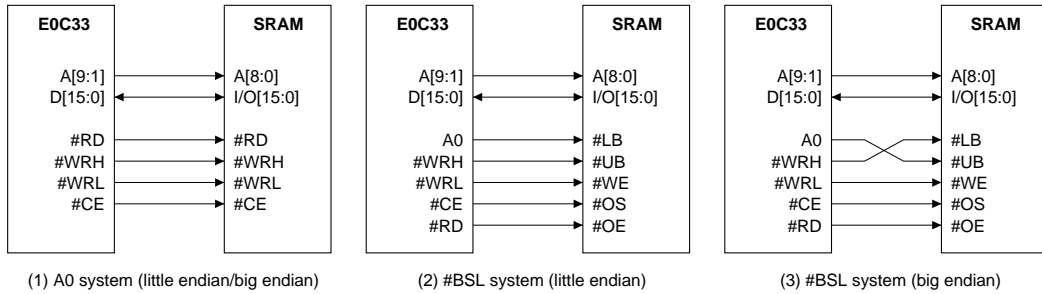


Figure II-4.20 Sample DRAM Connection

SRAM Read Cycles

Basic read cycle with no wait mode

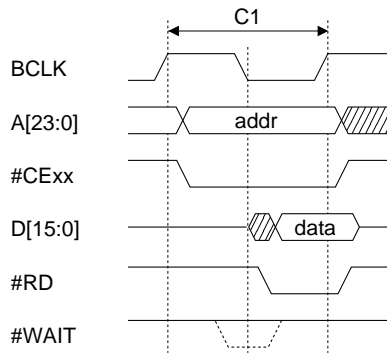


Figure II-4.21 Basic Read Cycle with No Wait

Read cycle with wait mode

Example: When the BCU has no internal wait mode and 2 wait cycles via #WAIT pin are inserted

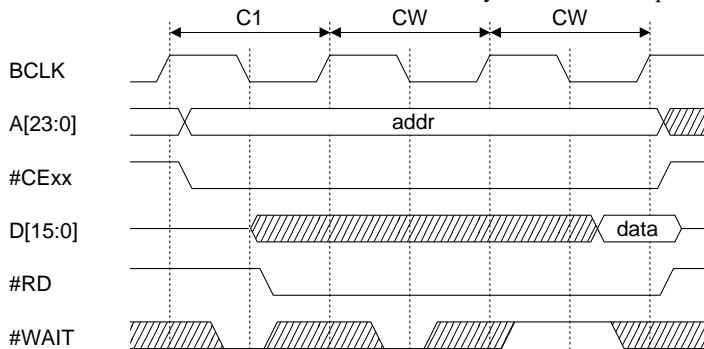


Figure II-4.22 Read Cycle with Wait

The #WAIT signal is sampled at the falling edge of the transition of BCLK (bus clock) and when it is sampled on an inactive (high level), the read cycle is terminated.

Note: Insertion of wait cycles via the #WAIT pin is possible only when the device for bus conditions is set for SRAM, and SWAIT (D0) / Bus control register (0x4812E) is enabled for waiting.

The above example shows a read cycle when a wait mode is inserted via the #WAIT signal. A wait mode consisting of 0 to 7 cycles can also be inserted using the wait control bits. The settings of these bits can also be used in combination with the #WAIT signal. In this case as well, the #WAIT signal is sampled at the falling edge of the transition of BCLK. However, even when the #WAIT signal is inactive before the wait cycles set by the wait control bits are terminated, the read cycle is not terminated at that time.

Precaution

#CE and address hold times at the rising edge of the #RD signal

In read cycles of this BCU, negating the #RD signal, negating the chip enable (#CE_{xx}) signal and changing the address (A[23:0]) occur simultaneously at the same clock edge. No hold time is inserted to the chip enable and address signals. The same applies even when an output disable delay time is inserted. Therefore when connecting a peripheral circuit, which changes its internal state by reading, to the bus, take a measure to insert a delay to the address and chip enable signals.

Output disable cycle

When an output disable cycle (set with output disable delay time parameter) is inserted, the chip enable (#CE_{xx}) signal temporarily goes high. This makes an interval between the next read cycle.

Note, however, that no output disable cycle is inserted when reading is continuously performed to the area that is accessed with the same chip enable signal.

SRAM Write Cycles

Basic write cycle with no wait mode

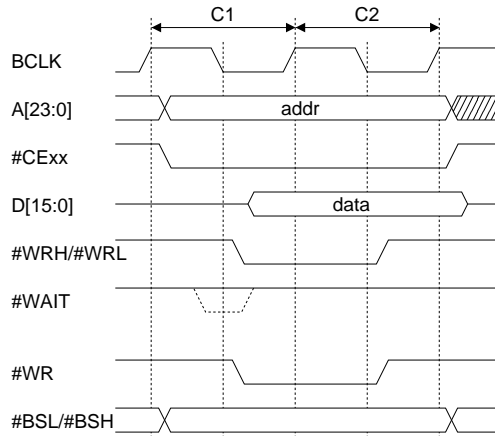


Figure II-4.23 Half-word Write Cycle with No Wait

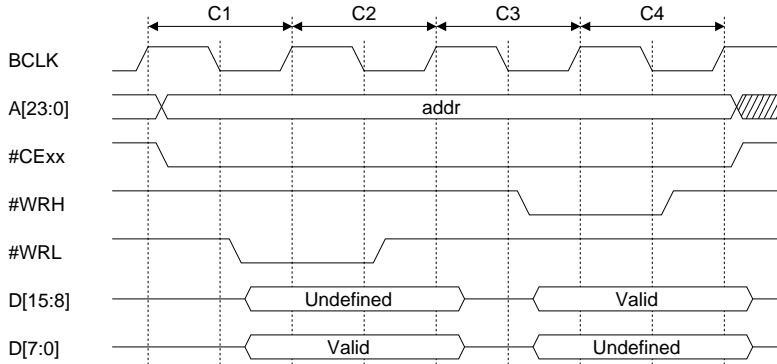


Figure II-4.24 Byte Write Cycle with No Wait (A0 system, little endian)

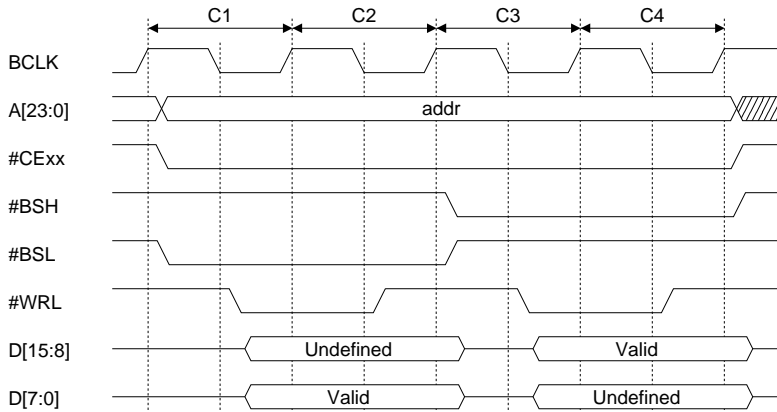


Figure II-4.25 Byte Write Cycle with No Wait (#BSL system, little endian)

Write cycle with wait mode

Example: When the BCU has no internal wait mode, and 1 wait cycle is inserted via the #WAIT pin

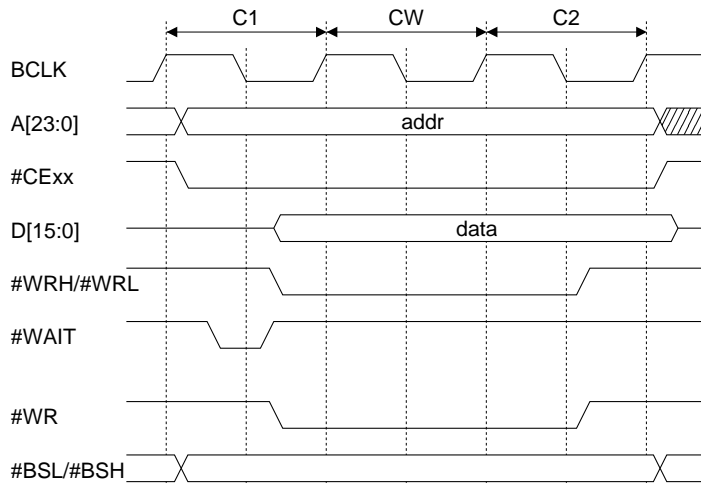


Figure II-4.26 Half-word Write Cycle with Wait

The #WAIT signal is sampled at the falling edge of the transition of BCLK (bus clock), and the write cycle is terminated in the cycle immediately following the cycle in which the #WAIT signal was sampled in an inactive (high level).

Note: Insertion of wait cycles via the #WAIT pin is possible only when the device for bus conditions is set to SRAM and SWAIT (D0) / Bus control register (0x4812E) is enabled for waiting.

The above example shows a write cycle when a wait mode is inserted via the #WAIT signal. A wait mode consisting of 2 to 7 cycles can also be inserted using the wait control bits. The settings of these bits also can be used in combination with the #WAIT signal. In this case as well, the #WAIT signal is sampled at the falling edge of the transition of BCLK. However, even when the #WAIT signal is inactive before the wait cycles set by the wait control bits are terminated, the write cycle is not terminated at that time.

Note: The basic write cycle consists of at least two cycles. This does not change regardless of whether zero or one wait cycle is set by the wait control bits. If the number of wait cycles set is 2 or more, the bus cycle is actually extended. In this case, the bus write cycle consists of [number of wait cycles + 1], as in the case of read cycles (providing that there is no external wait).

Burst ROM Read Cycles

Burst read cycle

Example: When 4-consecutive-burst and 2-wait cycles are set during the first access

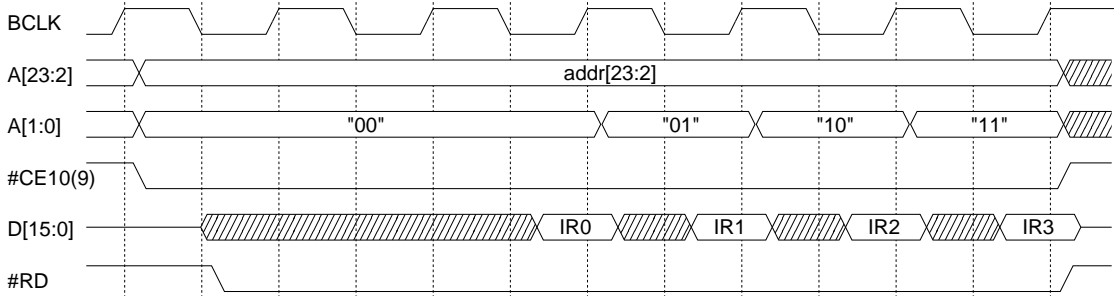


Figure II-4.27 Burst Read Cycle

A burst read cycle occurs when area 10 or 9 is set for burst ROM and one of those areas is accessed for the following reasons:

1) Instruction fetch

The burst read cycle is executed as long as a instruction fetch from contiguous addresses continues until
 A[2:1] = "11" (for 4-consecutive bursts); or
 A[3:1] = "111" (for 8-consecutive bursts)

2) Word (32-bit) data readout

Note: A 16-bit output is supported for the burst ROM. Set the device size to 16 bits.

Wait cycles during burst read

In the first bus operation, 0 to 7 wait cycles can be inserted using the wait control bits A10WT[2:0] (D[2:0]) / Areas 10–9 set-up register (0x48126) in the same way as for ordinary SRAM. For the wait cycles to be inserted in the burst cycle that follows, use a dedicated wait control bits, A10BW[1:0], which is only used for reading bursts. The wait cycles can be set in the range from 0 to 3 using these bits.

Note that no wait cycle via the #WAIT pin can be inserted into the burst-read cycle.

Write cycle to burst ROM area

If area 10 or 9 is set for burst ROM, a SRAM write cycle is executed when a write to that area is attempted. In this case, wait cycles via the #WAIT pin can be inserted.

DRAM Direct Interface

Outline of DRAM Interface

The BCU incorporates a DRAM direct interface that allows DRAM to be connected directly to areas 8 and 7 or areas 14 and 13. This interface supports the 2CAS method, so that column addresses can be set at between 8 and 11 bits. In addition, this interface supports a fast-page or an EDO-page mode (EDO DRAM directly connectable to areas) as well as random cycles. The refresh method (CAS-before-RAS refresh or self-refresh) and timing conditions (e.g., number of RAS/CAS cycles and number of precharge cycles) can be programmed using a control bit.

When selecting areas 8 and 7 or areas 14 and 13 to be used for DRAM, it depends on chip-enable settings using CEFUNC (D9) / DRAM timing set-up register (0x48130).

CEFUNC = "00": DRAM can be connected to areas 8 and 7 (default)

#CE8 and #CE7 function as #RAS0 and #RAS1, respectively.

CEFUNC ≠ "00": DRAM can be connected to areas 14 and 13.

#CE14 and #CE13 function as #RAS2 and #RAS3, respectively.

Figure II-4.28 shows a sample DRAM connection. Table II-4.15 and Table II-4.16 show examples of connectable DRAMs and typical configurations.

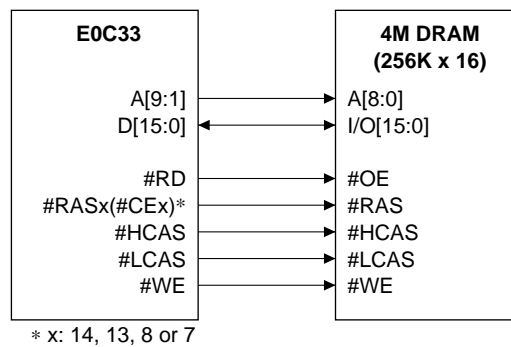


Figure II-4.28 Sample DRAM Connection

Table II-4.15 Connectable DRAM Example

DRAM	Number of devices	Number of Row bits	Number of Column bits	Memory size
1M (64K x 16)	1	8	8	128K bytes
4M (256K x 16)	1	9	9	512K bytes
16M (1M x 16)	1	12	8	2M bytes

Table II-4.16 DRAM Configuration Example (areas 7 and 8 only)

	Area 7	Area 8	Total memory size
1	I/O	DRAM (1M)	1M bits (128K bytes)
2	I/O	DRAM (4M)	4M bits (512K bytes)
3	I/O	DRAM (16M)	16M bits (2M bytes)
4	DRAM (1M)	DRAM (1M)	2M bits (256K bytes)
5	DRAM (4M)	DRAM (4M)	8M bits (1M bytes)
6	DRAM (16M)	DRAM (16M)	32M bits (4M bytes)

DRAM Setting Conditions

The DRAM interface allows the following conditions to be selected. Although DRAM can be used in areas 8 and 7 or areas 14 and 13, these condition are applied to all four areas and cannot be set individually for each area.

Table II-4.17 DRAM Interface Parameters

Parameter	Selectable condition	Initial setting	Control bits
Page mode	EDO page mode or Fast page mode	Fast page mode	REDO(DC)/Bus control register(0x4812E)
RAS mode	Successive RAS mode or Normal mode	Normal mode	CRAS(D8)/DRAM timing set-up register(0x48130)
Column address size	8, 9, 10 or 11 bits	8 bits	RCA[1:0](D[B:A])/Bus control register(0x4812E)
Refresh enable	Enabled or Disabled	Disabled	RPC2(D9)/Bus control register(0x4812E)
Refresh method	Self-refresh or CBR refresh	CBR refresh	RPC1(D8)/Bus control register(0x4812E)
Refresh RPC delay	2.0 or 1.0	1.0	RPC0(D7)/Bus control register(0x4812E)
Refresh RAS pulse width	2, 3, 4 or 5 cycles	2 cycles	RRA[1:0](D[6:5])/Bus control register(0x4812E)
Number of RAS precharge cycles	1, 2, 3 or 4 cycles	1 cycle	RPRC[1:0](D[7:6])/DRAM timing set-up register(0x48130)
CAS cycle control	1, 2, 3 or 4 cycles	1 cycle	CASC[1:0](D[4:3])/DRAM timing set-up register(0x48130)
RAS cycle control	1, 2, 3 or 4 cycles	1 cycle	RASC[1:0](D[1:0])/DRAM timing set-up register(0x48130)

Page mode

The DRAM interface allows EDO DRAM to be connected directly. Therefore, the EDO-page mode is supported along with the fast-page mode.

Use REDO to choose the desired page mode that suits the DRAM to be used.

REDO = "1": EDO page mode

REDO = "0": Fast page mode (default)

Successive RAS mode

For applications that require high-speed DRAM access, the DRAM interface supports a successive RAS mode. In this mode, even when successive accesses to the DRAM are not requested by the CPU or DMA, the #RAS signal is kept low and operation is continued without inserting any precharge cycle. Therefore, when accessing the same page (row address) of the DRAM that has been accessed previously, the page mode remains active, allowing read/write to be performed at high speeds.

However, to maintain the rated AC characteristics, one idle cycle is inserted when access in the page mode is begun and when finished.

CRAS is used to set the successive RAS mode.

CRAS = "1": Successive RAS mode

CRAS = "0": Normal mode (default)

The successive RAS mode is suspended by one of the following causes:

- a refresh cycle has occurred;
- bus control is requested by an external bus master;
- the requested device and page are not compatible with DRAM memory; and
- the slp or halt instruction is executed.

If the successive RAS mode is suspended, a precharge cycle is inserted before the next bus cycle begins.

Note: When using the successive RAS mode, always be sure to use #DRD for the read signal and #DWE for the low-byte write signal.

Column address size

When accessing DRAM, addresses are divided into a row address and a column address as they are output. Choose the size of this column address using RCA, as shown below.

Table II-4.18 Column Address Size

RCA1	RCA0	Column address size
1	1	11
1	0	10
0	1	9
0	0	8

The initial default size is 8 bits. Choose the desired size according to the address input pins of the DRAM to be used.

The row addresses output synchronously with falling edges of the #RAS signal are derived from the CPU's internal 28-bit addresses by logically shifting them to the right by an amount equal to the column address size. The MSB contains a 1. The column addresses are output to the address bus along with the falling edges of the #CAS signal. These addresses are derived directly from the CPU's internal 28-bit addresses.

Figure II-4.29 shows the contents of the row addresses thus output.

28-bit CPU internal address

27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	---	---	---	---	---	---	---	---	---	---

(1) Row address when column address is set to 8 bits

T	T	T	T	T	T	T	T	T	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8
---	---	---	---	---	---	---	---	---	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	---	---

(2) Row address when column address is set to 9 bits

T	T	T	T	T	T	T	T	T	T	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9
---	---	---	---	---	---	---	---	---	---	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	---

(3) Row address when column address is set to 10 bits

T	T	T	T	T	T	T	T	T	T	T	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10
---	---	---	---	---	---	---	---	---	---	---	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----

(4) Row address when column address is set to 11 bits

T	T	T	T	T	T	T	T	T	T	T	T	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11
---	---	---	---	---	---	---	---	---	---	---	---	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----	----

T = "1", 0–27: Bit number of CPU internal address

Figure II-4.29 Example of Row/Column Address Mapping

Refresh enable

Use RPC2 to enable or disable the internal refresh function.

RPC2 = "1": Enabled

RPC2 = "0": Disabled (default)

After choosing the desired refresh method using RPC1, write "1" to RPC2.

Refresh method

The DRAM interface supports both a CAS-before-RAS refresh cycle and a self-refresh cycle. Choose the desired method using RPC1.

RPC1 = "1": Self-refresh

RPC1 = "0": CAS-before-RAS refresh

The generation interval of the CAS-before-RAS refresh is determined by the underflow signal of an 8-bit programmable timer 0. Consequently, before the CAS-before-RAS refresh can be executed, the 8-bit programmable timer 0 must be set to obtain the necessary underflow timing. When this method is selected and RPC2 is enabled, the refresh cycle is generated each time the 8-bit programmable timer 0 underflows. The self-refresh is started by writing "1" to RPC2 while RPC1 = "1" and is terminated by clearing RPC1 or RPC2 to "0".

If RPC1 is switched over when RPC2 = "1" (refresh enabled), an undesirable self-refresh cycle is generated. So be sure to clear RPC2 to "0" (refresh disabled) before selecting the refresh method.

Refresh RPC delay

Use RPC0 to set the RPC delay value of a refresh cycle (a delay time from the immediately preceding precharge to the fall of #CAS).

RPC0 = "1": 2 cycles

RPC0 = "0": 1 cycle

Refresh RAS pulse width

Use RRA to set the #RAS pulse width of a CAS-before-RAS refresh cycle.

Table II-4.19 Refresh RAS Pulse Width

RRA1	RRA0	Pulse width
1	1	5 cycles
1	0	4 cycles
0	1	3 cycles
0	0	2 cycles

The initial default value is 2 cycles.

Number of RAS precharge cycles

Use RPRC to choose the number of RAS precharge cycles.

Table II-4.20 Number of RAS Precharge Cycles

RPRC1	RPRC0	Number of cycles
1	1	4 cycles
1	0	3 cycles
0	1	2 cycles
0	0	1 cycle

The initial default value is 1 cycle.

CAS cycle control

Use CASC to choose the number of CAS cycles when accessing DRAM.

Table II-4.21 Number of CAS Cycles

CASC1	CASC0	Number of cycles
1	1	4 cycles
1	0	3 cycles
0	1	2 cycles
0	0	1 cycle

The initial default value is 1 cycle.

RAS cycle control

Use RASC to choose the number of RAS cycles when accessing DRAM.

Table II-4.22 Number of RAS Cycles

RASC1	RASC0	Number of cycles
1	1	4 cycles
1	0	3 cycles
0	1	2 cycles
0	0	1 cycle

The initial default value is 1 cycle.

DRAM Read/Write Cycles

The following shows the basic bus cycles of DRAM.

The DRAM interface does not accept wait cycles inserted via the #WAIT pin.

DRAM random read cycle

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle

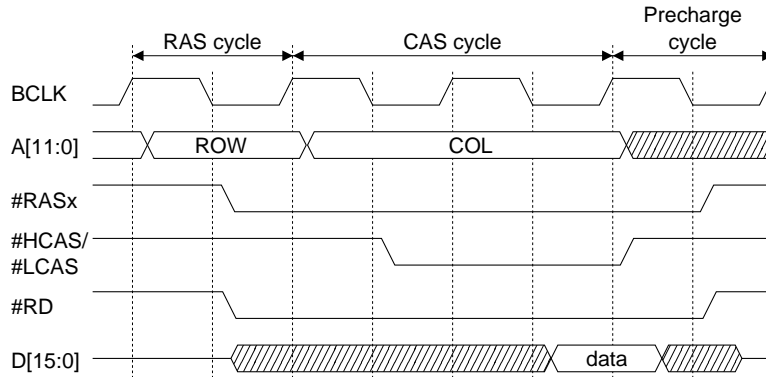


Figure II-4.30 DRAM Random Read Cycle

DRAM read cycle (fast page mode)

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle

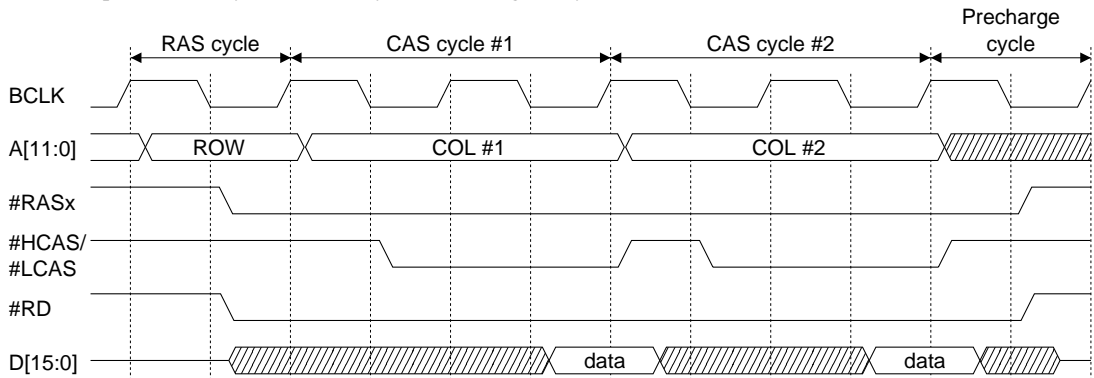


Figure II-4.31 DRAM Read Cycle (fast page mode)

DRAM read cycle (EDO page mode)

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle

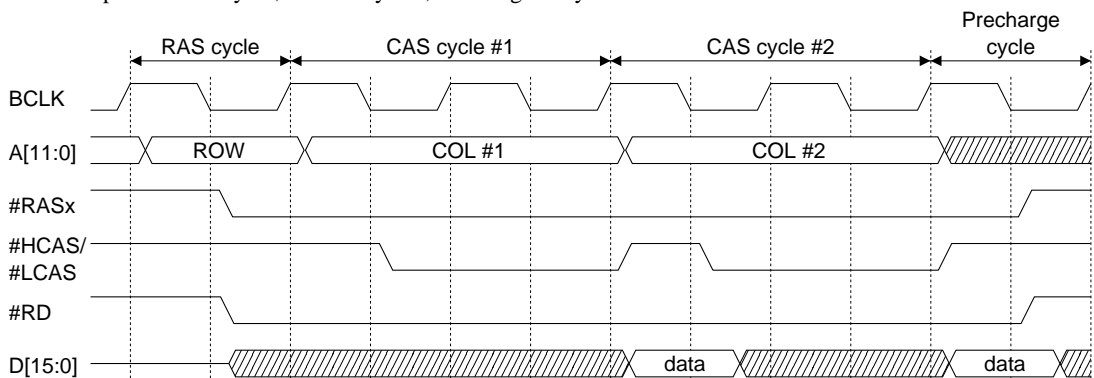


Figure II-4.32 DRAM Read Cycle (EDO page mode)

The read timing in EDO page-mode lags 0.5 cycles behind that in fast page mode.

DRAM random write cycle

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle

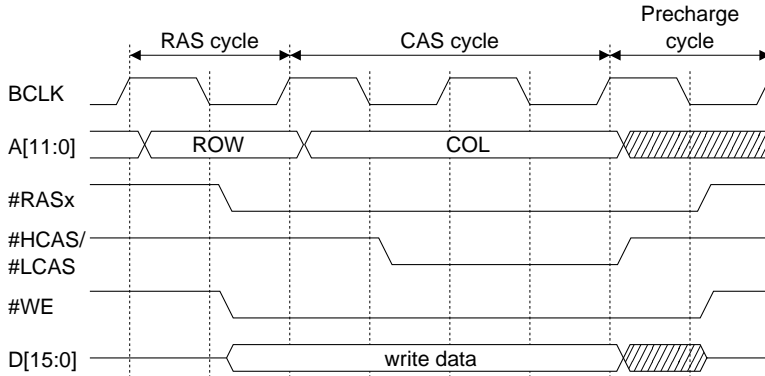


Figure II-4.33 2CAS Type DRAM Random Write Cycle

DRAM write cycle (fast page or EDO page mode)

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle; word-write sample

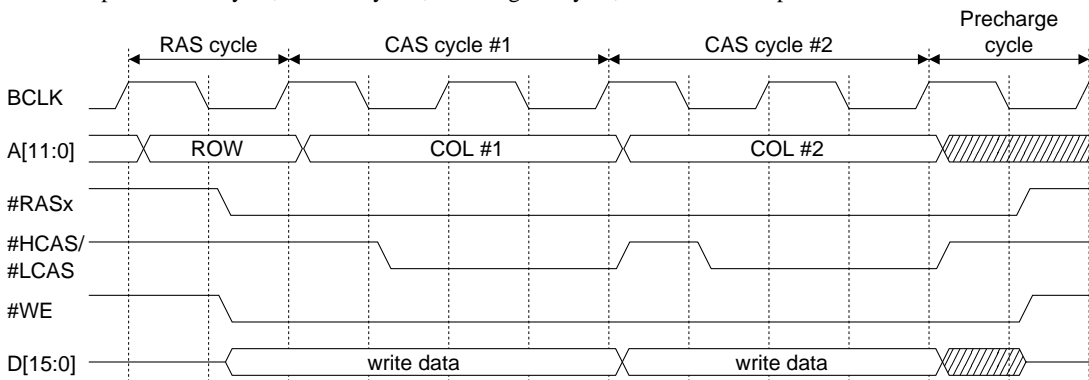


Figure II-4.34 DRAM Word-Write Cycle (fast page or EDO page mode)

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle; byte-write sample (little endian)

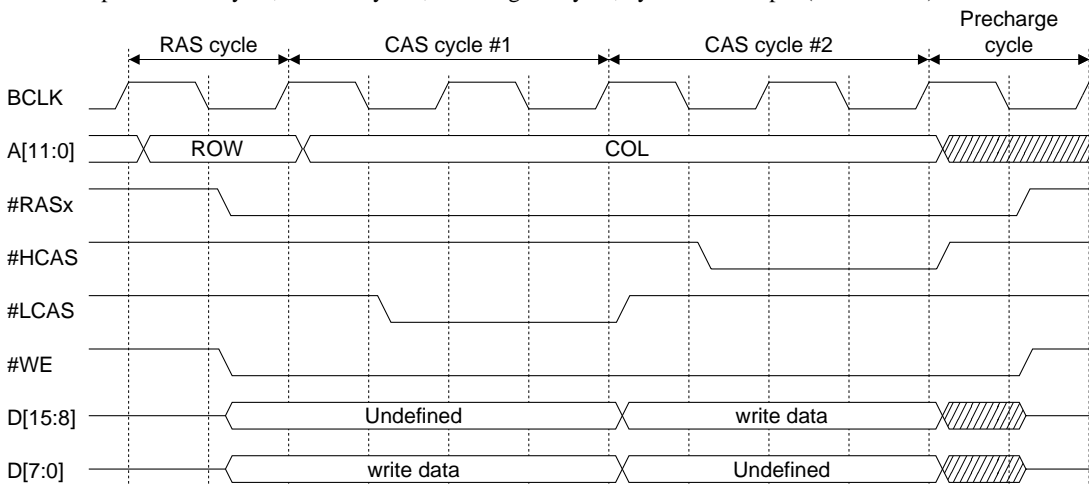


Figure II-4.35 DRAM Byte-Write Cycle (fast page or EDO page mode)

Operation in successive RAS mode

Example: RAS: 2 cycles; CAS: 1 cycle; Precharge: 2 cycles

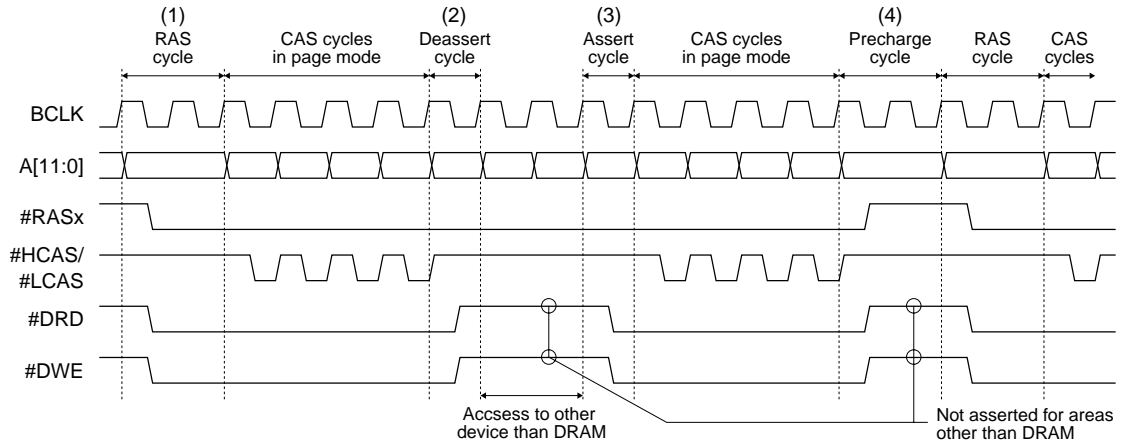


Figure II-4.36 Operation in Successive RAS Mode

- (1) When accessing the DRAM area, an ordinary RAS cycle is executed first.
- (2) If access to the same DRAM is suspended during a page mode, #RASx remains asserted while some other device is accessed. In this case, a cycle to temporarily deassert #DRD/#DWE is inserted before accessing the other device.
- (3) If access to the same page in the same DRAM area as in (1) is requested after (2), #DRD/#DWE is asserted back again to restart the page mode.
- (4) A precharge cycle is executed when one of the following conditions that cause the page mode to suspend is encountered:
 - access to different DRAM is requested;
 - access to a different page in the same DRAM area is requested;
 - access to some other device than DRAM is requested;
 - CAS-before-RAS refresh is requested; and
 - relinquishing of bus control is requested by an external bus master.

Note: When using the successive RAS mode, always be sure to use #DRD for the read signal and #DWE for the low-byte write signal.

DRAM Refresh Cycles

The DRAM interface supports a CAS-before-RAS refresh cycle and a self-refresh cycle.

CAS-before-RAS refresh cycle

Before performing a CAS-before-RAS refresh, set RPC2 to "1" while RPC1 = "0" in order to enable the DRAM refresh function. Once this is done, the BCU executes a CAS-before-RAS refresh by using the underflow signal that is output by the 8-bit programmable timer 0 as a trigger. Therefore, refresh generation timing can be programmed using the internal prescaler and 8-bit programmable timer 0.

For details on how to control the prescaler and 8-bit programmable timer 0, refer to "Prescaler and Operating Clock for Peripheral Circuits", and "8-Bit Programmable Timers".

Example: RPC delay: 1 cycle; Refresh RAS pulse width: 2 cycles; Precharge: 1 cycle

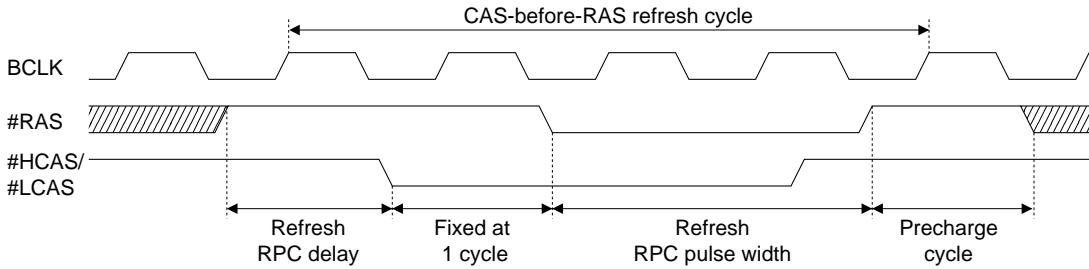


Figure II-4.37 CAS-Before-RAS Refresh

When the refresh cycle is terminated, the #HCAS/#LCAS signal boot timing is 0.5 cycles before that of #RAS. Consequently, the pulse width of #HCAS/#LCAS is determined by the refresh RAS pulse width that was set using RRA. The number of precharge cycles after the refresh cycle is defined by the value that was set using RPRC, the same value that is used for both random cycles and page mode accesses.

Self-refresh

To support DRAM chips equipped with a self-refresh function, the BCU has a function to generate a self-refresh cycle.

To start a self-refresh cycle, set RPC2 to "1" after setting RPC1 to "1". To deactivate a self-refresh cycle, write "0" to RPC1 or RPC2.

Example: RPC delay: 1 cycle

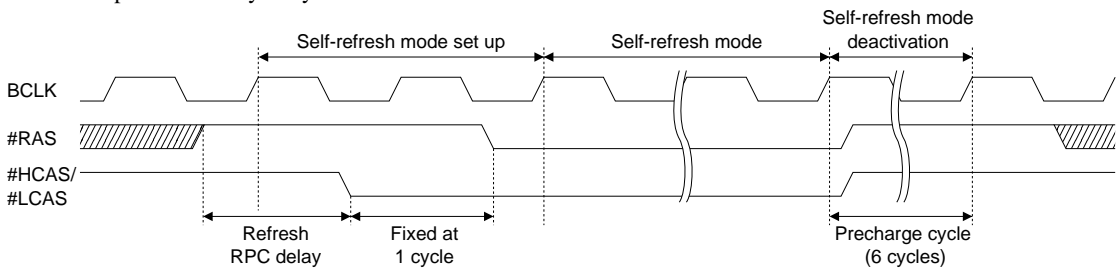


Figure II-4.38 Self-Refresh

For a self-refresh function as well, the RPC delay is determined by setting RPC0 in the same way as for a CAS-before-RAS refresh.

The refresh RAS pulse width is determined by the timing at which the refresh is deactivated in software and is unaffected by settings of RRA.

#RAS and #HCAS/#LCAS are booted up simultaneously upon completion of a self-refresh and the precharge duration that follows is fixed at 6 cycles.

Normally, DRAM specifications require that the contents of all row addresses be refreshed within a certain time before and after a self-refresh. To meet this requirement, make sure a CAS-before-RAS refresh is executed by a program. In this case, set the 8-bit programmable timer 0 so that the contents of all row addresses are refreshed within a predetermined time.

Note: If read from or write to the DRAM under a self-refresh is attempted, the BCU keeps #RAS and #HCAS/#LCAS low as it executes a read/write cycle. Other bus signals than #RAS and #HCAS/#LCAS (e.g., address, data, and control signals) change their state according to the specified conditions. Since said attempt initiates an invalid access to the DRAM, do not read from or write to the DRAM during a self-refresh.

Releasing External Bus

The external bus is normally controlled by the CPU, but the BCU is designed to release control of the bus ownership to an external device. This function is enabled by writing "1" to SEMAS (D2) / Bus control register (0x4812E) (disabled by default). The #BUSREQ (P34) and #BUSACK (P35) pins are used for control of the bus ownership. To direct the P34 and P35 pins for input/output of the #BUSREQ and #BUSACK signals, write "1" to CFP34 (D4) and CFP35 (D5) / P3 function select register (0x402DC [Byte]).

Sequence in which control of the bus is released

This sequence is described below.

1. The external bus master device requesting control of the bus ownership lowers the #BUSREQ pin.
2. The CPU keeps monitoring the status of the #BUSREQ pin, so that when this pin is lower, the CPU terminates the bus cycle being executed and places the signals listed below in high-impedance state one cycle later:
A[23:0], D[15:0], #RD, #WRL, #WRH, #HCAS, #LCAS, #CE_{xx}
Then the CPU lowers the #BUSACK pin to inform the external device that control of the bus ownership has been released.
3. One cycle later, the external bus starts its own bus cycle. The external bus master must hold the #BUSREQ pin low until the bus cycle is completed.
4. After completing the necessary bus cycles, the external bus master places the bus in high-impedance state and releases the #BUSREQ pin back high.
5. After confirming that the #BUSREQ pin is raised again, the CPU raises the #BUSACK pin one cycle later and resumes the processing that has been suspended.

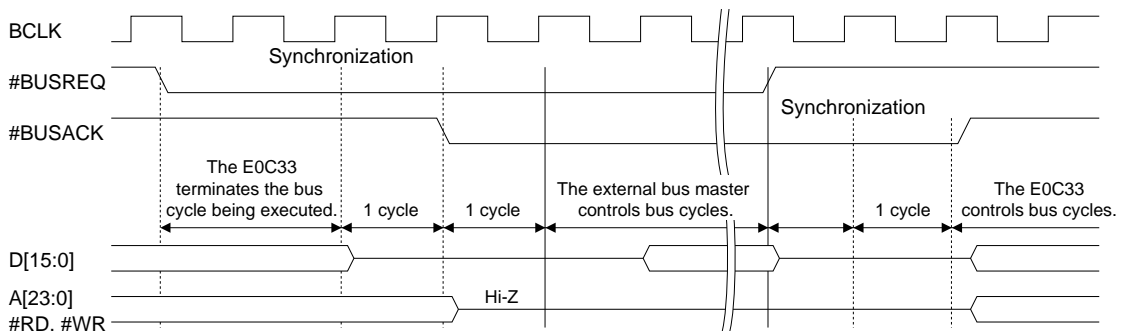


Figure II-4.39 External Bus Release Timing

If control of the bus ownership is requested during a DMA transfer by the internal DMA controller, the DMA transfer under way is suspended at a break in data to accept the request for bus ownership control. The DMA transfer that has been kept pending is restarted when the CPU gains control of the bus ownership.

DRAM refresh when bus ownership control is released

In systems where DRAM is connected directly, a refresh request could arise while control of the bus ownership is released from the CPU. In such a case, take one of the corrective measures described below.

- **Monitoring the output signal of the 8-bit programmable timer 0**

The underflow signal (DRAM refresh request) of the 8-bit programmable timer 0 can be output from the P10 I/O port pin.

If a refresh request arises while the external bus master is monitoring this output, release #BUSREQ back high to drop the request for bus ownership control.

Start a DRAM refresh cycle when control of the bus ownership is returned to the CPU.

To direct the P10 pin in order to output the underflow signal of the 8-bit programmable timer 0, write "1" to CFP10 (D0) / P1 function select register (0x402D4 [Byte]) and IOC10 (D0) / P1 I/O control register (0x402D6 [Byte]). Also, to output the underflow signal to an external device, write "1" to PTOUT0 (D2) / 8-bit Timer 0 control register (0x40160 [Byte]). For details about output control, refer to "8-Bit Programmable Timers".

- **Monitoring the #BUSGET signal**

The #BUSGET signal can be output from the P31 I/O port pin.

The #BUSGET signal is derived from logical sum of the following signals:

1. DRAM refresh request signal (output from the 8-bit programmable timer 0)
2. Interrupt request signal from the interrupt controller to the CPU
3. Startup request signal from the interrupt controller to the IDMA

If the #BUSGET signal is found to be active when the external bus master is monitoring it, release #BUSREQ back high to drop the request for bus ownership control.

When using the #BUSGET signal to only monitor a refresh request, set the interrupt controller in such a way that no interrupt request or IDMA startup request will be generated.

To direct the P31 pin for output of the #BUSGET signal, write "1" to CFP31 (D1) / P3 function select register (0x402DC [Byte]) and CFEX3 (D3) / Port function extension register (0x402DF [Byte]).

Power-down Control by External Device

In addition to requesting the releasing of bus ownership control described above, it is possible to place the CPU in a HALT state by using the #BUSREQ signal. This allows the CPU to be stopped during bus operation by an external bus master in order to conserve power.

This function is enabled by writing "1" to SEPD (D1) / Bus control register (0x4812E).

If SEPD = "1", the CPU and the BCU stop operating when the #BUSREQ pin is lowered, thus entering a HALT state. This HALT state is not cleared by an interrupt from the internal peripheral circuits and remains set until the #BUSREQ pin is released back high. Unlike in the case of ordinary releasing of the bus by #BUSREQ, the address bus and bus control signals are not placed in high-impedance state.

For a DRAM refresh request that may arise in this HALT state, take one of the corrective measures described above.

I/O Memory of BCU

Table II-4.23 shows the control bits of the BCU. These I/O memories are mapped into the area (0x48000 and following addresses) used for the internal 16-bit peripheral circuits. However, these I/O memories can be accessed in bytes or words, as well as in half-words.

For the control bits of the external system interface pins assigned to the I/O ports, and for details on how to control the 8-bit programmable timer 0 in order to generate a DRAM refresh cycle, refer to each corresponding section in this manual.

Table II-4.23 Control Bits of External System Interface

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Areas 18–15 set-up register	0048120 (HW)	DF	–	reserved		–	–	0 when being read.	
		DE	A18SZ	Areas 18–17 device size selection	1 8 bits 0 16 bits	0	R/W		
		DD	A18DF1	Areas 18–17 output disable delay time	A18DF[1:0] Number of cycles	1 1 3.5	1	R/W	
		DC	A18DF0			1 0 2.5			
						0 1 1.5			
						0 0 0.5			
		DB	–	reserved		–	–	0 when being read.	
		DA	A18WT2	Areas 18–17 wait control	A18WT[2:0] Wait cycles	1 1 1 7	1	R/W	
		D9	A18WT1			1 1 0 6			
		D8	A18WT0			1 0 1 5			
						1 0 0 4			
						0 1 1 3			
						0 1 0 2			
						0 0 1 1			
						0 0 0 0			
		D7	–	reserved		–	–	0 when being read.	
D6	A16SZ	Areas 16–15 device size selection	1 8 bits 0 16 bits	0	R/W				
D5	A16DF1	Areas 16–15 output disable delay time	A16DF[1:0] Number of cycles	1 1 3.5	1	R/W			
D4	A16DF0			1 0 2.5					
				0 1 1.5					
				0 0 0.5					
D3	–	reserved		–	–	0 when being read.			
D2	A16WT2	Areas 16–15 wait control	A16WT[2:0] Wait cycles	1 1 1 7	1	R/W			
D1	A16WT1			1 1 0 6					
D0	A16WT0			1 0 1 5					
				1 0 0 4					
				0 1 1 3					
				0 1 0 2					
				0 0 1 1					
				0 0 0 0					
Areas 14–13 set-up register	0048122 (HW)	DF–9	–	reserved		–	–	0 when being read.	
		D8	A14DRA	Area 14 DRAM selection	1 Used 0 Not used	0	R/W		
		D7	A13DRA	Area 13 DRAM selection	1 Used 0 Not used	0	R/W		
		D6	A14SZ	Areas 14–13 device size selection	1 8 bits 0 16 bits	0	R/W		
		D5	A14DF1	Areas 14–13 output disable delay time	A14DF[1:0] Number of cycles	1 1 3.5	1	R/W	
		D4	A14DF0			1 0 2.5			
						0 1 1.5			
						0 0 0.5			
		D3	–	reserved		–	–	0 when being read.	
		D2	A14WT2	Areas 14–13 wait control	A14WT[2:0] Wait cycles	1 1 1 7	1	R/W	
D1	A14WT1	1 1 0 6							
D0	A14WT0	1 0 1 5							
		1 0 0 4							
		0 1 1 3							
		0 1 0 2							
		0 0 1 1							
		0 0 0 0							

II CORE BLOCK: BCU (Bus Control Unit)

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Areas 12–11 set-up register	0048124 (HW)	DF–7	–	reserved	–	–	–	0 when being read.	
		D6	A12SZ	Areas 12–11 device size selection	1 8 bits 0 16 bits	0	R/W		
		D5	A12DF1	Areas 12–11 output disable delay time	A18DF[1:0] Number of cycles		1	R/W	
		D4	A12DF0		1 1 3.5	1			
					1 0 2.5				
					0 1 1.5				
					0 0 0.5				
		D3	–	reserved	–	–	–	0 when being read.	
		D2	A12WT2	Areas 12–11 wait control	A18WT[2:0] Wait cycles		1	R/W	
		D1	A12WT1		1 1 1 7	1			
D0	A12WT0	1 1 0 6	1						
		1 0 1 5							
		1 0 0 4							
		0 1 1 3							
			0 1 0 2						
			0 0 1 1						
			0 0 0 0						
Areas 10–9 set-up register	0048126 (HW)	DF	–	reserved	–	–	–	0 when being read.	
		DE	A10IR2	Area 10 internal ROM wait control	A10IR[2:0] ROM size		1	R/W	
		DD	A10IR1	Area 10 internal ROM size selection	1 1 1 2MB	1			
		DC	A10IR0		1 1 0 1MB	1			
					1 0 1 512KB				
					1 0 0 256KB				
					0 1 1 128KB				
					0 1 0 64KB				
					0 0 1 32KB				
					0 0 0 16KB				
		DB	–	reserved	–	–	–	0 when being read.	
		DA	A10BW1	Areas 10–9 burst ROM burst read cycle wait control	A10BW[1:0] Wait cycles		0	R/W	
		D9	A10BW0		1 1 3	0			
					1 0 2				
					0 1 1				
					0 0 0				
D8	A10DRA	Area 10 burst ROM selection	1 Used	0 Not used	0	R/W			
D7	A9DRA	Area 9 burst ROM selection	1 Used	0 Not used	0	R/W			
D6	A10SZ	Areas 10–9 device size selection	1 8 bits	0 16 bits	0	R/W			
D5	A10DF1	Areas 10–9 output disable delay time	A10DF[1:0] Number of cycles		1	R/W			
D4	A10DF0		1 1 3.5	1					
			1 0 2.5						
			0 1 1.5						
			0 0 0.5						
D3	–	reserved	–	–	–	0 when being read.			
D2	A10WT2	Areas 10–9 wait control	A10WT[2:0] Wait cycles		1	R/W			
D1	A10WT1		1 1 1 7	1					
D0	A10WT0		1 1 0 6	1					
			1 0 1 5						
			1 0 0 4						
			0 1 1 3						
			0 1 0 2						
			0 0 1 1						
			0 0 0 0						
Areas 8–7 set-up register	0048128 (HW)	DF–9	–	reserved	–	–	–	0 when being read.	
		D8	A8DRA	Area 8 DRAM selection	1 Used	0 Not used	0	R/W	
		D7	A7DRA	Area 7 DRAM selection	1 Used	0 Not used	0	R/W	
		D6	A8SZ	Areas 8–7 device size selection	1 8 bits	0 16 bits	0	R/W	
		D5	A8DF1	Areas 8–7 output disable delay time	A8DF[1:0] Number of cycles		1	R/W	
		D4	A8DF0		1 1 3.5	1			
					1 0 2.5				
					0 1 1.5				
					0 0 0.5				
		D3	–	reserved	–	–	–	0 when being read.	
D2	A8WT2	Areas 8–7 wait control	A8WT[2:0] Wait cycles		1	R/W			
D1	A8WT1		1 1 1 7	1					
D0	A8WT0		1 1 0 6	1					
			1 0 1 5						
			1 0 0 4						
			0 1 1 3						
			0 1 0 2						
			0 0 1 1						
			0 0 0 0						

II CORE BLOCK: BCU (Bus Control Unit)

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Areas 6–4 set-up register	004812A (HW)	DF–E	–	reserved	–	–	–	0 when being read.	
		DD	A6DF1	Area 6	A6DF[1:0]	Number of cycles	1	R/W	
		DC	A6DF0	output disable delay time	1 1	3.5	1	R/W	
					1 0	2.5			
					0 1	1.5			
					0 0	0.5			
		DB	–	reserved	–	–	–	–	0 when being read.
		DA	A6WT2	Area 6 wait control	A6WT[2:0]	Wait cycles	1	R/W	
		D9	A6WT1		1 1 1	7	1		
		D8	A6WT0		1 1 0	6	1		
					1 0 1	5			
					1 0 0	4			
					0 1 1	3			
					0 1 0	2			
					0 0 1	1			
				0 0 0	0				
D7	–	reserved	–	–	–	–	0 when being read.		
D6	A5SZ	Areas 5–4 device size selection	1 8 bits	0 16 bits	0	R/W			
D5	A5DF1	Areas 5–4 output disable delay time	A5DF[1:0]	Number of cycles	1	R/W			
D4	A5DF0		1 1	3.5	1	R/W			
			1 0	2.5					
			0 1	1.5					
			0 0	0.5					
D3	–	reserved	–	–	–	–	0 when being read.		
D2	A5WT2	Areas 5–4 wait control	A5WT[2:0]	Wait cycles	1	R/W			
D1	A5WT1		1 1 1	7	1				
D0	A5WT0		1 1 0	6	1				
			1 0 1	5					
			1 0 0	4					
			0 1 1	3					
		0 1 0	2						
		0 0 1	1						
		0 0 0	0						
Bus control register	004812E (HW)	DF	RBCLK	BCLK output control	1 Fixed at H	0 Enabled	0	R/W	
		DE	–	reserved	–	–	0	–	Writing 1 not allowed.
		DD	RBST8	Burst ROM burst mode selection	1 8-successive	0 4-successive	0	R/W	
		DC	REDO	DRAM page mode selection	1 EDO	0 Fast page	0	R/W	
		DB	RCA1	Column address size selection	RCA[1:0]	Size	0	R/W	
		DA	RCA0		1 1	11	0	R/W	
					1 0	10			
					0 1	9			
					0 0	8			
		D9	RPC2	Refresh enable	1 Enabled	0 Disabled	0	R/W	
		D8	RPC1	Refresh method selection	1 Self-refresh	0 CBR-refresh	0	R/W	
		D7	RPC0	Refresh RPC delay setup	1 2.0	0 1.0	0	R/W	
		D6	RRA1	Refresh RAS pulse width selection	RRA[1:0]	Number of cycles	0	R/W	
		D5	RRA0		1 1	5	0	R/W	
		1 0	4						
		0 1	3						
			0 0	2					
D4	–	reserved	–	–	0	–	Writing 1 not allowed.		
D3	SBUSST	External interface method selection	1 #BSL	0 A0	0	R/W			
D2	SEMAS	External bus master setup	1 Existing	0 Nonexistent	0	R/W			
D1	SEPD	External power-down control	1 Enabled	0 Disabled	0	R/W			
D0	SWAITE	#WAIT enable	1 Enabled	0 Disabled	0	R/W			

II CORE BLOCK: BCU (Bus Control Unit)

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
DRAM timing set-up register	0048130 (HW)	DF-C	-	reserved	-	-	-	0 when being read.
		DB	A3EEN	Area 3 emulation	1 Internal ROM 0 Emulation	1	R/W	
		DA	CEFUNC1	#CE pin function selection	CFFUNC[1:0] #CE output	0	R/W	
		D9	CEFUNC0		1 x #CE7/8..#CE17/18	0		
					0 1 #CE6..#CE17			
				0 0 #CE4..#CE10				
		D8	CRAS	Successive RAS mode setup	1 Successive 0 Normal	0	R/W	
		D7	RPRC1	DRAM RAS precharge cycles selection	RPRC[1:0] Number of cycles	0	R/W	
		D6	RPRC0		1 1 4	0		
					1 0 3			
					0 1 2			
				0 0 1				
D5	-	reserved	-	-	-	0 when being read.		
D4	CASC1	DRAM CAS cycles selection	CASC[1:0] Number of cycles	0	R/W			
D3	CASC0		1 1 4	0				
			1 0 3					
			0 1 2					
		0 0 1						
D2	-	reserved	-	-	-	0 when being read.		
D1	RASC1	DRAM RAS cycles selection	RASC[1:0] Number of cycles	0	R/W			
D0	RASC0		1 1 4	0				
			1 0 3					
			0 1 2					
		0 0 1						
Access control register	0048132 (HW)	DF	A18IO	Area 18, 17 internal/external access	1 Internal access 0 External access	0	R/W	
		DE	A16IO	Area 16, 15 internal/external access		0	R/W	
		DD	A14IO	Area 14, 13 internal/external access		0	R/W	
		DC	A12IO	Area 12, 11 internal/external access		0	R/W	
		DB	-	reserved	-	0	-	0 when being read.
		DA	A8IO	Area 8, 7 internal/external access	1 Internal access 0 External access	0	R/W	
		D9	A6IO	Area 6 internal/external access		0	R/W	
		D8	A5IO	Area 5, 4 internal/external access		0	R/W	
		D7	A18EC	Area 18, 17 endian control	1 Big endian 0 Little endian	0	R/W	
		D6	A16EC	Area 16, 15 endian control		0	R/W	
		D5	A14EC	Area 14, 13 endian control		0	R/W	
		D4	A12EC	Area 12, 11 endian control		0	R/W	
		D3	A10EC	Area 10, 9 endian control		0	R/W	
		D2	A8EC	Area 8, 7 endian control		0	R/W	
		D1	A6EC	Area 6 endian control		0	R/W	
		D0	A5EC	Area 5, 4 endian control		0	R/W	
G/A read signal control register	0048138 (HW)	DF	A18AS	Area 18, 17 address strobe signal	1 Enabled 0 Disabled	0	R/W	
		DE	A16AS	Area 16, 15 address strobe signal		0	R/W	
		DD	A14AS	Area 14, 13 address strobe signal		0	R/W	
		DC	A12AS	Area 12, 11 address strobe signal		0	R/W	
		DB	-	reserved	-	0	-	0 when being read.
		DA	A8AS	Area 8, 7 address strobe signal	1 Enabled 0 Disabled	0	R/W	
		D9	A6AS	Area 6 address strobe signal		0	R/W	
		D8	A5AS	Area 5, 4 address strobe signal		0	R/W	
		D7	A18RD	Area 18, 17 read signal	1 Enabled 0 Disabled	0	R/W	
		D6	A16RD	Area 16, 15 read signal		0	R/W	
		D5	A14RD	Area 14, 13 read signal		0	R/W	
		D4	A12RD	Area 12, 11 read signal		0	R/W	
		D3	-	reserved	-	0	-	0 when being read.
		D2	A8RD	Area 8, 7 read signal	1 Enabled 0 Disabled	0	R/W	
		D1	A6RD	Area 6 read signal		0	R/W	
		D0	A5RD	Area 5, 4 read signal		0	R/W	
BCLK select register	004813A (B)	D7-4	-	reserved	-	0	-	0 when being read.
		D3	A1X1MD	Area 1 access-speed	1 2 cycles 0 4 cycles	0	R/W	x2 speed mode only
		D2	-	reserved	-	0	-	0 when being read.
		D1	BCLKSEL1	BCLK output clock selection	BCLKSEL[1:0] BCLK	0	R/W	
D0	BCLKSEL0	1 1 PLL_CLK	0					
		1 0 OSC3_CLK						
		0 1 BCU_CLK						
		0 0 CPU_CLK						

A18SZ: Areas 18–17 device size selection (DE) / Areas 18–15 set-up register (0x48120)
A16SZ: Areas 16–15 device size selection (D6) / Areas 18–15 set-up register (0x48120)
A14SZ: Areas 14–13 device size selection (D6) / Areas 14–13 set-up register (0x48122)
A12SZ: Areas 12–11 device size selection (D6) / Areas 12–11 set-up register (0x48124)
A10SZ: Areas 10–9 device size selection (D6) / Areas 10–9 set-up register (0x48126)
A8SZ: Areas 8–7 device size selection (D6) / Areas 8–7 set-up register (0x48128)
A5SZ: Areas 5–4 device size selection (D6) / Areas 6–4 set-up register (0x4812A)

Select the size of the device connected to each area.

Write "1": 8 bits
 Write "0": 16 bits
 Read: Valid

A device size can be selected for every two areas.

An 8-bit size is selected by writing "1" to AxxSZ and a 16-bit size is selected by writing "0" to AxxSZ.

Area 6 has its first half (0x300000 through 0x37FFFF) fixed to an 8-bit device and the last half (0x380000 through 0x3FFFFFF) fixed to a 16-bit device.

At cold start, these bits are set to "0" (16 bits). At hot start, these bits retain their status before being initialized.

A18DF1–A18DF0: Areas 18–17 output disable delay time (D[D:C]) / Areas 18–15 set-up register (0x48120)
A16DF1–A16DF0: Areas 16–15 output disable delay time (D[5:4]) / Areas 18–15 set-up register (0x48120)
A14DF1–A14DF0: Areas 14–13 output disable delay time (D[5:4]) / Areas 14–13 set-up register (0x48122)
A12DF1–A12DF0: Areas 12–11 output disable delay time (D[5:4]) / Areas 12–11 set-up register (0x48124)
A10DF1–A10DF0: Areas 10–9 output disable delay time (D[5:4]) / Areas 10–9 set-up register (0x48126)
A8DF1–A8DF0: Areas 8–7 output disable delay time (D[5:4]) / Areas 8–7 set-up register (0x48128)
A6DF1–A6DF0: Area 6 output disable delay time (D[D:C]) / Areas 6–4 set-up register (0x4812A)
A5DF1–A5DF0: Areas 5–4 output disable delay time (D[5:4]) / Areas 6–4 set-up register (0x4812A)

Set the output-disable delay time.

Table II-4.24 Output Disable Delay Time

AxxDF1	AxxDF0	Delay time
1	1	3.5 cycles
1	0	2.5 cycles
0	1	1.5 cycles
0	0	0.5 cycles

When using a device that has a long output-disable time, set a delay time to ensure that no contention for the data bus occurs during the bus operation immediately after a device is read.

At cold start, these bits are set to "11" (3.5 cycles). At hot start, the bits retain their status before being initialized.

A18WT2–A18WT0: Areas 18–17 wait control (D[A:8]) / Areas 18–15 set-up register (0x48120)
A16WT2–A16WT0: Areas 16–15 wait control (D[2:0]) / Areas 18–15 set-up register (0x48120)
A14WT2–A14WT0: Areas 14–13 wait control (D[2:0]) / Areas 14–13 set-up register (0x48122)
A12WT2–A12WT0: Areas 12–11 wait control (D[2:0]) / Areas 12–11 set-up register (0x48124)
A10WT2–A10WT0: Areas 10–9 wait control (D[2:0]) / Areas 10–9 set-up register (0x48126)
A8WT2–A8WT0: Areas 8–7 wait control (D[2:0]) / Areas 8–7 set-up register (0x48128)
A6WT2–A6WT0: Area 6 wait control (D[A:8]) / Areas 6–4 set-up register (0x4812A)
A5WT2–A5WT0: Areas 5–4 wait control (D[2:0]) / Areas 6–4 set-up register (0x4812A)

Set the number of wait cycles to be inserted when accessing an SRAM device.

The values 0 through 7 written to the control bits equal the number of wait cycles inserted.

Note that the write cycle consists of a minimum of two cycles, so that a writing 0 or 1 is invalid.

When an SRAM device is connected, wait cycles derived via the #WAIT pin can also be inserted. In this case too, the wait cycles set by AxxWT are valid.

The DRAM read/write cycles do not have wait cycles inserted that are set by AxxWT or derived from the #WAIT pin.

The burst read cycle of a burst ROM (except for the first access) also does not have any wait cycle inserted. The first read cycle of a burst ROM and the write cycle to the burst ROM area have wait cycles inserted that are set by AxxWT. Wait cycles derived from the #WAIT pin also can be inserted in the cycle for writing to the burst ROM area.

II CORE BLOCK: BCU (Bus Control Unit)

At cold start, these bits are set to "111" (7 cycles). At hot start, the bits retain their status before being initialized.

A14DRA: Area 14 DRAM selection (D8) / Areas 14–13 set-up register (0x48122)

A13DRA: Area 13 DRAM selection (D7) / Areas 14–13 set-up register (0x48122)

A8DRA: Area 8 DRAM selection (D8) / Areas 8–7 set-up register (0x48128)

A7DRA: Area 7 DRAM selection (D7) / Areas 8–7 set-up register (0x48128)

Select the DRAM direct interface.

Write "1": DRAM is used

Write "0": DRAM is not used

Read: Valid

When DRAM is used by connecting it directly to the BCU, write "1" to this bit. The ordinary SRAM interface is selected by writing "0" to the control bit.

The areas to which DRAM can be connected are areas 8 and 7 when the CEFUNC = "0", or areas 14 and 13 when the bit = "1".

At cold start, these bits are set to "0" (DRAM not used). At hot start, the bits retain their status before being initialized.

A10IR2–A10IR0: Area 10 internal ROM size selection (D[D:B]) / Areas 10–9 set-up register (0x48126)

Select an area 10 internal/emulation memory size.

Table II-4.25 Area 10 Internal ROM Size

A10IR2	A10IR1	A10IR0	ROM size
0	0	0	16KB
0	0	1	32KB
0	1	0	64KB
0	1	1	128KB
1	0	0	256KB
1	0	1	512KB
1	1	0	1MB
1	1	1	2MB

At cold start, A10IR is set to "111" (2MB). At hot start, A10IR retains its status before being initialized.

A10BW1–A10BW0: Burst read cycle wait control (D[A:9]) / Areas 10–9 set-up register (0x48126)

Set the number of wait cycles inserted during a burst read.

The values 0 to 3 written to the bits constitute the number of wait cycles inserted. The contents set here are applied to both areas 10 and 9. The wait cycles set by AxxWT are inserted in the first read cycle of burst ROM and in the burst ROM write cycle. For the burst ROM write cycle, the wait cycles set via the #WAIT pin can also be used.

At cold start, A10BW is set to "0" (no wait cycle). At hot start, A10BW retains its status before being initialized.

A10DRA: Area 10 burst ROM selection (D8) / Areas 10–9 set-up register (0x48126)

A9DRA: Area 9 burst ROM selection (D7) / Areas 10–9 set-up register (0x48126)

Set areas 10 and 9 for use of burst ROM.

Write "1": Burst ROM is used

Write "0": Burst ROM is not used

Read: Valid

When using burst ROM, write "1" to the control bit. The ordinary SRAM interface is selected by writing "0" to the bit.

Area 9 can only be used when the CEFUNC = "00".

At cold start, these bits are set to "0" (burst ROM not used). At hot start, the bits retain their status before being initialized.

RBCLK: BCLK output control (DF) / Bus control register (0x4812E)

Control the bus clock BCLK to enable or disable external output.

Write "1": Fixed at high level

Write "0": Output enabled

Read: Valid

To stop outputting the bus clock from the BCLK pin, write "1" to RBCLK. When the clock output is stopped, the BCLK pin is fixed at high level. The bus clock output from the BCLK pin is enabled by writing "0" to RBCLK.

The bus clock output from the BCLK pin also is stopped in the HALT2 and the SLEEP modes.

At cold start, the RBCLK is set to "0" (output enabled). At hot start, RBCLK retains its status before being initialized.

RBST8: Burst mode selection (DD) / Bus control register (0x4812E)

Set the operation mode during a burst read.

Write "1": 8-successive-burst mode

Write "0": 4-successive-burst mode

Read: Valid

The 8-successive-burst mode is selected by writing "1" to RBST8 and the 4-successive-burst mode is selected by writing "0" to RBST8. This setting is valid when areas 10 and 9 are set for burst ROM, and the setting is applied to both areas simultaneously.

At cold start, RBST8 is set to "0" (4-successive-burst mode). At hot start, RBST8 retains its status before being initialized.

REDO: Page mode selection (DC) / Bus control register (0x4812E)

Select the page mode of DRAM.

Write "1": EDO-page mode

Write "0": Fast-page mode

Read: Valid

When using EDO DRAM, write "1" to REDO to select the EDO-page mode.

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, REDO is set to "0" (fast-page mode). At hot start, REDO retains its status before being initialized.

RCA1–RCA0: Column address size selection (D[B:A]) / Bus control register (0x4812E)

Select the column address size of DRAM.

Table II-4.26 Column Address Size

RCA1	RCA0	Column address size
1	1	11
1	0	10
0	1	9
0	0	8

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

RCA can be read to obtain its set value.

At cold start, RCA is set to "0" (8 bits). At hot start, RCA retain its status before being initialized.

RPC2: Refresh enable (D9) / Bus control register (0x4812E)

Control the DRAM refresh function.

Write "1": Enabled

Write "0": Disabled

Read: Valid

When DRAM is connected directly, a refresh cycle is generated by writing "1" to RPC2. The internal refresh function is disabled by writing "0" to RPC2.

Since the BCU stops operating in the HALT2 and the SLEEP modes, no refresh cycle is generated regardless of how this bit is set.

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, RPC2 is set to "0" (disabled). At hot start, RPC2 retains its status before being initialized.

RPC1: Refresh method selection (D8) / Bus control register (0x4812E)

Select the DRAM refresh method.

Write "1": Self-refresh

Write "0": CAS-before-RAS refresh

Read: Valid

To perform a CAS-before-RAS refresh, set RPC1 to "0" and then RPC2 to "1". This causes the underflow output signal of the 8-bit programmable timer 0 is fed to the DRAM interface, at which timing a refresh cycle is generated.

To start a self-refresh, set RPC1 to "1" and then RPC2 to "1". The self-refresh is disabled by writing "0" to RPC2.

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, RPC1 is set to "0" (CAS-before-RAS refresh). At hot start, RPC1 retains its status before being initialized.

RPC0: Refresh RPC delay (D7) / Bus control register (0x4812E)

Set a RPC delay when at start of refresh.

Write "1": 2 cycles

Write "0": 1 cycle

Read: Valid

Set a time from the immediately preceding precharge to the falling transition of #HCAS/#LCAS necessary in order to perform a refresh. This time is 2 cycles when RPC0 = "1" or 1 cycle when RPC0 = "0".

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, RPC0 is set to "0" (1 cycle). At hot start, RPC0 retains its status before being initialized.

RRA1–RRA0: Refresh RAS pulse width selection (D[6:5]) / Bus control register (0x4812E)

Select the RAS pulse width of a CAS-before-RAS refresh.

Table II-4.27 Refresh RAS Pulse Width

RRA1	RRA0	Pulse width
1	1	5 cycles
1	0	4 cycles
0	1	3 cycles
0	0	2 cycles

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

The RRA can be read to obtain their set value.

At cold start, RRA is set to "0" (2 cycles). At hot start, RRA retains its status before being initialized.

SBUSST: External interface method select register (D3) / Bus control register (0x4812E)

Select the interface method of an SRAM device.

Write "1": #BSL system

Write "0": A0 system

Read: Valid

When using the #BSL system, write "1" to SBUSST.

The contents set here are applied to all areas that are set for the SRAM type.

At cold start, SBUSST is set to "0" (A0 system). At hot start, SBUSST retains its status before being initialized.

SEMAS: External bus master setup (D2) / Bus control register (0x4812E)

Specify whether an external bus master exists.

Write "1": Existing

Write "0": Nonexistent

Read: Valid

A request for bus ownership control via the #BUSREQ pin is made acceptable by writing "1" to SEMAS. If the system does not have any external bus master, fix this register at "0".

At cold start, SEMAS is set to "0" (nonexistent). At hot start, SEMAS retains its status before being initialized.

SEPD: External power-down control (D1) / Bus control register (0x4812E)

Enable or disable the CPU's power-down control by an external bus master.

Write "1": Enabled

Write "0": Disabled

Read: Valid

Power-down control via an external pin (#BUSREQ) is enabled by writing "1" to SEPD. If the #BUSREQ pin is lowered when external power-down control is thus enabled, the CPU is placed in a HALT state, allowing for reduction in power consumption.

At cold start, SEPD is set to "0" (disabled). At hot start, SEPD retains its status before being initialized.

SWAITE: #WAIT enable (D0) / Bus control register (0x4812E)

Enable or disable wait cycle control via the #WAIT pin.

- Write "1": Enabled
- Write "0": Disabled
- Read: Valid

A wait request from an SRAM device is made acceptable by writing "1" to SWAITE. The wait request signal input from the #WAIT pin is sampled at each falling edge of the bus clock when executing an SRAM read/write cycle. Wait cycles are inserted until the wait request signal is sampled and detected as high (inactive).

Wait control for 0 to 7 cycles can be accomplished by AxxWT without using the #WAIT pin. However, since the setting via AxxWT is applied to every two areas, the number of wait cycles may be controlled individually in each area or more than 7 wait cycles may be set. In such a case, use an external wait request via the #WAIT pin.

Wait requests from the #WAIT pin are ignored when SWAITE = "0".

The contents set here are applied to all areas that are set for SRAM, and are also effective for write cycles in the areas that are set for burst ROM.

At cold start, SWAITE is set to "0" (disabled). At hot start, SWAITE retains its status before being initialized.

A3EEN: Area 3 emulation (DB) / DRAM timing set-up register (0x48130)

Select area 3 emulation mode.

- Write "1": Internal ROM mode
- Write "0": Emulation mode
- Read: Valid

When "1" is written to A3EEN, internal ROM emulation mode is selected and the external device will be accessed with the same condition as the internal ROM. When "0" is written, the internal ROM will be used for accessing area 3. This bit functions the same as the EA3MD pin. The bit status and the pin status are logically ORED.

At cold start, A3EEN is set to "1" (internal ROM mode). At hot start, A3EEN retains its status before being initialized.

CEFUNC1–CEFUNC0: #CE pin function selection (D[A:9]) / DRAM timing set-up register (0x48130)

Change the #CE pin-assigned area.

Table II-4.28 #CE Output Assignment

Pin	CEFUNC = "00"	CEFUNC = "01"	CEFUNC = "1x"
#CE4	#CE4	#CE11	#CE11+#CE12
#CE5	#CE5	#CE15	#CE15+#CE16
#CE6	#CE6	#CE6	#CE7+#CE8
#CE7/#RAS0	#CE7/#RAS0	#CE13/#RAS2	#CE13/#RAS2
#CE8/#RAS1	#CE8/#RAS1	#CE14/#RAS3	#CE14/#RAS3
#CE9	#CE9	#CE17	#CE17+#CE18
#CE10EX	#CE10EX	#CE10EX	#CE9+#CE10EX

(Default: CEFUNC = "00")

The high-order areas that are made available for use by writing "01" to CEFUNC can be larger in size than the default low-order areas. For example, when using DRAM in default settings, the available space is 4MB in areas 7 and 8. However, if areas 13 and 14 are used, up to 32MB of DRAM can be used. The same applies to the other areas.

Furthermore, when CEFUNC is set to "10" or "11", four chip enable signal is expanded into two area size.

At cold start, CEFUNC is set to "00". At hot start, CEFUNC retains its status before being initialized.

CRAS: Successive RAS mode (D8) / DRAM timing set-up register (0x48130)

Set the successive RAS mode.

Write "1": Successive RAS mode
 Write "0": Normal mode
 Read: Valid

In systems using DRAM, the successive RAS mode is entered by writing "1" to CRAS. In this mode, read/write operations can be performed in page mode even when DRAM accesses do not occur back-to-back. When using the successive RAS mode, be sure to use #DRD for the read signal and #DWE for the write signal for low-byte.

When CRAS = "0", random read/write cycles are used for non-successive DRAM accesses.

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, CRAS is set to "0" (normal mode). At hot start, CRAS retains its status before being initialized.

RPRC1–RPRC0: Number of RAS precharge cycles (D[7:6]) / DRAM timing set-up register (0x48130)

Select the number of precharge cycles during a DRAM access.

Table II-4.29 Number of RAS Precharge Cycles

RPRC1	RPRC0	Number of cycles
1	1	4 cycles
1	0	3 cycles
0	1	2 cycles
0	0	1 cycle

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, RPRC is set to "0" (1 cycle). At hot start, RPRC retains its status before being initialized.

CASC1–CASC0: Number of CAS cycles (D[4:3]) / DRAM timing set-up register (0x48130)

Select the number of CAS cycles during a DRAM access.

Table II-4.30 Number of CAS Cycles

CASC1	CASC0	Number of cycles
1	1	4 cycles
1	0	3 cycles
0	1	2 cycles
0	0	1 cycle

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, CASC is set to "0" (1 cycle). At hot start, CASC retains its status before being initialized.

RASC1–RASC0: Number of RAS cycles (D[1:0]) / DRAM timing set-up register (0x48130)

Select the number of RAS cycles during a DRAM access.

Table II-4.31 Number of RAS Cycles

RASC1	RASC0	Number of cycles
1	1	4 cycles
1	0	3 cycles
0	1	2 cycles
0	0	1 cycle

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, RASC is set to "0" (1 cycle). At hot start, RASC retains its status before being initialized.

II CORE BLOCK: BCU (Bus Control Unit)

A18IO: Areas 18–17 internal/external access selection (DF) / Access control register (0x48132)
A16IO: Areas 16–15 internal/external access selection (DE) / Access control register (0x48132)
A14IO: Areas 14–13 internal/external access selection (DD) / Access control register (0x48132)
A12IO: Areas 12–11 internal/external access selection (DC) / Access control register (0x48132)
A8IO: Areas 8–7 internal/external access selection (DA) / Access control register (0x48132)
A6IO: Area 6 internal/external access selection (D9) / Access control register (0x48132)
A5IO: Areas 5–4 internal/external access selection (D8) / Access control register (0x48132)

Select either internal access or external access for each area.

Write "1": Internal access
Write "0": External access
Read: Valid

When AxxIO is set to "1", the internal device that mapped to the corresponding area is accessed. When AxxIO is set to "0", the external device is accessed.

At cold start, these bits are set to "0" (external access). At hot start, these bits retain their status before being initialized.

A18EC: Areas 18–17 little/big endian method selection (D7) / Access control register (0x48132)
A16EC: Areas 16–15 little/big endian method selection (D6) / Access control register (0x48132)
A14EC: Areas 14–13 little/big endian method selection (D5) / Access control register (0x48132)
A12EC: Areas 12–11 little/big endian method selection (D4) / Access control register (0x48132)
A10EC: Areas 10–9 little/big endian method selection (D3) / Access control register (0x48132)
A8EC: Areas 8–7 little/big endian method selection (D2) / Access control register (0x48132)
A6EC: Area 6 little/big endian method selection (D1) / Access control register (0x48132)
A5EC: Areas 5–4 little/big endian method selection (D0) / Access control register (0x48132)

Select either little endian or big-endian method for accessing each area.

Write "1": Big-endian
Write "0": Little-endian
Read: Valid

When AxxEC is set to "1", the corresponding area is accessed in big-endian method. When AxxEC is set to "0", the area is accessed in little-endian method. When using area 10 as the boot area, fix A10EC at "0" (little-endian).

At cold start, these bits are set to "0" (little-endian). At hot start, these bits retain their status before being initialized.

A18AS: Areas 18–17 address strobe signal (DF) / G/A read signal control register (0x48138)
A16AS: Areas 16–15 address strobe signal (DE) / G/A read signal control register (0x48138)
A14AS: Areas 14–13 address strobe signal (DD) / G/A read signal control register (0x48138)
A12AS: Areas 12–11 address strobe signal (DC) / G/A read signal control register (0x48138)
A8AS: Areas 8–7 address strobe signal (DA) / G/A read signal control register (0x48138)
A6AS: Area 6 address strobe signal (D9) / G/A read signal control register (0x48138)
A5AS: Areas 5–4 address strobe signal (D8) / G/A read signal control register (0x48138)

Enable/disable the exclusive address strobe signal output.

Write "1": Enabled
Write "0": Disabled
Read: Valid

If AxxAS is set to "1", the exclusive address strobe signal is output from #GAAS (P21) pin when the corresponding area is accessed. If AxxAS is set to "0", the signal output is disabled.

At cold start, these bits are set to "0" (disabled). At hot start, these bits retain their status before being initialized.

A18RD: Areas 18–17 read signal (D7) / G/A read signal control register (0x48138)
A16RD: Areas 16–15 read signal (D6) / G/A read signal control register (0x48138)
A14RD: Areas 14–13 read signal (D5) / G/A read signal control register (0x48138)
A12RD: Areas 12–11 read signal (D4) / G/A read signal control register (0x48138)
A8RD: Areas 8–7 read signal (D2) / G/A read signal control register (0x48138)
A6RD: Area 6 read signal (D1) / G/A read signal control register (0x48138)
A5RD: Areas 5–4 read signal (D0) / G/A read signal control register (0x48138)

Enable/disable the exclusive read signal output.

Write "1": Enabled
 Write "0": Disabled
 Read: Valid

If AxxRD is set to "1", the exclusive read signal is output from #GARD (P31) pin when the corresponding area is read. If AxxRD is set to "0", the signal output is disabled.

At cold start, these bits are set to "0" (disabled). At hot start, these bits retain their status before being initialized.

BCLKSEL1–BCLKSEL0: BCLK output clock selection (D[1:0]) / BCLK select register (0x4813A)

Select a clock to be output from the BCLK pin.

Table II-4.32 Selection of BCLK Output Clock

BCLKSEL1	BCLKSEL0	Output clock
1	1	PLL_CLK (PLL output clock)
1	0	OSC3_CLK (OSC3 oscillation clock)
0	1	BCU_CLK (BCU operating clock)
0	0	CPU_CLK (CPU operating clock)

PLL_CLK: PLL output clock. This clock is stable and kept as output except in the following cases:

1. When the PLL is off by setting the PLLS[1:0] pins.
2. When the OSC3 (high-speed) oscillation is stopped by executing the SLP instruction.
3. When the OSC3 (high-speed) oscillation is stopped using the CLG register.

Note that the PLL_CLK clock is out of phase with the CPU operating clock.

OSC3_CLK: OSC3 (high-speed) oscillation circuit output clock. This clock is stable and kept as output except in the following cases:

1. When the OSC3 (high-speed) oscillation is stopped by executing the SLP instruction.
2. When the OSC3 (high-speed) oscillation is stopped using the CLG register.

Note that the OSC3_CLK clock is out of phase with the CPU operating clock.

BCU_CLK: Bus clock in the bus controller. This clock varies according to the bus cycle speed. Furthermore, the clock frequency changes dynamically in x2 speed mode as follows:

1. When the internal RAM/ROM is accessed, x2 clock (e.g., 50 MHz same as the CPU operating clock) is output.
2. When an external device is accessed via the external bus, x1 clock (e.g., 25 MHz) is output. This dynamic change (e.g., between 50 MHz and 25 MHz) does not affect the external memory access timing, such as position relationship between the rising or falling edge of the 25 MHz clock and the falling edge of the #WR signal. (It is the same as that in the x1 speed mode with 25 MHz clock.)

CPU_CLK: The CPU operating clock. The clock frequency is as follows:

1. Equals to the PLL output clock frequency when the PLL is on.
2. Equals to the OSC3 (high-speed) oscillation circuit output clock frequency when the PLL is off.
3. However, it equals to the divided frequency when the CLG is set to generate the CPU operating clock by dividing the source clock.
4. When the CPU stops by the HALT or SLP instruction, this clock is also stopped.

This clock is almost in phase with the bus clock.

At initial reset, BCLKSEL is set to "0" (CPU_CLK).

A1X1MD: Area 1 access speed (D3) / BCLK select register (0x4813A)

Select a number of access cycles for area 1 in x2 speed mode.

Write "1": 2 cycles

Write "0": 4 cycles

Read: Valid

When x2 speed mode is set (#X2SPD pin = L) and A1X1MD = "1", area 1 is read/written in 2 cycles of the CPU system clock.

When A1X1MD = "0", area 1 is read/written in 4 cycles.

When x1 speed mode is set (#X2SPD pin = H), area 1 is always accessed in 2 cycles regardless of the A1X1MD value.

At cold start, A1X1MD is set to "0" (4 cycles). At hot start, A1X1MD retains its status before being initialized.

II-5 ITC (Interrupt Controller)

The C33 Core Block contains an interrupt controller, making it possible to control all interrupts generated by the internal peripheral circuits. This section explains the functions of this interrupt controller centering around the method for controlling maskable interrupts. For details about the various factors and conditions under which interrupts are generated, refer to the description of each peripheral circuit in this manual.

Outline of Interrupt Functions

Maskable Interrupts

The ITC can handle 39 kinds of maskable interrupts as shown in the table below.

Table II-5.1 List of Maskable Interrupts

No.	HEX No.	Vector number (Hex address)	Interrupt system (Peripheral circuit)	Interrupt factor	IDMA Ch.	Priority
1	10	16(Base+40)	Port input interrupt 0	Edge (rising or falling) or level (High or Low)	1	High ↑
2	11	17(Base+44)	Port input interrupt 1	Edge (rising or falling) or level (High or Low)	2	
3	12	18(Base+48)	Port input interrupt 2	Edge (rising or falling) or level (High or Low)	3	
4	13	19(Base+4C)	Port input interrupt 3	Edge (rising or falling) or level (High or Low)	4	
5	14	20(Base+50)	Key input interrupt 0	Rising or falling edge	–	
6	15	21(Base+54)	Key input interrupt 1	Rising or falling edge	–	
7	16	22(Base+58)	High-speed DMA Ch.0	High-speed DMA Ch.0, end of transfer	5	
8	17	23(Base+5C)	High-speed DMA Ch.1	High-speed DMA Ch.1, end of transfer	6	
9	18	24(Base+60)	High-speed DMA Ch.2	High-speed DMA Ch.2, end of transfer	–	
10	19	25(Base+64)	High-speed DMA Ch.3	High-speed DMA Ch.3, end of transfer	–	
11	1A	26(Base+68)	IDMA	Intelligent DMA, end of transfer	–	
–	–	27–29	reserved	–	–	
12	1E	30(Base+78)	16-bit programmable timer 0	Timer 0 comparison B	7	
13	1F	31(Base+7C)		Timer 0 comparison A	8	
–	–	32–33	reserved	–	–	
14	22	34(Base+88)	16-bit programmable timer 1	Timer 1 comparison B	9	
15	23	35(Base+8C)		Timer 1 comparison A	10	
–	–	36–37	reserved	–	–	
16	26	38(Base+98)	16-bit programmable timer 2	Timer 2 comparison B	11	
17	27	39(Base+9C)		Timer 2 comparison A	12	
–	–	40–41	reserved	–	–	
18	2A	42(Base+A8)	16-bit programmable timer 3	Timer 3 comparison B	13	
19	2B	43(Base+AC)		Timer 3 comparison A	14	
–	–	44–45	reserved	–	–	
20	2E	46(Base+B8)	16-bit programmable timer 4	Timer 4 comparison B	15	
21	2F	47(Base+BC)		Timer 4 comparison A	16	
–	–	48–49	reserved	–	–	
22	32	50(Base+C8)	16-bit programmable timer 5	Timer 5 comparison B	17	
23	33	51(Base+CC)		Timer 5 comparison A	18	
24	34	52(Base+D0)	8-bit programmable timer	Timer 0 underflow	19	
25	35	53(Base+D4)		Timer 1 underflow	20	
26	36	54(Base+D8)		Timer 2 underflow	21	
27	37	55(Base+DC)		Timer 3 underflow	22	
28	38	56(Base+E0)		Serial interface Ch.0	Receive error	–
29	39	57(Base+E4)	Receive buffer full		23	
30	3A	58(Base+E8)	Transmit buffer empty		24	
–	–	59	reserved	–	–	
31	3C	60(Base+F0)	Serial interface Ch.1	Receive error	–	
32	3D	61(Base+F4)		Receive buffer full	25	
33	3E	62(Base+F8)		Transmit buffer empty	26	
–	–	63	reserved	–	–	
34	40	64(Base+100)	A/D converter	A/D converter, end of conversion	27	
35	41	65(Base+104)	Clock timer	Falling edge of 32 Hz, 8 Hz, 2 Hz or 1 Hz signal 1-minute, 1-hour or specified time count up	–	
–	–	66–67	reserved	–	–	
36	44	68(Base+110)	Port input interrupt 4	Edge (rising or falling) or level (High or Low)	28	
37	45	69(Base+114)	Port input interrupt 5	Edge (rising or falling) or level (High or Low)	29	
38	46	70(Base+118)	Port input interrupt 6	Edge (rising or falling) or level (High or Low)	30	
39	47	71(Base+11C)	Port input interrupt 7	Edge (rising or falling) or level (High or Low)	31	↓ Low

Contents of table

"Hex No." indicates an interrupt number in hexadecimal value.

"Vector number (Address)" indicates the trap table's vector number. The numerals in parentheses show an offset (in bytes) from the starting address (Base) of the trap table. The starting address (Base) of the trap table by default is the boot address, 0xC00000 set at an initial reset. This address can be changed using the TTBR register (0x48134 to 0x48137).

For details about the trap table contents including exception factors, etc., refer to the "E0C33000 Core CPU Manual".

"Interrupt system (Peripheral circuit)" indicates that interrupt levels can be programmed for each peripheral circuit written.

"Interrupt factor" indicates the factor of the interrupt occurring in each interrupt system.

"IDMA Ch." indicates that an interrupt factor which has a numeric value in this column can start up the intelligent DMA (IDMA) to transfer data when an interrupt factor occurs. The numeric value indicates the IDMA's channel number. Interrupt factors that do not have a numeric value here cannot start up the IDMA.

"Priority" indicates the priority of interrupts in cases when all interrupt systems are set to the same interrupt level. If two or more interrupt factors occur simultaneously, interrupt requests are accepted in order of highest priority. Interrupt priority varies depending on the interrupt levels set in each interrupt system. However, the priorities of interrupt factors in the same interrupt system are fixed in the order that they are written here.

Maskable interrupt generating conditions

A maskable interrupt to the CPU occurs when all of the conditions described below are met.

- The interrupt enable register for the interrupt factor that has occurred is set to "1".
- The IE (Interrupt Enable) bit of the Processor Status Register (PSR) in the CPU is set to "1".
- The interrupt factor that has occurred has a higher priority level than the value that is set in the PSR's Interrupt Level (IL). (The interrupt levels can be set using the interrupt priority register in each interrupt system.)
- No other trap factor having higher priority, such as NMI, has occurred.
- The interrupt factor does not invoke IDMA (the IDMA request bit is set to "0").

When an interrupt factor occurs, the corresponding interrupt factor flag is set to "1" and the flag remains set until it is reset in the software program. Therefore, in no cases can the generated interrupt factor be inadvertently cleared even if the above conditions are not met when the interrupt factor has occurred. The interrupt will occur when the above conditions are met.

However, when the interrupt factor invokes IDMA, the interrupt factor is reset if the following condition is met.

- The IDMA transfer counter is not "0".
- Interrupts are disabled in the IDMA control information even if the transfer counter is "0".

If two or more maskable interrupt factors occur simultaneously, the interrupt factor that has the highest priority is allowed to signal an interrupt request to the CPU. The other interrupts with lower priorities are kept pending until the above conditions are met.

The PSR and interrupt control register will be detailed later.

For details about interrupt factor generating conditions, refer to the description of each peripheral circuit in this manual.

Interrupt Factors and Intelligent DMA

Several interrupt factors can be set so that they can invoke IDMA startup. When one of these interrupt factors occurs, IDMA is started up before an interrupt request to the CPU. The interrupt request to the CPU is generated after IDMA is completed. (The interrupt request can be disabled by a program.)

IDMA is always started up regardless of how the PSR is set. For details, refer to "IDMA Invocation".

Nonmaskable Interrupt (NMI)

The nonmaskable interrupt (NMI) can be generated by pulling the #NMI pin low or using the internal watchdog timer. The vector number of NMI is 7, with the vector address set to the trap table's starting address + 28 bytes.

This interrupt is prioritized over other interrupts and is unconditionally accepted by the CPU.

However, since this interrupt may operate erratically if it occurs before the stack pointer (SP) is set up, it is masked in hardware until a write to the SP is completed after an initial reset.

Interrupt Processing by the CPU

The CPU keeps sampling interrupt requests every cycle. When the CPU accepts an interrupt request, it enters trap processing after completing execution of the instruction that was being executed.

The following lists the contents executed in trap processing.

- (1) The PSR and the current program counter (PC) value are saved to the stack.
- (2) The IE bit of the PSR is reset to "0" (following maskable interrupts are disabled).
- (3) The IL of the PSR is set to the priority level of the accepted interrupt (NMI does not have its interrupt level changed).
- (4) The vector of the generated interrupt factor is loaded into the PC, thus executing the interrupt processing routine.

Thus, once an interrupt is accepted, all maskable interrupts that may follow are disabled in (2). Multiple interrupts can also be handled by setting the IE bit to "1" in the interrupt processing routine. In this case, since the IL has been changed in (3), only an interrupt that has a higher priority than that of the currently processed interrupt is accepted.

When the interrupt processing routine is terminated by the `reti` instruction, the PSR is restored to its previous status before the interrupt has occurred. The program restarts processing after branching to the instruction next to the one that was being executed when the interrupt occurred.

Clearing Standby Mode by Interrupts

The standby modes (HALT and SLEEP) are cleared by an NMI or a maskable interrupt.

All maskable interrupts can be used to clear HALT mode. However, if the bus clock has stopped in HALT2 mode, a DMA interrupt cannot be used.

In SLEEP mode, since the high-speed (OSC3) oscillation circuit is deactivated, interrupts from the peripheral circuits that operate with the OSC3 clock cannot be used.

Interrupts that can be used to clear basic HALT mode: NMI and all maskable interrupts

Interrupts that can be used to clear HALT2 mode: NMI and all maskable interrupts (except DMA interrupts)

Interrupts that can be used to clear SLEEP mode: NMI, input port interrupts, and clock timer interrupts

Clearing of the standby modes is accomplished by an interrupt request to the CPU. Therefore, this requires that the PSR be set in such a way that the requested interrupt will be accepted, and that the interrupt enable register for the interrupt factor be set to accept the interrupt.

When standby mode is cleared and the CPU has accepted the interrupt, it returns to the instruction next to the `halt` or `slp` instruction after executing the interrupt processing routine.

Note: If the interrupt factor used to restart from the standby mode has been set to invoke the IDMA, the IDMA is started up by that interrupt.

In the case of SLEEP mode, the high-speed (OSC3) oscillation circuit also starts operating.

If an interrupt to be generated upon completion of IDMA is disabled at the setting of the IDMA side, no interrupt request is signaled to the CPU. Therefore, the CPU remains idle until the next interrupt request is generated.

Trap Table

The C33 Core Block allows the base (starting) address of the trap table to be set by the TTBR register.

TTBR0 (D[9:0]) / TTBR low-order register (0x48134): Trap table base address [9:0] (fixed at "0")

TTBR1 (D[F:A]) / TTBR low-order register (0x48134): Trap table base address [15:10]

TTBR2 (D[B:0]) / TTBR high-order register (0x48136): Trap table base address [27:16]

TTBR3 (D[F:C]) / TTBR high-order register (0x48136): Trap table base address [31:28] (fixed at "0")

After an initial reset, the TTBR register is set to the boot address determined by the BTA3 pin status.

BTA3 = high: 0x0080000

BTA3 = low: 0x0C00000

Therefore, even when the trap table position is changed, it is necessary that at least the reset vector be written to the above address.

TTBR0 and TTBR3 are read-only bits which are fixed at "0". Therefore, the trap table starting address always begins with a 1KB boundary address.

The TTBR register is normally write-protected to prevent them from being inadvertently rewritten. To remove this write protection function, another register, TBRP (D[7:0]) / TTBR write-protect register (0x4812D [byte]), is provided. A write to the TTBR register is enabled by writing "0x59" to TBRP and is disabled back again by a write to the most significant byte of the TTBR register (0x48137). Consequently, a write to the TTBR register needs to begin with the low-order half-word first. However, since an occurrence of NMI or the like between writes of the low-order and high-order half-words would cause a malfunction, it is recommended that the register be written in words.

Control of Maskable Interrupts

Structure of the Interrupt Controller

The interrupt controller is configured as shown in Figure II-5.1.

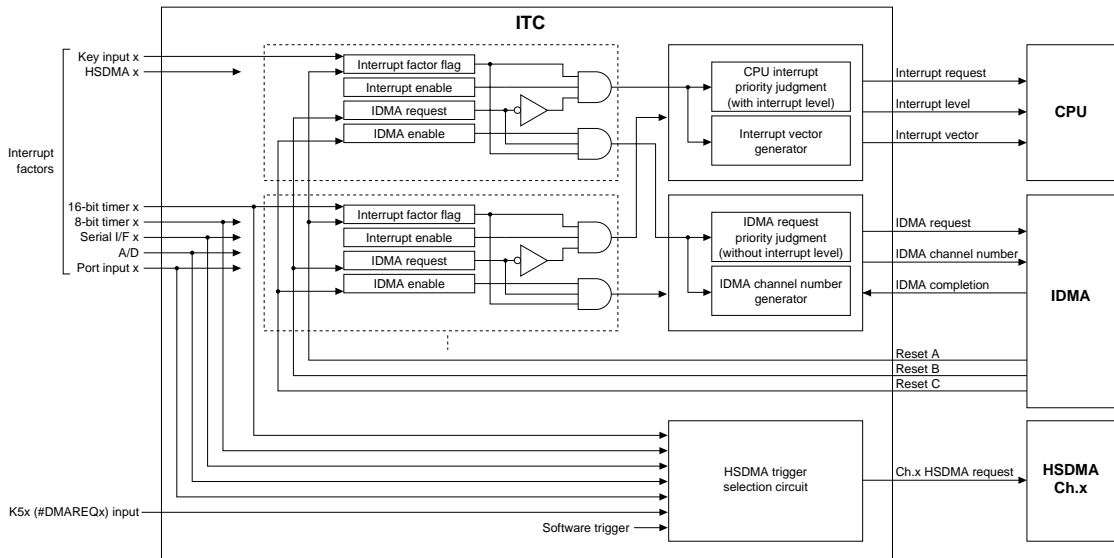


Figure II-5.1 Configuration of Interrupt Controller

The following sections explain the functions of the registers used to control interrupts.

Processor Status Register (PSR)

The PSR is a special register incorporated in the core CPU and contains control bits to enable or disable an interrupt request to the CPU.

Interrupt Enable (IE) bit: PSR[4]

This bit is used to enable or disable an interrupt request to the CPU. When this bit is set to "1", the CPU is enabled to accept a maskable interrupt request. When this bit is reset to "0", no maskable interrupt request is accepted by the CPU.

When the CPU accepts an interrupt request (or some other trap occurs), it saves the PSR to the stack and resets the IE bit to "0". Consequently, no maskable interrupt request occurring thereafter will be accepted unless the IE bit is set to "1" in software program or the interrupt (trap) processing routine is terminated by the reti instruction.

The IE bit is initialized to "0" (interrupts disabled) by an initial reset.

Interrupt Level (IL): PSR[11:8]

The IL bits disable the interrupts whose priorities are below the set interrupt level. For example, if the interrupt level set in the IL is 3, the interrupts whose priorities are set below 3 in the interrupt priority register (described later) are not accepted by the CPU even if the IE bit is set to "1". The IL and the interrupt priority register together allow you to control the interrupt priorities in each interrupt system. For details about the interrupt levels, refer to "Interrupt Priority Register and Interrupt Levels".

When the CPU accepts a maskable interrupt request, it saves the PSR to the stack and sets the IL to the accepted interrupt's priority level. Therefore, even when the IE bit is set to "1" in the interrupt processing routine, no interrupts whose priority levels are equal or below that of the interrupt currently being processed are accepted unless the IL is rewritten.

The IL is restored to its previous status when the interrupt processing routine is terminated by the reti instruction.

II CORE BLOCK: ITC (Interrupt Controller)

The IL is rewritten for only maskable interrupts and not for any other traps (except a reset).

The IL is set to level 0 (that is, all interrupts above level 1 are enabled) by an initial reset.

Note: As the E0C33000 Core CPU function, the IL allows interrupt levels to be set in the range of 0 to 15. However, since the interrupt priority register in the ITC consists of three bits, interrupt levels in each interrupt system can only be set for up to 8.

Interrupt Factor Flag and Interrupt Enable Register

An interrupt factor flag and an interrupt enable register are provided for each maskable interrupt factor.

Interrupt factor flag

The interrupt factor flag is set to "1" when the corresponding interrupt factor occurs. Reading the flag enables you to determine what caused an interrupt, making it unnecessary to resort to the CPU's trap processing. The interrupt factor flag is reset only by writing data in software. Note that the method by which this flag is reset can be selected from the software application using either of the two methods described below. This selection is accomplished using RSTONLY (D0) / Interrupt factor flag reset method select register (0x4029F).

□□□□ □□□□□□□□ □□□□□□□□□□□□

This method is selected (RSTONLY = "1") when initially reset.

With this method, the interrupt factor flag is reset by writing "1". Although multiple interrupt factor flags are located at the same address of the interrupt control register, the interrupt factor flags for which "0" has been written can be neither set nor reset. Therefore, this method ensures that only a specific factor flag is reset. However, when using read-modify-write instructions (e.g., bset, bclr, or bnot), note that an interrupt factor flag that has been set to "1" is reset by writing.

In this method, no interrupt factor flag can be set in the software application.

□□□□ □□□□ □□□□ □□□□

This method is selected by writing "0" to RSTONLY.

When this method is used, interrupt factor flags can be read and written as for other registers. Therefore, the flag is reset by writing "0" and set by writing "1". In this case, all factor flags for which "0" has been written are reset. Even in a read-modify-write operation, an interrupt factor can occur between the read and the write, so be careful when using this method.

Since interrupt factor flags are not initialized by an initial reset, be sure to reset them before enabling interrupts.

Note: Even when a maskable interrupt request is accepted by the CPU and control branches off to the interrupt processing routine, the interrupt factor flag is not reset. Consequently, if control is returned from the interrupt processing routine by the reti instruction without resetting the interrupt factor flag in a program, the same interrupt factor occurs again.

For details about interrupt factor generating conditions, refer to the description of each peripheral circuit in this manual.

Interrupt enable register

This register controls the output of an interrupt request to the CPU. Only when the interrupt enable bit of this register is set to "1" can an interrupt request to the CPU be enabled by an occurrence of the corresponding interrupt factor. If the bit is set to "0", no interrupt request is made to the CPU even when the corresponding interrupt factor occurs.

Interrupt enable bits can be read and written as for other registers. Therefore, the interrupt enable bit is reset by writing "0" and set by writing "1". By reading this register, its setup status can be checked at any time. Settings of the interrupt enable register do not affect the operation of interrupt factor flags, so when an interrupt factor occurs the interrupt factor flag is set to "1" even if the corresponding interrupt enable bit is set to "0".

When initially reset, the interrupt enable register is set to "0" (interrupts are disabled).

In cases when IDMA is started up by occurrence of an interrupt factor or when clearing standby mode (HALT or SLEEP mode) too, the corresponding interrupt enable bit must be set to "1".

The interrupt controller outputs an interrupt request to the CPU when the following conditions are met:

- An interrupt factor has occurred and the interrupt factor flag is set to "1".
- The bit of the interrupt enable register for the interrupt factor that has occurred is set to "1" (interrupt enable).
- The bit of the IDMA request register for the interrupt factor that has occurred is set to "0" (interrupt request).

If two or more interrupt factors occur simultaneously, the interrupt factor that has the highest priority is allowed to signal an interrupt request to the CPU. (See the following section.)

When these conditions are met, the interrupt controller outputs an interrupt request signal to the CPU along with the setup content (interrupt level) of the interrupt priority register for the generated interrupt system and its vector number.

These signals remain asserted until the interrupt factor flag is reset to "0" or the corresponding bit of the interrupt enable register is set to "0" (interrupts are disabled) or until some other interrupt factor of higher priority occurs. They are not cleared if the CPU simply accepts the interrupt request.

Interrupt Priority Register and Interrupt Levels

The interrupt priority register is a 3-bit register provided for each interrupt system. It allows the interrupt levels of a given interrupt system to be set in the range of 0 to 7. The default priorities shown in Table II-5.1 can be modified according to system requirements by this setting.

The value set in this register is used by the interrupt controller and the CPU as described below.

Roles of the interrupt priority register in the interrupt controller

If two or more interrupt factors that have been enabled by the interrupt enable register occur simultaneously, the interrupt factor in the interrupt system whose interrupt priority register contains the greatest value is allowed by the interrupt controller to signal an interrupt request to the CPU.

If an interrupt factor occurs in two or more interrupt systems having the same value, the interrupt priority is resolved according to the default priorities in Table II-5.1. Interrupt factors in the same interrupt system also have their priorities resolved according to the order in Table II-5.1.

Other interrupt factors are kept pending until all interrupts of higher priority are accepted by the CPU.

When outputting an interrupt request signal to the CPU, the interrupt controller outputs the content of the interrupt priority register to the CPU along with it.

If another interrupt factor of higher priority occurs during outputting an interrupt request signal, the interrupt controller changes the vector number and interrupt level to those of the new interrupt factor before they are output to the CPU. The first interrupt request is left pending.

Roles of the interrupt priority register in CPU processing

The CPU compares the content of the interrupt priority register received from the interrupt controller with the interrupt level that is set in the IL of the PSR to determine whether or not to accept the interrupt request.

IE bit = "1" & $IL < \text{interrupt priority register}$: the interrupt request is accepted

IE bit = "1" & $IL \geq \text{interrupt priority register}$: the interrupt request is rejected

Before interrupts can be controlled by an interrupt level, the interrupt disabling level must be written to the IL. For example, if the value written to the IL is 3, only the interrupts whose interrupt levels written in the interrupt priority register are 4 or more will be accepted.

When an interrupt is accepted, the interrupt level that is set in its interrupt priority register is written to the IL. As a result, the interrupt requests below that interrupt level can no longer be accepted.

If the interrupt priority register for an interrupt is set to "0", the interrupt is disabled. However, invoking IDMA by means of an interrupt factor works fine.

- Notes:**
- As the E0C33000 Core CPU function, the IL allows interrupt levels to be set in the range of 0 to 15. However, since the interrupt priority register in the C33 Core Block consists of three bits, interrupt levels in each interrupt system can only be set for up to 8.
 - Multiple interrupts can also be handled by rewriting the interrupt level to the IL in the interrupt processing routine. However, if the interrupt level of the IL is set below the current level and the IE is set to enable interrupts before resetting the interrupt factor flag after an interrupt has occurred, the same interrupt may occur again.

IDMA Invocation

The interrupt factors for which IDMA channel numbers are written in Table II-5.1 have the function to invoke the intelligent DMA (IDMA).

IDMA request register

The IDMA request register is used to specify the interrupt factor that invoke an IDMA transfer. If an IDMA request bit is set to "1", the IDMA request will be generated when the corresponding interrupt factor occurs. When the IDMA request bit is set to "0", the corresponding interrupt factor does not invoke IDMA and a normal interrupt processing will be performed. The IDMA request register is set to "0" by an initial reset. The method by which this register is set can be selected from the software application using either of the two methods described below. This selection is accomplished using IDMAONLY (D1) / Flag set/reset method select register (0x4029F).

- **Set-only method (default)**

This method is selected (IDMAONLY = "1") when initially reset.

With this method, an IDMA request bit is set by writing "1". Although multiple IDMA request bits are located in the IDMA request register, the IDMA request bits for which "0" has been written can be neither set nor reset. Therefore, this method ensures that only a specific IDMA request bit is set.

However, when using read-modify-write instructions (e.g., bset, bclr, or bnot), note that an IDMA request bit that has been set to "1" is not reset by writing.

- **Read/write method**

This method is selected by writing "0" to IDMAONLY.

When this method is used, IDMA request bits can be read and written as for other registers. Therefore, the IDMA request bit is reset by writing "0" and set by writing "1". In this case, all IDMA request bits for which "0" has been written are reset. Even in a read-modify-write operation, an IDMA request bit can be reset by the hardware between the read and the write, so be careful when using this method.

IDMA enable register

To perform IDMA transfer using an interrupt factor, the corresponding bit of the IDMA enable register must be set to "1". If this bit is set to "0", the interrupt factor cannot invoke the IDMA channel. The IDMA enable register is set to "0" by an initial reset.

The IDMA enable register allows selection of a set method (set-only method or Read/write method) similar to the IDMA request register. This selection is accomplished using DENONLY (D2) / Flag set/reset method select register (0x4029F). See the above explanation for the set method.

Invoking IDMA

Before IDMA can be invoked by the occurrence of an interrupt factor, the corresponding bits of the IDMA request and IDMA enable registers must be set to "1". Then when an interrupt factor occurs, the interrupt request to the CPU is made pending and the corresponding IDMA channel is invoked. The DMA transfer is performed according to the control information of that IDMA channel. The interrupt level set by the interrupt priority register of the ITC does not affect the IDMA invocation. The IDMA request can be accepted even if the interrupt level of the CPU is higher than the set value of the interrupt priority register. However, when generating the interrupt request to the CPU after the IDMA transfer is completed, the interrupt is controlled using the interrupt level set by the interrupt priority register.

An IDMA invocation request is accepted even when the interrupt enable register and PSR of the CPU is set to disable interrupts. It is also necessary that the control information for the IDMA channel has been set.

Interrupt after IDMA transfer

To generate an interrupt after completion of IDMA transfer:

The interrupt request that has been kept pending can be generated after completion of the DMA transfer. In this case, the interrupt must be enabled by the IDMA control information (DINTEM = "1") in addition to the interrupt controller and the PSR register settings.

However, if the transfer counter set for the selected IDMA channel does not reach the terminal count of 0 after the number of transfers set have been performed, the interrupt factor flag is reset and no interrupt request is generated. The transfer counter is decremented by 1 for each transfer performed.

If the transfer counter is decremented to 0 when DINTEN is set to "1", the interrupt factor flag is not reset and the IDMA request bit is cleared to "0". An interrupt request is generated if other interrupt conditions are met.

The IDMA request bit must be set up again in order for IDMA to be invoked when an interrupt factor occurs next time as well. To ensure that no unwanted IDMA request occurs, this setup must be performed after resetting the interrupt factor flag.

Figure II-5.2 shows the hardware sequence when DINTEN is set to "1".

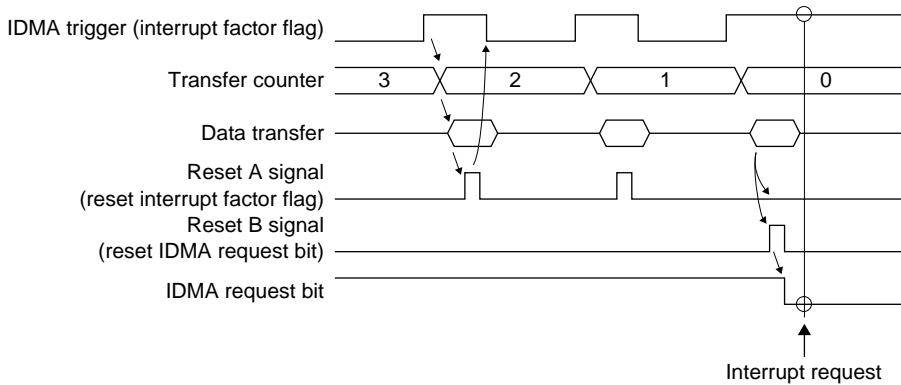


Figure II-5.2 Sequence when DINTEN = "1"

To disable an interrupt after completion of IDMA transfer:

If an interrupt has been disabled in the IDMA control information (DINTEN = "0"), the interrupt is not generated since the interrupt factor flag is reset when the transfer counter becomes 0.

In this case, the IDMA request bit remains set to "1" without being cleared. However, the IDMA enable bit is cleared, so the following IDMA request by the same interrupt factor will be disabled.

Figure II-5.3 shows the hardware sequence when DINTEN is set to "0".

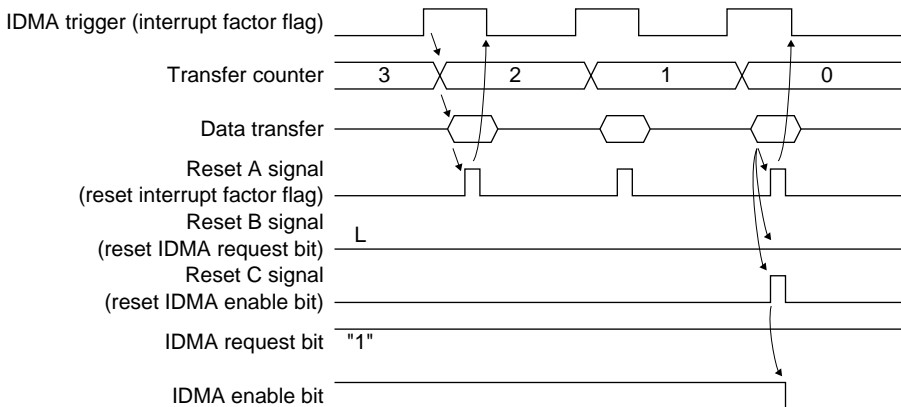


Figure II-5.3 Sequence when DINTEN = "0"

For details on IDMA, refer to "IDMA (Intelligent DMA)".

HSDMA Invocation

Some interrupt factors can invoke high-speed DMAs (HSDMA).

HSDMA trigger set-up register

The DMA block contains four channel of HSDMA circuit. Each channel allows selection of an interrupt factor as the trigger. The HSDMA trigger set-up registers are used for this selection.

HSDMA Ch.0: HSD0S[3:0] (D[3:0])/HSDMA Ch.0/1 trigger set-up register (0x40298)

HSDMA Ch.1: HSD1S[3:0] (D[7:4])/HSDMA Ch.0/1 trigger set-up register (0x40298)

HSDMA Ch.2: HSD2S[3:0] (D[3:0])/HSDMA Ch.2/3 trigger set-up register (0x40299)

HSDMA Ch.3: HSD3S[3:0] (D[7:4])/HSDMA Ch.2/3 trigger set-up register (0x40299)

Table II-5.2 shows the setting value and the corresponding trigger factor.

Table II-5.2 HSDMA Trigger Factor

Value	Ch.0 trigger factor	Ch.1 trigger factor	Ch.2 trigger factor	Ch.3 trigger factor
0000	Software trigger	Software trigger	Software trigger	Software trigger
0001	K50 port input (falling edge)	K51 port input (falling edge)	K53 port input (falling edge)	K54 port input (falling edge)
0010	K50 port input (rising edge)	K51 port input (rising edge)	K53 port input (rising edge)	K54 port input (rising edge)
0011	Port 0 input	Port 1 input	Port 2 input	Port 3 input
0100	Port 4 input	Port 5 input	Port 6 input	Port 7 input
0101	8-bit timer 0 underflow	8-bit timer 1 underflow	8-bit timer 2 underflow	8-bit timer 3 underflow
0110	16-bit timer 0 compare B	16-bit timer 1 compare B	16-bit timer 2 compare B	16-bit timer 3 compare B
0111	16-bit timer 0 compare A	16-bit timer 1 compare A	16-bit timer 2 compare A	16-bit timer 3 compare A
1000	16-bit timer 4 compare B	16-bit timer 5 compare B	16-bit timer 4 compare B	16-bit timer 5 compare B
1001	16-bit timer 4 compare A	16-bit timer 5 compare A	16-bit timer 4 compare A	16-bit timer 5 compare A
1010	Serial I/F Ch.0 Rx buffer full	Serial I/F Ch.1 Rx buffer full	Serial I/F Ch.0 Rx buffer full	Serial I/F Ch.1 Rx buffer full
1011	Serial I/F Ch.0 Tx buffer empty	Serial I/F Ch.1 Tx buffer empty	Serial I/F Ch.0 Tx buffer empty	Serial I/F Ch.1 Tx buffer empty
1100	A/D conversion completion	A/D conversion completion	A/D conversion completion	A/D conversion completion

Invoking HSDMA

By selecting an interrupt factor with the HSDMA trigger set-up register, the HSDMA channel is invoked when the selected interrupt factor occurs. The interrupt control bits (interrupt factor flag, interrupt enable register, IDMA request register, interrupt priority register) do not affect this invocation.

Since HSDMA does not reset the interrupt factor flag, an interrupt will occur when the DMA transfer is completed if the interrupt is enabled by ITC.

Before HSDMA can be invoked by the occurrence of an interrupt factor, it is necessary that DMA be enabled on the HSDMA side by setting the control register for HSDMA transfer.

For details about HSDMA, refer to "HSDMA (High-Speed DMA)".

I/O Memory of Interrupt Controller

Table II-5.3 shows the control bits of the interrupt controller.

Table II-5.3 Control Bits of Interrupt Controller

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Port input 0/1 interrupt priority register	0040260 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PP1L2	Port input 1 interrupt level	0 to 7	X	R/W		
		D5	PP1L1			X			
		D4	PP1L0			X			
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PP0L2	Port input 0 interrupt level	0 to 7	X	R/W		
D1	PP0L1	X							
D0	PP0L0	X							
Port input 2/3 interrupt priority register	0040261 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PP3L2	Port input 3 interrupt level	0 to 7	X	R/W		
		D5	PP3L1			X			
		D4	PP3L0			X			
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PP2L2	Port input 2 interrupt level	0 to 7	X	R/W		
D1	PP2L1	X							
D0	PP2L0	X							
Key input interrupt priority register	0040262 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PK1L2	Key input 1 interrupt level	0 to 7	X	R/W		
		D5	PK1L1			X			
		D4	PK1L0			X			
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PK0L2	Key input 0 interrupt level	0 to 7	X	R/W		
D1	PK0L1	X							
D0	PK0L0	X							
High-speed DMA Ch.0/1 interrupt priority register	0040263 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PHSD1L2	High-speed DMA Ch.1 interrupt level	0 to 7	X	R/W		
		D5	PHSD1L1			X			
		D4	PHSD1L0			X			
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PHSD0L2	High-speed DMA Ch.0 interrupt level	0 to 7	X	R/W		
D1	PHSD0L1	X							
D0	PHSD0L0	X							
High-speed DMA Ch.2/3 interrupt priority register	0040264 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PHSD3L2	High-speed DMA Ch.3 interrupt level	0 to 7	X	R/W		
		D5	PHSD3L1			X			
		D4	PHSD3L0			X			
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PHSD2L2	High-speed DMA Ch.2 interrupt level	0 to 7	X	R/W		
D1	PHSD2L1	X							
D0	PHSD2L0	X							
IDMA interrupt priority register	0040265 (B)	D7–3	–	reserved	–	–	–	0 when being read.	
		D2	PDM2	IDMA interrupt level	0 to 7	X	R/W		
		D1	PDM1			X			
		D0	PDM0			X			
16-bit timer 0/1 interrupt priority register	0040266 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T12	16-bit timer 1 interrupt level	0 to 7	X	R/W		
		D5	P16T11			X			
		D4	P16T10			X			
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	P16T02	16-bit timer 0 interrupt level	0 to 7	X	R/W		
D1	P16T01	X							
D0	P16T00	X							
16-bit timer 2/3 interrupt priority register	0040267 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T32	16-bit timer 3 interrupt level	0 to 7	X	R/W		
		D5	P16T31			X			
		D4	P16T30			X			
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	P16T22	16-bit timer 2 interrupt level	0 to 7	X	R/W		
D1	P16T21	X							
D0	P16T20	X							

II CORE BLOCK: ITC (Interrupt Controller)

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks						
16-bit timer 4/5 interrupt priority register	0040268 (B)	D7	–	reserved	–	–	–	0 when being read.						
		D6	P16T52	16-bit timer 5 interrupt level	0 to 7	X	R/W							
		D5	P16T51											
		D4	P16T50											
		D3	–	reserved	–	–	–	–	0 when being read.					
		D2	P16T42	16-bit timer 4 interrupt level	0 to 7	X	R/W							
		D1	P16T41											
D0	P16T40													
8-bit timer, serial I/F Ch.0 interrupt priority register	0040269 (B)	D7	–	reserved	–	–	–	0 when being read.						
		D6	PSI002	Serial interface Ch.0 interrupt level	0 to 7	X	R/W							
		D5	PSI001											
		D4	PSI000											
		D3	–	reserved	–	–	–	–	0 when being read.					
		D2	P8TM2	8-bit timer 0–3 interrupt level	0 to 7	X	R/W							
		D1	P8TM1											
D0	P8TM0													
Serial I/F Ch.1, A/D interrupt priority register	004026A (B)	D7	–	reserved	–	–	–	0 when being read.						
		D6	PAD2	A/D converter interrupt level	0 to 7	X	R/W							
		D5	PAD1											
		D4	PAD0											
		D3	–	reserved	–	–	–	–	0 when being read.					
		D2	PSI012	Serial interface Ch.1 interrupt level	0 to 7	X	R/W							
		D1	PSI011											
D0	PSI010													
Clock timer interrupt priority register	004026B (B)	D7–3	–	reserved	–	–	–	Writing 1 not allowed.						
		D2	PCTM2	Clock timer interrupt level	0 to 7	X	R/W							
		D1	PCTM1											
		D0	PCTM0											
Port input 4/5 interrupt priority register	004026C (B)	D7	–	reserved	–	–	–	0 when being read.						
		D6	PP5L2	Port input 5 interrupt level	0 to 7	X	R/W							
		D5	PP5L1											
		D4	PP5L0											
		D3	–	reserved	–	–	–	–	0 when being read.					
		D2	PP4L2	Port input 4 interrupt level	0 to 7	X	R/W							
		D1	PP4L1											
D0	PP4L0													
Port input 6/7 interrupt priority register	004026D (B)	D7	–	reserved	–	–	–	0 when being read.						
		D6	PP7L2	Port input 7 interrupt level	0 to 7	X	R/W							
		D5	PP7L1											
		D4	PP7L0											
		D3	–	reserved	–	–	–	–	0 when being read.					
		D2	PP6L2	Port input 6 interrupt level	0 to 7	X	R/W							
		D1	PP6L1											
D0	PP6L0													
Key input, port input 0–3 interrupt enable register	0040270 (B)	D7–6	–	reserved	–	–	–	0 when being read.						
		D5	EK1	Key input 1	1	Enabled	0	R/W						
		D4	EK0	Key input 0										
		D3	EP3	Port input 3										
		D2	EP2	Port input 2										
		D1	EP1	Port input 1										
		D0	EP0	Port input 0										
		D0	EP0	Port input 0										
DMA interrupt enable register	0040271 (B)	D7–5	–	reserved						–	–	–	0 when being read.	
		D4	EIDMA	IDMA	1	Enabled	0	R/W						
		D3	EHDM3	High-speed DMA Ch.3										
		D2	EHDM2	High-speed DMA Ch.2										
		D1	EHDM1	High-speed DMA Ch.1										
		D0	EHDM0	High-speed DMA Ch.0										
16-bit timer 0/1 interrupt enable register	0040272 (B)	D7	E16TC1	16-bit timer 1 comparison A						1	Enabled	0	R/W	
		D6	E16TU1	16-bit timer 1 comparison B										
		D5–4	–	reserved	–	–	–	–	0 when being read.					
		D3	E16TC0	16-bit timer 0 comparison A	1	Enabled	0	R/W						
		D2	E16TU0	16-bit timer 0 comparison B										
		D1–0	–	reserved										
		16-bit timer 2/3 interrupt enable register	0040273 (B)	D7	E16TC3	16-bit timer 3 comparison A	1	Enabled	0					
D6	E16TU3			16-bit timer 3 comparison B										
D5–4	–			reserved	–	–				–	–	0 when being read.		
D3	E16TC2			16-bit timer 2 comparison A	1	Enabled				0	R/W			
D2	E16TU2			16-bit timer 2 comparison B										
D1–0	–			reserved									–	–

II CORE BLOCK: ITC (Interrupt Controller)

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks					
16-bit timer 4/5 interrupt enable register	0040274 (B)	D7	E16TC5	16-bit timer 5 comparison A	1	Enabled	0	Disabled	0	R/W	0 when being read.			
		D6	E16TU5	16-bit timer 5 comparison B					0	R/W				
		D5-4	–	reserved	–		–	–	–	–				
		D3	E16TC4	16-bit timer 4 comparison A	1	Enabled	0	Disabled	0	R/W				
		D2	E16TU4	16-bit timer 4 comparison B					0	R/W				
		D1-0	–	reserved	–		–	–	–	–				
8-bit timer interrupt enable register	0040275 (B)	D7-4	–	reserved	–		–	–	–	0 when being read.				
		D3	E8TU3	8-bit timer 3 underflow	1	Enabled	0	Disabled	0	R/W				
		D2	E8TU2	8-bit timer 2 underflow					0	R/W				
		D1	E8TU1	8-bit timer 1 underflow					0	R/W				
		D0	E8TU0	8-bit timer 0 underflow					0	R/W				
Serial I/F interrupt enable register	0040276 (B)	D7-6	–	reserved	–		–	–	–	0 when being read.				
		D5	ESTX1	SIF Ch.1 transmit buffer empty	1	Enabled	0	Disabled	0	R/W				
		D4	ESRX1	SIF Ch.1 receive buffer full					0	R/W				
		D3	ESERR1	SIF Ch.1 receive error					0	R/W				
		D2	ESTX0	SIF Ch.0 transmit buffer empty					0	R/W				
		D1	ESRX0	SIF Ch.0 receive buffer full					0	R/W				
		D0	ESERR0	SIF Ch.0 receive error					0	R/W				
		Port input 4-7, clock timer, A/D interrupt enable register	0040277 (B)	D7-6					–	reserved	–		–	–
D5	EP7			Port input 7					1	Enabled	0	Disabled	0	R/W
D4	EP6			Port input 6	0	R/W								
D3	EP5			Port input 5	0	R/W								
D2	EP4			Port input 4	0	R/W								
D1	ECTM			Clock timer	0	R/W								
D0	EADE			A/D converter	0	R/W								
Key input, port input 0-3 interrupt factor flag register	0040280 (B)	D7-6	–	reserved	–		–	–					–	0 when being read.
		D5	FK1	Key input 1	1	Factor is generated	0	No factor is generated	X	R/W				
		D4	FK0	Key input 0					X	R/W				
		D3	FP3	Port input 3					X	R/W				
		D2	FP2	Port input 2					X	R/W				
		D1	FP1	Port input 1					X	R/W				
		D0	FP0	Port input 0					X	R/W				
DMA interrupt factor flag register	0040281 (B)	D7-5	–	reserved					–		–	–	–	0 when being read.
		D4	FIDMA	IDMA	1	Factor is generated	0	No factor is generated	X	R/W				
		D3	FHDM3	High-speed DMA Ch.3					X	R/W				
		D2	FHDM2	High-speed DMA Ch.2					X	R/W				
		D1	FHDM1	High-speed DMA Ch.1					X	R/W				
		D0	FHDM0	High-speed DMA Ch.0					X	R/W				
16-bit timer 0/1 interrupt factor flag register	0040282 (B)	D7	F16TC1	16-bit timer 1 comparison A					1	Factor is generated	0	No factor is generated	X	R/W
		D6	F16TU1	16-bit timer 1 comparison B	X	R/W								
		D5-4	–	reserved	–		–	–	–	0 when being read.				
		D3	F16TC0	16-bit timer 0 comparison A	1	Factor is generated	0	No factor is generated	X	R/W				
		D2	F16TU0	16-bit timer 0 comparison B					X	R/W				
		D1-0	–	reserved	–		–	–	–	–	0 when being read.			
16-bit timer 2/3 interrupt factor flag register	0040283 (B)	D7	F16TC3	16-bit timer 3 comparison A	1	Factor is generated	0	No factor is generated	X	R/W				
		D6	F16TU3	16-bit timer 3 comparison B					X	R/W				
		D5-4	–	reserved	–		–	–	–	0 when being read.				
		D3	F16TC2	16-bit timer 2 comparison A	1	Factor is generated	0	No factor is generated	X	R/W				
		D2	F16TU2	16-bit timer 2 comparison B					X	R/W				
		D1-0	–	reserved	–		–	–	–	–	0 when being read.			
16-bit timer 4/5 interrupt factor flag register	0040284 (B)	D7	F16TC5	16-bit timer 5 comparison A	1	Factor is generated	0	No factor is generated	X	R/W				
		D6	F16TU5	16-bit timer 5 comparison B					X	R/W				
		D5-4	–	reserved	–		–	–	–	0 when being read.				
		D3	F16TC4	16-bit timer 4 comparison A	1	Factor is generated	0	No factor is generated	X	R/W				
		D2	F16TU4	16-bit timer 4 comparison B					X	R/W				
		D1-0	–	reserved	–		–	–	–	–	0 when being read.			
8-bit timer interrupt factor flag register	0040285 (B)	D7-4	–	reserved	–		–	–	–	0 when being read.				
		D3	F8TU3	8-bit timer 3 underflow	1	Factor is generated	0	No factor is generated	X	R/W				
		D2	F8TU2	8-bit timer 2 underflow					X	R/W				
		D1	F8TU1	8-bit timer 1 underflow					X	R/W				
		D0	F8TU0	8-bit timer 0 underflow					X	R/W				
Serial I/F interrupt factor flag register	0040286 (B)	D7-6	–	reserved					–		–	–	–	0 when being read.
		D5	FSTX1	SIF Ch.1 transmit buffer empty	1	Factor is generated	0	No factor is generated	X	R/W				
		D4	FSRX1	SIF Ch.1 receive buffer full					X	R/W				
		D3	FSERR1	SIF Ch.1 receive error					X	R/W				
		D2	FSTX0	SIF Ch.0 transmit buffer empty					X	R/W				
		D1	FSRX0	SIF Ch.0 receive buffer full					X	R/W				
		D0	FSERR0	SIF Ch.0 receive error					X	R/W				

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
Port input 4–7, clock timer, A/D interrupt factor flag register	0040287 (B)	D7–6	–	reserved		–	–	0 when being read.		
		D5	FP7	Port input 7	1	Factor is generated	0	No factor is generated	X	R/W
		D4	FP6	Port input 6					X	R/W
		D3	FP5	Port input 5					X	R/W
		D2	FP4	Port input 4					X	R/W
		D1	FCTM	Clock timer					X	R/W
		D0	FADE	A/D converter					X	R/W
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA request register	0040290 (B)	D7	R16TC0	16-bit timer 0 comparison A					1	IDMA request
		D6	R16TU0	16-bit timer 0 comparison B	0	R/W				
		D5	RHDM1	High-speed DMA Ch.1	0	R/W				
		D4	RHDM0	High-speed DMA Ch.0	0	R/W				
		D3	RP3	Port input 3	0	R/W				
		D2	RP2	Port input 2	0	R/W				
		D1	RP1	Port input 1	0	R/W				
		D0	RP0	Port input 0	0	R/W				
16-bit timer 1–4 IDMA request register	0040291 (B)	D7	R16TC4	16-bit timer 4 comparison A	1	IDMA request	0	Interrupt request	0	R/W
		D6	R16TU4	16-bit timer 4 comparison B					0	R/W
		D5	R16TC3	16-bit timer 3 comparison A					0	R/W
		D4	R16TU3	16-bit timer 3 comparison B					0	R/W
		D3	R16TC2	16-bit timer 2 comparison A					0	R/W
		D2	R16TU2	16-bit timer 2 comparison B					0	R/W
		D1	R16TC1	16-bit timer 1 comparison A					0	R/W
		D0	R16TU1	16-bit timer 1 comparison B					0	R/W
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register	0040292 (B)	D7	RSTX0	SIF Ch.0 transmit buffer empty	1	IDMA request	0	Interrupt request	0	R/W
		D6	RSRX0	SIF Ch.0 receive buffer full					0	R/W
		D5	R8TU3	8-bit timer 3 underflow					0	R/W
		D4	R8TU2	8-bit timer 2 underflow					0	R/W
		D3	R8TU1	8-bit timer 1 underflow					0	R/W
		D2	R8TU0	8-bit timer 0 underflow					0	R/W
		D1	R16TC5	16-bit timer 5 comparison A					0	R/W
		D0	R16TU5	16-bit timer 5 comparison B					0	R/W
Serial I/F Ch.1, A/D, port input 4–7 IDMA request register	0040293 (B)	D7	RP7	Port input 7	1	IDMA request	0	Interrupt request	0	R/W
		D6	RP6	Port input 6					0	R/W
		D5	RP5	Port input 5					0	R/W
		D4	RP4	Port input 4					0	R/W
		D3	–	reserved		–	–	0 when being read.		
		D2	RADE	A/D converter	1	IDMA request	0	Interrupt request	0	R/W
		D1	RSTX1	SIF Ch.1 transmit buffer empty					0	R/W
		D0	RSRX1	SIF Ch.1 receive buffer full					0	R/W
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA enable register	0040294 (B)	D7	DE16TC0	16-bit timer 0 comparison A	1	IDMA enabled	0	IDMA disabled	0	R/W
		D6	DE16TU0	16-bit timer 0 comparison B					0	R/W
		D5	DEHDM1	High-speed DMA Ch.1					0	R/W
		D4	DEHDM0	High-speed DMA Ch.0					0	R/W
		D3	DEP3	Port input 3					0	R/W
		D2	DEP2	Port input 2					0	R/W
		D1	DEP1	Port input 1					0	R/W
		D0	DEP0	Port input 0					0	R/W
16-bit timer 1–4 IDMA enable register	0040295 (B)	D7	DE16TC4	16-bit timer 4 comparison A	1	IDMA enabled	0	IDMA disabled	0	R/W
		D6	DE16TU4	16-bit timer 4 comparison B					0	R/W
		D5	DE16TC3	16-bit timer 3 comparison A					0	R/W
		D4	DE16TU3	16-bit timer 3 comparison B					0	R/W
		D3	DE16TC2	16-bit timer 2 comparison A					0	R/W
		D2	DE16TU2	16-bit timer 2 comparison B					0	R/W
		D1	DE16TC1	16-bit timer 1 comparison A					0	R/W
		D0	DE16TU1	16-bit timer 1 comparison B					0	R/W
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register	0040296 (B)	D7	DESTX0	SIF Ch.0 transmit buffer empty	1	IDMA enabled	0	IDMA disabled	0	R/W
		D6	DESRX0	SIF Ch.0 receive buffer full					0	R/W
		D5	DE8TU3	8-bit timer 3 underflow					0	R/W
		D4	DE8TU2	8-bit timer 2 underflow					0	R/W
		D3	DE8TU1	8-bit timer 1 underflow					0	R/W
		D2	DE8TU0	8-bit timer 0 underflow					0	R/W
		D1	DE16TC5	16-bit timer 5 comparison A					0	R/W
		D0	DE16TU5	16-bit timer 5 comparison B					0	R/W
Serial I/F Ch.1, A/D, port input 4–7 IDMA enable register	0040297 (B)	D7	DEP7	Port input 7	1	IDMA enabled	0	IDMA disabled	0	R/W
		D6	DEP6	Port input 6					0	R/W
		D5	DEP5	Port input 5					0	R/W
		D4	DEP4	Port input 4					0	R/W
		D3	–	reserved		–	–	0 when being read.		
		D2	DEADE	A/D converter	1	IDMA enabled	0	IDMA disabled	0	R/W
		D1	DESTX1	SIF Ch.1 transmit buffer empty					0	R/W
		D0	DESRX1	SIF Ch.1 receive buffer full					0	R/W

II CORE BLOCK: ITC (Interrupt Controller)

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks						
High-speed DMA Ch.0/1 trigger set-up register	0040298 (B)	D7	HSD1S3	High-speed DMA Ch.1 trigger set-up	0	Software trigger	0	R/W						
		D6	HSD1S2		1	K51 input (falling edge)	0							
		D5	HSD1S1		2	K51 input (rising edge)	0							
		D4	HSD1S0		3	Port 1 input	0							
					4	Port 5 input								
					5	8-bit timer Ch.1 underflow								
					6	16-bit timer Ch.1 compare B								
					7	16-bit timer Ch.1 compare A								
					8	16-bit timer Ch.5 compare B								
					9	16-bit timer Ch.5 compare A								
					A	SI/F Ch.1 Rx buffer full								
					B	SI/F Ch.1 Tx buffer empty								
					C	A/D conversion completion								
					D3	HSD0S3	High-speed DMA Ch.0 trigger set-up			0	Software trigger	0	R/W	
					D2	HSD0S2				1	K50 input (falling edge)	0		
					D1	HSD0S1				2	K50 input (rising edge)	0		
		D0	HSD0S0	3	Port 0 input	0								
				4	Port 4 input									
				5	8-bit timer Ch.0 underflow									
				6	16-bit timer Ch.0 compare B									
				7	16-bit timer Ch.0 compare A									
				8	16-bit timer Ch.4 compare B									
				9	16-bit timer Ch.4 compare A									
				A	SI/F Ch.0 Rx buffer full									
				B	SI/F Ch.0 Tx buffer empty									
				C	A/D conversion completion									
High-speed DMA Ch.2/3 trigger set-up register	0040299 (B)	D7	HSD3S3	High-speed DMA Ch.3 trigger set-up	0	Software trigger	0	R/W						
		D6	HSD3S2		1	K54 input (falling edge)	0							
		D5	HSD3S1		2	K54 input (rising edge)	0							
		D4	HSD3S0		3	Port 3 input	0							
					4	Port 7 input								
					5	8-bit timer Ch.3 underflow								
					6	16-bit timer Ch.3 compare B								
					7	16-bit timer Ch.3 compare A								
					8	16-bit timer Ch.5 compare B								
					9	16-bit timer Ch.5 compare A								
					A	SI/F Ch.1 Rx buffer full								
					B	SI/F Ch.1 Tx buffer empty								
					C	A/D conversion completion								
					D3	HSD2S3	High-speed DMA Ch.2 trigger set-up			0	Software trigger	0	R/W	
					D2	HSD2S2				1	K53 input (falling edge)	0		
					D1	HSD2S1				2	K53 input (rising edge)	0		
		D0	HSD2S0	3	Port 2 input	0								
				4	Port 6 input									
				5	8-bit timer Ch.2 underflow									
				6	16-bit timer Ch.2 compare B									
				7	16-bit timer Ch.2 compare A									
				8	16-bit timer Ch.4 compare B									
				9	16-bit timer Ch.4 compare A									
				A	SI/F Ch.0 Rx buffer full									
				B	SI/F Ch.0 Tx buffer empty									
				C	A/D conversion completion									
Flag set/reset method select register	004029F (B)	D7-3	–	reserved	–	–	–	–						
		D2	DENONLY	IDMA enable register set method selection	1	Set only	0	RD/W/R	1	R/W				
		D1	IDMAONLY	IDMA request register set method selection	1	Set only	0	RD/W/R	1	R/W				
		D0	RSTONLY	Interrupt factor flag reset method selection	1	Reset only	0	RD/W/R	1	R/W				

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
TTBR write protect register	004812D (B)	D7	TBRP7	TTBR register write protect	Writing 01011001(0x59) removes the TTBR (0x48134) write protection. Writing other data sets the write protection.	0	W	Undefined in read.		
		D6	TBRP6							
		D5	TBRP5							
		D4	TBRP4							
		D3	TBRP3							
		D2	TBRP2							
		D1	TBRP1							
		D0	TBRP0							
		TTBR low-order register	0048134 (HW)			DF			TTBR15	Trap table base address [15:10]
DE	TTBR14									
DD	TTBR13									
DC	TTBR12									
DB	TTBR11									
DA	TTBR10									
D9	TTBR09			Trap table base address [9:0]	Fixed at 0	0	R	0 when being read. Writing 1 not allowed.		
D8	TTBR08									
D7	TTBR07									
D6	TTBR06									
D5	TTBR05									
D4	TTBR04									
D3	TTBR03									
D2	TTBR02									
D1	TTBR01									
D0	TTBR00									
TTBR high-order register	0048136 (HW)			DF	TTBR33	Trap table base address [31:28]	Fixed at 0	0	R	0 when being read. Writing 1 not allowed.
				DE	TTBR32					
				DD	TTBR31					
		DC	TTBR30							
		DB	TTBR2B	Trap table base address [27:16]	The initial value is set according to the BTA3 pin status. BTA3 = "1": 0x008 BTA3 = "0": 0x0C0	←	R/W			
		DA	TTBR2A							
		D9	TTBR29							
		D8	TTBR28							
		D7	TTBR27							
		D6	TTBR26							
		D5	TTBR25							
		D4	TTBR24							
		D3	TTBR23							
		D2	TTBR22							
		D1	TTBR21							
		D0	TTBR20							

The following collectively explains the basic functions of each control register/bit. For details about individual interrupt systems and the contents classified by an interrupt factor, refer to the descriptions of the peripheral circuits in this manual.

Pxxx2–Pxxx0: Interrupt priority register

Set the priority levels of each interrupt system in the range of 0 to 7.

If this register is set below the IL value of the PSR, no interrupt is generated. The value of this register when initially reset is indeterminate.

Exxx: Interrupt enable register

Enable or disable interrupt generation to the CPU.

Write "1": Interrupt enabled

Write "0": Interrupt disabled

Read: Valid

Interrupts are enabled when the corresponding bits of this register are set to "1" and are disabled when the bits are set to "0".

For the interrupt factors used to request IDMA invocation or clear the standby mode, the corresponding interrupt enable register bit must be set for interrupt enable.

When initially reset, this register is set to "0" (interrupt disabled).

Fxxx: Interrupt factor flag

Indicate the status of interrupt factors generated.

When read

Read "1": Interrupt factor generated

Read "0": No interrupt factor generated

When written using the reset-only method (default)

Write "1": Factor flag is reset

Write "0": Invalid

When written using the read/write method

Write "1": Factor flag is set

Write "0": Factor flag is reset

The interrupt factor flag is set to "1" when an interrupt factor occurs in each peripheral circuit.

If the following conditions are met at this time, an interrupt is generated to the CPU:

1. The corresponding bit of the interrupt enable register is set to "1".
2. No other interrupt request of higher priority has occurred.
3. The IE bit of the PSR is set to "1" (interrupt enabled).
4. The corresponding interrupt priority register is set to a level higher than the CPU's interrupt level (IL).

When using an interrupt factor to request IDMA, note that even when the above conditions are met, no interrupt request to the CPU is generated for the interrupt factor that has occurred. If interrupts are enabled at the setting of IDMA, an interrupt is generated under the above conditions after the data transfer by IDMA is completed.

The interrupt factor flag is always set to "1" when an interrupt factor occurs no matter how the interrupt enable and interrupt priority registers are set.

In order for the next interrupt to be accepted after interrupt generation, the interrupt factor flag must be reset and the PSR must be set up again (by setting the IL below the level indicated by the interrupt priority register and setting the IE bit to "1" or executing the reti instruction).

The interrupt factor flag can only be reset by a write instruction in the software application. If the PSR is again set up to accept interrupts (or the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt may occur again. Note also that the value to be written to reset the flag is "1" when using the reset-only method (RSTONLY = "1") and "0" when using the read/write method (RSTONLY = "0"). Be careful not to confuse these two conditions.

The interrupt factor flag becomes indeterminate when initially reset, so be sure to reset the flag in the software application.

Rxxx: IDMA request register

Specify whether or not to invoke IDMA when an interrupt factor occurs.

When using the set-only method (default)

Write "1": IDMA request

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA request

Write "0": Interrupt request

Read: Valid

If a bit of this register is set to "1", IDMA is invoked when the corresponding interrupt factor occurs and the programmed data transfer is performed. If the register bit is set to "0", regular interrupt processing is performed, without ever invoking IDMA.

For details about IDMA, refer to "IDMA (Intelligent DMA)".

If interrupts are enabled on the IDMA side and the transfer counter reaches the terminal count of 0 after completion of DMA transfer, the IDMA request register is reset to "0" and an interrupt request for the interrupt factor that enabled IDMA invoking is generated.

After an initial reset, this register is set to "0" (Interrupt is requested).

DExxx: IDMA enable register

Enable or disable the IDMA request.

When using the set-only method (default)

Write "1": IDMA enabled

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA enabled

Write "0": IDMA disabled

Read: Valid

If a bit of this register is set to "1", the IDMA request by the interrupt factor is enabled. If the register bit is set to "0", the IDMA request is disabled.

After an initial reset, this register is set to "0" (IDMA is disabled).

RSTONLY: Interrupt factor flag reset method selection
(D0) / Flag set/reset method select register (0x4029F)

Select the method for resetting the interrupt factor flag.

Write "1": Reset-only method

Write "0": Read/write method

Read: Valid

With the reset-only method, the interrupt factor flag is reset by writing "1".

The interrupt factor flags for which "0" has been written can neither be set nor reset. Therefore, this method ensures that only a specific factor flag is reset. However, when using read-modify-write instructions (e.g., bset, bclr, or bnot), note that an interrupt factor flag that has been set to "1" is reset by writing. This method cannot be used to set any interrupt factor flag in the software application.

The read/write method is selected by writing "0" to RSTONLY. When this method is selected, interrupt factor flags can be read and written as for other registers. Therefore, the flag is reset by writing "0" and set by writing "1". In this case all factor flags for which "0" has been written are reset. Even in a read-modify-write operation, an interrupt factor can occur between read and write instructions, so be careful when using this method.

After an initial reset, RSTONLY is set to "1" (reset-only method).

IDMAONLY: IDMA request register set method selection
(D1) / Flag set/reset method select register (0x4029F)

Select the method for setting the IDMA request registers.

Write "1": Set-only method

Write "0": Read/write method

Read: Valid

With the set-only method, IDMA request bits are set by writing "1".

The IDMA request bits for which "0" has been written can neither be set nor reset. Therefore, this method ensures that only a specific IDMA request bit is set. However, when using read-modify-write instructions (e.g., bset, bclr, or bnot), note that an IDMA request bit that has been set to "1" is not reset by writing.

The read/write method is selected by writing "0" to IDMAONLY. When this method is selected, IDMA request bits can be read and written as for other registers. Therefore, the IDMA request bit is reset by writing "0" and set by writing "1". In this case all IDMA request bits for which "0" has been written are reset. Even in a read-modify-write operation, an IDMA request bit can be reset by the hardware between the read and the write, so be careful when using this method.

After an initial reset, IDMAONLY is set to "1" (set-only method).

DENONLY: IDMA enable register set method selection
(D2) / Flag set/reset method select register (0x4029F)

Select the method for setting the IDMA enable registers.

Write "1": Set-only method
Write "0": Read/write method
Read: Valid

With the set-only method, IDMA enable bits are set by writing "1".

The IDMA enable bits for which "0" has been written can neither be set nor reset. Therefore, this method ensures that only a specific IDMA enable bit is set. However, when using read-modify-write instructions (e.g., bset, bclr, or bnot), note that an IDMA enable bit that has been set to "1" is not reset by writing.

The read/write method is selected by writing "0" to DENONLY. When this method is selected, IDMA enable bits can be read and written as for other registers. Therefore, the IDMA enable bit is reset by writing "0" and set by writing "1". In this case all IDMA enable bits for which "0" has been written are reset. Even in a read-modify-write operation, an interrupt enable bit can be reset by the hardware between the read and the write, so be careful when using this method.

After an initial reset, DENONLY is set to "1" (set-only method).

TBRP7–TBRP0: TTBR register write protection ([D[7:0]]) / TTBR write-protect register (0x4812D)

Remove write protection for the TTBR register.

Write 0x59: Write protection is removed
Write not the above: No operation (write protected)
Read: Valid

Before writing to the TTBR register, set TBRP to "0x59" to remove the write protection. Then when data is written to the most significant byte (0x48137) of the TTBR, the register once again becomes write-protected.

After an initial reset, TBRP is set to "0x0" (write protected).

TTBR09–TTBR00: Trap table base address [9:0] (D[9:0]) / TTBR low-order register (0x48134[HW])
TTBR15–TTBR10: Trap table base address [15:10] (D[F:A]) / TTBR low-order register (0x48134[HW])
TTBR2B–TTBR20: Trap table base address [27:16] (D[B:0]) / TTBR high-order register (0x48136[HW])
TTBR33–TTBR30: Trap table base address [31:28] (D[F:C]) / TTBR high-order register (0x48136[HW])

Set the starting address of the trap table.

TTBR0 and TTBR3 are read-only registers and are fixed to "0". For this reason, the trap table starting address always begins with a 1KB boundary address.

The TTBR registers normally are write-protected to prevent them from being inadvertently rewritten. To remove this write protect function, another register, TBRP (D[F:8]) / TTBR write-protect register (0x4812D), is provided. A write to the TTBR register is enabled by writing "0x59" to TBRP and is disabled back again by a write to the most significant byte of the TTBR register (0x48137). Consequently, writes to the TTBR register need to begin with the low-order half-word first. However, since occurrences of NMI and the like between writes of the low-order and high-order half-words cause malfunctions, it is recommended that the register be written in words.

After an initial reset, the TTBR register is set to the boot address that is determined by the BTA3 pin status (BTA3 = high: 0x0080000; BTA3 = low: 0x0C00000).

Programming Notes

- (1) In cases when an interrupt factor that is used for restarting from the standby mode has been set to invoke IDMA, IDMA is started up by the interrupt at its occurrence. In SLEEP mode, the high-speed (OSC3) oscillation circuit also starts operating. However, if an interrupt to be generated upon completion of IDMA is disabled at the setting of IDMA side, no interrupt request is signaled to the CPU. Therefore, the CPU remains idle until the next interrupt request is generated.
- (2) As the E0C33000 Core CPU function, the IL allows interrupt levels to be set in the range of 0 to 15. However, since the interrupt priority register in the C33 Core Block consists of three bits, interrupt levels in each interrupt system can only be set for up to 8.
- (3) When the reset-only method is used to reset the interrupt factor flag (by writing "1"), if a read-modify-write instruction (e.g., bset, bclr, or bnot) is executed, the other interrupt factor flags at the same address that have been set to "1" are reset by a write. This requires caution. In cases when the read/write method is used to reset the interrupt factor flag (by writing "0"), all factor flags for which "0" has been written are reset. When a read-modify-write operation is performed, an interrupt factor may occur between reads and writes, so be careful when using this method.
The same applies to the set-only method and read/write method for the IDMA request and IDMA enable registers.
- (4) After an initial reset, the interrupt factor flags and interrupt priority registers all become indeterminate. To prevent unwanted interrupts or IDMA requests from being generated inadvertently, be sure to reset these flags and registers in the software application.
- (5) To prevent another interrupt from being generated for the same factor again after generation of an interrupt, be sure to reset the interrupt factor flag before enabling interrupts and setting the PSR again or executing the reti instruction.

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II-6 CLG (Clock Generator)

This section describes the method for controlling the system clock.

Configuration of Clock Generator

The C33 Core Block has a built-in clock generator that consists of a high-speed oscillation circuit (OSC3) and a PLL.

The high-speed (OSC3) oscillation circuit generates the main clock for the CPU and internal peripheral circuits (e.g., DMA, serial interface, programmable timer, and A/D converter).

Furthermore, the clock generator can input a sub clock, such as low-speed (OSC1, 32.768 kHz, Typ.) clock generated by the Peripheral Block, for the clock timer and for operating the CPU at a low clock speed in order to reduce current consumption.

Note: When the Peripheral Block including the low-speed (OSC1) oscillation circuit is used, the source clocks for the CPU and the peripheral circuits (e.g., DMA, serial interface, programmable timer, and A/D converter) can be selected between the OSC3 clock and the OSC1 clock independently. For details, refer to "Setting and Switching Over the CPU Operating Clock" in this section and "Prescaler" and "Low-Speed (OSC1) oscillation circuit" of the Peripheral Block.

Figure II-6.1 shows the configuration of the clock generator.

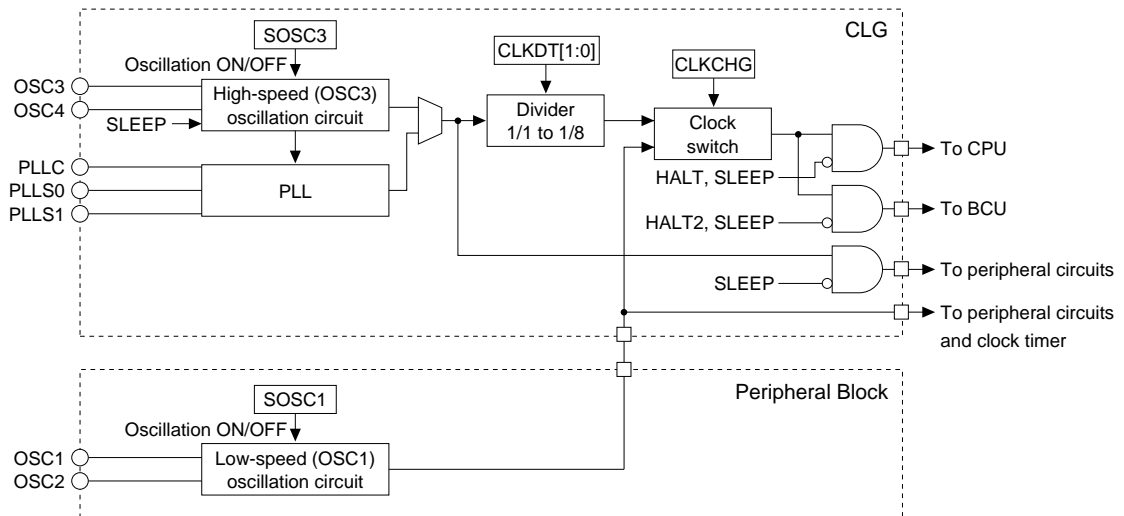


Figure II-6.1 Configuration of Clock Generator

After an initial reset, the output (OSC3 clock) of the high-speed (OSC3) oscillation circuit is set for the CPU operating clock.

When the low-speed (OSC1) oscillation circuit is used, the CPU operating clock can be switched to the output (OSC1 clock) of the low-speed (OSC1) oscillation circuit in a program. Furthermore, each oscillation circuit can be stopped in a program.

If the OSC3 clock is unnecessary such as when performing clock processing only, set the OSC1 clock for operation of the CPU and turn off the high-speed (OSC3) oscillation circuit in order to reduce current consumption. In addition, when SLEEP mode is set, the high-speed (OSC3) oscillation circuit is turned off, greatly reducing current consumption (no internal units except for the clock timer need to be operated).

I/O Pins of Clock Generator

Table II-6.1 lists the I/O pins of the clock generator.

Table II-6.1 I/O Pins of Clock Generator

Pin name	I/O	Function																														
OSC3	I	High-speed (OSC3) oscillation input pin Crystal/ceramic oscillation or external clock input																														
OSC4	O	High-speed (OSC3) oscillation output pin Crystal/ceramic oscillation (open when external clock is used)																														
PLLC	-	Capasitor connecting pin for PLL																														
PLLS[1:0]	I	PLL set-up pins																														
		<table border="1"> <thead> <tr> <th>PLLS1</th> <th>PLLS0</th> <th>fin (fosc3)</th> <th>fout (fPSCIN)</th> <th></th> </tr> </thead> <tbody> <tr> <td>1</td> <td>1</td> <td>10–30MHz</td> <td>20–60MHz</td> <td>*1</td> </tr> <tr> <td></td> <td></td> <td>10–25MHz</td> <td>20–50MHz</td> <td>*2</td> </tr> <tr> <td>0</td> <td>1</td> <td>10–15MHz</td> <td>40–60MHz</td> <td>*1</td> </tr> <tr> <td></td> <td></td> <td>10–12.5MHz</td> <td>40–50MHz</td> <td>*2</td> </tr> <tr> <td>0</td> <td>0</td> <td>PLL is not used</td> <td>L</td> <td>*3</td> </tr> </tbody> </table>	PLLS1	PLLS0	fin (fosc3)	fout (fPSCIN)		1	1	10–30MHz	20–60MHz	*1			10–25MHz	20–50MHz	*2	0	1	10–15MHz	40–60MHz	*1			10–12.5MHz	40–50MHz	*2	0	0	PLL is not used	L	*3
		PLLS1	PLLS0	fin (fosc3)	fout (fPSCIN)																											
		1	1	10–30MHz	20–60MHz	*1																										
				10–25MHz	20–50MHz	*2																										
0	1	10–15MHz	40–60MHz	*1																												
		10–12.5MHz	40–50MHz	*2																												
0	0	PLL is not used	L	*3																												
*1: ROM-less model with 3.3 V ± 0.3 V operating voltage																																
*2: ROM built-in model, or 3.0 V ± 0.3 V operating voltage																																
*3: When the PLL is not used, the OSC3 clock is used directly.																																

High-Speed (OSC3) Oscillation Circuit

The high-speed (OSC3) oscillation circuit generates the main clock for the CPU and internal peripheral circuits (e.g., DMA, serial interface, programmable timer, and A/D converter).

This circuit can be a crystal or a ceramic oscillation circuit. Optionally an external clock source can be used.

Figure II-6.2 shows the structure of the high-speed (OSC3) oscillation circuit.

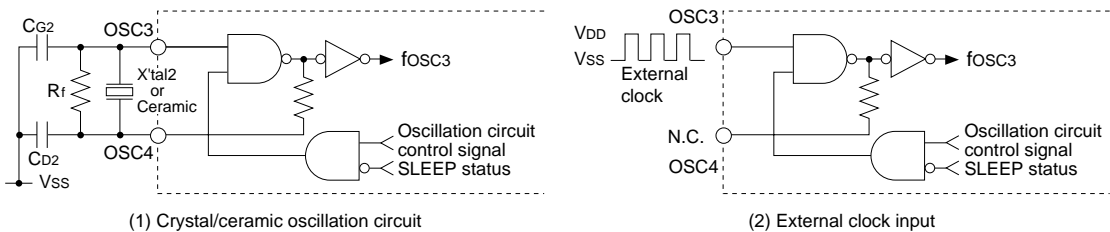


Figure II-6.2 High-Speed (OSC3) Oscillation Circuit

When using a crystal or a ceramic oscillation for this circuit, connect a crystal (X'tal2) or ceramic (Ceramic) resonator and feedback resistor (Rf) between the OSC3 and OSC4 pins, and two capacitors (CG2, CD2) between the OSC3 pin and Vss and the OSC4 pin and Vss, respectively.

When an external clock is used, leave the OSC4 pin open and input a square-wave clock to the OSC3 pin.

The range of oscillation frequencies is 10 MHz to 33 MHz. This frequency range also applies when an external clock is used.

Note: When using the PLL, the oscillation frequency range changes according to the PLL setting. See Table II-6.2.

For details on oscillation characteristics and the external clock input characteristics, refer to "Electrical Characteristics".

PLL

The PLL inputs the OSC3 clock and multiply its frequency. The multiply mode should be set using the PLLS[1:0] pins according to the OSC3 clock frequency.

Table II-6.2 Setting the PLLS[1:0] Pins

PLLS1	PLLS0	Mode	fin (OSC3 clock)	fout	Notes
1	1	x2	10 to 30 MHz 10 to 25 MHz	20 to 60 MHz 20 to 50 MHz	No ROM, and 3.3 V ± 0.3 V ROM incorporated, or 3.3 V ± 0.3 V
0	1	x4	10 to 15 MHz 10 to 12.5 MHz	40 to 60 MHz 20 to 50 MHz	No ROM, and 3.3 V ± 0.3 V ROM incorporated, or 3.3 V ± 0.3 V
0	0	PLL Not used	–	Not used	

Figure II-6.3 shows a basic external connection diagram for the PLL pins.

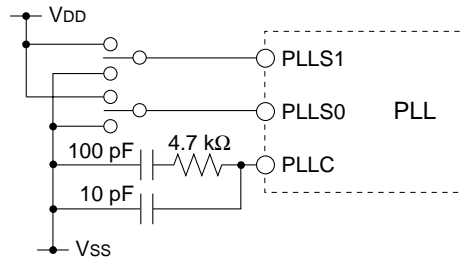


Figure II-6.3 External Connection Diagram

Note: When the PLL is not used, the OSC3 oscillation output is used as the source clock. In this case, the oscillation frequency range is 10 MHz to 33 MHz. Furthermore, leave the PLLC pin open.

Controlling Oscillation

The high-speed (OSC3) oscillation circuit can be turned on or off using SOSC3 (D1) / Power control register (0x40180).

The oscillation circuit is turned off by writing "0" to SOSC3 and turned back on again by writing "1". SOSC3 is set to "1" at initial reset, so the oscillation circuit is turned on.

- Notes:**
- When the high-speed (OSC3) oscillation circuit is used as the clock source for the CPU operating clock, it cannot be turned off. In this case, writing "0" to SOSC3 is ignored. Note also that writing to SOSC3 is allowed only when the power-control register protection flag is set to "0b10010110".
 - Immediately after the oscillation circuit is turned on, a certain period of time is required for oscillation to stabilize (for 3.3-V crystal resonator, this time is 10 ms max.). To prevent the device from operating erratically, do not use the clock until its oscillation has stabilized.

The high-speed (OSC3) oscillation circuit turns off when the CPU is set in SLEEP mode.

Setting and Switching Over the CPU Operating Clock

Setting the CPU operating clock frequency

When operating the CPU with the high-speed (OSC3) clock, the operating frequency can be switched over in four steps. Use CLKDTC[1:0] (D[7:6]) / Power control register (0x40180) for this switchover.

Table II-6.3 Setting of CPU Operating Clock

CLKDTC1	CLKDTC0	Division ratio
1	1	fout/8
1	0	fout/4
0	1	fout/2
0	0	fout/1

fout: PLL output

II CORE BLOCK: CLG (Clock Generator)

The clock thus set becomes the system clock, which is used as the CPU operating clock and the bus clock. At initial reset, the division ratio is set to fout/1, so the CPU is operated directly by the PLL output clock. Since the device's current consumption can be decreased by reducing the CPU operating speed, switch over the operating frequency as necessary.

This setting is effective only for the high-speed (OSC3) clock, and has no effect when the low-speed (OSC1) clock is used as the system clock.

Note: Writing to CLKDT[1:0] is effective only when the power-control register protection flag is set to "0b10010110".

Switching over the CPU operating clock

Note: The CPU operating clock can be switched from OSC3 to OSC1 only when the low-speed (OSC1) oscillation circuit in the Peripheral Block is used.

After an initial reset, the CPU starts operating using the OSC3 clock. All internal peripheral circuits also operate.

In cases in which some peripheral circuits (e.g., programmable timer, serial interface, and A/D converter) that are clocked by the OSC3 clock do not need to be operate and the CPU can process its jobs at a low clock speed, the CPU operating clock can be switched to the OSC1 clock, thereby reducing current consumption. Use CLKCHG (D2) / Power control register (0x40180) to switch over the operating clock.

Procedure for switching over from the OSC3 clock to the OSC1 clock

1. Turn on the low-speed (OSC1) oscillation circuit (by writing "1" to SOSC1).
2. Wait until the OSC1 oscillation stabilizes (three seconds or more).
3. Change the CPU operating clock (by writing "0" to CLKCHG).
4. Turn off the high-speed (OSC3) oscillation circuit (by writing "0" to SOSC3).
 - * Steps 1 and 2 are required only when the low-speed (OSC1) oscillation circuit is inactive.

Notes: • Use separate instructions to switch from OSC3 to OSC1 and turn the OSC3 oscillation off. If these operations are processed simultaneously using one instruction, the CPU may operate erratically.

- Make sure the operation of the peripheral circuits, such as the programmable timer, A/D converter, and serial interface, which are clocked by the OSC3 oscillation circuit, is terminated before the OSC3 oscillation is turned off in order to prevent them from operating erratically.

Procedure for switching over from the OSC1 clock to the OSC3 clock

1. Turn on the high-speed (OSC3) oscillation circuit (by writing "1" to SOSC3).
2. Wait until the OSC3 oscillation stabilizes (10 ms or more for a 3.3-V crystal resonator).
3. Switch over the CPU operating clock (by writing "1" to CLKCHG).

Note: The operating clock switchover by CLKCHG is effective only when both oscillation circuits are on and the power-control register protection flag is set to "0b10010110".

Power-Control Register Protection Flag

The power-control register at address 0x40180, which is used to control the oscillation circuits and the CPU operating clock, is normally disabled against writing in order to prevent it from malfunctioning due to unnecessary writing.

To enable this register for writing, the power-control register protection flag CLGP[7:0] (D[7:0]) / Power-control protection register (0x4019E) must be set to "0b10010110". Note that this setting allows for the power-control register (0x40180) to be written to only once, so all bits of CLGP[7:0] are cleared to "0" when this address is written to. Therefore, CLGP[7:0] must be set to "0b10010110" each time the power-control register (0x40180) is written to.

The flag CLGP[7:0] does not affect the readout from the power-control register (0x40180).

I/O Memory of Clock Generator

Table II-6.4 lists the control bits of clock generator.

Table II-6.4 Control Bits of Clock Generator

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
Power control register	0040180 (B)	D7	CLKDT1	System clock division ratio selection	CLKDTC[1:0]		0	R/W		
		D6	CLKDT0		Division ratio					
					1	1				1/8
					1	0				1/4
				0	1	1/2				
				0	0	1/1				
		D5	PSCON	Prescaler On/Off control	1	On	0	Off	1	R/W
D4-3	-	-	reserved	-	-	-	0	-	Writing 1 not allowed.	
D2	CLKCHG	CPU operating clock switch	1	OSC3	0	OSC1	1	R/W		
D1	SOSC3	High-speed (OSC3) oscillation On/Off	1	On	0	Off	1	R/W		
D0	SOSC1	Low-speed (OSC1) oscillation On/Off	1	On	0	Off	1	R/W		
Clock option register	0040190 (B)	D7-4	-	-	-	-	-	-	0 when being read.	
		D3	HLT2OP	HALT clock option	1	On	0	Off	0	R/W
		D2	8T1ON	OSC3-stabilize waiting function	1	Off	0	On	1	R/W
		D1	-	reserved	-	-	-	0	-	Do not write 1.
		D0	PF1ON	OSC1 external output control	1	On	0	Off	0	R/W
Power control protect register	004019E (B)	D7	CLGP7	Power control register protect flag	Writing 10010110 (0x96)		0	R/W		
		D6	CLGP6		removes the write protection of the power control register (0x40180) and the clock option register (0x40190).		0			
		D5	CLGP5		Writing another value set the write protection.		0			
		D4	CLGP4				0			
		D3	CLGP3				0			
		D2	CLGP2				0			
		D1	CLGP1				0			
		D0	CLGP0				0			

SOSC1: Low-speed (OSC1) oscillation control (D0) / Power control register (0x40180)

Turns the low-speed (OSC1) oscillation on or off.

Write "1": OSC1 oscillation turned on

Write "0": OSC1 oscillation turned off

Read: Valid

The oscillation of the low-speed (OSC1) oscillation circuit is stopped by writing "0" to SOSC1, and started again by writing "1".

Since a duration of maximum three seconds is required for oscillation to stabilize after the oscillation has been restarted, at least this length of time must pass before the OSC1 clock can be used.

Writing to SOSC1 is allowed only when CLGP[7:0] is set to "0b10010110". Note also that if the CPU is operating using the OSC1 clock, writing "0" to SOSC1 is ignored and the oscillation is not turned off.

At initial reset, SOSC1 is set to "1" (OSC1 oscillation turned on).

Note: This control bit is effective only when the low-speed (OSC1) oscillation circuit in the Peripheral Block is used.

SOSC3: High-speed (OSC3) oscillation control (D1) / Power control register (0x40180)

Turns the high-speed (OSC3) oscillation on or off.

Write "1": OSC3 oscillation turned on

Write "0": OSC3 oscillation turned off

Read: Valid

The oscillation of the high-speed (OSC3) oscillation circuit is stopped by writing "0" to SOSC3, and started again by writing "1".

Since a duration of maximum 10 ms (for a 3.3-V crystal resonator) is required for oscillation to stabilize after the oscillation has been restarted, at least this length of time must pass before the OSC3 clock can be used.

Writing to SOSC3 is allowed only when CLGP[7:0] is set to "0b10010110". Note also that if the CPU is operating using the OSC3 clock, writing "0" to SOSC3 is ignored and the oscillation is not turned off.

At initial reset, SOSC3 is set to "1" (OSC3 oscillation turned on).

CLKCHG: CPU operating clock switch (D2) / Power control register (0x40180)

Selects the CPU operating clock.

Write "1": OSC3 clock
 Write "0": OSC1 clock
 Read: Valid

The OSC3 clock is selected as the CPU operating clock by writing "1" to CLKCHG, and OSC1 is selected by writing "0". The operating clock can be switched over in this way only when both the high-speed (OSC3) and low-speed (OSC1) oscillation circuits are on. In addition, writing to CLKCHG is effective only when CLGP[7:0] is set to "0b10010110". Immediately after the oscillation circuit has started oscillating, wait for the oscillation to stabilize before switching over the CPU operating clock.

At initial reset, CLKCHG is set to "1" (OSC3 clock).

Note: This control bit is effective only when the low-speed (OSC1) oscillation circuit in the Peripheral Block is used.

CLKDT1–CLKDT0: CPU operating frequency selection (D[7:6]) / Power control register (0x40180)

Select the CPU operating clock frequency.

Table II-6.5 Setting of CPU Operating Clock

CLKDT1	CLKDT0	Division ratio
1	1	fout/8
1	0	fout/4
0	1	fout/2
0	0	fout/1

fout: PLL output

This setting is effective when the CPU is operated using the high-speed (OSC3) clock and has no effect on the low-speed (OSC1) clock. Writing to CLKDT[1:0] is allowed only when CLGP[7:0] is set to "0b10010110". At initial reset, CLKDT is set to "0" (fout/1).

8T1ON: High-speed (OSC3) oscillation waiting function (D2) / Clock option register (0x40190)

Sets the function for waiting until the high-speed (OSC3) oscillation stabilizes after SLEEP mode is exited.

Write "1": Off
 Write "0": On
 Read: Valid

After SLEEP mode is exited, the high-speed (OSC3) oscillation waiting function is effective by writing "1" to 8T1ON. For this function to be used, the waiting time must be set in 8-bit programmable timer 1 to allow it to start counting before entering SLEEP mode. After SLEEP mode is exited, the OSC3 clock is not supplied to the CPU until 8-bit programmable timer 1 underflows. This function will not work when 8T1ON is set to "0".

The high-speed (OSC3) oscillation waiting function is effective only when SLEEP mode is exited.

Writing to 8T1ON is effective only when CLGP[7:0] is set to "0b10010110".

When writing to 8T1ON, always be sure to write "0" to the reserved bits at address 0x40190.

At initial reset, 8T1ON is set to "0" (Off).

HLT2OP: HALT clock option (D3) / Clock option register (0x40190)

Select a HALT condition (basic mode or HALT2 mode).

Write "1": HALT2 mode
 Write "0": Basic mode
 Read: Valid

When "1" is written to HLT2OP, the CPU will enter HALT2 mode when the HALT instruction is executed. When "0" is written, the CPU will enter basic mode.

Writing to HLT2OP is allowed only when CLGP[7:0] is set to "0b10010110".

At initial reset, HLT2OP is set to "0" (basic mode).

The following shows the operating status in HALT mode (basic mode and HALT2 mode) and SLEEP mode.

Table II-6.6 Operating Status in Standby Mode

Standby mode		Operating status	Reactivating factor
HALT mode	Basic mode	(1) The CPU clock is stopped. (CPU stop status) (2) BCU clock is supplied. (BCU run status) (3) Clocks for the peripheral circuits maintain the status before entering HALT mode. (run or stop) (4) The high-speed oscillation circuit maintains the status before entering HALT mode. (5) The low-speed oscillation circuit maintains the status before entering HALT mode.	(1) Reset, NMI (2) Enabled (not masked) interrupt factors
	HALT2 mode	(1) The CPU clock is stopped. (CPU stop status) (2) BCU clock is stopped. (BCU stop status) (3) Clocks for the peripheral circuits maintain the status before entering HALT mode. (run or stop) (4) The high-speed oscillation circuit maintains the status before entering HALT mode. (5) The low-speed oscillation circuit maintains the status before entering HALT mode.	In HALT2 mode, the A/D, SIO, and timers (8-bit and 16-bit) continue operating without stopping, but since the synchronization clock is stopped, these circuits cannot be restarted. A restart is possible only in the case of: (1) Interrupt from input pin (2) Interrupt from clock timer (3) NMI (4) Reset
SLEEP mode		(1) The CPU clock is stopped. (CPU stop status) (2) BCU clock is stopped. (BCU stop status) (3) Clocks for the peripheral circuits are stopped. (4) The high-speed oscillation circuit is stopped. (5) The low-speed oscillation circuit maintains the status before entering SLEEP mode.	(1) Reset, NMI (2) Enabled (not masked) input port interrupt factors (3) Clock timer interrupt when the low-speed oscillation circuit is being operated

CLGP7–CLGP0:Power-control register protection flag ([D[7:0]) / Power control protection register (0x4019E)

These bits remove the protection against writing to addresses 0x40180 and 0x40190.

Write "0b10010110": Write protection removed

Write other than the above: No operation (write-protected)

Read: Valid

Before writing to address 0x40180 or 0x40190, set CLGP[7:0] to "0b10010110" to remove the protection against writing to that address. This clearing of write protection is effective for only one writing, so the bits are cleared to "0b00000000" by one writing. Therefore, CLGP[7:0] must be set each time the protected address is written to. At initial reset, CLGP is set to "0b00000000" (write-protected).

Programming Notes

- (1) Immediately after the high-speed (OSC3) oscillation circuit is turned on, a certain period of time is required for oscillation to stabilize (for a 3.3-V crystal resonator, this time is 10 ms max.). To prevent the device from operating erratically, do not use the clock until its oscillation has stabilized.
In particular, if the CPU is set in SLEEP mode during operation using the OSC3 clock, the high-speed (OSC3) oscillation circuit is turned off during in SLEEP mode and starts oscillating again after SLEEP mode is exited. To prevent the CPU from operating erratically at restart due to an unstable OSC3 clock, set a sufficient stabilization waiting time in 8-bit programmable timer 1 to turn on the oscillation stabilization waiting function after SLEEP mode is exited before entering SLEEP mode.
- (2) The oscillation circuit used for the CPU operating clock cannot be turned off.
- (3) The CPU operating clock can only be switched over when both the OSC3 and OSC1 oscillation circuits are on. Furthermore, when turning off an oscillation circuit that has become unnecessary as a result of the CPU operating clock switchover, be sure to use separate instructions for switchover and oscillation turnoff. If these two operations are processed simultaneously using one instruction, the CPU may operate erratically.
- (4) If the high-speed (OSC3) oscillation circuit is turned off, all peripheral circuits operated using the OSC3 clock will be inactive.
- (5) If the OSC3 clock is unnecessary, use the OSC1 clock to operate the CPU and turn the high-speed (OSC3) oscillation circuit off. This helps reduce current consumption.

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II-7 DBG (Debug Unit)

Debug Circuit

The C33 Core Block has a built-in debug circuit.

This functional block is provided to simply realize an advanced software development environment.

Note: The debug circuit does not work during normal operation. To construct a software development environment using the debug circuit, the ICD33 (In-Circuit Debugger for E0C33 Family) is separately required.

I/O Pins of Debug Circuit

Six pins used to exclusively connect the ICD33 (In-Circuit Debugger for E0C33 Family) are reserved for the debug circuit. The I/O voltage level of these pins is 3.3 V.

Table II-7.1 lists the I/O pins of the debug circuit.

Table II-7.1 I/O Pins of Debug Circuit

Pin name	I/O	Pull-up	Initial status	Voltage level	Function
DCLK	O	–	1	3.3 V	Clock output for debugging
DST2	O	–	0	3.3 V	Status output 2 for debugging
DST1	O	–	1	3.3 V	Status output 1 for debugging
DST0	O	–	1	3.3 V	Status output 0 for debugging
DPCO	O	–	1	3.3 V	PC output for debugging
DSIO	I/O	With pull-up	1 (Input)	3.3 V	Serial I/O for debugging

The DCLK, DST[2:0] and DPCO outputs are extended functions of the I/O port pins P14, P1[2:0] and P13, respectively. At initial reset, these pins are set as debug signal outputs.

If the debug circuit is not used, these pins can be used for I/O ports or the redefined peripheral circuits by writing "0" to CFEX[1:0] (D[1:0]) / Port function extension register (0x402DF). Refer to "I/O Ports (P Ports)" for the pin functions.

Note: When these pins are set as debug signal outputs, only the ICD33 (In-Circuit Debugger for E0C33 Family) can be connected to these pins. Leave these pins open if the ICD33 is not connected. For connecting the ICD33, refer to the "In-Circuit Debugger (ICD33) Manual". Furthermore, the pin status is fixed as shown in the above table after a user reset.

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E0C33 Block Technical Manual

III PERIPHERAL BLOCK

III-1 INTRODUCTION

The peripheral block consists of a prescaler, four channels of 8-bit programmable timer, six channels of 16-bit programmable timer including watchdog timer function, two channels of serial interface, input and I/O ports, low-speed (OSC1) oscillation circuit and a clock timer.

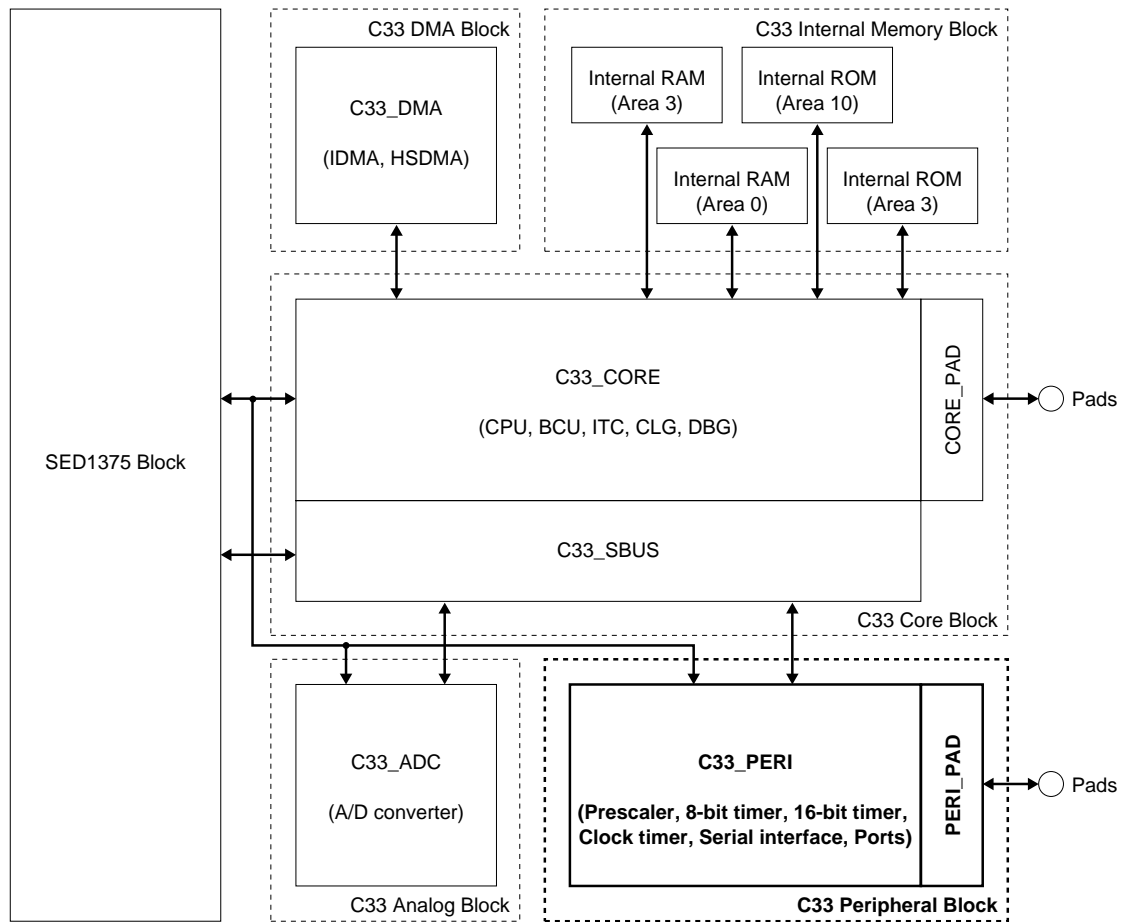


Figure III-1.1 Peripheral Block

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III-2 PRESCALER

Configuration of Prescaler

The prescaler divides the source clock (OSC3/PLL output clock or OSC1 clock) to generate the clocks for the internal peripheral circuits. The prescaler division ratio can be selected for each peripheral circuit in a program. A clock control circuit to control the clock supply to each peripheral circuit is also included.

The following are the peripheral circuits that use the output clock:

- 16-bit programmable timers 5 to 0 (and watchdog timer)
- 8-bit programmable timers 3 to 0 (and serial interface)
- A/D converter

Figure III-2.1 shows the configuration of the prescaler.

For details on control of each peripheral circuit, refer to each corresponding section in this manual.

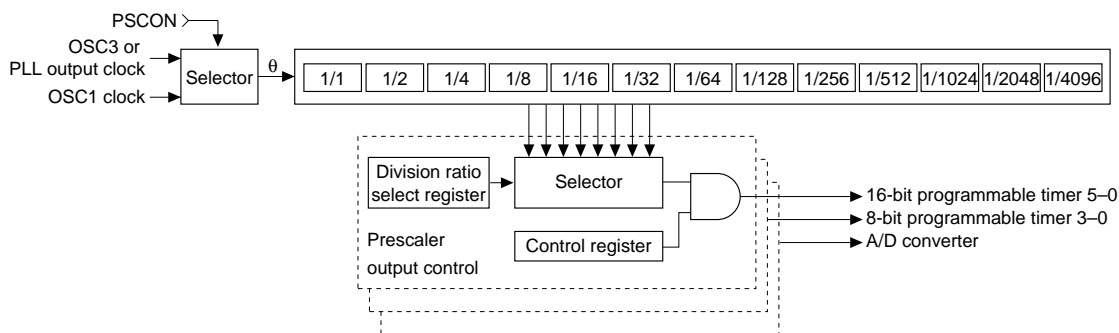


Figure III-2.1 Configuration of Prescaler and Clock Control Circuit

Source Clock

The source clock for the prescaler can be selected using PSCDT0 (D0) / Prescaler clock select register (0x40181). When PSCDT0 = "0", the OSC3 clock (when the PLL is not used) or the PLL output clock (when the PLL is used) is selected.

When PSCDT0 = "1", the OSC1 clock (typ. 32 kHz) is selected.

At initial reset, the OSC3/PLL output clock is selected.

Note: For the prescaler clock, the clock source same as the CPU operating clock must be selected.

For details on how to control the oscillation circuit and CPU operating clock, refer to "CLG (Clock Generator)".

At initial reset, the OSC3 clock is selected.

The source clock is supplied to the prescaler by writing "1" to PSCON (D5) / Power control register (0x40180). At initial reset, PSCON is set to "1", so the prescaler is in an operating state. If all of said peripheral circuits can be turned off, stop the prescaler by writing "0" to PSCON. This helps to reduce current consumption.

Selecting Division Ratio and Output Control for Prescaler

The prescaler has registers for selecting the division ratio and clock output control separately for each peripheral circuit described above, allowing each peripheral circuit to be controlled.

The prescaler's division ratio can be selected from among eight ratios set for each peripheral circuit through the use of the division ratio selection bits. The divided clock is output to the corresponding peripheral circuit by writing "1" to the clock control bit.

Table III-2.1 Control Bits of the Clock Control Registers

Peripheral circuit	Division ratio selection bit	Clock control bit
16-bit programmable timer 0	P16TS0[2:0] (D[2:0]/0x40147)*1	P16TON0 (D3/0x40147)
16-bit programmable timer 1	P16TS1[2:0] (D[2:0]/0x40148)*1	P16TON1 (D3/0x40148)
16-bit programmable timer 2	P16TS2[2:0] (D[2:0]/0x40149)*1	P16TON2 (D3/0x40149)
16-bit programmable timer 3	P16TS3[2:0] (D[2:0]/0x4014A)*1	P16TON3 (D3/0x4014A)
16-bit programmable timer 4	P16TS4[2:0] (D[2:0]/0x4014B)*1	P16TON4 (D3/0x4014B)
16-bit programmable timer 5	P16TS5[2:0] (D[2:0]/0x4014C)*1	P16TON5 (D3/0x4014C)
8-bit programmable timer 0	P8TS0[2:0] (D[2:0]/0x4014D)*2	P8TON0 (D3/0x4014D)
8-bit programmable timer 1	P8TS1[2:0] (D[6:4]/0x4014D)*3	P8TON1 (D7/0x4014D)
8-bit programmable timer 2	P8TS2[2:0] (D[2:0]/0x4014E)*4	P8TON2 (D3/0x4014E)
8-bit programmable timer 3	P8TS3[2:0] (D[6:4]/0x4014E)*2	P8TON3 (D7/0x4014E)
A/D converter	PSAD[2:0] (D[2:0]/0x4014F)*2	PSONAD (D3/0x4014F)

*1 to *4: See Table III-2.2.

Table III-2.2 Division Ratio

Bit setting	7	6	5	4	3	2	1	0
*1	$\theta/4096$	$\theta/1024$	$\theta/256$	$\theta/64$	$\theta/16$	$\theta/4$	$\theta/2$	$\theta/1$
*2	$\theta/256$	$\theta/128$	$\theta/64$	$\theta/32$	$\theta/16$	$\theta/8$	$\theta/4$	$\theta/2$
*3	$\theta/4096$	$\theta/2048$	$\theta/1024$	$\theta/512$	$\theta/256$	$\theta/128$	$\theta/64$	$\theta/32$
*4	$\theta/4096$	$\theta/2048$	$\theta/64$	$\theta/32$	$\theta/16$	$\theta/8$	$\theta/4$	$\theta/2$

(θ = Source clock selected by PSCDT0)

Current consumption can be reduced by turning off the clock output to the peripheral circuits that are unused among those listed above.

Note: In the following cases, the prescaler output clock may contain a hazard:

- If, when a clock is output, its division ratio is changed
- When the clock output is switched between on and off
- When the oscillation circuit is turned off or the CPU operating clock is switched over

Before performing these operations, make sure the 16-bit and 8-bit programmable timers and the A/D converter are turned off.

Source Clock Output to 8-Bit Programmable Timer

In addition to the divided clock, the prescaler can output the source clock directly to the 8-bit programmable timer. This function can be selected for each 8-bit timer using P8TPCK_x bit.

8-bit timer 0: P8TPCK0 (D0) / 8-bit timer clock select register (0x40146)

8-bit timer 1: P8TPCK1 (D1) / 8-bit timer clock select register (0x40146)

8-bit timer 2: P8TPCK2 (D2) / 8-bit timer clock select register (0x40146)

8-bit timer 3: P8TPCK3 (D3) / 8-bit timer clock select register (0x40146)

When P8TPCK_x is set to "1", the prescaler input clock ($\theta/1$) is selected for the 8-bit timer x operating clock.

The clock output is controlled by the P8TON_x bit even if P8TPCK_x is set to "1".

When P8TPCK_x is "0", the divided clock that is selected by P8TS_x[2:0] will be output to the 8-bit timer x.

At initial reset, P8TPCK_x is set to "0" and P8TS_x[2:0] becomes effective.

I/O Memory of Prescaler

Table III-2.3 shows the control bits of the prescaler.

Table III-2.3 Control Bits of Prescaler

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
8-bit timer clock select register	0040146 (B)	D7-4	–	reserved	–	–	–	0 when being read.
		D3	P8TPCK3	8-bit timer 3 clock selection	1 0/1 0 Divided clk.	0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D2	P8TPCK2	8-bit timer 2 clock selection	1 0/1 0 Divided clk.	0	R/W	
		D1	P8TPCK1	8-bit timer 1 clock selection	1 0/1 0 Divided clk.	0	R/W	
D0	P8TPCK0	8-bit timer 0 clock selection	1 0/1 0 Divided clk.	0	R/W			
16-bit timer 0 clock control register	0040147 (B)	D7-4	–	reserved	–	–	–	0 when being read.
		D3	P16TON0	16-bit timer 0 clock control	1 On 0 Off	0	R/W	θ: selected by Prescaler clock select register (0x40181) 16-bit timer 0 can be used as a watchdog timer.
		D2	P16TS02	16-bit timer 0 clock division ratio selection	P16TS0[2:0] Division ratio	0	R/W	
		D1	P16TS01		1 1 1 0/4096	0		
		D0	P16TS00		1 1 0 0/1024	0		
					1 0 1 0/256			
					1 0 0 0/64			
					0 1 1 0/16			
					0 1 0 0/4			
					0 0 1 0/2			
		0 0 0 0/1						
16-bit timer 1 clock control register	0040148 (B)	D7-4	–	reserved	–	–	–	0 when being read.
		D3	P16TON1	16-bit timer 1 clock control	1 On 0 Off	0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D2	P16TS12	16-bit timer 1 clock division ratio selection	P16TS1[2:0] Division ratio	0	R/W	
		D1	P16TS11		1 1 1 0/4096	0		
		D0	P16TS10		1 1 0 0/1024	0		
					1 0 1 0/256			
					1 0 0 0/64			
					0 1 1 0/16			
					0 1 0 0/4			
					0 0 1 0/2			
		0 0 0 0/1						
16-bit timer 2 clock control register	0040149 (B)	D7-4	–	reserved	–	–	–	0 when being read.
		D3	P16TON2	16-bit timer 2 clock control	1 On 0 Off	0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D2	P16TS22	16-bit timer 2 clock division ratio selection	P16TS2[2:0] Division ratio	0	R/W	
		D1	P16TS21		1 1 1 0/4096	0		
		D0	P16TS20		1 1 0 0/1024	0		
					1 0 1 0/256			
					1 0 0 0/64			
					0 1 1 0/16			
					0 1 0 0/4			
					0 0 1 0/2			
		0 0 0 0/1						
16-bit timer 3 clock control register	004014A (B)	D7-4	–	reserved	–	–	–	0 when being read.
		D3	P16TON3	16-bit timer 3 clock control	1 On 0 Off	0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D2	P16TS32	16-bit timer 3 clock division ratio selection	P16TS3[2:0] Division ratio	0	R/W	
		D1	P16TS31		1 1 1 0/4096	0		
		D0	P16TS30		1 1 0 0/1024	0		
					1 0 1 0/256			
					1 0 0 0/64			
					0 1 1 0/16			
					0 1 0 0/4			
					0 0 1 0/2			
		0 0 0 0/1						
16-bit timer 4 clock control register	004014B (B)	D7-4	–	reserved	–	–	–	0 when being read.
		D3	P16TON4	16-bit timer 4 clock control	1 On 0 Off	0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D2	P16TS42	16-bit timer 4 clock division ratio selection	P16TS4[2:0] Division ratio	0	R/W	
		D1	P16TS41		1 1 1 0/4096	0		
		D0	P16TS40		1 1 0 0/1024	0		
					1 0 1 0/256			
					1 0 0 0/64			
					0 1 1 0/16			
					0 1 0 0/4			
					0 0 1 0/2			
		0 0 0 0/1						

III PERIPHERAL BLOCK: PRESCALER

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
16-bit timer 5 clock control register	004014C (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	P16TON5	16-bit timer 5 clock control	1 On	0 Off	0	R/W	
		D2	P16TS52	16-bit timer 5 clock division ratio selection	P16TS5[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D1	P16TS51		1 1 1	θ/4096	0		
		D0	P16TS50		1 1 0	θ/1024	0		
					1 0 1	θ/256			
					1 0 0	θ/64			
					0 1 1	θ/16			
					0 1 0	θ/4			
					0 0 1	θ/2			
		0 0 0	θ/1						
8-bit timer 0/1 clock control register	004014D (B)	D7	P8TON1	8-bit timer 1 clock control	1 On	0 Off	0	R/W	
		D6	P8TS12	8-bit timer 1 clock division ratio selection	P8TS1[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181) 8-bit timer 1 can generate the OSC3 oscillation-stabilize waiting period.
		D5	P8TS11		1 1 1	θ/4096	0		
		D4	P8TS10		1 1 0	θ/2048	0		
					1 0 1	θ/1024			
					1 0 0	θ/512			
					0 1 1	θ/256			
					0 1 0	θ/128			
					0 0 1	θ/64			
				0 0 0	θ/32				
		D3	P8TON0	8-bit timer 0 clock control	1 On	0 Off	0	R/W	
		D2	P8TS02	8-bit timer 0 clock division ratio selection	P8TS0[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181) 8-bit timer 0 can generate the DRAM refresh clock.
		D1	P8TS01		1 1 1	θ/256	0		
		D0	P8TS00		1 1 0	θ/128	0		
		1 0 1	θ/64						
		1 0 0	θ/32						
		0 1 1	θ/16						
		0 1 0	θ/8						
		0 0 1	θ/4						
		0 0 0	θ/2						
8-bit timer 2/3 clock control register	004014E (B)	D7	P8TON3	8-bit timer 3 clock control	1 On	0 Off	0	R/W	
		D6	P8TS32	8-bit timer 3 clock division ratio selection	P8TS3[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181) 8-bit timer 3 can generate the clock for the serial I/F Ch.1.
		D5	P8TS31		1 1 1	θ/256	0		
		D4	P8TS30		1 1 0	θ/128	0		
					1 0 1	θ/64			
					1 0 0	θ/32			
					0 1 1	θ/16			
					0 1 0	θ/8			
					0 0 1	θ/4			
				0 0 0	θ/2				
		D3	P8TON2	8-bit timer 2 clock control	1 On	0 Off	0	R/W	
		D2	P8TS22	8-bit timer 2 clock division ratio selection	P8TS2[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181) 8-bit timer 2 can generate the clock for the serial I/F Ch.0.
		D1	P8TS21		1 1 1	θ/4096	0		
		D0	P8TS20		1 1 0	θ/2048	0		
		1 0 1	θ/64						
		1 0 0	θ/32						
		0 1 1	θ/16						
		0 1 0	θ/8						
		0 0 1	θ/4						
		0 0 0	θ/2						
A/D clock control register	004014F (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	PSONAD	A/D converter clock control	1 On	0 Off	0	R/W	
		D2	PSAD2	A/D converter clock division ratio selection	P8TS0[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D1	PSAD1		1 1 1	θ/256	0		
		D0	PSAD0		1 1 0	θ/128	0		
					1 0 1	θ/64			
					1 0 0	θ/32			
					0 1 1	θ/16			
					0 1 0	θ/8			
					0 0 1	θ/4			
		0 0 0	θ/2						

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
Power control register	0040180 (B)	D7	CLKDT1	System clock division ratio selection	CLKDT[1:0]	Division ratio	0	R/W		
		D6	CLKDT0				1			1
					1	0	1/4			
					0	1	1/2			
					0	0	1/1			
		D5	PSCON	Prescaler On/Off control	1	On	0	Off		1
D4-3	-	reserved			-		0	-	Writing 1 not allowed.	
D2	CLKCHG	CPU operating clock switch	1	OSC3	0	OSC1	1	R/W		
D1	SOSC3	High-speed (OSC3) oscillation On/Off	1	On	0	Off	1	R/W		
D0	SOSC1	Low-speed (OSC1) oscillation On/Off	1	On	0	Off	1	R/W		
Prescaler clock select register	0040181 (B)	D7-1	-	reserved		-		0	-	
		D0	PSCDT0	Prescaler clock selection	1	OSC1	0	OSC3/PLL	0	R/W
Power control protect register	004019E (B)	D7	CLGP7	Power control register protect flag	Writing 10010110 (0x96) removes the write protection of the power control register (0x40180). Writing another value set the write protection.	0	R/W			
		D6	CLGP6			0				
		D5	CLGP5			0				
		D4	CLGP4			0				
		D3	CLGP3			0				
		D2	CLGP2			0				
		D1	CLGP1			0				
		D0	CLGP0			0				

PSCON: Prescaler on/off control (D5) / Power control register (0x40180)

Turns the prescaler on or off.

Write "1": On

Write "0": Off

Read: Valid

The source clock is input to the prescaler by writing "1" to PSCON, thereby starting a dividing operation.

The prescaler is turned off by writing "0". If the peripheral circuits do not need to be operated, write "0" to this bit to reduce current consumption. Since PSCON is protected against writing the same as SOSC1, SOSC3, CLKCHG and CLKDT[1:0], CLGP[7:0] must be set to "0b10010110" before PSCON can be changed.

At initial reset, PSCON is set to "1" (On).

CLGP7-CLGP0: Power-control register protection flag ([D7:0]) / Power control protection register (0x4019E)

These bits remove the protection against writing to addresses 0x40180 and 0x40190.

Write "0b10010110": Write protection removed

Write other than the above: No operation (write-protected)

Read: Valid

Before writing to address 0x40180 or 0x40190, set CLGP[7:0] to "0b10010110" to remove the protection against writing to that address. This clearing of write protection is effective for only one writing, so the bits are cleared to "0b00000000" by one writing. Therefore, CLGP[7:0] must be set each time the protected address is written to.

At initial reset, CLGP is set to "0b00000000" (write-protected).

PSCDT0: Prescaler clock selection (D0) / Prescaler clock select register (0x40181)

Select the source clock for the prescaler.

Write "1": OSC1 clock

Write "0": OSC3 clock/PLL output clock

Read: Valid

When "1" is written to PSCDT0, the OSC1 clock (typ. 32 kHz) is selected.

When "0" is written, the OSC3 clock (when the PLL is not used) or the PLL output clock (when the PLL is used) is selected.

For the prescaler clock, the clock source same as the CPU operating clock must be selected.

At initial reset, PSCDT0 is set to "0" (OSC3 clock/PLL output clock).

P16TS0[2:0]: 16-bit timer 0 clock division ratio (D[2:0]) / 16-bit timer 0 clock control register (0x40147)
P16TS1[2:0]: 16-bit timer 1 clock division ratio (D[2:0]) / 16-bit timer 1 clock control register (0x40148)
P16TS2[2:0]: 16-bit timer 2 clock division ratio (D[2:0]) / 16-bit timer 2 clock control register (0x40149)
P16TS3[2:0]: 16-bit timer 3 clock division ratio (D[2:0]) / 16-bit timer 3 clock control register (0x4014A)
P16TS4[2:0]: 16-bit timer 4 clock division ratio (D[2:0]) / 16-bit timer 4 clock control register (0x4014B)
P16TS5[2:0]: 16-bit timer 5 clock division ratio (D[2:0]) / 16-bit timer 5 clock control register (0x4014C)
P8TS0[2:0]: 8-bit timer 0 clock division ratio (D[2:0]) / 8-bit timer 0/1 clock control register (0x4014D)
P8TS1[2:0]: 8-bit timer 1 clock division ratio (D[6:4]) / 8-bit timer 0/1 clock control register (0x4014D)
P8TS2[2:0]: 8-bit timer 2 clock division ratio (D[2:0]) / 8-bit timer 2/3 clock control register (0x4014E)
P8TS3[2:0]: 8-bit timer 3 clock division ratio (D[6:4]) / 8-bit timer 2/3 clock control register (0x4014E)
PSAD[2:0]: A/D converter clock division ratio (D[2:0]) / A/D clock control register (0x4014F)

Select a clock for each peripheral circuit.

The desired division ratio can be selected from among the eight ratios shown on the I/O map. Note that the division ratio differs for each peripheral circuit.

These bits can also be read out.

At initial reset, all of these bits are set to "0b000" (highest frequency available).

P16TON0: 16-bit timer 0 clock control (D3) / 16-bit timer 0 clock control register (0x40147)
P16TON1: 16-bit timer 1 clock control (D3) / 16-bit timer 1 clock control register (0x40148)
P16TON2: 16-bit timer 2 clock control (D3) / 16-bit timer 2 clock control register (0x40149)
P16TON3: 16-bit timer 3 clock control (D3) / 16-bit timer 3 clock control register (0x4014A)
P16TON4: 16-bit timer 4 clock control (D3) / 16-bit timer 4 clock control register (0x4014B)
P16TON5: 16-bit timer 5 clock control (D3) / 16-bit timer 5 clock control register (0x4014C)
P8TON0: 8-bit timer 0 clock control (D3) / 8-bit timer 0/1 clock control register (0x4014D)
P8TON1: 8-bit timer 1 clock control (D7) / 8-bit timer 0/1 clock control register (0x4014D)
P8TON2: 8-bit timer 2 clock control (D3) / 8-bit timer 2/3 clock control register (0x4014E)
P8TON3: 8-bit timer 3 clock control (D7) / 8-bit timer 2/3 clock control register (0x4014E)
PSONAD: A/D converter clock control (D3) / A/D clock control register (0x4014F)

Control the clock supply to each peripheral circuit.

Write "1": On
 Write "0": Off
 Read: Valid

The clock selected using the division ratio setup bits is output to the corresponding peripheral circuit by writing "1" to these bits.

The clock is not output by writing "0". If the peripheral circuits do not need to be operated, write "0" to these bits. This helps to reduce current consumption.

At initial reset, all of these bits are set to "0" (Off).

P8TPCK0: 8-bit timer 0 clock selection (D0) / 8-bit timer clock select register (0x40146)
P8TPCK1: 8-bit timer 1 clock selection (D1) / 8-bit timer clock select register (0x40146)
P8TPCK2: 8-bit timer 2 clock selection (D2) / 8-bit timer clock select register (0x40146)
P8TPCK3: 8-bit timer 3 clock selection (D3) / 8-bit timer clock select register (0x40146)

Select the operating clock for the 8-bit programmable timer.

Write "1": Prescaler input clock ($\theta/1$)
 Write "0": Divided clock
 Read: Valid

When "1" is written to P8TPCKx, the prescaler input clock ($\theta/1$) is selected for the 8-bit timer x operating clock. The clock output is controlled by the P8TONx bit even if P8TPCKx is set to "1".

When "0" is written, the divided clock that is selected by P8TSx[2:0] will be output to the 8-bit timer x.

At initial reset, P8TPCKx is set to "0" (divided clock).

Programming Notes

- (1) For the prescaler clock, the clock source same as the CPU operating clock must be selected.
- (2) In the following cases, the prescaler output clock may contain a hazard:
 - If, during outputting of a clock, its division ratio is changed
 - When the clock output is switched between on and off
 - When the oscillation circuit is turned off or the CPU operating clock is switched overBefore performing these operations, make sure the 16-bit and 8-bit programmable timers and the A/D converter are turned off.
- (3) When the 16-bit and 8-bit programmable timers and the A/D converter do not need to be operated, turn off the clock supply to those peripheral circuits. This helps to reduce current consumption.

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III-3 8-BIT PROGRAMMABLE TIMERS

Configuration of 8-Bit Programmable Timer

The Peripheral Block contains four channels of 8-bit programmable timers (timers 0 to 3).

Figure III-3.1 shows the structure of the 8-bit programmable timer.

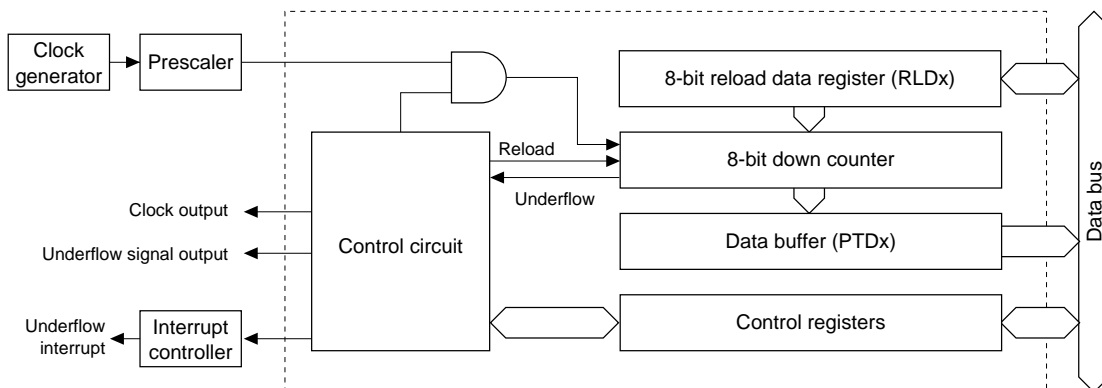


Figure III-3.1 Structure of 8-Bit Programmable Timer

Each timer consists of an 8-bit presentable counter and can output a clock generated by the counter's underflow signal to the internal peripheral circuits or external devices. The output clock cycle can be selected from a wide range of cycles by setting the preset data that can be set in the software and the input clock in the prescaler.

Output Pins of 8-Bit Programmable Timers

Table III-3.1 shows the pins that are used to output the underflow signals of the 8-bit programmable timers to external devices.

Table III-3.1 Output Pins of 8-Bit Programmable Timers

Pin name	I/O	Function	Function select bit
P10/EXCL0/ T8UF0	I/O	I/O port / 16-bit timer 0 event counter input / 8-bit timer 0 output / DST0 output	CFP10(D0)/P1 function select register (0x402D4) CFEX1(D1)/Port function extension register (0x402DF)
P11/EXCL1/ T8UF1	I/O	I/O port / 16-bit timer 1 event counter input / 8-bit timer 1 output / DST1 output	CFP11(D1)/P1 function select register (0x402D4) CFEX1(D1)/Port function extension register (0x402DF)
P12/EXCL2/ T8UF2	I/O	I/O port / 16-bit timer 2 event counter input / 8-bit timer 2 output / DST2 output	CFP12(D2)/P1 function select register (0x402D4) CFEX0(D0)/Port function extension register (0x402DF)
P13/EXCL3/ T8UF3	I/O	I/O port / 16-bit timer 3 event counter input / 8-bit timer 3 output / DPCO output	CFP13(D3)/P1 function select register (0x402D4) CFEX1(D1)/Port function extension register (0x402DF)

T8UFx (output pin of the 8-bit programmable timer)

This pin outputs a clock divided in each 8-bit programmable timer. The pulse width is equal to that of input clock of the 8-bit programmable timer (prescaler output). Therefore, the pulse width varies according to the prescaler setting.

How to set the output pins of the 8-bit programmable timer

All pins used by the 8-bit programmable timers are shared with I/O ports, event counter inputs of the 16-bit programmable timers and debug signal outputs. At cold start, all these pins are set for the debug signal outputs (function select bit CFP1[3:0] = "0", port extended function bit CFEX[1:0] = "1"). When using the clock output function of the 8-bit programmable timer, write "0" to the port extended function bit CFEXx and write "1" to the function select bit CFP1x for the corresponding pin.

Then, after setting the above, write "1" to the I/O port's I/O control bit IOC1x (D[3:0]) / P1 I/O control register (0x402D6) to set to output mode. In input mode, the pin functions as the 16-bit programmable timer's event counter input and cannot be used to output a clock of the 8-bit programmable timer. At cold start, the register is set to input mode. At hot start, the register retains its status from prior to the reset.

Uses of 8-Bit Programmable Timers

The down-counter of the 8-bit programmable timer cyclically outputs an underflow signal according to the preset data that is set in the software. This underflow signal is used to generate an interrupt request to the CPU or to control the internal peripheral circuits. In addition, this signal can be output to external devices.

Furthermore, each 8-bit programmable timer generates a clock from the underflow signal by dividing it by 2, and the resulting clock is output to a specific internal peripheral circuit.

CPU interrupt request/IDMA invocation request

Each timer's underflow condition can be used as an interrupt factor to output an interrupt request to the CPU.

Therefore, an interrupt can be generated at an interval that is set in the software.

This interrupt factor also can be used to invoke IDMA or HSDMA.

Clock output to external devices

The underflow signal can be output from the chip to the outside. This output can be used to control external devices. The output pins of each timer are described in the preceding section.

Control of and clock supply to internal peripheral circuits

The following describes the functions controlled by the underflow signal from the 8-bit programmable timer and the internal peripheral circuits that use the timer's output clock.

8-bit programmable timer 0

- DRAM refresh

When the BCU has a DRAM directly connected to its external bus, the underflow signal from timer 0 can be used as a DRAM refresh request signal. This enables the intervals of the refresh cycle to be programmed.

To use this function, write "1" to the BCU's control bit RPC (D9) / Bus control register (0x4812E) to enable the DRAM refresh.

- A/D conversion start trigger

The A/D converter enables a trigger for starting the A/D conversion to be selected from among four available types. One of these is the underflow signal of the 8-bit programmable timer 0. This makes it possible to perform the A/D conversion at programmable intervals.

To use this function, write "10" to the A/D converter control bit TS[1:0] (D[4:3]) / A/D trigger register (0x40242) to select the 8-bit programmable timer 0 as the trigger.

8-bit programmable timer 1

- Oscillation stabilization wait time of the high-speed (OSC3) oscillation circuit

When SLEEP mode is cleared by an external interrupt, the high-speed (OSC3) oscillation circuit starts oscillating. To prevent the CPU from being operated erratically by an unstable clock before the oscillation stabilizes, the C33 Core Block enables setting of the waiting time before the CPU starts operating after SLEEP is cleared. Use the 8-bit programmable timer 1 to generate this waiting time. If the 8-bit programmable timer 1 is set so that the timer is actuated when the high-speed (OSC3) oscillation circuit starts oscillating the timer and, after the oscillation stabilization time elapses, an underflow signal is generated, then the CPU can be started up by that underflow signal.

To use this function, write "0" to the oscillation circuit control bit 8T1ON (D2) / Clock option register (0x40190) to enable the oscillation stabilization waiting function.

8-bit programmable timer 2

- Clock supply to the Ch.0 serial interface

When using the Ch.0 serial interface in the clock-synchronized master mode or the internal clock-based asynchronous mode, the output clock derived from the underflow signal of the 8-bit programmable timer 2 by dividing it by 2 is supplied to the serial interface as its operating clock. This enables the transfer rate of the serial interface to be programmed.

To use this function, write "0" to the serial interface control bit SSCK0 (D2) / Serial I/F Ch.0 control register (0x401E3) to select the internal clock.

8-bit programmable timer 3

- Clock supply to the Ch.1 serial interface

When using the Ch.1 serial interface in the clock-synchronized master mode or the internal clock-based asynchronous mode, the output clock derived from the underflow signal of the 8-bit programmable timer 3 by dividing it by 2 is supplied to the serial interface as its operating clock. This enables the transfer rate of the serial interface to be programmed.

To use this function, write "0" to the serial interface control bit SSCK1 (D2) / Serial I/F Ch.1 control register (0x401E8) to select the internal clock.

Control and Operation of 8-Bit Programmable Timer

With the 8-bit programmable timer, the following settings must first be made before it starts counting:

1. Setting the output pin (only when necessary)
2. Setting the input clock
3. Setting the preset data (initial counter value)
4. Setting the interrupt/IDMA/HSDMA

Setting of an output pin is necessary only when the output clock of the 8-bit programmable timer is supplied to external devices. For details on how to set the pin, refer to "Output Pins of 8-Bit Programmable Timers".

For details on how to set interrupts and DMA, refer to "8-Bit Programmable Timer Interrupts and DMA".

Note: The 8-bit programmable timers 0 through 3 all operate in the same way during counting, and the structure of their control registers is also the same. The control bit names are assigned the numerals "0" through "3" to denote the timer numbers. Since all these timers have common functions, timer numbers here are represented it is by "x" unless necessary to specify a timer number.

Setting the input clock

The 8-bit programmable timer is operated by the prescaler's output clock. The prescaler's division ratio can be selected for each timer.

Division ratio select bit	Clock control bit	Register
8-bit timer 0: P8TS0[2:0] (D2:0)	P8TON0 (D3)	8-bit timer 0/1 clock control register (0x4014D)
8-bit timer 1: P8TS1[2:0] (D6:4)	P8TON1 (D7)	8-bit timer 0/1 clock control register (0x4014D)
8-bit timer 2: P8TS2[2:0] (D2:0)	P8TON2 (D3)	8-bit timer 2/3 clock control register (0x4014E)
8-bit timer 3: P8TS3[2:0] (D6:4)	P8TON3 (D7)	8-bit timer 2/3 clock control register (0x4014E)

Note that the division ratios differ for each timer (see Table III-3.2).

Furthermore, the prescaler input clock can be directly supplied to the 8-bit timer by writing "1" to the P8TCPKx bit in the 8-bit timer clock select register (0x40146).

Timer 0 clock selection: P8TCPK0 (D0) / 8-bit timer clock select register (0x40146)

Timer 1 clock selection: P8TCPK1 (D1) / 8-bit timer clock select register (0x40146)

Timer 2 clock selection: P8TCPK2 (D2) / 8-bit timer clock select register (0x40146)

Timer 3 clock selection: P8TCPK3 (D3) / 8-bit timer clock select register (0x40146)

When using the divided clock selected by P8TSx, set P8TCPKx to "0".

Table III-3.2 Input Clock Selection

Timer	P8TSx = 7	P8TSx = 6	P8TSx = 5	P8TSx = 4	P8TSx = 3	P8TSx = 2	P8TSx = 1	P8TSx = 0	P8TCPK = 1
Timer 0	fPSCIN/256	fPSCIN/128	fPSCIN/64	fPSCIN/32	fPSCIN/16	fPSCIN/8	fPSCIN/4	fPSCIN/2	fPSCIN/1
Timer 1	fPSCIN/4096	fPSCIN/2048	fPSCIN/1024	fPSCIN/512	fPSCIN/256	fPSCIN/128	fPSCIN/64	fPSCIN/32	fPSCIN/1
Timer 2	fPSCIN/4096	fPSCIN/2048	fPSCIN/64	fPSCIN/32	fPSCIN/16	fPSCIN/8	fPSCIN/4	fPSCIN/2	fPSCIN/1
Timer 3	fPSCIN/256	fPSCIN/128	fPSCIN/64	fPSCIN/32	fPSCIN/16	fPSCIN/8	fPSCIN/4	fPSCIN/2	fPSCIN/1

fPSCIN: Prescaler input clock frequency

The selected clock is output from the prescaler to the 8-bit programmable timer by writing "1" to P8TONx.

Notes: • The 8-bit programmable timer operates only when the prescaler is operating. (Refer to "Prescaler".)

- Do not use a clock that is faster than the CPU operating clock as the 8-bit programmable timer.
- When setting an input clock, make sure the 8-bit programmable timer is turned off.

Setting preset data (initial counter value)

Each timer has an 8-bit down-counter and a reload data register. The reload data register RLD_x is used to set the initial value of the down-counter of each timer.

Timer 0 reload data: RLD0[7:0] (D[7:0]) / 8-bit timer 0 reload data register (0x40161)

Timer 1 reload data: RLD1[7:0] (D[7:0]) / 8-bit timer 1 reload data register (0x40165)

Timer 2 reload data: RLD2[7:0] (D[7:0]) / 8-bit timer 2 reload data register (0x40169)

Timer 3 reload data: RLD3[7:0] (D[7:0]) / 8-bit timer 3 reload data register (0x4016D)

The reload data registers can be read and written. At initial reset, the reload data registers are not initialized.

The data written to this register is preset in the down-counter, and the counter starts counting down from the preset value.

Data is thus preset in the down-counter in the following two cases:

1. When it is preset in the software

Presetting in the software is performed using the preset control bit PSET_x. When this bit is set to "1", the content of the reload data register is loaded into the down-counter at that point.

Timer 0 preset: PSET0 (D1) / 8-bit timer 0 control register (0x40160)

Timer 1 preset: PSET1 (D1) / 8-bit timer 1 control register (0x40164)

Timer 2 preset: PSET2 (D1) / 8-bit timer 2 control register (0x40168)

Timer 3 preset: PSET3 (D1) / 8-bit timer 3 control register (0x4016C)

2. When the down-counter underflown during counting

Since the reload data is preset in the down-counter upon underflow, its underflow cycle is determined by the value that is set in the reload data register. This underflow signal controls each function described in the preceding section.

Before starting the 8-bit programmable timer, set the initial value in the reload data register and use the PSET_x bit to preset the data in the down-counter.

The underflow cycle is determined by the prescaler setting and the reload data. The relationship between these two parameters is expressed by the following equation:

$$\text{Under flow cycle} = \frac{\text{RLD}_x + 1}{f_{\text{PSCIN}} \times \text{dr}} \quad [\text{sec.}]$$

f_{PSCIN}: Prescaler input clock frequency [Hz]

dr: Prescaler division ratio set by P8TS_x

RLD_x: Set value of the RLD_x register (0 to 255)

Timer RUN/STOP control

Each timer has a PTRUN_x bit to control RUN/STOP.

Timer 0 RUN/STOP control: PTRUN0 (D0) / 8-bit timer 0 control register (0x40160)

Timer 1 RUN/STOP control: PTRUN1 (D0) / 8-bit timer 1 control register (0x40164)

Timer 2 RUN/STOP control: PTRUN2 (D0) / 8-bit timer 2 control register (0x40168)

Timer 3 RUN/STOP control: PTRUN3 (D0) / 8-bit timer 3 control register (0x4016C)

The timer is initiated to start counting down by writing "1" to PTRUN_x. Writing "0" to PTRUN_x disables the clock input and causes the timer to stop counting.

This RUN/STOP control does not affect the counter data. Even when the timer has stopped counting, the counter retains its count so that it can start counting again from that point.

When the terminal count is reached and the counter underflows, the initial value is reloaded from the reload data register into the counter.

When both the timer RUN/STOP control bit (PTRUN_x) and the timer preset bit (PSET_x) are set to "1" at the same time, the timer starts counting after presetting the reload register value into the counter.

III PERIPHERAL BLOCK: 8-BIT PROGRAMMABLE TIMERS

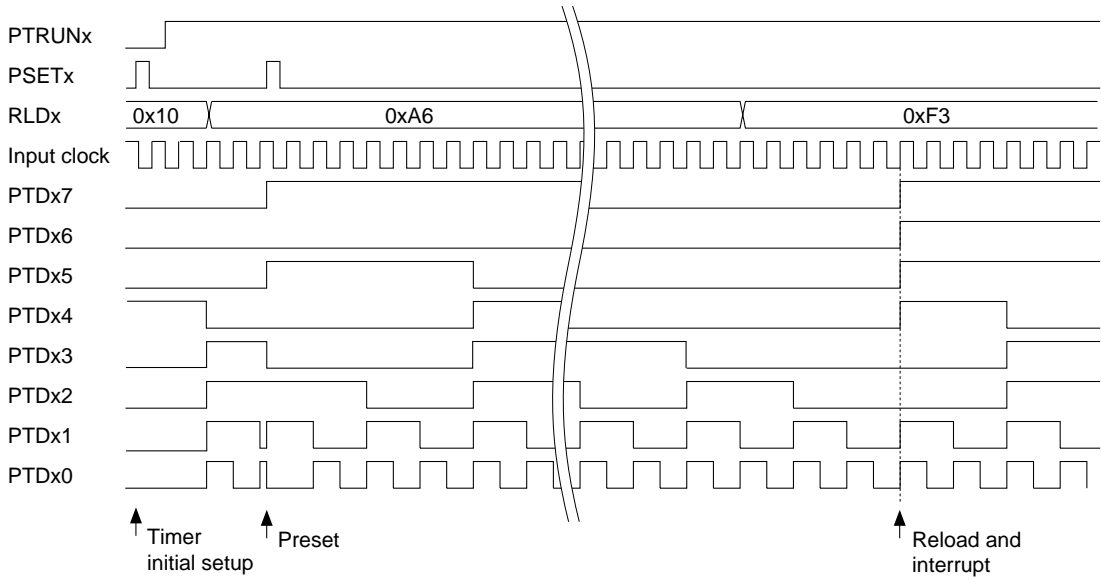


Figure III-3.2 Basic Operation Timing of Counter

Reading out counter data

The counter data is read out via a PTDx data buffer. The counter data can be read out at any time.

Timer 0 data: PTD0[7:0] (D[7:0]) / 8-bit timer 0 counter data register (0x40162)

Timer 1 data: PTD1[7:0] (D[7:0]) / 8-bit timer 1 counter data register (0x40166)

Timer 2 data: PTD2[7:0] (D[7:0]) / 8-bit timer 2 counter data register (0x4016A)

Timer 3 data: PTD3[7:0] (D[7:0]) / 8-bit timer 3 counter data register (0x4016E)

Control of Clock Output

When outputting an underflow signal of the 8-bit programmable timer to external devices, or when supplying a clock generated by the underflow signal to the serial interface, it is necessary to control the clock output of the timer.

Timer 0 clock output control: PTOUT0 (D2) / 8-bit timer 0 control register (0x40160)

Timer 1 clock output control: PTOUT1 (D2) / 8-bit timer 1 control register (0x40164)

Timer 2 clock output control: PTOUT2 (D2) / 8-bit timer 2 control register (0x40168)

Timer 3 clock output control: PTOUT3 (D2) / 8-bit timer 3 control register (0x4016C)

To output the underflow signal/clock, write "1" to PTOUTx. If an output pin has been set, the underflow signal is output from that pin.

The same applies when timer 2 or 3 has been set as the clock source of the serial interface. A clock generated from the underflow signal by dividing it by 2 is output to the serial interface through this control. The clock output is turned off by writing "0" to PTOUTx, and the external output is fixed at "0" and the internal clock output is fixed at "1".

Figure III-3.3 shows the waveforms of the output signals.

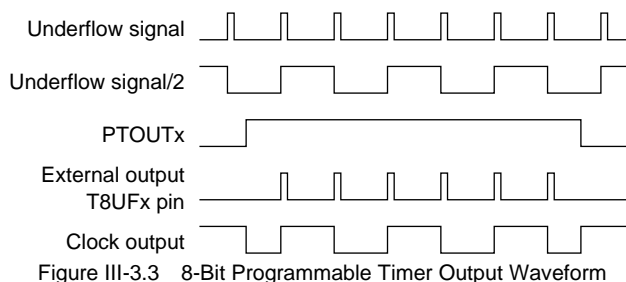


Figure III-3.3 8-Bit Programmable Timer Output Waveform

The underflow signal's pulse width (duration of the high period) is equal to that of the timer's input clock (prescaler's output).

8-bit timer external output (P10–P13 ports)

- 1) After an initial reset (cold start), the ports (P10–P13) are set to debug signal output ports.
- 2) The port (P10–P13) outputs "0" when it is set to the 8-bit timer output (timer output is off status).
- 3) The timer output is left as "0" when the timer output is turned on after setting the input clock and timer initial value.
- 4) When an underflow occurs after starting the timer, the port outputs a pulse with the same width as the 8-bit timer input clock pulse (prescaler's output).

8-Bit Programmable Timer Interrupts and DMA

The 8-bit programmable timer has a function to generate an interrupt based on the underflow state of each timer. The timing at which an interrupt is generated is shown in Figure III-3.2 in the preceding section.

Control registers of the interrupt controller

Table III-3.3 shows the interrupt controller's control register provided for each timer.

Table III-3.3 Control Registers of Interrupt Controller

Timer	Interrupt factor flag	Interrupt enable register	Interrupt priority register
Timer 0	F8TU0(D0/0x40285)	E8TU0(D0/0x40275)	P8TM[2:0](D[2:0]/0x40269)
Timer 1	F8TU1(D1/0x40285)	E8TU1(D1/0x40275)	
Timer 2	F8TU2(D2/0x40285)	E8TU2(D2/0x40275)	
Timer 3	F8TU3(D3/0x40285)	E8TU3(D3/0x40275)	

When the timer underflows, the corresponding interrupt factor flag is set to "1". If the interrupt enable register bit corresponding to that interrupt factor flag has been set to "1", an interrupt request is generated. An interrupt caused by a timer can be disabled by leaving the interrupt enable register bit for that timer set to "0". The interrupt factor flag is set to "1" whenever the timer underflows, regardless of how the interrupt enable register is set (even when it is set to "0").

The interrupt priority register sets an interrupt priority level (0 to 7) for the four timers as one interrupt source. Within 8-bit programmable timers, timer 0 has the highest priority and timer 3 the lowest. An interrupt request to the CPU is accepted on the condition that no other interrupt request of a higher priority has been generated.

It is only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the timer interrupt level set by the interrupt priority register, that a timer interrupt request is actually accepted by the CPU.

For details on these interrupt control registers and device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

Intelligent DMA

The underflow interrupt factor of each timer can invoke intelligent DMA (IDMA). This enables memory-to-memory DMA transfers to be performed cyclically.

The following shows the IDMA channel numbers set to each timer:

IDMA channel
 Timer 0: 0x13
 Timer 1: 0x14
 Timer 2: 0x15
 Timer 3: 0x16

For IDMA to be invoked, the IDMA request and IDMA enable bits shown in Table III-3.4 must be set to "1" in advance. Transfer conditions, etc. must also be set on the IDMA side in advance.

Table III-3.4 Control Bits for IDMA Transfer

Timer	IDMA request bit	IDMA enable bit
Timer 0	R8TU0(D2/0x40292)	DE8TU0(D2/0x40296)
Timer 1	R8TU1(D3/0x40292)	DE8TU1(D3/0x40296)
Timer 2	R8TU2(D4/0x40292)	DE8TU2(D4/0x40296)
Timer 3	R8TU3(D5/0x40292)	DE8TU3(D5/0x40296)

If the IDMA request and enable bits are set to "1", IDMA is invoked through generation of an interrupt factor. No interrupt request is generated at that point. An interrupt request is generated after the DMA transfer is completed. The registers can also be set so as not to generate an interrupt, with only a DMA transfer performed.

For details on IDMA transfers and interrupt control upon completion of IDMA transfer, refer to "IDMA (Intelligent DMA)".

High-speed DMA

The underflow interrupt factor of each timer can also invoke high-speed DMA (HSDMA).

The following shows the HSDMA channel number and trigger set-up bit corresponding to each timer:

Table III-3.5 HSDMA Trigger Set-up Bits

Timer	HSDMA channel	Trigger set-up bits
Timer 0	0	HSD0S[3:0] (D[3:0]) / HSDMA Ch.0/1 trigger set-up register (0x40298)
Timer 1	1	HSD1S[3:0] (D[7:4]) / HSDMA Ch.0/1 trigger set-up register (0x40298)
Timer 2	2	HSD2S[3:0] (D[3:0]) / HSDMA Ch.2/3 trigger set-up register (0x40299)
Timer 3	3	HSD3S[3:0] (D[7:4]) / HSDMA Ch.2/3 trigger set-up register (0x40299)

For HSDMA to be invoked, the trigger set-up bits should be set to "0101" in advance. Transfer conditions, etc. must also be set on the HSDMA side.

If the 8-bit timer is selected as the HSDMA trigger, the HSDMA channel is invoked through generation of the interrupt factor.

For details on HSDMA transfer, refer to "HSDMA (High-Speed DMA)".

Trap vectors

The trap vector addresses for individual underflow interrupt factors are set by default as shown below:

(BTA3 = high) (BTA3 = low)

- Timer 0 underflow interrupt: 0x00800D0 0x0C000D0
- Timer 1 underflow interrupt: 0x00800D4 0x0C000D4
- Timer 2 underflow interrupt: 0x00800D8 0x0C000D8
- Timer 3 underflow interrupt: 0x00800DC 0x0C000DC

The base address of the trap table can be changed using the TTBR register (0x48134 to 0x48137).

I/O Memory of 8-Bit Programmable Timers

Table III-3.6 shows the control bits of the 8-bit programmable timers.

For details on the I/O memory of the prescaler used to set a clock, refer to "Prescaler".

Table III-3.6 Control Bits of 8-Bit Programmable Timer

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
8-bit timer 0 control register	0040160 (B)	D7-3	–	reserved	–	–	–	0 when being read.	
		D2	PTOUT0	8-bit timer 0 clock output control	1 On 0 Off	0	R/W		
		D1	PSET0	8-bit timer 0 preset	1 Preset 0 Invalid	–	W	0 when being read.	
		D0	PTRUN0	8-bit timer 0 Run/Stop control	1 Run 0 Stop	0	R/W		
8-bit timer 0 reload data register	0040161 (B)	D7	RLD07	8-bit timer 0 reload data RLD07 = MSB RLD00 = LSB	0 to 255		X	R/W	
		D6	RLD06				X		
		D5	RLD05				X		
		D4	RLD04				X		
		D3	RLD03				X		
		D2	RLD02				X		
		D1	RLD01				X		
		D0	RLD00				X		
8-bit timer 0 counter data register	0040162 (B)	D7	PTD07	8-bit timer 0 counter data PTD07 = MSB PTD00 = LSB	0 to 255		X	R	
		D6	PTD06				X		
		D5	PTD05				X		
		D4	PTD04				X		
		D3	PTD03				X		
		D2	PTD02				X		
		D1	PTD01				X		
		D0	PTD00				X		
8-bit timer 1 control register	0040164 (B)	D7-3	–	reserved	–	–	–	0 when being read.	
		D2	PTOUT1	8-bit timer 1 clock output control	1 On 0 Off	0	R/W		
		D1	PSET1	8-bit timer 1 preset	1 Preset 0 Invalid	–	W	0 when being read.	
		D0	PTRUN1	8-bit timer 1 Run/Stop control	1 Run 0 Stop	0	R/W		
8-bit timer 1 reload data register	0040165 (B)	D7	RLD17	8-bit timer 1 reload data RLD17 = MSB RLD10 = LSB	0 to 255		X	R/W	
		D6	RLD16				X		
		D5	RLD15				X		
		D4	RLD14				X		
		D3	RLD13				X		
		D2	RLD12				X		
		D1	RLD11				X		
		D0	RLD10				X		
8-bit timer 1 counter data register	0040166 (B)	D7	PTD17	8-bit timer 1 counter data PTD17 = MSB PTD10 = LSB	0 to 255		X	R	
		D6	PTD16				X		
		D5	PTD15				X		
		D4	PTD14				X		
		D3	PTD13				X		
		D2	PTD12				X		
		D1	PTD11				X		
		D0	PTD10				X		
8-bit timer 2 control register	0040168 (B)	D7-3	–	reserved	–	–	–	0 when being read.	
		D2	PTOUT2	8-bit timer 2 clock output control	1 On 0 Off	0	R/W		
		D1	PSET2	8-bit timer 2 preset	1 Preset 0 Invalid	–	W	0 when being read.	
		D0	PTRUN2	8-bit timer 2 Run/Stop control	1 Run 0 Stop	0	R/W		
8-bit timer 2 reload data register	0040169 (B)	D7	RLD27	8-bit timer 2 reload data RLD27 = MSB RLD20 = LSB	0 to 255		X	R/W	
		D6	RLD26				X		
		D5	RLD25				X		
		D4	RLD24				X		
		D3	RLD23				X		
		D2	RLD22				X		
		D1	RLD21				X		
		D0	RLD20				X		
8-bit timer 2 counter data register	004016A (B)	D7	PTD27	8-bit timer 2 counter data PTD27 = MSB PTD20 = LSB	0 to 255		X	R	
		D6	PTD26				X		
		D5	PTD25				X		
		D4	PTD24				X		
		D3	PTD23				X		
		D2	PTD22				X		
		D1	PTD21				X		
		D0	PTD20				X		

III PERIPHERAL BLOCK: 8-BIT PROGRAMMABLE TIMERS

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
8-bit timer 3 control register	004016C (B)	D7-3	–	reserved	–	–	–	0 when being read.	
		D2	PTOUT3	8-bit timer 3 clock output control	1 On	0 Off	0	R/W	
		D1	PSET3	8-bit timer 3 preset	1 Preset	0 Invalid	–	W	0 when being read.
		D0	PTRUN3	8-bit timer 3 Run/Stop control	1 Run	0 Stop	0	R/W	
8-bit timer 3 reload data register	004016D (B)	D7	RLD37	8-bit timer 3 reload data RLD37 = MSB RLD30 = LSB	0 to 255		X	R/W	
		D6	RLD36		X				
		D5	RLD35		X				
		D4	RLD34		X				
		D3	RLD33		X				
		D2	RLD32		X				
		D1	RLD31		X				
		D0	RLD30		X				
8-bit timer 3 counter data register	004016E (B)	D7	PTD37	8-bit timer 3 counter data PTD37 = MSB PTD30 = LSB	0 to 255		X	R	
		D6	PTD36		X				
		D5	PTD35		X				
		D4	PTD34		X				
		D3	PTD33		X				
		D2	PTD32		X				
		D1	PTD31		X				
		D0	PTD30		X				
8-bit timer, serial I/F Ch.0 interrupt priority register	0040269 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PSIO02	Serial interface Ch.0 interrupt level	0 to 7		X	R/W	
		D5	PSIO01		X				
		D4	PSIO00		X				
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	P8TM2	8-bit timer 0–3 interrupt level	0 to 7		X	R/W	
D1	P8TM1	X							
D0	P8TM0	X							
8-bit timer interrupt enable register	0040275 (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	E8TU3	8-bit timer 3 underflow	1 Enabled	0 Disabled	0	R/W	
		D2	E8TU2	8-bit timer 2 underflow			0	R/W	
		D1	E8TU1	8-bit timer 1 underflow			0	R/W	
		D0	E8TU0	8-bit timer 0 underflow			0	R/W	
8-bit timer interrupt factor flag register	0040285 (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	F8TU3	8-bit timer 3 underflow	1 Factor is generated	0 No factor is generated	X	R/W	
		D2	F8TU2	8-bit timer 2 underflow			X	R/W	
		D1	F8TU1	8-bit timer 1 underflow			X	R/W	
		D0	F8TU0	8-bit timer 0 underflow			X	R/W	
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register	0040292 (B)	D7	RSTX0	SIF Ch.0 transmit buffer empty	1 IDMA request	0 Interrupt request	0	R/W	
		D6	RSRX0	SIF Ch.0 receive buffer full			0	R/W	
		D5	R8TU3	8-bit timer 3 underflow			0	R/W	
		D4	R8TU2	8-bit timer 2 underflow			0	R/W	
		D3	R8TU1	8-bit timer 1 underflow			0	R/W	
		D2	R8TU0	8-bit timer 0 underflow			0	R/W	
		D1	R16TC5	16-bit timer 5 comparison A			0	R/W	
		D0	R16TU5	16-bit timer 5 comparison B			0	R/W	
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register	0040296 (B)	D7	DESTX0	SIF Ch.0 transmit buffer empty	1 IDMA enabled	0 IDMA disabled	0	R/W	
		D6	DESRX0	SIF Ch.0 receive buffer full			0	R/W	
		D5	DE8TU3	8-bit timer 3 underflow			0	R/W	
		D4	DE8TU2	8-bit timer 2 underflow			0	R/W	
		D3	DE8TU1	8-bit timer 1 underflow			0	R/W	
		D2	DE8TU0	8-bit timer 0 underflow			0	R/W	
		D1	DE16TC5	16-bit timer 5 comparison A			0	R/W	
		D0	DE16TU5	16-bit timer 5 comparison B			0	R/W	
P1 function select register	00402D4 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	CFP16	P16 function selection	1 EXCL5 #DMAEND1	0 P16	0	R/W	Extended functions (0x402DF)
		D5	CFP15	P15 function selection	1 EXCL4 #DMAEND0	0 P15	0	R/W	
		D4	CFP14	P14 function selection	1 FOSC1	0 P14	0	R/W	
		D3	CFP13	P13 function selection	1 EXCL3 T8UF3	0 P13	0	R/W	
		D2	CFP12	P12 function selection	1 EXCL2 T8UF2	0 P12	0	R/W	
		D1	CFP11	P11 function selection	1 EXCL1 T8UF1	0 P11	0	R/W	
		D0	CFP10	P10 function selection	1 EXCL0 T8UF0	0 P10	0	R/W	

III PERIPHERAL BLOCK: 8-BIT PROGRAMMABLE TIMERS

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks	
P1 I/O control register	00402D6 (B)	D7	–	reserved	–		–	–	0 when being read.	
		D6	IOCI6	P16 I/O control	1	Output	0	Input	0	R/W
		D5	IOCI5	P15 I/O control					0	R/W
		D4	IOCI4	P14 I/O control					0	R/W
		D3	IOCI3	P13 I/O control					0	R/W
		D2	IOCI2	P12 I/O control					0	R/W
		D1	IOCI1	P11 I/O control					0	R/W
		D0	IOCI0	P10 I/O control					0	R/W
Port function extension register	00402DF (B)	D7	CFEX7	P07 port extended function	1	#DMAEND3	0	P07, etc.	0	R/W
		D6	CFEX6	P06 port extended function	1	#DMAACK3	0	P06, etc.	0	R/W
		D5	CFEX5	P05 port extended function	1	#DMAEND2	0	P05, etc.	0	R/W
		D4	CFEX4	P04 port extended function	1	#DMAACK2	0	P04, etc.	0	R/W
		D3	CFEX3	P31 port extended function	1	#GARD	0	P31, etc.	0	R/W
		D2	CFEX2	P21 port extended function	1	#GAAS	0	P21, etc.	0	R/W
		D1	CFEX1	P10, P11, P13 port extended function	1	DST0 DST1 DPC0	0	P10, etc. P11, etc. P13, etc.	1	R/W
		D0	CFEX0	P12, P14 port extended function	1	DST2 DCLK	0	P12, etc. P14, etc.	1	R/W

CFP13–CFP10: P1[3:0] pin function selection (D[3:0]) / P1 function select register (0x402D4)

Selects the pin that is used to output a timer underflow signal to external devices.

Write "1": Underflow signal output pin

Write "0": I/O port pin

Read: Valid

Select the pin used to output a timer underflow signal to external devices from among P10 through P13 by writing "1" to the corresponding bit, CFP10 through CFP13. P10 through P13 correspond to timers 0 through 3, respectively. If "0" is written to CFP1x, the pin is set for an I/O port.

At cold start, CFP1x is set to "0" (I/O port). At hot start, the bit retains its state from prior to the initial reset.

IOCI3–IOCI0: P1[3:0] port I/O control (D[3:0]) / P1 I/O control register (0x402D6)

Sets input or output mode for P10 through P13.

Write "1": Output mode

Write "0": Input mode

Read: Valid

If a pin chosen from among P10 through P13 is used to output an underflow signal, write "1" to the corresponding I/O control bit to set it to output mode. If the pin is set to input mode, even if its CFP1x is set to "1", it functions as the event counter input pin of a 16-bit programmable timer cannot be used to output a timer underflow signal.

At cold start, IOCIx is set to "0" (input mode). At hot start, the bit retains its state from prior to the initial reset.

CFEX1: P10, P11, P13 port extended function (D1) / Port function extension register (0x402DF)

CFEX0: P12, P14 port extended function (D0) / Port function extension register (0x402DF)

Sets whether the function of an I/O-port pin is to be extended.

Write "1": Function-extended pin

Write "0": I/O-port/peripheral-circuit pin

Read: Valid

When CFEX[1:0] is set to "1", the P13–P10 ports function as debug signal output ports. When CFEX[1:0] = "0", the CFP1[3:0] bit becomes effective, so the settings of these bits determine whether the P13–P10 ports function as I/O ports or timer underflow signal output ports.

At cold start, CFEX[1:0] is set to "1" (function-extended pins). At hot start, CFEX[1:0] retains its state from prior to the initial reset.

RLD07–RLD00: Timer 0 reload data (D[7:0]) / 8-bit timer 0 reload data register (0x40161)

RLD17–RLD10: Timer 1 reload data (D[7:0]) / 8-bit timer 1 reload data register (0x40165)

RLD27–RLD20: Timer 2 reload data (D[7:0]) / 8-bit timer 2 reload data register (0x40169)

RLD37–RLD30: Timer 3 reload data (D[7:0]) / 8-bit timer 3 reload data register (0x4016D)

Set the initial counter value of each timer.

The reload data set in this register is loaded into each counter, and the counter starts counting down beginning with this data, which is used as the initial count.

There are two cases in which the reload data is loaded into the counter: when data is preset after "1" is written to PSETx, or when data is automatically reloaded upon counter underflow.

At initial reset, RLD is not initialized.

PTD07–PTD00: Timer 0 counter data (D[7:0]) / 8-bit timer 0 counter data (0x40162)

PTD17–PTD10: Timer 1 counter data (D[7:0]) / 8-bit timer 1 counter data (0x40166)

PTD27–PTD20: Timer 2 counter data (D[7:0]) / 8-bit timer 2 counter data (0x4016A)

PTD37–PTD30: Timer 3 counter data (D[7:0]) / 8-bit timer 3 counter data (0x4016E)

The 8-bit programmable timer data can be read out from these bits.

These bits function as buffers that retain the counter data when read out, enabling the data to be read out at any time.

At initial reset, PTD is not initialized.

PSET0: Timer 0 preset (D1) / 8-bit timer 0 control register (0x40160)

PSET1: Timer 1 preset (D1) / 8-bit timer 1 control register (0x40164)

PSET2: Timer 2 preset (D1) / 8-bit timer 2 control register (0x40168)

PSET3: Timer 3 preset (D1) / 8-bit timer 3 control register (0x4016C)

Preset the reload data in the counter.

Write "1": Preset

Write "0": Invalid

Read: Always "0"

The reload data of RLDx is preset in the counter of timer x by writing "1" to PSETx. If the counter is preset when in a RUN state, the counter starts counting immediately after the reload data is preset.

If the counter is preset when in a STOP state, the reload data that has been preset is retained.

Writing "0" results in No Operation.

Since PSETx is a write-only bit, its content when read is always "0".

PTRUN0: Timer 0 RUN/STOP control (D0) / 8-bit timer 0 control register (0x40160)

PTRUN1: Timer 1 RUN/STOP control (D0) / 8-bit timer 1 control register (0x40164)

PTRUN2: Timer 2 RUN/STOP control (D0) / 8-bit timer 2 control register (0x40168)

PTRUN3: Timer 3 RUN/STOP control (D0) / 8-bit timer 3 control register (0x4016C)

Controls the counter's RUN/STOP states.

Write "1": RUN

Write "0": STOP

Read: Valid

The counter of each timer starts counting down when "1" written to PTRUNx, and stops counting when "0" is written.

While in a STOP state, the counter retains its count until it is preset with reload data or placed in a RUN state.

When the state is changed from STOP to RUN, the counter can restart counting beginning with the retained count.

At initial reset, PTRUNx is set to "0" (STOP).

PTOUT0: Timer 0 clock output control register (D2) / 8-bit timer 0 control register (0x40160)

PTOUT1: Timer 1 clock output control register (D2) / 8-bit timer 1 control register (0x40164)

PTOUT2: Timer 2 clock output control register (D2) / 8-bit timer 2 control register (0x40168)

PTOUT3: Timer 3 clock output control register (D2) / 8-bit timer 3 control register (0x4016C)

Controls the clock output of each timer.

Write "1": On

Write "0": Off

Read: Valid

The underflow signal of timer x is output from the external output pin set by CFP1x by writing "1" to PTOUTx.

When using timer 2 or 3 as the clock source of the serial interface, a clock generated from the underflow signal by dividing it by 2 is output to the corresponding channel of the serial interface.

The clock output is turned off by writing "0" to PTOUT, and the external output is fixed at "0" and the internal clock output is fixed at "1".

At initial reset, PTOUT is set to "0" (off).

P8TM2–P8TM0: 8-bit timer interrupt level (D[2:0]) / 8-bit timer, serial I/F Ch.0 interrupt priority register (0x40269)

Set the priority level of the 8-bit programmable timer interrupt in the range of 0 to 7.

At initial reset, the content of the P8TM register becomes indeterminate.

E8TU0: Timer 0 interrupt enable (D0) / 8-bit timer interrupt enable register (0x40275)

E8TU1: Timer 1 interrupt enable (D1) / 8-bit timer interrupt enable register (0x40275)

E8TU2: Timer 2 interrupt enable (D2) / 8-bit timer interrupt enable register (0x40275)

E8TU3: Timer 3 interrupt enable (D3) / 8-bit timer interrupt enable register (0x40275)

Enables or disables generation of an interrupt to the CPU.

Write "1": Interrupt enabled

Write "0": Interrupt disabled

Read: Valid

E8TUX is the interrupt enable bit which controls the interrupt generated by each timer. The interrupt set to "1" by this bit is enabled, and the interrupt set to "0" by this bit is disabled.

At initial reset, E8TUX is set to "0" (interrupt disabled).

F8TU0: Timer 0 interrupt factor flag (D0) / 8-bit timer interrupt factor flag register (0x40285)

F8TU1: Timer 1 interrupt factor flag (D1) / 8-bit timer interrupt factor flag register (0x40285)

F8TU2: Timer 2 interrupt factor flag (D2) / 8-bit timer interrupt factor flag register (0x40285)

F8TU3: Timer 3 interrupt factor flag (D3) / 8-bit timer interrupt factor flag register (0x40285)

Indicates the interrupt generation status of the 8-bit programmable timer.

When read

Read "1": Interrupt factor has occurred

Read "0": No interrupt factor has occurred

When written using the reset-only method (default)

Write "1": Interrupt factor flag is reset

Write "0": Invalid

When written using the read/write method

Write "1": Interrupt flag is set

Write "0": Interrupt flag is reset

F8TUx is the interrupt factor flag corresponding to each timer. It is set to "1" when the counter underflows.

At this time, if the following conditions are met, an interrupt to the CPU is generated:

1. The corresponding interrupt enable register bit is set to "1".
2. No other interrupt request of a higher priority has been generated.
3. The IE bit of the PSR is set to "1" (interrupts enabled).
4. The value set in the corresponding interrupt priority register is higher than the interrupt level (IL) of the CPU.

When using the interrupt factor of the 8-bit programmable timer to request IDMA, note that even when the above conditions are met, no interrupt request to the CPU is generated for the interrupt factor that has occurred. If interrupts are enabled at the setting of IDMA, an interrupt is generated under the above conditions after the data transfer by IDMA is completed.

The interrupt factor flag is set to "1" whenever interrupt generation conditions are met, regardless of how the interrupt enable and interrupt priority registers are set.

If the next interrupt is to be accepted after an interrupt has occurred, it is necessary that the interrupt factor flag be reset, and that the PSR be set again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can be reset only by writing to it in the software. Note that if the PSR is set again to accept interrupts generated (or if the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

At initial reset, the content of F8TUx becomes indeterminate, so be sure to reset it in the software.

R8TU0: Timer 0 IDMA request (D2) / 16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register (0x40292)

R8TU1: Timer 1 IDMA request (D3) / 16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register (0x40292)

R8TU2: Timer 2 IDMA request (D4) / 16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register (0x40292)

R8TU3: Timer 3 IDMA request (D5) / 16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register (0x40292)

Specifies whether IDMA is to be invoked at the occurrence of an interrupt factor.

When using the set-only method (default)

Write "1": IDMA request

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA request
Write "0": Interrupt request
Read: Valid

R8TU_x is the IDMA request bit for each timer. If this bit is set to "1", IDMA can be invoked when an interrupt factor occurs, and thus programmed data transfers are performed. If the bit is set to "0", normal interrupt processing is performed and IDMA is not invoked.

For details on IDMA, refer to "IDMA (Intelligent DMA)".

At initial reset, R8TU_x is set to "0" (interrupt request).

DE8TU0: Timer 0 IDMA enable (D2) / 16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register (0x40296)

DE8TU1: Timer 1 IDMA enable (D3) / 16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register (0x40296)

DE8TU2: Timer 2 IDMA enable (D4) / 16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register (0x40296)

DE8TU3: Timer 3 IDMA enable (D5) / 16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register (0x40296)

Enables IDMA transfer by means of an interrupt factor.

When using the set-only method (default)

Write "1": IDMA enabled
Write "0": Not changed
Read: Valid

When using the read/write method

Write "1": IDMA enabled
Write "0": IDMA disabled
Read: Valid

If DE8TU_x is set to "1", the IDMA request by the interrupt factor is enabled. If the register bit is set to "0", the IDMA request is disabled.

After an initial reset, DE8TU_x is set to "0" (IDMA disabled).

Programming Notes

- (1) The 8-bit programmable timer operates only when the prescaler is operating.
- (2) Do not use a clock that is faster than the CPU operating clock for the 8-bit programmable timer.
- (3) When setting an input clock, make sure the 8-bit programmable timer is turned off.
- (4) Since the underflow interrupt condition and the timer output status are undefined after an initial reset, the counter initial value should be set to the 8-bit timer before resetting the interrupt factor flag or turning the timer output on.
- (5) After an initial reset, the interrupt factor flag (F8TU_x) becomes indeterminate. To prevent generation of an unwanted interrupt or IDMA request, be sure to reset this flag in the software.
- (6) To prevent another interrupt from being generated again by the same factor after an interrupt has occurred, be sure to reset the interrupt factor flag (F8TU_x) before setting the PSR again or executing the reti instruction.

III-4 16-BIT PROGRAMMABLE TIMERS

Configuration of 16-Bit Programmable Timer

The Peripheral Block contains six systems of 16-bit programmable timers (timers 0 to 5). They also have an event counter function using an I/O port pin.

Note: On the following pages, each timer is identified as timer x ($x = 0$ to 5). The functions and control register structures of 16-bit programmable timers 0 to 5 are the same. Control bit names are assigned numerals "0" to "5" denoting timer numbers. Since explanations are common to all timers, timer numbers are represented by "x" unless it is necessary to specify a timer number.

Figure III-4.1 shows the structure of one channel of the 16-bit programmable timer.

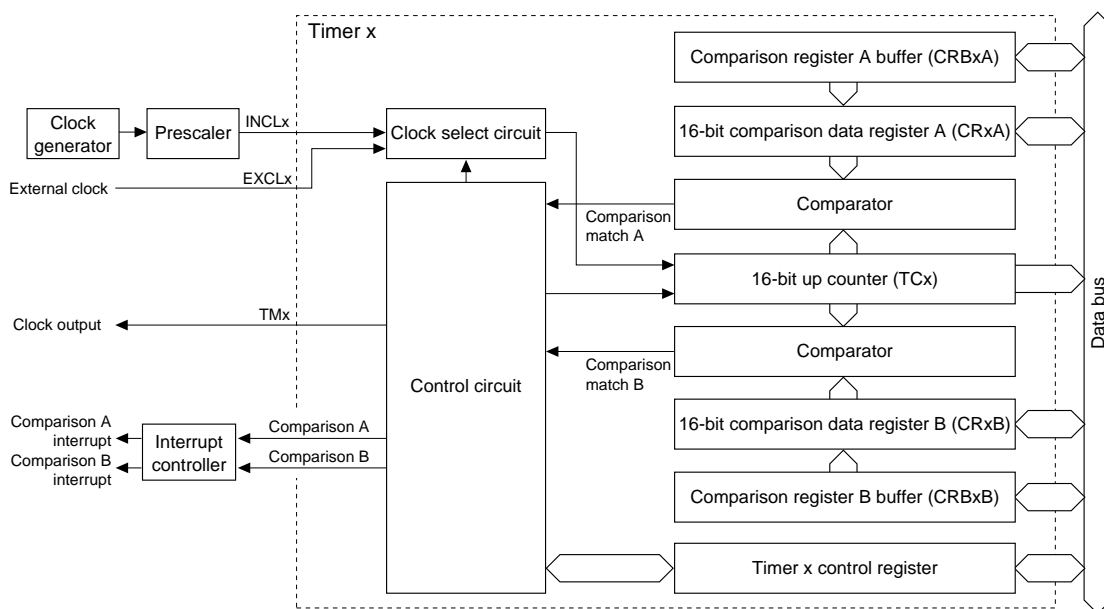


Figure III-4.1 Structure of 16-Bit Programmable Timer

In each timer, a 16-bit up-counter (TCx), as well as two 16-bit comparison data registers (CRxA, CRxB) and their buffers (CRBxA, CRBxB), are provided.

The 16-bit counter can be reset to "0" by software and counts up using the prescaler output clock or an external signal input from the I/O port. The counter value can be read by software.

The comparison data registers A and B are used to store the data to be compared with the content of the up-counter. This register can be directly read and written. Furthermore, comparison data can be set via the comparison register buffer. In this case, the set value is loaded to the comparison data register when the counter is reset by the comparison match B signal or software (by writing "1" to PRESETx bit). The software can select whether comparison data is written to the comparison data register or the buffer.

When the counter value matches to the content of each comparison data register, the comparator outputs a signal that controls the interrupt and the output signal. Thus the registers allow interrupt generating intervals and the timer's output clock frequency and duty ratio to be programmed.

I/O Pins of 16-Bit Programmable Timers

Table III-4.1 shows the input/output pins used for the 16-bit programmable timers.

Table III-4.1 I/O Pins of 16-Bit Programmable Timer

Pin name	I/O	Function	Function select bit
P10/EXCL0/ T8UF0/DST0	I/O	I/O port / 16-bit timer 0 event counter input (I) / 8-bit timer 0 output (O) / DST0 output (Ex)	CFP10(D0)/P1 function select register(0x402D4) CFEX1(D1)/Port function extension register(0x402DF)
P11/EXCL1/ T8UF1/DST1	I/O	I/O port / 16-bit timer 1 event counter input (I) / 8-bit timer 1 output (O) / DST1 output (Ex)	CFP11(D1)/P1 function select register(0x402D4) CFEX1(D1)/Port function extension register(0x402DF)
P12/EXCL2/ T8UF2/DST2	I/O	I/O port / 16-bit timer 2 event counter input (I) / 8-bit timer 2 output (O) / DST2 output (Ex)	CFP12(D2)/P1 function select register(0x402D4) CFEX0(D0)/Port function extension register(0x402DF)
P13/EXCL3/ T8UF3/DPCO	I/O	I/O port / 16-bit timer 3 event counter input (I) / 8-bit timer 3 output (O) / DPCO output (Ex)	CFP13(D3)/P1 function select register(0x402D4) CFEX1(D1)/Port function extension register(0x402DF)
P15/EXCL4 /#DMAEND0	I/O	I/O port / 16-bit timer 4 event counter input (I) / High-speed DMA Ch.0 end signal output (O)	CFP15(D5)/P1 function select register(0x402D4)
P16/EXCL5 /#DMAEND1	I/O	I/O port / 16-bit timer 5 event counter input (I) / High-speed DMA Ch.1 end signal output (O)	CFP16(D6)/P1 function select register(0x402D4)
P22/TM0	I/O	I/O port / 16-bit timer 0 output	CFP22(D2)/P2 function select register(0x402D8)
P23/TM1	I/O	I/O port / 16-bit timer 1 output	CFP23(D3)/P2 function select register(0x402D8)
P24/TM2	I/O	I/O port / 16-bit timer 2 output	CFP24(D4)/P2 function select register(0x402D8)
P25/TM3	I/O	I/O port / 16-bit timer 3 output	CFP25(D5)/P2 function select register(0x402D8)
P26/TM4	I/O	I/O port / 16-bit timer 4 output	CFP26(D6)/P2 function select register(0x402D8)
P27/TM5	I/O	I/O port / 16-bit timer 5 output	CFP27(D7)/P2 function select register(0x402D8)

(I): Input mode, (O): Output mode, (Ex): Extended function

TMx (output pin of the 16-bit programmable timer)

This pin outputs a clock generated by the timer x.

EXCLx (event counter input pin)

When using the timer x as an event counter, input count pulses from an external source to this pin.

How to set the input/output pins of 16-bit programmable timers

All clock output pins used by the 16-bit programmable timers are shared with I/O ports. At cold start, all these pins are set for the I/O port pins P2x (function select bit CFP2x = "0"), and go into high-impedance. When using the clock output function of the 16-bit programmable timer, select the desired timer and write "1" to the function select bit CFP2x for the corresponding pin. At hot start, these pins retain their status before from prior to the reset.

All event-counter input pins are also shared with I/O-ports. At cold start, the EXCL[3:0] pins are set for debug signal output pins (function extension bit CFEX[1:0] = "1") and the EXCL[5:4] pins are set for I/O-port pins P1[5:4] (function select bit CFP1[5:4] = "0"). When using the event counter function, select the desired timer and write "1" to the function select bit CFP1x and write "0" to the function select bit CFEXx for the corresponding pin.

Note that these pins are also shared with output pins for the 8-bit programmer timers, etc. When the input/output pins are set in input mode, they function as event counter inputs. Therefore, it is necessary to set the I/O port's I/O control bit IOC1x to "0" in advance. At cold start, these pins are set in input mode. At hot start, they retain their status from prior to the reset.

Uses of 16-Bit Programmable Timers

The up-counters of the 16-bit programmable timer cyclically output a comparison-match signal in accordance with the comparison data that are set in the software. This signal is used to generate an interrupt request to the CPU or control the internal peripheral circuits. A clock generated from the signal can also be output to external devices.

CPU interrupt request/IDMA invocation request

Each timer's comparison match (matching of counter and comparison data) can be used as an interrupt factor to generate an interrupt request to the CPU. Therefore, an interrupt can be generated at an interval that is set in the software.

Furthermore, this interrupt factor can also be used to invoke IDMA or HSDMA.

Clock output to external devices

A clock generated from the comparison-match signal can be output from the chip to the outside. The clock cycle is determined by comparison data B, and the duty ratio is determined by comparison data A. This output can be used to control external devices. The output pins of each timer are described in the preceding section.

A/D converter start trigger

The A/D converter allows a trigger to start the A/D conversion to be selected from among four available types. One is the comparison-match B of the 16-bit programmable timer 0. This makes it possible to perform the A/D conversion at programmable intervals.

To use this function, write "01" to the A/D converter control TS[1:0] (D[4:3]) / A/D trigger register (0x40242) to select the 16-bit programmable timer 0 as the trigger.

Watchdog timer

The 16-bit programmable timer 0 can be used as a watchdog timer to monitor CPU crash. In this case, the comparison-match B of this timer serves as an NMI request signal to the CPU.

To use this function, write "1" to the watchdog timer control bit EWD (D1) / Watchdog timer enable register (0x40171) to enable the NMI. For details on how to control the watchdog timer, refer to "Watchdog Timer".

Control and Operation of 16-Bit Programmable Timer

The following settings must first be made before the 16-bit programmable timer starts counting:

1. Setting pins for input/output (only when necessary)
2. Setting input clock
3. Selecting comparison data register/buffer
4. Setting clock output conditions (signal active level, fine mode)
5. Setting comparison data
6. Setting interrupt/IDMA

For details on how to set clock output conditions and interrupts and DMA, refer to "Controlling Clock Output" and "16-Bit Programmable Timer Interrupts and DMA".

Setting pin for input/output

The pin must be set for output for the output clock of the 16-bit programmable timer to be fed to external devices.

The pin for input must be set for the 16-bit programmable timer to be used as an event counter that counts external clock pulses.

For details on how to set the pin, refer to "I/O Pins of 16-Bit Programmable Timers".

Setting the input clock

The count clock for each timer can be selected from between an internal clock and an external clock. Use the following control bits to select the input clock:

Timer 0 input clock selection: CKSL0 (D3) / 16-bit timer 0 control register (0x48186)

Timer 1 input clock selection: CKSL1 (D3) / 16-bit timer 1 control register (0x4818E)

Timer 2 input clock selection: CKSL2 (D3) / 16-bit timer 2 control register (0x48196)

Timer 3 input clock selection: CKSL3 (D3) / 16-bit timer 3 control register (0x4819E)

Timer 4 input clock selection: CKSL4 (D3) / 16-bit timer 4 control register (0x481A6)

Timer 5 input clock selection: CKSL5 (D3) / 16-bit timer 5 control register (0x481AE)

An external clock is selected by writing "1" to CKSLx, and the internal clock is selected by writing "0".

At initial reset, CKSLx is set for the internal clock.

An external clock can be used for the timer for which the pin is set for input.

• Internal clock

When the internal clock is selected as a timer, the timer is operated by the prescaler output clock. The prescaler division ratio can be selected for each timer.

Table III-4.2 Setting the Internal Clock

Timer	Control register	Division ratio select bit	Clock control bit
Timer 0	16-bit timer 0 clock control register (0x40147)	P16TS0[2:0] (D2:0)	P16TON0 (D3)
Timer 1	16-bit timer 1 clock control register (0x40148)	P16TS1[2:0] (D2:0)	P16TON1 (D3)
Timer 2	16-bit timer 2 clock control register (0x40149)	P16TS2[2:0] (D2:0)	P16TON2 (D3)
Timer 3	16-bit timer 3 clock control register (0x4014A)	P16TS3[2:0] (D2:0)	P16TON3 (D3)
Timer 4	16-bit timer 4 clock control register (0x4014B)	P16TS4[2:0] (D2:0)	P16TON4 (D3)
Timer 5	16-bit timer 5 clock control register (0x4014C)	P16TS5[2:0] (D2:0)	P16TON5 (D3)

The division ratio can be selected from among eight types as shown in Table III-4.3.

Table III-4.3 Input Clock Selection

P16TS = 7	P16TS = 6	P16TS = 5	P16TS = 4	P16TS = 3	P16TS = 2	P16TS = 1	P16TS = 0
fPSCIN/4096	fPSCIN/1024	fPSCIN/256	fPSCIN/64	fPSCIN/16	fPSCIN/4	fPSCIN/2	fPSCIN/1

fPSCIN: Prescaler input clock frequency

The selected clock is output from the prescaler to the 16-bit programmable timer by writing "1" to P16TONx.

Notes: • When the internal clock is used, the 16-bit programmable timer operates only when the prescaler is operating (refer to "Prescaler").

- When setting an input clock, make sure the 16-bit programmable timer is turned off.

- **External clock**

When using the timer as an event counter by supplying clock pulses from an external source, make sure the event cycle is at least the CPU operating clock period.

Selecting comparison data register/buffer

The comparison data registers A and B are used to store the data to be compared with the content of the up-counter. This register can be directly read and written. Furthermore, comparison data can be set via the comparison register buffer. In this case, the set value is loaded to the comparison data register when the counter is reset by the comparison match B signal or software (by writing "1" to PRESETx bit).

Select whether comparison data is written to the comparison data register or the buffer using the following control bits:

Timer 0 comparison register buffer enable: SELCRB0 (D5) / 16-bit timer 0 control register (0x48186)

Timer 1 comparison register buffer enable: SELCRB1 (D5) / 16-bit timer 1 control register (0x4818E)

Timer 2 comparison register buffer enable: SELCRB2 (D5) / 16-bit timer 2 control register (0x48196)

Timer 3 comparison register buffer enable: SELCRB3 (D5) / 16-bit timer 3 control register (0x4819E)

Timer 4 comparison register buffer enable: SELCRB4 (D5) / 16-bit timer 4 control register (0x481A6)

Timer 5 comparison register buffer enable: SELCRB5 (D5) / 16-bit timer 5 control register (0x481AE)

When "1" is written to SELCRBx, the comparison register buffer is selected and when "0" is written, the comparison data register is selected.

At initial reset, the comparison data register is selected.

Setting comparison data

The programmable timer contains two data comparators that allows the count data to be compared with given values. The following registers are used to set these values.

Timer 0 comparison data A: CR0A[15:0] (D[F:0]) / 16-bit timer 0 comparison data A set-up register (0x48180)

Timer 0 comparison data B: CR0B[15:0] (D[F:0]) / 16-bit timer 0 comparison data B set-up register (0x48182)

Timer 1 comparison data A: CR1A[15:0] (D[F:0]) / 16-bit timer 1 comparison data A set-up register (0x48188)

Timer 1 comparison data B: CR1B[15:0] (D[F:0]) / 16-bit timer 1 comparison data B set-up register (0x4818A)

Timer 2 comparison data A: CR2A[15:0] (D[F:0]) / 16-bit timer 2 comparison data A set-up register (0x48190)

Timer 2 comparison data B: CR2B[15:0] (D[F:0]) / 16-bit timer 2 comparison data B set-up register (0x48192)

Timer 3 comparison data A: CR3A[15:0] (D[F:0]) / 16-bit timer 3 comparison data A set-up register (0x48198)

Timer 3 comparison data B: CR3B[15:0] (D[F:0]) / 16-bit timer 3 comparison data B set-up register (0x4819A)

Timer 4 comparison data A: CR4A[15:0] (D[F:0]) / 16-bit timer 4 comparison data A set-up register (0x481A0)

Timer 4 comparison data B: CR4B[15:0] (D[F:0]) / 16-bit timer 4 comparison data B set-up register (0x481A2)

Timer 5 comparison data A: CR5A[15:0] (D[F:0]) / 16-bit timer 5 comparison data A set-up register (0x481A8)

Timer 5 comparison data B: CR5B[15:0] (D[F:0]) / 16-bit timer 5 comparison data B set-up register (0x481AA)

When SELCRBx is set to "0", these registers allow direct reading/writing from/to the comparison data register.

When SELCRBx is set to "1", these registers are used to read/write from/to the comparison register buffer. The content of the buffer is loaded to the comparison data register when the counter is reset.

At initial reset, the comparison data registers/buffers are not initialized.

The programmable timer compares the comparison data register and count data and, when the two values are equal, generates a comparison match signal. This comparison match signal controls the clock output (TMx signal) to external devices, in addition to generating an interrupt.

The comparison data B is also used to reset the counter.

Resetting the counter

Each timer includes the PRESETx bit to reset the counter.

- Timer 0 reset: PRESET0 (D1) / 16-bit timer 0 control register (0x48186)
- Timer 1 reset: PRESET1 (D1) / 16-bit timer 1 control register (0x4818E)
- Timer 2 reset: PRESET2 (D1) / 16-bit timer 2 control register (0x48196)
- Timer 3 reset: PRESET3 (D1) / 16-bit timer 3 control register (0x4819E)
- Timer 4 reset: PRESET4 (D1) / 16-bit timer 4 control register (0x481A6)
- Timer 5 reset: PRESET5 (D1) / 16-bit timer 5 control register (0x481AE)

Normally, reset the counter before starting count-up by writing "1" to this control bit. After the counter starts counting, it will be reset by comparison match B.

Timer RUN/STOP control

Each timer includes the PRUNx bit to control RUN/STOP.

- Timer 0 RUN/STOP control: PRUN0 (D0) / 16-bit timer 0 control register (0x48186)
- Timer 1 RUN/STOP control: PRUN1 (D0) / 16-bit timer 1 control register (0x4818E)
- Timer 2 RUN/STOP control: PRUN2 (D0) / 16-bit timer 2 control register (0x48196)
- Timer 3 RUN/STOP control: PRUN3 (D0) / 16-bit timer 3 control register (0x4819E)
- Timer 4 RUN/STOP control: PRUN4 (D0) / 16-bit timer 4 control register (0x481A6)
- Timer 5 RUN/STOP control: PRUN5 (D0) / 16-bit timer 5 control register (0x481AE)

The timer starts counting when "1" is written to PRUNx. The clock input is disabled and the timer stops counting when "0" is written to PRUNx.

This RUN/STOP control does not affect the counter data. Even when the timer has stopped counting, the counter retains its count so that the timer can start counting again from that point.

If the count of the counter matches the set value of the comparison data register during count-up, the timer generates a comparison match interrupt.

When the counter matches comparison data B, an interrupt is generated and the counter is reset. At the same time, the values set in the compare register buffer are loaded to the compare data register if SELCRBx is set to "1".

The counter continues counting up regardless of which interrupt has occurred. In the case of a comparison B interrupt, the counter starts counting beginning with 0.

When both the timer RUN/STOP control bit (PRUNx) and the timer reset bit (PRESETx) are set to "1" at the same time, the timer starts counting after resetting the counter.

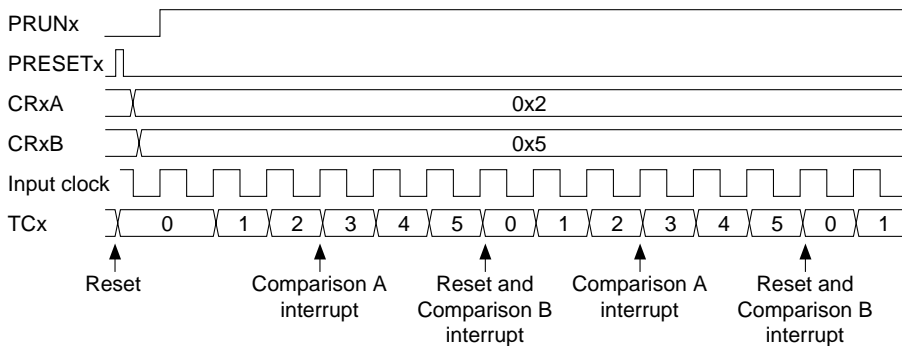


Figure III-4.2 Basic Operation Timing of Counter

Reading counter data

The counter data can be read out from the following addresses shown below at any time:

- Timer 0 counter data: TC0[15:0] (D[F:0]) / 16-bit timer 0 counter data register (0x48184)
- Timer 1 counter data: TC1[15:0] (D[F:0]) / 16-bit timer 1 counter data register (0x4818C)
- Timer 2 counter data: TC2[15:0] (D[F:0]) / 16-bit timer 0 counter data register (0x48194)
- Timer 3 counter data: TC3[15:0] (D[F:0]) / 16-bit timer 1 counter data register (0x4819C)
- Timer 4 counter data: TC4[15:0] (D[F:0]) / 16-bit timer 0 counter data register (0x481A4)
- Timer 5 counter data: TC5[15:0] (D[F:0]) / 16-bit timer 1 counter data register (0x481AC)

Controlling Clock Output

The timers can generate a TMx signal using the comparison match signals from the counter.

Setting the signal active level

By default, an active high signal (normal low) is generated. This logic can be inverted using the OUTINVx bit.

When "1" is written to the OUTINVx bit, the timer generates an active low (normal high) signal.

Timer 0 clock output inversion: OUTINV0 (D4) / 16-bit timer 0 control register (0x48186)

Timer 1 clock output inversion: OUTINV1 (D4) / 16-bit timer 1 control register (0x4818E)

Timer 2 clock output inversion: OUTINV2 (D4) / 16-bit timer 2 control register (0x48196)

Timer 3 clock output inversion: OUTINV3 (D4) / 16-bit timer 3 control register (0x4819E)

Timer 4 clock output inversion: OUTINV4 (D4) / 16-bit timer 4 control register (0x481A6)

Timer 5 clock output inversion: OUTINV5 (D4) / 16-bit timer 5 control register (0x481AE)

See Figure III-4.3 for the waveforms.

Setting the output port

The TMx signal generated here can be output from the clock output pins (see Table III-4.1), enabling a programmable clock to be supplied to external devices.

After a cold start, the output pins are set for the I/O ports and set in input mode. The pins go into high-impedance status.

When the pin function is switched to the timer output, the pin goes low if OUTINVx is set to "0" or goes high if OUTINVx is set to "1".

Starting clock output

To output the TMx clock, write "1" to the clock output control bit PTMx. Clock output is stopped by writing "0" to PTMx and goes to the off level according to the OUTINVx setting (low when OUTINVx = "0" or high when OUTINVx = "1").

Timer 0 clock output control: PTM0 (D2) / 16-bit timer 0 control register (0x48186)

Timer 1 clock output control: PTM1 (D2) / 16-bit timer 1 control register (0x4818E)

Timer 2 clock output control: PTM2 (D2) / 16-bit timer 2 control register (0x48196)

Timer 3 clock output control: PTM3 (D2) / 16-bit timer 3 control register (0x4819E)

Timer 4 clock output control: PTM4 (D2) / 16-bit timer 4 control register (0x481A6)

Timer 5 clock output control: PTM5 (D2) / 16-bit timer 5 control register (0x481AE)

Figure III-4.3 shows the waveform of the output signal.

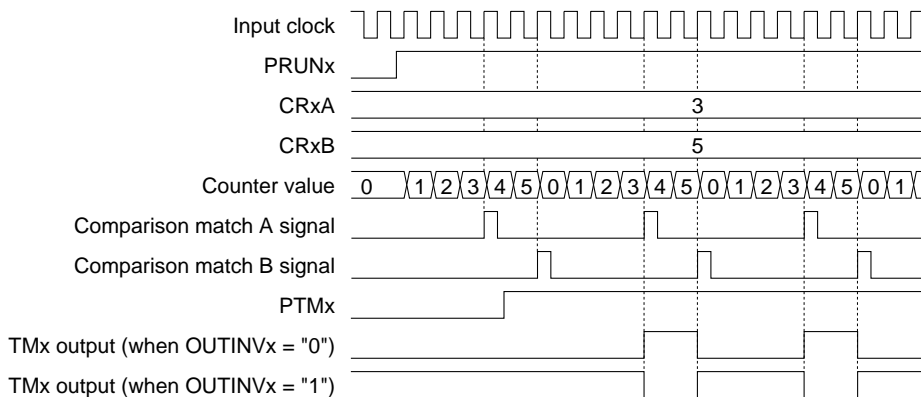


Figure III-4.3 Waveform of 16-Bit Programmable Timer Output

When OUTINVx = "0" (active high):

The timer outputs a low level until the counter becomes equal to the comparison data A set in the CRxA register. When the counter is incremented to the next value from the comparison data A, the output pin goes high and a comparison A interrupt occurs. When the counter becomes equal to the comparison data B set in the CRxB register, the counter is reset and the output pin goes low. At the same time a comparison B interrupt occurs.

When OUTINVx = "1" (active low):

The timer outputs a high level until the counter becomes equal to the comparison data A set in the CRxA register. When the counter is incremented to the next value from the comparison data A, the output pin goes low and a comparison A interrupt occurs. When the counter becomes equal to the comparison data B set in the CRxB register, the counter is reset and the output pin goes high. At the same time a comparison B interrupt occurs.

Setting clock output fine mode

By default (after an initial reset), the clock output signal changes at the rising edge of the input clock when CRxA[15:0] becomes equal to TCx[15:0].

In fine mode, the output signal changes according to CRxA[0] when CRxA[15:1] becomes equal to TCx[14:0].

When CRxA[0] is "0", the output signal changes at the rising edge of the input clock.

When CRxA[0] is "1", the output signal changes at the falling edge of the input clock a half cycle from the default setting.

Example) CRxA = 3, CRxB = 5

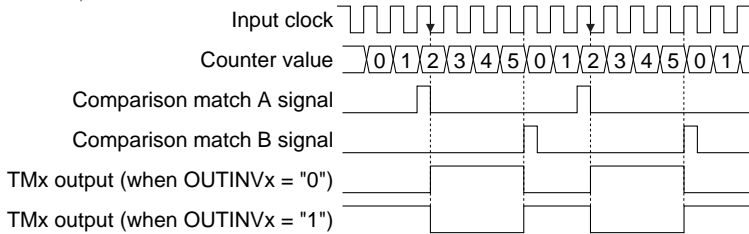


Figure III-4.4 Clock Output in Fine Mode

As shown in the figure above, in fine mode the output clock duty ratio can be adjusted in the half cycle of the input clock. However, when the CRxA value is "0", the timer outputs a pulse with a 1-cycle width as the input clock, the same as the default setting.

In fine mode, the maximum value of CRxB is $2^{15} - 1 = 32,767$ and the range of CRxA that can be set is 0 to $(2 \times CRxB - 1)$.

The fine mode is set by the following registers:

Timer 0 fine mode selection: SELFM0 (D6) / 16-bit timer 0 control register (0x48186)

Timer 1 fine mode selection: SELFM1 (D6) / 16-bit timer 1 control register (0x4818E)

Timer 2 fine mode selection: SELFM2 (D6) / 16-bit timer 2 control register (0x48196)

Timer 3 fine mode selection: SELFM3 (D6) / 16-bit timer 3 control register (0x4819E)

Timer 4 fine mode selection: SELFM4 (D6) / 16-bit timer 4 control register (0x481A6)

Timer 5 fine mode selection: SELFM5 (D6) / 16-bit timer 5 control register (0x481AE)

When "1" is written to the SELFMx bit, fine mode is set. At initial reset, the fine mode is disabled.

Precautions

- 1) If a same value is set to the comparison data A and B registers, a hazard may be generated in the output signal. Therefore, do not set the comparison registers as A = B.
There is no problem when the interrupt function only is used.
- 2) When using the output clock, set the comparison data registers as $A \geq 0$ and $B \geq 1$. The minimum settings are A = 0 and B = 1. In this case, the timer output clock cycle is the input clock $\times 1/2$.

- 3) When the comparison data registers are set as $A > B$, no comparison A signal is generated. In this case, the output signal is fixed at the off level.

16-Bit Programmable Timer Interrupts and DMA

The 16-bit programmable timer has a function for generating an interrupt using the comparison match A and B states.

The timing at which an interrupt is generated is shown in Figure III-4.2 in the preceding section.

Control registers of the interrupt controller

Table III-4.4 shows the control registers of the interrupt controller provided for each timer.

Table III-4.4 Control Registers of Interrupt Controller

Interrupt factor	Interrupt factor flag	Interrupt enable register	Interrupt priority register
Timer 0 comparison A	F16TC0 (D3/0x40282)	E16TC0 (D3/0x40272)	P16T0[2:0] (D[2:0]/0x40266)
Timer 0 comparison B	F16TU0 (D2/0x40282)	E16TU0 (D2/0x40272)	
Timer 1 comparison A	F16TC1 (D7/0x40282)	E16TC1 (D7/0x40272)	P16T1[2:0] (D[6:4]/0x40266)
Timer 1 comparison B	F16TU1 (D6/0x40282)	E16TU1 (D6/0x40272)	
Timer 2 comparison A	F16TC2 (D3/0x40283)	E16TC2 (D3/0x40273)	P16T2[2:0] (D[2:0]/0x40267)
Timer 2 comparison B	F16TU2 (D2/0x40283)	E16TU2 (D2/0x40273)	
Timer 3 comparison A	F16TC3 (D7/0x40283)	E16TC3 (D7/0x40273)	P16T3[2:0] (D[6:4]/0x40267)
Timer 3 comparison B	F16TU3 (D6/0x40283)	E16TU3 (D6/0x40273)	
Timer 4 comparison A	F16TC4 (D3/0x40284)	E16TC4 (D3/0x40274)	P16T4[2:0] (D[2:0]/0x40268)
Timer 4 comparison B	F16TU4 (D2/0x40284)	E16TU4 (D2/0x40274)	
Timer 5 comparison A	F16TC5 (D7/0x40284)	E16TC5 (D7/0x40274)	P16T5[2:0] (D[6:4]/0x40268)
Timer 5 comparison B	F16TU5 (D6/0x40284)	E16TU5 (D6/0x40274)	

When a comparison match state occurs in the timer, the corresponding interrupt factor flag is set to "1".

If the interrupt enable register bit corresponding to that interrupt factor flag has been set to "1", an interrupt request is generated.

An interrupt caused by a timer can be disabled by leaving the interrupt enable register bit for that timer set to "0". The interrupt factor flag is always set to "1" by the timer's comparison match state, regardless of how the interrupt enable register is set (even when set to "0").

The interrupt priority register sets an interrupt priority level (0 to 7) for each timer. Priorities within a timer block are such that timers of smaller numbers have a higher priority. Priorities between interrupt types are such that the comparison B interrupt has priority over the comparison A interrupt. An interrupt request to the CPU is accepted only when no other interrupt request of a higher priority has been generated.

It is only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the timer interrupt level set by the interrupt priority register, that a timer interrupt request is actually accepted by the CPU.

For details on these interrupt control registers, as well as the device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

Intelligent DMA

The interrupt factor of each timer can also invoke intelligent DMA (IDMA). This allows memory-to-memory DMA transfers to be performed cyclically.

The following shows the IDMA channel numbers set for each interrupt factor of timer:

	IDMA Ch.		IDMA Ch.
Timer 0 comparison B:	0x07	Timer 0 comparison A:	0x08
Timer 1 comparison B:	0x09	Timer 1 comparison A:	0x0A
Timer 2 comparison B:	0x0B	Timer 2 comparison A:	0x0C
Timer 3 comparison B:	0x0D	Timer 3 comparison A:	0x0E
Timer 4 comparison B:	0x0F	Timer 4 comparison A:	0x10
Timer 5 comparison B:	0x11	Timer 5 comparison A:	0x12

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For IDMA to be invoked, the IDMA request and IDMA enable bits shown in Table III-4.5 must be set to "1" in advance. Transfer conditions, etc. must also be set on the IDMA side in advance.

Table III-4.5 Control Bits for IDMA Transfer

Interrupt factor	IDMA request bit	IDMA enable bit
Timer 0 comparison A	R16TC0(D7/0x40290)	DE16TC0(D7/0x40294)
Timer 0 comparison B	R16TU0(D6/0x40290)	DE16TU0(D6/0x40294)
Timer 1 comparison A	R16TC1(D1/0x40291)	DE16TC1(D1/0x40295)
Timer 1 comparison B	R16TU1(D0/0x40291)	DE16TU1(D0/0x40295)
Timer 2 comparison A	R16TC2(D3/0x40291)	DE16TC2(D3/0x40295)
Timer 2 comparison B	R16TU2(D2/0x40291)	DE16TU2(D2/0x40295)
Timer 3 comparison A	R16TC3(D5/0x40291)	DE16TC3(D5/0x40295)
Timer 3 comparison B	R16TU3(D4/0x40291)	DE16TU3(D4/0x40295)
Timer 4 comparison A	R16TC4(D7/0x40291)	DE16TC4(D7/0x40295)
Timer 4 comparison B	R16TU4(D6/0x40291)	DE16TU4(D6/0x40295)
Timer 5 comparison A	R16TC5(D1/0x40292)	DE16TC5(D1/0x40296)
Timer 5 comparison B	R16TU5(D0/0x40292)	DE16TU5(D0/0x40296)

If the IDMA request and enable bits are set to "1", IDMA is invoked through generation of an interrupt factor. No interrupt request is generated at that point. An interrupt request is generated after the DMA transfer is completed. The registers can also be set so as not to generate an interrupt, with only a DMA transfer performed.

For details on IDMA transfers and interrupt control upon completion of IDMA transfer, refer to "IDMA (Intelligent DMA)".

High-speed DMA

The interrupt factor of each timer can also invoke high-speed DMA (HSDMA).

The following shows the HSDMA channel number and trigger set-up bit corresponding to each timer:

Table III-4.6 HSDMA Trigger Set-up Bits

Interrupt factor	HSDMA Ch.	Trigger set-up bits
Timer 0 comparison A	0	HSD0S[3:0] (D[3:0]) / HSDMA Ch.0/1 trigger set-up register (0x40298) = "0111"
Timer 0 comparison B	0	HSD0S[3:0] (D[3:0]) / HSDMA Ch.0/1 trigger set-up register (0x40298) = "0110"
Timer 1 comparison A	1	HSD1S[3:0] (D[7:4]) / HSDMA Ch.0/1 trigger set-up register (0x40298) = "0111"
Timer 1 comparison B	1	HSD1S[3:0] (D[7:4]) / HSDMA Ch.0/1 trigger set-up register (0x40298) = "0110"
Timer 2 comparison A	2	HSD2S[3:0] (D[3:0]) / HSDMA Ch.2/3 trigger set-up register (0x40299) = "0111"
Timer 2 comparison B	2	HSD2S[3:0] (D[3:0]) / HSDMA Ch.2/3 trigger set-up register (0x40299) = "0110"
Timer 3 comparison A	3	HSD3S[3:0] (D[7:4]) / HSDMA Ch.2/3 trigger set-up register (0x40299) = "0111"
Timer 3 comparison B	3	HSD3S[3:0] (D[7:4]) / HSDMA Ch.2/3 trigger set-up register (0x40299) = "0110"
Timer 4 comparison A	0	HSD0S[3:0] (D[3:0]) / HSDMA Ch.0/1 trigger set-up register (0x40298) = "1001"
	2	HSD2S[3:0] (D[3:0]) / HSDMA Ch.2/3 trigger set-up register (0x40299) = "1001"
Timer 4 comparison B	0	HSD0S[3:0] (D[3:0]) / HSDMA Ch.0/1 trigger set-up register (0x40298) = "1000"
	2	HSD2S[3:0] (D[3:0]) / HSDMA Ch.2/3 trigger set-up register (0x40299) = "1000"
Timer 5 comparison A	1	HSD1S[3:0] (D[7:4]) / HSDMA Ch.0/1 trigger set-up register (0x40298) = "1001"
	3	HSD3S[3:0] (D[7:4]) / HSDMA Ch.2/3 trigger set-up register (0x40299) = "1001"
Timer 5 comparison B	1	HSD1S[3:0] (D[7:4]) / HSDMA Ch.0/1 trigger set-up register (0x40298) = "1000"
	3	HSD3S[3:0] (D[7:4]) / HSDMA Ch.2/3 trigger set-up register (0x40299) = "1000"

For HSDMA to be invoked, a 16-bit timer interrupt factor should be selected using the trigger set-up bits in advance. Transfer conditions, etc. must also be set on the HSDMA side.

If a 16-bit timer is selected as the HSDMA trigger, the HSDMA channel is invoked through generation of the interrupt factor.

For details on HSDMA transfer, refer to "HSDMA (High-Speed DMA)".

Trap vectors

The trap vector addresses for each default interrupt factor are set as shown below:

	(BTA3 = high)	(BTA3 = low)
Timer 0 comparison B:	0x0080078	0x0C00078
Timer 0 comparison A:	0x008007C	0x0C0007C
Timer 1 comparison B:	0x0080088	0x0C00088
Timer 1 comparison A:	0x008008C	0x0C0008C
Timer 2 comparison B:	0x0080098	0x0C00098
Timer 2 comparison A:	0x008009C	0x0C0009C
Timer 3 comparison B:	0x00800A8	0x0C000A8
Timer 3 comparison A:	0x00800AC	0x0C000AC
Timer 4 comparison B:	0x00800B8	0x0C000B8
Timer 4 comparison A:	0x00800BC	0x0C000BC
Timer 5 comparison B:	0x00800C8	0x0C000C8
Timer 5 comparison A:	0x00800CC	0x0C000CC

The base address of the trap table can be changed using the TTBR register (0x48134 to 0x48137).

I/O Memory of 16-Bit Programmable Timers

Table III-4.7 shows the control bits of the 16-bit programmable timers.

For details on the I/O memory of the prescaler used to set a clock, refer to "Prescaler".

Table III-4.7 Control Bits of 16-Bit Programmable Timer

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
16-bit timer 0/1 interrupt priority register	0040266 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T12	16-bit timer 1 interrupt level	0 to 7	X	R/W		
		D5	P16T11			X			
		D4	P16T10			X			
		D3	–	reserved	–	–	–	0 when being read.	
		D2	P16T02	16-bit timer 0 interrupt level	0 to 7	X	R/W		
		D1	P16T01			X			
D0	P16T00	X							
D7	–	reserved	–			–	–		0 when being read.
16-bit timer 2/3 interrupt priority register	0040267 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T32	16-bit timer 3 interrupt level	0 to 7	X	R/W		
		D5	P16T31			X			
		D4	P16T30			X			
		D3	–	reserved	–	–	–	0 when being read.	
		D2	P16T22	16-bit timer 2 interrupt level	0 to 7	X	R/W		
		D1	P16T21			X			
D0	P16T20	X							
D7	–	reserved	–			–	–		0 when being read.
16-bit timer 4/5 interrupt priority register	0040268 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T52	16-bit timer 5 interrupt level	0 to 7	X	R/W		
		D5	P16T51			X			
		D4	P16T50			X			
		D3	–	reserved	–	–	–	0 when being read.	
		D2	P16T42	16-bit timer 4 interrupt level	0 to 7	X	R/W		
		D1	P16T41			X			
D0	P16T40	X							
D7	–	reserved	–			–	–		0 when being read.
16-bit timer 0/1 interrupt enable register	0040272 (B)	D7	E16TC1	16-bit timer 1 comparison A	1 Enabled	0 Disabled	0	R/W	
		D6	E16TU1				16-bit timer 1 comparison B	0	
		D5–4	–	reserved	–	–			–
		D3	E16TC0	16-bit timer 0 comparison A	1 Enabled	0 Disabled	0	R/W	
		D2	E16TU0				16-bit timer 0 comparison B	0	
		D1–0	–	reserved	–	–			–
		16-bit timer 2/3 interrupt enable register	0040273 (B)	D7	E16TC3	16-bit timer 3 comparison A	1 Enabled	0 Disabled	0
D6	E16TU3			16-bit timer 3 comparison B	0				R/W
D5–4	–					reserved	–	–	
D3	E16TC2			16-bit timer 2 comparison A	1 Enabled	0 Disabled	0	R/W	
D2	E16TU2						16-bit timer 2 comparison B	0	
D1–0	–			reserved	–	–			–
16-bit timer 4/5 interrupt enable register	0040274 (B)			D7	E16TC5	16-bit timer 5 comparison A	1 Enabled	0 Disabled	0
		D6	E16TU5	16-bit timer 5 comparison B	0				R/W
		D5–4	–			reserved	–	–	
		D3	E16TC4	16-bit timer 4 comparison A	1 Enabled	0 Disabled	0	R/W	
		D2	E16TU4				16-bit timer 4 comparison B	0	
		D1–0	–	reserved	–	–			–
		16-bit timer 0/1 interrupt factor flag register	0040282 (B)	D7	F16TC1	16-bit timer 1 comparison A	1 Factor is generated	0 No factor is generated	X
D6	F16TU1			16-bit timer 1 comparison B	0				R/W
D5–4	–					reserved	–	–	
D3	F16TC0			16-bit timer 0 comparison A	1 Factor is generated	0 No factor is generated	X	R/W	
D2	F16TU0						16-bit timer 0 comparison B	0	
D1–0	–			reserved	–	–			–
16-bit timer 2/3 interrupt factor flag register	0040283 (B)			D7	F16TC3	16-bit timer 3 comparison A	1 Factor is generated	0 No factor is generated	X
		D6	F16TU3	16-bit timer 3 comparison B	0				R/W
		D5–4	–			reserved	–	–	
		D3	F16TC2	16-bit timer 2 comparison A	1 Factor is generated	0 No factor is generated	X	R/W	
		D2	F16TU2				16-bit timer 2 comparison B	0	
		D1–0	–	reserved	–	–			–
		16-bit timer 4/5 interrupt factor flag register	0040284 (B)	D7	F16TC5	16-bit timer 5 comparison A	1 Factor is generated	0 No factor is generated	X
D6	F16TU5			16-bit timer 5 comparison B	0				R/W
D5–4	–					reserved	–	–	
D3	F16TC4			16-bit timer 4 comparison A	1 Factor is generated	0 No factor is generated	X	R/W	
D2	F16TU4						16-bit timer 4 comparison B	0	
D1–0	–			reserved	–	–			–

III PERIPHERAL BLOCK: 16-BIT PROGRAMMABLE TIMERS

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA request register	0040290 (B)	D7	R16TC0	16-bit timer 0 comparison A	1	IDMA request	0	Interrupt request	0	R/W	
		D6	R16TU0	16-bit timer 0 comparison B					0	R/W	
		D5	RHDM1	High-speed DMA Ch.1					0	R/W	
		D4	RHDM0	High-speed DMA Ch.0					0	R/W	
		D3	RP3	Port input 3					0	R/W	
		D2	RP2	Port input 2					0	R/W	
		D1	RP1	Port input 1					0	R/W	
		D0	RP0	Port input 0					0	R/W	
16-bit timer 1–4 IDMA request register	0040291 (B)	D7	R16TC4	16-bit timer 4 comparison A	1	IDMA request	0	Interrupt request	0	R/W	
		D6	R16TU4	16-bit timer 4 comparison B					0	R/W	
		D5	R16TC3	16-bit timer 3 comparison A					0	R/W	
		D4	R16TU3	16-bit timer 3 comparison B					0	R/W	
		D3	R16TC2	16-bit timer 2 comparison A					0	R/W	
		D2	R16TU2	16-bit timer 2 comparison B					0	R/W	
		D1	R16TC1	16-bit timer 1 comparison A					0	R/W	
		D0	R16TU1	16-bit timer 1 comparison B					0	R/W	
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register	0040292 (B)	D7	RSTX0	SIF Ch.0 transmit buffer empty	1	IDMA request	0	Interrupt request	0	R/W	
		D6	RSRX0	SIF Ch.0 receive buffer full					0	R/W	
		D5	R8TU3	8-bit timer 3 underflow					0	R/W	
		D4	R8TU2	8-bit timer 2 underflow					0	R/W	
		D3	R8TU1	8-bit timer 1 underflow					0	R/W	
		D2	R8TU0	8-bit timer 0 underflow					0	R/W	
		D1	R16TC5	16-bit timer 5 comparison A					0	R/W	
		D0	R16TU5	16-bit timer 5 comparison B					0	R/W	
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA enable register	0040294 (B)	D7	DE16TC0	16-bit timer 0 comparison A	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D6	DE16TU0	16-bit timer 0 comparison B					0	R/W	
		D5	DEHDM1	High-speed DMA Ch.1					0	R/W	
		D4	DEHDM0	High-speed DMA Ch.0					0	R/W	
		D3	DEP3	Port input 3					0	R/W	
		D2	DEP2	Port input 2					0	R/W	
		D1	DEP1	Port input 1					0	R/W	
		D0	DEP0	Port input 0					0	R/W	
16-bit timer 1–4 IDMA enable register	0040295 (B)	D7	DE16TC4	16-bit timer 4 comparison A	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D6	DE16TU4	16-bit timer 4 comparison B					0	R/W	
		D5	DE16TC3	16-bit timer 3 comparison A					0	R/W	
		D4	DE16TU3	16-bit timer 3 comparison B					0	R/W	
		D3	DE16TC2	16-bit timer 2 comparison A					0	R/W	
		D2	DE16TU2	16-bit timer 2 comparison B					0	R/W	
		D1	DE16TC1	16-bit timer 1 comparison A					0	R/W	
		D0	DE16TU1	16-bit timer 1 comparison B					0	R/W	
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register	0040296 (B)	D7	DESTX0	SIF Ch.0 transmit buffer empty	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D6	DESRX0	SIF Ch.0 receive buffer full					0	R/W	
		D5	DE8TU3	8-bit timer 3 underflow					0	R/W	
		D4	DE8TU2	8-bit timer 2 underflow					0	R/W	
		D3	DE8TU1	8-bit timer 1 underflow					0	R/W	
		D2	DE8TU0	8-bit timer 0 underflow					0	R/W	
		D1	DE16TC5	16-bit timer 5 comparison A					0	R/W	
		D0	DE16TU5	16-bit timer 5 comparison B					0	R/W	
P1 function select register	00402D4 (B)	D7	–	reserved	–	–	–	–	–	0 when being read.	
		D6	CFP16	P16 function selection	1	EXCL5 #DMAEND1	0	P16	0	R/W	Extended functions (0x402DF)
		D5	CFP15	P15 function selection	1	EXCL4 #DMAEND0	0	P15	0	R/W	
		D4	CFP14	P14 function selection	1	FOSC1	0	P14	0	R/W	
		D3	CFP13	P13 function selection	1	EXCL3 T8UF3	0	P13	0	R/W	
		D2	CFP12	P12 function selection	1	EXCL2 T8UF2	0	P12	0	R/W	
		D1	CFP11	P11 function selection	1	EXCL1 T8UF1	0	P11	0	R/W	
D0	CFP10	P10 function selection	1	EXCL0 T8UF0	0	P10	0	R/W			
P2 function select register	00402D8 (B)	D7	CFP27	P27 function selection	1	TM5	0	P27	0	R/W	
		D6	CFP26	P26 function selection	1	TM4	0	P26	0	R/W	
		D5	CFP25	P25 function selection	1	TM3	0	P25	0	R/W	
		D4	CFP24	P24 function selection	1	TM2	0	P24	0	R/W	
		D3	CFP23	P23 function selection	1	TM1	0	P23	0	R/W	
		D2	CFP22	P22 function selection	1	TM0	0	P22	0	R/W	
		D1	CFP21	P21 function selection	1	#DWE	0	P21	0	R/W	
		D0	CFP20	P20 function selection	1	#DRD	0	P20	0	R/W	

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Port function extension register	00402DF (B)	D7	CFEX7	P07 port extended function	1 #DMAEND3	0 P07, etc.	0	R/W	
		D6	CFEX6	P06 port extended function	1 #DMAACK3	0 P06, etc.	0	R/W	
		D5	CFEX5	P05 port extended function	1 #DMAEND2	0 P05, etc.	0	R/W	
		D4	CFEX4	P04 port extended function	1 #DMAACK2	0 P04, etc.	0	R/W	
		D3	CFEX3	P31 port extended function	1 #GARD	0 P31, etc.	0	R/W	
		D2	CFEX2	P21 port extended function	1 #GAAS	0 P21, etc.	0	R/W	
		D1	CFEX1	P10, P11, P13 port extended function	1 DST0 DST1 DPC0	0 P10, etc. P11, etc. P13, etc.	1	R/W	
		D0	CFEX0	P12, P14 port extended function	1 DST2 DCLK	0 P12, etc. P14, etc.	1	R/W	
16-bit timer 0 comparison data A set-up register	0048180 (HW)	DF	CR0A15	16-bit timer 0 comparison data A CR0A15 = MSB CR0A0 = LSB	0 to 65535		X	R/W	
		DE	CR0A14				X		
		DD	CR0A13				X		
		DC	CR0A12				X		
		DB	CR0A11				X		
		DA	CR0A10				X		
		D9	CR0A9				X		
		D8	CR0A8				X		
		D7	CR0A7				X		
		D6	CR0A6				X		
		D5	CR0A5				X		
		D4	CR0A4				X		
		D3	CR0A3				X		
		D2	CR0A2				X		
D1	CR0A1	X							
D0	CR0A0	X							
16-bit timer 0 comparison data B set-up register	0048182 (HW)	DF	CR0B15	16-bit timer 0 comparison data B CR0B15 = MSB CR0B0 = LSB	0 to 65535		X	R/W	
		DE	CR0B14				X		
		DD	CR0B13				X		
		DC	CR0B12				X		
		DB	CR0B11				X		
		DA	CR0B10				X		
		D9	CR0B9				X		
		D8	CR0B8				X		
		D7	CR0B7				X		
		D6	CR0B6				X		
		D5	CR0B5				X		
		D4	CR0B4				X		
		D3	CR0B3				X		
		D2	CR0B2				X		
D1	CR0B1	X							
D0	CR0B0	X							
16-bit timer 0 counter data register	0048184 (HW)	DF	TC015	16-bit timer 0 counter data TC015 = MSB TC00 = LSB	0 to 65535		X	R	
		DE	TC014				X		
		DD	TC013				X		
		DC	TC012				X		
		DB	TC011				X		
		DA	TC010				X		
		D9	TC09				X		
		D8	TC08				X		
		D7	TC07				X		
		D6	TC06				X		
		D5	TC05				X		
		D4	TC04				X		
		D3	TC03				X		
		D2	TC02				X		
D1	TC01	X							
D0	TC00	X							
16-bit timer 0 control register	0048186 (B)	D7	–	reserved	–		0	–	0 when being read.
		D6	SELFM0	16-bit timer 0 fine mode selection	1 Fine mode	0 Normal	0	R/W	
		D5	SELCRB0	16-bit timer 0 comparison buffer	1 Enabled	0 Disabled	0	R/W	
		D4	OUTINV0	16-bit timer 0 output inversion	1 Invert	0 Normal	0	R/W	
		D3	CKSL0	16-bit timer 0 input clock selection	1 External clock	0 Internal clock	0	R/W	
		D2	PTM0	16-bit timer 0 clock output control	1 On	0 Off	0	R/W	
		D1	PRESET0	16-bit timer 0 reset	1 Reset	0 Invalid	0	W	0 when being read.
		D0	PRUN0	16-bit timer 0 Run/Stop control	1 Run	0 Stop	0	R/W	

III PERIPHERAL BLOCK: 16-BIT PROGRAMMABLE TIMERS

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
16-bit timer 1 comparison data A set-up register	0048188 (HW)	DF	CR1A15	16-bit timer 1 comparison data A CR1A15 = MSB CR1A0 = LSB	0 to 65535	X	R/W		
		DE	CR1A14						
		DD	CR1A13						
		DC	CR1A12						
		DB	CR1A11						
		DA	CR1A10						
		D9	CR1A9						
		D8	CR1A8						
		D7	CR1A7						
		D6	CR1A6						
		D5	CR1A5						
		D4	CR1A4						
		D3	CR1A3						
		D2	CR1A2						
		D1	CR1A1						
		D0	CR1A0						
16-bit timer 1 comparison data B set-up register	004818A (HW)	DF	CR1B15	16-bit timer 1 comparison data B CR1B15 = MSB CR1B0 = LSB	0 to 65535	X	R/W		
		DE	CR1B14						
		DD	CR1B13						
		DC	CR1B12						
		DB	CR1B11						
		DA	CR1B10						
		D9	CR1B9						
		D8	CR1B8						
		D7	CR1B7						
		D6	CR1B6						
		D5	CR1B5						
		D4	CR1B4						
		D3	CR1B3						
		D2	CR1B2						
		D1	CR1B1						
		D0	CR1B0						
16-bit timer 1 counter data register	004818C (HW)	DF	TC115	16-bit timer 1 counter data TC115 = MSB TC10 = LSB	0 to 65535	X	R		
		DE	TC114						
		DD	TC113						
		DC	TC112						
		DB	TC111						
		DA	TC110						
		D9	TC19						
		D8	TC18						
		D7	TC17						
		D6	TC16						
		D5	TC15						
		D4	TC14						
		D3	TC13						
		D2	TC12						
		D1	TC11						
		D0	TC10						
16-bit timer 1 control register	004818E (B)	D7	–	reserved	–	0	–	0 when being read.	
		D6	SELF M1	16-bit timer 1 fine mode selection	1 Fine mode	0 Normal	0	R/W	
		D5	SEL CRB1	16-bit timer 1 comparison buffer	1 Enabled	0 Disabled	0	R/W	
		D4	OUT IN V1	16-bit timer 1 output inversion	1 Invert	0 Normal	0	R/W	
		D3	CK SL1	16-bit timer 1 input clock selection	1 External clock	0 Internal clock	0	R/W	
		D2	PT M1	16-bit timer 1 clock output control	1 On	0 Off	0	R/W	
		D1	PRE SET1	16-bit timer 1 reset	1 Reset	0 Invalid	0	W	0 when being read.
		D0	PR UN1	16-bit timer 1 Run/Stop control	1 Run	0 Stop	0	R/W	
16-bit timer 2 comparison data A set-up register	0048190 (HW)	DF	CR2A15	16-bit timer 2 comparison data A CR2A15 = MSB CR2A0 = LSB	0 to 65535	X	R/W		
		DE	CR2A14						
		DD	CR2A13						
		DC	CR2A12						
		DB	CR2A11						
		DA	CR2A10						
		D9	CR2A9						
		D8	CR2A8						
		D7	CR2A7						
		D6	CR2A6						
		D5	CR2A5						
		D4	CR2A4						
		D3	CR2A3						
		D2	CR2A2						
		D1	CR2A1						
		D0	CR2A0						

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
16-bit timer 2 comparison data B set-up register	0048192 (HW)	DF	CR2B15	16-bit timer 2 comparison data B CR2B15 = MSB CR2B0 = LSB	0 to 65535		X	R/W			
		DE	CR2B14								
		DD	CR2B13								
		DC	CR2B12								
		DB	CR2B11								
		DA	CR2B10								
		D9	CR2B9								
		D8	CR2B8								
		D7	CR2B7								
		D6	CR2B6								
		D5	CR2B5								
		D4	CR2B4								
		D3	CR2B3								
		D2	CR2B2								
		D1	CR2B1								
		D0	CR2B0								
		16-bit timer 2 counter data register	0048194 (HW)				DF			TC215	16-bit timer 2 counter data TC215 = MSB TC20 = LSB
DE	TC214										
DD	TC213										
DC	TC212										
DB	TC211										
DA	TC210										
D9	TC29										
D8	TC28										
D7	TC27										
D6	TC26										
D5	TC25										
D4	TC24										
D3	TC23										
D2	TC22										
D1	TC21										
D0	TC20										
16-bit timer 2 control register	0048196 (B)			D7	–	reserved	–		0	–	
		D6	SELFM2	16-bit timer 2 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB2	16-bit timer 2 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV2	16-bit timer 2 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL2	16-bit timer 2 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM2	16-bit timer 2 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET2	16-bit timer 2 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN2	16-bit timer 2 Run/Stop control	1	Run	0	Stop	0	R/W	
		16-bit timer 3 comparison data A set-up register	0048198 (HW)	DF	CR3A15	16-bit timer 3 comparison data A CR3A15 = MSB CR3A0 = LSB	0 to 65535		X	R/W	
DE	CR3A14										
DD	CR3A13										
DC	CR3A12										
DB	CR3A11										
DA	CR3A10										
D9	CR3A9										
D8	CR3A8										
D7	CR3A7										
D6	CR3A6										
D5	CR3A5										
D4	CR3A4										
D3	CR3A3										
D2	CR3A2										
D1	CR3A1										
D0	CR3A0										
16-bit timer 3 comparison data B set-up register	004819A (HW)	DF	CR3B15	16-bit timer 3 comparison data B CR3B15 = MSB CR3B0 = LSB	0 to 65535		X	R/W			
		DE	CR3B14								
		DD	CR3B13								
		DC	CR3B12								
		DB	CR3B11								
		DA	CR3B10								
		D9	CR3B9								
		D8	CR3B8								
		D7	CR3B7								
		D6	CR3B6								
		D5	CR3B5								
		D4	CR3B4								
		D3	CR3B3								
D2	CR3B2										
D1	CR3B1										
D0	CR3B0										

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
16-bit timer 3 counter data register	004819C (HW)	DF	TC315	16-bit timer 3 counter data TC315 = MSB TC30 = LSB	0 to 65535		X	R			
		DE	TC314								
		DD	TC313								
		DC	TC312								
		DB	TC311								
		DA	TC310								
		D9	TC39								
		D8	TC38								
		D7	TC37								
		D6	TC36								
		D5	TC35								
		D4	TC34								
		D3	TC33								
		D2	TC32								
		D1	TC31								
		D0	TC30								
16-bit timer 3 control register	004819E (B)	D7	–	reserved	–		0	–	0 when being read.		
		D6	SELFM3	16-bit timer 3 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB3	16-bit timer 3 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV3	16-bit timer 3 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL3	16-bit timer 3 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM3	16-bit timer 3 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET3	16-bit timer 3 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN3	16-bit timer 3 Run/Stop control	1	Run	0	Stop	0	R/W	
16-bit timer 4 comparison data A set-up register	00481A0 (HW)	DF	CR4A15	16-bit timer 4 comparison data A CR4A15 = MSB CR4A0 = LSB	0 to 65535		X	R/W			
		DE	CR4A14								
		DD	CR4A13								
		DC	CR4A12								
		DB	CR4A11								
		DA	CR4A10								
		D9	CR4A9								
		D8	CR4A8								
		D7	CR4A7								
		D6	CR4A6								
		D5	CR4A5								
		D4	CR4A4								
		D3	CR4A3								
		D2	CR4A2								
		D1	CR4A1								
		D0	CR4A0								
16-bit timer 4 comparison data B set-up register	00481A2 (HW)	DF	CR4B15	16-bit timer 4 comparison data B CR4B15 = MSB CR4B0 = LSB	0 to 65535		X	R/W			
		DE	CR4B14								
		DD	CR4B13								
		DC	CR4B12								
		DB	CR4B11								
		DA	CR4B10								
		D9	CR4B9								
		D8	CR4B8								
		D7	CR4B7								
		D6	CR4B6								
		D5	CR4B5								
		D4	CR4B4								
		D3	CR4B3								
		D2	CR4B2								
		D1	CR4B1								
		D0	CR4B0								
16-bit timer 4 counter data register	00481A4 (HW)	DF	TC415	16-bit timer 4 counter data TC415 = MSB TC40 = LSB	0 to 65535		X	R			
		DE	TC414								
		DD	TC413								
		DC	TC412								
		DB	TC411								
		DA	TC410								
		D9	TC49								
		D8	TC48								
		D7	TC47								
		D6	TC46								
		D5	TC45								
		D4	TC44								
		D3	TC43								
		D2	TC42								
		D1	TC41								
		D0	TC40								

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Register name	Address	Bit	Name	Function	Setting			Init.	R/W	Remarks	
16-bit timer 4 control register	00481A6 (B)	D7	–	reserved	–			0	–	0 when being read.	
		D6	SELFM4	16-bit timer 4 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB4	16-bit timer 4 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV4	16-bit timer 4 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL4	16-bit timer 4 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM4	16-bit timer 4 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET4	16-bit timer 4 reset	1	Reset	0	Invalid	0	W	0 when being read.
D0	PRUN4	16-bit timer 4 Run/Stop control	1	Run	0	Stop	0	R/W			
16-bit timer 5 comparison data A set-up register	00481A8 (HW)	DF	CR5A15	16-bit timer 5 comparison data A	0 to 65535			X	R/W		
		DE	CR5A14	CR5A15 = MSB				X			
		DD	CR5A13	CR5A0 = LSB				X			
		DC	CR5A12					X			
		DB	CR5A11					X			
		DA	CR5A10					X			
		D9	CR5A9					X			
		D8	CR5A8					X			
		D7	CR5A7					X			
		D6	CR5A6					X			
		D5	CR5A5					X			
		D4	CR5A4					X			
		D3	CR5A3					X			
		D2	CR5A2					X			
D1	CR5A1					X					
D0	CR5A0					X					
16-bit timer 5 comparison data B set-up register	00481AA (HW)	DF	CR5B15	16-bit timer 5 comparison data B	0 to 65535			X	R/W		
		DE	CR5B14	CR5B15 = MSB				X			
		DD	CR5B13	CR5B0 = LSB				X			
		DC	CR5B12					X			
		DB	CR5B11					X			
		DA	CR5B10					X			
		D9	CR5B9					X			
		D8	CR5B8					X			
		D7	CR5B7					X			
		D6	CR5B6					X			
		D5	CR5B5					X			
		D4	CR5B4					X			
		D3	CR5B3					X			
		D2	CR5B2					X			
D1	CR5B1					X					
D0	CR5B0					X					
16-bit timer 5 counter data register	00481AC (HW)	DF	TC515	16-bit timer 5 counter data	0 to 65535			X	R		
		DE	TC514	TC515 = MSB				X			
		DD	TC513	TC50 = LSB				X			
		DC	TC512					X			
		DB	TC511					X			
		DA	TC510					X			
		D9	TC59					X			
		D8	TC58					X			
		D7	TC57					X			
		D6	TC56					X			
		D5	TC55					X			
		D4	TC54					X			
		D3	TC53					X			
		D2	TC52					X			
D1	TC51					X					
D0	TC50					X					
16-bit timer 5 control register	00481AE (B)	D7	–	reserved	–			0	–	0 when being read.	
		D6	SELFM5	16-bit timer 5 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB5	16-bit timer 5 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV5	16-bit timer 5 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL5	16-bit timer 5 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM5	16-bit timer 5 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET5	16-bit timer 5 reset	1	Reset	0	Invalid	0	W	0 when being read.
D0	PRUN5	16-bit timer 5 Run/Stop control	1	Run	0	Stop	0	R/W			

CFP16–CFP10: P1[6:0] pin function selection (D[6:0]) / P1 function select register (0x402D4)

Selects the pin to be used for input of an external count clock to the timer.

Write "1": Clock input pin
Write "0": I/O port pin
Read: Valid

Select clock input pins for the timers that are used as an event counter from among P10 through P16, by writing "1" to CFP10–CFP16. For the relationship between each pin and timer, refer to Table III-4.1. The pin is set for an I/O port by writing "0" to CFP1x.

In addition to pin selection here, the pin to be used for clock input to the 16-bit programmable timer must be set to input mode using the I/O control register.

At cold start, CFP1x is set to "0" (I/O port). At hot start, CFP1x retains its status from prior to the initial reset.

CFP27–CFP22: P2[7:2] pin function selection (D[7:2]) / P2 function select register (0x402D8)

Selects the pin used for clock output.

Write "1": Clock output pin
Write "0": I/O port pin
Read: Valid

Select the pin to be used to output a timer-generated clock to external devices from among P22 through P27, by writing "1" to CFP22–CFP27. For the relationship between each pin and timer, refer to Table III-4.1. The pin is set for an I/O port by writing "0" to CFP2x.

At cold start, CFP2x is set to "0" (I/O port). At hot start, CFP2x retains its status from prior to the initial reset.

CFEX1: P10, P11, P13 port extended function (D1) / Port function extension register (0x402DF)**CFEX0:** P12, P14 port extended function (D0) / Port function extension register (0x402DF)

Sets whether the function of an I/O-port pin is to be extended.

Write "1": Function-extended pin
Write "0": I/O-port/peripheral-circuit pin
Read: Valid

When CFEX[1:0] is set to "1", the P14–P10 ports function as debug signal output ports. When CFEX[1:0] = "0", the CFP1[4:0] bit becomes effective, so the settings of these bits determine whether the P14–P10 ports function as I/O ports or external clock input ports.

At cold start, CFEX[1:0] is set to "1" (function-extended pins). At hot start, CFEX[1:0] retains its state from prior to the initial reset.

IOC16–IOC10: P1[6:0] port I/O control (D[6:0]) / P1 I/O control register (0x402D6)

Directs P10 through P16 for input or output.

Write "1": Output mode
Write "0": Input mode
Read: Valid

For the pin selected from among P10 through P16 for use for external clock input, write "0" to the corresponding I/O control bit to set it to input mode. If the pin is set to output mode, even though its CFP1x may be set to "1", it functions as the output pin of an 8-bit programmable timer and cannot be used to receive an external clock.

At cold start, all IOC1x is set to "0" (input mode). At hot start, IOC1x retains its state from prior to the initial reset.

SELFM0: Timer 0 fine mode selection (D6) / 16-bit timer 0 control register (0x48186)
SELFM1: Timer 1 fine mode selection (D6) / 16-bit timer 1 control register (0x4818E)
SELFM2: Timer 2 fine mode selection (D6) / 16-bit timer 2 control register (0x48196)
SELFM3: Timer 3 fine mode selection (D6) / 16-bit timer 3 control register (0x4819E)
SELFM4: Timer 4 fine mode selection (D6) / 16-bit timer 4 control register (0x481A6)
SELFM5: Timer 5 fine mode selection (D6) / 16-bit timer 5 control register (0x481AE)

Sets fine mode for clock output.

Write "1": Fine mode
 Write "0": Normal output
 Read: Valid

When SELFM_x is set to "1", clock output is set in fine mode which allows adjustment of the output signal duty ratio in units of a half cycle for the input clock.

When SELFM_x is set to "0", normal clock output will be performed.

At initial reset, SELCFM_x is set to "0" (normal output).

SELCRB0: Timer 0 comparison register buffer enable (D5) / 16-bit timer 0 control register (0x48186)
SELCRB1: Timer 1 comparison register buffer enable (D5) / 16-bit timer 1 control register (0x4818E)
SELCRB2: Timer 2 comparison register buffer enable (D5) / 16-bit timer 2 control register (0x48196)
SELCRB3: Timer 3 comparison register buffer enable (D5) / 16-bit timer 3 control register (0x4819E)
SELCRB4: Timer 4 comparison register buffer enable (D5) / 16-bit timer 4 control register (0x481A6)
SELCRB5: Timer 5 comparison register buffer enable (D5) / 16-bit timer 5 control register (0x481AE)

Enables or disables writing to the comparison register buffer.

Write "1": Enabled
 Write "0": Disabled
 Read: Valid

When SELCRB_x is set to "1", comparison data is read and written from/to the comparison register buffer. The content of the buffer is loaded to the comparison data register when the counter is reset by the software or the comparison B signal.

When SELCRB_x is set to "0", comparison data is read and written from/to the comparison data register.

At initial reset, SELCRB_x is set to "0" (disabled).

OUTINV0: Timer 0 output inversion (D4) / 16-bit timer 0 control register (0x48186)
OUTINV1: Timer 1 output inversion (D4) / 16-bit timer 1 control register (0x4818E)
OUTINV2: Timer 2 output inversion (D4) / 16-bit timer 2 control register (0x48196)
OUTINV3: Timer 3 output inversion (D4) / 16-bit timer 3 control register (0x4819E)
OUTINV4: Timer 4 output inversion (D4) / 16-bit timer 4 control register (0x481A6)
OUTINV5: Timer 5 output inversion (D4) / 16-bit timer 5 control register (0x481AE)

Selects a logic of the output signal.

Write "1": Inverted (active low)
 Write "0": Normal (active high)
 Read: Valid

By writing "1" to OUTINV_x, an active-low signal (off level = high) is generated for the TM_x output. When OUTINV_x is set to "0", an active-high signal (off level = low) is generated.

At initial reset, OUTINV_x is set to "0" (normal).

CKSL0: Timer 0 input clock selection (D3) / 16-bit timer 0 control register (0x48186)
CKSL1: Timer 1 input clock selection (D3) / 16-bit timer 1 control register (0x4818E)
CKSL2: Timer 2 input clock selection (D3) / 16-bit timer 2 control register (0x48196)
CKSL3: Timer 3 input clock selection (D3) / 16-bit timer 3 control register (0x4819E)
CKSL4: Timer 4 input clock selection (D3) / 16-bit timer 4 control register (0x481A6)
CKSL5: Timer 5 input clock selection (D3) / 16-bit timer 5 control register (0x481AE)

Selects the input clock of each timer.

Write "1": External clock
 Write "0": Internal clock
 Read: Valid

The internal clock (prescaler output) is selected for the input clock of each timer by writing "0" to CKSLx. An external clock (one that is fed from the clock input pin) is selected by writing "1", and the timer functions as an event counter. In this case, the clock input pin must be set using CFP1x before an external clock is selected here. At initial reset, CKSLx is set to "0" (internal clock).

PTM0: Timer 0 clock output control (D2) / 16-bit timer 0 control register (0x48186)
PTM1: Timer 1 clock output control (D2) / 16-bit timer 1 control register (0x4818E)
PTM2: Timer 2 clock output control (D2) / 16-bit timer 2 control register (0x48196)
PTM3: Timer 3 clock output control (D2) / 16-bit timer 3 control register (0x4819E)
PTM4: Timer 4 clock output control (D2) / 16-bit timer 4 control register (0x481A6)
PTM5: Timer 5 clock output control (D2) / 16-bit timer 5 control register (0x481AE)

Controls the output of the TMx signal (timer output clock).

Write "1": On
 Write "0": Off
 Read: Valid

The TMx signal is output from the clock output pin by writing "1" to PTMx. Clock output is stopped by writing "0" to PTMx and goes to the off level according to the OUTINVx setting (low when OUTINVx = "0" or high when OUTINVx = "1"). In this case, the clock output pin must be set using CFP2x before outputting the TMx signal here.

At initial reset, PTMx is set to "0" (off).

PRESET0: Timer 0 reset (D1) / 16-bit timer 0 control register (0x48186)
PRESET1: Timer 1 reset (D1) / 16-bit timer 1 control register (0x4818E)
PRESET2: Timer 2 reset (D1) / 16-bit timer 2 control register (0x48196)
PRESET3: Timer 3 reset (D1) / 16-bit timer 3 control register (0x4819E)
PRESET4: Timer 4 reset (D1) / 16-bit timer 4 control register (0x481A6)
PRESET5: Timer 5 reset (D1) / 16-bit timer 5 control register (0x481AE)

Resets the counter.

Write "1": Reset
 Write "0": Invalid
 Read: Always "0"

The counter of timer x is reset by writing "1" to PRESETx.

Writing "0" results in No Operation.

Since PRESETx is a write-only bit, its content when read is always "0".

PRUN0: Timer 0 RUN/STOP control (D0) / 16-bit timer 0 control register (0x48186)
PRUN1: Timer 1 RUN/STOP control (D0) / 16-bit timer 1 control register (0x4818E)
PRUN2: Timer 2 RUN/STOP control (D0) / 16-bit timer 2 control register (0x48196)
PRUN3: Timer 3 RUN/STOP control (D0) / 16-bit timer 3 control register (0x4819E)
PRUN4: Timer 4 RUN/STOP control (D0) / 16-bit timer 4 control register (0x481A6)
PRUN5: Timer 5 RUN/STOP control (D0) / 16-bit timer 5 control register (0x481AE)

Controls the timer's RUN/STOP state.

Write "1": RUN
 Write "0": STOP
 Read: Valid

Each timer is made to start counting up by writing "1" to PRUNx and made to stop counting by writing "0". In the STOP state, the counter data is retained until the timer is reset or placed in a RUN state. By changing states from STOP to RUN, the timer can restart counting beginning at the retained count. At initial reset, PRUNx is set to "0" (STOP).

CR0A15–CR0A0: Timer 0 comparison data A (D[F:0]) / 16-bit timer 0 comparison data A set-up register (0x48180)
CR1A15–CR1A0: Timer 1 comparison data A (D[F:0]) / 16-bit timer 1 comparison data A set-up register (0x48188)
CR2A15–CR2A0: Timer 2 comparison data A (D[F:0]) / 16-bit timer 2 comparison data A set-up register (0x48190)
CR3A15–CR3A0: Timer 3 comparison data A (D[F:0]) / 16-bit timer 3 comparison data A set-up register (0x48198)
CR4A15–CR4A0: Timer 4 comparison data A (D[F:0]) / 16-bit timer 4 comparison data A set-up register (0x481A0)
CR5A15–CR5A0: Timer 5 comparison data A (D[F:0]) / 16-bit timer 5 comparison data A set-up register (0x481A8)

Sets the comparison data A of each timer.

When SELCRBx is set to "0", comparison data is directly read or writing from/to the comparison data register A. When SELCRBx is set to "1", comparison data is read or written from/to the comparison register buffer A. The content of the buffer is loaded to the comparison data register A when the counter is reset. The data set in this register is compared with each corresponding counter data. When the contents match, a comparison A interrupt is generated and the output signal rises (OUTINVx = "0") or falls (OUTINVx = "1"). This does not affect the counter value and count-up operation. At initial reset, CRxA is not initialized.

CR0B15–CR0B0: Timer 0 comparison data B (D[F:0]) / 16-bit timer 0 comparison data B set-up register (0x48182)
CR1B15–CR1B0: Timer 1 comparison data B (D[F:0]) / 16-bit timer 1 comparison data B set-up register (0x4818A)
CR2B15–CR2B0: Timer 2 comparison data B (D[F:0]) / 16-bit timer 2 comparison data B set-up register (0x48192)
CR3B15–CR3B0: Timer 3 comparison data B (D[F:0]) / 16-bit timer 3 comparison data B set-up register (0x4819A)
CR4B15–CR4B0: Timer 4 comparison data B (D[F:0]) / 16-bit timer 4 comparison data B set-up register (0x481A2)
CR5B15–CR5B0: Timer 5 comparison data B (D[F:0]) / 16-bit timer 5 comparison data B set-up register (0x481AA)

Sets the comparison data B of each timer.

When SELCRBx is set to "0", comparison data is directly read or writing from/to the comparison data register B. When SELCRBx is set to "1", comparison data is read or written from/to the comparison register buffer B. The content of the buffer is loaded to the comparison data register B when the counter is reset.

The data set in this register is compared with each corresponding counter data. When the contents match, a comparison B interrupt is generated and the output signal falls (OUTINV_x = "0") or rises (OUTINV_x = "1"). Furthermore, the counter is reset to "0".

At initial reset, CR_xB is not initialized.

TC015–TC00: Timer 0 counter data (D[F:0]) / 16-bit timer 0 counter data register (0x48184)

TC115–TC10: Timer 1 counter data (D[F:0]) / 16-bit timer 1 counter data register (0x4818C)

TC215–TC20: Timer 2 counter data (D[F:0]) / 16-bit timer 2 counter data register (0x48194)

TC315–TC30: Timer 3 counter data (D[F:0]) / 16-bit timer 3 counter data register (0x4819C)

TC415–TC40: Timer 4 counter data (D[F:0]) / 16-bit timer 4 counter data register (0x481A4)

TC515–TC50: Timer 5 counter data (D[F:0]) / 16-bit timer 5 counter data register (0x481AC)

The counter data of each timer can be read from this register.

The data can be read out at any time.

Since TC_x is a read-only register, writing to this register is ignored.

At initial reset, TC_x is not initialized.

P16T02–P16T00: Timer 0 interrupt level (D[2:0]) / 16-bit timer 0/1 interrupt priority register (0x40266)

P16T12–P16T10: Timer 1 interrupt level (D[6:4]) / 16-bit timer 0/1 interrupt priority register (0x40266)

P16T22–P16T20: Timer 2 interrupt level (D[2:0]) / 16-bit timer 2/3 interrupt priority register (0x40267)

P16T32–P16T30: Timer 3 interrupt level (D[6:4]) / 16-bit timer 2/3 interrupt priority register (0x40267)

P16T42–P16T40: Timer 4 interrupt level (D[2:0]) / 16-bit timer 4/5 interrupt priority register (0x40268)

P16T52–P16T50: Timer 5 interrupt level (D[6:4]) / 16-bit timer 4/5 interrupt priority register (0x40268)

Sets the priority levels of 16-bit programmable timer interrupts.

The priority level can be set in the range of 0 to 7.

At initial reset, P16T_x becomes indeterminate.

E16TU0, E16TC0: Timer 0 interrupt enable (D2, D3) / 16-bit timer 0/1 interrupt enable register (0x40272)

E16TU1, E16TC1: Timer 1 interrupt enable (D6, D7) / 16-bit timer 0/1 interrupt enable register (0x40272)

E16TU2, E16TC2: Timer 2 interrupt enable (D2, D3) / 16-bit timer 2/3 interrupt enable register (0x40273)

E16TU3, E16TC3: Timer 3 interrupt enable (D6, D7) / 16-bit timer 2/3 interrupt enable register (0x40273)

E16TU4, E16TC4: Timer 4 interrupt enable (D2, D3) / 16-bit timer 4/5 interrupt enable register (0x40274)

E16TU5, E16TC5: Timer 5 interrupt enable (D6, D7) / 16-bit timer 4/5 interrupt enable register (0x40274)

Enables or disables the generation of an interrupt to the CPU.

Write "1": Interrupt enabled

Write "0": Interrupt disabled

Read: Valid

The E16TU_x and E16TC_x are provided for the comparison B and comparison A interrupt factors, respectively.

The interrupt for which the bit is set to "1" is enabled, and the interrupt for which the bit is set to "0" is disabled.

At initial reset, these bits are set to "0" (interrupt disabled).

F16TU0, F16TC0: Timer 0 interrupt factor flag (D2, D3) / 16-bit timer 0/1 interrupt factor flag register (0x40282)

F16TU1, F16TC1: Timer 1 interrupt factor flag (D6, D7) / 16-bit timer 0/1 interrupt factor flag register (0x40282)

F16TU2, F16TC2: Timer 2 interrupt factor flag (D2, D3) / 16-bit timer 2/3 interrupt factor flag register (0x40283)

F16TU3, F16TC3: Timer 3 interrupt factor flag (D6, D7) / 16-bit timer 2/3 interrupt factor flag register (0x40283)

F16TU4, F16TC4: Timer 4 interrupt factor flag (D2, D3) / 16-bit timer 4/5 interrupt factor flag register (0x40284)

F16TU5, F16TC5: Timer 5 interrupt factor flag (D6, D7) / 16-bit timer 4/5 interrupt factor flag register (0x40284)

Indicates the status of 16-bit programmable timer interrupt generation.

When read

Read "1": Interrupt factor has occurred
 Read "0": No interrupt factor has occurred

When written using the reset-only method (default)

Write "1": Interrupt factor flag is reset
 Write "0": Invalid

When written using the read/write method

Write "1": Interrupt flag is set
 Write "0": Interrupt flag is reset

F16TUx and F16TCx are the interrupt factor flags corresponding to the comparison B and comparison A interrupts, respectively. The flag is set to "1" when each interrupt factor occurs.

At this time, if the following conditions are met, an interrupt to the CPU is generated:

1. The corresponding interrupt enable register bit is set to "1".
2. No other interrupt request of a higher priority has been generated.
3. The PSR's IE bit is set to "1" (interrupts enabled).
4. The value set in the corresponding interrupt priority register is higher than the CPU's interrupt level (IL).

When using the interrupt factor of the 16-bit programmable timer to request IDMA, note that even when the above conditions are met, no interrupt request to the CPU is generated for the interrupt factor that has occurred. If interrupts are enabled at the setting of IDMA, an interrupt is generated under the above conditions after the data transfer by IDMA is completed.

The interrupt factor flag is set to "1" whenever interrupt generation conditions are met, regardless of how the interrupt enable and interrupt priority registers are set.

If the next interrupt is to be accepted after an interrupt has occurred, it is necessary that the interrupt factor flag be reset, and that the PSR be set again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can be reset only by writing to it in the software. Note that if the PSR is set again to accept interrupts generated (or if the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

At initial reset, all these flags become indeterminate, so be sure to reset them in the software.

R16TU0, R16TC0: Timer 0 IDMA request (D6, D7) /

Port input 0–3, HSDMA, 16-bit timer 0 IDMA request register (0x40290)

R16TU1, R16TC1: Timer 1 IDMA request (D0, D1) / 16-bit timer 1–4 IDMA request register (0x40291)

R16TU2, R16TC2: Timer 2 IDMA request (D2, D3) / 16-bit timer 1–4 IDMA request register (0x40291)

R16TU3, R16TC3: Timer 3 IDMA request (D4, D5) / 16-bit timer 1–4 IDMA request register (0x40291)

R16TU4, R16TC4: Timer 4 IDMA request (D6, D7) / 16-bit timer 1–4 IDMA request register (0x40291)

R16TU5, R16TC5: Timer 5 IDMA request (D0, D1) /

16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register (0x40292)

Specifies whether to invoke IDMA when an interrupt factor occurs.

When using the set-only method (default)

Write "1": IDMA request
 Write "0": Not changed
 Read: Valid

When using the read/write method

Write "1": IDMA request
 Write "0": Interrupt request
 Read: Valid

R16TUx and R16TCx are IDMA request bits corresponding to the comparison B and comparison A interrupt factors, respectively. When the bit is set to "1", IDMA is invoked when the interrupt factor occurs, thereby performing programmed data transfers. When the register is set to "0", normal interrupt processing is performed and IDMA is not invoked. For details on IDMA, refer to "IDMA (Intelligent DMA)".

At initial reset, these bits are set to "0" (interrupt request).

DE16TU0, DE16TC0: Timer 0 IDMA enable (D6, D7) /

Port input 0–3, HSDMA, 16-bit timer 0 IDMA enable register (0x40294)

DE16TU1, DE16TC1: Timer 1 IDMA enable (D0, D1) / 16-bit timer 1–4 IDMA enable register (0x40295)

DE16TU2, DE16TC2: Timer 2 IDMA enable (D2, D3) / 16-bit timer 1–4 IDMA enable register (0x40295)

DE16TU3, DE16TC3: Timer 3 IDMA enable (D4, D5) / 16-bit timer 1–4 IDMA enable register (0x40295)

DE16TU4, DE16TC4: Timer 4 IDMA enable (D6, D7) / 16-bit timer 1–4 IDMA enable register (0x40295)

DE16TU5, DE16TC5: Timer 5 IDMA enable (D0, D1) /

16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register (0x40296)

Enables IDMA transfer by means of an interrupt factor.

When using the set-only method (default)

Write "1": IDMA enabled

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA enabled

Write "0": IDMA disabled

Read: Valid

DE16TUx and DE16TCx are IDMA enable bits corresponding to the comparison B and comparison A interrupt factors, respectively. If the bit is set to "1", the IDMA request by the interrupt factor is enabled. If the bit is set to "0", the IDMA request is disabled.

After an initial reset, these bits are set to "0" (IDMA disabled).

Programming Notes

- (1) The 16-bit programmable timers clocked by the internal clock operate only when the prescaler is operating.
- (2) When setting the input clock or operation mode, make sure the 16-bit programmable timer is turned off.
- (3) If a same value is set to the comparison data A and B registers, a hazard may be generated in the output signal. Therefore, do not set the comparison registers as $A = B$.
There is no problem when the interrupt function only is used.
- (4) When using the output clock, set the comparison data registers as $A \geq 0$ and $B \geq 1$. The minimum settings are $A = 0$ and $B = 1$. In this case, the timer output clock cycle is the input clock $\times 1/2$.
- (5) When the comparison data registers are set as $A > B$ in normal mode, no comparison A interrupt is generated. In this case, the output signal is fixed at the off level.
In fine mode, no comparison A interrupt is generated when the comparison data registers are set as $A > 2 \times B + 1$.
- (6) After an initial reset, the interrupt factor flag becomes indeterminate. To prevent generation of an unwanted interrupt or IDMA request, be sure to reset this flag and register in the software.
- (7) To prevent another interrupt from being generated by the same factor after an interrupt has occurred, be sure to reset the interrupt factor flag before setting the PSR again or executing the reti instruction.
- (8) Be aware that unnecessary pulse may be generated according to the control of the clock output and port configuration when a 16-bit programmable timer is used to output the TMx clock.
For example, when TMx is set as inverted output ($OUTINVx = "1"$), the output waveform falls with the comparison B signal and it rises with the comparison A signal. Furthermore, the output pin is fixed at high level when PTMx is set to "0" to stop the clock output. When switching the output pin to the I/O port pin and then setting the port to low after the TMx signal falls with the comparison A signal, a high level pulse will be generated if "0" is written to PTMx before setting the port to low. It can be prevented by writing "0" to PTMx after setting the port to low.

III-5 WATCHDOG TIMER

Configuration of Watchdog Timer

The Peripheral Block incorporates a watchdog timer function to detect the CPU's crash.

This function is implemented through the use of the 16-bit programmable timer 0. When this function is enabled, an NMI (nonmaskable interrupt) is generated by the comparison B signal from the 16-bit programmable timer 0 (generating intervals can be set through the use of software). The 16-bit programmable timer 0 set in the software so as not to generate the NMI, making it possible to detect a program crash that may not pass through this processing routine.

Figure III-5.1 shows the block diagram of the watchdog timer.

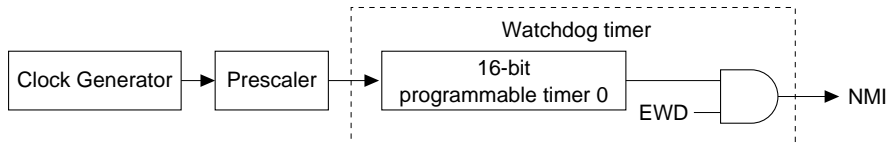


Figure III-5.1 Watchdog Timer Block Diagram

Control of Watchdog Timer

Setting the operating clock and NMI generating interval

The watchdog timer is operated by the prescaler's output clock. Therefore, the watchdog timer function cannot be used when the prescaler is inactive.

The NMI is generated every time the 16-bit programmable timer 0 is reset by the comparison B setting. Therefore, this interval is determined by the prescaler's P16TS0[2:0] (D[2:0]) / 16-bit timer 0 clock control register (0x40147), and the comparison data B set in CR0B[15:0] (D[F:0]) / 16-bit timer 0 comparison register B (0x48182).

The NMI generating interval is calculated using the following equation:

$$\text{NMI generating interval} = \frac{\text{CR0B} + 1}{\text{fPSCIN} \times \text{dr}} \quad [\text{sec.}]$$

fPSCIN: Prescaler input clock frequency [Hz]

dr: Prescaler's division ratio set by the P16TS0 register (1/4096, 1/1024, 1/256, 1/64, 1/16, 1/4, 1/2, 1/1)

CR0B: Set value of the CR0B register (0 to 65,535)

For details on how to control the prescaler and the 16-bit programmable timer 0, refer to "Prescaler" and "16-Bit Programmable Timers".

Setting the watchdog timer function

To use the watchdog timer function, enable the NMI that is generated by the comparison B signal from the 16-bit programmable timer 0. For this purpose, use EWD (D1) / Watchdog timer enable register (0x40171). The NMI is enabled by writing "1" to EWD. At initial reset, EWD is set to "0", so generation of the NMI is disabled.

To prevent an unwanted NMI from being generated by erroneous writing to EWD, this register is normally write-protected. To write-enable EWD, write "1" to WRWD (D7) / Watchdog timer write-protect register (0x40170). Only one writing to EWD is enabled in this way by the WRWD bit. When data is written to EWD after it is write-enabled, the WRWD bit is reset back to "0", thus making EWD write-protected again.

For the 16-bit programmable timer 0, set an appropriate comparison B value to make it start operating.

If the watchdog timer function is not to be used, set EWD to "0" and do not change it.

Resetting the watchdog timer

When using the watchdog timer, prepare a routine to reset the 16-bit programmable timer 0 before an NMI is generated in a location where it will be periodically processed. Make sure this routine is processed within the NMI generation interval described above.

The 16-bit programmable timer 0 is reset by writing "1" to PRESET0 (D1) / 16-bit timer 0 control register (0x48186). At this point, the timer counter is set to 0, and the timer starts counting the NMI generation interval over again from that point.

If the watchdog timer is not reset within the set interval for any reason, the CPU is made to enter trap processing by an NMI and starts executing the processing routine indicated by the NMI vector.

The NMI trap vector address is set by default as follows:

When BTA3 = high, 0x008001C

When BTA3 = low, 0x0C0001C

The trap table base address can be changed using the TTBR registers (0x48134 to 0x48137).

Operation in Standby Modes

During HALT mode

In HALT mode (basic mode or HALT2 mode), the prescaler and watchdog timer are operating. Consequently, if HALT mode continues beyond the NMI generation interval, HALT mode is cleared by the NMI.

To disable the watchdog timer in HALT mode, set EWD to "0" before executing the halt instruction or turn off the 16-bit programmable timer 0.

If the NMI is disabled by EWD, the 16-bit programmable timer 0 continues counting even in HALT mode.

To reenble the NMI after clearing HALT mode, reset the 16-bit programmable timer 0 in advance.

If HALT mode was entered after the 16-bit programmable timer 0 was turned off, reset the timer before restarting it.

During SLEEP mode

In SLEEP mode, the prescaler is turned off. Therefore, the watchdog timer also stops operating. To prevent generation of an unwanted NMI after clearing SLEEP mode, reset the 16-bit programmable timer 0 before executing the slp instruction. In addition, disable generation of the NMI by EWD as necessary.

I/O Memory of Watchdog Timer

Table III-5.1 shows the control bits of the watchdog timer.

Table III-5.1 Control Bits of Watchdog Timer

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
Watchdog timer write-protect register	0040170 (B)	D7	WRWD	EWD write protection	1 Write enabled 0 Write-protect	0	R/W	
		D6-0	-	-	-	-	-	0 when being read.
Watchdog timer enable register	0040171 (B)	D7-2	-	-	-	-	-	0 when being read.
		D1	EWD	Watchdog timer enable	1 NMI enabled 0 NMI disabled	0	R/W	
		D0	-	-	-	-	-	0 when being read.

WRWD: EWD write protection (D7) / Watchdog timer write-protect register (0x40170)

Enables writing to the EWD register.

Write "1": Writing enabled

Write "0": Write-protected

Read: Valid

The EWD bit is write-protected to prevent unwanted modifications. Writing to this bit is enabled for only one writing by setting WRWD to "1". WRWD is reset back to "0" by writing to EWD, so EWD is write-protected again.

If WRWD is reset to "0" when EWD is write-enabled (WRWD = "1"), EWD becomes write-protected again.

At initial reset, WRWD is set to "0" (write-protected).

EWD: NMI enable (D1) / Watchdog timer enable register (0x40171)

Controls the generation of a nonmaskable interrupt (NMI) by the watchdog timer.

Write "1": NMI is enabled

Write "0": NMI is disabled

Read: Valid

The watchdog timer's interrupt signal is masked by writing "0" to EWD, so a nonmaskable interrupt (NMI) to the CPU is not generated. If EWD is set to "1", an NMI is generated by the 16-bit programmable timer 0 comparison B signal.

Writing to EWD is valid only when WRWD = "1".

Even when EWD is set to "0", the 16-bit programmable timer 0 does not stop counting. Therefore, if the NMI has been temporarily disabled, be sure to reset the 16-bit programmable timer 0 before setting the EWD register back to "1".

At initial reset, EWD is set to "0" (NMI disabled).

Programming Notes

- (1) If the watchdog timer's NMI is enabled, the watchdog timer must be reset in the software before the 16-bit programmable timer 0 outputs the comparison B signal.
- (2) Even when EWD is set to "0", the 16-bit programmable timer 0 does not stop counting. Therefore, if the NMI has been temporarily disabled, be sure to reset the 16-bit programmable timer 0 before setting EWD back to "1".

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III-6 LOW-SPEED (OSC1) OSCILLATION CIRCUIT

Configuration of Low-Speed (OSC1) Oscillation Circuit

The Peripheral Block has a built-in low-speed (OSC1) oscillation circuit.

The low-speed (OSC1) oscillation circuit generates a 32.768-kHz (Typ.) subclock.

The OSC1 clock output by this circuit is delivered to the CLG (clock generator) in the Core Block and is used as the source clock for the clock timer. It can also be used as a sub-clock for the low-speed (low-power) operation of the CPU and peripheral circuits (switchable in a program).

Figure III-6.1 shows the configuration of the clock system.

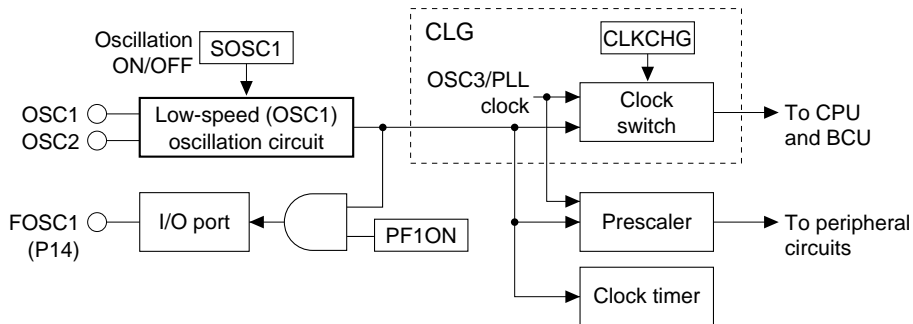


Figure III-6.1 Configuration of Clock System

The CPU operating clock can be switched to the output (OSC1 clock) of the low-speed (OSC1) oscillation circuit in a program. Furthermore, the oscillation circuit can be stopped in a program.

If the OSC3 clock is unnecessary such as when performing clock processing only, set the OSC1 clock for operation of the CPU/peripheral circuits and turn off the high-speed (OSC3) oscillation circuit in order to reduce current consumption.

The low-speed (OSC1) oscillation circuit does not stop in SLEEP mode.

For the control method when using the OSC1 clock for the operating clock of the peripheral circuits, refer to "Prescaler".

I/O Pins of Low-Speed (OSC1) Oscillation Circuit

Table III-6.1 lists the I/O pins of the low-speed (OSC1) oscillation circuit.

Table III-6.1 I/O Pins of Low-Speed (OSC1) Oscillation Circuit

Pin name	I/O	Function
OSC1	I	Low-speed (OSC1) oscillation input pin Crystal oscillation or external clock input
OSC2	O	Low-speed (OSC1) oscillation output pin Crystal oscillation (open when external clock is used)
P14/FOSC1/DCLK	I/O	I/O port / Low-speed (OSC1) oscillation clock output / DCLK signal output

Oscillator Types

In the low-speed (OSC1) oscillation circuit, either a crystal oscillation or an external clock input can be selected as the type of oscillation circuit.

Figure III-6.2 shows the structure of the low-speed (OSC1) oscillation circuit.

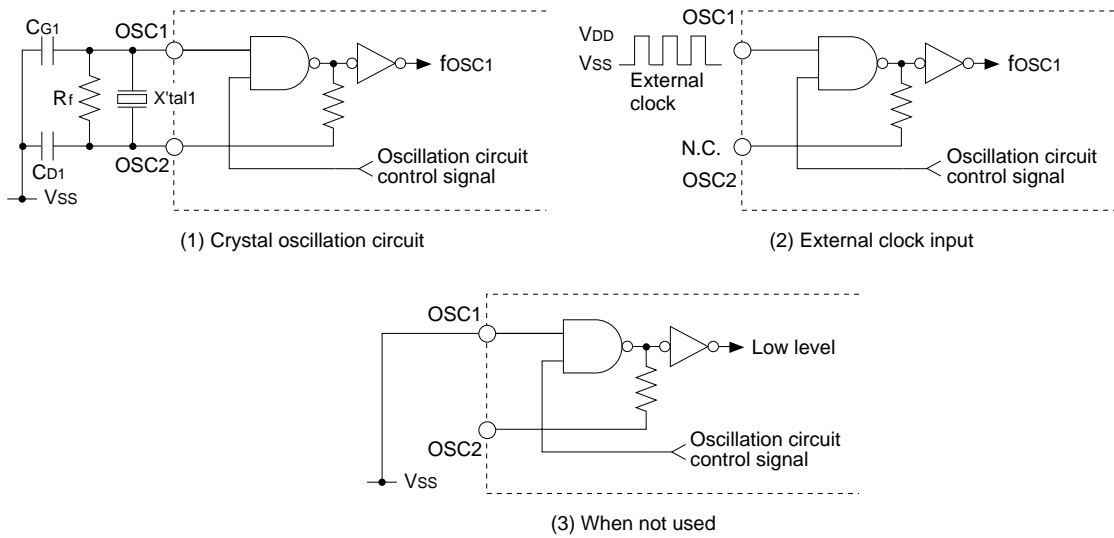


Figure III-6.2 Low-Speed (OSC1) Oscillation Circuit

When using a crystal oscillation for this circuit, connect a crystal resonator X'tal1 (32.768 kHz, Typ.) and feedback resistor (Rf) between the OSC1 and OSC2 pins, and two capacitors (Cg1, Cd1) between the OSC1 pin and Vss and the OSC2 pin and Vss, respectively.

When an external clock source is used, leave the OSC2 pin open and input a square-wave clock to the OSC1 pin. If the low-speed (OSC1) oscillation circuit is not used, connect the OSC1 pin to Vss and leave the OSC2 pin open.

The oscillation frequency is 32.768 kHz (Typ.). Use a crystal resonator or external clock that oscillates at this frequency. No other frequency can be used for clock applications.

For details on oscillation characteristics and the external clock input characteristics, refer to "Electrical Characteristics".

Controlling Oscillation

The low-speed (OSC1) oscillation circuit can be turned on or off using SOSC1 (D0) / Power control register (0x40180).

The oscillation circuit is turned off by writing "0" to SOSC1 and turned back on again by writing "1". SOSC1 is set to "1" at initial reset, so the oscillation circuit is turned on.

- Notes:**
- When the low-speed (OSC1) oscillation circuit is used as the clock source for the CPU operating clock, it cannot be turned off. In this case, writing "0" to SOSC1 is ignored. Note also that writing to SOSC1 is allowed only when the power-control register protection flag is set to "0b10010110".
 - Immediately after the oscillation circuit is turned on, a certain period of time is required for oscillation to stabilize (3 sec max.). To prevent the device from operating erratically, do not use the clock until its oscillation has stabilized.

The low-speed (OSC1) oscillation circuit does not stop when the CPU is set in SLEEP mode.

Switching Over the CPU Operating Clock

After an initial reset, the CPU starts operating using the OSC3 clock.

In cases in which some peripheral circuits (e.g., programmable timer, serial interface, and A/D converter) that are clocked by the OSC3 clock do not need to be operate and the CPU can process its jobs at a low clock speed, the CPU operating clock can be switched to the OSC1 clock, thereby reducing current consumption. Use CLKCHG (D2) / Power control register (0x40180) to switch over the operating clock.

Procedure for switching over from the OSC3 clock to the OSC1 clock

1. Turn on the low-speed (OSC1) oscillation circuit (by writing "1" to SOSC1).
2. Wait until the OSC1 oscillation stabilizes (three seconds or more).
3. Change the CPU operating clock (by writing "0" to CLKCHG).
4. Turn off the high-speed (OSC3) oscillation circuit (by writing "0" to SOSC3).

* Steps 1 and 2 are required only when the low-speed (OSC1) oscillation circuit is inactive.

- Notes:**
- Use separate instructions to switch from OSC3 to OSC1 and turn the OSC3 oscillation off. If these operations are processed simultaneously using one instruction, the CPU may operate erratically.
 - Make sure the operation of the peripheral circuits, such as the programmable timer, A/D converter, and serial interface, which are clocked by the OSC3 oscillation circuit, is terminated before the OSC3 oscillation is turned off in order to prevent them from operating erratically.

Procedure for switching over from the OSC1 clock to the OSC3 clock

1. Turn on the high-speed (OSC3) oscillation circuit (by writing "1" to SOSC3).
2. Wait until the OSC3 oscillation stabilizes (10 ms or more for a 3.3-V crystal resonator).
3. Switch over the CPU operating clock (by writing "1" to CLKCHG).

Note: The operating clock switchover by CLKCHG is effective only when both oscillation circuits are on and the power-control register protection flag is set to "0b10010110".

Power-Control Register Protection Flag

The power-control register (SOSC1, SOSC3, CLKCHG, CLKDT[1:0]) at address 0x40180, which is used to control the oscillation circuits and the CPU operating clock, is normally disabled against writing in order to prevent it from malfunctioning due to unnecessary writing.

III PERIPHERAL BLOCK: LOW-SPEED (OSC1) OSCILLATION CIRCUIT

To enable this register for writing, the power-control register protection flag CLGP[7:0] (D[7:0]) / Power-control protection register (0x4019E) must be set to "0b10010110". Note that this setting allows for the power-control register (0x40180) to be written to only once, so all bits of CLGP[7:0] are cleared to "0" when this address is written to. Therefore, CLGP[7:0] must be set to "0b10010110" each time the power-control register (0x40180) is written to.

The flag CLGP[7:0] does not affect the readout from the power-control register (0x40180).

Operation in Standby Mode

In HALT mode, which is entered by executing the halt instruction, the low-speed (OSC1) oscillation circuits retains its status before HALT mode is entered. Under normal conditions, therefore, there is no need to control the oscillation circuit before entering or after exiting HALT mode.

The low-speed (OSC1) oscillation circuit does not stop operating in SLEEP mode set by executing the slp (sleep) instruction. Therefore, if the CPU was operating using the OSC1 clock before SLEEP mode was entered, the CPU keeps operating using the OSC1 clock in SLEEP mode.

OSC1 Clock Output to External Devices

The low-speed (OSC1) oscillation clock can be output from the FOSC1 (P14) pin to external devices.

Table III-6.2 OSC1 Clock Output Pin

Pin name	I/O	Function	Function select bit
P14/FOSC1/ DCLK	I/O	I/O port / Low-speed (OSC1) oscillation clock output / DCLK signal output	CFP14(D4) / P1 function select register (0x402D4) CFEX0 (D0) / Port function extension register (0x402DF)

Setting the clock output pin

The pin used to output the OSC1 clock to external devices is shared with the P14 I/O port and the debug clock signal DCLK.

At cold start, it is set for the DCLK signal output (CFP14 = "0" and CFEX0 = "1"). When using the clock output function, write "1" to CFP14 and "0" to CFEX0 (refer to "I/O Ports").

At hot start, the pin retains its pre-reset status.

Output control

To start clock output, write "1" to PF1ON (D0) / Clock option register (0x40190). The clock output is stopped by writing "0".

At initial reset, PF1ON is set to "0" (output disabled).

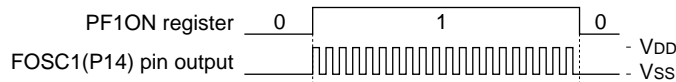


Figure III-6.3 OSC1 Clock Output

I/O Memory of Clock Generator

Table III-6.3 lists the control bits of clock generator.

Table III-6.3 Control Bits of Clock Generator

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Power control register	0040180 (B)	D7	CLKDT1	System clock division ratio selection	CLKDRT[1:0]		0	R/W			
		D6	CLKD0		1	1				1/8	
					1	0				1/4	
					0	1				1/2	
				0	0	1/1					
		D5	PSCON	Prescaler On/Off control	1	On	0	Off		1	R/W
		D4–3	–	reserved	–	–	–	–		0	–
D2	CLKCHG	CPU operating clock switch	1	OSC3	0	OSC1	1	R/W			
D1	SOSC3	High-speed (OSC3) oscillation On/Off	1	On	0	Off	1	R/W			
D0	SOSC1	Low-speed (OSC1) oscillation On/Off	1	On	0	Off	1	R/W			
Clock option register	0040190 (B)	D7–4	–	–	–	–	–	–	0 when being read.		
		D3	HLT2OP	HALT clock option	1	On	0	Off	0	R/W	
		D2	8T1ON	OSC3-stabilize waiting function	1	Off	0	On	1	R/W	
		D1	–	reserved	–	–	–	0	–	Do not write 1.	
		D0	PF1ON	OSC1 external output control	1	On	0	Off	0	R/W	
Power control protect register	004019E (B)	D7	CLGP7	Power control register protect flag	Writing 10010110 (0x96) removes the write protection of the power control register (0x40180) and the clock option register (0x40190). Writing another value set the write protection.		0	R/W			
		D6	CLGP6								
		D5	CLGP5								
		D4	CLGP4								
		D3	CLGP3								
		D2	CLGP2								
		D1	CLGP1								
		D0	CLGP0								
P1 function select register	00402D4 (B)	D7	–	reserved	–	–	–	–	0 when being read.		
		D6	CFP16	P16 function selection	1	EXCL5 #DMAEND1	0	P16	0	R/W	
		D5	CFP15	P15 function selection	1	EXCL4 #DMAEND0	0	P15	0	R/W	
		D4	CFP14	P14 function selection	1	FOSC1	0	P14	0	R/W	
		D3	CFP13	P13 function selection	1	EXCL3 T8UF3	0	P13	0	R/W	
		D2	CFP12	P12 function selection	1	EXCL2 T8UF2	0	P12	0	R/W	
		D1	CFP11	P11 function selection	1	EXCL1 T8UF1	0	P11	0	R/W	
		D0	CFP10	P10 function selection	1	EXCL0 T8UF0	0	P10	0	R/W	
Port function extension register	00402DF (B)	D7	CFEX7	P07 port extended function	1	#DMAEND3	0	P07, etc.	0	R/W	
		D6	CFEX6	P06 port extended function	1	#DMAACK3	0	P06, etc.	0	R/W	
		D5	CFEX5	P05 port extended function	1	#DMAEND2	0	P05, etc.	0	R/W	
		D4	CFEX4	P04 port extended function	1	#DMAACK2	0	P04, etc.	0	R/W	
		D3	CFEX3	P31 port extended function	1	#GARD	0	P31, etc.	0	R/W	
		D2	CFEX2	P21 port extended function	1	#GAAS	0	P21, etc.	0	R/W	
		D1	CFEX1	P10, P11, P13 port extended function	1	DST0 DST1 DPC0	0	P10, etc. P11, etc. P13, etc.	1	R/W	
		D0	CFEX0	P12, P14 port extended function	1	DST2 DCLK	0	P12, etc. P14, etc.	1	R/W	

SOSC1: Low-speed (OSC1) oscillation control (D0) / Power control register (0x40180)

Turns the low-speed (OSC1) oscillation on or off.

Write "1": OSC1 oscillation turned on

Write "0": OSC1 oscillation turned off

Read: Valid

The oscillation of the low-speed (OSC1) oscillation circuit is stopped by writing "0" to SOSC1, and started again by writing "1".

Since a duration of maximum three seconds is required for oscillation to stabilize after the oscillation has been restarted, at least this length of time must pass before the OSC1 clock can be used.

Writing to SOSC1 is allowed only when CLGP[7:0] is set to "0b10010110". Note also that if the CPU is operating using the OSC1 clock, writing "0" to SOSC1 is ignored and the oscillation is not turned off.

At initial reset, SOSC1 is set to "1" (OSC1 oscillation turned on).

CLKCHG: CPU operating clock switch (D2) / Power control register (0x40180)

Selects the CPU operating clock.

Write "1": OSC3 clock

Write "0": OSC1 clock

Read: Valid

The OSC3 clock is selected as the CPU operating clock by writing "1" to CLKCHG, and OSC1 is selected by writing "0". The operating clock can be switched over in this way only when both the high-speed (OSC3) and low-speed (OSC1) oscillation circuits are on. In addition, writing to CLKCHG is effective only when CLGP[7:0] is set to "0b10010110". Immediately after the oscillation circuit has started oscillating, wait for the oscillation to stabilize before switching over the CPU operating clock.

At initial reset, CLKCHG is set to "1" (OSC3 clock).

For controlling the high-speed (OSC3) oscillation circuit, refer to "CLG (Clock Generator)" in the Core Block.

HLT2OP: HALT clock option (D3) / Clock option register (0x40190)

Select a HALT condition (basic mode or HALT2 mode).

Write "1": HALT2 mode

Write "0": Basic mode

Read: Valid

When "1" is written to HLT2OP, the CPU will enter HALT2 mode when the HALT instruction is executed. When "0" is written, the CPU will enter basic mode.

Writing to HLT2OP is allowed only when CLGP[7:0] is set to "0b10010110".

At initial reset, HLT2OP is set to "0" (basic mode).

The following shows the operating status in HALT mode (basic mode and HALT2 mode) and SLEEP mode.

Table III-6.4 Operating Status in Standby Mode

Standby mode		Operating status	Reactivating factor
HALT mode	Basic mode	(1) The CPU clock is stopped. (CPU stop status) (2) BCU clock is supplied. (BCU run status) (3) Clocks for the peripheral circuits maintain the status before entering HALT mode. (run or stop) (4) The high-speed oscillation circuit maintains the status before entering HALT mode. (5) The low-speed oscillation circuit maintains the status before entering HALT mode.	(1) Reset, NMI (2) Enabled (not masked) interrupt factors
	HALT2 mode	(1) The CPU clock is stopped. (CPU stop status) (2) BCU clock is stopped. (BCU stop status) (3) Clocks for the peripheral circuits maintain the status before entering HALT mode. (run or stop) (4) The high-speed oscillation circuit maintains the status before entering HALT mode. (5) The low-speed oscillation circuit maintains the status before entering HALT mode.	
SLEEP mode		(1) The CPU clock is stopped. (CPU stop status) (2) BCU clock is stopped. (BCU stop status) (3) Clocks for the peripheral circuits are stopped. (4) The high-speed oscillation circuit is stopped. (5) The low-speed oscillation circuit maintains the status before entering SLEEP mode.	(1) Reset, NMI (2) Enabled (not masked) input port interrupt factors (3) Clock timer interrupt when the low-speed oscillation circuit is being operated

PF10N: OSC1 external output control (D0) / Clock option register (0x40190)

Turns the low-speed (OSC1) clock output to external devices on or off.

Write "1": On
 Write "0": Off
 Read: Valid

The low-speed (OSC1) clock is output from the FOSC1 pin to an external device by writing "1" to PF10N. However, for this setting to be effective, the P14 pin must be set for the FOSC1 pin by CFP14 and CFEX0, and output must be set by setting IOC14 (D4/0x402D6 <P1 I/O control register>) to "1".

The clock output is disabled by writing "0".

Writing to PF10N is allowed only when CLGP[7:0] is set to "0b10010110".

At initial reset, PF10N is set to "0" (Off).

CLGP7–CLGP0: Power-control register protection flag ([D7:0]) / Power control protection register (0x4019E)

These bits remove the protection against writing to addresses 0x40180 and 0x40190.

Write "0b10010110": Write protection removed
 Write other than the above: No operation (write-protected)
 Read: Valid

Before writing to address 0x40180 or 0x40190, set CLGP[7:0] to "0b10010110" to remove the protection against writing to that address. This clearing of write protection is effective for only one writing, so the bits are cleared to "0b00000000" by one writing. Therefore, CLGP[7:0] must be set each time the protected address is written to.

At initial reset, CLGP is set to "0b00000000" (write-protected).

CFP14: P14 function selection (D4) / P1 function select register (0x402D4)

Selects the pin function of the P14 I/O port.

Write "1": OSC1 clock output pin

Write "0": I/O port pin

Read: Invalid

The P14 pin is set for OSC1 clock output (FOSC1) by writing "1" to CFP14.

When this pin is used as the FOSC1 output pin, also set IOC14 (D4/0x402D6 <P1 I/O control register>) to "1" (output).

At cold start, CFP14 is set to "0" (I/O port pin). At hot start, CFP14 retains its status from before the initial reset.

CFEX0: P12, P14 extended function (D0) / Port function extension register (0x402DF)

Sets whether the function of the P14 pin is to be extended.

Write "1": DCLK output pin

Write "0": P14/FOSC1 output pin

Read: Invalid

When CFEX0 is set to "1", the P14 pin functions as a debug clock DCLK output pin. When CFEX0 = "0", the CFP14 register becomes effective, so the settings of this register determine whether the P14 pin functions as an P14 I/O port or a FOSC1 output pin.

At cold start, CFEX0 is set to "1" (DCLK output pin). At hot start, CFEX0 retains its state from prior to the initial reset.

Programming Notes

- (1) Immediately after the low-speed (OSC1) oscillation circuit is turned on, a certain period of time is required for oscillation to stabilize (3 sec max.). To prevent the device from operating erratically, do not use the clock until its oscillation has stabilized.
- (2) The oscillation circuit used for the CPU operating clock cannot be turned off.
- (3) The CPU operating clock can only be switched over when both the OSC3 and OSC1 oscillation circuits are on. Furthermore, when turning off an oscillation circuit that has become unnecessary as a result of the CPU operating clock switchover, be sure to use separate instructions for switchover and oscillation turnoff. If these two operations are processed simultaneously using one instruction, the CPU may operate erratically.
- (4) If the low-speed (OSC1) oscillation circuit is turned off, all peripheral circuits operated using the OSC1 clock will be inactive.
- (5) If the OSC3 clock is unnecessary, use the OSC1 clock to operate the CPU and turn the high-speed (OSC3) oscillation circuit off. This helps reduce current consumption.
- (6) When the P14/FOSC1/DCLK pin is used as the FOSC1 output pin, set IOC14 (D4/0x402D6) to "1" (output) in addition to the CFP14 (D4/0x402D4) and CFEX0 (D0/0x402DF) settings.

III-7 CLOCK TIMER

Configuration of Clock Timer

The clock timer consists of an 8-bit binary counter that is clocked by a 256-Hz signal derived from the low-speed (OSC1) oscillation clock fosc1, and second, minute, hour, and day counters, allowing all data (128 Hz to 1 Hz, seconds, minutes, hours, and day) to be read out in a software. It can also generate an interrupt using a 32-Hz, 8-Hz, 2-Hz, or 1-Hz (1-second) signal or when a one-minute, one-hour, or one-day count is up, in addition to generating an alarm at a specified time (minute or hour) or day.

The low-speed (OSC1) oscillation circuit and the clock timer can be kept operating even when the CPU and other internal peripheral circuits are placed in standby mode (HALT or SLEEP).

Normally, this clock timer should be used for a clock and various other clocking functions.

Figure III-7.1 shows the structure of the clock timer.

Note: Since the clock timer is driven by a clock originating from the low-speed (OSC1) oscillation circuit, this timer cannot be used unless the low-speed (OSC1) oscillation circuit (32.768 kHz, Typ.) is used.

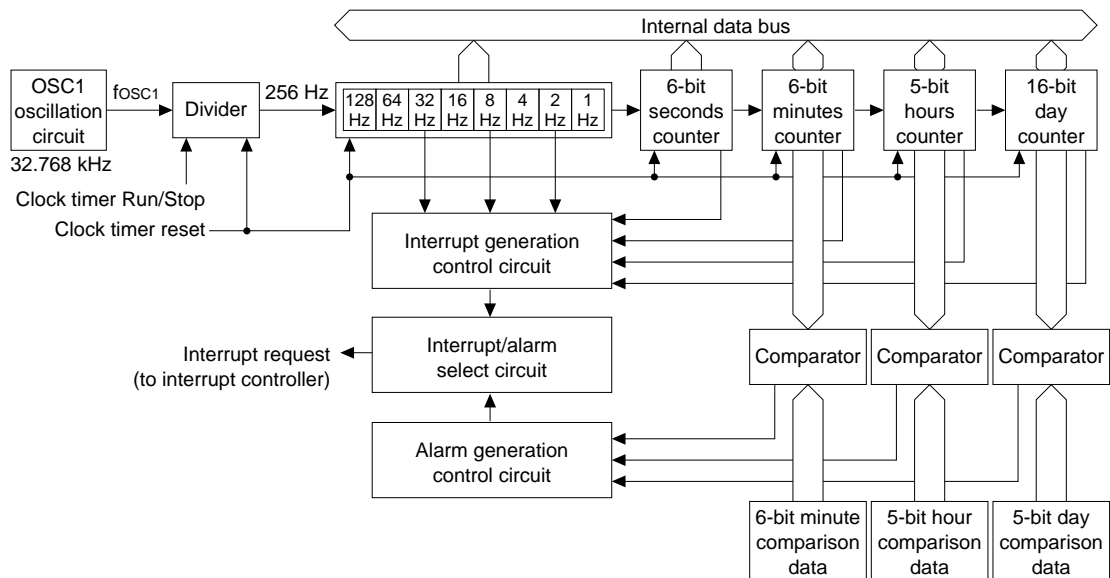


Figure III-7.1 Structure of Clock Timer

Control and Operation of the Clock Timer

Initial setting

At initial reset, the clock timer's counter data, setup contents of alarms, and control bits including RUN/STOP, are not initialized. (This does not include the CPU core power on/off flag TCHVOF or OSC1 auto-off flag TCAOFF.)

Therefore, when using the clock timer, initialize it as follows:

1. Before you start setting up, stop the clock timer and disable the clock timer interrupt.
2. Reset the counters.
3. Preset the minute, hour, and day data (only when necessary).
4. Select an interrupt factor.
5. Select the alarm function.
6. Enable the interrupt.
7. Start the clock timer.

The following shows how to set and control each of the above. For details on interrupt control, refer to "Interrupt Function".

Resetting the counters

Each counter of the clock timer can only be reset to "0" in the software. Note that they are not reset by an initial reset or the auto-off function.

To reset the clock timer, write "1" to TCRST (D1) / Clock timer Run/Stop register (0x40151). Note, however, that this reset input is accepted only when the clock timer is inactive, and is ignored when the timer is operating.

- Notes:**
- The clock timer reset bit TCRST and the clock timer RUN/STOP control bit TCRUN are located at the same address (0x40151). However, the clock timer cannot be reset at the same time it is set to RUN by writing "1" to both. In this case, the reset input is ignored and the timer starts counting up from the counter values then in effect. Always make sure TCRUN = "0" before resetting the timer.
 - When the counters are cleared as the clock timer is reset, an interrupt may be generated depending on the timer settings. Therefore, first disable the clock timer interrupt before resetting the clock timer, and after resetting the clock timer, reset the interrupt factor flag, interrupt factor generation flag, and alarm factor generation flag.

Presetting minute, hour, and day data

The clock timer's minute, hour, and day counters have a data preset function, enabling the desired time and day to be set.

Table III-7.1 Presetting the Counters

Counter	Data register	Preset value
Minute counter	TCHD[5:0] (D[5:0]) / Clock timer minute register (0x40155)	0 to 59
Hour counter	TCDD[4:0] (D[4:0]) / Clock timer hour register (0x40156)	0 to 23
Day counter	TCND[15:0](D[7:0]) / Clock timer day (high-order) register (0x40158) (D[7:0]) / Clock timer day (low-order) register (0x40157)	0 to 65535

When using the clock timer as an RTC, be sure to set these counter values before starting operating of the clock timer. For the day counter, set a number of days starting from the reference day (e.g., January 1, 1990).

RUN/STOP the clock timer

The clock timer starts counting when "1" is written to TCRUN (D0) / Clock timer Run/Stop register (0x40151) and stops counting when "0" is written.

When the clock timer is made to RUN, the 256-Hz clock input is enabled at a falling edge of the low-speed (OSC1) oscillation clock pulse, and the 8-bit binary counter counts up at each falling edge of this 256-Hz clock. Figure III-7.2 shows the operation of the 8-bit binary counter.

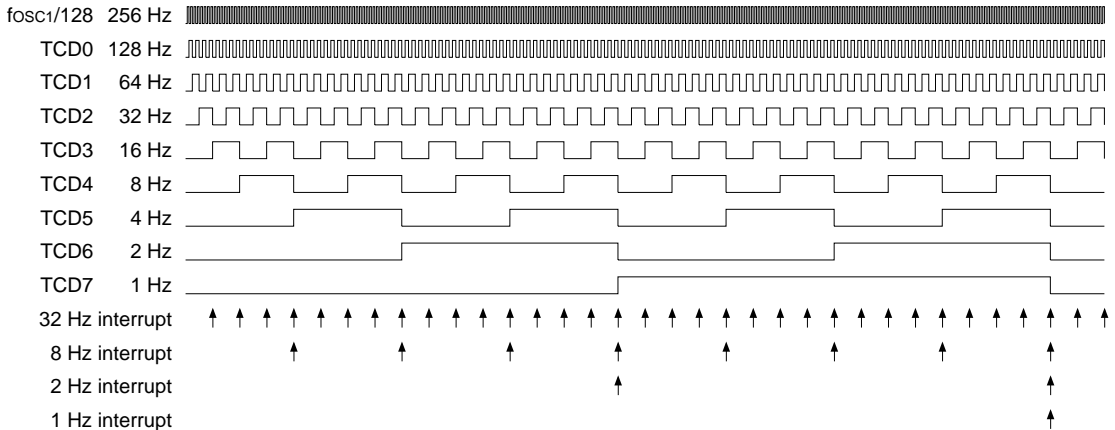


Figure III-7.2 Timing Chart of 8-Bit Binary Counter

The 8-bit binary counter outputs a 1-Hz signal in its final stage.

The second counter counts the 1-Hz signal thus output. When it counts 60 seconds, the counter outputs a 60-second signal and is reset to 0 seconds.

Similarly, the minute and hour counters count 60 minutes and 24 hours, respectively, using the signals output by each preceding counter.

The day counter is a 16-bit binary counter and can count up to 65,536 days using the 24-hour signal output by the hour counter.

One of the following signals output by each counter can be selected to generate an interrupt:

32 Hz, 8 Hz, 2 Hz, 1 Hz (1 second), 1 minute, 1 hour, 1 day

If "0" is written to TCRUN, the clock timer is stopped at a rising edge of the low-speed (OSC1) oscillation clock to prevent device malfunction caused by the concurrent termination of counting (falling edge of the 256-Hz clock).

Even when the clock timer is stopped, each counter retains the data set at that point. When the timer is made to RUN again while in that state, each counter restarts counting from the retained value.

Reading out counter data

The data in each counter can be read out in a software as binary data.

Table III-7.2 Reading Out Counter Data

Counter	Counter data
1 Hz to 128 Hz	TCDD[7:0] (D[7:0]) / Clock timer divider register (0x40153)
Second counter	TCMD[5:0] (D[5:0]) / Clock timer second counter (0x40154)
Minute counter	TCHD[5:0] (D[5:0]) / Clock timer minute counter (0x40155)
Hour counter	TCDD[4:0] (D[4:0]) / Clock timer hour counter (0x40156)
Day counter	TCND[15:0](D[7:0]) / Clock timer day (high-order) counter (0x40158) (D[7:0]) / Clock timer day (low-order) counter (0x40157)

Data is read directly from the counter during operation. For this reason, a counter can overflow while reading data from each counter, so the data thus read may not be exact. For example, if the 8-bit binary counter is read at 0xFF and then overflows before reading the next seconds counter, the value of the seconds counter is its count plus the one second that has elapsed since the 8-bit binary counter was read. To prevent this problem, try reading out each counter several times and make sure data has not been modified.

Setting alarm function

The clock timer has an alarm function, enabling an interrupt to be generated at a specified time and day. This specification can be made in minutes, hours, and days for each alarm or a combination of multiple alarms. Use TCASE[2:0] (D[4:2]) / Clock timer interrupt control register (0x40152) for this specification.

Table III-7.3 Alarm Factor Selection

TCASE2	TCASE1	TCASE0	Alarm factor
X	X	1	Minutes alarm
X	1	X	Hours alarm
1	X	X	Day alarm
0	0	0	None

For example, if TCASE is set to "001", only a minutes alarm is enabled and an alarm is generated at a specified minute every hour. If TCASE is set to "111", an alarm is generated on each specified day at each specified hour and minute. If alarms are not to be used, set TCASE to "000".

An interrupt can be generated every minute, every hour, and every day through the use of the counter's interrupt function instead of the alarm function.

To specify a day, hours, and minutes, use the registers shown below:

To specify minutes: TCCH[5:0] (D[5:0]) / Minute-comparison data register (90x40159) 0 to 59 minutes*

To specify hours: TCCD[4:0] (D[4:0]) / Hour-comparison data register (0x4015A) 0 to 23 hours*

To specify day: TCCN4[4:0] (D[4:0]) / Day-comparison data register 0x4015B) 0 to 31 days after

- * The minute-comparison data register (6 bits) and hour-comparison data register (5 bits) can be set for up to 63 minutes and 31 hours, respectively. Note that even when the data set in these registers exceeds 59 minutes or 23 hours, the data is not considered invalid.

The values set in these registers are compared with those of each counter, and when they match, the alarm factor generation flag TCAF (D0) / Clock timer interrupt control register (0x40152) is set to "1". If clock timer interrupts have been enabled using the interrupt controller, an interrupt is generated when the flag is set.

The day-comparison data register is a 5-bit register, and its value is compared with the five low-order bits of the day counter. Therefore, an alarm can be generated for up to 31 days after the register is set.

Interrupt Function

Clock timer interrupt factors

The clock timer can generate an interrupt using a 32-Hz, 8-Hz, 2-Hz, 1-Hz (1-second), 1-minute, 1-hour, or 1-day signal. The interrupt factor to be used from among these signals can be selected using the interrupt factor selection bit TCISE[2:0] (D[7:5]) / Clock timer interrupt control register (0x40152).

Table III-7.4 Selecting Interrupt Factor

TCISE2	TCISE1	TCISE0	Interrupt factor
1	1	1	None
1	1	0	1 day
1	0	1	1 hour
1	0	0	1 minute
0	1	1	1 Hz
0	1	0	2 Hz
0	0	1	8 Hz
0	0	0	32 Hz

An interrupt factor is generated at intervals of a selected signal (each falling edge of the signal).

If interrupts based on these signals are not to be used, set TCISE to "111".

When a selected interrupt factor is generated, the interrupt factor generation flag TCIF (D1) / Clock timer interrupt control register (0x40152) is set to "1". At the same time, the clock timer interrupt factor flag FCTM (D1) / Port input 4–7, clock timer, A/D interrupt factor flag register (0x40287) also is set to "1". At this time, if the interrupt conditions set by the interrupt control registers are met, an interrupt to the CPU is generated.

An interrupt can be generated on a specified alarm day at a specified time as described in the preceding section.

Interrupts generated by a signal and those generated by an alarm can both be used. However, since the clock timer has only one interrupt factor flag, it is the same interrupt that is generated by the timer. Therefore, if both types of interrupts are used, when an interrupt occurs, read the interrupt factor generation flag TCIF and alarm factor generation flag TCAF to determine which factor has generated the interrupt.

Once the factor generation flag is set to "1", it remains set until it is reset by writing "1" in the software. After confirming that the flag is set, write "1" to reset it.

The interrupt factor generation flag TCIF and alarm factor generation flag TCAF should be reset after at least 4 ms have passed from generation of an interrupt or an alarm.

Note: To prevent generation of an unwanted interrupt, disable the clock timer interrupt before selecting the interrupt and alarm factors. Then, before reenabling the interrupt, reset each factor generation flag and the interrupt factor flag.

Control registers of the interrupt controller

The following lists the clock timer interrupt control registers:

Interrupt factor flag: FCTM (D1) / Port input 4–7, clock timer, A/D interrupt factor flag register (0x40287)

Interrupt enable: ECTM (D1) / Port input 4–7, clock timer, A/D interrupt enable register (0x40277)

Interrupt level: PCTM[2:0] (D[2:0]) / Clock timer interrupt priority register (0x4026B)

When an interrupt factor occurs, the clock timer sets the interrupt factor flag to "1" as described above. At this time, if the interrupt enable register bit is set to "1", an interrupt request is generated.

Interrupts can be disabled by leaving the interrupt enable register bit reset to "0". The interrupt factor flag is always set to "1" when an interrupt factor is generated, regardless of the setting of the interrupt enable register (even when it is set to "0").

The interrupt priority register sets the priority levels (0 to 7) of interrupts. An interrupt request to the CPU is accepted on the condition that no other interrupt request has been generated that is of a higher priority.

It is only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the clock timer interrupt level set by the interrupt priority register that a clock timer interrupt request is actually accepted by the CPU.

For details on these interrupt control registers, as well as the device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

Note that the clock timer interrupt factor does not have a function to invoke an intelligent DMA.

Trap vectors

The trap vector addresses for the clock-timer interrupt by default are set as shown below:

When BTA3 = high, 0x0080104

When BTA3 = low, 0x0C00104

The trap table base address can be changed using the TTBR registers (0x48134 to 0x48137).

Examples of Use of Clock Timer

The following shows examples of use of the clock timer and how to control the timer in each case.

To use the clock timer as a timer/counter

Example in which while the CPU is inactive, the clock timer is kept operating in order to start again the CPU after a specified length of time has elapsed (e.g., three days):

1. Make sure the low-speed (OSC1) oscillation circuit is oscillating stably (SOSC1 = "1").
Wait for approximately three seconds after the oscillation starts for its oscillation to stabilize.
2. Disable the clock timer interrupt using the interrupt controller (ECTM = "0").
3. Stop the clock timer and set "3 days" in the day-comparison register (TCRUN = "0", TCCN = "3").
4. Choose a "day-specified alarm" using the alarm-factor select bit and set "none" in the interrupt-factor select bit (TCASE = "100", TCISE = "111").
5. Reset the interrupt factor and alarm factor generation flags (FCTM = "0", TCAF = "0").
6. Reenable the clock timer interrupt using the interrupt controller (ECTM = "1").
7. Switch the CPU operating clock to the low-speed (OSC1) clock (CLKCHG = "0").
8. Turn off the high-speed (OSC3) oscillation circuit (SOSC3 = "0").
9. Reset the clock timer (TCRST = "0").
10. Start the clock timer (TCRUN = "1").
11. Execute the halt instruction to stop the CPU.

:

Wait until an interrupt is generated by a day-specified alarm from the clock timer. When an interrupt occurs, the CPU starts up using the OSC1 clock.

12. If necessary, turn on the high-speed (OSC3) oscillation circuit and change the CPU operating clock back to the OSC3 clock.

In the above example, if the device is reset before a three-day period has elapsed, the device operates as follows:

- The CPU starts up using the OSC3 clock.
- The clock timer counters are not reset. They remain in the RUN state.

The time during which the CPU has been idle can be checked by reading out the clock timer counters.

For using the clock timer as RTC

Example in which the clock timer is kept operating and an alarm is generated at 10:00 A.M. every day:

1. Disable the clock timer interrupt using the interrupt controller (ECTM = "0").
2. Stop the clock timer (TCRUN = "0").
3. Reset the clock timer (TCRST = "1").
4. Set the current day and time in the minute (TCHD), hour (TCDD), and day (TCND) counters. For the day counter, set a number of days starting from the reference day (e.g., January 1, 1990). When the count is read, it is converted into the current date by the software.
5. Set "10:00" in the hour-compare register (TCCD = "0x0A").
6. Select an a "hour-specified alarm" using the alarm factor select bit, and set "none" in the interrupt factor select bit (TCASE = "010", TCISE = "111").
7. Reset the interrupt factor and alarm-factor generation flags (FCTM = "1", TCAF = "0").
8. Reenable the clock timer interrupt using the interrupt controller (ECTM = "1").
9. Start the clock timer (TCRUN = "1").

:

The clock timer is made to generate an interrupt at 10:00 every day by an hour-specified alarm.

:

In the above example, if any interrupt factor other than an alarm is selected, an interrupt is also generated by that interrupt factor. To determine which factor caused the interrupt generated, read the interrupt factor generation flag TCIF and alarm factor generation flag TCAF. If TCAF is set to 1, the interrupt has been caused by an alarm. If you select an interrupt factor (other than a 1-day factor) along with the hour-specified alarm, the selected interrupt factor occurs at the same time as the alarm factor.

I/O Memory of Clock Timer

Table III-7.5 shows the control bits of the clock timer.

Table III-7.5 Control Bits of Clock Timer

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks						
Clock timer Run/Stop register	0040151 (B)	D7-2	–	reserved	–	–	–	0 when being read.						
		D1	TCRST	Clock timer reset	1 Reset 0 Invalid	X	W	0 when being read.						
		D0	TCRUN	Clock timer Run/Stop control	1 Run 0 Stop	X	R/W							
Clock timer interrupt control register	0040152 (B)	D7	TCISE2	Clock timer interrupt factor selection	TCISE[2:0] Interrupt factor	X	R/W							
		D6	TCISE1		1 1 1 None	X								
		D5	TCISE0		1 1 0 Day	X								
					1 0 1 Hour									
					1 0 0 Minute									
					0 1 1 1 Hz									
					0 1 0 2 Hz									
				0 0 1 8 Hz										
		0 0 0 32 Hz												
D4	TCASE2	Clock timer alarm factor selection	TCASE[2:0] Alarm factor		X		R/W							
D3	TCASE1		1 X X Day		X									
D2	TCASE0		X 1 X Hour		X									
			X X 1 Minute											
		0 0 0 None												
D1	TCIF	Interrupt factor generation flag	1 Generated 0 Not generated			X	R/W	Reset by writing 1.						
D0	TCAF	Alarm factor generation flag	1 Generated 0 Not generated	X		R/W	Reset by writing 1.							
Clock timer divider register	0040153 (B)	D7	TCD7	Clock timer data 1 Hz		1 High 0 Low	X	R						
		D6	TCD6	Clock timer data 2 Hz	1 High 0 Low	X	R							
		D5	TCD5	Clock timer data 4 Hz	1 High 0 Low	X	R							
		D4	TCD4	Clock timer data 8 Hz	1 High 0 Low	X	R							
		D3	TCD3	Clock timer data 16 Hz	1 High 0 Low	X	R							
		D2	TCD2	Clock timer data 32 Hz	1 High 0 Low	X	R							
		D1	TCD1	Clock timer data 64 Hz	1 High 0 Low	X	R							
		D0	TCD0	Clock timer data 128 Hz	1 High 0 Low	X	R							
Clock timer second register	0040154 (B)	D7-6	–	reserved	–	–	–	0 when being read.						
		D5	TCMD5	Clock timer second counter data TCMD5 = MSB TCMD0 = LSB	0 to 59 seconds	X	R							
		D4	TCMD4			X								
		D3	TCMD3			X								
		D2	TCMD2			X								
		D1	TCMD1			X								
		D0	TCMD0			X								
Clock timer minute register	0040155 (B)	D7-6		–	reserved	–		–					–	0 when being read.
		D5		TCHD5	Clock timer minute counter data TCHD5 = MSB TCHD0 = LSB	0 to 59 minutes	X	R/W						
		D4		TCHD4			X							
		D3		TCHD3			X							
		D2		TCHD2			X							
		D1		TCHD1			X							
		D0	TCHD0	X										
Clock timer hour register	0040156 (B)	D7-5		–	reserved	–						–	–	0 when being read.
		D4		TCDD4	Clock timer hour counter data TCDD4 = MSB TCDD0 = LSB	0 to 23 hours		X				R/W		
		D3		TCDD3				X						
		D2		TCDD2				X						
		D1		TCDD1				X						
		D0		TCDD0			X							
Clock timer day (low-order) register	0040157 (B)	D7		TCND7	Clock timer day counter data (low-order 8 bits) TCND0 = LSB	0 to 65535 days (low-order 8 bits)	X					R/W		
		D6		TCND6			X							
		D5		TCND5			X							
		D4		TCND4			X							
		D3		TCND3			X							
		D2	TCND2	X										
		D1	TCND1	X										
		D0	TCND0	X										
Clock timer day (high-order) register	0040158 (B)	D7	TCND15	Clock timer day counter data (high-order 8 bits) TCND15 = MSB	0 to 65535 days (high-order 8 bits)	X							R/W	
		D6	TCND14			X								
		D5	TCND13			X								
		D4	TCND12			X								
		D3	TCND11			X								
		D2	TCND10			X								
		D1	TCND9			X								
		D0	TCND8			X								

III PERIPHERAL BLOCK: CLOCK TIMER

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Clock timer minute comparison register	0040159 (B)	D7-6	–	reserved	–	–	–	0 when being read.	
		D5	TCCH5	Clock timer minute comparison data	0 to 59 minutes	X	R/W		
		D4	TCCH4		(Note) Can be set within 0–63.	X			
		D3	TCCH3	TCCH5 = MSB		X			
		D2	TCCH2	TCCH0 = LSB		X			
		D1	TCCH1			X			
		D0	TCCH0			X			
Clock timer hour comparison register	004015A (B)	D7-5	–	reserved	–	–	–	0 when being read.	
		D4	TCCD4	Clock timer hour comparison data	0 to 23 hours	X	R/W		
		D3	TCCD3	TCCD4 = MSB	(Note) Can be set within 0–31.	X			
		D2	TCCD2	TCCD0 = LSB		X			
		D1	TCCD1			X			
		D0	TCCD0			X			
Clock timer day comparison register	004015B (B)	D7-5	–	reserved	–	–	–	0 when being read.	
		D4	TCCN4	Clock timer day comparison data	0 to 31 days	X	R/W	Compared with TCND[4:0].	
		D3	TCCN3	TCCN4 = MSB		X			
		D2	TCCN2	TCCN0 = LSB		X			
		D1	TCCN1			X			
		D0	TCCN0			X			
Clock timer interrupt priority register	004026B (B)	D7-3	–	reserved	–	–	–	Writing 1 not allowed.	
		D2	PCTM2	Clock timer interrupt level	0 to 7	X	R/W		
		D1	PCTM1			X			
		D0	PCTM0			X			
Port input 4–7, clock timer, A/D interrupt enable register	0040277 (B)	D7-6	–	reserved	–	–	–	0 when being read.	
		D5	EP7	Port input 7	1 Enabled	0 Disabled	0	R/W	
		D4	EP6	Port input 6			0	R/W	
		D3	EP5	Port input 5			0	R/W	
		D2	EP4	Port input 4			0	R/W	
		D1	ECTM	Clock timer			0	R/W	
		D0	EADE	A/D converter			0	R/W	
Port input 4–7, clock timer, A/D interrupt factor flag register	0040287 (B)	D7-6	–	reserved	–	–	–	0 when being read.	
		D5	FP7	Port input 7	1 Factor is generated	0 No factor is generated	X	R/W	
		D4	FP6	Port input 6			X	R/W	
		D3	FP5	Port input 5			X	R/W	
		D2	FP4	Port input 4			X	R/W	
		D1	FCTM	Clock timer			X	R/W	
		D0	FADE	A/D converter			X	R/W	

TCRST: Clock timer reset (D1) / Clock timer Run/Stop register (0x40151)

Resets the clock timer.

Write "1": The clock timer is reset

Write "0": Invalid

Read: Always "0"

The clock timer is reset by writing "1" to TCRST when the timer is inactive. All timer counters are cleared to "0". The clock timer cannot be reset when in the RUN state, nor can it be reset at the same time it is made to RUN through the execution of one write to address 0x40151. (The clock timer is started, but not reset.) In this case, first reset the clock timer and then use another instruction to RUN the clock timer. When the counters are cleared as the clock timer is reset, an interrupt may be generated, depending on the register settings. Therefore, before resetting the clock timer, first disable the clock timer interrupt, and after resetting the clock timer, reset the interrupt factor flag and the interrupt factor and alarm factor generation flags.

Writing "0" to TCRST results in No Operation. Since this TCRST is a write-only bit, its value when read is always "0".

The clock timer is not reset by an initial reset.

TCRUN: Clock timer RUN/STOP control (D0) / Clock timer Run/Stop register (0x40151)

Controls the RUN/STOP of the clock timer.

- Write "1": RUN
- Write "0": STOP
- Read: Valid

The clock timer is made to start counting by writing "1" to the TCRUN register and made to stop by writing "0". The timer data is retained even in the STOP state. The timer can also be made to start counting from the retained data by changing its state from STOP to RUN.

The TCRUN register is not initialized at initial reset.

TCDD7–TCDD0: 1–128 Hz counter data (D[7:0]) / Clock timer divider register (0x40153)

TCMD5–TCMD0: Second counter data (D[5:0]) / Clock timer second register (0x40154)

TCHD5–TCHD0: Minute counter data (D[5:0]) / Clock timer minute register (0x40155)

TCDD4–TCDD0: Hour counter data (D[4:0]) / Clock timer hour register (0x40156)

TCND15–TCND0: Day counter data (D[7:0]) / Clock timer day (high-order) register (0x40158)
(D[7:0]) / Clock timer day (low-order) register (0x40157)

Data can be read out from each counter.

The minute, hour, and day counters allow data to be written to, in addition to being read out.

The 1–128 Hz counter and seconds counter are read-only, so writing to these registers is ignored.

The unused high-order bits at each address of the second, minute, and hour counter data are always "0" when read out.

The counter data is not initialized at initial reset.

TCCH5–TCCH0: Minute-comparison data (D[5:0]) / Clock timer minute-comparison register (0x40159)

TCCD4–TCCD0: Hour-comparison data (D[4:0]) / Clock timer hour-comparison register (0x4015A)

TCCN4–TCCN0: Day-comparison data (D[4:0]) / Clock timer day-comparison register (0x4015B)

Set a day on which and a time at which an alarm is to be generated.

The comparison data register corresponding to the alarm factor selected using the TCASE register is compared with the counter data, and when the data matches, an alarm interrupt request is generated.

The day-comparison data is compared with the 5 low-order bits of the day counter.

Each register can be read out.

These registers are not initialized at initial reset.

TCISE2–TCISE0: Interrupt factor selection (D[7:5]) / Clock timer interrupt control register (0x40152)

Selects the factor for which the clock timer interrupt is to be generated.

Table III-7.6 Selecting Interrupt Factor

TCISE2	TCISE1	TCISE0	Interrupt factor
1	1	1	None
1	1	0	1 day
1	0	1	1 hour
1	0	0	1 minute
0	1	1	1 Hz
0	1	0	2 Hz
0	0	1	8 Hz
0	0	0	32 Hz

When the clock timer interrupt is enabled, an interrupt is generated cyclically at each falling edge of the selected signal. If you the interrupt caused by these factors is not be used set TCISE to "111".

TCISE is not initialized at initial reset.

TCASE2–TCASE0: Alarm factor select register (D[4:2]) / Clock timer interrupt control register (0x40152)

Selects the factor for which an alarm is to be generated.

Table III-7.7 Selecting Alarm Factor

TCASE2	TCASE1	TCASE0	Alarm factor
X	X	1	Minute alarm
X	1	X	Hour alarm
1	X	X	Day alarm
0	0	0	None

Use the TCASE2, TCASE1, and TCASE0 bits to select a day, hour, and minute alarm, respectively. It is therefore possible to select multiple alarm factors. When one of these bits is set to "1", the contents of the comparison data register that corresponds to the selected alarm factor is compared with the counter. If the comparison data of all selected alarm factors matches the counter data, an alarm interrupt request is generated. The comparison data register from which the alarm factor is unselected by writing "0" is not compared with the counter data. TCASE is not initialized at initial reset.

TCIF: Interrupt factor generation flag (D1) / Clock timer interrupt control register (0x40152)

Indicates whether an interrupt factor has occurred.

- Read "1": Interrupt factor has occurred
- Read "0": No interrupt factor has occurred
- Write "1": Flag is reset
- Write "0": Invalid

TCIF is set to "1" when an interrupt factor selected using TCISE occurs. Since there is only one source for the clock timer interrupt, use this flag to differentiate it from interrupts caused by an alarm.

Once set to "1", TCIF remains set until it is reset by writing "1".

TCIF is not initialized at initial reset.

This bit does not affect generation of an interrupt even if it is set to "1" or "0".

TCAF: Alarm factor generation flag (D0) / Clock timer interrupt control register (0x40152)

Indicates whether an alarm factor has occurred.

- Read "1": Alarm factor has occurred
- Read "0": No alarm factor has occurred
- Write "1": Flag is reset
- Write "0": Invalid

TCAF is set to "1" when all alarm factors selected using the TCASE register occur. Since there is only one source for the clock timer interrupt, use this flag to differentiate it from interrupts due to other interrupt factors.

Once set to "1", TCAF remains set until it is reset by writing "1".

TCAF is not initialized at initial reset.

This bit does not affect generation of an alarm even if it is set to "1" or "0".

PCTM2–PCTM0: Clock timer interrupt level (D[2:0]) / Clock timer interrupt priority register (0x4026B)

Sets the priority level of the clock timer interrupt between 0 and 7.

At initial reset, PCTM becomes indeterminate.

ECTM: Clock timer interrupt enable (D1) / Port input 4–7, clock timer, A/D interrupt enable register (0x40277)

Enables or disables generation of an interrupt to the CPU.

Write "1": Interrupt enabled
 Write "0": Interrupt disabled
 Read: Valid

This bit controls the clock timer interrupt. The interrupt is enabled by setting ECTM to "1" and is disabled by setting it to "0".

At initial reset, ECTM is set to "0" (interrupt disabled).

FCTM: Clock timer interrupt factor flag (D1) / Port input 4–7, clock timer, A/D interrupt factor flag register (0x40287)

Indicates whether the clock timer interrupt factor has occurred.

When read

Read "1": Interrupt factor has occurred
 Read "0": No interrupt factor has occurred

When written using the reset-only method (default)

Write "1": Interrupt factor flag is reset
 Write "0": Invalid

When written using the read/write method

Write "1": Interrupt flag is set
 Write "0": Interrupt flag is reset

FCTM is set to "1" when the selected interrupt factor or alarm factor occurs.

At this time, if the following conditions are met, an interrupt to the CPU is generated:

1. The corresponding interrupt enable register bit is set to "1".
2. No other interrupt request of a higher interrupt priority is generated.
3. The IE bit of the PSR is set to "1" (interrupt enabled).
4. The corresponding interrupt priority register is set to a value higher than the CPU interrupt level (IL).

The interrupt factor flag is always set to "1" when an interrupt factor occurs, no matter how the interrupt enable and interrupt priority registers are set.

For the next interrupt to be accepted after an interrupt has occurred, it is necessary that the interrupt factor flag be reset, and that the PSR be set again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can be reset only by writing to it in the software. Note that if the PSR is set again to accept generated interrupts (or if the reti instruction is executed) without the interrupt factor flag being reset, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

The FCTM flag becomes indeterminate at initial reset, so be sure to reset it in the software.

Programming Notes

- (1) The low-speed (OSC1) oscillation circuit, which is the clock source for the clock timer, requires a maximum of three seconds for its oscillation to stabilize after it is started up. Therefore, immediately after power-on, wait until the oscillation stabilizes before starting the clock timer.
- (2) At initial reset, the clock timer counter data, the setup contents of alarms, and control bits, including RUN/STOP, are not initialized. Therefore, always initialize the clock timer in the software following power-on.
- (3) The clock timer reset bit TCRST and the clock timer RUN/STOP control bit TCRUN are located at the same address (0x40151). However, the clock timer cannot be reset at the same time it is set to RUN by writing "1" to both. In this case, the reset input is ignored and the timer starts counting up from the counter values then in effect. When resetting the timer, always make sure TCRUN = "0" (timer stopped).
- (4) When the counters are cleared as the clock timer is reset, an interrupt may be generated depending on the register settings. Therefore, before resetting the clock timer, first disable the clock timer interrupt and, after resetting the clock timer, reset the interrupt factor flag and the interrupt factor generation and alarm factor generation flags.
- (5) To prevent generation of an unwanted interrupt, disable the clock timer interrupt before selecting the interrupt and alarm factors. Then, before reenabling the interrupt, reset each factor generation flag and the interrupt factor flag.
- (6) The interrupt factor flag (FCTM) becomes indeterminate at initial reset. To prevent generation of an unwanted interrupt, be sure to reset the flag in a program.
- (7) To prevent regeneration of interrupts with the same factor after an interrupt has occurred, be sure to reset the interrupt factor flag (FCTM) before setting the PSR again or executing the reti instruction.

III-8 SERIAL INTERFACE

Configuration of Serial Interfaces

Features of Serial Interfaces

The Peripheral Block contains two channels (Ch.0, Ch.1) of serial interfaces, the features of which are described below. The functions of these two serial interfaces are the same.

- A clock-synchronized or asynchronous mode can be selected for the transfer method.

Clock-synchronized mode

Data length: 8 bits, fixed (No start, stop, and parity bits)

Receive error: An overrun error can be detected.

Asynchronous mode

Data length: 7 or 8 bits, selectable

Receive error: Overrun, framing, or parity errors can be detected.

Start bit: 1 bit, fixed

Stop bit: 1 or 2 bits, selectable

Parity bit: Even, odd, or none; selectable

Since the transmit and receive units are independent, full-duplex communication is possible.

- Baud-rate setting: Any desired baud rate can be set by selecting the prescaler's division ratio, setting the 8-bit programmable timer, or using external clock input (asynchronous mode only).
- The receive and transmit units are constructed with a double-buffer structure, allowing for successive receive and transmit operations.
- Data transfers using IDMA or HSDMA are possible.
- Three types of interrupts (transmit data empty, receive data full, and receive error) can be generated.

Figure III-8.1 shows the configuration of the serial interface (one channel).

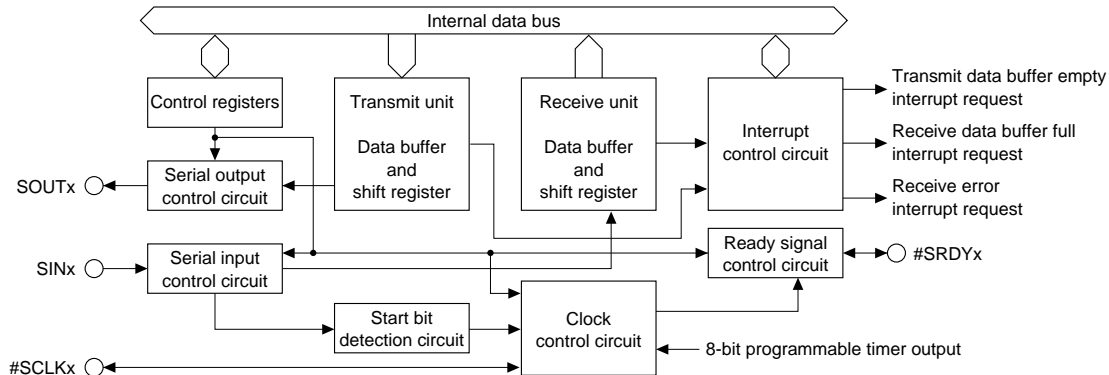


Figure III-8.1 Configuration of Serial Interface

Note: Ch.0 and Ch.1 have the same configuration and the same function. The signal and control bit names are suffixed by a 0 or a 1 to indicate the channel number, enabling discrimination between channels 0 and 1. In this manual, however, channel numbers 0 and 1 are replaced with "x" unless discrimination is necessary, because explanations are common to both channels.

I/O Pins of Serial Interface

Table III-8.1 lists the I/O pins used by the serial interface.

Table III-8.1 Serial-Interface Pin Configuration

Pin name	I/O	Function	Function select bit
P00/SIN0	I/O	I/O port / Serial IF Ch.0 data input	CFP00(D0)/P0 function select register(0x402D0)
P01/SOUT0	I/O	I/O port / Serial IF Ch.0 data output	CFP01(D1)/P0 function select register(0x402D0)
P02/#SCLK0	I/O	I/O port / Serial IF Ch.0 clock input/output	CFP02(D2)/P0 function select register(0x402D0)
P03/#SRDY0	I/O	I/O port / Serial IF Ch.0 ready input/output	CFP03(D3)/P0 function select register(0x402D0)
P04/SIN1/ #DMAACK2	I/O	I/O port / Serial IF Ch.1 data input	CFP04(D4)/P0 function select register(0x402D0) CFEX4(D4)/Port function extension register(0x402DF)
P05/SOUT1/ #DMAEND2	I/O	I/O port / Serial IF Ch.1 data output	CFP05(D5)/P0 function select register(0x402D0) CFEX5(D5)/Port function extension register(0x402DF)
P06/#SCLK1/ #DMAACK3	I/O	I/O port / Serial IF Ch.1 clock input/output	CFP06(D6)/P0 function select register(0x402D0) CFEX6(D6)/Port function extension register(0x402DF)
P07/#SRDY1/ #DMAEND3	I/O	I/O port / Serial IF Ch.1 ready input/output	CFP07(D7)/P0 function select register(0x402D0) CFEX7(D7)/Port function extension register(0x402DF)

SINx (serial-data input pin)

This pin is used to input serial data to the device, regardless of the transfer mode.

SOUTx (serial-data output pin)

This pin is used to output serial data from the device, regardless of the transfer mode.

#SCLKx (clock input/output pin)

This pin is used to input or output a clock.

In the clock-synchronized slave mode, it is used as a clock input pin; in the clock-synchronized master mode, it is used as a clock output pin.

In the asynchronous mode, this pin is used as clock input when an external clock is used. This pin is not used when the internal clock is used, so it can be used as an I/O port.

#SRDYx (ready-signal input/output pin)

This pin is used to input or output the ready signal that is used in the clock-synchronized mode.

In the clock-synchronized slave mode, it is used as a ready-signal output pin; in the clock-synchronized master mode, it is used as a ready-signal input pin.

This pin is not used in the asynchronous mode, so it can be used as an I/O port.

Method for setting the serial-interface input/output pins

All of the pins used in the serial interface are shared with I/O ports. At cold start, they are all set for I/O port pins P0x (function select bit CFP0x = "0"). When using the serial interface, write "1" to CFP0x for the pin to be used in accordance with the channel and transfer mode used.

Furthermore, the P04–P07 ports that are used for channel 1 may be used for channels 2 and 3 of HSDMA.

When using the serial interface Ch.1, fix CFEX[7:4] at "0" (default).

At hot start, the pins retain their status from prior to the reset.

Setting Transfer Mode

The transfer mode of the serial interface can be set using SMDx[1:0] individually for each channel as shown in Table III-8.2 below.

Table III-8.2 Transfer Mode

SMDx1	SMDx0	Transfer mode
1	1	8-bit asynchronous mode
1	0	7-bit asynchronous mode
0	1	Clock-synchronized slave mode
0	0	Clock-synchronized master mode

At initial reset, SMDx becomes indeterminate, so be sure to initialize it in the software.

When using the IrDA interface, set the transfer mode for the asynchronous 7-bit or asynchronous 8-bit mode.

The input/output pins are configured differently, depending on the transfer mode. The pin configuration in each mode is shown in Table III-8.3.

Table III-8.3 Pin Configuration by Transfer Mode

Transfer mode	SINx (P00/P04)	SOUTx (P01/P05)	#SCLKx (P02/P06)	#SRDYx (P03/P07)
8-bit asynchronous	Data input	Data output	Clock input/P port	P port
7-bit asynchronous	Data input	Data output	Clock input/P port	P port
Clock-synchronized slave	Data input	Data output	Clock input	Ready output
Clock-synchronized master	Data input	Data output	Clock output	Ready input

All four pins are used in the clock-synchronized mode.

In the asynchronous mode, since #SRDYx is unused, P03 (or P07) can be used as an I/O (P) port. In addition, when an external clock is not used, P02 (or P06) can also be used as an I/O port.

The I/O control and data registers for the I/O ports used in the serial interface can be used as general-purpose read/write registers.

Note: To enable the IrDA interface to be set, IRMDx[1:0] (D[1:0]) / Serial I/F Ch.0 IrDA register (0x401E4) or Serial I/F Ch.1 IrDA register (0x401E9) is provided. Since these bits become indeterminate at initial reset, be sure to initialize them by writing "00" when using as the normal interface or "10" when using as the IrDA interface.

Clock-Synchronized Interface

Outline of Clock-Synchronized Interface

In the clock-synchronized transfer mode, 8 bits of data are synchronized to the common clock on both the transmit and receive sides when the data is transferred. Since the transmit and receive units both have a double-buffer structure, successive transmit and receive operations are possible. Since the clock line is shared between the transmit and receive units, the communication mode is half-duplex.

Master and slave modes

Either the clock-synchronized master mode or the clock-synchronized slave mode can be selected using SMDx[1:0].

Clock-synchronized master mode (SMDx[1:0] = "00")

In this mode, clock-synchronized 8-bit serial transfers, in which the serial interface functions as the master, can be performed using the internal clock to synchronize the operation of the internal shift registers. The synchronizing clock is output from the #SCLKx pin, enabling an external (slave side) serial input/output device to be controlled. The #SRDYx pin is also used to input a signal that indicates whether the external serial input/output device is ready to transmit or receive (when ready in a low level).

Clock-synchronized slave mode (SMDx[1:0] = "01")

In this mode, clock-synchronized 8-bit serial transfers, in which the serial interface functions as a slave, can be performed using the synchronizing clock that is supplied by an external (master side) serial input/output device.

The synchronizing clock is input from the #SCLKx pin for use as the synchronizing clock of the serial interface. In addition, a #SRDYx signal indicating whether the serial interface is ready to transmit or receive (when ready in a low level) is output from the #SRDYx pin.

Figure III-8.2 shows an example of how the input/output pins are connected in the clock-synchronized mode.

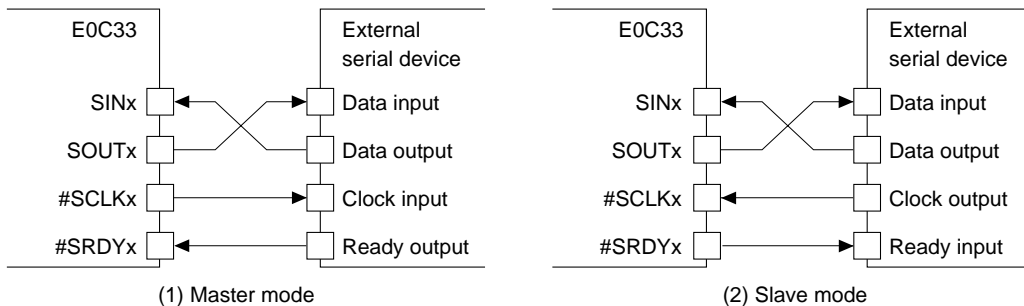


Figure III-8.2 Example of Connection in Clock-Synchronized Mode

Clock-synchronized transfer data format

In clock-synchronized transfers, the data format is fixed as shown below.

- Data length: 8 bits
- Start bit: None
- Stop bit: None
- Parity bit: None

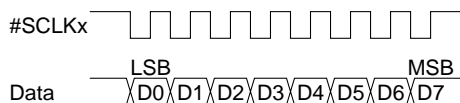


Figure III-8.3 Clock-Synchronized Transfer Data Format

Serial data is transmitted and received starting with the LSB.

Setting Clock-Synchronized Interface

When performing clock-synchronized transfers via the serial interface, the following settings must be made before data transfer is actually begun:

1. Setting input/output pins
2. Setting the interface mode
3. Setting the transfer mode
4. Setting the input clock
5. Setting interrupts and IDMA/HSDMA

The following explains the content of each setting. For details on interrupt/DMA settings, refer to "Serial Interface Interrupts and DMA".

Note: Always make sure the serial interface is inactive (TXENx and RXENx = "0") before these settings are made. A change of settings during operation may cause a malfunction.

Setting input/output pins

All four pins—SINx, SOUTx, #SCLKx, and #SRDYx—are used in the clock-synchronized mode. When using Ch.0, set CFP0[3:0] (D[3:0]) / P0 function select register (0x402D0) to "1111" and when using Ch.1, set CFP0[7:4] (D[7:4]) / P0 function select register (0x402D0) to "1111". (It is possible to use both channels.)

Setting the interface mode

IRMDx[1:0] (D[1:0]) / Serial I/F Ch.0 IrDA register (0x401E4) or Serial I/F Ch.1 IrDA register (0x401E9) is used to set the interface mode (normal or IrDA interface). Write "00" to IRMDx[1:0] to choose the ordinary interface. Since IRMDx[1:0] becomes indeterminate at initial reset, it must be initialized.

Setting the transfer mode

Use SMDx to set the transfer mode of the serial interface as described earlier. When using the serial interface as the master for clock-synchronized transfer, set SMDx[1:0] to "00"; when using the serial interface as a slave, set SMDx[1:0] to "01".

Setting the input clock

- **Clock-synchronized master mode**

This mode operates using an internally derived clock. The clock source for each channel is as follows:

Ch.0: A clock output by 8-bit programmable timer 2

Ch.1: A clock output by 8-bit programmable timer 3

Therefore, in order for the serial interface to be used in the clock-synchronized master mode, the following conditions must be met:

1. The prescaler is feeding a clock to 8-bit programmable timer 2 (3).
2. The 8-bit programmable timer 2 (3) is generating a clock.

Any desired clock frequency can be selected by setting the division ratio of the prescaler and the reload data of the 8-bit programmable timer as necessary. The relationship between the contents of these settings and the transfer rate is expressed by Eq. 1 below.

To ensure that the duty ratio of the clock to be fed to the serial interface is 50%, the 8-bit programmable timer further divides the underflow signal frequency by 2 internally. This 1/2 frequency division is factored into Eq. 1.

$$RLD = \frac{f_{PSCIN} \times dr}{2 \times bps} - 1 \quad (\text{Eq. 1})$$

RLD: Reload data register setup value of the 8-bit programmable timer

f_{PSCIN}: Prescaler input clock frequency (Hz)

bps: Transfer rate (bits/second)

dr: Division ratio of the prescaler

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Note: The division ratios selected by the prescaler differ between 8-bit programmable timers 2 and 3, so be careful when setting the ratio.

8-bit programmable timer 2: 1/2, 1/4, 1/8, 1/32, 1/64, 1/2048, 1/4096

8-bit programmable timer 3: 1/2, 1/4, 1/8, 1/32, 1/64, 1/128, 1/256

For details on how to control the prescaler and 8-bit programmable timers, refer to "Prescaler", and "8-Bit Programmable Timers".

The serial-interface control register contains an SSCKx bit to select the clock source used for the asynchronous mode. Although this bit does not affect the clock in the clock-synchronized mode, its content becomes indeterminate at initial reset. Therefore, be sure to initialize this bit by writing "0" (Internal clock), even when using the serial interface in the clock-synchronized master mode.

- **Clock-synchronized slave mode**

This mode operates using the clock that is output by the external master. This clock is input from the #SCLK pin.

Therefore, there is no need to control the prescaler or 8-bit programmable timer.

Initialize SSCKx by writing "1" (#SCLKx).

Control and Operation of Clock-Synchronized Transfer

Transmit control

(1) Enabling transmit operation

Use the transmit-enable bit TXENx for transmit control.

Ch.0 transmit-enable: TXEN0 (D7) / Serial I/F Ch.0 control register (0x401E3)

Ch.1 transmit-enable: TXEN1 (D7) / Serial I/F Ch.1 control register (0x401E8)

When transmit is enabled by writing "1" to this bit, the clock input to the shift register is enabled (ready for input), thus allowing for data to be transmitted. The synchronizing clock input/output of the #SCLKx pin is also enabled (ready for input/output).

Transmit is disabled by writing "0" to TXENx.

After the P0 function select register is set for the serial interface, the I/O direction of the #SRDY and #SCLK pins are changed at follows:

#SRDY: When transmission is enabled in slave mode, P03 (P07) enters output mode.

Otherwise, P03 (P07) stays in input mode.

#SCLK: When transmission is enabled in master mode, P02 (P06) enters output mode.

Otherwise, P02 (P06) stays in input mode.

Note: In clock-synchronized transfers, the clock line is shared between the transmit and receive units, so the communication mode is half-duplex. Therefore, TXENx and receive-enable bit RXENx cannot be enabled simultaneously. When transmitting data, fix RXENx at "0" and do not change it during a transmit operation.

In addition, make sure TXENx is not set to "0" during a transmit operation.

(2) Transmit procedure

The serial interface contains a transmit shift register and a transmit data register (transmit data buffer), which are provided independently of those used for a receive operation.

Ch.0 transmit data: TXD0[7:0] (D[7:0]) / Serial I/F Ch.0 transmit data register (0x401E0)

Ch.1 transmit data: TXD1[7:0] (D[7:0]) / Serial I/F Ch.1 transmit data register (0x401E5)

The serial interface contains a status bit to indicate the status of the transmit data register.

Ch.0 transmit data buffer empty: TDBE0(D1) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 transmit data buffer empty: TDBE1(D1) / Serial I/F Ch.1 status register (0x401E7)

This bit is reset to "0" by writing data to the transmit-data register, and set to "1" again (buffer empty) when the data is transferred to the shift register.

The serial interface starts transmitting when data is written to the transmit data register.

The transfer status can be checked using the transmit-completion flag (TENDx).

Ch.0 transmit-completion flag: TEND0 (D5) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 transmit-completion flag: TEND1 (D5) / Serial I/F Ch.1 status register (0x401E7)

This bit goes "1" when data is being transmitted and goes "0" when the transmission has completed.

When data is transmitted successively in clock-synchronized master mode, TENDx maintains "1" until all data is transmitted (Figure III-8.4). In slave mode, TENDx goes "0" every time 1-byte data is transmitted (Figure III-8.5).

Following explains transmit operation in both the master and slave modes.

- **Clock-synchronized master mode**

The timing at which the device starts transmitting in the master mode is as follows:

When #SRDY is on a low level while TDBEx = "0" (the transmit-data register contains data written to it) or when TDBEx is set to "0" (data has been written to the transmit-data register) while #SRDY is on a low level.

Figure III-8.4 shows a transmit timing chart in the clock-synchronized master mode.

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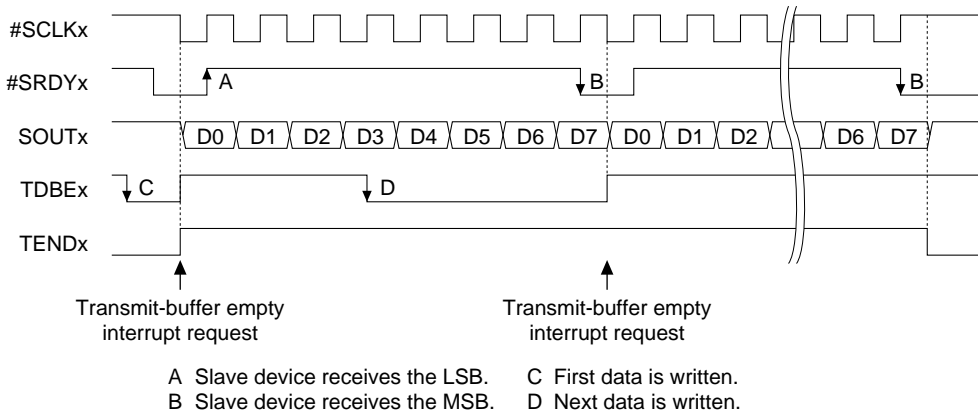


Figure III-8.4 Transmit Timing Chart in Clock-Synchronized Master Mode

1. If the #SRDYx signal from the slave is on a high level, the master waits until it is on a low level (ready to receive).
2. If #SRDYx is on a low level, the synchronizing clock input to the serial interface begins. The synchronizing clock is also output from the #SCLKx pin to the slave device.
3. The content of the data register is transferred to the shift register synchronously with the first falling edge of the clock. At the same time, the LSB of the data transferred to the shift register is output from the SOUTx pin.
4. The data in the shift register is shifted 1 bit by the next falling edge of the clock, and the bit following the LSB is output from SOUTx. This operation is repeated until all 8 bits of data are transmitted.

The slave device must take in each bit synchronously with the rising edges of the synchronizing clock.

• Clock-synchronized slave mode

Figure III-8.5 shows a transmit timing chart in the clock-synchronized slave mode.

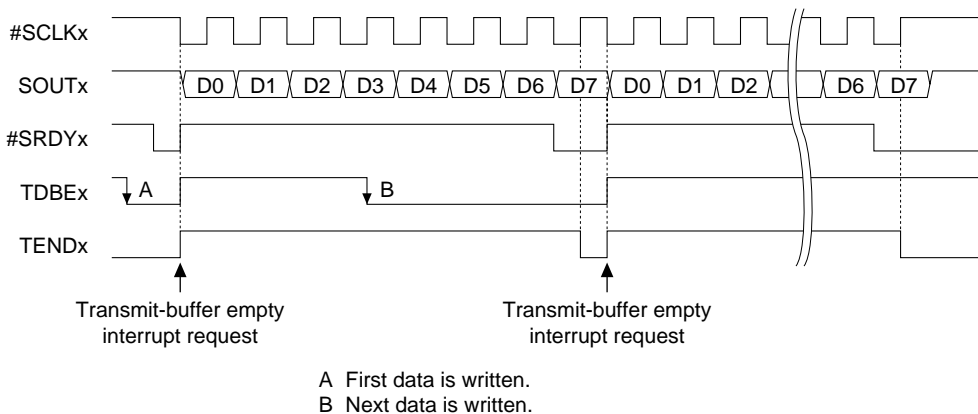


Figure III-8.5 Transmit Timing Chart in Clock-Synchronized Slave Mode

1. After setting the #SRDYx signal to a low level (ready to transmit), the slave waits for clock input from the master.
2. When the synchronizing clock is input from the #SCLKx pin, the content of the data register is transferred to the shift register synchronously with the first falling edge of the clock. At the same time, the LSB of the data transferred to the shift register is output from the SOUTx pin. The #SRDYx signal is returned to a high level at this point.
3. The data in the shift register is shifted 1 bit by the next falling edge of the clock, and the bit following the LSB is output from SOUTx. This operation is repeated until all 8 bits of data are transmitted.
4. The #SRDYx signal is set to a low level when the last bit (8th bit) is output from the SOUTx pin.

The master device must take in each bit synchronously with the rising edges of the synchronizing clock.

• Successive transmit operations

When the data in the transmit data register is transferred to the shift register, TDBEx is reset to "1" (buffer empty). Once this occurs, the next transmit data can be written to the transmit data register, even during data transmission.

This allows data to be transmitted successively. The transmit procedure is described above.

When TDBEx is set to "1", a transmit-data empty interrupt factor occurs. Since an interrupt can be generated as set by the interrupt controller, the next piece of transmit data can be written using an interrupt processing routine. In addition, since this interrupt factor can be used to invoke DMA, the data prepared in memory can be transmitted successively to the transmit-data register through DMA transfers.

For details on how to control interrupts and DMA requests, refer to "Serial Interface Interrupts and DMA".

(3) Terminating transmit operation

Upon completion of data transmission, write "0" to the transmit-enable bit TXENx to disable transmit operation.

Receive control

(1) Enabling receive operation

Use the receive-enable bit RXENx for receive control.

Ch.0 receive-enable: RXEN0 (D6) / Serial I/F Ch.0 receive-enable register (0x401E3)

Ch.1 receive-enable: RXEN1 (D6) / Serial I/F Ch.1 receive-enable register (0x401E8)

When receive operations are enabled by writing "1" to this bit, clock input to the shift register is enabled (ready for input), thereby starting a data-receive operation. The synchronizing clock input/output on the #SCLKx pin also is enabled (ready for input/output). Receive operations are disabled by writing "0" to RXENx.

After the P0 function select register is set for the serial interface, the I/O direction of the #SRDY and #SCLK pins are changed at follows:

#SRDY: When receive operation is enabled in slave mode, P03 (P07) enters output mode.
Otherwise, P03 (P07) stays in input mode.

#SCLK: When receive operation is enabled in master mode, P02 (P06) enters output mode.
Otherwise, P02 (P06) stays in input mode.

Note: In clock-synchronized transfers, the clock line is shared between the transmit and receive units, so the communication mode is half-duplex. Therefore, RXENx and transmit-enable bit TXENx cannot be enabled simultaneously. When receiving data, fix TXENx at "0" and do not change it during a receive operation. In addition, make sure RXENx is not set to "0" during a receive operation.

(2) Receive procedure

This serial interface has a receive shift register and a receive data register (receive data buffer) that are provided independently of those used for transmit operations.

Ch.0 receive data: RXD0[7:0] (D[7:0]) / Serial I/F Ch.0 receive data register (0x401E1)

Ch.1 receive data: RXD1[7:0] (D[7:0]) / Serial I/F Ch.1 receive data register (0x401E6)

The receive data can be read out from this register.

A status bit is also provided that indicates the status of the receive data register.

Ch.0 receive data buffer full: RDBF0 (D0) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 receive data buffer full: RDBF1 (D0) / Serial I/F Ch.1 status register (0x401E7)

This bit is set to "1" (buffer full) when the MSB of serial data is received and the data in the shift register is transferred to the receive data register, indicating that the received data can be read out. When the data is read out, the bit is reset to "0".

The following describes a receive operation in the master and slave modes.

• **Clock-synchronized master mode**

Figure III-8.6 shows a receive timing chart in the clock-synchronized master mode.

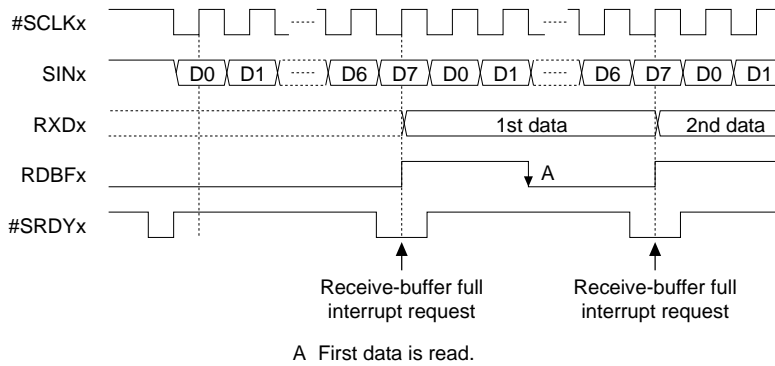
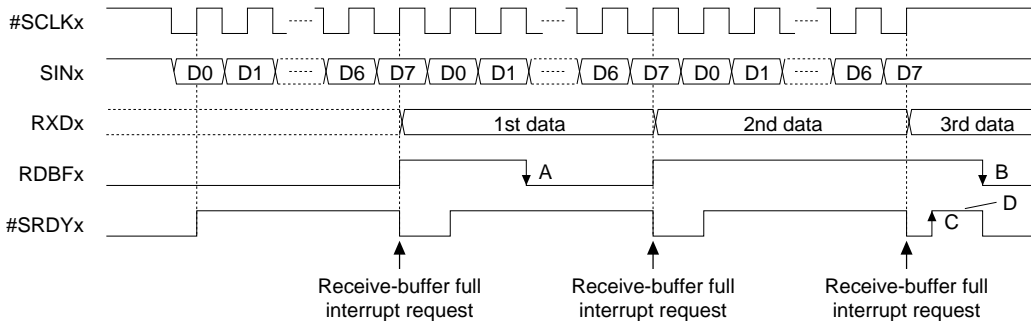


Figure III-8.6 Receive Timing Chart in Clock-Synchronized Master Mode

1. If the #SRDYx signal from the slave is on a high level, the master waits until it turns to a low level (ready to receive).
2. If #SRDYx is on a low level, synchronizing clock input to the serial interface begins. The synchronizing clock is also output from the #SCLKx pin to the slave device.
3. The slave device outputs each bit of data synchronously with the falling edges of the clock. The LSB is output first.
4. This serial interface takes the SIN input into the shift register at the rising edges of the clock. The data in the shift register is sequentially shifted as bits are taken in. This operation is repeated until the MSB of data is received.
5. When the MSB is taken in, the data in the shift register is transferred to the receive data register, enabling the data to be read out.

• **Clock-synchronized slave mode**

Figure III-8.7 shows a receive timing chart in the clock-synchronized slave mode.



- A First data is read. C An overrun error occurs because the receive operation has completed when RDBFx = "1".
 B 3rd data is read. D Send the busy signal to the master device to stop the clock.

Figure III-8.7 Receive Timing Chart in Clock-Synchronized Slave Mode

1. After setting the #SRDYx signal to a low level (ready to receive), the slave waits for clock input from the master.
2. The master device outputs each bit of data synchronously with the falling edges of the clock. The LSB is output first.
3. This serial interface takes the SIN input into the shift register at the rising edges of the clock that is input from #SCLKx. The data in the shift register is sequentially shifted as bits are taken in. This operation is repeated until the MSB of data is received.
4. When the MSB is taken in, the data in the shift register is transferred to the receive data register, enabling the data to be read out.

- **Successive receive operations**

When the data received in the shift register is transferred to the receive data register, RDBFx is set to "1" (buffer full), indicating that the received data can be read out.

Since the receive data register can be read out while receiving the next data, data can be received successively. The procedure for receiving is described above.

When RDBFx is set to "1", a receive-data full interrupt factor occurs. Since an interrupt can be generated as set by the interrupt controller, the received data can be read by an interrupt processing routine. In addition, since this interrupt factor can be used to invoke DMA, the received data can be received successively in locations prepared in memory through DMA transfers.

For details on how to control interrupts/DMA, refer to "Serial Interface Interrupts and DMA".

(3) Overrun error

If, during successive receive operation, a receive operation for the next data is completed before the receive data register is read out, the receive data register is overwritten with the new data. Therefore, the receive data register must always be read out before a receive operation for the next data is completed.

When the receive data register is overwritten, an overrun error is generated and the overrun error flag is set to "1".

Ch.0 overrun error flag: OER0 (D2) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 overrun error flag: OER1 (D2) / Serial I/F Ch.1 status register (0x401E7)

Once the overrun error flag is set to "1", it remains set until it is reset by writing "0" to it in the software.

The overrun error is one of the receive-error interrupt factors in the serial interface. An interrupt can be generated for this error by setting the interrupt controller as necessary, so that the error can be processed by an interrupt processing routine.

(4) #SRDYx in slave mode

When receive operations are enabled by writing "1" to RXENx, the #SRDYx signal is turned to a low level, thereby indicating to the master device that the slave is ready to receive. When the LSB of serial data is received, #SRDYx is turned to a high level; when the MSB is received, #SRDYx is returned to a low level, in preparation for the next receive operation.

If an overrun error occurs, #SRDYx is turned to a high level (unable to receive) at that point, with receive operations for the following data thus suspended. In this case, #SRDYx is returned to a low by reading out the data overwritten in the receive data register, and if any receive data follows, the slave restarts receiving data.

(5) Terminating receive operation

Upon completion of a data receive operation, write "0" to the receive-enable bit RXENx to disable receive operations.

Asynchronous Interface

Outline of Asynchronous Interface

Asynchronous transfers are performed by adding a start bit and a stop bit to the start and end points of each serial-converted data. With this method, there is no need to use a clock that is fully synchronized on the transmit and receive sides; instead, transfer operations are timed by the start and stop bits added to the start and end points of each data.

In the 8-bit asynchronous mode (SMDx[1:0] = "11"), 8 bits of data can be transferred; in the 7-bit asynchronous mode (SMDx[1:0] = "10"), 7 bits of data can be transferred.

In either mode, it is possible to select the stop-bit length, add a parity bit, and choose between even and odd parity. The start bit is fixed at "1".

The operating clock can be selected between an internal clock generated by an 8-bit programmable timer or an external clock that is input from the #SCLKx pin.

Since the transmit and receive units are both constructed with a double-buffer structure, successive transmit and receive operations are possible. Furthermore, since the transmit and receive units are independent, full-duplex communication in which transmit and receive operations are performed simultaneously is also possible.

Figure III-8.8 shows an example of how input/output pins are connected for transfers in the asynchronous mode.

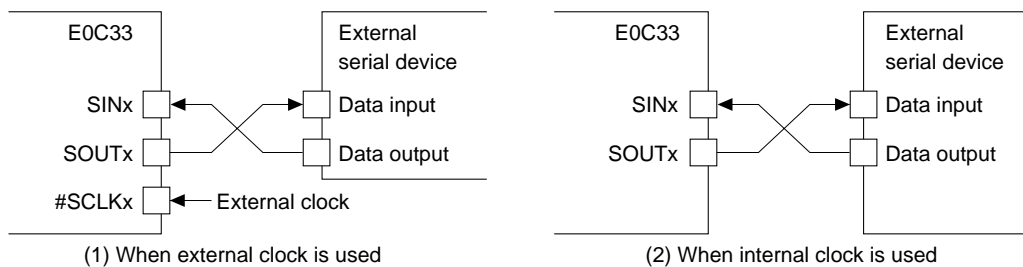


Figure III-8.8 Example of Connection in Asynchronous Mode

When the asynchronous mode is selected, it is possible to use the IrDA interface function.

Asynchronous-transfer data format

The data format for asynchronous transfer is shown below.

Data length: 7 or 8 bits (determined by the selected transfer mode)

Start bit: 1 bit, fixed

Stop bit: 1 or 2 bits

Parity bit: Even or odd parity, or none

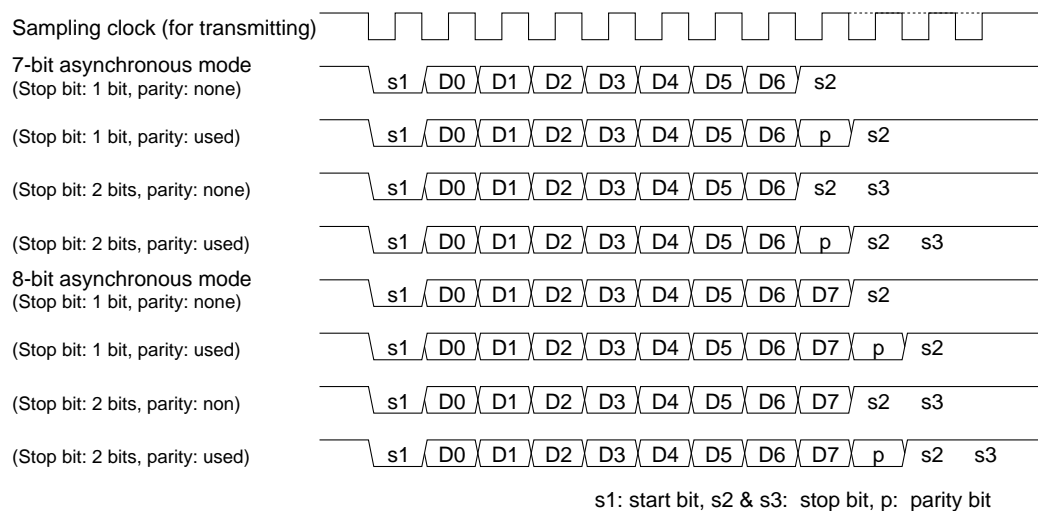


Figure III-8.9 Data Format for Asynchronous Transfer

Serial data is transmitted and received, starting with the LSB.

Setting Asynchronous Interface

When performing asynchronous transfer via the serial interface, the following must be done before data transfer can be started:

1. Setting input/output pins
2. Setting the interface mode
3. Setting the transfer mode
4. Setting the input clock
5. Setting the data format
6. Setting interrupt/IDMA/HSDMA

The following describes how to set each of the above. For details on interrupt/DMA settings, refer to "Serial Interface Interrupts and DMA".

Note: Always make sure the serial interface is inactive (TXENx and RXENx = "0") before making these settings. A change in settings during operation may result in a malfunction.

Setting input/output pins

In the asynchronous mode, two pins—SINx and SOUTx—are used. When external clock input is used, one more pin, #SCLKx, is also used.

Set CFP0[7:0] (D[7:0]) / P0 function select register (0x402D0) according to the pins used. (Both channels can be used, if necessary.) Since the #SRDYx pin is not used, P03 or P07 can be used as an I/O port. During operation using the internal clock, P03 or P06 can also be used as an I/O port.

Setting the interface mode

IRMDx[1:0] (D[1:0]) / Serial I/F Ch.0 IrDA register (0x401E4) is used to set the IrDA interface. Since IRMDx[1:0] becomes indeterminate at initial reset, initialize it by writing "00" when using the serial interface as a normal interface, or "10" when using the serial interface as an IrDA interface. This setting must be made before a transfer mode is set.

Setting the transfer mode

Use SMDx to set the transfer mode of the serial interface as described earlier. When using the serial interface in the 8-bit asynchronous mode, set SMDx[1:0] to "11", when using the serial interface in the 7-bit asynchronous mode, set SMDx[1:0] to "10".

Setting the input clock

In the asynchronous mode, the operating clock can be selected between the internal clock and an external clock.

Ch.0 input clock selection: SSCK0 (D2) / Serial I/F Ch.0 control register (0x401E3)

Ch.1 input clock selection: SSCK1 (D2) / Serial I/F Ch.1 control register (0x401E8)

The external clock is selected (input from the #SCLKx pin) by writing "1" to SSCKx, and an internal clock is selected by writing "0".

Note: SSCKx becomes indeterminate at initial reset, so be sure to reset it in the software.

- **Internal clock**

When the internal clock is selected, the serial interface is clocked by a clock generated using an 8-bit programmable timer. The clock source for each channel is as follows:

Ch.0: Clock output by 8-bit programmable timer 2

Ch.1: Clock output by 8-bit programmable timer 3

Therefore, before the internal clock can be used, the following conditions must be met:

1. The prescaler is outputting a clock to the 8-bit programmable timer 2 (or 3).
2. The 8-bit programmable timer 2 (or 3) is outputting a clock.

III PERIPHERAL BLOCK: SERIAL INTERFACE

Any desired clock frequency can be obtained by setting the prescaler division ratio and the reload data of the 8-bit programmable timer as necessary. The relationship between the contents of these setting and the transfer rate is expressed by Eq. 2.

The 8-bit programmable timer has its underflow signal further divided by 2 internally, in order to ensure that the duty ratio of the clock supplied to the serial interface is 50%.

Furthermore, the clock output by the 8-bit programmable timer is divided by 16 or 8 internally in the serial interface, in order to create a sampling clock (refer to "Sampling clock"). This division ratio must also be considered when setting the transfer rate.

These division ratios are taken into account in Eq. 2.

$$RLD = \frac{f_{PSCIN} \times pdr \times sdr}{2 \times bps} - 1 \quad (\text{Eq. 2})$$

RLD: Set value of the 8-bit programmable timer's reload data register

fPSCIN: Prescaler input clock frequency (Hz)

bps: Transfer rate (bits/second)

pdr: Division ratio of the prescaler

sdr: Internal division ratio of the serial interface (1/16 or 1/8)

Note: The division ratio selected using the prescaler differs between 8-bit programmable timers 2 and 3. Take this into account when setting a division ratio.

8-bit programmable timer 2: 1/2, 1/4, 1/8, 1/32, 1/64, 1/2048, 1/4096

8-bit programmable timer 3: 1/2, 1/4, 1/8, 1/32, 1/64, 1/128, 1/256

Table III-8.4 shows examples of prescaler division ratios and the reload data settings of the programmable timer, in cases in which the internal division ratio of the serial interface is set to 1/16.

Table III-8.4 Example of Transfer Rate Settings

Transfer rate (bps)	fPSCIN = 20 MHz			fPSCIN = 25 MHz			fPSCIN = 33 MHz		
	RLD	dr	Error (%)	RLD	dr	Error (%)	RLD	dr	Error (%)
300	129	1/16	0.16025	162	1/16	-0.14698	216	1/16	0.00640
1200	129	1/4	0.16025	162	1/4	-0.14698	216	1/4	0.00640
2400	129	1/2	0.16025	162	1/2	-0.14698	216	1/2	0.00640
4800	64	1/2	0.16025	80	1/2	-0.46939	108	1/2	-0.45234
9600	32	1/2	-1.35732	40	1/2	-0.75584	53	1/2	0.46939
14400	21	1/2	-1.35732	13	1/4	-3.11880	35	1/2	0.46939
28800	10	1/2	-1.35732	13	1/2	-3.11880	17	1/2	0.46939

Make sure the error is within 1%. Calculate the error using the following equation:

$$\text{Error} = \left\{ \frac{f_{PSCIN} \times dr}{(RLD + 1) \times 32 \times bps} - 1 \right\} \times 100 [\%]$$

For details on how to control the prescaler and 8-bit programmable timers, refer to "Prescaler" and "8-Bit Programmable Timers".

• External clock

When an external clock is selected, the serial interface is clocked by a clock input from the #SCLKx pin. Therefore, there is no need to control the prescaler and 8-bit programmable timers.

Any desired clock frequency can be set. The clock input from the #SCLKx pin is internally divided by 16 or 8 in the serial interface, in order to create a sampling clock (refer to "Sampling clock"). This division ratio must also be considered when setting the transfer rate.

• **Sampling clock**

In the asynchronous mode, TCLK (the clock output by the 8-bit programmable timer or input from the #SCLKx pin) is internally divided in the serial interface, in order to create a sampling clock.

A 1/16 division ratio is selected by writing "1" to DIVMDx , and a 1/8 ratio is selected by writing "0".

Ch.0 clock division ratio selection: DIVMD0 (D4) / Serial I/F Ch.0 IrDA register (0x401E4)

Ch.1 clock division ratio selection: DIVMD1 (D4) / Serial I/F Ch.1 IrDA register (0x401E9)

Note: The DIVMDx bit becomes indeterminate at initial reset, so be sure to reset it in the software. Settings of this bit are valid only in the asynchronous mode (and when using the IrDA interface).

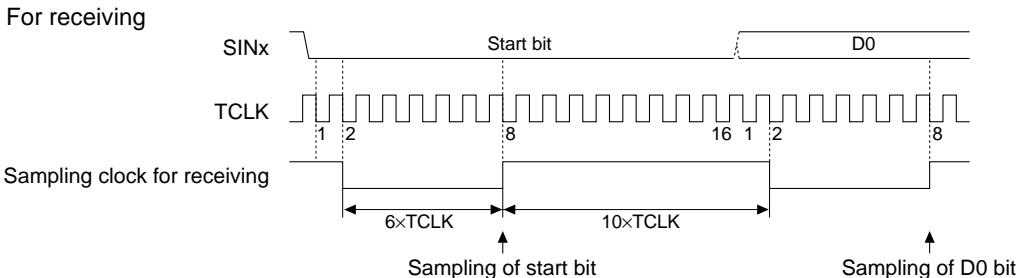


Figure III-8.10 Sampling Clock for Asynchronous Receive Operation (when 1/16 division is selected)

As shown in Figure III-8.10, the sampling clock is created by dividing TCLK by 16 (or 8). Its duty ratio (low: high ratio) is 6:10 (or 2:6 when divided by 8), and not 50%. Since the receive data is sampled in the middle point of each bit, the sampling clock recognizes the start bit first, and then changes the level from high to low at the second falling edge of TCLK. And at the 8th (4th for 1/8) falling edge of TCLK, it changes the level from low to high. This change in levels is repeated for the following bits of data:

Each bit of data is sampled at each rising edge of this sampling clock. When the stop bit is sampled, the sampling clock is fixed at high level until the next start bit is sampled.

If the SINx pin is returned to high level at the second falling edge of TCLK when it recognize the start bit, the data is assumed to be noise, and generation of the sampling clock is stopped.

If the SINx pin is not on a low level when the start bit is sampled at the 8th (4th for 1/8) clock, such as when the baud rate is not matched between the transmit and receive units, the serial interface stops sampling the following data and returns to a start-bit detection mode. In this case, no error is generated.

For transmitting

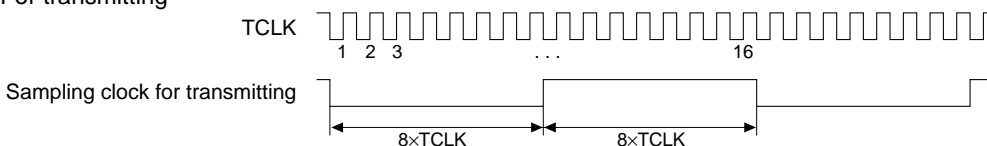


Figure III-8.11 Sampling Clock for Asynchronous Transmit Operation (when 1/16 division is selected)

When transmitting data, a sampling clock of a 50% duty cycle is generated from TCLK by dividing it by 16 (or 8), and each bit of data is output synchronously with this clock.

Setting the data format

In the asynchronous mode, the data length is 7 or 8 bits as determined by the transfer mode set. The start bit is fixed at 1.

The stop and parity bits can be set as shown in the Table III-8.5 using the following control bits:

Stop-bit selection	Ch.0: STPB0 (D3) / Serial I/F Ch.0 control register (0x401E3)
	Ch.1: STPB1 (D3) / Serial I/F Ch.1 control register (0x401E8)
Parity enable	Ch.0: EPR0 (D5) / Serial I/F Ch.0 control register (0x401E3)
	Ch.1: EPR1 (D5) / Serial I/F Ch.1 control register (0x401E8)
Parity-mode selection	Ch.0: PMD0 (D4) / Serial I/F Ch.0 control register (0x401E3)
	Ch.1: PMD1 (D4) / Serial I/F Ch.1 control register (0x401E8)

Table III-8.5 Stop Bit and Parity Bit Settings

STPBx	EPRx	PMDx	Stop bit	Parity bit
1	1	1	2 bits	Odd
		0	2 bits	Even
	0	*	2 bits	None
0	1	1	1 bit	Odd
		0	1 bit	Even
	0	*	1 bit	Non

* Setting PMDx is invalid when EPRx = "0".

Note: These bits become indeterminate at initial reset, so be sure to initialize them in the software.

Control and Operation of Asynchronous Transfer

Transmit control

(1) Enabling transmit operation

Use the transmit-enable bit TXENx for transmit control.

Ch.0 transmit-enable: TXEN0 (D7) / Serial I/F Ch.0 control register (0x401E3)

Ch.1 transmit-enable: TXEN1 (D7) / Serial I/F Ch.1 control register (0x401E8)

When transmit is enabled by writing "1" to this bit, the clock input to the shift register is enabled (ready for input), thus allowing data to be transmitted.

Transmit is disabled by writing "0" to TXENx.

Note: Do not set TXENx to "0" during a transmit operation.

(2) Transmit procedure

The serial interface has a transmit shift register and a transmit data register (transmit data buffer) that are provided independently of those used for receive operations.

Ch.0 transmit data: TXD0[7:0] (D[7:0]) / Serial I/F Ch.0 transmit data register (0x401E0)

Ch.1 transmit data: TXD1[7:0] (D[7:0]) / Serial I/F Ch.1 transmit data register (0x401E5)

The serial interface starts a transmit operation by writing data to this register. In the 7-bit asynchronous mode, bit 7 (MSB) in each register is ignored.

The serial interface also contains a status bit to indicate the status of the transmit data register.

Ch.0 transmit data buffer empty: TDBE0 (D1) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 transmit data buffer empty: TDBE1 (D1) / Serial I/F Ch.1 status register (0x401E7)

This bit is reset to "0" by writing data to the transmit data register, and set back to "1" (buffer empty) when the data is transferred to the shift register. The transfer begins when the serial interface starts sending the start bit.

The transfer status can be checked using the transmit-completion flag (TENDx).

Ch.0 transmit-completion flag: TEND0 (D5) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 transmit-completion flag: TEND1 (D5) / Serial I/F Ch.1 status register (0x401E7)

This bit goes "1" when data is being transmitted and goes "0" when the transmission has completed.

When data is transmitted successively in asynchronous mode, TENDx maintains "1" until all data is transmitted.

Figure III-8.12 shows a transmit timing chart in the asynchronous mode.

Example: Data length 8 bits
 Stop bit 1 bit
 Parity bit Included

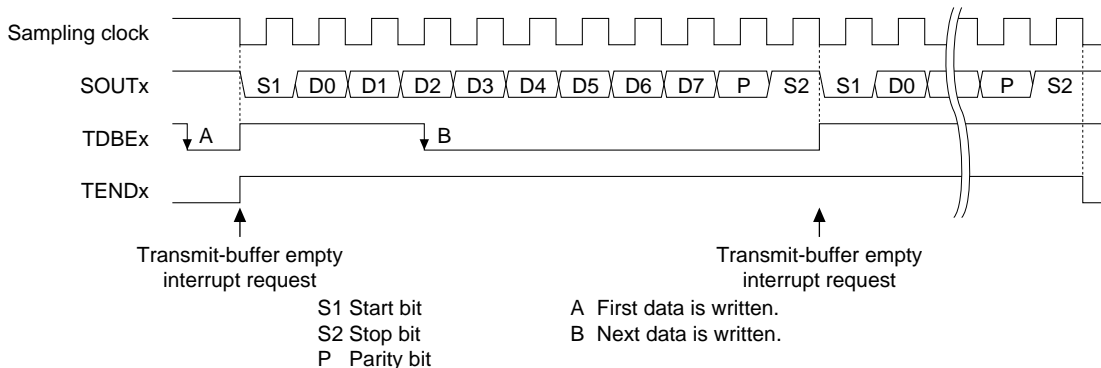


Figure III-8.12 Transmit Timing Chart in Asynchronous Mode

1. The contents of the data register are transferred to the shift register synchronously with the first falling edge of the sampling clock. At the same time, the SOUTx pin is setting to a low level to send the start bit.
2. Each bit of data in the shift register is transmitted beginning with the LSB at each falling edge of the subsequent sampling clock. This operation is repeated until all 8 (or 7) bits of data are transmitted.
3. After sending the MSB, the parity bit (if EPRx = "1") and the stop bit are transmitted insuccession.

• **Successive transmit operation**

When the data in the transmit data register is transferred to the shift register, TDBEx is reset to "1" (buffer empty). Once this occurs, the next transmit data can be written to the transmit data register, even during data transmission.

This allows data to be transmitted successively. The transmit procedure is described above.

When TDBEx is set to "1", a transmit-data empty interrupt factor simultaneously occurs. Since an interrupt can be generated as set by the interrupt controller, the next transmit data can be written using an interrupt processing routine. In addition, since this interrupt factor can be used to invoke IDMA, the data prepared in memory can be transmitted successively to the transmit data register through DMA transfers.

For details on how to control interrupts and IDMA requests, refer to "Serial Interface Interrupts and DMA".

(3) Terminating transmit operations

When data transmission is completed, write "0" to the transmit-enable bit TXENx to disable transmit operations.

Receive control

(1) Enabling receive operations

Use the receive-enable bit RXENx for receive control.

Ch.0 receive-enable: RXEN0 (D6) / Serial I/F Ch.0 control register (0x401E3)

Ch.1 receive-enable: RXEN1 (D6) / Serial I/F Ch.1 control register (0x401E8)

When receiving enabled by writing "1" to this bit, clock input to the shift register is enabled (ready for input), meaning that it is ready to receive data.

Receive operations are disabled by writing "0" to RXENx.

Note: Do not set RXENx to "0" during a receive operation.

(2) Receive procedure

This serial interface has a receive shift register and a receive data register (receive data buffer) that are provided independently of those used for transmit operations.

Ch.0 receive data: RXD0[7:0] (D[7:0]) / Serial I/F Ch.0 receive data register (0x401E1)

Ch.1 receive data: RXD1[7:0] (D[7:0]) / Serial I/F Ch.1 receive data register (0x401E6)

Receive data can be read out from this register.

A status bit is also provided to indicate the status of the receive data register.

Ch.0 receive data buffer full: RDBF0 (D0) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 receive data buffer full: RDBF1 (D0) / Serial I/F Ch.1 status register (0x401E7)

This bit is set to "1" (buffer full) when data is transferred from the shift register to the receive data register after the stop bit is sampled (the second bit if two stop bits are used), indicating that the received data can be read out. When the data is read out, the bit is reset to "0".

Figure III-8.13 shows a receive timing chart in the asynchronous mode.

Example: Data length 8 bits

Stop bit 1 bit

Parity bit Included

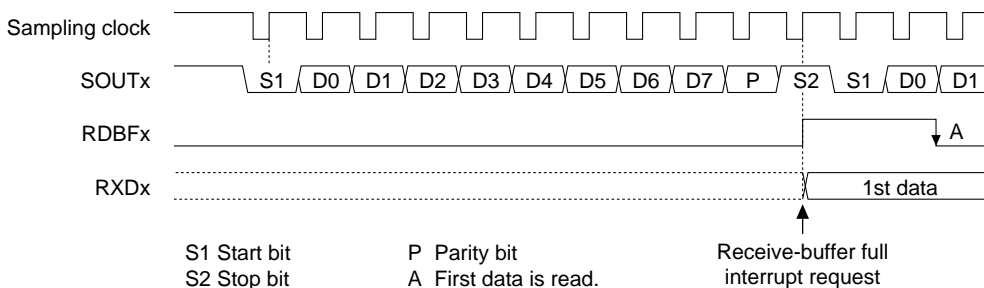


Figure III-8.13 Receive Timing Chart in Asynchronous Mode

1. The serial interface starts sampling when the start bit is input (SINx = low).
2. When the start bit is sampled at the first rising edge of the sampling clock, each bit of receive data is taken into the shift register, beginning with the LSB at each rising edge of the subsequent clock. This operation is repeated until the MSB of data is received.
3. When the MSB is taken in, the parity bit that follows is also taken in (if EPRx = "1").
4. When the stop bit is sampled, the data in the shift register is transferred to the receive data register, enabling the data to be read out.
The parity is checked when data is transferred to the receive data register (if EPRx = "1").

Note: The receive operation is terminated when the first stop bit is sampled even if the stop bit is configured with two bits.

• **Successive receive operations**

When the data received in the shift register is transferred to the receive data register, RDBFx is set to "1" (buffer full), indicating that the received data can be read out. Thereafter, data can be received successively because the receive data register can be read out while the next data is received. The procedure for receiving is described above.

When RDBFx is set to "1", a receive-data full interrupt factor occurs. Since an interrupt can be generated as set by the interrupt controller, the received data can be read using an interrupt processing routine. In addition, since this interrupt factor can be used to invoke IDMA, the received data can be received successively in locations prepared in memory through DMA transfers.

For details on how to control interrupts and IDMA requests, refer to "Serial Interface Interrupts and DMA".

(3) Receive errors

Three types of receive errors can be detected when receiving data in the asynchronous mode.

Since an interrupt can be generated by setting the interrupt controller, the error can be processed using an interrupt processing routine. For details on receive error interrupts, refer to "Serial Interface Interrupts and DMA".

- **Parity error**

If EPRx is set to "1" (parity added), the parity is checked when data is received.

This parity check is performed when the data received in the shift register is transferred to the receive data register in order to check conformity with PMDx settings (odd or even parity). If any nonconformity is found in this check, a parity error is assumed and the parity error flag is set to "1".

Ch.0 parity error flag: PER0 (D3) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 parity error flag: PER1 (D3) / Serial I/F Ch.1 status register (0x401E7)

Even when this error occurs, the received data in error is transferred to the receive data register and the receive operation is continued. However, the content of the received data for which a parity error is flagged cannot be guaranteed.

The PERx flag is reset to "0" by writing "0".

- **Framing error**

If data with a stop bit = "0" is received, the serial interface assumes that the data is out of synchronization and generates a framing error.

If two stop bits are used, only the first stop bit is checked.

When this error occurs, the framing-error flag is set to "1".

Ch.0 framing-error flag: FER0 (D4) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 framing-error flag: FER1 (D4) / Serial I/F Ch.1 status register (0x401E7)

Even when this error occurs, the received data in error is transferred to the receive data register and the receive operation is continued. However, the content of the received data for which a framing error is flagged cannot be guaranteed, even if no framing error is found in the following data received.

The FERx flag is reset to "0" by writing "0".

- **Overrun error**

If during successive receive operations, a receive operation for the next data is completed before the receive data register is read out, the receive data register is overwritten with the new data. Therefore, the receive data register must always be read out before a receive operation for the next data is completed.

When the receive data register is overwritten, an overrun error is generated and the overrun-error flag is set to "1".

Ch.0 overrun-error flag: OER0 (D2) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 overrun-error flag: OER1 (D2) / Serial I/F Ch.1 status register (0x401E7)

Even when this error occurs, the received data in error is transferred to the receive data register and the receive operation is continued.

The OERx flag is reset to "0" by writing "0".

(4) Terminating receive operation

When a data receive operation is completed, write "0" to the receive-enable bit RXENx to disable receive operations.

IrDA Interface

Outline of IrDA Interface

Each channel of the serial interface contains a PPM modulator circuit, allowing an infrared-ray communication circuit to be configured based on IrDA 1.0 simply by adding a simple external circuit.

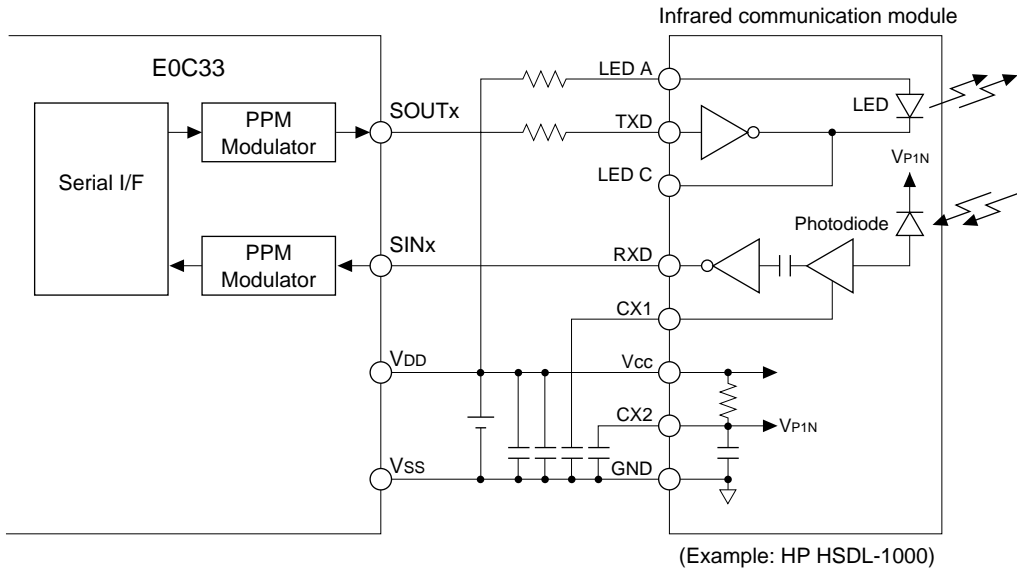


Figure III-8.14 Configuration Example of IrDA Interface

This IrDA interface function can be used only when the selected transfer mode is an asynchronous mode. Since the contents of the asynchronous mode are applied directly for the serial-interface functions other than the IrDA interface unit, refer to "Asynchronous Interface", for details on how to set and control the data formats and data transfers.

Setting IrDA Interface

When performing infrared-ray communication, the following settings must be made before communication can be started:

1. Setting input/output pins
2. Selecting the interface mode (IrDA interface function)
3. Setting the transfer mode
4. Setting the input clock
5. Setting the data format
6. Setting the interrupt/IDMA
7. Setting the input/output logic

The contents for items 1 through 5 have been explained in connection with the asynchronous interface. For details, refer to "Asynchronous Interface". For details on item 6, refer to "Serial Interface Interrupts and DMA".

Note: Before making these settings, always make sure the serial interface is inactive (TXENx and RXENx are both set to "0"), as a change in settings during operation could cause a malfunction. In addition, be sure to set the transfer mode in (3) and the following items before selecting the IrDA interface function in (2).

Selecting the IrDA interface function

To use the IrDA interface function, select it using the control bits shown below and then set the 8-bit (or 7-bit) asynchronous mode as the transfer mode.

Ch.0 IrDA interface-function selection: IRMD0[1:0] (D[1:0]) / Serial I/F Ch.0 IrDA register (0x401E4)

Ch.1 IrDA interface-function selection: IRMD1[1:0] (D[1:0]) / Serial I/F Ch.1 IrDA register (0x401E9)

Table III-8.6 Setting of IrDA Interface

IRMDx1	IRMDx0	Interface mode
1	1	Do not set. (reserved)
1	0	IrDA 1.0 interface
0	1	Do not set. (reserved)
0	0	Normal interface

Note: The IRMDx bit becomes indeterminate when initially reset, so be sure to initialize it in the software.

Setting the input/output logic

When using the IrDA interface, the logic of the input/output signals of the PPM modulator circuit can be changed in accordance with the infrared-ray communication module or the circuit connected externally to the chip. The logic of the internal serial interface is "active-low". If the input/output signals are active-high, the logic of these signals must be inverted before they can be used. The input SINx and output SOUTx logic can be set individually through the use of the IRRLx and IRTLx bits, respectively.

IrDA input logic inversion Ch.0: IRRL0 (D2) / Serial I/F Ch.0 IrDA register (0x401E4)

Ch.1: IRRL1 (D2) / Serial I/F Ch.1 IrDA register (0x401E9)

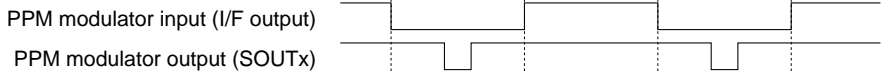
IrDA output logic inversion Ch.0: IRTL0 (D3) / Serial I/F Ch.0 IrDA register (0x401E4)

Ch.1: IRTL1 (D3) / Serial I/F Ch.1 IrDA register (0x401E9)

The logic of the input/output signal is inverted by writing "1" to each corresponding bit. Logic is not inverted if the bit is set to "0".

When transmitting

(1) IRTLx = "0"

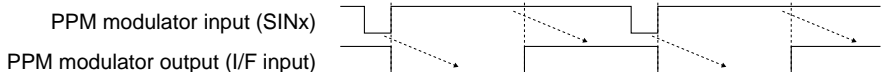


(2) IRTLx = "1"



When receiving

(1) IRRLx = "0"



(2) IRRLx = "1"

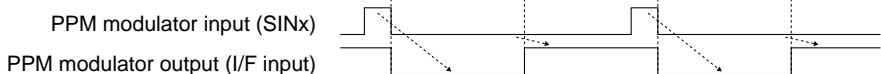


Figure III-8.15 IRRLx and IRTLx Settings

Note: The IRRLx and IRTLx bits become indeterminate at initial reset, so be sure to initialize them in the software.

Control and Operation of IrDA Interface

The transmit/receive procedures have been explained in the section on the asynchronous interface, so refer to "Control and Operation of Asynchronous Transfer".

The following describes the data modulation and demodulation performed using the PPM modulator circuit:

When transmitting

During data transmission, the pulse width of the serial interface output signal is set to $3/16$ before the signal is output from the SOUTx pin.

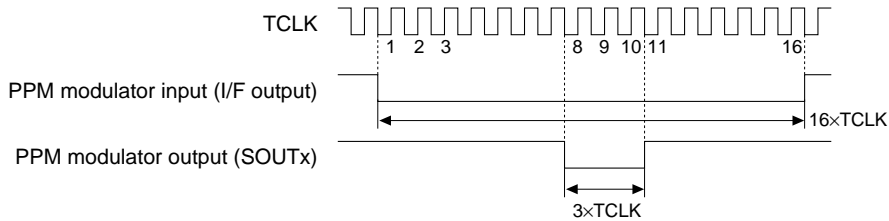


Figure III-8.16 Data Modulation by PPM Circuit

When receiving

During data reception, the pulse width of the input signal from SINx is set to $16/3$ before the signal is transferred to the serial interface.

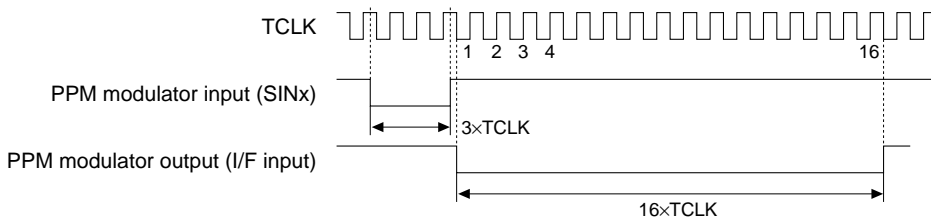


Figure III-8.17 Demodulation by PPM Circuit

Note: When using the IrDA interface, set the internal division ratio of the serial interface $1/16$ (DIVMDx = "1"), rather than $1/8$ (DIVMDx = "0").

Serial Interface Interrupts and DMA

The serial interface can generate the following three types of interrupts in each channel:

- Transmit-buffer empty interrupt
- Receive-buffer full interrupt
- Receive-error interrupt

Transmit-buffer empty interrupt factor

This interrupt factor occurs when the transmit data set in the transmit data register is transferred to the shift register, in which case the interrupt factor flag FSTXx is set to "1". At this time, if the interrupt conditions set using the interrupt control register are met, an interrupt to the CPU is generated.

Occurrence of this interrupt factor indicates that the next transmit data can be written to the transmit data register.

This interrupt factor can also be used to invoke IDMA, enabling transmit data to be written to the register by means of a DMA transfer.

Receive-completion interrupt

This interrupt factor occurs when a receive operation is completed and the receive data taken into the shift register is transferred to the receive data register, in which case the interrupt factor flag FSRXx is set to "1". At this time, if the interrupt conditions set using the interrupt control register are met, an interrupt to the CPU is generated. Occurrence of this interrupt factor indicates that the received data can be read out.

This interrupt factor can also be used to invoke IDMA, enabling the received data to be written into specified memory locations by means of a DMA transfer.

Receive-error interrupt

This interrupt factor occurs when a parity, framing, or overrun error is detected during data reception, in which case the interrupt factor flag FSERRx is set to "1". At this time, if the interrupt conditions set using the interrupt control register are met, an interrupt to the CPU is generated.

Since all three types of errors generate the same interrupt factor, check the error flags PERx (parity error), OERx (overrun error), and FERx (framing error) to identify the type of error that has occurred. In the clock-synchronized mode, parity and framing errors do not occur.

Note: If a receive error (parity or framing error) occurs, the receive-error interrupt and receive-buffer full interrupt factors occur simultaneously. However, since the receive-error interrupt has priority over the receive-buffer full interrupt, the receive-error interrupt is processed first. It is therefore necessary for the receive-buffer full interrupt factor flag be cleared through the use of the receive-error interrupt processing routine.

Control registers of the interrupt controller

Table III-8.7 shows the interrupt controller's control registers provided for each interrupt source (channel).

Table III-8.7 Control Register of Interrupt Controller

Channel	Interrupt factor	Interrupt factor flag	Interrupt enable register	Interrupt priority register
Ch.0	Receive-error interrupt	FSERR0(D0/0x40286)	ESERR0(D0/0x40276)	PSIO0[2:0](D[6:4]/0x40269)
	Receive-buffer full	FSRX0(D1/0x40286)	ESRX0(D1/0x40276)	
	Transmit-buffer empty	FSTX0(D2/0x40286)	ESTX0(D2/0x40276)	
Ch.1	Receive-error interrupt	FSERR1(D3/0x40286)	ESERR1(D3/0x40276)	PSIO1[2:0](D[2:0]/0x4026A)
	Receive-buffer full	FSRX1(D4/0x40286)	ESRX1(D4/0x40276)	
	Transmit-buffer empty	FSTX1(D5/0x40286)	ESTX1(D5/0x40276)	

When the interrupt factor described above occurs, the corresponding interrupt factor flag is set to "1". If the interrupt enable register bit for that interrupt factor has been set to "1", an interrupt request is generated. Interrupts caused by an interrupt factor can be disabled by leaving the interrupt enable register bit for that factor set to "0". The interrupt factor flag is set to "1" whenever interrupt conditions are met, regardless of the setting of the interrupt enable register (even if it is set to "0").

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The interrupt priority register sets the interrupt priority level of each interrupt source in a range between 0 and 7. An interrupt request to the CPU is accepted only when no other interrupt request of a higher priority has been generated.

In addition, only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the input interrupt level set by the interrupt priority register, will the input interrupt request actually be accepted by the CPU.

For details on these interrupt control registers, as well as the device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

Intelligent DMA

The receive-buffer full interrupt and transmit-buffer empty interrupt factors can be used to invoke intelligent DMA (IDMA). This enables successive transmit/receive operations between memory and the transmit/receive-buffer to be performed by means of a DAM transfer.

The following shows the IDMA channel numbers set for each interrupt factor:

IDMA Ch.

Ch.0 receive-buffer full interrupt: 0x17
 Ch.0 transmit-buffer empty interrupt: 0x18
 Ch.1 receive-buffer full interrupt: 0x19
 Ch.1 transmit-buffer empty interrupt: 0x1A

The IDMA request and enable bits shown in Table III-8.8 must be set to "1" for IDMA to be invoked. Transfer conditions, etc. on the IDMA side must also be set in advance.

Table III-8.8 Control Bits for IDMA Transfer

Channel	Interrupt factor	IDMA request bit	IDMA enable bit
Ch.0	Receive-buffer full	RSRX0(D6/0x40292)	DESRX0(D6/0x40296)
	Transmit-buffer empty	RSTX0(D7/0x40292)	DESTX0(D7/0x40296)
Ch.1	Receive-buffer full	RSRX1(D0/0x40293)	DESRX1(D0/0x40297)
	Transmit-buffer empty	RSTX1(D1/0x40293)	DESTX1(D1/0x40297)

If an interrupt factor occurs when the IDMA request and enable bits are set to "1", IDMA is invoked. No interrupt request is generated at that point. An interrupt request is generated upon completion of the DMA transfer. The bits can also be set so as not to generate an interrupt, with only a DAM transfer performed. For details on DMA transfer and how to control interrupts upon completion of DMA transfer, refer to "IDMA (Intelligent DMA)".

High-speed DMA

The receive-buffer full interrupt and transmit-buffer empty interrupt factors can also invoke high-speed DMA (HSDMA).

The following shows the HSDMA channel number and trigger set-up bit corresponding to each channel:

Table III-8.9 HSDMA Trigger Set-up Bits

SIF Ch.	HSDMA Ch.	Trigger set-up bits
0	0	HSD0S[3:0] (D[3:0]) / HSDMA Ch.0/1 trigger set-up register (0x40298)
1	1	HSD1S[3:0] (D[7:4]) / HSDMA Ch.0/1 trigger set-up register (0x40298)
0	2	HSD2S[3:0] (D[3:0]) / HSDMA Ch.2/3 trigger set-up register (0x40299)
1	3	HSD3S[3:0] (D[7:4]) / HSDMA Ch.2/3 trigger set-up register (0x40299)

For HSDMA to be invoked by the receive-buffer full interrupt factor, the trigger set-up bits should be set to "1010". For HSDMA to be invoked by the transmit-buffer empty interrupt factor, the trigger set-up bits should be set to "1011". Transfer conditions, etc. must also be set on the HSDMA side.

The HSDMA channel is invoked through generation of the interrupt factor.

For details on HSDMA transfer, refer to "HSDMA (High-Speed DMA)".

Trap vectors

The trap-vector address of each default interrupt factor is set as follows:

	(BTA3=high)	(BTA3=low)
Ch.0 receive-error interrupt:	0x00800E0	0x0C000E0
Ch.0 receive-buffer full interrupt:	0x00800E4	0x0C000E4
Ch.0 transmit-buffer empty interrupt:	0x00800E8	0x0C000E8
Ch.1 receive-error interrupt:	0x00800EC	0x0C000EC
Ch.1 receive-buffer full interrupt:	0x00800F0	0x0C000F0
Ch.1 transmit-buffer empty interrupt:	0x00800F4	0x0C000F4

The base address of the trap table can be changed using the TTBR register (0x48134 to 0x48137).

I/O Memory of Serial Interface

Table III-8.10 shows the control bits of the serial interface.

For details on the I/O memory of the prescaler that is used to set clocks, as well as that of 8-bit programmable timers, refer to "Prescaler" and "8-Bit Programmable Timers", respectively.

Table III-8.10 Control Bits of Serial Interface

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Serial I/F Ch.0 transmit data register	00401E0 (B)	D7	TXD07	Serial I/F Ch.0 transmit data TXD07(06) = MSB TXD00 = LSB	0x0 to 0xFF(0x7F)		X	R/W	7-bit asynchronous mode does not use TXD07.		
		D6	TXD06								
		D5	TXD05								
		D4	TXD04								
		D3	TXD03								
		D2	TXD02								
		D1	TXD01								
		D0	TXD00								
Serial I/F Ch.0 receive data register	00401E1 (B)	D7	RXD07	Serial I/F Ch.0 receive data RXD07(06) = MSB RXD00 = LSB	0x0 to 0xFF(0x7F)		X	R	7-bit asynchronous mode does not use RXD07 (fixed at 0).		
		D6	RXD06								
		D5	RXD05								
		D4	RXD04								
		D3	RXD03								
		D2	RXD02								
		D1	RXD01								
		D0	RXD00								
Serial I/F Ch.0 status register	00401E2 (B)	D7-6	-	-	-		-	-	0 when being read.		
		D5	TEND0	Ch.0 transmit-completion flag	1	Transmitting	0	End	0	R	
		D4	FER0	Ch.0 flaming error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D3	PER0	Ch.0 parity error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D2	OER0	Ch.0 overrun error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE0	Ch.0 transmit data buffer empty	1	Empty	0	Buffer full	1	R	
		D0	RDBF0	Ch.0 receive data buffer full	1	Buffer full	0	Empty	0	R	
		Serial I/F Ch.0 control register	00401E3 (B)	D7	TXEN0	Ch.0 transmit enable	1	Enabled	0	Disabled	0
D6	RXEN0			Ch.0 receive enable	1	Enabled	0	Disabled	0	R/W	
D5	EPR0			Ch.0 parity enable	1	With parity	0	No parity	X	R/W	Valid only in asynchronous mode.
D4	PMD0			Ch.0 parity mode selection	1	Odd	0	Even	X	R/W	
D3	STPB0			Ch.0 stop bit selection	1	2 bits	0	1 bit	X	R/W	
D2	SSCK0			Ch.0 input clock selection	1	#SCLK0	0	Internal clock	X	R/W	
D1	SMD01			Ch.0 transfer mode selection	SMD0[1:0]		Transfer mode		X	R/W	
D0	SMD00				1	1	8-bit asynchronous	X			
					1	0	7-bit asynchronous				
					0	1	Clock sync. Slave				
		0	0	Clock sync. Master							
Serial I/F Ch.0 IrDA register	00401E4 (B)	D7-5	-	-	-		-	-	0 when being read.		
		D4	DIVMD0	Ch.0 async. clock division ratio	1	1/8	0	1/16	X	R/W	
		D3	IRTL0	Ch.0 IrDA I/F output logic inversion	1	Inverted	0	Direct	X	R/W	Valid only in asynchronous mode.
		D2	IRRL0	Ch.0 IrDA I/F input logic inversion	1	Inverted	0	Direct	X	R/W	
		D1	IRMD01	Ch.0 interface mode selection	IRMD0[1:0]		I/F mode		X	R/W	
		D0	IRMD00		1	1	reserved				
1	0				IrDA 1.0						
0	1				reserved						
0	0			General I/F							
Serial I/F Ch.1 transmit data register	00401E5 (B)	D7	TXD17	Serial I/F Ch.1 transmit data TXD17(16) = MSB TXD10 = LSB	0x0 to 0xFF(0x7F)		X	R/W	7-bit asynchronous mode does not use TXD17.		
		D6	TXD16								
		D5	TXD15								
		D4	TXD14								
		D3	TXD13								
		D2	TXD12								
		D1	TXD11								
		D0	TXD10								
Serial I/F Ch.1 receive data register	00401E6 (B)	D7	RXD17	Serial I/F Ch.1 receive data RXD17(16) = MSB RXD10 = LSB	0x0 to 0xFF(0x7F)		X	R	7-bit asynchronous mode does not use RXD17 (fixed at 0).		
		D6	RXD16								
		D5	RXD15								
		D4	RXD14								
		D3	RXD13								
		D2	RXD12								
		D1	RXD11								
		D0	RXD10								

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Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks		
Serial I/F Ch.1 status register	00401E7 (B)	D7-6	–	–	–	–	–	–	0 when being read.		
		D5	TEND1	Ch.1 transmit-completion flag	1	Transmitting	0	End	0	R	
		D4	FER1	Ch.1 flaming error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D3	PER1	Ch.1 parity error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D2	OER1	Ch.1 overrun error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE1	Ch.1 transmit data buffer empty	1	Empty	0	Buffer full	1	R	
		D0	RDBF1	Ch.1 receive data buffer full	1	Buffer full	0	Empty	0	R	
Serial I/F Ch.1 control register	00401E8 (B)	D7	TXEN1	Ch.1 transmit enable	1	Enabled	0	Disabled	0	R/W	
		D6	RXEN1	Ch.1 receive enable	1	Enabled	0	Disabled	0	R/W	
		D5	EPR1	Ch.1 parity enable	1	With parity	0	No parity	X	R/W	Valid only in asynchronous mode.
		D4	PMD1	Ch.1 parity mode selection	1	Odd	0	Even	X	R/W	
		D3	STPB1	Ch.1 stop bit selection	1	2 bits	0	1 bit	X	R/W	
		D2	SSCK1	Ch.1 input clock selection	1	#SCLK1	0	Internal clock	X	R/W	
		D1	SMD11	Ch.1 transfer mode selection	SMD1[1:0]	Transfer mode	X	R/W	X		
		D0	SMD10								1
		1	0								7-bit asynchronous
		0	1								Clock sync. Slave
				0	0	Clock sync. Master					
Serial I/F Ch.1 IrDA register	00401E9 (B)	D7-5	–	–	–	–	–	–	0 when being read.		
		D4	DIVMD1	Ch.1 async. clock division ratio	1	1/8	0	1/16	X	R/W	
		D3	IRTL1	Ch.1 IrDA I/F output logic inversion	1	Inverted	0	Direct	X	R/W	Valid only in asynchronous mode.
		D2	IRRL1	Ch.1 IrDA I/F input logic inversion	1	Inverted	0	Direct	X	R/W	
		D1	IRMD11	Ch.1 interface mode selection	IRMD1[1:0]	I/F mode	X	R/W	X		
		D0	IRMD10								1
		1	0								IrDA 1.0
				0	1	reserved					
				0	0	General I/F					
8-bit timer, serial I/F Ch.0 interrupt priority register	0040269 (B)	D7	–	reserved	–	–	–	–	0 when being read.		
		D6	PSIO02	Serial interface Ch.0 interrupt level	0 to 7		X	R/W			
		D5	PSIO01		X	R/W					
		D4	PSIO00		X	R/W					
		D3	–	reserved	–	–	–	–	0 when being read.		
		D2	P8TM2	8-bit timer 0–3 interrupt level	0 to 7		X	R/W			
D1	P8TM1	X	R/W								
D0	P8TM0	X	R/W								
Serial I/F Ch.1, A/D interrupt priority register	004026A (B)	D7	–	reserved	–	–	–	–	0 when being read.		
		D6	PAD2	A/D converter interrupt level	0 to 7		X	R/W			
		D5	PAD1		X	R/W					
		D4	PAD0		X	R/W					
		D3	–	reserved	–	–	–	–	0 when being read.		
		D2	PSIO12	Serial interface Ch.1 interrupt level	0 to 7		X	R/W			
D1	PSIO11	X	R/W								
D0	PSIO10	X	R/W								
Serial I/F interrupt enable register	0040276 (B)	D7-6	–	reserved	–	–	–	–	0 when being read.		
		D5	ESTX1	SIF Ch.1 transmit buffer empty	1	Enabled	0	Disabled	0	R/W	
		D4	ESRX1	SIF Ch.1 receive buffer full					0	R/W	
		D3	ESERR1	SIF Ch.1 receive error					0	R/W	
		D2	ESTX0	SIF Ch.0 transmit buffer empty					0	R/W	
		D1	ESRX0	SIF Ch.0 receive buffer full					0	R/W	
		D0	ESERR0	SIF Ch.0 receive error					0	R/W	
Serial I/F interrupt factor flag register	0040286 (B)	D7-6	–	reserved	–	–	–	–	0 when being read.		
		D5	FSTX1	SIF Ch.1 transmit buffer empty	1	Factor is generated	0	No factor is generated	X	R/W	
		D4	FSRX1	SIF Ch.1 receive buffer full					X	R/W	
		D3	FSERR1	SIF Ch.1 receive error					X	R/W	
		D2	FSTX0	SIF Ch.0 transmit buffer empty					X	R/W	
		D1	FSRX0	SIF Ch.0 receive buffer full					X	R/W	
		D0	FSERR0	SIF Ch.0 receive error					X	R/W	
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register	0040292 (B)	D7	RSTX0	SIF Ch.0 transmit buffer empty	1	IDMA request	0	Interrupt request	0	R/W	
		D6	RSRX0	SIF Ch.0 receive buffer full					0	R/W	
		D5	R8TU3	8-bit timer 3 underflow					0	R/W	
		D4	R8TU2	8-bit timer 2 underflow					0	R/W	
		D3	R8TU1	8-bit timer 1 underflow					0	R/W	
		D2	R8TU0	8-bit timer 0 underflow					0	R/W	
		D1	R16TC5	16-bit timer 5 comparison A					0	R/W	
		D0	R16TU5	16-bit timer 5 comparison B					0	R/W	

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Register name	Address	Bit	Name	Function	Setting			Init.	R/W	Remarks	
Serial I/F Ch.1, A/D, port input 4-7 IDMA request register	0040293 (B)	D7	RP7	Port input 7	1	IDMA request	0	Interrupt request	0	R/W	
		D6	RP6	Port input 6					0	R/W	
		D5	RP5	Port input 5					0	R/W	
		D4	RP4	Port input 4					0	R/W	
		D3	-	reserved	-			-	-	0 when being read.	
		D2	RADE	A/D converter	1	IDMA request	0	Interrupt request	0	R/W	
		D1	RSTX1	SIF Ch.1 transmit buffer empty					0	R/W	
		D0	RSRX1	SIF Ch.1 receive buffer full					0	R/W	
			0	R/W							
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register	0040296 (B)	D7	DESTX0	SIF Ch.0 transmit buffer empty	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D6	DESRX0	SIF Ch.0 receive buffer full					0	R/W	
		D5	DE8TU3	8-bit timer 3 underflow					0	R/W	
		D4	DE8TU2	8-bit timer 2 underflow					0	R/W	
		D3	DE8TU1	8-bit timer 1 underflow					0	R/W	
		D2	DE8TU0	8-bit timer 0 underflow					0	R/W	
		D1	DE16TC5	16-bit timer 5 comparison A					0	R/W	
		D0	DE16TU5	16-bit timer 5 comparison B					0	R/W	
Serial I/F Ch.1, A/D, port input 4-7 IDMA enable register	0040297 (B)	D7	DEP7	Port input 7	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D6	DEP6	Port input 6					0	R/W	
		D5	DEP5	Port input 5					0	R/W	
		D4	DEP4	Port input 4					0	R/W	
		D3	-	reserved	-			-	-	0 when being read.	
		D2	DEADE	A/D converter	1	IDMA enabled	0	IDMA disabled	0	R/W	
		D1	DESTX1	SIF Ch.1 transmit buffer empty					0	R/W	
		D0	DESRX1	SIF Ch.1 receive buffer full					0	R/W	
			0	R/W							
P0 function select register	00402D0 (B)	D7	CFP07	P07 function selection	1	#SRDY1	0	P07	0	R/W	Extended functions (0x402DF)
		D6	CFP06	P06 function selection	1	#SCLK1	0	P06	0	R/W	
		D5	CFP05	P05 function selection	1	SOUT1	0	P05	0	R/W	
		D4	CFP04	P04 function selection	1	SIN1	0	P04	0	R/W	
		D3	CFP03	P03 function selection	1	#SRDY0	0	P03	0	R/W	
		D2	CFP02	P02 function selection	1	#SCLK0	0	P02	0	R/W	
		D1	CFP01	P01 function selection	1	SOUT0	0	P01	0	R/W	
		D0	CFP00	P00 function selection	1	SIN0	0	P00	0	R/W	
Port function extension register	00402DF (B)	D7	CFEX7	P07 port extended function	1	#DMAEND3	0	P07, etc.	0	R/W	
		D6	CFEX6	P06 port extended function	1	#DMAACK3	0	P06, etc.	0	R/W	
		D5	CFEX5	P05 port extended function	1	#DMAEND2	0	P05, etc.	0	R/W	
		D4	CFEX4	P04 port extended function	1	#DMAACK2	0	P04, etc.	0	R/W	
		D3	CFEX3	P31 port extended function	1	#GARD	0	P31, etc.	0	R/W	
		D2	CFEX2	P21 port extended function	1	#GAAS	0	P21, etc.	0	R/W	
		D1	CFEX1	P10, P11, P13 port extended function	1	DST0 DST1 DPC0	0	P10, etc. P11, etc. P13, etc.	1	R/W	
		D0	CFEX0	P12, P14 port extended function	1	DST2 DCLK	0	P12, etc. P14, etc.	1	R/W	

CFP07–CFP00: P0[7:0] pin function selection (D[7:0]) / P0 function select register (0x402D0)

Selects the pins used for the serial interface.

Write "1": Serial-interface input/output pin

Write "0": I/O port pin

Read: Valid

Select the pins used for the serial interface from among P00 through P07 by writing "1" to CFP00 through CFP07. P00–P03 (SIN0, SOUT0, #SCLK0, #SRDY0) are used for channel 0; P04–P07 (SIN1, SOUT1, #SCLK1, #SRDY1) are used for channel 1. If the bit for a pin is set to "0", the pin functions as an I/O port.

The necessary input/output pins differ depending on the transfer mode set (see Table III-8.3).

At cold start, CFP is set to "0" (I/O port). At hot start, CFP retains its state from prior to the initial reset.

CFEX7–CFEX4: P0[7:4] pin function selection (D[7:4]) / Port function extension register (0x402DF)

Selects the extended function of pins P07–P04.

Write "1": Function-extended pin

Write "0": I/O-port/serial I/O pin

Read: Valid

When CFEX[7:4] is set to "1", the P07–P04 ports function as DMA signal output ports. When CFEX[7:4] = "0", the CFP0[7:4] bit becomes effective, so the settings of these bits determine whether the P07–P04 ports function as I/O ports or serial interface Ch.1 signal output ports.

At cold start, CFEX[7:4] is set to "0" (I/O-port/serial I/O pin). At hot start, CFEX[7:4] retains its state from prior to the initial reset.

TXD07–TXD00: Ch.0 transmit data (D[7:0]) / Serial I/F Ch.0 transmit data register (0x401E0)**TXD17–TXD10:** Ch.1 transmit data (D[7:0]) / Serial I/F Ch.1 transmit data register (0x401E5)

Sets transmit data.

When data is written to this register (transmit buffer) after "1" is written to TXENx, a transmit operation is begun. TDBEx is set to "1" (transmit-buffer empty) when the data is transferred to the shift register. A transmit-buffer empty interrupt factor is simultaneously generated. The next transmit data can be written to the buffer at any time thereafter, even when the serial interface is sending data.

In the 7-bit asynchronous mode, TXDx7 (MSB) is ignored.

The serial-converted data is output from the SOUT pin beginning with the LSB, in which the bits set to "1" are output as high-level signals and those set to "0" output as low-level signals.

This register can be read as well as written.

At initial reset, the content of TXDx becomes indeterminate.

RXD07–RXD00: Ch.0 receive data (D[7:0]) / Serial I/F Ch.0 receive data register (0x401E1)**RXD17–RXD10:** Ch.1 receive data (D[7:0]) / Serial I/F Ch.1 receive data register (0x401E6)

Stores received data.

When a receive operation is completed and the data received in the shift register is transferred to this register (receive buffer), RDBFx is set to "1" (receive buffer full). At the same time, a receive-buffer full interrupt factor is generated. Thereafter, the data can be read out at any time before a receive operation for the next data is completed. If the next data receive operation is completed before this register is read out, the data in it is overwritten with the newly received data, causing an overrun error to occur.

In the 7-bit asynchronous mode, "0" is stored in RXDx7.

The serial data input from the SINx pin is converted into parallel data beginning with the LSB, with the high-level signals changed to "1"s and the low-level signals changed to "0"s. The resulting data is stored in this buffer.

This register is a read-only register, so no data can be written to it.

At initial reset, the content of RXDx becomes indeterminate.

TEND0: Ch.0 transmit-completion flag (D5) / Serial I/F Ch.0 status register (0x401E2)

TEND1: Ch.1 transmit-completion flag (D5) / Serial I/F Ch.1 status register (0x401E7)

Indicates the transmission status.

Read "1": During transmitting

Read "0": End of transmission

Write: Invalid

TENDx goes "1" when data is being transmitted and goes "0" when the transmission has completed.

When data is transmitted successively in clock-synchronized master mode or asynchronous mode, TENDx maintains "1" until all data is transmitted (see Figure III-8.4 and Figure III-8.12). In clock-synchronized slave mode, TENDx goes "0" every time 1-byte data is transmitted (see Figure III-8.5).

At initial reset, TENDx is set to "0" (End of transmission).

FER0: Ch.0 framing-error flag (D4) / Serial I/F Ch.0 status register (0x401E2)

FER1: Ch.1 framing-error flag (D4) / Serial I/F Ch.1 status register (0x401E7)

Indicates whether a framing error occurred.

Read "1": An error occurred

Read "0": No error occurred

Write "1": Invalid

Write "0": Reset to "0"

The FERx flag is an error flag indicating whether a framing error occurred. When an error has occurred, it is set to "1". A framing error occurs when data with a stop bit = "0" is received in the asynchronous mode.

The FERx flag is reset by writing "0".

At initial reset, as well as when RXENx and TXENx both are set to "0", the FERx flag is set to "0" (no error).

PER0: Ch.0 parity-error flag (D3) / Serial I/F Ch.0 status register (0x401E2)

PER1: Ch.1 parity-error flag (D3) / Serial I/F Ch.1 status register (0x401E7)

Indicates whether a parity error occurred.

Read "1": An error occurred

Read "0": No error occurred

Write "1": Invalid

Write "0": Reset to "0"

The PERx flag is an error flag indicating whether a parity error occurred. When an error has occurred, it is set to "1". Parity checks are valid only in the asynchronous mode with EPRx set to "1" (parity added). This check is performed when the received data is transferred from the shift register to the receive data register.

The PERx flag is reset by writing "0".

At initial reset, as well as when RXENx and TXENx both are set to "0", PERx is set to "0" (no error).

OER0: Ch.0 overrun-error flag (D2) / Serial I/F Ch.0 status register (0x401E2)

OER1: Ch.1 overrun-error flag (D2) / Serial I/F Ch.1 status register (0x401E7)

Indicates whether an overrun error occurred.

Read "1": An error occurred

Read "0": No error occurred

Write "1": Invalid

Write "0": Reset to "0"

The OERx flag is an error flag indicating whether an overrun error occurred. When an error has occurred, it is set to "1". An overrun error occurs when the next receive operation is completed before the receive data register is read out, resulting in the receive data register being overwritten.

The OERx flag is reset by writing "0".

At initial reset, as well as when RXENx and TXENx both are set to "0", OERx is set to "0" (no error).

TDBE0: Ch.0 transmit data buffer empty (D1) / Serial I/F Ch.0 status register (0x401E2)

TDBE1: Ch.1 transmit data buffer empty (D1) / Serial I/F Ch.1 status register (0x401E7)

Indicates the status of the transmit data register (buffer).

Read "1": Buffer empty

Read "0": Buffer full

Write: Invalid

TDBEx is set to "0" when transmit data is written to the transmit data register, and is set to "1" when this data is transferred to the shift register (transmit operation started).

Transmit data is written to the transmit data register when this bit = "1".

At initial reset, TDBEx is set to "1" (buffer empty).

RDBF0: Ch.0 receive data buffer full (D0) / Serial I/F Ch.0 status register (0x401E2)

RDBF1: Ch.1 receive data buffer full (D0) / Serial I/F Ch.1 status register (0x401E7)

Indicates the status of the receive data register (buffer).

Read "1": Buffer full

Read "0": Buffer empty

Write: Invalid

RDBFx is set to "1" when the data received in the shift register is transferred to the receive data register (receive operation completed), indicating that the received data can be read out. This bit is reset to "0" when the data is read out.

At initial reset, RDBFx is set to "0" (buffer empty).

TXEN0: Ch.0 transmit enable (D7) / Serial I/F Ch.0 control register (0x401E3)

TXEN1: Ch.1 transmit enable (D7) / Serial I/F Ch.1 control register (0x401E8)

Enables each channel for transmit operations.

Write "1": Transmit enabled

Write "0": Transmit disabled

Read: Valid

When TXENx for a channel is set to "1", the channel is enabled for transmit operations. When TXENx is set to "0", the channel is disabled for transmit operations.

Always make sure the TXENx = "0" before setting the transfer mode and other conditions.

At initial reset, TXENx is set to "0" (transmit disabled).

RXEN0: Ch.0 receive enable (D6) / Serial I/F Ch.0 control register (0x401E3)

RXEN1: Ch.1 receive enable (D6) / Serial I/F Ch.1 control register (0x401E8)

Enables each channel for receive operations.

Write "1": Receive enabled

Write "0": Receive disabled

Read: Valid

When RXENx for a channel is set to "1", the channel is enabled for receive operations. When RXENx is set to "0", the channel is disabled for receive operations.

Always make sure the RXENx = "0" before setting the transfer mode and other conditions.

At initial reset, RXENx is set to "0" (receive disabled).

EPR0: Ch.0 parity enable (D5) / Serial I/F Ch.0 control register (0x401E3)

EPR1: Ch.1 parity enable (D5) / Serial I/F Ch.1 control register (0x401E8)

Selects a parity function.

Write "1": Parity added

Write "0": No parity added

Read: Valid

EPRx is used to select whether receive data is to be checked for parity, and whether a parity bit is to be added to transmit data. When EPRx is set to "1", the receive data is checked for parity. A parity bit is automatically added to the transmit data. When EPRx is set to "0", parity is not checked and no parity bit is added.

The parity function is only valid in the asynchronous mode. Settings of EPRx have no effect in the clock-synchronized mode.

At initial reset, EPRx becomes indeterminate.

PMD0: Ch.0 parity mode selection (D4) / Serial I/F Ch.0 control register (0x401E3)

PMD1: Ch.1 parity mode selection (D4) / Serial I/F Ch.1 control register (0x401E8)

Selects an odd or even parity.

Write "1": Odd parity

Write "0": Even parity

Read: Valid

Odd parity is selected by writing "1" to PMDx, and even parity is selected by writing "0". Parity check and the addition of a parity bit are only effective in asynchronous transfers in which EPRx is set to "1". If EPRx = "0", settings of PMDx do not have any effect.

At initial reset, PMDx becomes indeterminate.

STPB0: Ch.0 stop bit selection (D3) / Serial I/F Ch.0 control register (0x401E3)

STPB1: Ch.1 stop bit selection (D3) / Serial I/F Ch.1 control register (0x401E8)

Selects a stop-bit length during the performance of an asynchronous transfer.

Write "1": 2 bits

Write "0": 1 bit

Read: Valid

STPBx is only valid in an asynchronous transfer. Two stop bits are selected by writing "1" to STPBx, and one stop bit is selected by writing "0". The start bit is fixed at 1 bit.

Settings of STPBx are ignored during the performance of a clock-synchronized transfer.

At initial reset, STPBx becomes indeterminate.

SSCK0: Ch.0 input clock selection (D2) / Serial I/F Ch.0 control register (0x401E3)

SSCK1: Ch.1 input clock selection (D2) / Serial I/F Ch.1 control register (0x401E8)

Selects the clock source for an asynchronous transfer.

Write "1": #SCLK (external clock)

Write "0": Internal clock

Read: Valid

During operation in the asynchronous mode, this bit is used to select the clock source between an internal clock (output by an 8-bit programmable timer) and an external clock (input from the #SCLKx pin). An external clock is selected by writing "1" to this bit, and an internal clock is selected by writing "0".

At initial reset, SSCKx becomes indeterminate.

SMD01–SMD00: Ch.0 transfer mode selection (D[1:0]) / Serial I/F Ch.0 control register (0x401E3)

SMD11–SMD10: Ch.1 transfer mode selection (D[1:0]) / Serial I/F Ch.1 control register (0x401E8)

Sets the transfer mode of the serial interface as shown in Table III-8.11 below.

Table III-8.11 Setting of Transfer Mode

SMDx1	SMDx0	Transfer mode
1	1	8-bit asynchronous mode
1	0	7-bit asynchronous mode
0	1	Clock-synchronized slave mode
0	0	Clock-synchronized master mode

The SMDx bit can be read as well as written.

When using the IrDA interface, always be sure to set an asynchronous mode for the transfer mode.

At initial reset, SMDx becomes indeterminate.

DIVMD0: Sampling clock division ratio (D4) / Serial I/F Ch.0 IrDA register (0x401E4)

DIVMD1: Sampling clock division ratio (D4) / Serial I/F Ch.1 IrDA register (0x401E9)

Selects the division ratio of the sampling clock.

Write "1": 1/8

Write "0": 1/16

Read: Valid

Select the division ratio necessary to generate the sampling clock for asynchronous transfers. When DIVMDx is set to "1", the sampling clock is generated from the input clock of the serial interface (output by an 8-bit programmable timer or input from #SCLKx) by dividing it by 8. When DIVMDx is set to "0", the input clock is divided by 16.

At initial reset, DIVMDx becomes indeterminate.

IRTL0: Ch.0 IrDA output logic inversion (D3) / Serial I/F Ch.0 IrDA register (0x401E4)

IRTL1: Ch.1 IrDA output logic inversion (D3) / Serial I/F Ch.1 IrDA register (0x401E9)

Inverts the logic of the IrDA output signal.

Write "1": Inverted

Write "0": Not inverted

Read: Valid

When using the IrDA interface, set the logic of the SOUTx output signal to suit the infrared-ray communication circuit that is connected external to the chip. If IRTLx is set to "1", a high pulse is output when the output data = "0" (held low-level when the output data = "1"). If IRTLx is set to "0", a low pulse is output when the output data = "0" (held high-level when the output data = "1").

At initial reset, IRTLx becomes indeterminate.

IRRL0: Ch.0 IrDA input logic inversion (D2) / Serial I/F Ch.0 IrDA register (0x401E4)

IRRL1: Ch.1 IrDA input logic inversion (D2) / Serial I/F Ch.1 IrDA register (0x401E9)

Inverts the logic of the IrDA input signal.

Write "1": Inverted

Write "0": Not inverted

Read: Valid

When using the IrDA interface, set the logic of the signal that is input from an external infrared-ray communication circuit to the chip to suit the serial interface. If IRRLx is set to "1", a high pulse is input as a logic "0". If IRRLx is set to "0", a low pulse is input as a logic "0".

At initial reset, IRRLx becomes indeterminate.

IRMD01–IRMD00: Ch.0 IrDA interface mode selection (D[1:0]) / Serial I/F Ch.0 IrDA register (0x401E4)

IRMD11–IRMD10: Ch.1 IrDA interface mode selection (D[1:0]) / Serial I/F Ch.1 IrDA register (0x401E9)

Selects the IrDA interface function.

Table III-8.12 IrDA Interface Setting

IRMDx1	IRMDx0	Interface mode
1	1	Do not set. (reserved)
1	0	IrDA 1.0 interface
0	1	Do not set. (reserved)
0	0	Normal interface

When using the IrDA interface function, write "10" to IRMDx while setting to an asynchronous mode for the transfer mode. If the IrDA interface function is not to be used, write "00" to IRMDx.

At initial reset, IRMDx becomes indeterminate.

Note: This selection must always be performed before the transfer mode and other conditions are set.

PSIO02–PSIO00: Ch.0 interrupt level (D[6:4]) / 8-bit timer, serial I/F Ch.0 interrupt priority register (0x40269)

PSIO12–PSIO10: Ch.1 interrupt level (D[2:0]) / Serial I/F Ch.1, A/D interrupt priority register (0x4026A)

Sets the priority level of the serial-interface interrupt.

The interrupt priority level can be set for each channel in the range of 0 to 7.

At initial reset, PSIOx becomes indeterminate.

ESERR0, ESRX0, ESTX0: Ch.0 interrupt enable (D0,D1,D2) / Serial I/F interrupt enable register (0x40276)

ESERR1, ESRX1, ESTX1: Ch.1 interrupt enable (D3,D4,D5) / Serial I/F interrupt enable register (0x40276)

Enable or disable interrupt generation to the CPU.

Write "1": Interrupt enabled

Write "0": Interrupt disabled

Read: Valid

The ESERRx, ESRXx, and ESTXx bits are interrupt enable bits corresponding to receive-error, receive-buffer full, and transmit-buffer empty interrupt factors, respectively, in each channel. The interrupts for which this bit is set to "1" are enabled, and the interrupts for which this bit is set to "0" are disabled.

At initial reset, all these bits are set to "0" (interrupts disabled).

FSERR0, FSRX0, FSTX0: Ch.0 interrupt factor flags (D0,D1,D2) / Serial I/F interrupt factor flag register (0x40286)

FSERR1, FSRX1, FSTX1: Ch.1 interrupt factor flags (D3,D4,D5) / Serial I/F interrupt factor flag register (0x40286)

Indicate the status of serial-interface interrupt generation.

When read

Read "1": An interrupt factor occurred

Read "0": No interrupt factor occurred

When written using the reset-only method (default)

Write "1": Flag is reset

Write "0": Invalid

When written using the read/write method

Write "1": Flag is set

Write "0": Flag is reset

The FSERRx, FSRXx, and FSTXx flags are interrupt factor flags corresponding to receive-error, receive-buffer full, and transmit-buffer empty interrupts, respectively, in each channel. The flag is set to "1" when each interrupt factor occurs.

A transmit-buffer empty interrupt factor occurs when transmit data is transferred from the transmit data register to the shift register.

A receive-buffer full interrupt factor occurs when receive data is transferred from the shift register to the receive data register.

A receive-error interrupt factor occurs when a parity, framing, or overrun error is detected during reception of data. At this time, if the following conditions are met, an interrupt to the CPU is generated:

1. The corresponding interrupt enable register bit is set to "1".
2. No other interrupt request of a higher priority has been generated.
3. The PSR's IE bit is set to "1" (interrupts enabled).
4. The set value of the corresponding interrupt priority register is higher than the CPU interrupt level (IL).

When using the receive-buffer full or transmit-buffer empty interrupt factor as an IDMA request, the fact that the above conditions are met does not necessarily mean that an interrupt request to the CPU has been output simultaneously when an interrupt factor occurs. An interrupt is generated under the above conditions upon completion of the data transfer by IDMA, provided that interrupts are enabled by settings on the IDMA side.

The interrupt factor flag is set to "1" whenever an interrupt factor occurs, regardless of the settings of the interrupt-enable and interrupt priority registers.

If the next interrupt is to be accepted following the occurrence of an interrupt, it is necessary that the interrupt factor flag be reset, and that the PSR be set up again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can only be reset by writing to it in the software. Note that if the PSR is set up again to accept interrupts generated (or if the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

At initial reset, all of these flags become indeterminate, so be sure to reset them in the software.

RSRX0, RSTX0: Ch.0 IDMA request (D6, D7) /

16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register (0x40292)

RSRX1, RSTX1: Ch.1 IDMA request (D0, D1) / Serial I/F Ch.1, A/D IDMA request register (0x40293)

Specifies whether to invoke IDMA when an interrupt factor occurs.

When using the set-only method (default)

Write "1": IDMA request

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA request

Write "0": Interrupt request

Read: Valid

The RSRXx and RSTXx bits are IDMA request bits corresponding to receive-buffer full and transmit-buffer empty interrupt factors, respectively. If the bit is set to "1", IDMA is invoked when an interrupt factor occurs, thus performing a programmed data transfer. If this bit is set to "0", normal interrupt processing is performed, without invoking IDMA.

For details on IDMA, refer to "IDMA (Intelligent DMA)".

At initial reset, these bits are set to "0" (interrupt request).

DESRX0, DESTX0: Ch.0 IDMA enable (D6, D7) /

16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register (0x40296)

DESRX1, DESTX1: Ch.1 IDMA enable (D0, D1) / Serial I/F Ch.1, A/D IDMA enable register (0x40297)

Enables IDMA transfer by means of an interrupt factor.

When using the set-only method (default)

Write "1": IDMA enabled

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA enabled

Write "0": IDMA disabled

Read: Valid

The DESRXx and DESTXx bits are IDMA enable bits corresponding to receive-buffer full and transmit-buffer empty interrupt factors, respectively. If the bit is set to "1", the IDMA request by the interrupt factor is enabled. If the bit is set to "0", the IDMA request is disabled.

At initial reset, these bits are set to "0" (IDMA disabled).

Programming Notes

- (1) Before setting various serial-interface parameters, make sure the transmit and receive operations are disabled (TXEN_x = RXEN_x = "0").
- (2) When the serial interface is transmitting or receiving data, do not set TXEN_x or RXEN_x to "0", and do not execute the slp instruction.
- (3) In clock-synchronized transfers, the mode of communication is half-duplex, in which the clock line is shared between the transmit and receive units. Therefore, RXEN_x and TXEN_x cannot be enabled simultaneously.
- (4) After an initial reset, the interrupt factor flag becomes indeterminate. To prevent generation of an unwanted interrupt or IDMA request, reset this flag in the program.
- (5) If a receive error occurs, the receive-error interrupt and receive-buffer full interrupt factors occur simultaneously. However, since the receive-error interrupt has priority over the receive-buffer full interrupt, the receive-error interrupt is processed first. Therefore, it is necessary to reset the receive-buffer full interrupt factor flag through the use of the receive-error interrupt processing routine.
- (6) To prevent the regeneration of interrupts due to the same factor following the occurrence of an interrupt, always be sure to reset the interrupt factor flag before setting the PSR again or executing the reti instruction.
- (7) Follow the procedure described below to initialize the serial interface.

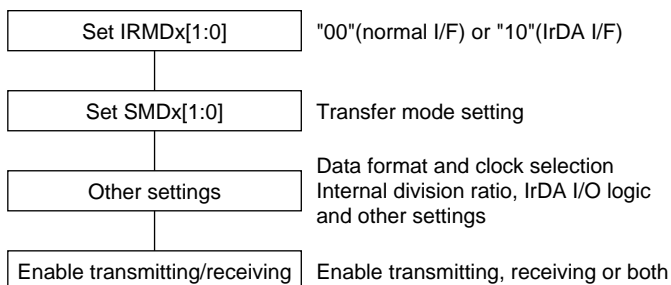


Figure III-8.18 Serial Interface Initialize Procedure

- (8) When transmitting data in the clock-synchronized master mode, transmit data is written to the transmit data register after the initial setting is performed following the flow in item (7). However, the clock generated by the 8-bit timer must be supplied to the serial interface (at least one underflow has had to have occurred in the 8-bit tier) before this writing. Otherwise, 0xFF will be transmitted prior to the written data.
- (9) The maximum transfer rate of the serial interface is limited to 1 Mbps.

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III-9 INPUT/OUTPUT PORTS

The Peripheral Block has a total of 42 input/output ports. Although each pin is used for input/output from/to the internal peripheral circuits, some pins can be used as general-purpose input/output ports unless they are used for the peripheral circuits.

Input Ports (K Ports)

Structure of Input Port

The Peripheral Block contains 13 bits of input ports (K50 to K54, K60 to K67).

Figure III-9.1 shows the structure of a typical input port.

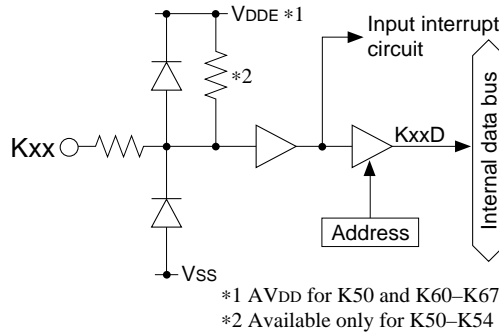


Figure III-9.1 Structure of Input Port

Each input-port pin is connected directly to the internal data bus via a three-state buffer. The state of the input signal when read at an input port is directly taken into the internal circuit as data.

Input-Port Pins

The input pins concurrently serve as the input pins for peripheral circuits, as shown in Table III-9.1. Whether they are used as input ports or for peripheral circuits can be set bit-for-bit using a function select register. All pins not used for peripheral circuits can be used as general-purpose input ports that have an interrupt function.

Table III-9.1 Input Pins

Pin name	I/O	Pull-up	Function	Function select bit
K50/#DMAREQ0	I	Available	Input port / High-speed DMA request 0	CFK50(D0)/K5 function select register(0x402C0)
K51/#DMAREQ1	I	Available	Input port / High-speed DMA request 1	CFK51(D1)/K5 function select register(0x402C0)
K52/#ADTRG	I	Available	Input port / AD converter trigger	CFK52(D2)/K5 function select register(0x402C0)
K53/#DMAREQ2	I	Available	Input port / High-speed DMA request 2	CFK53(D3)/K5 function select register(0x402C0)
K54/#DMAREQ3	I	Available	Input port / High-speed DMA request 3	CFK54(D4)/K5 function select register(0x402C0)
K60/AD0	I	–	Input port / AD converter input 0	CFK60(D0)/K6 function select register(0x402C3)
K61/AD1	I	–	Input port / AD converter input 1	CFK61(D1)/K6 function select register(0x402C3)
K62/AD2	I	–	Input port / AD converter input 2	CFK62(D2)/K6 function select register(0x402C3)
K63/AD3	I	–	Input port / AD converter input 3	CFK63(D3)/K6 function select register(0x402C3)
K64/AD4	I	–	Input port / AD converter input 4	CFK64(D4)/K6 function select register(0x402C3)
K65/AD5	I	–	Input port / AD converter input 5	CFK65(D5)/K6 function select register(0x402C3)
K66/AD6	I	–	Input port / AD converter input 6	CFK66(D6)/K6 function select register(0x402C3)
K67/AD7	I	–	Input port / AD converter input 7	CFK67(D7)/K6 function select register(0x402C3)

At cold start, all pins are set for input ports Kxx (function select register CFKxx = "0"). When these pins are used for the internal peripheral circuits, write "1" to CFKxx. For details on pin functions in this case, refer to the description of each peripheral circuit in this manual.

At hot start, the pins retain their state from prior to the reset.

When the ports set for A/D converter input are read, the value obtained is always "0".

Notes on Use

The input buffers of the K50 and K60 to K67 ports use AVDD (power voltage for A/D converter) as their power source. Furthermore, the K50 pull-up resistor is connected to AVDD. Therefore, the following precautions must be taken.

- 1) When using K50 and K60–K67 as general-purpose input ports, the voltage input to the port must be high level = AVDD and low level = VSS.
- 2) When using VDDE as high level similar to other ports, VDDE must be the same voltage level as AVDDE. If the input VDDE level is lower than the AVDDE level, current flows in the input buffer, or if the input VDDE level is higher than the AVDDE level, current flows from the VDDE power supply to the AVDDE power supply.
- 3) To fix the input level externally when the port is not used, the input pin should be connected to VSS or AVDD.

I/O Memory of Input Ports

Table III-9.2 shows the control bits of the input ports.

Table III-9.2 Control Bits of Input Ports

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
K5 function select register	00402C0 (B)	D7-5	--	reserved			--	--	0 when being read.	
		D4	CFK54	K54 function selection	1	#DMAREQ3	0	K54	0	R/W
		D3	CFK53	K53 function selection	1	#DMAREQ2	0	K53	0	R/W
		D2	CFK52	K52 function selection	1	#ADTRG	0	K52	0	R/W
		D1	CFK51	K51 function selection	1	#DMAREQ1	0	K51	0	R/W
		D0	CFK50	K50 function selection	1	#DMAREQ0	0	K50	0	R/W
K5 input port data register	00402C1 (B)	D7-5	--	reserved			--	--	0 when being read.	
		D4	K54D	K54 input port data	1	High	0	Low	--	R
		D3	K53D	K53 input port data					--	R
		D2	K52D	K52 input port data					--	R
		D1	K51D	K51 input port data					--	R
		D0	K50D	K50 input port data					--	R
K6 function select register	00402C3 (B)	D7	CFK67	K67 function selection	1	AD7	0	K67	0	R/W
		D6	CFK66	K66 function selection	1	AD6	0	K66	0	R/W
		D5	CFK65	K65 function selection	1	AD5	0	K65	0	R/W
		D4	CFK64	K64 function selection	1	AD4	0	K64	0	R/W
		D3	CFK63	K63 function selection	1	AD3	0	K63	0	R/W
		D2	CFK62	K62 function selection	1	AD2	0	K62	0	R/W
		D1	CFK61	K61 function selection	1	AD1	0	K61	0	R/W
		D0	CFK60	K60 function selection	1	AD0	0	K60	0	R/W
K6 input port data register	00402C4 (B)	D7	K67D	K67 input port data	1	High	0	Low	--	R
		D6	K66D	K66 input port data					--	R
		D5	K65D	K65 input port data					--	R
		D4	K64D	K64 input port data					--	R
		D3	K63D	K63 input port data					--	R
		D2	K62D	K62 input port data					--	R
		D1	K61D	K61 input port data					--	R
		D0	K60D	K60 input port data					--	R

CFK54–CFK50: K5[4:0] function selection (D[4:0]) / K5 function select register (0x402C0)

CFK67–CFK60: K6[7:0] function selection (D[7:0]) / K6 function select register (0x402C3)

Selects the function of each input-port pin.

Write "1": Used for peripheral circuit

Write "0": Input port pin

Read: Invalid

When a bit of the CFK register is set to "1", the corresponding pin is set for use with the peripheral circuit (see Table III-9.1). The pins for which register bits are set to "0" can be used as general-purpose input ports.

At cold start, CFK is set to "0" (input port). At hot start, CFK retains its state from prior to the initial reset.

K54D–K50D: K5[4:0] input port data (D[4:0]) / K5 input port data register (0x402C1)

K67D–K60D: K6[7:0] input port data (D[7:0]) / K6 input port data register (0x402C4)

The input data on each input port pin can be read from this register.

Read "1": High level

Read "0": Low level

Write: Invalid

The pin voltage of each input port can be read out "1" directly when the voltage is high (V_{DD}) or "0" when the voltage is low (V_{SS}) respectively.

Since this register is a read-only register, writing to the register is ignored.

When the ports set for A/D converter input are read, the value obtained is always "0".

I/O Ports (P Ports)

Structure of I/O Port

The Peripheral Block contains 29 bits of I/O ports (P00 to P07, P10 to P16, P20 to P27, P30 to P35) that can be directed for input or output through the use of a program.

Figure III-9.2 shows the structure of a typical I/O port.

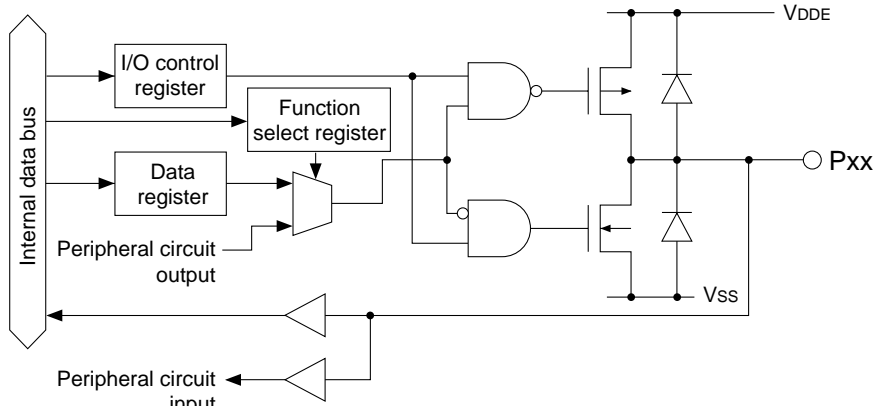


Figure III-9.2 Structure of I/O Port

I/O Port Pins

The I/O ports concurrently serve as the input/output pins for peripheral circuits, as shown in Table III-9.3.

Whether they are used as I/O ports or for peripheral circuits can be set bit-for-bit using a function select register.

All pins not used for peripheral circuits can be used as general-purpose I/O ports.

Table III-9.3 I/O Pins

Pin name	I/O	Pull-up	Function	Function select bit
P00/SIN0	I/O	-	I/O port / Serial IF Ch.0 data input	CFP00(D0)/P0 function select register(0x402D0)
P01/SOUT0	I/O	-	I/O port / Serial IF Ch.0 data output	CFP01(D1)/P0 function select register(0x402D0)
P02/#SCLK0	I/O	-	I/O port / Serial IF Ch.0 clock input/output	CFP02(D2)/P0 function select register(0x402D0)
P03/#SRDY0	I/O	-	I/O port / Serial IF Ch.0 ready input/output	CFP03(D3)/P0 function select register(0x402D0)
P04/SIN1/ #DMAACK2	I/O	-	I/O port / Serial IF Ch.1 data input / #DMAACK2 output (Ex)	CFP04(D4)/P0 function select register(0x402D0) CFEX4(D4)/Port function extension register(0x402DF)
P05/SOUT1/ #DMAEND2	I/O	-	I/O port / Serial IF Ch.1 data output / #DMAEND2 output (Ex)	CFP05(D5)/P0 function select register(0x402D0) CFEX5(D5)/Port function extension register(0x402DF)
P06/#SCLK1/ #DMAACK3	I/O	-	I/O port / Serial IF Ch.1 clock input/output / #DMAACK3 output (Ex)	CFP06(D6)/P0 function select register(0x402D0) CFEX6(D6)/Port function extension register(0x402DF)
P07/#SRDY1/ #DMAEND3	I/O	-	I/O port / Serial IF Ch.1 ready input/output / #DMAEND3 output (Ex)	CFP07(D7)/P0 function select register(0x402D0) CFEX7(D7)/Port function extension register(0x402DF)
P10/EXCL0/ T8UF0/DST0 *	I/O	-	I/O port / 16-bit timer 0 event counter input (I) / 8-bit timer 0 output (O) / DST0 output (Ex)	CFP10(D0)/P1 function select register(0x402D4) CFEX1(D1)/Port function extension register(0x402DF)
P11/EXCL1/ T8UF1/DST1 *	I/O	-	I/O port / 16-bit timer 1 event counter input (I) / 8-bit timer 1 output (O) / DST1 output (Ex)	CFP11(D1)/P1 function select register(0x402D4) CFEX1(D1)/Port function extension register(0x402DF)
P12/EXCL2/ T8UF2/DST2 *	I/O	-	I/O port / 16-bit timer 2 event counter input (I) / 8-bit timer 2 output (O) / DST2 output (Ex)	CFP12(D2)/P1 function select register(0x402D4) CFEX0(D0)/Port function extension register(0x402DF)
P13/EXCL3/ T8UF3/DPCO *	I/O	-	I/O port / 16-bit timer 3 event counter input (I) / 8-bit timer 3 output (O) / DPCO output (Ex)	CFP13(D3)/P1 function select register(0x402D4) CFEX1(D1)/Port function extension register(0x402DF)
P14/FOSC1/ DCLK *	I/O	-	I/O port / Low-speed (OSC1) clock output / DCLK output (Ex)	CFP14(D4)/P1 function select register(0x402D4) CFEX0(D0)/Port function extension register(0x402DF)
P15/EXCL4/ #DMAEND0	I/O	-	I/O port / 16-bit timer 4 event counter input (I) / #DMAEND0 output (O)	CFP15(D5)/P1 function select register(0x402D4)
P16/EXCL5/ #DMAEND1	I/O	-	I/O port / 16-bit timer 5 event counter input (I) / #DMAEND1 output (O)	CFP16(D6)/P1 function select register(0x402D4)

(I): Input mode, (O): Output mode, (Ex): Extended function

*: A 3-V system I/O voltage can only be used for the P10–P14 pins.

Pin name	I/O	Pull-up	Function	Function select bit
P20/#DRD	I/O	–	I/O port / #DRD output	CFP20(D0)/P2 function select register(0x402D8)
P21/#DWE/#GA AS	I/O	–	I/O port / #DWE output / GA address strobe output (Ex)	CFP21(D1)/P2 function select register(0x402D8) CFEX2(D2)/Port function extension register(0x402DF)
P22/TM0	I/O	–	I/O port / 16-bit timer 0 output	CFP22(D2)/P2 function select register(0x402D8)
P23/TM1	I/O	–	I/O port / 16-bit timer 1 output	CFP23(D3)/P2 function select register(0x402D8)
P24/TM2	I/O	–	I/O port / 16-bit timer 2 output	CFP24(D4)/P2 function select register(0x402D8)
P25/TM3	I/O	–	I/O port / 16-bit timer 3 output	CFP25(D5)/P2 function select register(0x402D8)
P26/TM4	I/O	–	I/O port / 16-bit timer 4 output	CFP26(D6)/P2 function select register(0x402D8)
P27/TM5	I/O	–	I/O port / 16-bit timer 5 output	CFP27(D7)/P2 function select register(0x402D8)
P30/#WAIT/ #CE4&5	I/O	–	I/O port / #WAIT input (I) / #CE4&5 output (O)	CFP30(D0)/P3 function select register(0x402DC)
P31/#BUSGET/ #GARD	I/O	–	I/O port / #BUSGET output / GA read signal output (Ex)	CFP31(D1)/P3 function select register(0x402DC) CFEX3(D3)/Port function extension register(0x402DF)
P32/#DMAACK0	I/O	–	I/O port / #DMAACK0 output	CFP32(D2)/P3 function select register(0x402DC)
P33/#DMAACK1	I/O	–	I/O port / #DMAACK1 output	CFP33(D3)/P3 function select register(0x402DC)
P34/#BUSREQ/ #CE6	I/O	–	I/O port / #BUSREQ input (I) / #CE6 output (O)	CFP34(D4)/P3 function select register(0x402DC)
P35/#BUSACK	I/O	–	I/O port / #BUSACK output	CFP35(D5)/P3 function select register(0x402DC)

(I): Input mode, (O): Output mode, (Ex): Extended function

At cold start, all pins are set for I/O ports Pxx (function select register CFPxx = "0"). When these pins are used for the internal peripheral circuits, write "1" to CFPxx. For details on pin functions in this case, refer to the description of each peripheral circuit in this manual.

At hot start, the pins retain their state from prior to the reset.

In addition to being an I/O port, the P10–P13, P15–P16, P30 and P34 pins are shared with two types (three types for P10–P13) of peripheral circuits. The type of peripheral circuit for which these pins are used is determined by the direction (input or output) in which the pin is set using an I/O control register, as will be described later.

The P04–P07, P10–P14, P21 and P31 ports have extended functions indicated with (Ex) in the table. They can be selected by writing "1" to CFEXx / Port function extension register (0x402DF).

The setting of CFEXx has priority over the CFPxx.

At cold start, CFEX1 and CFEX0 are set to "1", so the P10–P14 pins are set for debug signal outputs.

I/O Control Register and I/O Modes

The I/O ports are directed for input or output modes by writing data to an I/O control register corresponding to each port bit.

P07–P00 I/O control: IOC0[7:0] (D[7:0]) / P0 I/O control register (0x402D2)

P16–P10 I/O control: IOC1[6:0] (D[6:0]) / P1 I/O control register (0x402D6)

P27–P20 I/O control: IOC2[7:0] (D[7:0]) / P2 I/O control register (0x402DA)

P35–P30 I/O control: IOC3[5:0] (D[5:0]) / P3 I/O control register (0x402DE)

To set an I/O port for input, write "0" to the I/O control bit. I/O ports set for input mode are placed in the high-impedance state, and thus function as input ports.

In the input mode, the state of the input pin is read directly, so the data is "1" when the pin state is high (VDD level) or "0" when the pin state is low (VSS level).

Even in the input mode, data can be written to the data register without affecting the pin state.

To set an I/O port for output, write "1" to the I/O control bit. I/O port set for output function as output ports. When the port output data is "1", the port outputs a high level (VDD level); when the data is "0", the port outputs a low level (VSS level).

At cold start, the I/O control register is set to "0" (input mode).

At hot start, the pins retain their state from prior to the reset.

Note: If pins P10–P13, P15–P16, P30 and P34 are set for use with peripheral circuits, their pin functions vary depending on the input/output direction control by the IOC1x register.

I/O Memory of I/O Ports

Table III-9.4 shows the control bits of the I/O ports.

Table III-9.4 Control Bits of I/O Ports

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks		
P0 function select register	00402D0 (B)	D7	CFP07	P07 function selection	1	#SRDY1	0	P07	0	R/W	Extended functions (0x402DF)
		D6	CFP06	P06 function selection	1	#SCLK1	0	P06	0	R/W	
		D5	CFP05	P05 function selection	1	SOUT1	0	P05	0	R/W	
		D4	CFP04	P04 function selection	1	SIN1	0	P04	0	R/W	
		D3	CFP03	P03 function selection	1	#SRDY0	0	P03	0	R/W	
		D2	CFP02	P02 function selection	1	#SCLK0	0	P02	0	R/W	
		D1	CFP01	P01 function selection	1	SOUT0	0	P01	0	R/W	
		D0	CFP00	P00 function selection	1	SIN0	0	P00	0	R/W	
P0 I/O port data register	00402D1 (B)	D7	P07D	P07 I/O port data	1	High	0	Low	0	R/W	
		D6	P06D	P06 I/O port data					0	R/W	
		D5	P05D	P05 I/O port data					0	R/W	
		D4	P04D	P04 I/O port data					0	R/W	
		D3	P03D	P03 I/O port data					0	R/W	
		D2	P02D	P02 I/O port data					0	R/W	
		D1	P01D	P01 I/O port data					0	R/W	
		D0	P00D	P00 I/O port data					0	R/W	
P0 I/O control register	00402D2 (B)	D7	IOC07	P07 I/O control	1	Output	0	Input	0	R/W	
		D6	IOC06	P06 I/O control					0	R/W	
		D5	IOC05	P05 I/O control					0	R/W	
		D4	IOC04	P04 I/O control					0	R/W	
		D3	IOC03	P03 I/O control					0	R/W	
		D2	IOC02	P02 I/O control					0	R/W	
		D1	IOC01	P01 I/O control					0	R/W	
		D0	IOC00	P00 I/O control					0	R/W	
P1 function select register	00402D4 (B)	D7	–	reserved	–		–	–	–	–	0 when being read.
		D6	CFP16	P16 function selection	1	EXCL5 #DMAEND1	0	P16	0	R/W	Extended functions (0x402DF)
		D5	CFP15	P15 function selection	1	EXCL4 #DMAEND0	0	P15	0	R/W	
		D4	CFP14	P14 function selection	1	FOSC1	0	P14	0	R/W	
		D3	CFP13	P13 function selection	1	EXCL3 T8UF3	0	P13	0	R/W	
		D2	CFP12	P12 function selection	1	EXCL2 T8UF2	0	P12	0	R/W	
		D1	CFP11	P11 function selection	1	EXCL1 T8UF1	0	P11	0	R/W	
D0	CFP10	P10 function selection	1	EXCL0 T8UF0	0	P10	0	R/W			
P1 I/O port data register	00402D5 (B)	D7	–	reserved	–		–	–	–	–	0 when being read.
		D6	P16D	P16 I/O port data	1	High	0	Low	0	R/W	
		D5	P15D	P15 I/O port data					0	R/W	
		D4	P14D	P14 I/O port data					0	R/W	
		D3	P13D	P13 I/O port data					0	R/W	
		D2	P12D	P12 I/O port data					0	R/W	
		D1	P11D	P11 I/O port data					0	R/W	
		D0	P10D	P10 I/O port data					0	R/W	
P1 I/O control register	00402D6 (B)	D7	–	reserved					–		
		D6	IOC16	P16 I/O control	1	Output	0	Input	0	R/W	
		D5	IOC15	P15 I/O control					0	R/W	
		D4	IOC14	P14 I/O control					0	R/W	
		D3	IOC13	P13 I/O control					0	R/W	
		D2	IOC12	P12 I/O control					0	R/W	
		D1	IOC11	P11 I/O control					0	R/W	
		D0	IOC10	P10 I/O control					0	R/W	
P2 function select register	00402D8 (B)	D7	CFP27	P27 function selection					1	TM5	
		D6	CFP26	P26 function selection	1	TM4	0	P26	0	R/W	
		D5	CFP25	P25 function selection	1	TM3	0	P25	0	R/W	
		D4	CFP24	P24 function selection	1	TM2	0	P24	0	R/W	
		D3	CFP23	P23 function selection	1	TM1	0	P23	0	R/W	
		D2	CFP22	P22 function selection	1	TM0	0	P22	0	R/W	
		D1	CFP21	P21 function selection	1	#DWE	0	P21	0	R/W	
		D0	CFP20	P20 function selection	1	#DRD	0	P20	0	R/W	

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
P2 I/O port data register	00402D9 (B)	D7	P27D	P27 I/O port data	1	High	0	Low	0	R/W	
		D6	P26D	P26 I/O port data					0	R/W	
		D5	P25D	P25 I/O port data					0	R/W	
		D4	P24D	P24 I/O port data					0	R/W	
		D3	P23D	P23 I/O port data					0	R/W	
		D2	P22D	P22 I/O port data					0	R/W	
		D1	P21D	P21 I/O port data					0	R/W	
		D0	P20D	P20 I/O port data					0	R/W	
P2 I/O control register	00402DA (B)	D7	IOC27	P27 I/O control	1	Output	0	Input	0	R/W	
		D6	IOC26	P26 I/O control					0	R/W	
		D5	IOC25	P25 I/O control					0	R/W	
		D4	IOC24	P24 I/O control					0	R/W	
		D3	IOC23	P23 I/O control					0	R/W	
		D2	IOC22	P22 I/O control					0	R/W	
		D1	IOC21	P21 I/O control					0	R/W	
		D0	IOC20	P20 I/O control					0	R/W	
P3 function select register	00402DC (B)	D7-6	-	reserved					-	-	0 when being read.
		D5	CFP35	P35 function selection	1	#BUSACK	0	P35	0	R/W	
		D4	CFP34	P34 function selection	1	#BUSREQ #CE6	0	P34	0	R/W	
		D3	CFP33	P33 function selection	1	#DMAACK1	0	P33	0	R/W	
		D2	CFP32	P32 function selection	1	#DMAACK0	0	P32	0	R/W	
		D1	CFP31	P31 function selection	1	#BUSGET	0	P31	0	R/W	
		D0	CFP30	P30 function selection	1	#WAIT #CE4/#CE5	0	P30	0	R/W	
P3 I/O port data register	00402DD (B)	D7-6	-	reserved					-	-	
		D5	P35D	P35 I/O port data	1	High	0	Low	0	R/W	
		D4	P34D	P34 I/O port data					0	R/W	
		D3	P33D	P33 I/O port data					0	R/W	
		D2	P32D	P32 I/O port data					0	R/W	
		D1	P31D	P31 I/O port data					0	R/W	
		D0	P30D	P30 I/O port data					0	R/W	
P3 I/O control register	00402DE (B)	D7-6	-	reserved							
		D5	IOC35	P35 I/O control	1	Output	0	Input	0	R/W	
		D4	IOC34	P34 I/O control					0	R/W	
		D3	IOC33	P33 I/O control					0	R/W	
		D2	IOC32	P32 I/O control					0	R/W	
		D1	IOC31	P31 I/O control					0	R/W	
		D0	IOC30	P30 I/O control					0	R/W	
Port function extension register	00402DF (B)	D7	CFEX7	P07 port extended function					1	#DMAEND3	
		D6	CFEX6	P06 port extended function	1	#DMAACK3	0	P06, etc.	0	R/W	
		D5	CFEX5	P05 port extended function	1	#DMAEND2	0	P05, etc.	0	R/W	
		D4	CFEX4	P04 port extended function	1	#DMAACK2	0	P04, etc.	0	R/W	
		D3	CFEX3	P31 port extended function	1	#GARD	0	P31, etc.	0	R/W	
		D2	CFEX2	P21 port extended function	1	#GAAS	0	P21, etc.	0	R/W	
		D1	CFEX1	P10, P11, P13 port extended function	1	DST0 DST1 DPC0	0	P10, etc. P11, etc. P13, etc.	1	R/W	
		D0	CFEX0	P12, P14 port extended function	1	DST2 DCLK	0	P12, etc. P14, etc.	1	R/W	

CFP07–CFP00: P0[7:0] function selection (D[7:0]) / P0 function select register (0x402D0)
CFP16–CFP10: P1[6:0] function selection (D[6:0]) / P1 function select register (0x402D4)
CFP27–CFP20: P2[7:0] function selection (D[7:0]) / P2 function select register (0x402D8)
CFP35–CFP30: P3[5:0] function selection (D[5:0]) / P3 function select register (0x402DC)

Selects the function of each I/O port pin.

- Write "1": Used for peripheral circuit
- Write "0": I/O port pin
- Read: Valid

When a bit of the CFP register is set to "1", the corresponding pin is set for use with peripheral circuits (see Table III-9.3). The pins for which register bits are set to "0" can be used as general-purpose I/O ports.

At cold start, CFP is set to "0" (I/O port). At hot start, CFP retains its state from prior to the initial reset.

P07D–P00D: P0[7:0] I/O port data (D[7:0]) / P0 I/O port data register (0x402D1)
P16D–P10D: P1[6:0] I/O port data (D[6:0]) / P1 I/O port data register (0x402D5)
P27D–P20D: P2[7:0] I/O port data (D[7:0]) / P2 I/O port data register (0x402D9)
P35D–P30D: P3[5:0] I/O port data (D[5:0]) / P3 I/O port data register (0x402DD)

This register reads data from I/O-port pins or sets output data.

When writing data

Write "1": High level

Write "0": Low level

When an I/O port is set for output, the data written to it is directly output to the I/O port pin. If the data written to the port is "1", the port pin is set high (VDD and VDDE level); if the data is "0", the port pin is set low (VSS level). Even in the input mode, data can be written to the port data register.

When reading data

Read "1": High level

Read "0": Low level

The voltage level on the port pin is read out regardless of whether an I/O port is set for input or output mode. If the pin voltage is high (VDD and VDDE level), "1" is read out as input data; if the pin voltage is low (VSS level), "0" is read out as input data.

At cold start, all data bits are set to "0". At hot start, they retain their state from prior to the initial reset.

IOC07–IOC00: P0[7:0] port I/O control (D[7:0]) / P0 port I/O control register (0x402D2)
IOC16–IOC10: P1[6:0] port I/O control (D[6:0]) / P1 port I/O control register (0x402D6)
IOC27–IOC20: P2[7:0] port I/O control (D[7:0]) / P2 port I/O control register (0x402DA)
IOC35–IOC30: P3[5:0] port I/O control (D[5:0]) / P3 port I/O control register (0x402DE)

Directs an I/O port for input or output.

Write "1": Output mode

Write "0": Input mode

Read: Valid

This I/O control register corresponds bit-for-bit to each I/O port. When an IOC bit is set to "1", the corresponding I/O port is directed for output; if it is set to "0", the I/O port is directed for input.

At cold start, all IOC bits are set to "0" (input). At hot start, IOC retains its state from prior to the initial reset.

If pins P10–P13, P15–P16, P30 and P34 are set for use with peripheral circuits, their pin functions vary depending on the input/output direction control by the IOC1x register.

CFEX0: P12, P14 function extension (D0) / Port function extension register (0x402DF)
CFEX1: P10, P11, P13 function extension (D1) / Port function extension register (0x402DF)
CFEX2: P21 function extension (D2) / Port function extension register (0x402DF)
CFEX3: P31 function extension (D3) / Port function extension register (0x402DF)
CFEX4: P04 function extension (D4) / Port function extension register (0x402DF)
CFEX5: P05 function extension (D5) / Port function extension register (0x402DF)
CFEX6: P06 function extension (D6) / Port function extension register (0x402DF)
CFEX7: P07 function extension (D7) / Port function extension register (0x402DF)

Sets whether the function of an I/O-port pin is to be extended.

Write "1": Function-extended pin
Write "0": I/O-port/peripheral-circuit pin
Read: Valid

When CFEXx is set to "1", the corresponding pin is set to the extended function input/output pin. When CFEXx = "0", the corresponding CFP bit becomes effective.

At cold start, CFEX0 and CFEX1 are set to "1" (function-extended pin) and other bits are set to "0" (I/O-port/peripheral-circuit pin). At hot start, CFEX retains its state from prior to the initial reset.

Input Interrupt

The input ports and the I/O ports support eight system of port input interrupts and two systems of key input interrupts.

Port Input Interrupt

The port input interrupt circuit has eight interrupt systems (FPT7–FPT0) and a port can be selected for generating each interrupt factor.

The interrupt condition can also be selected from between input signal edge and input signal level.

Figure III-9.3 shows the configuration of the port input interrupt circuit.

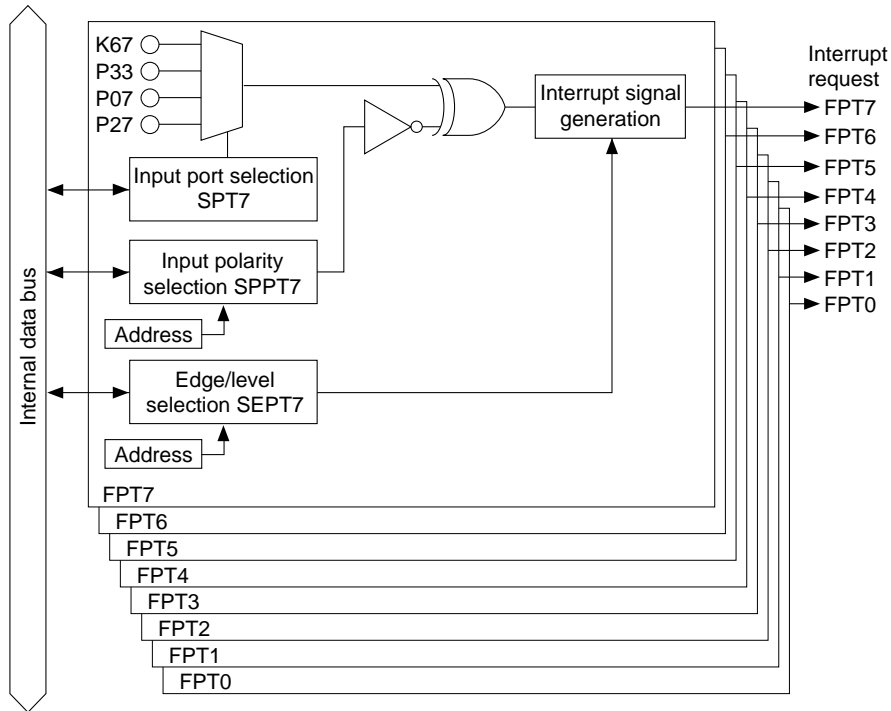


Figure III-9.3 Configuration of Port Input Interrupt Circuit

Selecting input pins

The interrupt factors allows selection of an input pin from the four predefined pins independently.

Table III-9.5 shows the control bits and the selectable pins for each factor.

Table III-9.5 Selecting Pins for Port Input Interrupts

Interrupt factor	Control bit	SPT settings			
		11	10	01	00
FPT7	SPT7[1:0] (D[7:6])/Port input interrupt select register 2 (0x402C7)	P27	P07	P33	K67
FPT6	SPT6[1:0] (D[5:4])/Port input interrupt select register 2 (0x402C7)	P26	P06	P32	K66
FPT5	SPT5[1:0] (D[3:2])/Port input interrupt select register 2 (0x402C7)	P25	P05	P31	K65
FPT4	SPT4[1:0] (D[1:0])/Port input interrupt select register 2 (0x402C7)	P24	P04	K54	K64
FPT3	SPT3[1:0] (D[7:6])/Port input interrupt select register 1 (0x402C6)	P23	P03	K53	K63
FPT2	SPT2[1:0] (D[5:4])/Port input interrupt select register 1 (0x402C6)	P22	P02	K52	K62
FPT1	SPT1[1:0] (D[3:2])/Port input interrupt select register 1 (0x402C6)	P21	P01	K51	K61
FPT0	SPT0[1:0] (D[1:0])/Port input interrupt select register 1 (0x402C6)	P20	P00	K50	K60

Conditions for port input-interrupt generation

Each port input interrupt can be generated by the edge or level of the input signal. The SEPT_x bit of the edge/level select register (0x402C9) is used for this selection. When SEPT_x is set to "1", the FPT_x interrupt will be generated at the signal edge. When SEPT_x is set to "0", the FPT_x interrupt will be generated by the input signal level.

Furthermore, the signal polarity can be selected using the SPPT_x bit of the input porarity select register (0x402C8).

With these registers, the port input interrupt condition is decided as shown in Table III-9.6.

Table III-9.6 Port Input Interrupt Condition

SEPT _x	SPPT _x	FPT _x interrupt condition
1	1	Rising edge
1	0	Falling edge
0	1	High level
0	0	Low level

When the input signal goes to the selected status, the interrupt factor flag FP is set to "1" and, if other interrupt conditions set by the interrupt controller are met, an interrupt is generated.

Key Input Interrupt

The key input interrupt circuit has two interrupt systems (FPK1 and FPK0) and a port group can be selected for generating each interrupt factor.

The interrupt condition can also be set by software.

Figure III-9.4 shows the configuration of the port input interrupt circuit.

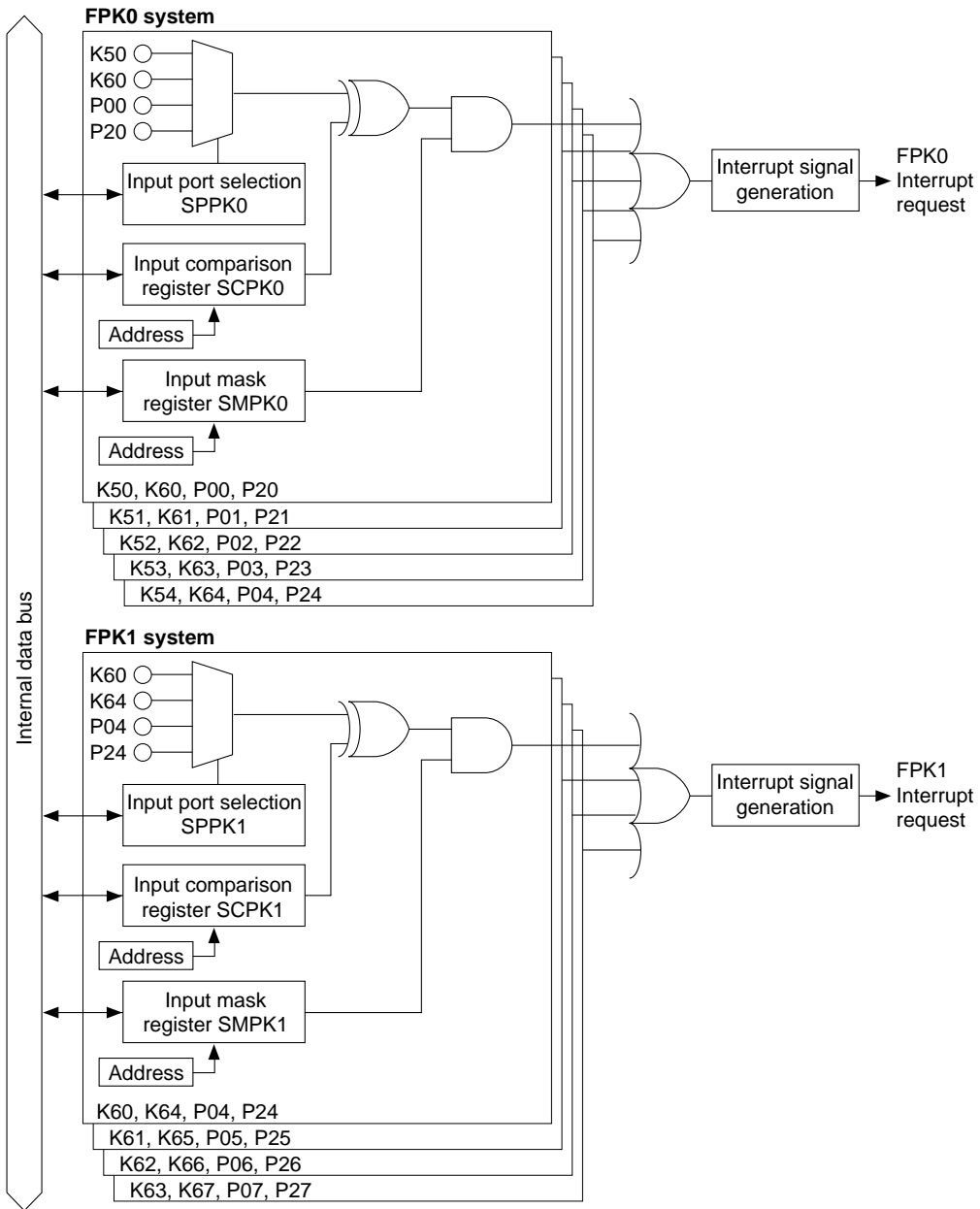


Figure III-9.4 Configuration of Key Input Interrupt Circuit

Selecting input pins

For the FPK1 interrupt system, a four-bit input pin group can be selected from the four predefined groups.
 For the FPK0 system, a five-bit input pin group can be selected.
 Table III-9.7 shows the control bits and the selectable groups for each factor.

Table III-9.7 Selecting Pins for Key Input Interrupts

Interrupt factor	Control bit	SPPK settings			
		11	10	01	00
FPK1	SPPK1[1:0] (D[3:2])/Key input interrupt select register (0x402CA)	P2[7:4]	P0[7:4]	K6[7:4]	K6[3:0]
FPK0	SPPK0[1:0] (D[1:0])/Key input interrupt select register (0x402CA)	P2[4:0]	P0[4:0]	K6[4:0]	K5[4:0]

Conditions for key input-interrupt generation

The key input interrupt circuit has two input mask registers (SMPK0[4:0] for FPK0 and SMPK1[3:0] for FPK1) and two input comparison registers (SCPK0[4:0] for FPK0 and SCPK1[3:0] for FPK1) to set input-interrupt conditions.

The input mask register SMPK is used to mask the input pin that is not used for an interrupt. This register masks each input pin, whereas the interrupt enable register of the interrupt controller masks the interrupt factor for each interrupt group.

The input comparison register SCPK is used to select whether an interrupt for each input port is to be generated at the rising or falling edge of the input.

A change in state occurs so that the input pin enabled for interrupt by the interrupt mask register SMPK and the content of the input comparison register SCPK become unmatched after being matched, the interrupt factor flag FK is set to "1" and, if other interrupt conditions are met, an interrupt is generated.

Figure III-9.5 shows cases in which a FPK0 interrupt is generated. Here, it is assumed that the K5[4:0] pins are selected for the input-pin group and the control register of the interrupt controller is set so as to enable generation of a FPK0 interrupt.

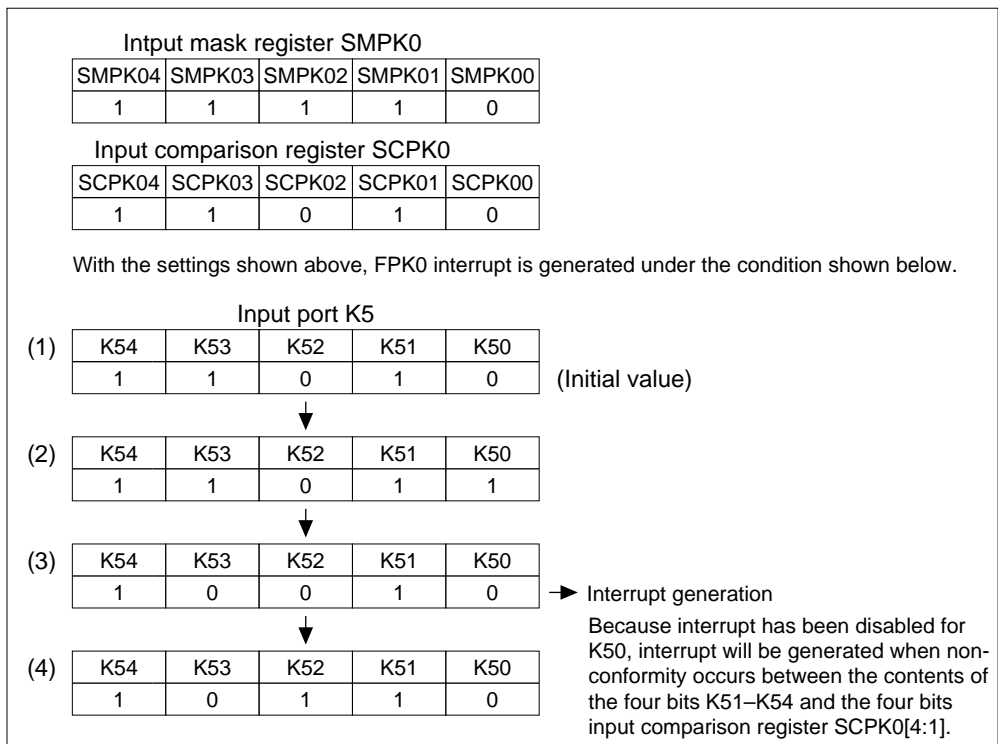


Figure III-9.5 FPK0 Interrupt Generation Example (when K5[4:0] is selected by SPPK[1:0])

Since K50 is masked from interrupt by SMPK00, no interrupt occurs at that point (2) above. Next, because K53 becomes "0" at (3), an interrupt is generated due to the lack of a match between the data of the input pin K5[4:1] that is enabled for interrupt and that of the input comparison register SCPK0[4:1]. Since only a change in states in which the input data and the content of the input comparison register SCPK become unmatched after being matched constitutes an interrupt generation condition as described above, no interrupt is generated when a change in states from one unmatched state to another, as in (4), occurs. Consequently, if another interrupt is to be generated again following the occurrence of an interrupt, the state of the input pin must be temporarily restored to the same content as that of the input comparison register SCPK, or the input comparison register SCPK must be set again. Note that the input pins masked from interrupt by the SMPK register do not affect interrupt generation conditions.

An interrupt is generated for FPK1 in the same way as described above.

Control Registers of the Interrupt Controller

Table III-9.8 shows the control registers of the interrupt controller that are provided for each input-interrupt system.

Table III-9.8 Control Registers of Interrupt Controller

System	Interrupt factor flag	Interrupt enable register	Interrupt priority register
FPT7	FP7(D5/0x40287)	EP7(D5/0x40277)	PP7L[2:0](D[6:4]/0x4026D)
FPT6	FP6(D4/0x40287)	EP6(D4/0x40277)	PP6L[2:0](D[2:0]/0x4026D)
FPT5	FP5(D3/0x40287)	EP5(D3/0x40277)	PP5L[2:0](D[6:4]/0x4026C)
FPT4	FP4(D2/0x40287)	EP4(D2/0x40277)	PP4L[2:0](D[2:0]/0x4026C)
FPT3	FP3(D3/0x40280)	EP3(D3/0x40270)	PP3L[2:0](D[6:4]/0x40261)
FPT2	FP2(D2/0x40280)	EP2(D2/0x40270)	PP2L[2:0](D[2:0]/0x40261)
FPT1	FP1(D1/0x40280)	EP1(D1/0x40270)	PP1L[2:0](D[6:4]/0x40260)
FPT0	FP0(D0/0x40280)	EP0(D0/0x40270)	PP0L[2:0](D[2:0]/0x40260)
FPK1	FK1(D5/0x40280)	EK1(D5/0x40270)	PK1L[2:0](D[6:4]/0x40262)
FPK0	FK0(D4/0x40280)	EK0(D4/0x40270)	PK0L[2:0](D[2:0]/0x40262)

When the interrupt generation condition described above is met, the corresponding interrupt factor flag is set to "1". If the interrupt enable register bit for that interrupt factor has been set to "1", an interrupt request is generated.

Interrupts due to an interrupt factor can be disabled by leaving the interrupt enable register bit for that factor set to "0". The interrupt factor flag is set to "1" whenever interrupt generation conditions are met, regardless of the setting of the interrupt enable register.

The interrupt priority register sets the interrupt priority level (0 to 7) for each interrupt system. An interrupt request to the CPU is accepted only when no other interrupt request of a higher priority has been generated. In addition, only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the input interrupt level set using the interrupt priority register will the input interrupt request actually be accepted by the CPU.

For details on these interrupt control registers, as well as the device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

Intelligent DMA

The port input interrupt system can invoke an intelligent DMA (IDMA) through the use of its interrupt factor. This enables the port inputs to be used as a trigger to perform DMA transfer.

The following shows the IDMA channel numbers assigned to each interrupt factor:

	IDMA Ch.		IDMA Ch.
FPT0 input interrupt:	1	FPT4 input interrupt:	28
FPT1 input interrupt:	2	FPT5 input interrupt:	29
FPT2 input interrupt:	3	FPT6 input interrupt:	30
FPT3 input interrupt:	4	FPT7 input interrupt:	31

For IDMA to be invoked, the IDMA request and IDMA enable bits shown in Table 9.9 must be set to "1" in advance. Transfer conditions, etc. must also be set on the IDMA side in advance.

Table III-9.9 Control Bits for IDMA Transfer

System	IDMA request bit	IDMA enable bit
FPT7	RP7(D7/0x40293)	DEP7(D7/0x40297)
FPT6	RP6(D6/0x40293)	DEP6(D6/0x40297)
FPT5	RP5(D5/0x40293)	DEP5(D5/0x40297)
FPT4	RP4(D4/0x40293)	DEP4(D4/0x40297)
FPT3	RP3(D3/0x40290)	DEP3(D3/0x40294)
FPT2	RP2(D2/0x40290)	DEP2(D2/0x40294)
FPT1	RP1(D1/0x40290)	DEP1(D1/0x40294)
FPT0	RP0(D0/0x40290)	DEP0(D0/0x40294)

If the IDMA request and enable bits are set to "1", IDMA is invoked through generation of an interrupt factor. No interrupt request is generated at that point. An interrupt request is generated after the DMA transfer is completed. The registers can also be set so as not to generate an interrupt, with only DMA transfers performed.

For details on IDMA transfers and interrupt control upon completion of IDMA transfer, refer to "IDMA (Intelligent DMA)".

Trap vectors

The trap-vector address of each input default interrupt factor is set as follows:

	(BTA3 = high)	(BTA3 = low)
FPT0 input interrupt:	0x0080040	0x0C00040
FPT1 input interrupt:	0x0080044	0x0C00044
FPT2 input interrupt:	0x0080048	0x0C00048
FPT3 input interrupt:	0x008004C	0x0C0004C
FPK0 input interrupt:	0x0080050	0x0C00050
FPK1 input interrupt:	0x0080054	0x0C00054
FPT4 input interrupt:	0x0080110	0x0C00110
FPT5 input interrupt:	0x0080114	0x0C00114
FPT6 input interrupt:	0x0080118	0x0C00118
FPT7 input interrupt:	0x008011C	0x0C0011C

The base address of the trap table can be changed using the TTBR register (0x48134 to 0x48137).

I/O Memory for Input Interrupts

Table III-9.10 shows the control bits for the port input and key input interrupts.

Table III-9.10 Control Bits for Input Interrupts

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Port input 0/1 interrupt priority register	0040260 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PP1L2	Port input 1 interrupt level	0 to 7	X	R/W		
		D5	PP1L1						
		D4	PP1L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PP0L2	Port input 0 interrupt level	0 to 7	X	R/W		
D1	PP0L1								
D0	PP0L0								
Port input 2/3 interrupt priority register	0040261 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PP3L2	Port input 3 interrupt level	0 to 7	X	R/W		
		D5	PP3L1						
		D4	PP3L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PP2L2	Port input 2 interrupt level	0 to 7	X	R/W		
D1	PP2L1								
D0	PP2L0								
Key input interrupt priority register	0040262 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PK1L2	Key input 1 interrupt level	0 to 7	X	R/W		
		D5	PK1L1						
		D4	PK1L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PK0L2	Key input 0 interrupt level	0 to 7	X	R/W		
D1	PK0L1								
D0	PK0L0								
Key input, port input 0–3 interrupt enable register	0040270 (B)	D7–6	–	reserved	–	–	–	0 when being read.	
		D5	EK1	Key input 1	1 Enabled	0 Disabled	0	R/W	
		D4	EK0	Key input 0			0	R/W	
		D3	EP3	Port input 3			0	R/W	
		D2	EP2	Port input 2			0	R/W	
		D1	EP1	Port input 1			0	R/W	
		D0	EP0	Port input 0			0	R/W	
Port input 4–7, clock timer, A/D interrupt enable register	0040277 (B)	D7–6	–	reserved	–	–	–	0 when being read.	
		D5	EP7	Port input 7	1 Enabled	0 Disabled	0	R/W	
		D4	EP6	Port input 6			0	R/W	
		D3	EP5	Port input 5			0	R/W	
		D2	EP4	Port input 4			0	R/W	
		D1	ECTM	Clock timer			0	R/W	
		D0	EADE	A/D converter			0	R/W	
Key input, port input 0–3 interrupt factor flag register	0040280 (B)	D7–6	–	reserved	–	–	–	0 when being read.	
		D5	FK1	Key input 1	1 Factor is generated	0 No factor is generated	X	R/W	
		D4	FK0	Key input 0			X	R/W	
		D3	FP3	Port input 3			X	R/W	
		D2	FP2	Port input 2			X	R/W	
		D1	FP1	Port input 1			X	R/W	
		D0	FP0	Port input 0			X	R/W	
Port input 4–7, clock timer, A/D interrupt factor flag register	0040287 (B)	D7–6	–	reserved	–	–	–	0 when being read.	
		D5	FP7	Port input 7	1 Factor is generated	0 No factor is generated	X	R/W	
		D4	FP6	Port input 6			X	R/W	
		D3	FP5	Port input 5			X	R/W	
		D2	FP4	Port input 4			X	R/W	
		D1	FCTM	Clock timer			X	R/W	
		D0	FADE	A/D converter			X	R/W	
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA request register	0040290 (B)	D7	R16TC0	16-bit timer 0 comparison A	1 IDMA request	0 Interrupt request	0	R/W	
		D6	R16TU0	16-bit timer 0 comparison B				R/W	
		D5	RHDM1	High-speed DMA Ch.1				R/W	
		D4	RHDM0	High-speed DMA Ch.0				R/W	
		D3	RP3	Port input 3				R/W	
		D2	RP2	Port input 2				R/W	
		D1	RP1	Port input 1				R/W	
		D0	RP0	Port input 0				R/W	

III PERIPHERAL BLOCK: INPUT/OUTPUT PORTS

Register name	Address	Bit	Name	Function	Setting				Init.	R/W	Remarks	
Serial I/F Ch.1, A/D, port input 4-7 IDMA request register	0040293 (B)	D7	RP7	Port input 7	1	IDMA request	0	Interrupt request	0	R/W	0 when being read.	
		D6	RP6	Port input 6					0	R/W		
		D5	RP5	Port input 5					0	R/W		
		D4	RP4	Port input 4					0	R/W		
		D3	–	reserved	–				–	–		
		D2	RADE	A/D converter	1	IDMA request	0	Interrupt request	0	R/W		
		D1	RSTX1	SIF Ch.1 transmit buffer empty					0	R/W		
		D0	RSRX1	SIF Ch.1 receive buffer full					0	R/W		
Port input 0-3, high-speed DMA, 16-bit timer 0 IDMA enable register	0040294 (B)	D7	DE16TC0	16-bit timer 0 comparison A	1	IDMA enabled	0	IDMA disabled	0	R/W		
		D6	DE16TU0	16-bit timer 0 comparison B					0	R/W		
		D5	DEHDM1	High-speed DMA Ch.1					0	R/W		
		D4	DEHDM0	High-speed DMA Ch.0					0	R/W		
		D3	DEP3	Port input 3					0	R/W		
		D2	DEP2	Port input 2					0	R/W		
		D1	DEP1	Port input 1					0	R/W		
		D0	DEP0	Port input 0					0	R/W		
Serial I/F Ch.1, A/D, port input 4-7 IDMA enable register	0040297 (B)	D7	DEP7	Port input 7	1	IDMA enabled	0	IDMA disabled	0	R/W	0 when being read.	
		D6	DEP6	Port input 6					0	R/W		
		D5	DEP5	Port input 5					0	R/W		
		D4	DEP4	Port input 4					0	R/W		
		D3	–	reserved	–				–	–		
		D2	DEADE	A/D converter	1	IDMA enabled	0	IDMA disabled	0	R/W		
		D1	DESTX1	SIF Ch.1 transmit buffer empty					0	R/W		
		D0	DESRX1	SIF Ch.1 receive buffer full					0	R/W		
Port input interrupt select register 1	00402C6 (B)	D7	SPT31	FPT3 interrupt input port selection	11	10	01	00	0	R/W		
		D6	SPT30		P23	P03	K53	K63	0			
		D5	SPT21	FPT2 interrupt input port selection	11	10	01	00	0	R/W		
		D4	SPT20		P22	P02	K52	K62	0			
		D3	SPT11	FPT1 interrupt input port selection	11	10	01	00	0	R/W		
		D2	SPT10		P21	P01	K51	K61	0			
		D1	SPT01	FPT0 interrupt input port selection	11	10	01	00	0	R/W		
		D0	SPT00		P20	P00	K50	K60	0			
Port input interrupt select register 2	00402C7 (B)	D7	SPT71	FPT7 interrupt input port selection	11	10	01	00	0	R/W		
		D6	SPT70		P27	P07	P33	K67	0			
		D5	SPT61	FPT6 interrupt input port selection	11	10	01	00	0	R/W		
		D4	SPT60		P26	P06	P32	K66	0			
		D3	SPT51	FPT5 interrupt input port selection	11	10	01	00	0	R/W		
		D2	SPT50		P25	P05	P31	K65	0			
		D1	SPT41	FPT4 interrupt input port selection	11	10	01	00	0	R/W		
		D0	SPT40		P24	P04	K54	K64	0			
Port input interrupt input polarity select register	00402C8 (B)	D7	SPPT7	FPT7 input polarity selection	1	High level or Rising edge	0	Low level or Falling edge	1	R/W		
		D6	SPPT6	FPT6 input polarity selection					1	R/W		
		D5	SPPT5	FPT5 input polarity selection					1	R/W		
		D4	SPPT4	FPT4 input polarity selection					1	R/W		
		D3	SPPT3	FPT3 input polarity selection					1	R/W		
		D2	SPPT2	FPT2 input polarity selection					1	R/W		
		D1	SPPT1	FPT1 input polarity selection					1	R/W		
		D0	SPPT0	FPT0 input polarity selection					1	R/W		
Port input interrupt edge/level select register	00402C9 (B)	D7	SEPT7	FPT7 edge/level selection	1	Edge	0	Level	1	R/W		
		D6	SEPT6	FPT6 edge/level selection					1	R/W		
		D5	SEPT5	FPT5 edge/level selection					1	R/W		
		D4	SEPT4	FPT4 edge/level selection					1	R/W		
		D3	SEPT3	FPT3 edge/level selection					1	R/W		
		D2	SEPT2	FPT2 edge/level selection					1	R/W		
		D1	SEPT1	FPT1 edge/level selection					1	R/W		
		D0	SEPT0	FPT0 edge/level selection					1	R/W		
Key input interrupt select register	00402CA (B)	D7-4	–	reserved	–				–	–	0 when being read.	
		D3	SPPK11	FPK1 interrupt input port selection	11	10	01	00	0	R/W		
		D2	SPPK10		P2[7:4]	P0[7:4]	K6[7:4]	K6[3:0]	0			
		D1	SPPK01	FPK0 interrupt input port selection	11	10	01	00	0	R/W		
		D0	SPPK00		P2[4:0]	P0[4:0]	K6[4:0]	K5[4:0]	0			
Key input interrupt (FPK0) input comparison register	00402CC (B)	D7-5	–	reserved	–				–	–	0 when being read.	
		D4	SCPK04	FPK04 input comparison	1	High	0	Low	0	R/W		
		D3	SCPK03	FPK03 input comparison					0	R/W		
		D2	SCPK02	FPK02 input comparison					0	R/W		
		D1	SCPK01	FPK01 input comparison					0	R/W		
		D0	SCPK00	FPK00 input comparison					0	R/W		

III PERIPHERAL BLOCK: INPUT/OUTPUT PORTS

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks		
Key input interrupt (FPK1) input comparison register	00402CD (B)	D7-4	–	reserved	–		–	–	0 when being read.		
		D3	SCP13	FPK13 input comparison	1	High	0	Low		0	R/W
		D2	SCP12	FPK12 input comparison						0	R/W
		D1	SCP11	FPK11 input comparison						0	R/W
		D0	SCP10	FPK10 input comparison						0	R/W
Key input interrupt (FPK0) input mask register	00402CE (B)	D7-5	–	reserved	–		–	–	0 when being read.		
		D4	SMPK04	FPK04 input mask	1	Interrupt enabled	0	Interrupt disabled		0	R/W
		D3	SMPK03	FPK03 input mask						0	R/W
		D2	SMPK02	FPK02 input mask						0	R/W
		D1	SMPK01	FPK01 input mask						0	R/W
		D0	SMPK00	FPK00 input mask						0	R/W
Key input interrupt (FPK1) input mask register	00402CF (B)	D7-4	–	reserved					–		–
		D3	SMPK13	FPK13 input mask	1	Interrupt enabled	0	Interrupt disabled	0	R/W	
		D2	SMPK12	FPK12 input mask					0	R/W	
		D1	SMPK11	FPK11 input mask					0	R/W	
		D0	SMPK10	FPK10 input mask					0	R/W	

SPT71–SPT70: FPT7 interrupt input port selection (D[7:6]) / Port input interrupt select register 2 (0x402C7)
SPT61–SPT60: FPT6 interrupt input port selection (D[5:4]) / Port input interrupt select register 2 (0x402C7)
SPT51–SPT50: FPT5 interrupt input port selection (D[3:2]) / Port input interrupt select register 2 (0x402C7)
SPT41–SPT40: FPT4 interrupt input port selection (D[1:0]) / Port input interrupt select register 2 (0x402C7)
SPT31–SPT30: FPT3 interrupt input port selection (D[7:6]) / Port input interrupt select register 1 (0x402C6)
SPT21–SPT20: FPT2 interrupt input port selection (D[5:4]) / Port input interrupt select register 1 (0x402C6)
SPT11–SPT10: FPT1 interrupt input port selection (D[3:2]) / Port input interrupt select register 1 (0x402C6)
SPT01–SPT00: FPT0 interrupt input port selection (D[1:0]) / Port input interrupt select register 1 (0x402C6)

Select an input pin for port interrupt generation.

Table III-9.11 Selecting Pins for Port Input Interrupts

Interrupt system	SPT settings			
	11	10	01	00
FPT7	P27	P07	P33	K67
FPT6	P26	P06	P32	K66
FPT5	P25	P05	P31	K65
FPT4	P24	P04	K54	K64
FPT3	P23	P03	K53	K63
FPT2	P22	P02	K52	K62
FPT1	P21	P01	K51	K61
FPT0	P20	P00	K50	K60

At cold start, SPT is set to "00". At hot start, SPT retains its state from prior to the initial reset.

SPPT7–SPPT0: Input polarity selection (D[7:0]) / Port interrupt input polarity select register (0x402C8)

Selects input signal polarity for port interrupt generation.

Write "1": High level or Rising edge

Write "0": Low level or Falling edge

Read: Valid

SPPTx is the input polarity select bit corresponding to the FPTx interrupt. When SPPTx is set to "1", the FPTx interrupt will be generated by a high level input or at the rising edge. When SPPTx is set to "0", the interrupt will be generated by a low level input or at the falling edge. An edge or a level interrupt is selected by the SEPTx bit. At cold start, SPPT is set to "0" (low level). At hot start, SPPT retains its state from prior to the initial reset.

SEPT7–SEPT0: Edge/level selection (D[7:0]) / Port interrupt edge/level select register (0x402C9)

Selects an edge trigger or a level trigger for port interrupt generation.

Write "1": Edge
 Write "0": Level
 Read: Valid

SEPTx is the edge/level select bit corresponding to the FPTx interrupt. When SEPTx is set to "1", the FPTx interrupt will be generated at the signal edge. Either falling edge or rising edge can be selected by the SPPTx bit. When SEPTx is set to "0", the interrupt will be generated by the level (high or low) specified with the SPPTx bit. At cold start, SEPT is set to "0" (level). At hot start, SEPT retains its state from prior to the initial reset.

SPPK11–SPPK10: FPK1 interrupt input port selection (D[3:2]) / Key input interrupt select register (0x402CA)
SPPK01–SPPK00: FPK0 interrupt input port selection (D[1:0]) / Key input interrupt select register (0x402CA)

Select an input-pin group for key interrupt generation.

Table III-9.12 Selecting Pins for Key Input Interrupts

Interrupt system	SPPK settings			
	11	10	01	00
FPK1	P2[7:4]	P0[7:4]	K6[7:4]	K6[3:0]
FPK0	P2[4:0]	P0[4:0]	K6[4:0]	K5[4:0]

At cold start, SPPK is set to "00". At hot start, SPPK retains its state from prior to the initial reset.

SCPK13–SCPK10: FPK1 input comparison (D[3:0]) / FPK1 input comparison register (0x402CD)
SCPK04–SCPK00: FPK0 input comparison (D[4:0]) / FPK0 input comparison register (0x402CC)

Sets the conditions for key-input interrupt generation (timing of interrupt generation).

Write "1": Generated at falling edge
 Write "0": Generated at rising edge
 Read: Valid

SCPK0[4:0] is compared with the input state of five bits of the FPK0 input ports, and SCPK1[3:0] is compared with the input state of four bits of the FPK1 input ports, and when a change in states from a matched to an unmatched state occurs in either, an interrupt is generated (except for the inputs disabled from interrupt by the SMPK register).

At cold start, SCPK is set to "0" (rising edge). At hot start, SCPK retains its state from prior to the initial reset.

SMPK13–SMPK10: FPK1 input mask (D[3:0]) / FPK1 input mask register (0x402CF)
SMPK04–SMPK00: FPK0 input mask (D[4:0]) / FPK0 input mask register (0x402CE)

Sets conditions for key-input interrupt generation (interrupt enabled/disabled).

Write "1": Interrupt enabled
 Write "0": Interrupt disabled
 Read: Valid

SMPK is an input mask register for each key-input interrupt system. Interrupts for bits set to "1" are enabled, and interrupts for bits set to "0" are disabled. A change in the state of an input pin that is disabled from interrupt does not affect interrupt generation.

At cold start, SMPK is set to "0" (interrupt disabled). At hot start, SMPK retains its state from prior to the initial reset.

PP0L2–PP0L0: Port input 0 interrupt level (D[2:0]) / Port input 0/1 interrupt priority register (0x40260)
PP1L2–PP1L0: Port input 1 interrupt level (D[6:4]) / Port input 0/1 interrupt priority register (0x40260)
PP2L2–PP2L0: Port input 2 interrupt level (D[2:0]) / Port input 2/3 interrupt priority register (0x40261)
PP3L2–PP3L0: Port input 3 interrupt level (D[6:4]) / Port input 2/3 interrupt priority register (0x40261)
PP4L2–PP4L0: Port input 4 interrupt level (D[2:0]) / Port input 4/5 interrupt priority register (0x4026C)
PP5L2–PP5L0: Port input 5 interrupt level (D[6:4]) / Port input 4/5 interrupt priority register (0x4026C)
PP6L2–PP6L0: Port input 6 interrupt level (D[2:0]) / Port input 6/7 interrupt priority register (0x4026D)
PP7L2–PP7L0: Port input 7 interrupt level (D[6:4]) / Port input 6/7 interrupt priority register (0x4026D)
PK0L2–PK0L0: Key input 0 interrupt level (D[2:0]) / Key input interrupt priority register (0x40262)
PK1L2–PK1L0: Key input 1 interrupt level (D[6:4]) / Key input interrupt priority register (0x40262)

Sets the priority level of the input interrupt.

PPxL and PKxL are interrupt priority registers corresponding to each port-input interrupt and key-input interrupt, respectively.

The priority level can be set for each interrupt group in the range of 0 to 7.

At initial reset, these registers becomes indeterminate.

EP3–EP0: Port input 3–0 interrupt enable (D[3:0]) /
 Key input, port input 0–3 interrupt enable register (0x40270)
EP7–EP4: Port input 7–4 interrupt enable (D[5:2]) /
 Port input 4–7, clock timer, A/D interrupt enable register (0x40277)
EK1, EK0: Key input 1, 0 interrupt enable (D[5:4]) /
 Key input, port input 0–3 interrupt enable register (0x40270)

Enables or disables the generation of an interrupt to the CPU.

Write "1": Interrupt enabled
 Write "0": Interrupt disabled
 Read: Valid

EP and EK are interrupt enable bits corresponding to the port-input interrupt and the key-input interrupt, respectively. Interrupts for input systems set to "1" are enabled, and interrupts for input systems set to "0" are disabled.

At initial reset, these bits are set to "0" (interrupt disabled).

FP3–FP0: Port input 3–0 interrupt factor flag (D[3:0]) /
 Key input, port input 0–3 interrupt factor flag register (0x40280)
FP7–FP4: Port input 7–4 interrupt factor flag (D[5:2]) /
 Port input 4–7, clock timer, A/D interrupt factor flag register (0x40287)
FK1, FK0: Key input 1, 0 interrupt factor flag (D[5:4]) /
 Key input, port input 0–3 interrupt factor flag register (0x40280)

Indicates the status of an input interrupt factor generated.

When read

Read "1": Interrupt factor has occurred
 Read "0": No interrupt factor has occurred

When written using the reset-only method (default)

Write "1": Interrupt factor flag is reset
 Write "0": Invalid

When written using the read/write method

Write "1": Interrupt flag is set
 Write "0": Interrupt flag is reset

FP and FK are an interrupt factor flags corresponding to the port-input interrupt and the key-input interrupt, respectively. The flag is set to "1" when interrupt generation conditions are met.

At this time, if the following conditions are met, an interrupt to the CPU is generated:

1. The corresponding interrupt enable register bit is set to "1".
 2. No other interrupt request of a higher priority has been generated.
 3. The IE bit of the PSR is set to "1" (interrupts enabled).
 4. The value set in the corresponding interrupt priority register is higher than the interrupt level (IL) of the CPU.
- When using the interrupt factor of the port-input to request IDMA, note that even when the above conditions are met, no interrupt request to the CPU is generated for the interrupt factor that has occurred. If interrupts are enabled at the setting of IDMA, an interrupt is generated under the above conditions after the data transfer by IDMA is completed.

The interrupt factor flag is set to "1" whenever interrupt generation conditions are met, regardless of how the interrupt enable and interrupt priority registers are set.

If the next interrupt is to be accepted after an interrupt has occurred, it is necessary that the interrupt factor flag be reset, and that the PSR be set again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can be reset only by writing to it in the software. Note that if the PSR is set again to accept interrupts generated (or if the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

At initial reset, all the flags become indeterminate, so be sure to reset them in the software.

RP3–RP0:	Port input 3–0 IDMA request (D[3:0]) / Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA request register (0x40290)
RP7–RP4:	Port input 7–4 IDMA request (D[7:4]) / Serial I/F Ch.1, A/D, Port input 4–7 IDMA request register (0x40293)

Specifies whether to invoke IDMA when an interrupt factor occurs.

When using the set-only method (default)

- Write "1": IDMA request
- Write "0": Not changed
- Read: Valid

When using the read/write method

- Write "1": IDMA request
- Write "0": Interrupt request
- Read: Valid

RP7 to RP0 are IDMA request bits corresponding to the port-input 7 to 0 interrupts, respectively. If the bit is set to "1", IDMA is invoked when an interrupt factor occurs, thereby performing a programmed data transfer. If the bit is set to "0", normal interrupt processing is performed, without invoking IDMA.

For details on IDMA, refer to "IDMA (Intelligent DMA)".

At initial reset, RP set to "0" (interrupt request).

DEP3–DEP0: Port input 3–0 IDMA enable (D[3:0]) /

Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA enable register (0x40294)

DEP7–DEP4: Port input 7–4 IDMA enable (D[7:4]) /

Serial I/F Ch.1, A/D, Port input 4–7 IDMA enable register (0x40297)

Enables IDMA transfer by means of an interrupt factor.

When using the set-only method (default)

Write "1": IDMA enabled

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA enabled

Write "0": IDMA disabled

Read: Valid

If DEP is set to "1", the IDMA request by the interrupt factor is enabled. If the register bit is set to "0", the IDMA request is disabled.

After an initial reset, DEP is set to "0" (IDMA disabled).

Programming Notes

- (1) After an initial reset, the interrupt factor flags become indeterminate. To prevent generation of an unwanted interrupt or IDMA request, be sure to reset the flags in a program.
- (2) To prevent regeneration of interrupts due to the same factor following the occurrence of an interrupt, always be sure to reset the interrupt factor flag before resetting the PSR or executing the reti instruction.

E0C33 Block Technical Manual

IV ANALOG BLOCK

IV-1 INTRODUCTION

The analog block consists of an A/D converter with 8 input channels.

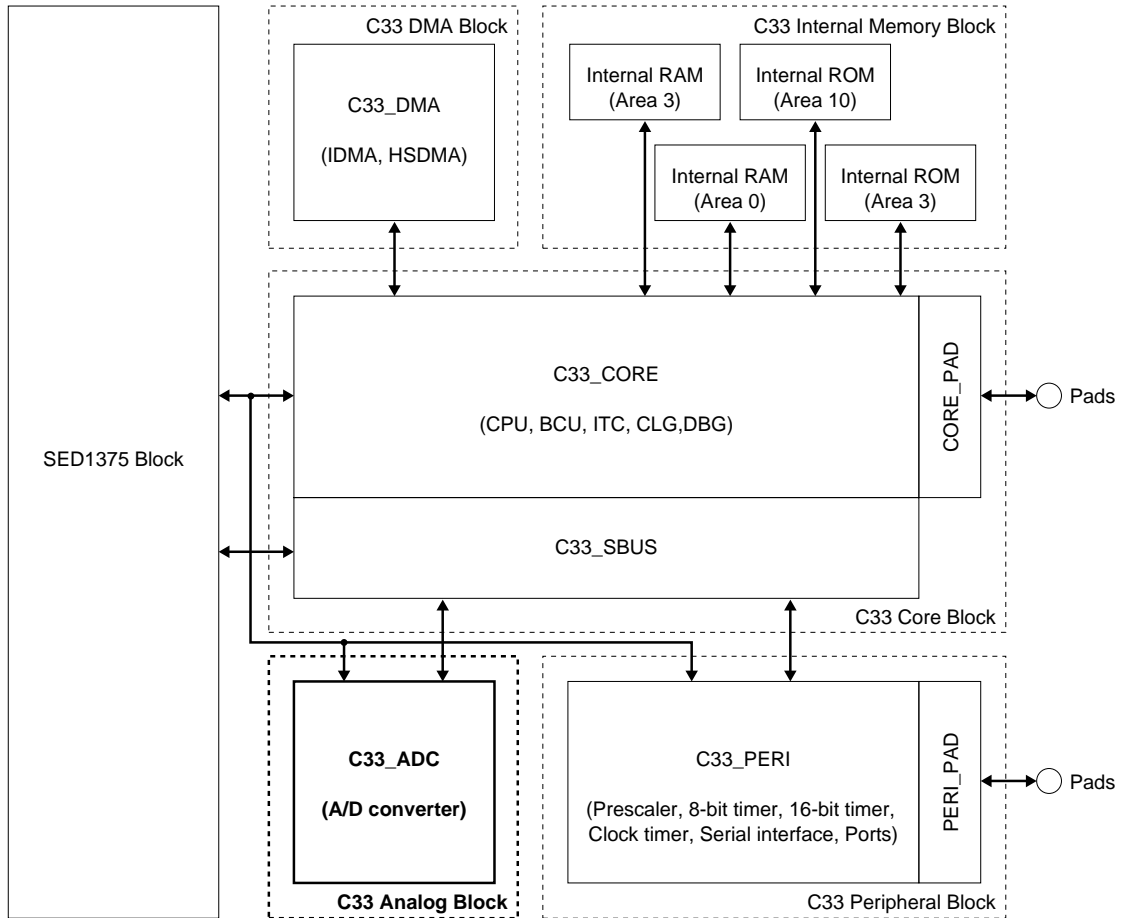


Figure IV-1.1 Analog Block

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IV-2 A/D CONVERTER

Features and Structure of A/D Converter

The Analog Block contains an A/D converter with the following features:

- Conversion method: Successive comparison
- Resolution: 10 bits
- Input channels: Maximum of 8
- Conversion time: Maximum of 10 μ s (when a 2-MHz input clock is selected)
- Conversion range: Between V_{SS} and AV_{DDE}
- Two conversion modes can be selected:
 - Normal mode: Conversion is completed in one operation.
 - Continuous mode: Conversion is continuous and terminated through software control.
 Continuous conversion of multiple channels can be performed in each mode.
- Four types of A/D-conversion start triggers can be selected:
 - Triggered by the external pin (#ADTRG)
 - Triggered by the compare match B of the 16-bit programmable timer 0
 - Triggered by the underflow of the 8-bit programmable timer 0
 - Triggered by the software
- A/D conversion results can be read out from a 10-bit data register.
- An interrupt is generated upon completion of A/D conversion.

Figure IV-2.1 shows the structure of the A/D converter.

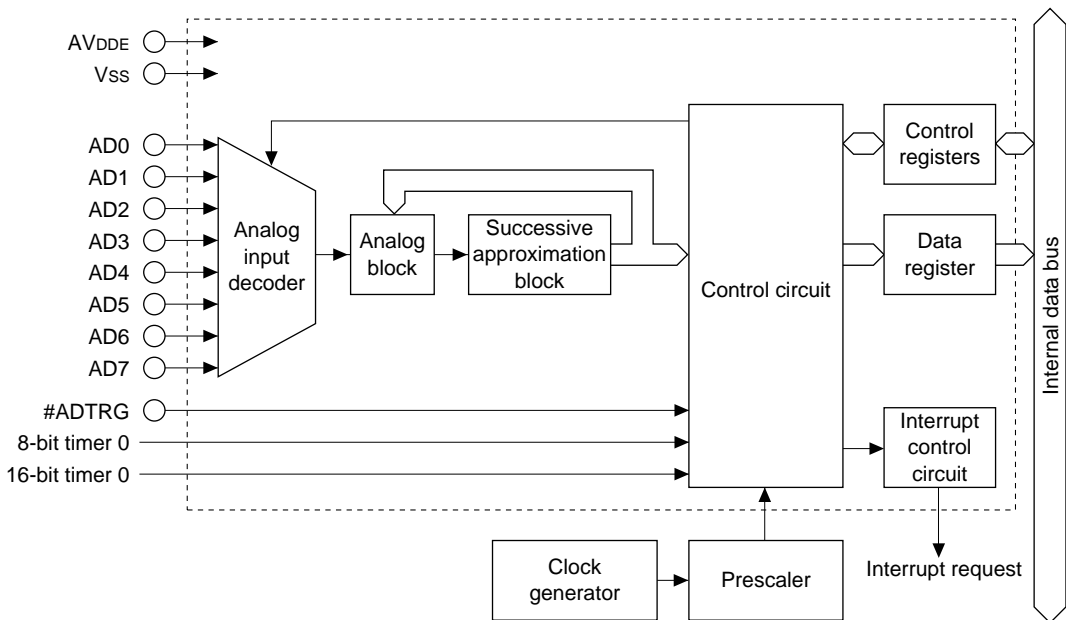


Figure IV-2.1 Structure of A/D Converter

I/O Pins of A/D Converter

Table IV-2.1 shows the pins used by the A/D converter.

Table IV-2.1 I/O Pins of A/D Converter

Pin name	I/O	Function	Function select bit
K52/#ADTRG	I	Input port / AD trigger	CFK52(D2)/K5 function select register(0x402C0)
K60/AD0	I	Input port / AD converter input 0	CFK60(D0)/K6 function select register(0x402C3)
K61/AD1	I	Input port / AD converter input 1	CFK61(D1)/K6 function select register(0x402C3)
K62/AD2	I	Input port / AD converter input 2	CFK62(D2)/K6 function select register(0x402C3)
K63/AD3	I	Input port / AD converter input 3	CFK63(D3)/K6 function select register(0x402C3)
K64/AD4	I	Input port / AD converter input 4	CFK64(D4)/K6 function select register(0x402C3)
K65/AD5	I	Input port / AD converter input 5	CFK65(D5)/K6 function select register(0x402C3)
K66/AD6	I	Input port / AD converter input 6	CFK66(D6)/K6 function select register(0x402C3)
K67/AD7	I	Input port / AD converter input 7	CFK67(D7)/K6 function select register(0x402C3)
AVDD	-	Power supply for analog system (+)	-
AVRL	-	Analog reference voltage (-)	-

AVDD (analog power-supply pin)

AVDD is the power-supply pin for the analog circuit. The voltage level supplied to this pin must be $AVDD = VDDE$.

Note: When the A/D converter is set to enabled state, a current flows between AVDD and VSS, and power is consumed, even when A/D operations are not performed. Therefore, when the A/D converter is not used, it must be set to the disabled state (default "0" setting of ADE(D2) in the A/D enable register (0x40244)).

AD[7:0] (analog-signal input pins)

The analog input pins AD7 (Ch.7) through AD0 (Ch.0) are shared with input port pins K67 through K60. Therefore, when these pins are used for analog input, they must be set for use with the A/D converter in the software. This setting can be made individually for each pin. At cold start, all these pins are set for input ports.

The analog input voltage $AVIN$ can be input in the range of $AVRL \leq AVIN \leq AVRH$.

#ADTRG (external-trigger input pin)

This pin is used to input a trigger signal to start A/D conversion from an external source. Since this pin is shared with input port K52, it must be set for use with the A/D converter in the software before an external trigger can be applied to the pin. At cold start, this pin is set for an input port.

Method for setting A/D-converter input pins

At cold start, the #ADTRG and AD[7:0] pins all are set for input ports Kxx (function select bit $CFKxx = "0"$).

When using these pins for the A/D converter, write "1" to the function select bit $CFKxx$.

At hot start, these pins retain their state from prior to the reset.

Setting A/D Converter

When the A/D converter is used, the following settings must be made before an A/D conversion can be performed:

1. Setting analog input pins
2. Setting the input clock
3. Selecting the analog-conversion start and end channels
4. Setting the A/D conversion mode
5. Selecting a trigger
6. Setting the sampling time
7. Setting interrupt/IDMA/HSDMA

The following describes how to set each item. For details on how to set the analog input pins, refer to the preceding section. For details on how to set interrupt/DMA, refer to "A/D Converter Interrupt and DMA".

Note: Before making these settings, make sure the A/D converter is disabled (ADE (D2) / A/D enable register (0x40244) = "0"). Changing the settings while the A/D converter is enabled could cause a malfunction.

Setting the input clock

As explained in "Prescaler", the A/D conversion clock can be selected from among the eight types shown in Table IV-2.2 below. Use PSAD[2:0] (D[2:0]) / A/D clock control register (0x4014F) for this selection.

Table IV-2.2 Input Clock Selection

PSAD2	PSAD1	PSAD0	Division ratio
1	1	1	fPSCIN/256
1	1	0	fPSCIN/128
1	0	1	fPSCIN/64
1	0	0	fPSCIN/32
0	1	1	fPSCIN/16
0	1	0	fPSCIN/8
0	0	1	fPSCIN/4
0	0	0	fPSCIN/2

fPSCIN: Prescaler input clock frequency

The selected clock is output from the prescaler to the A/D converter by writing "1" to PSONAD (D3) / A/D clock control register (0x4014F).

- Notes:**
- The A/D converter operates only when the prescaler is operating.
 - The recommended input clock frequency is a maximum of 2 MHz.
 - Do not start an A/D conversion when the clock output from the prescaler to the A/D converter is turned off, and do not turn off the prescaler's clock output when an A/D conversion is underway. This could cause the A/D converter to operate erratically.

Selecting analog-conversion start and end channels

Select the channel in which the A/D conversion is to be performed from among the pins (channels) that have been set for analog input. To enable A/D conversions in multiple channels to be performed successively through one convert operation, specify the conversion start and conversion end channels.

Conversion start channel: CS[2:0] (D[2:0]) / A/D channel register (0x40243)

Conversion end channel: CE[2:0] (D[5:3]) / A/D channel register (0x40243)

Table IV-2.3 Relationship between CS/CE and Input Channel

CS2/CE2	CS1/CE1	CS0/CE0	Channel selected
1	1	1	AD7
1	1	0	AD6
1	0	1	AD5
1	0	0	AD4
0	1	1	AD3
0	1	0	AD2
0	0	1	AD1
0	0	0	AD0

Example: Operation of one A/D conversion

CS[2:0] = "0", CE[2:0] = "0": Converted only in AD0

CS[2:0] = "0", CE[2:0] = "3": Converted in the following order: AD0→AD1→AD2→AD3

CS[2:0] = "5", CE[2:0] = "1": Converted in the following order: AD5→AD6→AD7→AD0→AD1

Note: Only conversion-channel input pins that have been set for use with the A/D converter can be set using the CS and CE bits.

Setting the A/D conversion mode

The A/D converter can operate in one of the following two modes. This operation mode is selected using MS (D5) / A/D trigger register (0x40242).

1. Normal mode (MS = "0")

All inputs in the range of channels set using the CS and CE bits are A/D converted once and then stopped.

2. Continuous mode (MS = "1")

A/D conversions in the range of channels set using the CS and CE bits are executed successively until stopped by the software.

At initial reset, the normal mode is selected.

Selecting a trigger

Use TS[1:0] (D[4:3]) / A/D trigger register (0x40242) to select a trigger to start A/D conversion from among the four types shown in Table IV-2.4.

Table IV-2.4 Trigger Selection

TS1	TS0	Trigger
1	1	External trigger (K52/#ADTRG)
1	0	8-bit programmable timer 0
0	1	16-bit programmable timer 0
0	0	Software

1. External trigger

The signal input to the #ADTRG pin is used as a trigger.

When this trigger is used, the K52 pin must be set for #ADTRG in advance by writing "1" to CFK52 (D2) / K5 function select register (0x402C0).

A/D conversion is started at a falling edge of the #ADTRG signal.

2. Programmable timer

The underflow signal of 8-bit programmable timer 0 or the comparison match B signal of the 16-bit programmable timer 0 is used as a trigger. Since the cycle can be programmed using each timer, this trigger is effective when cyclic A/D conversions are required.

For details on how to set a timer, refer to the explanation of each programmable timer in this manual.

3. Software trigger

Writing "1" to ADST (D1) / A/D enable register (0x40244) in the software serves as a trigger to start A/D conversion.

Setting the sampling time

The A/D converter contains ST[1:0] (D[1:0]) / A/D sampling register (0x40245) that allows the analog-signal input sampling time to be set in four steps (3, 5, 7, or 9 times the input clock period).

However, this register should be used as set by default (ST = "11"; x9 clock periods).

Control and Operation of A/D Conversion

Figure IV-2.2 shows the operation of the A/D converter.

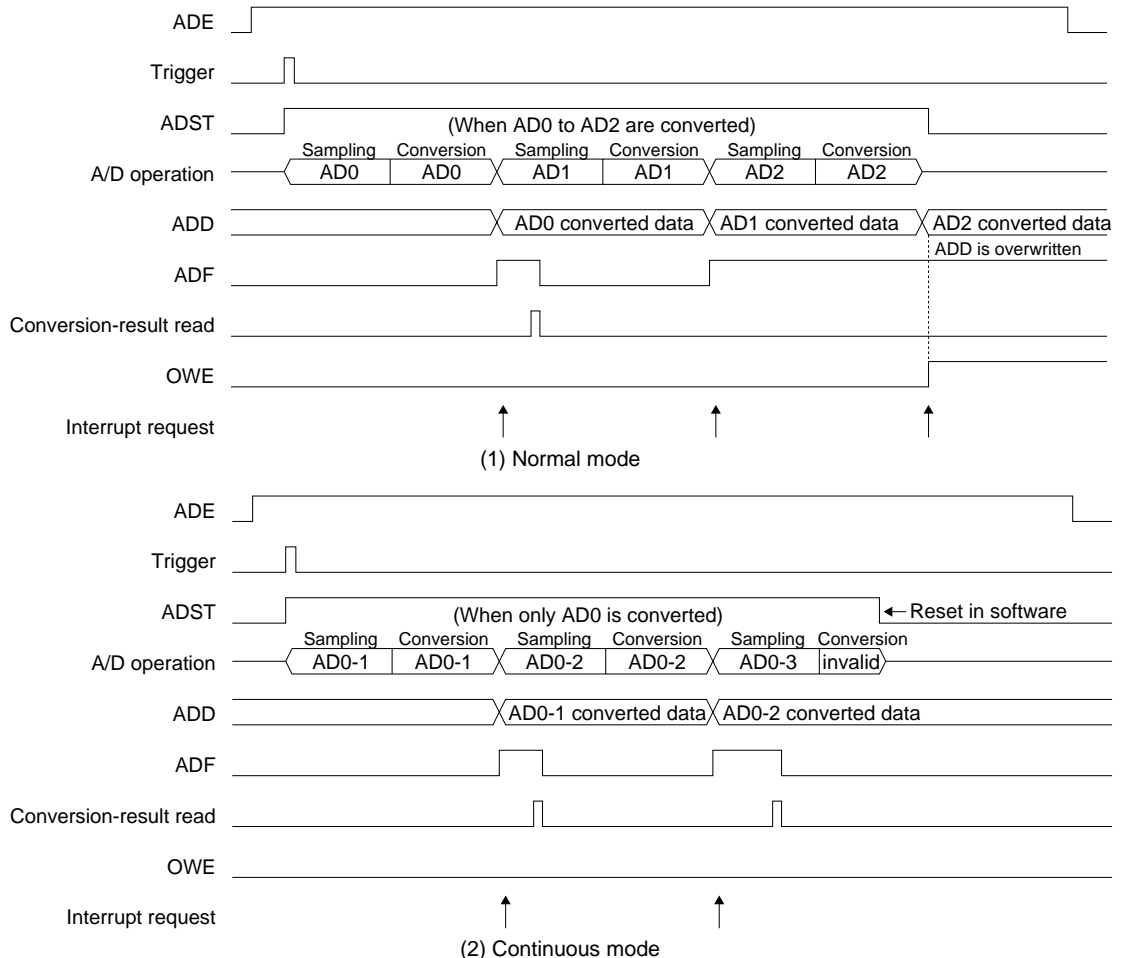


Figure IV-2.2 Operation of A/D Converter

Starting up the A/D converter circuit

After the settings specified in the preceding section have been made, write "1" to ADE (D2) / A/D enable register (0x40244) to enable the A/D converter. The A/D converter is thereby readied to accept a trigger to start A/D conversion. To set the A/D converter again, or if it is not to be used, set ADE to "0".

Starting A/D conversion

When a trigger is input while ADE = "1", A/D conversion is started. If a software trigger has been selected, A/D conversion is started by writing "1" to ADST (D1) / A/D enable register (0x40244).

Only the trigger selected using TS[1:0] (D[4:3]) / A/D trigger register (0x40242) are valid; no other trigger is accepted.

When a trigger is input, the A/D converter samples and A/D-converts the analog input signal, beginning with the conversion start channel selected by CS[2:0].

Upon completion of the A/D conversion in that channel, the A/D converter stores the conversion result, in 10-bit data registers ADD[9:0] (ADD[9:8] = D[1:0]/0x40241, ADD[7:0] = D[7:0]/0x40240), and sets the conversion-complete flag ADF (D3) / A/D enable register (0x40244) and interrupt factor flag FADE (D0) / Port input 4–7, clock timer and A/D interrupt factor flag register (0x40287). If multiple channels are specified using CS[2:0] and CE[2:0], A/D conversions in the subsequent channels are performed in succession.

The ADST used for the software trigger is set to "1" during A/D conversion, even when it is started by some other trigger, so it can be used as an A/D-conversion status bit.

The channel in which conversion is underway can be identified by reading CH[2:0] (D[2:0]) / A/D trigger register (0x40242).

Reading out A/D conversion results

As explained earlier, the results of A/D conversion are stored in the ADD[9:0] register each time conversion in one channel is completed. Since an interrupt can be generated simultaneously, this interrupt is normally used to read out the converted data. In addition, be sure to reset the interrupt factor flag (by writing "0") to prepare the A/D converter for the next operation.

Since the interrupt factor of the A/D converter can also be used to invoke DMA, the conversion results can automatically be transferred to a specified memory location.

If multiple A/D conversion channels are specified, the conversion results in one channel must be read out prior to completion of conversion in the next channel. If the A/D conversion currently under way is completed before the previous conversion results are read out, the ADD[9:0] register is overwritten with the new conversion results.

If ADD[9:0] is updated when the conversion-complete flag ADF = "1" (before the converted data is read out), the overwrite-error flag OWE (D0) / A/D enable register (0x40244) is set to "1". The conversion-complete flag ADF is reset to "0" when the converted data is read out. If ADD[9:0] is updated when ADF = "0", OWE remains at "0", indicating that the operation has been completed normally. When reading out data, also read the OWE flag also to make sure the data is valid. Once OWE is set, it remains set until it is reset to "0" in the software. Note also that if OWE is set, ADF also is set. In this case, read out the converted data and reset ADF.

Terminating A/D conversion

- **For normal mode (MS = "1")**

In the normal mode, A/D conversion is performed successively from the conversion start channel specified using CS[2:0] to the conversion end channel specified using CE[2:0], and is completed after these conversions are executed in one operation. ADST is reset to "0" upon completion of the conversion.

- **For continuous mode (MS = "0")**

In the continuous mode, A/D conversion from the conversion-start to the conversion-end channels is executed repeatedly, without being stopped in the hardware. To terminate conversion, therefore, ADST must be reset to "0" in the software. The A/D conversion being executed when ADST is reset to "0" is forcibly stopped. Therefore, the results of this conversion cannot be obtained.

- **Forced termination**

In either normal or continuous mode, A/D conversion is immediately terminated by writing "0" to ADST. The results of the conversion then under-way cannot be obtained.

In addition, ADST is reset to "0" by writing "0" to ADE, so the conversion under-way is terminated.

Note: Once A/D conversion ends, further A/D conversion will not be performed correctly if restarted within an interval shorter than one cycle of the A/D converter operating clock set by the prescaler.

A/D Converter Interrupt and DMA

Upon completion of A/D conversion in each channel, the A/D converter generates an interrupt and invokes the DMA if necessary.

Control registers of the interrupt controller

The following shows the interrupt control registers available for the A/D converter:

Interrupt factor flag: FADE (D0) / Port input 4–7, clock timer, A/D interrupt factor flag register (0x40287)

Interrupt enable: EADE (D0) / Port input 4–7, clock timer, A/D interrupt enable register (0x40277)

Interrupt level: PAD[2:0] (D[6:4]) / Serial I/F Ch.1, A/D interrupt priority register (0x4026A)

The A/D converter sets the interrupt factor flag to "1" when A/D conversion in one channel is completed, and the conversion results are stored in the ADD register. At this time, if the interrupt enable register bit has been set to "1", an interrupt request is generated.

Interrupts can be disabled by leaving the interrupt enable register bit set to "0". The interrupt factor flag is set to "1" upon completion of A/D conversion in each channel, regardless of the setting of the interrupt enable register (even when it is set to "0").

The interrupt priority register sets the priority level (0 to 7) of an interrupt. An interrupt request to the CPU is accepted no other interrupt request of a higher priority has been generated.

In addition, it is only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the A/D-converter interrupt level set by the interrupt priority register, that the A/D converter's interrupt request is actually accepted by the CPU.

For details on these interrupt control registers, as well as the device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

Intelligent DMA

The A/D converter can invoke the intelligent DMA (IDMA) through the use of its interrupt factor. This allows the conversion results to be transferred to a specified memory location with no need to execute an interrupt processing routine.

The IDMA channel number assigned to the A/D converter is 0x1B.

Before IDMA can be invoked, the IDMA request and IDMA enable bits must be set to "1". Transfer conditions on the IDMA side must also be set in advance.

IDMA request: RADE (D2)/ Serial I/F Ch.1, A/D, Port input 4–7 IDMA request register (0x40293)

IDMA enable: DEADE (D2)/ Serial I/F Ch.1, A/D, Port input 4–7 IDMA enable register (0x40297)

If an interrupt factor occurs when the IDMA request and IDMA enable bits are set to "1", IDMA is invoked. No interrupt request is generated at that point. An interrupt request is generated upon completion of the DMA transfer. Otherwise, the bit can be set so as not to generate an interrupt, with only a DMA transfer performed. For details on DMA transfers and how to control interrupts upon completion of a DMA transfer, refer to "IDMA (Intelligent DMA)".

High-speed DMA

The A/D interrupt factor can also invoke high-speed DMA (HSDMA).

The following shows the HSDMA channel number and trigger set-up bit:

Table IV-2.5 HSDMA Trigger Set-up Bits

HSDMA channel	Trigger set-up bits
0	HSD0S[3:0] (D[3:0]) / HSDMA Ch.0/1 trigger set-up register (0x40298)
1	HSD1S[3:0] (D[7:4]) / HSDMA Ch.0/1 trigger set-up register (0x40298)
2	HSD2S[3:0] (D[3:0]) / HSDMA Ch.2/3 trigger set-up register (0x40299)
3	HSD3S[3:0] (D[7:4]) / HSDMA Ch.2/3 trigger set-up register (0x40299)

For HSDMA to be invoked, the trigger set-up bits should be set to "1100" in advance. Transfer conditions, etc. must also be set on the HSDMA side.

If the A/D interrupt factor is selected as the HSDMA trigger, the HSDMA channel is invoked through generation of the interrupt factor.

For details on HSDMA transfer, refer to "HSDMA (High-Speed DMA)".

Trap vector

The A/D converter's interrupt trap-vector default address is set as follows:

When BTA3 = high: 0x0080100

When BTA3 = low: 0x0C00100

The base address of the trap table can be changed using the TTBR register (0x48134 to 0x48137).

I/O Memory of A/D Converter

Table IV-2.6 shows the control bits of the A/D converter.

For details on the I/O memory of the prescaler used to set clocks, refer to "Prescaler". For details on the I/O memory of the programmable timers used for a trigger, refer to "8-Bit Programmable Timers" or "16-Bit Programmable Timers".

Table IV-2.6 Control Bits of A/D Converter

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
A/D conversion result (low-order) register	0040240 (B)	D7	ADD7	A/D converted data (low-order 8 bits) ADD0 = LSB	0x0 to 0x3FF (low-order 8 bits)		0	R			
		D6	ADD6				0				
		D5	ADD5				0				
		D4	ADD4				0				
		D3	ADD3				0				
		D2	ADD2				0				
		D1	ADD1				0				
		D0	ADD0				0				
A/D conversion result (high-order) register	0040241 (B)	D7-2	–	–	–		–	–	0 when being read.		
		D1	ADD9	A/D converted data (high-order 2 bits) ADD9 = MSB	0x0 to 0x3FF (high-order 2 bits)		0	R			
		D0	ADD8				0				
A/D trigger register	0040242 (B)	D7-6	–	–	–		–	–	0 when being read.		
		D5	MS	A/D conversion mode selection	1	Continuous	0	Normal	0	R/W	
		D4	TS1	A/D conversion trigger selection	TS[1:0]		Trigger		0	R/W	
		D3	TS0		1	1	#ADTRG pin	0			
					1	0	8-bit timer 0	0			
					0	1	16-bit timer 0	0			
						0	0	Software			
		D2	CH2	A/D conversion channel status	CH[2:0]		Channel		0	R	
		D1	CH1		1	1	1	AD7	0		
		D0	CH0		1	1	0	AD6	0		
		1	0		1	AD5					
		1	0		0	AD4					
		0	1		1	AD3					
		0	1		0	AD2					
				0	0	1	AD1				
				0	0	0	AD0				
A/D channel register	0040243 (B)	D7-6	–	–	–		–	–	0 when being read.		
		D5	CE2	A/D converter end channel selection	CE[2:0]		End channel		0	R/W	
		D4	CE1		1	1	1	AD7	0		
		D3	CE0		1	1	0	AD6	0		
					1	0	1	AD5			
					1	0	0	AD4			
					0	1	1	AD3			
					0	1	0	AD2			
						0	0	1	AD1		
						0	0	0	AD0		
		D2	CS2	A/D converter start channel selection	CS[2:0]		Start channel		0	R/W	
		D1	CS1		1	1	1	AD7	0		
		D0	CS0		1	1	0	AD6	0		
		1	0		1	AD5					
		1	0		0	AD4					
		0	1		1	AD3					
		0	1		0	AD2					
				0	0	1	AD1				
				0	0	0	AD0				
A/D enable register	0040244 (B)	D7-4	–	–	–		–	–	0 when being read.		
		D3	ADF	Conversion-complete flag	1	Completed	0	Run/Standby	0	R	Reset when ADD is read.
		D2	ADE	A/D enable	1	Enabled	0	Disabled	0	R/W	
		D1	ADST	A/D conversion control/status	1	Start/Run	0	Stop	0	R/W	
		D0	OWE	Overwrite error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
A/D sampling register	0040245 (B)	D7-2	–	–	–		–	–	0 when being read.		
		D1	ST1	Input signal sampling time setup	ST[1:0]		Sampling time		1	R/W	Use with 9 clocks.
		D0	ST0		1	1	9 clocks	1			
					1	0	7 clocks				
					0	1	5 clocks				
		0	0		3 clocks						

IV ANALOG BLOCK: A/D CONVERTER

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
Serial I/F Ch.1, A/D interrupt priority register	004026A (B)	D7	–	reserved	–	–	–	0 when being read.		
		D6	PAD2	A/D converter interrupt level	0 to 7	X	R/W			
		D5	PAD1			X				
		D4	PAD0			X				
		D3	–	reserved	–	–	–	–	0 when being read.	
		D2	PSIO12	Serial interface Ch.1 interrupt level	0 to 7	X	R/W			
		D1	PSIO11			X				
D0	PSIO10	X								
Port input 4–7, clock timer, A/D interrupt enable register	0040277 (B)	D7–6	–	reserved	–	–	–	0 when being read.		
		D5	EP7	Port input 7	1 Enabled	0 Disabled	0	R/W		
		D4	EP6				0	R/W		
		D3	EP5	Port input 5	1 Enabled	0 Disabled	0	R/W		
		D2	EP4				0	R/W		
		D1	ECTM	Clock timer	0	R/W				
		D0	EADE	A/D converter	0	R/W				
Port input 4–7, clock timer, A/D interrupt factor flag register	0040287 (B)	D7–6	–	reserved	–	–	–	0 when being read.		
		D5	FP7	Port input 7	1 Factor is generated	0 No factor is generated	X	R/W		
		D4	FP6				X	R/W		
		D3	FP5	Port input 5	1 Factor is generated	0 No factor is generated	X	R/W		
		D2	FP4				X	R/W		
		D1	FCTM	Clock timer	X	R/W				
		D0	FADE	A/D converter	X	R/W				
Serial I/F Ch.1, A/D, port input 4–7 IDMA request register	0040293 (B)	D7	RP7	Port input 7	1 IDMA request	0 Interrupt request	0	R/W		
		D6	RP6				0	R/W		
		D5	RP5	Port input 5	1 IDMA request	0 Interrupt request	0	R/W		
		D4	RP4				0	R/W		
		D3	–	reserved	–	–	–	–	0 when being read.	
		D2	RADE	A/D converter	1 IDMA request	0 Interrupt request	0	R/W		
		D1	RSTX1	SIF Ch.1 transmit buffer empty	0	R/W				
D0	RSRX1	SIF Ch.1 receive buffer full	0	R/W						
Serial I/F Ch.1, A/D, port input 4–7 IDMA enable register	0040297 (B)	D7	DEP7	Port input 7	1 IDMA enabled	0 IDMA disabled	0	R/W		
		D6	DEP6				0	R/W		
		D5	DEP5	Port input 5	1 IDMA enabled	0 IDMA disabled	0	R/W		
		D4	DEP4				0	R/W		
		D3	–	reserved	–	–	–	–		0 when being read.
		D2	DEADE	A/D converter	1 IDMA enabled	0 IDMA disabled	0	R/W		
		D1	DESTX1	SIF Ch.1 transmit buffer empty	0	R/W				
D0	DESRX1	SIF Ch.1 receive buffer full	0	R/W						
K5 function select register	00402C0 (B)	D7–5	–	reserved	–	–	–	0 when being read.		
		D4	CFK54	K54 function selection	1 #DMAREQ3	0 K54	0	R/W		
		D3	CFK53	K53 function selection	1 #DMAREQ2	0 K53	0	R/W		
		D2	CFK52	K52 function selection	1 #ADTRG	0 K52	0	R/W		
		D1	CFK51	K51 function selection	1 #DMAREQ1	0 K51	0	R/W		
		D0	CFK50	K50 function selection	1 #DMAREQ0	0 K50	0	R/W		
K6 function select register	00402C3 (B)	D7	CFK67	K67 function selection	1 AD7	0 K67	0	R/W		
		D6	CFK66	K66 function selection	1 AD6	0 K66	0	R/W		
		D5	CFK65	K65 function selection	1 AD5	0 K65	0	R/W		
		D4	CFK64	K64 function selection	1 AD4	0 K64	0	R/W		
		D3	CFK63	K63 function selection	1 AD3	0 K63	0	R/W		
		D2	CFK62	K62 function selection	1 AD2	0 K62	0	R/W		
		D1	CFK61	K61 function selection	1 AD1	0 K61	0	R/W		
		D0	CFK60	K60 function selection	1 AD0	0 K60	0	R/W		

CFK52: K52 pin function selection (D2) / K5 function select register (0x402C0)

CFK67–CFK60: K6[7:0] pin function selection (D[7:0]) / K6 function select register (0x402C3)

Selects the pins used by the A/D converter.

Write "1": A/D converter

Write "0": Input port

Read: Valid

When an external trigger is used, write "1" to CFK52 to set the K52 pin for external trigger input #ADTRG. Select the pin used for analog input from among K60 (AD0) through K67 (AD7) by writing "1" to CFK60 through CFK67.

If the function select bit for a pin is set to "0", the pin is set for an input port.

At cold start, CFK is set to "0" (input port). At hot start, CFK retains its state from prior to the initial reset.

ADD9–ADD0: A/D converted data (D[1:0]) / A/D conversion result (high-order) register (0x40241)
 (D[7:0]) / A/D conversion result (low-order) register (0x40240)

Stores the results of A/D conversion.

The LSB is stored in ADD0, and the MSB is stored in ADD9. ADD0 and ADD1 are mapped to bits D0 and D1 at the address 0x40241, but bits D2 through D7 are always 0 when read.

This is a read-only register, so writing to this register is ignored.

At initial reset, the data in this register is cleared to "0".

MS: A/D conversion mode selection (D5) / A/D trigger register (0x40242)

Selects an A/D conversion mode.

Write "1": Continuous mode

Write "0": Normal mode

Read: Valid

The A/D converter is set for the continuous mode by writing "1" to MS. In this mode, A/D conversions in the range of the channels selected using CS and CE are executed continuously until stopped in the software.

When MS = "0", the A/D converter operates in the normal mode. In this mode, A/D conversion is completed after all inputs in the range of the channels selected by CS and CE are converted in one operation.

At initial reset, MS is set to "0" (normal mode).

TS1–TS0: Trigger selection (D[4:3]) / A/D trigger register (0X40242)

Selects a trigger to start A/D conversion.

Table IV-2.7 Trigger Selection

TS1	TS0	Trigger
1	1	External trigger (K52/#ADTRG)
1	0	8-bit programmable timer 0
0	1	16-bit programmable timer 0
0	0	Software

When an external trigger is used, use the CFK52 bit to set the K52 pin for #ADTRG.

When a programmable timer is used, since its underflow signal (8-bit timer) or comparison match B signal (16-bit timer) serves as a trigger, set the cycle and other parameters for the programmable timer.

At initial reset, TS is set to "0" (software trigger).

CH2–CH0: Conversion channel status (D[2:0]) / A/D trigger register (0X40242)

Indicates the channel number (0 to 7) currently being A/D-converted.

When A/D conversion is performed in multiple channels, read this bit to identify the channel in which conversion is underway.

At initial reset, CH is set to "0" (AD0).

CE2–CE0: Conversion end-channel setup (D[5:3]) / A/D channel register (0x40243)

Sets the conversion end channel by selecting a channel number from 0 to 7.

Analog inputs can be A/D-converted successively from the channel set using CS to the channel set using this bit in one operation. If only one channel is to be A/D converted, set the same channel number in both the CS and CE bits.

At initial reset, CE is set to "0" (AD0).

CS2–CS0: Conversion start-channel setup (D[2:0]) / A/D channel register (0x40243)

Sets the conversion start channel by selecting a channel number from 0 to 7.

Analog inputs can be A/D-converted successively from the channel set using this bit to the channel set using CE in one operation. If only one channel is to be A/D converted, set the same channel number in both the CS and CE bits.

At initial reset, CS is set to "0" (AD0).

ADF: Conversion-complete flag (D3) / A/D enable register (0x40244)

Indicates that A/D conversion has been completed.

Read "1": Conversion completed
 Read "0": Being converted or standing by
 Write: Invalid

This flag is set to "1" when A/D conversion is completed, and the converted data is stored in the data register and is reset to "0" when the converted data is read out. When A/D conversion is performed in multiple channels, if the next A/D conversion is completed while ADF = "1" (before the converted data is read out), the data register is overwritten with the new conversion results, causing an overrun error to occur. Therefore, ADF must be reset by reading out the converted data before the next A/D conversion is completed.

At initial reset, ADF is set to "0" (being converted or standing by).

ADE: A/D enable (D2) / A/D enable register (0x40244)

Enables the A/D converter (readied for conversion).

Write "1": Enabled
 Write "0": Disabled
 Read: Valid

When ADE is set to "1", the A/D converter is enabled, meaning it is ready to start A/D conversion (i.e., ready to accept a trigger). When ADE = "0", the A/D converter is disabled, meaning it is unable to accept a trigger.

Before setting the conversion mode, start/end channels, etc. for the A/D converter, be sure to reset ADE to "0". This helps to prevent the A/D converter from operating erratically.

At initial reset, ADE is set to "0" (disabled).

ADST: A/D conversion control/status (D1) / A/D enable register (0x40244)

Controls A/D conversion.

Write "1": Software trigger
 Write "0": A/D conversion is stopped
 Read: Valid

If A/D conversion is to be started by a software trigger, set ADST to "1". If any other trigger is used, ADST is automatically set to "1" by the hardware.

ADST remains set while A/D conversion is underway.

In normal mode, upon completion of A/D conversion in selected channels, ADST is reset to "0" and the A/D conversion circuit is turned off. To stop A/D conversion during operation in continuous mode or forcibly terminate A/D conversion, reset ADST by writing "0".

When ADE = "0" (A/D conversion disabled), ADST is fixed to "0", with no trigger accepted. In addition, ADST is reset to "0" when ADE is reset by writing "0" during A/D conversion.

At initial reset, ADST is set to "0" (A/D conversion stopped).

OWE: Overwrite-error flag (D0) / A/D enable register (0x40244)

Indicates that the converted data has been overwritten.

Read "1": Overwritten
 Read "0": Normal
 Write "1": Invalid
 Write "0": Flag is set

During A/D conversion in multiple channels, if the conversion results for the next channel are written to the converted-data register (overwritten) before the converted data is read out to reset the conversion-complete flag ADF that has been set through conversion of the preceding channel, OWE is set to "1". When ADF is reset, because this means that the converted data has been read out, OWE is not set.

Once OWE is set to "1", it remains set until it is reset by writing "0" in the software.

At initial reset, OWE is set to "0" (normal).

ST1–ST0: Sampling-time setup (D[1:0]) / A/D sampling register (0x40245)

Sets the analog input sampling time.

Table IV-2.8 Sampling Time

ST1	ST0	Sampling Time
1	1	9-clock period
1	0	7-clock period
0	1	5-clock period
0	0	3-clock period

The A/D converter input clock is used for counting.

At initial reset, ST is set to "11" (9-clock period).

To maintain the conversion accuracy, use ST as set by default (9-clock period).

PAD2–PAD0: A/D converter interrupt level (D[6:4]) / Serial I/F Ch.1, A/D interrupt priority register (0x4026A)

Sets the priority level of the A/D-converter interrupt in the range of 0 to 7.

At initial reset, PAD becomes indeterminate.

EADE: A/D converter interrupt enable (D0) / Port input 4–7, clock timer, A/D interrupt enable register (0x40277)

Enables or disables an interrupt to the CPU generated by the A/D converter.

Write "1": Interrupt enabled

Write "0": Interrupt disabled

Read: Valid

EADE is an interrupt enable bit to control the A/D converter interrupt.

When EADE is set to "1", the A/D converter interrupt is enabled. When EADE is set to "0", the A/D-converter interrupt is disabled.

At initial reset, EADE is set to "0" (interrupt disabled).

FADE: A/D converter interrupt factor flag (D0) / Port input 4–7, clock timer, A/D interrupt factor flag register (0x40287)

Indicates the status of an A/D-converter interrupt factor generated.

When read

Read "1": Interrupt factor has occurred

Read "0": No interrupt factor has occurred

When written using the reset-only method (default)

Write "1": Interrupt factor flag is reset

Write "0": Invalid

When written using the read/write method

Write "1": Interrupt flag is set

Write "0": Interrupt flag is reset

FADE is the interrupt factor flag of the A/D converter. It is set to "1" upon completion of A/D conversion in one channel (i.e., when the conversion results are written into the ADD register).

At this time, if the following conditions are met, an interrupt to the CPU is generated:

1. The corresponding interrupt enable register bit is set to "1".
2. No other interrupt request of a higher priority has been generated.
3. The IE bit of the PSR is set to "1" (interrupts enabled).
4. The value set in the corresponding interrupt priority register is higher than the interrupt level (IL) of the CPU.

When using the interrupt factor of the A/D converter to request IDMA, note that even when the above conditions are met, no interrupt request to the CPU is generated for the interrupt factor that has occurred. If interrupts are enabled at the setting of IDMA, an interrupt is generated under the above conditions after the data transfer by IDMA is completed.

IV ANALOG BLOCK: A/D CONVERTER

The interrupt factor flag is set to "1" whenever interrupt generation conditions are met, regardless of how the interrupt enable and interrupt priority registers are set.

If the next interrupt is to be accepted after an interrupt has occurred, it is necessary that the interrupt factor flag be reset, and that the PSR be set again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can be reset only by writing to it in the software. Note that if the PSR is set again to accept interrupts generated (or if the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

At initial reset, the content of FADE becomes indeterminate, so be sure to reset it in the software.

RADE: A/D converter IDMA request (D2) / Serial I/F Ch.1, A/D, port input 4–7 IDMA request register (0x40293)

Specifies whether to invoke IDMA when an interrupt factor occurs.

When using the set-only method (default)

Write "1": IDMA request

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA request

Write "0": Interrupt request

Read: Valid

When RADE is set to "1", IDMA is invoked when an interrupt factor occurs, thereby performing a programmed data transfer. If RADE is set to "0", normal interrupt processing is performed, without invoking IDMA.

For details on IDMA, refer to "IDMA (Intelligent DMA)".

At initial reset, RADE is set to "0" (interrupt request).

DEADE: A/D converter IDMA enable (D2) / Serial I/F Ch.1, A/D, port input 4–7 IDMA enable register (0x40297)

Enables IDMA transfer by means of an interrupt factor.

When using the set-only method (default)

Write "1": IDMA enabled

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA enabled

Write "0": IDMA disabled

Read: Valid

If DEADE is set to "1", the IDMA request by the interrupt factor is enabled. If this bit is set to "0", the IDMA request is disabled.

After an initial reset, DEADE is set to "0" (IDMA disabled).

Programming Notes

- (1) Before setting the conversion mode, start/end channels, etc. for the A/D converter, be sure to disable the A/D converter (ADE (D2) / A/D enable register (0x40244) = "0"). A change in settings while the A/D converter is enabled could cause it to operate erratically.
- (2) The A/D converter operates only when the prescaler is operating.
When the A/D converter registers are set up, the prescaler must be operating. Therefore, start the prescaler first and make sure the A/D converter is supplied with its operating clock before setting up the A/D converter registers.
In consideration of the conversion accuracy, we recommend that the A/D converter operating clock be 2 MHz (max.).
- (3) Do not start an A/D conversion when the clock supplied from the prescaler to the A/D converter is turned off, and do not turn off the prescaler's clock output when an A/D conversion is underway, as doing so could cause the A/D converter to operate erratically.
- (4) After an initial reset, the interrupt factor flag (FADE) becomes indeterminate. To prevent generation of an unwanted interrupt or IDMA request, be sure to reset this flag and register in a program.
- (5) To prevent the regeneration of interrupts due to the same factor following the occurrence an interrupt, always be sure to reset the interrupt factor flag before setting the PSR again or executing the reti instruction.
- (6) When the A/D converter is set to enabled state, a current flows between AVDD and VSS, and power is consumed, even when A/D operations are not performed. Therefore, when the A/D converter is not used, it must be set to the disabled state (default "0" setting of ADE(D2) in the A/D enable register (0x40244)).
- (7) Once A/D conversion ends, further A/D conversion will not be performed correctly if restarted within an interval shorter than one cycle of the A/D converter operating clock set by the prescaler.

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E0C33 Block Technical Manual

V DMA BLOCK

V-1 INTRODUCTION

The DMA block is configured with two types of DMA controllers: HSDMA (High-Speed DMA) that has on-chip registers for controlling DMA command information and IDMA (Intelligent DMA) that uses a memory area for storing DMA command information.

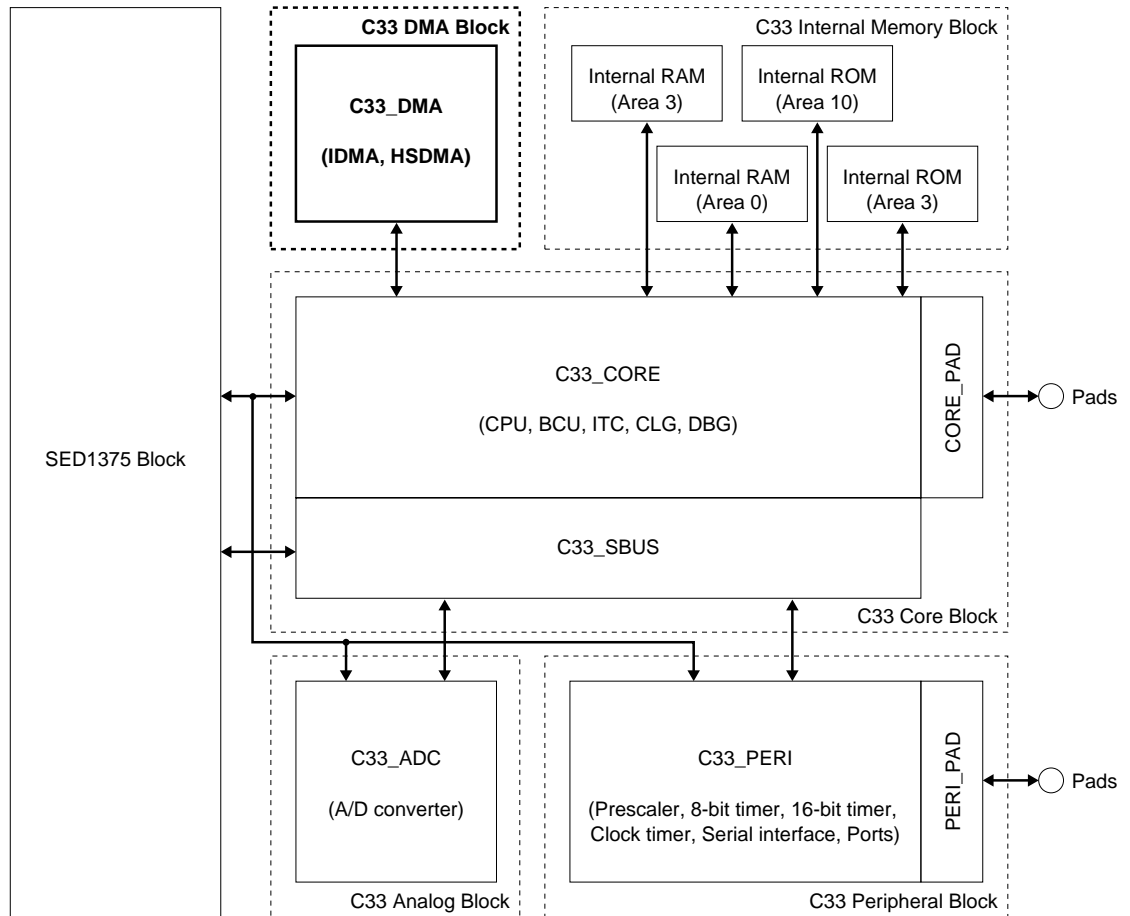


Figure V-1.1 DMA Block

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V-2 HSDMA (High-Speed DMA)

Functional Outline of HSDMA

The DMA Block contains four channels of HSDMA (High-Speed DMA) circuits that support dual-address transfer and single-address transfer methods.

Since the control registers required for the DMA function are built into the chip, DMA requests for data transfer can be responded to instantaneously.

Dual-address transfer

In this method, a source address and a destination address for DMA transfer can be specified and a DMA transfer is performed in two phases. The first phase reads data at the source address into the on-chip temporary register. The second phase writes the temporary register data to the destination address.

Unlike IDMA (Intelligent DMA), which has transfer information in memory, this DMA method does not support a DMA link function but allows high-speed data transfers because it is not necessary to read transfer information from a memory.

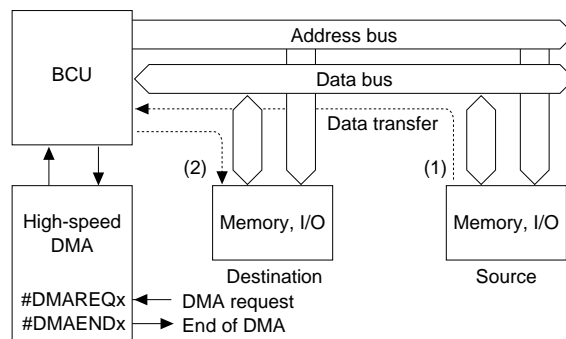


Figure V-2.1 Dual-Address Transfer Method

Single-address transfer

In this method, data transfers that are normally accomplished by executing data read and write operations back-to-back are executed on the external bus collectively at one time, thus further speeding up the transfer operation. The #DMAACKx and #DMAENDx signals are used to control data transfer.

Unlike dual-address transfer, this method does not allow memory to memory data transfer but data transfers can be performed in minimum cycles.

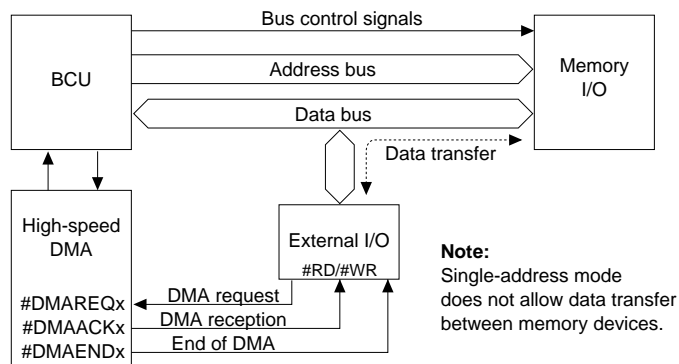


Figure V-2.2 Single-Address Transfer Method

Note: Channels 0 to 3 are configured in the same way and have the same functionality. Signal and control bit names are assigned channel numbers 0 to 3 to distinguish them from other channels. In this manual, however, channel numbers 0 to 3 are designated with an "x" except where they must be distinguished, as the explanation is the same for all channels.

I/O Pins of HSDMA

Table V-2.1 lists the I/O pins used for HSDMA.

Table V-2.1 I/O Pins of HSDMA

Pin name	I/O	Function	Function select bit
K50/#DMAREQ0	I	Input port / High-speed DMA request 0	CFK50(D0)/K5 function select register(0x402C0)
K51/#DMAREQ1	I	Input port / High-speed DMA request 1	CFK51(D1)/K5 function select register(0x402C0)
K53/#DMAREQ2	I	Input port / High-speed DMA request 2	CFK53(D3)/K5 function select register(0x402C0)
K54/#DMAREQ3	I	Input port / High-speed DMA request 3	CFK54(D4)/K5 function select register(0x402C0)
P04/SIN1/ #DMAACK2	I/O	I/O port / Serial IF Ch.1 data input / #DMAACK2 output (Ex)	CFEX4(D4)/Port function extension register(0x402DF)
P05/SOUT1/ #DMAEND2	I/O	I/O port / Serial IF Ch.1 data output / #DMAEND2 output (Ex)	CFEX5(D5)/Port function extension register(0x402DF)
P06/#SCLK1/ #DMAACK3	I/O	I/O port / Serial IF Ch.1 clock input/output / #DMAACK3 output (Ex)	CFEX6(D6)/Port function extension register(0x402DF)
P07/#SRDY1/ #DMAEND3	I/O	I/O port / Serial IF Ch.1 ready input/output / #DMAEND3 output (Ex)	CFEX7(D7)/Port function extension register(0x402DF)
P15/EXCL4/ #DMAEND0	I/O	I/O port / 16-bit timer 4 event counter input (I) / High-speed DMA Ch.0 end signal output (O)	CFP15(D5)/P1 function select register(0x402D4)
P16/EXCL5/ #DMAEND1	I/O	I/O port / 16-bit timer 5 event counter input (I) / High-speed DMA Ch.1 end signal output (O)	CFP16(D6)/P1 function select register(0x402D4)
P32/#DMAACK0	I/O	I/O port / #DMAACK0 output	CFP32(D2)/P3 function select register(0x402DC)
P33/#DMAACK1	I/O	I/O port / #DMAACK1 output	CFP33(D3)/P3 function select register(0x402DC)

(I): Input mode, (O): Output mode, (Ex): Extended function

#DMAREQx (DMA request input pin)

This pin is used to input a DMA request signal from an external peripheral circuit. One data transfer operation is performed by this trigger (either the rising edge or the falling edge of the signal can be selected). The #DMAREQ0 to #DMAREQ3 pins correspond to channel 0 to channel 3, respectively. In addition to this external input, software trigger or an interrupt factor can be selected for the HSDMA trigger factor using the register in the interrupt controller.

#DMAACKx (DMA acknowledge signal output pin for single-address mode)

This signal is output to indicate that a DMA request has been acknowledged by the DMA controller. In single-address mode, the I/O device that is the source or destination of transfer outputs data to the external bus or takes in data from the external data synchronously with this signal. The #DMAACK0 to #DMAACK3 pins correspond to channel 0 to channel 3, respectively. This signal is not output in dual-address mode.

#DMAENDx (End-of-transfer signal output pin)

This signal is output to indicate that the number of data transfer operations that is set in the control register have been completed. The #DMAEND0 to #DMAEND3 pins correspond to channel 0 to channel 3, respectively.

Method for setting HSDMA I/O pins

As shown in Table V-2.1, the pins used for HSDMA are shared with input ports and I/O ports. At cold start, all of these are set as input and I/O port pins (function select register = "0"). According to the signals to be used, set the corresponding pin function select bit by writing "1". At hot start, the register retains the previous status before a reset.

The #DMAEND3, #DMAACK3, #DMAEND2 and #DMAACK2 outputs are the extended functions of the P04 to P07 ports. When using these signals, the extended function bit (CFEX[7:4]) must be set to "1". In addition, setup of the #DMAEND0 pin or #DMAEND1 pin further requires setting the I/O port's I/O control bit IOC15 (D5) or IOC16 (D6) / P1 I/O control register (0x402D6) by writing "1" in order to direct the pin for output. If this pin is directed for input, it functions as a 16-bit programmable timer's event counter input and cannot be used to output the #DMAENDx signal. At cold start, this pin is set for input. At hot start, it retains the previous status.

Programming Control Information

The HSDMA operates according to the control information set in the registers.

Note that some control bits change their functions according to the address mode.

The following explains how to set the contents of control information. Before using HSDMA, make each the settings described below.

Setting the Registers in Dual-Address Mode

Make sure that the HSDMA channel is disabled (HSx_EN = "0") before setting the control information.

Address mode

The address mode select bit DUALMx should be set to "1" (dual-address mode). This bit is set to "0" (single-address mode) at initial reset.

DUALM0: Ch. 0 address mode selection (DF) / HSDMA Ch. 0 control register (0x48222)

DUALM1: Ch. 1 address mode selection (DF) / HSDMA Ch. 1 control register (0x48232)

DUALM2: Ch. 2 address mode selection (DF) / HSDMA Ch. 2 control register (0x48242)

DUALM3: Ch. 3 address mode selection (DF) / HSDMA Ch. 3 control register (0x48252)

Transfer mode

A transfer mode should be set using the DxMOD[1:0] bits.

D0MOD[1:0]: Ch. 0 transfer mode (D[F:E]) / HSDMA Ch. 0 high-order destination address set-up register (0x4822A)

D1MOD[1:0]: Ch. 1 transfer mode (D[F:E]) / HSDMA Ch. 1 high-order destination address set-up register (0x4823A)

D2MOD[1:0]: Ch. 2 transfer mode (D[F:E]) / HSDMA Ch. 2 high-order destination address set-up register (0x4824A)

D3MOD[1:0]: Ch. 3 transfer mode (D[F:E]) / HSDMA Ch. 3 high-order destination address set-up register (0x4825A)

The following three transfer modes are available:

Single transfer mode (DxMOD = "00", default)

In this mode, a transfer operation invoked by one trigger is completed after transferring one unit of data of the size set by DATSIZEx. If data transfer need to be performed a number of times as set by the transfer counter, an equal number of triggers are required.

Successive transfer mode (DxMOD = "01")

In this mode, data transfer operations are performed by one trigger a number of times as set by the transfer counter. The transfer counter is decremented to 0 each time data is transferred.

Block transfer mode (DxMOD = "10")

In this mode, a transfer operation invoked by one trigger is completed after transferring one block of data of the size set by BLKLENx. If a block transfer need to be performed a number of times as set by the transfer counter, an equal number of triggers are required.

Transfer data size

The DATSIZEx bit is used to set the unit size of data to be transferred.

A half-word size (16 bits) is assumed if this bit is "1" and a byte size (8 bits) is assumed if this bit is "0" (default).

DATSIZE0: Ch. 0 transfer data size (DE) / HSDMA Ch. 0 high-order source address set-up register (0x48226)

DATSIZE1: Ch. 1 transfer data size (DE) / HSDMA Ch. 1 high-order source address set-up register (0x48236)

DATSIZE2: Ch. 2 transfer data size (DE) / HSDMA Ch. 2 high-order source address set-up register (0x48246)

DATSIZE3: Ch. 3 transfer data size (DE) / HSDMA Ch. 3 high-order source address set-up register (0x48256)

Block length

When using block transfer mode (DxMOD = "10"), the data block length (in units of DATSIZE_x) should be set using the BLKLEN_x[7:0] bits.

BLKLEN0[7:0]: Ch. 0 block length (D[7:0]) / HSDMA Ch. 0 transfer counter register (0x48220)

BLKLEN1[7:0]: Ch. 1 block length (D[7:0]) / HSDMA Ch. 1 transfer counter register (0x48230)

BLKLEN2[7:0]: Ch. 2 block length (D[7:0]) / HSDMA Ch. 2 transfer counter register (0x48240)

BLKLEN3[7:0]: Ch. 3 block length (D[7:0]) / HSDMA Ch. 3 transfer counter register (0x48250)

Note: The block size thus set is decremented according to the transfers performed. If the block size is set to 0, it is decremented to all Fs by the first transfer performed. This means that you have set the maximum value that is determined by the number of bits available.

In single transfer and successive transfer modes, these bits are used as the bits7–0 of the transfer counter.

Transfer counter

Block transfer mode

In block transfer mode, up to 16 bits of transfer count can be specified.

TC0_L[7:0]: Ch. 0 transfer counter [7:0] (D[F:8]) / HSDMA Ch. 0 transfer counter register (0x48220)

TC1_L[7:0]: Ch. 1 transfer counter [7:0] (D[F:8]) / HSDMA Ch. 1 transfer counter register (0x48230)

TC2_L[7:0]: Ch. 2 transfer counter [7:0] (D[F:8]) / HSDMA Ch. 2 transfer counter register (0x48240)

TC3_L[7:0]: Ch. 3 transfer counter [7:0] (D[F:8]) / HSDMA Ch. 3 transfer counter register (0x48250)

TC0_H[7:0]: Ch. 0 transfer counter [15:8] (D[7:0]) / HSDMA Ch. 0 control register (0x48222)

TC1_H[7:0]: Ch. 1 transfer counter [15:8] (D[7:0]) / HSDMA Ch. 1 control register (0x48232)

TC2_H[7:0]: Ch. 2 transfer counter [15:8] (D[7:0]) / HSDMA Ch. 2 control register (0x48242)

TC3_H[7:0]: Ch. 3 transfer counter [15:8] (D[7:0]) / HSDMA Ch. 3 control register (0x48252)

Single transfer and successive transfer modes

In single transfer and successive transfer modes, up to 24 bits of transfer count can be specified.

BLKLEN0[7:0]: Ch. 0 transfer counter [7:0] (D[7:0]) / HSDMA Ch.0 transfer counter register (0x48220).

BLKLEN1[7:0]: Ch. 1 transfer counter [7:0] (D[7:0]) / HSDMA Ch.1 transfer counter register (0x48230).

BLKLEN2[7:0]: Ch. 2 transfer counter [7:0] (D[7:0]) / HSDMA Ch.2 transfer counter register (0x48240).

BLKLEN3[7:0]: Ch. 3 transfer counter [7:0] (D[7:0]) / HSDMA Ch.3 transfer counter register (0x48250).

TC0_L[7:0]: Ch. 0 transfer counter [15:8] (D[F:8]) / HSDMA Ch. 0 transfer counter register (0x48220)

TC1_L[7:0]: Ch. 1 transfer counter [15:8] (D[F:8]) / HSDMA Ch. 1 transfer counter register (0x48230)

TC2_L[7:0]: Ch. 2 transfer counter [15:8] (D[F:8]) / HSDMA Ch. 2 transfer counter register (0x48240)

TC3_L[7:0]: Ch. 3 transfer counter [15:8] (D[F:8]) / HSDMA Ch. 3 transfer counter register (0x48250)

TC0_H[7:0]: Ch. 0 transfer counter [23:16] (D[7:0]) / HSDMA Ch. 0 control register (0x48222)

TC1_H[7:0]: Ch. 1 transfer counter [23:16] (D[7:0]) / HSDMA Ch. 1 control register (0x48232)

TC2_H[7:0]: Ch. 2 transfer counter [23:16] (D[7:0]) / HSDMA Ch. 2 control register (0x48242)

TC3_H[7:0]: Ch. 3 transfer counter [23:16] (D[7:0]) / HSDMA Ch. 3 control register (0x48252)

Note: The transfer count thus set is decremented according to the transfers performed. If the transfer count is set to 0, it is decremented to all Fs by the first transfer performed. This means that you have set the maximum value that is determined by the number of bits available.

Source and destination addresses

In dual-address mode, a source address and a destination address for DMA transfer can be specified.

S0ADRL[15:0]: Ch. 0 source address [15:0] (D[F:0]) / Ch. 0 low-order source address set-up register (0x48224)

S1ADRL[15:0]: Ch. 1 source address [15:0] (D[F:0]) / Ch. 1 low-order source address set-up register (0x48234)

S2ADRL[15:0]: Ch. 2 source address [15:0] (D[F:0]) / Ch. 2 low-order source address set-up register (0x48244)

S3ADRL[15:0]: Ch. 3 source address [15:0] (D[F:0]) / Ch. 3 low-order source address set-up register (0x48254)

S0ADRH[11:0]: Ch. 0 source address [27:16] (D[B:0]) / Ch. 0 high-order source address set-up register (0x48226)

S1ADRH[11:0]: Ch. 1 source address [27:16] (D[B:0]) / Ch. 1 high-order source address set-up register (0x48236)

S2ADRH[11:0]: Ch. 2 source address [27:16] (D[B:0]) / Ch. 2 high-order source address set-up register (0x48246)

S3ADRH[11:0]: Ch. 3 source address [27:16] (D[B:0]) / Ch. 3 high-order source address set-up register (0x48256)

D0ADRL[15:0]: Ch. 0 destination address [15:0] (D[F:0]) / Ch. 0 low-order destination address set-up register (0x48228)
 D1ADRL[15:0]: Ch. 1 destination address [15:0] (D[F:0]) / Ch. 1 low-order destination address set-up register (0x48238)
 D2ADRL[15:0]: Ch. 2 destination address [15:0] (D[F:0]) / Ch. 2 low-order destination address set-up register (0x48248)
 D3ADRL[15:0]: Ch. 3 destination address [15:0] (D[F:0]) / Ch. 3 low-order destination address set-up register (0x48258)
 D0ADRH[11:0]: Ch. 0 destination address [27:16] (D[B:0]) / Ch. 0 high-order destination address set-up register (0x4822A)
 D1ADRH[11:0]: Ch. 1 destination address [27:16] (D[B:0]) / Ch. 1 high-order destination address set-up register (0x4823A)
 D2ADRH[11:0]: Ch. 2 destination address [27:16] (D[B:0]) / Ch. 2 high-order destination address set-up register (0x4824A)
 D3ADRH[11:0]: Ch. 3 destination address [27:16] (D[B:0]) / Ch. 3 high-order destination address set-up register (0x4825A)

Address increment/decrement control

The source and/or destination addresses can be incremented or decremented when one data transfer is completed. The SxIN[1:0] bits (for source address) and DxIN[1:0] bits (for destination address) are used to set this function.

S0IN[1:0]: Ch. 0 source address control (D[D:C]) / Ch. 0 high-order source address set-up register (0x48226)

S1IN[1:0]: Ch. 1 source address control (D[D:C]) / Ch. 1 high-order source address set-up register (0x48236)

S2IN[1:0]: Ch. 2 source address control (D[D:C]) / Ch. 2 high-order source address set-up register (0x48246)

S3IN[1:0]: Ch. 3 source address control (D[D:C]) / Ch. 3 high-order source address set-up register (0x48256)

D0IN[1:0]: Ch. 0 destination address control (D[D:C]) / Ch. 0 high-order destination address set-up register (0x4822A)

D1IN[1:0]: Ch. 1 destination address control (D[D:C]) / Ch. 1 high-order destination address set-up register (0x4823A)

D2IN[1:0]: Ch. 2 destination address control (D[D:C]) / Ch. 2 high-order destination address set-up register (0x4824A)

D3IN[1:0]: Ch. 3 destination address control (D[D:C]) / Ch. 3 high-order destination address set-up register (0x4825A)

SxIN/DxIN = "00": address fixed (default)

The address is not changed by a data transfer performed. Even when transferring multiple data, the transfer data is always read/write from/to the same address.

SxIN/DxIN = "01": address decremented without initialization

The address is decremented by an amount equal to the data size set by DATSIZE_x when one data transfer is completed. The address that has been decremented during transfer does not return to the initial value.

SxIN/DxIN = "10": address incremented with initialization

If this function is selected in single and successive transfer modes, the address is incremented by an amount equal to the data size set by DATSIZE_x when one data transfer is completed. The address that has been incremented during transfer does not return to the initial value.

In block transfer mode too, the address is incremented when one data unit is transferred. However, the address that has been incremented during a block transfer recycles returns to the initial value when the block transfer is completed.

SxIN/DxIN = "11": address incremented without initialization

The address is incremented by an amount equal to the data size set by DATSIZE_x when one data transfer is completed. The address that has been incremented during transfer does not return to the initial value.

Setting the Registers in Single-Address Mode

Make sure that the HSDMA channel is disabled (HSx_EN = "0") before setting the control information.

Address mode

The address mode select bit DUALMx should be set to "0" (single-address mode). This bit is set to "0" at initial reset.

Transfer mode

A transfer mode should be set using the DxMOD[1:0] bits.

- Single transfer mode (DxMOD = "00", default)
- Successive transfer mode (DxMOD = "01")
- Block transfer mode (DxMOD = "10")

Refer to the explanation in "Setting the Registers in Dual-Address Mode".

Direction of transfer

The direction of data transfer should be set using DxDIR.

D0DIR: Ch. 0 transfer direction control (DE) / HSDMA Ch. 0 control register (0x48222)

D1DIR: Ch. 1 transfer direction control (DE) / HSDMA Ch. 1 control register (0x48232)

D2DIR: Ch. 2 transfer direction control (DE) / HSDMA Ch. 2 control register (0x48242)

D3DIR: Ch. 3 transfer direction control (DE) / HSDMA Ch. 3 control register (0x48252)

Memory write operations (data transfer from I/O device to memory) are specified by writing "1" and memory read operations (data transfer from memory to I/O device) are specified by writing "0".

Transfer data size

The DATSIZEx bit is used to set the unit size of data to be transferred.

A half-word size (16 bits) is assumed if this bit is "1" and a byte size (8 bits) is assumed if this bit is "0" (default).

Block length

When using block transfer mode (DxMOD = "10"), the data block length (in units of DATSIZEx) should be set using the BLKLENx[7:0] bits.

In single transfer and successive transfer modes, BLKLENx[7:0] is used as the bits 7–0 of the transfer counter.

Transfer counter

Block transfer mode

In block transfer mode, up to 16 bits of transfer count can be specified using TCx_L[7:0] and TCx_H[7:0].

Single transfer and successive transfer modes

In single transfer and successive transfer modes, up to 24 bits of transfer count can be specified using BLKLENx[7:0], TCx_L[7:0] and TCx_H[7:0].

Memory address

In single-address mode, SxADRL[15:0] and SxADRH[11:0] are used to specify a memory address.

S0ADRL[15:0]: Ch. 0 memory address [15:0] (D[F:0]) / Ch. 0 low-order source address set-up register (0x48224)

S0ADRH[11:0]: Ch. 0 memory address [27:16] (D[B:0]) / Ch. 0 high-order source address set-up register (0x48226)

S1ADRL[15:0]: Ch. 1 memory address [15:0] (D[F:0]) / Ch. 1 low-order source address set-up register (0x48234)

S1ADRH[11:0]: Ch. 1 memory address [27:16] (D[B:0]) / Ch. 1 high-order source address set-up register (0x48236)

S2ADRL[15:0]: Ch. 2 memory address [15:0] (D[F:0]) / Ch. 2 low-order source address set-up register (0x48244)

S2ADRH[11:0]: Ch. 2 memory address [27:16] (D[B:0]) / Ch. 2 high-order source address set-up register (0x48246)

S3ADRL[15:0]: Ch. 3 memory address [15:0] (D[F:0]) / Ch. 3 low-order source address set-up register (0x48254)

S3ADRH[11:0]: Ch. 3 memory address [27:16] (D[B:0]) / Ch. 3 high-order source address set-up register (0x48256)

In single-address mode, data transfer is performed between the memory connected to the system interface and an external I/O device. The I/O device is accessed directly by the #DMAACKx signal, so it is unnecessary to specify an address. DxADRL[15:0] and DxADRH[11:0] are not used in single-address mode.

Address increment/decrement control

The memory addresses can be incremented or decremented when one data transfer is completed. SxIN[1:0] is used to set this function.

S0IN[1:0]: Ch. 0 memory address control (D[D:C]) / Ch. 0 high-order source address set-up register (0x48226)

S1IN[1:0]: Ch. 1 memory address control (D[D:C]) / Ch. 1 high-order source address set-up register (0x48236)

S2IN[1:0]: Ch. 2 memory address control (D[D:C]) / Ch. 2 high-order source address set-up register (0x48246)

S3IN[1:0]: Ch. 3 memory address control (D[D:C]) / Ch. 3 high-order source address set-up register (0x48256)

SxIN = "00": address fixed (default)

SxIN = "01": address decremented without initialization

SxIN = "10": address incremented with initialization

SxIN = "00": address incremented without initialization

Refer to the explanation in "Setting the Registers in Dual-Address Mode".

D0IN[1:0] is not used in single-address mode.

Enabling/Disabling DMA Transfer

The HSDMA transfer is enabled by writing "1" to the enable bit HSx_EN.

HS0_EN: Ch. 0 enable (D0) / Ch. 0 enable register (0x4822C)

HS1_EN: Ch. 1 enable (D0) / Ch. 1 enable register (0x4823C)

HS2_EN: Ch. 2 enable (D0) / Ch. 2 enable register (0x4824C)

HS3_EN: Ch. 3 enable (D0) / Ch. 3 enable register (0x4825C)

However, the control information must always be set correctly before enabling a DMA transfer.

Note that the control information cannot be set when HSx_EN = "1".

When HSx_EN is set to "0", HSDMA requests are no longer accepted.

When a DMA transfer is completed (transfer counter = 0), HSx_EN is reset to "0" to disable the following trigger inputs.

Trigger Factor

A HSDMA trigger factor can be selected from among 13 types using the HSDMA trigger set-up register for each channel. This function is supported by the interrupt controller.

HSD0S[3:0]: Ch. 0 trigger set-up (D[3:0]) / HSDMA Ch. 0/1 trigger set-up register (0x40298)

HSD1S[3:0]: Ch. 1 trigger set-up (D[7:4]) / HSDMA Ch. 0/1 trigger set-up register (0x40298)

HSD2S[3:0]: Ch. 2 trigger set-up (D[3:0]) / HSDMA Ch. 2/3 trigger set-up register (0x40299)

HSD3S[3:0]: Ch. 3 trigger set-up (D[7:4]) / HSDMA Ch. 2/3 trigger set-up register (0x40299)

Table V-2.2 shows the setting value and the corresponding trigger factor.

Table V-2.2 HSDMA Trigger Factor

Value	Ch.0 trigger factor	Ch.1 trigger factor	Ch.2 trigger factor	Ch.3 trigger factor
0000	Software trigger	Software trigger	Software trigger	Software trigger
0001	K50 port input (falling edge)	K51 port input (falling edge)	K53 port input (falling edge)	K54 port input (falling edge)
0010	K50 port input (rising edge)	K51 port input (rising edge)	K53 port input (rising edge)	K54 port input (rising edge)
0011	Port 0 input	Port 1 input	Port 2 input	Port 3 input
0100	Port 4 input	Port 5 input	Port 6 input	Port 7 input
0101	8-bit timer 0 underflow	8-bit timer 1 underflow	8-bit timer 2 underflow	8-bit timer 3 underflow
0110	16-bit timer 0 compare B	16-bit timer 1 compare B	16-bit timer 2 compare B	16-bit timer 3 compare B
0111	16-bit timer 0 compare A	16-bit timer 1 compare A	16-bit timer 2 compare A	16-bit timer 3 compare A
1000	16-bit timer 4 compare B	16-bit timer 5 compare B	16-bit timer 4 compare B	16-bit timer 5 compare B
1001	16-bit timer 4 compare A	16-bit timer 5 compare A	16-bit timer 4 compare A	16-bit timer 5 compare A
1010	Serial I/F Ch.0 Rx buffer full	Serial I/F Ch.1 Rx buffer full	Serial I/F Ch.0 Rx buffer full	Serial I/F Ch.1 Rx buffer full
1011	Serial I/F Ch.0 Tx buffer empty	Serial I/F Ch.1 Tx buffer empty	Serial I/F Ch.0 Tx buffer empty	Serial I/F Ch.1 Tx buffer empty
1100	A/D conversion completion	A/D conversion completion	A/D conversion completion	A/D conversion completion

By selecting an interrupt factor with the HSDMA trigger set-up register, the HSDMA channel is invoked when the selected interrupt factor occurs. The interrupt control bits (interrupt factor flag, interrupt enable register, IDMA request register, interrupt priority register) do not affect this invocation. The interrupt factor that invokes HSDMA sets the interrupt factor flag, and HSDMA does not reset the flag. Consequently, when the DMA transfer is completed (even if the transfer counter is not 0), an interrupt request to the CPU will be generated if the interrupt has been enabled. To generate an interrupt only when the transfer counter reaches 0, disable the interrupt by the interrupt factor that invokes HSDMA and use the HSDMA transfer completion interrupt.

When software trigger is selected, the HSDMA channel can be invoked by writing "1" to the HSTx bit.

HST0: Ch. 0 software trigger (D0) / HSDMA software trigger register (0x4029F)

HST1: Ch. 1 software trigger (D1) / HSDMA software trigger register (0x4029F)

HST2: Ch. 2 software trigger (D2) / HSDMA software trigger register (0x4029F)

HST3: Ch. 3 software trigger (D3) / HSDMA software trigger register (0x4029F)

When the selected trigger factor occurs, the trigger flag is set to "1" to invoke the HSDMA channel.

The HSDMA starts a DMA transfer if it has been enabled and the trigger flag is cleared by the hardware at the same time. This makes it possible to queue the HSDMA triggers that have been generated.

The trigger flag can be read and cleared using the HSx_TF bit.

HS0_TF: Ch. 0 trigger flag status/clear (D0) / Ch. 0 trigger flag register (0x4822E)

HS1_TF: Ch. 1 trigger flag status/clear (D0) / Ch. 1 trigger flag register (0x4823E)

HS2_TF: Ch. 2 trigger flag status/clear (D0) / Ch. 2 trigger flag register (0x4824E)

HS3_TF: Ch. 3 trigger flag status/clear (D0) / Ch. 3 trigger flag register (0x4825E)

By writing "1" to this bit, the set trigger flag can be cleared if the DMA transfer has not been started.

When this bit is read, "1" indicates that the flag is set and "0" indicates that the flag is cleared.

Operation of HSDMA

An HSDMA channel starts data transfer by the selected trigger factor.

Make sure that transfer conditions and a trigger factor are set and the HSDMA channel is enabled before starting a DMA transfer.

Operation in Dual-Address Mode

In dual-address mode, both the source and destination addresses are accessed according to the bus condition set by the BCU.

HSDMA has three transfer modes, in each of which data transfer operates differently. The following describes the operation of HSDMA in each transfer mode.

Single transfer mode

The channel for which DxMOD in control information is set to "00" operates in single transfer mode. In this mode, a transfer operation invoked by one trigger is completed after transferring one data unit of the size set by DATSIZE_x. If a data transfer needs to be performed a number of times as set by the transfer counter, an equal number of triggers are required.

The operation of HSDMA in single transfer mode is shown by the flow chart in Figure V-2.3.

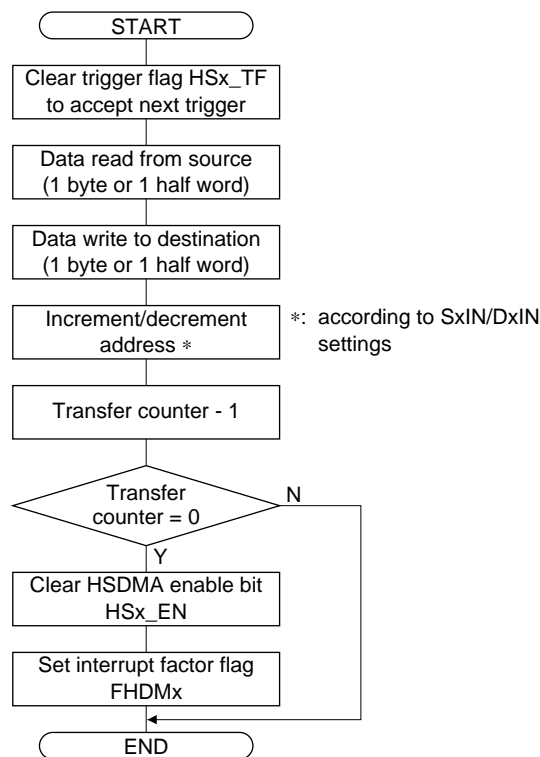


Figure V-2.3 Operation Flow in Single Transfer Mode

- (1) When a trigger is accepted, the trigger flag HS_x_TF is cleared and then data of the size set in the control information is read from the source address.
- (2) The read data is written to the destination address.
- (3) The addresses are incremented or decremented according to the S_xIN/D_xIN settings.
- (4) The transfer counter is decremented.
- (5) The HSDMA enable bit HS_x_EN is cleared and HSDMA interrupt factor flag in ITC is set when the transfer counter reaches 0 (when DINTEN_x = "1").

Successive transfer mode

The channel for which DxMOD in control information is set to "01" operates in successive transfer mode. In this mode, a data transfer is performed by one trigger a number of times as set by the transfer counter. The transfer counter is decremented to "0" by one transfer executed.

The operation of HSDMA in successive transfer mode is shown by the flow chart in Figure V-2.4.

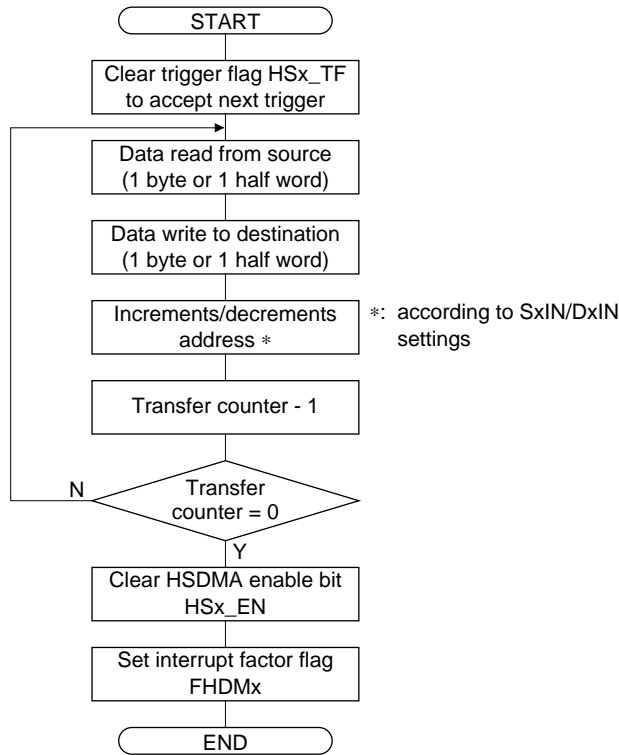


Figure V-2.4 Operation Flow in Successive Transfer Mode

- (1) When a trigger is accepted, the trigger flag HSx_TF is cleared and then data of the size set in the control information is read from the source address.
- (2) The read data is written to the destination address.
- (3) The addresses are incremented or decremented according to the SxIN/DxIN settings.
- (4) The transfer counter is decremented.
- (5) Steps (1) to (4) are repeated until the transfer counter reaches 0.
- (6) The HSDMA enable bit HSx_EN is cleared and HSDMA interrupt factor flag in ITC is set when the transfer counter reaches 0 (when DINTENx = "1").

Block transfer mode

The channel for which $DxMOD$ in control information is set to "10" operates in block transfer mode. In this mode, a transfer operation invoked by one trigger is completed after transferring one block of data of the size set by $BLKLENx$. If a block transfer needs to be performed a number of times as set by the transfer counter, an equal number of triggers are required.

The operation of HSDMA in block transfer mode is shown by the flow chart in Figure V-2.5.

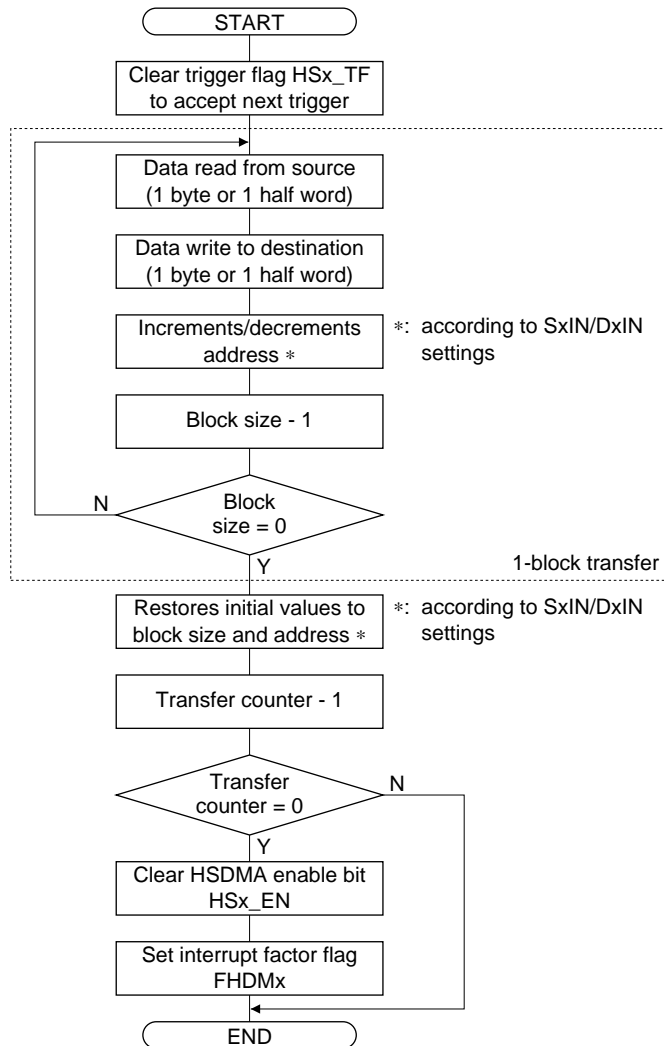


Figure V-2.5 Operation Flow in Block Transfer Mode

- (1) When a trigger is accepted, the trigger flag HSx_TF is cleared and then data of the size set in the control information is read from the source address.
- (2) The read data is written to the destination address.
- (3) The address is incremented or decremented and $BLKLENx$ is decremented.
- (4) Steps (1) to (3) are repeated until $BLKLENx$ reaches 0.
- (5) If $SxIN$ or $DxIN$ is "10", the address is recycled to the initial value.
- (6) The transfer counter is decremented.
- (7) The HSDMA enable bit HSx_EN is cleared and HSDMA interrupt factor flag in ITC is set when the transfer counter reaches 0 (when $DINTENx = "1"$).

Operation in Single-Address Mode

The operation of each transfer mode is almost the same as that of dual-address mode (see the previous section). However, data read/write operation is performed simultaneously in single-address mode. The following explains the data transfer operation different from dual-address mode.

#DMAACKx signal output and bus operation

When the HSDMA circuit accepts the DMA request, it outputs a low-level pulse from the #DMAACKx pin and starts bus operation for the memory at the same time.

The contents of this bus operation are as follows:

- **Data transfer from I/O device to memory**

The address that has been set in the memory address register is output to the address bus.

A write operation is performed under the interface conditions set on the area to which the memory at the destination of transfer belongs. The data bus is left floating.

The external I/O device outputs the transfer data onto the data bus using the #DMAACKx signal as the read signal. The memory takes in this data using the write signal.

- **Data transfer from memory to an I/O device**

The address that has been set in the memory address register is output to the address bus.

A read operation is performed under the interface conditions set on the area to which the memory at the source of transfer belongs.

The memory outputs the transfer data onto the data bus using the read signal.

The external I/O device takes in the data from the data bus using the #DMAACKx signal as the write signal.

If the transfer data size is 16 bits and the I/O device is an 8-bit device, two bus operations are performed. Otherwise, transfer is completed in one bus operation.

#DMAENDx signal output

When the transfer counter reaches 0, the end-of-transfer signal is output from the #DMAENDx pin indicating that a specified number of transfers has been completed. At the same time, the interrupt factor for the completion of HSDMA is generated.

Timing Chart

Dual-address mode

(1) SRAM

Example: When 2 (RD)/1 (WR) wait cycles are inserted

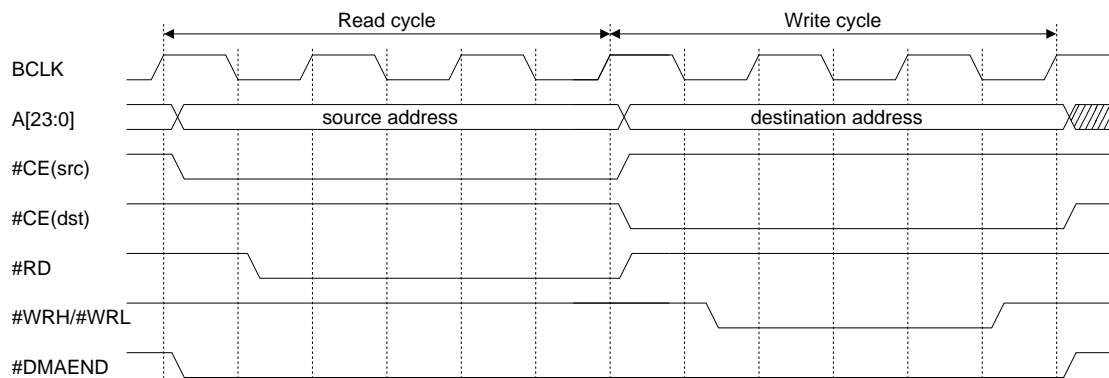


Figure V-2.6 #DMAEND Signal Output Timing (SRAM)

(2) DRAM

Example: Page mode, RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle

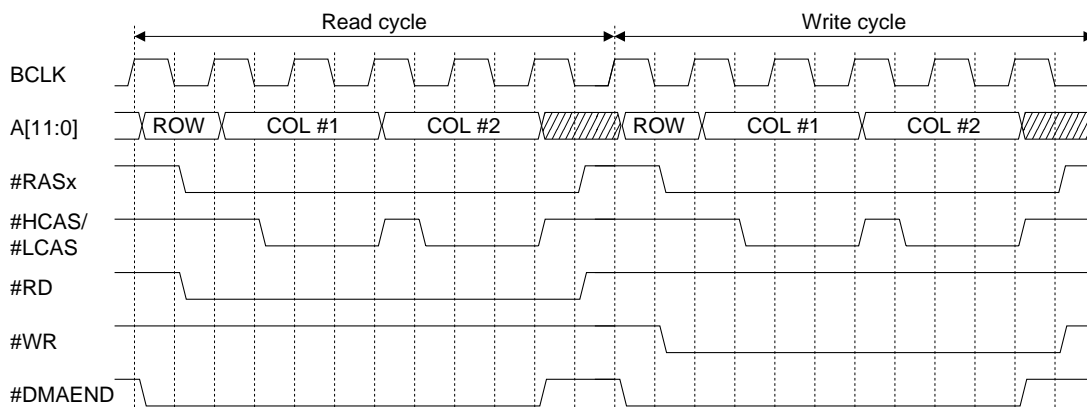


Figure V-2.7 #DMAEND Signal Output Timing (DRAM)

Single-address mode

(1) SRAM

Example: When 2 (RD)/1 (WR) wait cycles are inserted

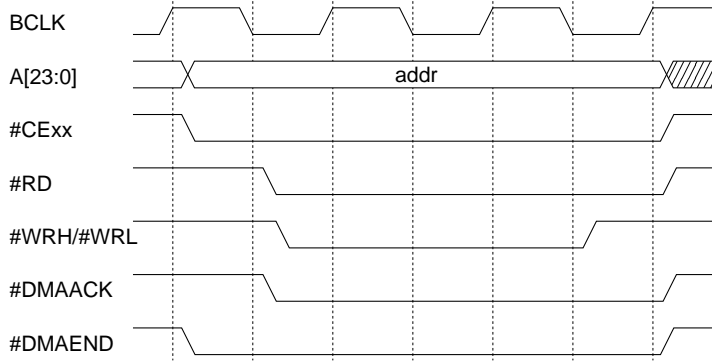


Figure V-2.8 #DMAACK/#DMAEND Signal Output Timing (SRAM)

(2) Burst ROM

Example: When 4-consecutive-burst and 2-wait cycles are set during the first access

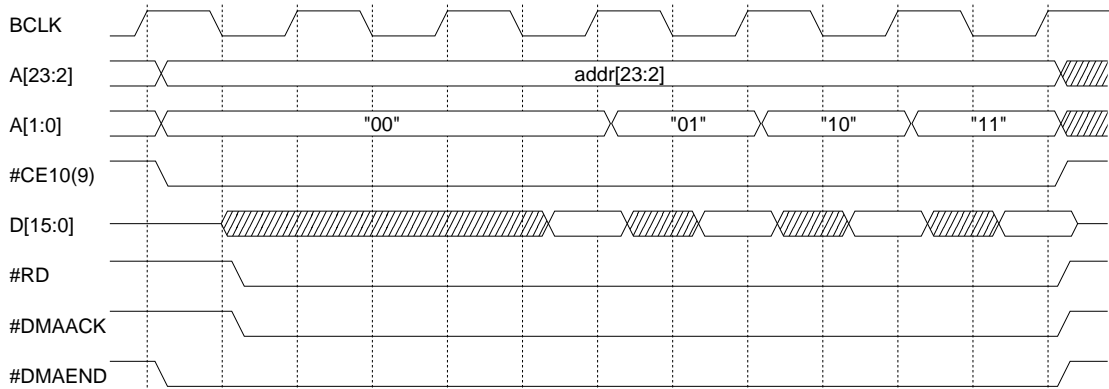


Figure V-2.9 #DMAACK/#DMAEND Signal Output Timing (Burst ROM)

(3) DRAM

Example: Page mode, RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle

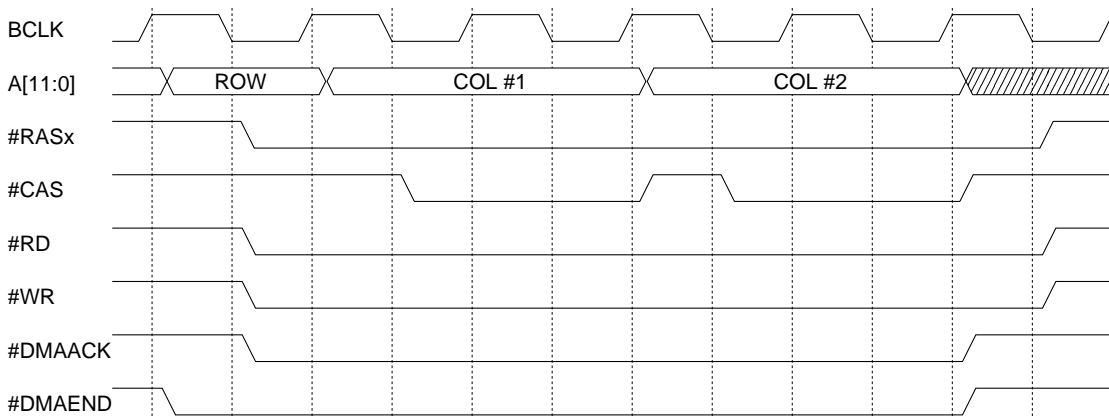


Figure V-2.10 #DMAACK/#DMAEND Signal Output Timing (DRAM)

Interrupt Function of HSDMA

The DMA controller can generate an interrupt when the transfer counter in each HSDMA channel reaches 0. Furthermore, channels 0 and 1 can invoke IDMA using their interrupt factor.

Interrupt enable bit in the HSDMA circuit

The DINTEN_x bit in each channel allows selection whether to set the HSDMA interrupt factor flag in the interrupt controller or not. If DINTEN_x = "1", the HSDMA interrupt factor flag is set to "1" when the transfer counter reaches 0. If DINTEN_x = "0", the HSDMA interrupt factor flag is not set and an interrupt does not occur.

DINTEN0: Ch. 0 interrupt enable (DF) / HSDMA Ch. 0 high-order source address set-up register (0x48226)

DINTEN1: Ch. 1 interrupt enable (DF) / HSDMA Ch. 1 high-order source address set-up register (0x48236)

DINTEN2: Ch. 2 interrupt enable (DF) / HSDMA Ch. 2 high-order source address set-up register (0x48246)

DINTEN3: Ch. 3 interrupt enable (DF) / HSDMA Ch. 3 high-order source address set-up register (0x48256)

Control registers of the interrupt controller

Table V-2.3 shows the control registers of the interrupt controller that are provided for each channel.

Table V-2.3 Control Registers of Interrupt Controller

Channel	Interrupt factor flag	Interrupt enable register	Interrupt priority register
Ch. 0	FHDM0(D0/0x40281)	EHDM0(D0/0x40271)	PHSD0L[2:0](D[2:0]/0x40263)
Ch. 1	FHDM1(D1/0x40281)	EHDM1(D1/0x40271)	PHSD1L[2:0](D[6:4]/0x40263)
Ch. 2	FHDM2(D2/0x40281)	EHDM2(D2/0x40271)	PHSD2L[2:0](D[2:0]/0x40264)
Ch. 3	FHDM3(D3/0x40281)	EHDM3(D3/0x40271)	PHSD3L[2:0](D[6:4]/0x40264)

If DINTEN_x = "1", the HSDMA controller sets the HSDMA interrupt factor flag to "1" when the transfer counter reaches 0 after completing a series of HSDMA transfers. If the corresponding bit of the interrupt enable register is set to "1" at this time, an interrupt request is generated. Interrupts can be disabled by leaving the interrupt enable register bit set to "0". The HSDMA interrupt factor flag is always set to "1" when the data transfer in each channel is completed no matter what value the interrupt enable register bit is set to. (This is true even when it is set to "0".)

The interrupt priority register sets an interrupt priority level (0 to 7). An interrupt request to the CPU is accepted only when there is no other interrupt request of higher priority. Furthermore, it is only when the PSR's IE bit = "1" (interrupt enable) and the set value of IL is smaller than the HSDMA interrupt level which is set in the interrupt priority register that the CPU actually accepts a HSDMA interrupt. For details about the interrupt control register and for the device operation when an interrupt occurs, refer to "ITC (Interrupt Controller)".

Intelligent DMA

Intelligent DMA (IDMA) can be invoked by the end-of-transfer interrupt factor of channels 0 and 1 of HSDMA. The following shows the IDMA channels set in HSDMA:

IDMA channel

Channel 0 end-of-transfer interrupt: 0x05

Channel 1 end-of-transfer interrupt: 0x06

Before IDMA can be invoked, the corresponding bits of the IDMA request and IDMA enable registers must be set to "1". Settings of transfer conditions on the IDMA side are also required.

Table V-2.4 Control Bits for IDMA Transfer

Channel	IDMA request bit	IDMA enable bit
Ch. 0	RHDM0(D4/0x40290)	DEHDM0(D4/0x40294)
Ch. 1	RHDM1(D5/0x40290)	DEHDM1(D5/0x40294)

If the IDMA request and enable bits are set to "1", IDMA is invoked through generation of an interrupt factor. No interrupt request is generated at that point. An interrupt request is generated after the DMA transfer is completed. The registers can also be set so as not to generate an interrupt, with only a DMA transfer performed.

For details on IDMA transfers and interrupt control upon completion of IDMA transfer, refer to "IDMA (Intelligent DMA)".

Trap vector

The trap vector addresses for interrupt factors in each channel are set by default as follows:

(BTA3 = High) (BTA3 = Low)

Channel 0 end-of-transfer interrupt: 0x0080058 0x0C00058

Channel 1 end-of-transfer interrupt: 0x008005C 0x0C0005C

Channel 2 end-of-transfer interrupt: 0x0080060 0x0C00060

Channel 3 end-of-transfer interrupt: 0x0080064 0x0C00064

Note that the trap table base address can be modified using the TTBR registers (0x48134 to 0x48137).

I/O Memory of HSDMA

Table V-2.5 shows the control bits of HSDMA.

Table V-2.5 Control Bits of HSDMA

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
High-speed DMA Ch.0/1 interrupt priority register	0040263 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PHSD1L2	High-speed DMA Ch.1 interrupt level	0 to 7	X	R/W		
		D5	PHSD1L1				X		
		D4	PHSD1L0				X		
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PHSD0L2	High-speed DMA Ch.0 interrupt level	0 to 7	X	R/W		
		D1	PHSD0L1			X			
		D0	PHSD0L0			X			
High-speed DMA Ch.2/3 interrupt priority register	0040264 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PHSD3L2	High-speed DMA Ch.3 interrupt level	0 to 7	X	R/W		
		D5	PHSD3L1				X		
		D4	PHSD3L0				X		
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PHSD2L2	High-speed DMA Ch.2 interrupt level	0 to 7	X	R/W		
		D1	PHSD2L1			X			
		D0	PHSD2L0			X			
DMA interrupt enable register	0040271 (B)	D7–5	–	reserved	–	–	–	0 when being read.	
		D4	EIDMA	IDMA	1 Enabled 0 Disabled	0	R/W		
		D3	EHDM3	High-speed DMA Ch.3		0	R/W		
		D2	EHDM2	High-speed DMA Ch.2		0	R/W		
		D1	EHDM1	High-speed DMA Ch.1		0	R/W		
		D0	EHDM0	High-speed DMA Ch.0		0	R/W		
DMA interrupt factor flag register	0040281 (B)	D7–5	–	reserved	–	–	–	0 when being read.	
		D4	FIDMA	IDMA	1 Factor is generated 0 No factor is generated	X	R/W		
		D3	FHDM3	High-speed DMA Ch.3		X	R/W		
		D2	FHDM2	High-speed DMA Ch.2		X	R/W		
		D1	FHDM1	High-speed DMA Ch.1		X	R/W		
		D0	FHDM0	High-speed DMA Ch.0		X	R/W		
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA request register	0040290 (B)	D7	R16TC0	16-bit timer 0 comparison A	1 IDMA request 0 Interrupt request	0	R/W		
		D6	R16TU0	16-bit timer 0 comparison B		0	R/W		
		D5	RHDM1	High-speed DMA Ch.1		0	R/W		
		D4	RHDM0	High-speed DMA Ch.0		0	R/W		
		D3	RP3	Port input 3		0	R/W		
		D2	RP2	Port input 2		0	R/W		
		D1	RP1	Port input 1		0	R/W		
		D0	RP0	Port input 0		0	R/W		
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA enable register	0040294 (B)	D7	DE16TC0	16-bit timer 0 comparison A	1 IDMA enabled 0 IDMA disabled	0	R/W		
		D6	DE16TU0	16-bit timer 0 comparison B		0	R/W		
		D5	DEHDM1	High-speed DMA Ch.1		0	R/W		
		D4	DEHDM0	High-speed DMA Ch.0		0	R/W		
		D3	DEP3	Port input 3		0	R/W		
		D2	DEP2	Port input 2		0	R/W		
		D1	DEP1	Port input 1		0	R/W		
		D0	DEP0	Port input 0		0	R/W		

V DMA BLOCK: HSDMA (High-Speed DMA)

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
High-speed DMA Ch.0/1 trigger set-up register	0040298 (B)	D7	HSD1S3	High-speed DMA Ch.1 trigger set-up	0	Software trigger	0	R/W			
		D6	HSD1S2		1	K51 input (falling edge)	0				
		D5	HSD1S1		2	K51 input (rising edge)	0				
		D4	HSD1S0		3	Port 1 input	0				
					4	Port 5 input	0				
					5	8-bit timer Ch.1 underflow					
					6	16-bit timer Ch.1 compare B					
					7	16-bit timer Ch.1 compare A					
					8	16-bit timer Ch.5 compare B					
					9	16-bit timer Ch.5 compare A					
					A	SI/F Ch.1 Rx buffer full					
					B	SI/F Ch.1 Tx buffer empty					
					C	A/D conversion completion					
					D3	HSD0S3	High-speed DMA Ch.0 trigger set-up			0	Software trigger
		D2	HSD0S2	1	K50 input (falling edge)	0					
		D1	HSD0S1	2	K50 input (rising edge)	0					
		D0	HSD0S0	3	Port 0 input	0					
				4	Port 4 input	0					
				5	8-bit timer Ch.0 underflow						
				6	16-bit timer Ch.0 compare B						
				7	16-bit timer Ch.0 compare A						
				8	16-bit timer Ch.4 compare B						
				9	16-bit timer Ch.4 compare A						
				A	SI/F Ch.0 Rx buffer full						
				B	SI/F Ch.0 Tx buffer empty						
				C	A/D conversion completion						
High-speed DMA Ch.2/3 trigger set-up register	0040299 (B)	D7	HSD3S3	High-speed DMA Ch.3 trigger set-up	0	Software trigger	0	R/W			
		D6	HSD3S2		1	K54 input (falling edge)	0				
		D5	HSD3S1		2	K54 input (rising edge)	0				
		D4	HSD3S0		3	Port 3 input	0				
					4	Port 7 input	0				
					5	8-bit timer Ch.3 underflow					
					6	16-bit timer Ch.3 compare B					
					7	16-bit timer Ch.3 compare A					
					8	16-bit timer Ch.5 compare B					
					9	16-bit timer Ch.5 compare A					
					A	SI/F Ch.1 Rx buffer full					
					B	SI/F Ch.1 Tx buffer empty					
					C	A/D conversion completion					
					D3	HSD2S3	High-speed DMA Ch.2 trigger set-up			0	Software trigger
		D2	HSD2S2	1	K53 input (falling edge)	0					
		D1	HSD2S1	2	K53 input (rising edge)	0					
		D0	HSD2S0	3	Port 2 input	0					
				4	Port 6 input	0					
				5	8-bit timer Ch.2 underflow						
				6	16-bit timer Ch.2 compare B						
				7	16-bit timer Ch.2 compare A						
				8	16-bit timer Ch.4 compare B						
				9	16-bit timer Ch.4 compare A						
				A	SI/F Ch.0 Rx buffer full						
				B	SI/F Ch.0 Tx buffer empty						
				C	A/D conversion completion						
High-speed DMA software trigger register	004029A (B)	D7-4	-	reserved	-		-	-	0 when being read.		
		D3	HST3	HSDMA Ch.3 software trigger	1	Trigger	0	Invalid		0	W
		D2	HST2	HSDMA Ch.2 software trigger						0	W
		D1	HST1	HSDMA Ch.1 software trigger						0	W
		D0	HST0	HSDMA Ch.0 software trigger						0	W
K5 function select register	00402C0 (B)	D7-5	-	reserved	-		-	-	0 when being read.		
		D4	CFK54	K54 function selection	1	#DMAREQ3	0	K54		0	R/W
		D3	CFK53	K53 function selection	1	#DMAREQ2	0	K53		0	R/W
		D2	CFK52	K52 function selection	1	#ADTRG	0	K52		0	R/W
		D1	CFK51	K51 function selection	1	#DMAREQ1	0	K51		0	R/W
		D0	CFK50	K50 function selection	1	#DMAREQ0	0	K50		0	R/W

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks			
P1 function select register	00402D4 (B)	D7	–	reserved	–		–	–	0 when being read.			
		D6	CFP16	P16 function selection	1	EXCL5 #DMAEND1	0	P16		0	R/W	
		D5	CFP15	P15 function selection	1	EXCL4 #DMAEND0	0	P15		0	R/W	
		D4	CFP14	P14 function selection	1	FOSC1	0	P14		0	R/W	Extended functions (0x402DF)
		D3	CFP13	P13 function selection	1	EXCL3 T8UF3	0	P13		0	R/W	
		D2	CFP12	P12 function selection	1	EXCL2 T8UF2	0	P12		0	R/W	
		D1	CFP11	P11 function selection	1	EXCL1 T8UF1	0	P11		0	R/W	
		D0	CFP10	P10 function selection	1	EXCL0 T8UF0	0	P10		0	R/W	
P1 I/O control register	00402D6 (B)	D7	–	reserved	–		–	–	0 when being read.			
		D6	IOC16	P16 I/O control	1	Output	0	Input		0	R/W	
		D5	IOC15	P15 I/O control						0	R/W	
		D4	IOC14	P14 I/O control						0	R/W	
		D3	IOC13	P13 I/O control						0	R/W	
		D2	IOC12	P12 I/O control						0	R/W	
		D1	IOC11	P11 I/O control						0	R/W	
		D0	IOC10	P10 I/O control						0	R/W	
P3 function select register	00402DC (B)	D7–6	–	reserved					–		–	–
		D5	CFP35	P35 function selection	1	#BUSACK	0	P35	0	R/W		
		D4	CFP34	P34 function selection	1	#BUSREQ #CE6	0	P34	0	R/W		
		D3	CFP33	P33 function selection	1	#DMAACK1	0	P33	0	R/W		
		D2	CFP32	P32 function selection	1	#DMAACK0	0	P32	0	R/W		
		D1	CFP31	P31 function selection	1	#BUSGET	0	P31	0	R/W	Ext. func.(0x402DF)	
		D0	CFP30	P30 function selection	1	#WAIT #CE4/#CE5	0	P30	0	R/W		
		Port function extension register	00402DF (B)	D7	CFEX7	P07 port extended function	1	#DMAEND3	0	P07, etc.	0	R/W
D6	CFEX6			P06 port extended function	1	#DMAACK3	0	P06, etc.	0	R/W		
D5	CFEX5			P05 port extended function	1	#DMAEND2	0	P05, etc.	0	R/W		
D4	CFEX4			P04 port extended function	1	#DMAACK2	0	P04, etc.	0	R/W		
D3	CFEX3			P31 port extended function	1	#GARD	0	P31, etc.	0	R/W		
D2	CFEX2			P21 port extended function	1	#GAAS	0	P21, etc.	0	R/W		
D1	CFEX1			P10, P11, P13 port extended function	1	DST0 DST1 DPC0	0	P10, etc. P11, etc. P13, etc.	1	R/W		
D0	CFEX0			P12, P14 port extended function	1	DST2 DCLK	0	P12, etc. P14, etc.	1	R/W		
High-speed DMA Ch.0 transfer counter register	0048220 (HW)	DF	TC0_L7	Ch.0 transfer counter[7:0] (block transfer mode)								
		DE	TC0_L6									
		DD	TC0_L5									
		DC	TC0_L4									
		DB	TC0_L3								Ch.0 transfer counter[15:8] (single/successive transfer mode)	
		DA	TC0_L2									
		D9	TC0_L1									
		D8	TC0_L0									
		D7	BLKLEN07	Ch.0 block length (block transfer mode)								
		D6	BLKLEN06									
		D5	BLKLEN05									
		D4	BLKLEN04									Ch.0 transfer counter[7:0] (single/successive transfer mode)
		D3	BLKLEN03									
		D2	BLKLEN02									
		D1	BLKLEN01									
		D0	BLKLEN00									

V DMA BLOCK: HSDMA (High-Speed DMA)

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
High-speed DMA Ch.0 control register	0048222 (HW)	DF	DUALM0	Ch.0 address mode selection	1 Dual addr 0 Single addr	0	R/W		
		DE	D0DIR	D) Invalid S) Ch.0 transfer direction control	–	–	–		
		DD-8	–	reserved	–	–	–	Undefined in read.	
		D7	TC0_H7	Ch.0 transfer counter[15:8]		X	R/W		
		D6	TC0_H6	(block transfer mode)		X			
		D5	TC0_H5			X			
		D4	TC0_H4	Ch.0 transfer counter[23:16]		X			
		D3	TC0_H3	(single/successive transfer mode)		X			
		D2	TC0_H2			X			
		D1	TC0_H1			X			
D0	TC0_H0			X					
High-speed DMA Ch.0 low-order source address set-up register	0048224 (HW)	DF	S0ADRL15	D) Ch.0 source address[15:0]		X	R/W		
		DE	S0ADRL14	S) Ch.0 memory address[15:0]		X			
		DD	S0ADRL13			X			
		DC	S0ADRL12			X			
		DB	S0ADRL11			X			
		DA	S0ADRL10			X			
		D9	S0ADRL9			X			
		A8	S0ADRL8			X			
		D7	S0ADRL7			X			
		D6	S0ADRL6			X			
		D5	S0ADRL5			X			
		D4	S0ADRL4			X			
		D3	S0ADRL3			X			
D2	S0ADRL2			X					
D1	S0ADRL1			X					
D0	S0ADRL0			X					
High-speed DMA Ch.0 high-order source address set-up register	0048226 (HW)	DF	DINTEN0	Ch.0 interrupt enable	1 Enabled 0 Disabled	0	R/W		
		DE	DATSIZE0	Ch.0 transfer data size	1 Half word 0 Byte	0	R/W		
		DD	S0IN1	D) Ch.0 source address control	S0IN[1:0]	Inc/dec	0	R/W	
		DC	S0IN0	S) Ch.0 memory address control	1 1 1 0 0 1 0 0	Inc.(no init) Inc.(init) Dec.(no init) Fixed	0		
		DB	S0ADRH11	D) Ch.0 source address[27:16]		X	R/W		
		DA	S0ADRH10	S) Ch.0 memory address[27:16]		X			
		D9	S0ADRH9			X			
		A8	S0ADRH8			X			
		D7	S0ADRH7			X			
		D6	S0ADRH6			X			
		D5	S0ADRH5			X			
		D4	S0ADRH4			X			
		D3	S0ADRH3			X			
D2	S0ADRH2			X					
D1	S0ADRH1			X					
D0	S0ADRH0			X					
High-speed DMA Ch.0 low-order destination address set-up register	0048228 (HW)	DF	D0ADRL15	D) Ch.0 destination address[15:0]		X	R/W		
		DE	D0ADRL14	S) Invalid		X			
		DD	D0ADRL13			X			
		DC	D0ADRL12			X			
		DB	D0ADRL11			X			
		DA	D0ADRL10			X			
		D9	D0ADRL9			X			
		A8	D0ADRL8			X			
		D7	D0ADRL7			X			
		D6	D0ADRL6			X			
		D5	D0ADRL5			X			
		D4	D0ADRL4			X			
		D3	D0ADRL3			X			
D2	D0ADRL2			X					
D1	D0ADRL1			X					
D0	D0ADRL0			X					

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
High-speed DMA Ch.0 high-order destination address set-up register Note: D) Dual address mode S) Single address mode	004822A (HW)	DF	D0MOD1	Ch.0 transfer mode	D0MOD[1:0]	Mode	0	R/W			
		DE	D0MOD0				1			1	Invalid
							1			0	Block
							0			1	Successive
							0			0	Single
				DD	D0IN1	D) Ch.0 destination address control S) Invalid	D0IN[1:0]	Inc/dec	0	R/W	
		DC	D0INO	1	1				Inc.(no init)		
				1	0				Inc.(init)		
				0	1				Dec.(no init)		
				0	0				Fixed		
				DB	D0ADRH11	D) Ch.0 destination address[27:16] S) Invalid			X	R/W	
				DA	D0ADRH10				X		
		D9	D0ADRH9	X							
		A8	D0ADRH8	X							
		D7	D0ADRH7	X							
		D6	D0ADRH6	X							
		D5	D0ADRH5	X							
		D4	D0ADRH4	X							
		D3	D0ADRH3	X							
		D2	D0ADRH2	X							
		D1	D0ADRH1	X							
		D0	D0ADRH0	X							
High-speed DMA Ch.0 enable register	004822C (HW)	DF-1	-	reserved	-	-	-	Undefined in read.			
		D0	HS0_EN	Ch.0 enable	1 Enable	0 Disable	0	R/W			
High-speed DMA Ch.0 trigger flag register	004822E (HW)	DF-1	-	reserved	-	-	-	Undefined in read.			
		D0	HS0_TF	Ch.0 trigger flag clear (writing) Ch.0 trigger flag status (reading)	1 Clear 1 Set	0 No operation 0 Cleared	0	R/W			
High-speed DMA Ch.1 transfer counter register	0048230 (HW)	DF	TC1_L7	Ch.1 transfer counter[7:0] (block transfer mode)			X	R/W			
		DE	TC1_L6				X				
		DD	TC1_L5				X				
		DC	TC1_L4				Ch.1 transfer counter[15:8] (single/successive transfer mode)			X	
		DB	TC1_L3							X	
		DA	TC1_L2							X	
		D9	TC1_L1							X	
		D8	TC1_L0				X				
		D7	BLKLEN17	Ch.1 block length (block transfer mode)			X	R/W			
		D6	BLKLEN16				X				
		D5	BLKLEN15	Ch.1 transfer counter[7:0] (single/successive transfer mode)			X				
		D4	BLKLEN14				X				
		D3	BLKLEN13				X				
		D2	BLKLEN12				X				
		D1	BLKLEN11				X				
		D0	BLKLEN10	X							
		High-speed DMA Ch.1 control register Note: D) Dual address mode S) Single address mode	0048232 (HW)	DF	DUALM1	Ch.1 address mode selection	1 Dual addr	0 Single addr	0	R/W	
DE	D1DIR			D) Invalid S) Ch.1 transfer direction control	1 Memory WR	0 Memory RD	0	R/W			
DD-8	-			reserved	-	-	-	-	Undefined in read.		
D7	TC1_H7			Ch.1 transfer counter[15:8] (block transfer mode)			X	R/W			
D6	TC1_H6						X				
D5	TC1_H5			Ch.1 transfer counter[23:16] (single/successive transfer mode)			X				
D4	TC1_H4						X				
D3	TC1_H3						X				
D2	TC1_H2						X				
D1	TC1_H1			X							
D0	TC1_H0	X									

V DMA BLOCK: HSDMA (High-Speed DMA)

High-speed DMA Ch.1 low-order source address set-up register Note: D) Dual address mode S) Single address mode	0048234 (HW)	DF	S1ADRL15	D) Ch.1 source address[15:0]				X	R/W		
		DE	S1ADRL14	S) Ch.1 memory address[15:0]				X			
		DD	S1ADRL13					X			
		DC	S1ADRL12					X			
		DB	S1ADRL11					X			
		DA	S1ADRL10					X			
		D9	S1ADRL9					X			
		A8	S1ADRL8					X			
		D7	S1ADRL7					X			
		D6	S1ADRL6					X			
		D5	S1ADRL5					X			
		D4	S1ADRL4					X			
		D3	S1ADRL3					X			
		D2	S1ADRL2					X			
D1	S1ADRL1					X					
D0	S1ADRL0					X					
High-speed DMA Ch.1 high-order source address set-up register Note: D) Dual address mode S) Single address mode	0048236 (HW)	DF	DINTEN1	Ch.1 interrupt enable	1	Enabled	0	Disabled	0	R/W	
		DE	DATSIZE1	Ch.1 transfer data size	1	Half word	0	Byte	0	R/W	
		DD	S1IN1	D) Ch.1 source address control	S1IN[1:0]		Inc/dec		0	R/W	
		DC	S1IN0	S) Ch.1 memory address control	1	1	Inc.(no init)		0		
					1	0	Inc.(init)				
					0	1	Dec.(no init)				
					0	0	Fixed				
		DB	S1ADRH11	D) Ch.1 source address[27:16]					X	R/W	
		DA	S1ADRH10	S) Ch.1 memory address[27:16]					X		
		D9	S1ADRH9						X		
		A8	S1ADRH8						X		
		D7	S1ADRH7						X		
		D6	S1ADRH6						X		
		D5	S1ADRH5						X		
D4	S1ADRH4						X				
D3	S1ADRH3						X				
D2	S1ADRH2						X				
D1	S1ADRH1						X				
D0	S1ADRH0						X				
High-speed DMA Ch.1 low-order destination address set-up register Note: D) Dual address mode S) Single address mode	0048238 (HW)	DF	D1ADRL15	D) Ch.1 destination address[15:0]					X	R/W	
		DE	D1ADRL14	S) Invalid					X		
		DD	D1ADRL13						X		
		DC	D1ADRL12						X		
		DB	D1ADRL11						X		
		DA	D1ADRL10						X		
		D9	D1ADRL9						X		
		A8	D1ADRL8						X		
		D7	D1ADRL7						X		
		D6	D1ADRL6						X		
		D5	D1ADRL5						X		
		D4	D1ADRL4						X		
		D3	D1ADRL3						X		
		D2	D1ADRL2						X		
D1	D1ADRL1						X				
D0	D1ADRL0						X				
High-speed DMA Ch.1 high-order destination address set-up register Note: D) Dual address mode S) Single address mode	004823A (HW)	DF	D1MOD1	Ch.1 transfer mode	D1MOD[1:0]		Mode		0	R/W	
		DE	D1MOD0		1	1	Invalid		0		
					1	0	Block				
					0	1	Successive				
					0	0	Single				
		DD	D1IN1	D) Ch.1 destination address control	D1IN[1:0]		Inc/dec		0	R/W	
		DC	D1IN0	S) Invalid	1	1	Inc.(no init)		0		
					1	0	Inc.(init)				
					0	1	Dec.(no init)				
					0	0	Fixed				
		DB	D1ADRH11	D) Ch.1 destination address[27:16]					X	R/W	
		DA	D1ADRH10	S) Invalid					X		
		D9	D1ADRH9						X		
		A8	D1ADRH8						X		
D7	D1ADRH7						X				
D6	D1ADRH6						X				
D5	D1ADRH5						X				
D4	D1ADRH4						X				
D3	D1ADRH3						X				
D2	D1ADRH2						X				
D1	D1ADRH1						X				
D0	D1ADRH0						X				

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
High-speed DMA Ch.1 enable register	004823C (HW)	DF-1	–	reserved		–	–	Undefined in read.
		D0	HS1_EN	Ch.1 enable	1 Enable 0 Disable	0	R/W	
High-speed DMA Ch.1 trigger flag register	004823E (HW)	DF-1	–	reserved		–	–	Undefined in read.
		D0	HS1_TF	Ch.1 trigger flag clear (writing) Ch.1 trigger flag status (reading)	1 Clear 0 No operation 1 Set 0 Cleared	0	R/W	
High-speed DMA Ch.2 transfer counter register	0048240 (HW)	DF	TC2_L7	Ch.2 transfer counter[7:0] (block transfer mode)			X	R/W
		DE	TC2_L6			X		
		DD	TC2_L5			X		
		DC	TC2_L4		Ch.2 transfer counter[15:8] (single/successive transfer mode)		X	
		DB	TC2_L3			X		
		DA	TC2_L2			X		
		D9	TC2_L1			X		
		D8	TC2_L0		X			
		D7	BLKLEN27	Ch.2 block length (block transfer mode)		X	R/W	
		D6	BLKLEN26			X		
		D5	BLKLEN25		X			
		D4	BLKLEN24	Ch.2 transfer counter[7:0] (single/successive transfer mode)		X		
		D3	BLKLEN23			X		
		D2	BLKLEN22			X		
D1	BLKLEN21		X					
D0	BLKLEN20		X					
High-speed DMA Ch.2 control register	0048242 (HW)	DF	DUALM2	Ch.2 address mode selection	1 Dual addr 0 Single addr	0	R/W	
		DE	D2DIR	D) Invalid S) Ch.2 transfer direction control	– 1 Memory WR 0 Memory RD	– 0	– R/W	
		DD-8	–	reserved	–	–	–	Undefined in read.
		D7	TC2_H7	Ch.2 transfer counter[15:8] (block transfer mode)		X	R/W	
		D6	TC2_H6			X		
		D5	TC2_H5		X			
		D4	TC2_H4	Ch.2 transfer counter[23:16] (single/successive transfer mode)		X		
		D3	TC2_H3			X		
		D2	TC2_H2			X		
		D1	TC2_H1			X		
D0	TC2_H0		X					
High-speed DMA Ch.2 low-order source address set-up register	0048244 (HW)	DF	S2ADRL15	D) Ch.2 source address[15:0]			X	R/W
		DE	S2ADRL14	S) Ch.2 memory address[15:0]			X	
		DD	S2ADRL13			X		
		DC	S2ADRL12			X		
		DB	S2ADRL11			X		
		DA	S2ADRL10			X		
		D9	S2ADRL9			X		
		A8	S2ADRL8			X		
		D7	S2ADRL7			X		
		D6	S2ADRL6			X		
		D5	S2ADRL5			X		
		D4	S2ADRL4			X		
		D3	S2ADRL3			X		
		D2	S2ADRL2			X		
D1	S2ADRL1			X				
D0	S2ADRL0			X				
High-speed DMA Ch.2 high-order source address set-up register	0048246 (HW)	DF	DINTEN2	Ch.2 interrupt enable	1 Enabled 0 Disabled	0	R/W	
		DE	DATSIZE2	Ch.2 transfer data size	1 Half word 0 Byte	0	R/W	
		DD	S2IN1	D) Ch.2 source address control	S2IN[1:0] 1 1 Inc.(no init) 1 0 Inc.(init) 0 1 Dec.(no init) 0 0 Fixed	0	0	R/W
		DC	S2IN0	S) Ch.2 memory address control				
		DB	S2ADRH11	D) Ch.2 source address[27:16]				
		DA	S2ADRH10	S) Ch.2 memory address[27:16]				
		D9	S2ADRH9			X	R/W	
		A8	S2ADRH8			X		
		D7	S2ADRH7			X		
		D6	S2ADRH6			X		
D5	S2ADRH5			X				
D4	S2ADRH4			X				
D3	S2ADRH3			X				
D2	S2ADRH2			X				
D1	S2ADRH1			X				
D0	S2ADRH0			X				

V DMA BLOCK: HSDMA (High-Speed DMA)

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks					
High-speed DMA Ch.2 low-order destination address set-up register Note: D) Dual address mode S) Single address mode	0048248 (HW)	DF	D2ADRL15	D) Ch.2 destination address[15:0]			X	R/W					
		DE	D2ADRL14	S) Invalid			X						
		DD	D2ADRL13				X						
		DC	D2ADRL12				X						
		DB	D2ADRL11				X						
		DA	D2ADRL10				X						
		D9	D2ADRL9				X						
		A8	D2ADRL8				X						
		D7	D2ADRL7				X						
		D6	D2ADRL6				X						
		D5	D2ADRL5				X						
		D4	D2ADRL4				X						
		D3	D2ADRL3				X						
		D2	D2ADRL2				X						
D1	D2ADRL1		X										
D0	D2ADRL0		X										
High-speed DMA Ch.2 high-order destination address set-up register Note: D) Dual address mode S) Single address mode	004824A (HW)	DF	D2MOD1	Ch.2 transfer mode	D2MOD[1:0]	Mode	0	R/W					
		DE	D2MOD0							1 1 Invalid	0		
					1 0 Block								
					0 1 Successive								
					0 0 Single								
		DD	D2IN1	D) Ch.2 destination address control	D2IN[1:0]	Inc/dec	0			R/W			
		DC	D2IN0								1 1 Inc.(no init)	0	
					1 0 Inc.(init)								
					0 1 Dec.(no init)								
					0 0 Fixed								
		DB	D2ADRH11	D) Ch.2 destination address[27:16]							R/W		
		DA	D2ADRH10									S) Invalid	X
D9	D2ADRH9		X										
A8	D2ADRH8		X										
D7	D2ADRH7		X										
D6	D2ADRH6		X										
D5	D2ADRH5		X										
D4	D2ADRH4		X										
D3	D2ADRH3		X										
D2	D2ADRH2		X										
D1	D2ADRH1		X										
D0	D2ADRH0		X										
High-speed DMA Ch.2 enable register	004824C (HW)	DF-1	–	reserved	–		–	–	Undefined in read.				
		D0	HS2_EN	Ch.2 enable	1 Enable	0 Disable	0	R/W					
High-speed DMA Ch.2 trigger flag register	004824E (HW)	DF-1	–	reserved	–		–	–	Undefined in read.				
		D0	HS2_TF	Ch.2 trigger flag clear (writing) Ch.2 trigger flag status (reading)	1 Clear 1 Set	0 No operation 0 Cleared	0	R/W					
High-speed DMA Ch.3 transfer counter register	0048250 (HW)	DF	TC3_L7	Ch.3 transfer counter[7:0] (block transfer mode)			X	R/W					
		DE	TC3_L6				X						
		DD	TC3_L5	X									
		DC	TC3_L4	Ch.3 transfer counter[15:8] (single/successive transfer mode)			X						
		DB	TC3_L3				X						
		DA	TC3_L2	X									
		D9	TC3_L1	X									
		D8	TC3_L0	X									
		D7	BLKLEN37	Ch.3 block length (block transfer mode)								R/W	
		D6	BLKLEN36										X
		D5	BLKLEN35	X									
		D4	BLKLEN34	Ch.3 transfer counter[7:0] (single/successive transfer mode)									X
		D3	BLKLEN33										X
		D2	BLKLEN32	X									
		D1	BLKLEN31	X									
		D0	BLKLEN30	X									

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks		
High-speed DMA Ch.3 control register Note: D) Dual address mode S) Single address mode	0048252 (HW)	DF	DUALM3	Ch.3 address mode selection	1	Dual addr	0	Single addr	0	R/W	
		DE	D3DIR	D) Invalid S) Ch.3 transfer direction control	1	Memory WR	0	Memory RD	0	R/W	
		DD-8	-	reserved	-	-	-	-	-	-	Undefined in read.
		D7	TC3_H7	Ch.3 transfer counter[15:8] (block transfer mode)					X	R/W	
		D6	TC3_H6						X		
		D5	TC3_H5						X		
		D4	TC3_H4	Ch.3 transfer counter[23:16] (single/successive transfer mode)					X		
		D3	TC3_H3						X		
		D2	TC3_H2						X		
		D1	TC3_H1						X		
D0	TC3_H0						X				
High-speed DMA Ch.3 low-order source address set-up register Note: D) Dual address mode S) Single address mode	0048254 (HW)	DF	S3ADRL15	D) Ch.3 source address[15:0]					X	R/W	
		DE	S3ADRL14	S) Ch.3 memory address[15:0]					X		
		DD	S3ADRL13						X		
		DC	S3ADRL12						X		
		DB	S3ADRL11						X		
		DA	S3ADRL10						X		
		D9	S3ADRL9						X		
		A8	S3ADRL8						X		
		D7	S3ADRL7						X		
		D6	S3ADRL6						X		
		D5	S3ADRL5						X		
		D4	S3ADRL4						X		
		D3	S3ADRL3						X		
D2	S3ADRL2						X				
D1	S3ADRL1						X				
D0	S3ADRL0						X				
High-speed DMA Ch.3 high-order source address set-up register Note: D) Dual address mode S) Single address mode	0048256 (HW)	DF	DINTEN3	Ch.3 interrupt enable	1	Enabled	0	Disabled	0	R/W	
		DE	DATSIZE3	Ch.3 transfer data size	1	Half word	0	Byte	0	R/W	
		DD	S3IN1	D) Ch.3 source address control	S3IN[1:0]		Inc/dec		0	R/W	
		DC	S3IN0	S) Ch.3 memory address control	1	1	Inc.(no init)		0		
					1	0	Inc.(init)				
					0	1	Dec.(no init)				
					0	0	Fixed				
		DB	S3ADRH11	D) Ch.3 source address[27:16]					X	R/W	
		DA	S3ADRH10	S) Ch.3 memory address[27:16]					X		
		D9	S3ADRH9						X		
		A8	S3ADRH8						X		
		D7	S3ADRH7						X		
		D6	S3ADRH6						X		
D5	S3ADRH5						X				
D4	S3ADRH4						X				
D3	S3ADRH3						X				
D2	S3ADRH2						X				
D1	S3ADRH1						X				
D0	S3ADRH0						X				
High-speed DMA Ch.3 low-order destination address set-up register Note: D) Dual address mode S) Single address mode	0048258 (HW)	DF	D3ADRL15	D) Ch.3 destination address[15:0]					X	R/W	
		DE	D3ADRL14	S) Invalid					X		
		DD	D3ADRL13						X		
		DC	D3ADRL12						X		
		DB	D3ADRL11						X		
		DA	D3ADRL10						X		
		D9	D3ADRL9						X		
		A8	D3ADRL8						X		
		D7	D3ADRL7						X		
		D6	D3ADRL6						X		
		D5	D3ADRL5						X		
		D4	D3ADRL4						X		
		D3	D3ADRL3						X		
D2	D3ADRL2						X				
D1	D3ADRL1						X				
D0	D3ADRL0						X				

V DMA BLOCK: HSDMA (High-Speed DMA)

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
High-speed DMA Ch.3 high-order destination address set-up register Note: D) Dual address mode S) Single address mode	004825A (HW)	DF DE	D3MOD1 D3MOD0	Ch.3 transfer mode	D3MOD[1:0] Mode		0	R/W			
					1	1				Invalid	
					1	0				Block	
					0	1				Successive	
							0	0	Single		
		DD DC	D3IN1 D3IN0	D) Ch.3 destination address control S) Invalid	D3IN[1:0]		Inc/dec	0	R/W		
					1	1					Inc.(no init)
					1	0					Inc.(init)
					0	1					Dec.(no init)
					0	0					Fixed
		DB DA D9 A8 D7 D6 D5 D4 D3 D2 D1 D0	D3ADRH11 D3ADRH10 D3ADRH9 D3ADRH8 D3ADRH7 D3ADRH6 D3ADRH5 D3ADRH4 D3ADRH3 D3ADRH2 D3ADRH1 D3ADRH0	D) Ch.3 destination address[27:16] S) Invalid				X	R/W		
								X			
								X			
						X					
						X					
						X					
						X					
						X					
						X					
						X					
						X					
High-speed DMA Ch.3 enable register	004825C (HW)	DF-1	–	reserved	–		–	–	Undefined in read.		
		D0	HS3_EN	Ch.3 enable	1	Enable	0	Disable	0	R/W	
High-speed DMA Ch.3 trigger flag register	004825E (HW)	DF-1	–	reserved	–		–	–	Undefined in read.		
		D0	HS3_TF	Ch.3 trigger flag clear (writing)	1	Clear	0	No operation	0	R/W	
Ch.3 trigger flag status (reading)	1			Set	0	Cleared					

CFK51–CFK50: K5[1:0] pin function selection (D[1:0]) / K5 function select register (0x402C0)

CFK54–CFK53: K5[4:3] pin function selection (D[4:3]) / K5 function select register (0x402C0)

Set the #DMAREQx pin of HSDMA.

Write "1": #DMAREQx input

Write "0": Input port

Read: Valid

CFK50, CFK51, CFK53 and CFK54 are the function select bits for K50 (#DMAREQ0), K51 (#DMAREQ1), K53 (#DMAREQ2) and K54 (#DMAREQ3), respectively. When using the #DMAREQx signal, write "1" to CFK5x to set the K5x port for inputting the signal.

If this bit is set to "0", the pin is set for an input port.

At cold start, CFK5x is set to "0" (input port). At hot start, CFK5x retains the previous status before an initial reset.

CFP16–CFP15: P1[6:5] pin function selection (D[6:5]) / P1 function select register (0x402D4)

Set the #DMAENDx pin of HSDMA.

Write "1": #DMAENDx output

Write "0": I/O port

Read: Valid

When using the #DMAEND0 signal, set the P15 pin for the #DMAEND0 output pin by writing "1" to CFP15.

Similarly, when using the #DMAEND1 signal, set the P16 pin for the #DMAEND1 output pin by writing "1" to CFP16. Furthermore, direct these pins for output by writing "1" to the corresponding I/O control register.

If CFP1x is set to "0", the pin is set for an I/O port.

At cold start, CFP1x is set to "0" (I/O port). At hot start, CFP1x retains the previous status before an initial reset.

IOC16–IOC15: P1[6:5] port I/O control (D[6:5]) / P1 I/O control register (0x402D6)

Direct the I/O port for input or output.

Write "1": Output mode
Write "0": Input mode
Read: Valid

To use the #DMAEND0 pin (channel 0), direct the pin for output by writing "1" to IOC15; to use the #DMAEND1 pin (channel 1), direct the pin for output by writing "1" to IOC16. If these pins are set for input, the P15 and P16 pins do not function as the #DMAENDx output pins even when CFP15 and CFP16 are set to "1". At cold start, IOC1x is set to "0" (input mode). At hot start, IOC1x retains the previous state before an initial reset.

CFP33–CFP32: P3[3:2] pin function selection (D[3:2]) / P3 function select register (0x402DC)

Set the #DMAACKx pin of HSDMA.

Write "1": #DMAACKx output
Write "0": I/O port
Read: Valid

When using the #DMAACK0 signal, set the P32 pin for the #DMAACK0 output pin by writing "1" to CFP32. Similarly, when using the #DMAACK1 signal, set the P33 pin for the #DMAACK1 output pin by writing "1" to CFP33.

If CFP3x is set to "0", the pin is set for an I/O port.

At cold start, CFP3x is set to "0" (I/O port). At hot start, CFP3x retains the previous status before an initial reset.

CFEX7–CFEX4: P0[7:4] function extension (D[7:4]) / Port function extension register (0x402DF)

Set the #DMAACKx and #DMAENDx pins of HSDMA.

Write "1": HSDMA output pin
Write "0": I/O-port/serial interface I/O pin
Read: Valid

CFEX4, CFEX5, CFEX6 and CFEX7 are the function extension bits for P04 (#DMAACK2), P05 (#DMAEND2), P06 (#DMAACK3) and P07 (#DMAEND3), respectively. When using the HSDMA signal, write "1" to CFEXx to set the P0x port for outputting the signal.

When CFEXx is set to "0", the corresponding CFP bit becomes effective.

At cold start, these bits are set to "0" (I/O-port/serial interface I/O pin). At hot start, these bits retain the previous status before an initial reset.

HSD0S3–HSD0S0: Ch. 0 trigger set-up (D[3:0]) / HSDMA Ch. 0/1 trigger set-up register (0x40298)
HSD1S3–HSD1S0: Ch. 1 trigger set-up (D[7:4]) / HSDMA Ch. 0/1 trigger set-up register (0x40298)
HSD2S3–HSD2S0: Ch. 2 trigger set-up (D[3:0]) / HSDMA Ch. 2/3 trigger set-up register (0x40299)
HSD3S3–HSD3S0: Ch. 3 trigger set-up (D[7:4]) / HSDMA Ch. 2/3 trigger set-up register (0x40299)

Select a trigger factor for each HSDMA channel.

Table V-2.6 HSDMA Trigger Factor

Value	Ch.0 trigger factor	Ch.1 trigger factor	Ch.2 trigger factor	Ch.3 trigger factor
0000	Software trigger	Software trigger	Software trigger	Software trigger
0001	K50 port input (falling edge)	K51 port input (falling edge)	K53 port input (falling edge)	K54 port input (falling edge)
0010	K50 port input (rising edge)	K51 port input (rising edge)	K53 port input (rising edge)	K54 port input (rising edge)
0011	Port 0 input	Port 1 input	Port 2 input	Port 3 input
0100	Port 4 input	Port 5 input	Port 6 input	Port 7 input
0101	8-bit timer 0 underflow	8-bit timer 1 underflow	8-bit timer 2 underflow	8-bit timer 3 underflow
0110	16-bit timer 0 compare B	16-bit timer 1 compare B	16-bit timer 2 compare B	16-bit timer 3 compare B
0111	16-bit timer 0 compare A	16-bit timer 1 compare A	16-bit timer 2 compare A	16-bit timer 3 compare A
1000	16-bit timer 4 compare B	16-bit timer 5 compare B	16-bit timer 4 compare B	16-bit timer 5 compare B
1001	16-bit timer 4 compare A	16-bit timer 5 compare A	16-bit timer 4 compare A	16-bit timer 5 compare A
1010	Serial I/F Ch.0 Rx buffer full	Serial I/F Ch.1 Rx buffer full	Serial I/F Ch.0 Rx buffer full	Serial I/F Ch.1 Rx buffer full
1011	Serial I/F Ch.0 Tx buffer empty	Serial I/F Ch.1 Tx buffer empty	Serial I/F Ch.0 Tx buffer empty	Serial I/F Ch.1 Tx buffer empty
1100	A/D conversion completion	A/D conversion completion	A/D conversion completion	A/D conversion completion

At initial reset, HSDxS is set to "0000" (software trigger).

HST0: Ch. 0 software trigger (D0) / HSDMA software trigger register (0x4029A)
HST1: Ch. 1 software trigger (D1) / HSDMA software trigger register (0x4029A)
HST2: Ch. 2 software trigger (D2) / HSDMA software trigger register (0x4029A)
HST3: Ch. 3 software trigger (D3) / HSDMA software trigger register (0x4029A)

Start a DMA transfer.

Write "1": Trigger
 Write "0": Invalid
 Read: Invalid

Writing "1" to HSTx generates a trigger pulse that starts a DMA transfer.

HSTx is effective only when software trigger is selected as the trigger factor of the HSDMA channel by the HSDxS bits.

At initial reset, HSTx is set to "0".

HS0_TF: Ch. 0 trigger flag clear/status (D0) / HSDMA Ch. 0 trigger flag register (0x4022E)
HS1_TF: Ch. 1 trigger flag clear/status (D0) / HSDMA Ch. 1 trigger flag register (0x4023E)
HS2_TF: Ch. 2 trigger flag clear/status (D0) / HSDMA Ch. 2 trigger flag register (0x4024E)
HS3_TF: Ch. 3 trigger flag clear/status (D0) / HSDMA Ch. 3 trigger flag register (0x4025E)

These bits are used to check and clear the trigger flag status.

Write "1": Trigger flag clear
 Write "0": Invalid
 Read "1": Trigger flag has been set
 Read "0": Trigger flag has been cleared

The trigger flag is set when the trigger factor is input to the HSDMA channel and is cleared when the HSDMA channel starts a data transfer. By reading HSx_TF, the flag status can be checked. Writing "1" to HSx_TF clears the trigger flag if the DMA transfer has not been started.

At initial reset, HSx_TF is set to "0".

HS0_EN: Ch. 0 enable (D0) / HSDMA Ch. 0 enable register (0x4822C)

HS1_EN: Ch. 1 enable (D1) / HSDMA Ch. 1 enable register (0x4823C)

HS2_EN: Ch. 2 enable (D2) / HSDMA Ch. 2 enable register (0x4824C)

HS3_EN: Ch. 3 enable (D3) / HSDMA Ch. 3 enable register (0x4825C)

Enable a DMA transfer.

Write "1": Enabled

Write "0": Disabled

Read: Valid

DMA transfer is enabled by writing "1" to this bit.

HSDMA is placed in a state ready to accept a DMA request from the #DMAREQx pin or by the selected trigger factor.

DMA transfer is disabled by writing "0" to this bit.

When DMA transfers are completed (transfer counter = 0), HSx_EN is cleared by the hardware.

Be sure to disable DMA transfers (HSx_EN = "0") before setting the transfer condition.

At initial reset, HSx_EN is set to "0" (disabled).

DUALM0: Ch. 0 address mode selection (DF) / HSDMA Ch. 0 control register (0x48222)

DUALM1: Ch. 1 address mode selection (DF) / HSDMA Ch. 1 control register (0x48232)

DUALM2: Ch. 2 address mode selection (DF) / HSDMA Ch. 2 control register (0x48242)

DUALM3: Ch. 3 address mode selection (DF) / HSDMA Ch. 3 control register (0x48252)

Select an address mode.

Write "1": Dual-address mode

Write "0": Single-address mode

Read: Valid

When "1" is written to DUALMx, the HSDMA channel enters dual-address mode that allows specification of source and destination addresses. When "0" is written, the HSDMA channel enters single-address mode for high-speed data transfer between the external memory and an I/O device.

At initial reset, DUALMx is set to "0" (single-address mode).

D0DIR: Ch. 0 transfer direction control (DE) / HSDMA Ch.0 control register (0x48222)

D1DIR: Ch. 1 transfer direction control (DE) / HSDMA Ch.1 control register (0x48232)

D2DIR: Ch. 2 transfer direction control (DE) / HSDMA Ch.2 control register (0x48242)

D3DIR: Ch. 3 transfer direction control (DE) / HSDMA Ch.3 control register (0x48252)

Control the direction of data transfer in single-address mode.

Write "1": Memory write (I/O to memory)

Write "0": Memory read (memory to I/O)

Read: Valid

Data transfer from an external I/O device to external memory is performed by writing "1" to DxDIR. Data transfer from external memory to an external I/O is performed by writing "0".

At initial reset, DxDIR is set to "0" (memory to I/O).

This bit is effective only in single-address mode.

D0MOD1–D0MOD0: Ch. 0 transfer mode (D[F:E]) / Ch. 0 high-order destination address set-up register (0x4822A)

D1MOD1–D1MOD0: Ch. 1 transfer mode (D[F:E]) / Ch. 1 high-order destination address set-up register (0x4823A)

D2MOD1–D2MOD0: Ch. 2 transfer mode (D[F:E]) / Ch. 2 high-order destination address set-up register (0x4824A)

D3MOD1–D3MOD0: Ch. 3 transfer mode (D[F:E]) / Ch. 3 high-order destination address set-up register (0x4825A)

Select a transfer mode.

Table V-2.7 Transfer Mode

DxMOD1	DxMOD0	Mode
1	1	Invalid
1	0	Block transfer mode
0	1	Successive transfer mode
0	0	Single transfer mode

In single transfer mode, a transfer operation invoked by one trigger is completed after transferring one unit of data of the size set by DATSIZE_x.

In successive transfer mode, data transfer operations are performed by one trigger a number of times as set by the transfer counter.

In block transfer mode, a transfer operation invoked by one trigger is completed after transferring one block of data of the size set by BLKLEN_x.

At initial reset, DxMOD is set to "00" (single transfer mode).

DATSIZE0: Ch. 0 transfer data size (DE) / Ch. 0 high-order source address register (0x48226)

DATSIZE1: Ch. 1 transfer data size (DE) / Ch. 1 high-order source address register (0x48236)

DATSIZE2: Ch. 2 transfer data size (DE) / Ch. 2 high-order source address register (0x48246)

DATSIZE3: Ch. 3 transfer data size (DE) / Ch. 3 high-order source address register (0x48256)

Select the data size to be transferred.

Write "1": Half-word (16 bits)

Write "0": Byte (8 bits)

Read: Valid

The transfer data size is set to 16 bits by writing "1" to DATSIZE_x and set to 8 bits by writing "0".

At initial reset, DATSIZE_x is set to "0" (8 bits).

S0IN1–S0IN0: Ch. 0 source address control (D[D:C]) / Ch. 0 high-order source address set-up register (0x48226)

S1IN1–S1IN0: Ch. 1 source address control (D[D:C]) / Ch. 1 high-order source address set-up register (0x48236)

S2IN1–S2IN0: Ch. 2 source address control (D[D:C]) / Ch. 2 high-order source address set-up register (0x48246)

S3IN1–S3IN0: Ch. 3 source address control (D[D:C]) / Ch. 3 high-order source address set-up register (0x48256)

Control the incrementing or decrementing of the memory address.

Table V-2.8 Address Control

SxIN1	SxIN0	Address control
1	1	Increment without initialization
1	0	Increment with initialization
0	1	Decrement without initialization
0	0	Fixed

In dual-address mode, this setting applies to the source address. In single-address mode, this setting applies to the external memory address.

When "address fixed" (00) is selected, the source address is not changed by a data transfer performed. Even when transferring multiple data, the transfer data is always read from the same address.

When "address increment" (11 or 10) is selected in single and successive transfer modes, the source address is incremented by an amount equal to the data size set by DATSIZE_x when one data transfer is completed.

When "address decrement" (01) is selected, the source address is decremented in the same way.

In block transfer mode too, the source address is incremented or decremented when one data unit is transferred.

However, if SxIN is set to "10", the source address that has been incremented during a block transfer recycles back to the initial value when the block transfer is completed.

At initial reset, SxIN is set to "00" (Fixed).

D0IN1–D0INO: Ch. 0 destination address control (D[D:C]) / Ch. 0 high-order destination address set-up register (0x4822A)
D1IN1–D1INO: Ch. 1 destination address control (D[D:C]) / Ch. 1 high-order destination address set-up register (0x4823A)
D2IN1–D2INO: Ch. 2 destination address control (D[D:C]) / Ch. 2 high-order destination address set-up register (0x4824A)
D3IN1–D3INO: Ch. 3 destination address control (D[D:C]) / Ch. 3 high-order destination address set-up register (0x4825A)

Control the incrementing or decrementing of the memory address.

Table V-2.9 Address Control

DxIN1	DxINO	Address control
1	1	Increment without initialization
1	0	Increment with initialization
0	1	Decrement without initialization
0	0	Fixed

In dual-address mode, this setting applies to the destination address. In single-address mode, these bits are not used.

When "address fixed" (00) is selected, the destination address is not changed by a data transfer performed. Even when transferring multiple data, the transfer data is always written to the same address.

When "address increment" (11 or 10) is selected in single and successive transfer modes, the destination address is incremented by an amount equal to the data size set by DATSIZE_x when one data transfer is completed.

When "address decrement" (01) is selected, the destination address is decremented in the same way.

In block transfer mode too, the destination address is incremented or decremented when one data unit is transferred. However, if DxIN is set to "10", the destination address that has been incremented during a block transfer recycles back to the initial value when the block transfer is completed.

At initial reset, DxIN is set to "00" (Fixed).

BLKLEN07–BLKLEN00: Ch. 0 block length/transfer counter[7:0] (D[7:0]) / Ch. 0 transfer counter register (0x48220)

BLKLEN17–BLKLEN10: Ch. 1 block length/transfer counter[7:0] (D[7:0]) / Ch. 1 transfer counter register (0x48230)

BLKLEN27–BLKLEN20: Ch. 2 block length/transfer counter[7:0] (D[7:0]) / Ch. 2 transfer counter register (0x48240)

BLKLEN37–BLKLEN30: Ch. 3 block length/transfer counter[7:0] (D[7:0]) / Ch. 3 transfer counter register (0x48250)

In block transfer mode, these bits are used to specify a transfer block size. A transfer operation invoked by one trigger is completed after transferring one block of data of the size set by BLKLEN_x.

In single or successive transfer mode, these bits are used to specify the 8 low-order bits of the transfer counter.

At initial reset, these bits are not initialized.

TC0_L7–TC0_L0: Ch. 0 transfer counter[7:0]/[15:8] (D[F:8]) / Ch. 0 transfer counter register (0x48220)

TC0_H7–TC0_H0: Ch. 0 transfer counter[15:8]/[23:16] (D[F:8]) / Ch. 0 control register (0x48222)

TC1_L7–TC1_L0: Ch. 1 transfer counter[7:0]/[15:8] (D[F:8]) / Ch. 1 transfer counter register (0x48230)

TC1_H7–TC1_H0: Ch. 1 transfer counter[15:8]/[23:16] (D[F:8]) / Ch. 1 control register (0x48232)

TC2_L7–TC2_L0: Ch. 2 transfer counter[7:0]/[15:8] (D[F:8]) / Ch. 2 transfer counter register (0x48240)

TC2_H7–TC2_H0: Ch. 2 transfer counter[15:8]/[23:16] (D[F:8]) / Ch. 2 control register (0x48242)

TC3_L7–TC3_L0: Ch. 3 transfer counter[7:0]/[15:8] (D[F:8]) / Ch. 3 transfer counter register (0x48250)

TC3_H7–TC3_H0: Ch. 3 transfer counter[15:8]/[23:16] (D[F:8]) / Ch. 3 control register (0x48252)

Set the data transfer count.

In block transfer mode, TC_x_L[7:0] is bits[7:0] of the transfer counter, and TC_x_H[7:0] is bits[15:8] of the transfer counter.

In single or successive transfer mode, TC_x_L[7:0] is bits[15:8] of the transfer counter, and TC_x_H[7:0] is bits[23:16] of the transfer counter. The 8 low-order bits are specified by BLKLEN_x[7:0].

This counter is decremented each time a DMA transfer in the corresponding channel is performed. When the counter reaches 0, an interrupt factor is generated. In single-address mode, the end-of-transfer signal is output from the #DMAEND_x pin at the same time.

Even when the counter is 0, a DMA request is accepted and the counter is decremented to "0xFFFF" (or "0xFFFFF").

Be sure to disable DMA transfers (HS_x_EN = "0") before writing and reading to and from the counter.

At initial reset, these bits are not initialized.

S0ADRL15–S0ADRL0:	Ch. 0 source address[15:0] (D[F:0]) / Ch. 0 low-order source address set-up register (0x48224)
S0ADRH11–S0ADRH0:	Ch. 0 source address[27:16] (D[B:0]) / Ch. 0 high-order source address set-up register (0x48226)
S1ADRL15–S1ADRL0:	Ch. 1 source address[15:0] (D[F:0]) / Ch. 1 low-order source address set-up register (0x48234)
S1ADRH11–S1ADRH0:	Ch. 1 source address[27:16] (D[B:0]) / Ch. 1 high-order source address set-up register (0x48236)
S2ADRL15–S2ADRL0:	Ch. 2 source address[15:0] (D[F:0]) / Ch. 2 low-order source address set-up register (0x48244)
S2ADRH11–S2ADRH0:	Ch. 2 source address[27:16] (D[B:0]) / Ch. 2 high-order source address set-up register (0x48246)
S3ADRL15–S3ADRL0:	Ch. 3 source address[15:0] (D[F:0]) / Ch. 3 low-order source address set-up register (0x48254)
S3ADRH11–S3ADRH0:	Ch. 3 source address[27:16] (D[B:0]) / Ch. 3 high-order source address set-up register (0x48256)

In dual-address mode, these bits are used to specify a source address. In single-address mode, an external memory address at the destination or source of transfer is specified.

Use SxADRL to set the 16 low-order bits of the address and SxADRH to set the 12 high-order bits.

Be sure to disable DMA transfers (HSx_EN = "0") before writing or reading to and from these registers.

The address is incremented or decremented (as set by SxIN) according to the transfer data size each time a DMA transfer in the corresponding channel is performed.

At initial reset, these bits are not initialized.

D0ADRL15–D0ADRL0:	Ch. 0 destination address[15:0] (D[F:0]) / Ch. 0 low-order destination address set-up register (0x48228)
D0ADRH11–D0ADRH0:	Ch. 0 destination address[27:16] (D[B:0]) / Ch. 0 high-order destination address set-up register (0x4822A)
D1ADRL15–D1ADRL0:	Ch. 1 destination address[15:0] (D[F:0]) / Ch. 1 low-order destination address set-up register (0x48238)
D1ADRH11–D1ADRH0:	Ch. 1 destination address[27:16] (D[B:0]) / Ch. 1 high-order destination address set-up register (0x4823A)
D2ADRL15–D2ADRL0:	Ch. 2 destination address[15:0] (D[F:0]) / Ch. 2 low-order destination address set-up register (0x48248)
D2ADRH11–D2ADRH0:	Ch. 2 destination address[27:16] (D[B:0]) / Ch. 2 high-order destination address set-up register (0x4824A)
D3ADRL15–D3ADRL0:	Ch. 3 destination address[15:0] (D[F:0]) / Ch. 3 low-order destination address set-up register (0x48258)
D3ADRH11–D3ADRH0:	Ch. 3 destination address[27:16] (D[B:0]) / Ch. 3 high-order destination address set-up register (0x4825A)

In dual-address mode, these bits are used to specify a destination address. In single-address mode, these bits are not used.

Be sure to disable DMA transfers (HSx_EN = "0") before writing or reading to and from these registers.

The address is incremented or decremented (as set by DxIN) according to the transfer data size each time a DMA transfer in the corresponding channel is performed.

At initial reset, these bits are not initialized.

DINTEN0: Ch. 0 interrupt enable (DF) / Ch. 0 high-order source address register (0x48226)
DINTEN1: Ch. 1 interrupt enable (DF) / Ch. 1 high-order source address register (0x48236)
DINTEN2: Ch. 2 interrupt enable (DF) / Ch. 2 high-order source address register (0x48246)
DINTEN3: Ch. 3 interrupt enable (DF) / Ch. 3 high-order source address register (0x48256)

Enable to set the interrupt factor flag for each channel.

Write "1": Enabled
 Write "0": Disabled
 Read: Valid

If DINTENx = "1", the HSDMA interrupt factor flag is set to "1" when the transfer counter reaches 0. If DINTENx = "0", the HSDMA interrupt factor flag is not set and an interrupt does not occur. At initial reset, DINTENx is set to "0" (Disabled).

PHSD0L2–PHSD0L0: Ch. 0 interrupt level (D[2:0]) / HSDMA Ch. 0/1 interrupt priority register (0x40263)
PHSD1L2–PHSD1L0: Ch. 1 interrupt level (D[6:4]) / HSDMA Ch. 0/1 interrupt priority register (0x40263)
PHSD2L2–PHSD2L0: Ch. 2 interrupt level (D[2:0]) / HSDMA Ch. 2/3 interrupt priority register (0x40264)
PHSD3L2–PHSD3L0: Ch. 3 interrupt level (D[6:4]) / HSDMA Ch. 2/3 interrupt priority register (0x40264)

Set the priority level of an end-of-DMA interrupt in the range of 0 to 7. At initial reset, these registers become indeterminate.

EHDM0: Ch. 0 interrupt enable (D0) / DMA interrupt enable register (0x40271)
EHDM1: Ch. 1 interrupt enable (D1) / DMA interrupt enable register (0x40271)
EHDM2: Ch. 2 interrupt enable (D2) / DMA interrupt enable register (0x40271)
EHDM3: Ch. 3 interrupt enable (D3) / DMA interrupt enable register (0x40271)

Enable or disable interrupt generation to the CPU.

Write "1": Interrupt enabled
 Write "0": Interrupt disabled
 Read: Valid

EHDMx is the interrupt enable bit for HSDMA channel x. The interrupt is enabled when EHDMx is set to "1" and disabled when EHDMx is set to "0". At initial reset, EHDMx is set to "0" (interrupt disabled).

FHDM0: Ch. 0 interrupt factor flag (D0) / DMA interrupt factor flag register (0x40281)
FHDM1: Ch. 1 interrupt factor flag (D1) / DMA interrupt factor flag register (0x40281)
FHDM2: Ch. 2 interrupt factor flag (D2) / DMA interrupt factor flag register (0x40281)
FHDM3: Ch. 3 interrupt factor flag (D3) / DMA interrupt factor flag register (0x40281)

Indicate the occurrence status of HSDMA interrupt factor.

When read

Read "1": Interrupt factor generated
 Read "0": No interrupt factor generated

When written using the reset-only method (default)

Write "1": Factor flag is reset
 Write "0": Invalid

When written using the read/write method

Write "1": Factor flag is set
 Write "0": Factor flag is reset

FHDMx is the interrupt factor flag for HSDMA channel x. These flags are set to "1" when the transfer counter reaches 0. An interrupt to the CPU is generated if the following conditions are met at this time:

1. The corresponding interrupt enable register is set to "1".
2. No other interrupt request of higher priority is generated.
3. The IE bit of the PSR is set to "1" (interrupt enable).
4. The corresponding interrupt priority register is set to a level higher than the CPU's interrupt level (IL).

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When using an interrupt factor to request IDMA, note that even when the above conditions are met, no interrupt request to the CPU is generated for the interrupt factor that has occurred. If interrupts are enabled at the setting of the IDMA side, an interrupt is generated under the above conditions after the data transfer by IDMA is completed. The interrupt factor flag is always set to "1" when an interrupt factor occurs no matter how the interrupt enable and interrupt priority registers are set.

In order for the next interrupt to be accepted after interrupt generation, the interrupt factor flag must be reset and the PSR must be set up again (by setting the IL below the level indicated by the interrupt priority register and setting the IE bit to "1" or executing the reti instruction).

The interrupt factor flag can only be reset by a write instruction in the software application. If the PSR is again set up to accept interrupts (or the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt may occur again. Note also that the value to be written to reset the flag is "1" when using the reset-only method (RSTONLY = "1") and "0" when using the read/write method (RSTONLY = "0"). Be careful not to confuse these two cases.

The FHDMx flag becomes indeterminate when initially reset, so be sure to reset the flag in the software application.

RHDM0: Ch.0 IDMA request (D4) / Port input 0–3, HSDMA, 16-bit timer 0 IDMA request register (0x40290)

RHDM1: Ch.1 IDMA request (D5) / Port input 0–3, HSDMA, 16-bit timer 0 IDMA request register (0x40290)

Specify whether IDMA need to be invoked when an interrupt factor occurs.

When using the set-only method (default)

Write "1": IDMA request

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA request

Write "0": Interrupt request

Read: Valid

RHDM0 and RHDM1 are the IDMA request bits for HSDMA channels 0 and 1, respectively. If the bit is set to "1", IDMA is invoked when an interrupt factor occurs, thus performing a programmed data transfer. If the register is set to "0", regular interrupt processing is performed without ever invoking IDMA.

For details on IDMA, refer to "IDMA (Intelligent DMA)".

At initial reset, RHDMx is set to "0" (interrupt request).

DEHDM0: Ch.0 IDMA enable (D4) / Port input 0–3, HSDMA, 16-bit timer 0 IDMA enable register (0x40294)

DEHDM1: Ch.1 IDMA enable (D5) / Port input 0–3, HSDMA, 16-bit timer 0 IDMA enable register (0x40294)

Enables IDMA transfer by means of an interrupt factor.

When using the set-only method (default)

Write "1": IDMA enabled

Write "0": Not changed

Read: Valid

When using the read/write method

Write "1": IDMA enabled

Write "0": IDMA disabled

Read: Valid

DEHDM0 and DEHDM1 are the IDMA enable bits for HSDMA channels 0 and 1, respectively. If DEHDMx is set to "1", the IDMA request by the interrupt factor is enabled. If the bit is set to "0", the IDMA request is disabled.

At initial reset, DEHDMx is set to "0" (IDMA disabled).

Programming Notes

- (1) When setting the transfer conditions, always make sure the DMA controller is inactive ($HSx_EN = "0"$).
- (2) After an initial reset, the interrupt factor flag (FHDMA x) becomes indeterminate. Always be sure to reset the flag to prevent interrupts or IDMA requests from being generated inadvertently.
- (3) To prevent an interrupt from being generated repeatedly for the same factor, be sure to reset the interrupt factor flag before setting up the PSR again or executing the reti instruction.
- (4) HSDMA is given higher priority over IDMA (intelligent DMA) and the CPU. However, since HSDMA and IDMA share the same circuit, HSDMA cannot gain the bus ownership while an IDMA transfer is under way. Requests for HSDMA invocation that have occurred during an IDMA transfer are kept pending until the IDMA transfer is completed.
A request for IDMA invocation or an interrupt request that has occurred during a HSDMA transfer are accepted after completion of the HSDMA transfer.

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V-3 IDMA (Intelligent DMA)

Functional Outline of IDMA

The DMA Block contains an intelligent DMA (IDMA), a function that allows control information to be programmed in RAM. Up to 128 channels can be programmed, including 31 channels that are invoked by an interrupt factor that occurs in some internal peripheral circuit.

Although an additional overhead for loading and storing control information in RAM may be incurred, this intelligent DMA supports such functions as successive transfers, block transfers, and linking to another IDMA.

IDMA is invoked by an interrupt factor that occurs in some internal peripheral circuit or a software trigger, thereby performing a data transfer according to the control information in RAM. When the transfer is completed, IDMA can generate an interrupt or invoke another IDMA according to link settings.

Programming Control Information

The intelligent DMA operates according to the control information prepared in RAM. The control information can be stored in either internal RAM or external RAM should the necessary area be allocated.

The control information is 3 words (12 bytes) per channel in size, and must be located at contiguous addresses beginning with the base address that is set in the software application as the starting address of channel 0. Consequently, an area of 384 words (1,536 bytes) in RAM is required in order for all of 128 channels to be used.

The following explains how to set the base address and the contents of control information. Before using IDMA, make each the settings described below.

Setting the base address

Set the starting address of control information (starting address of channel 0) in the IDMA base address register.

16 low-order bits: DBASEL[15:0](D[15:0]) / IDMA base address low-order register (0x48200)

12 high-order bits: DBASEH[11:0](D[11:0]) / IDMA base address high-order register (0x48202)

When initially reset, the base address is set to 0x0C003A0.

- Notes:**
- The address you set in the IDMA base address register must always be a word (32-bit) boundary address.
 - Be sure to disable DMA transfers (IDMAEN = "0") before setting the base address. Writing to the IDMA base address register is ignored when the DMA transfer is enabled (IDMAEN = "1"). When the register is read, the read data is indeterminate.

Control information

Write the control information for the IDMA channels used to RAM.

The addresses at which the control information of each channel is placed are determined by the base address and a channel number.

Starting address of channel = base address + (channel number × 12 [bytes])

- Note:** The control information must be written only when the channel to be set does not start a DMA transfer. If a DMA transfer starts when the control information is being written to the RAM, proper transfer cannot be performed. Reading the control information can always be done.

The contents of control information (3 words) in each channel are shown in the table below.

Table V-3.1 IDMA Control Information

Word	Bit	Name	Function		
1st	D31	LNKEN	IDMA link enable "1" = Enabled, "0" = Disabled		
	D30–24	LNKCHN[6:0]	IDMA link field		
	D23–8	TC[15:0]	Transfer counter (block transfer mode) Transfer counter - high-order 16 bits (single or successive transfer mode)		
	D7–0	BLKLEN[7:0]	Block size (block transfer mode) Transfer counter - low-order 8 bits (single or successive transfer mode)		
2nd	D31	DINTEN	End-of-transfer interrupt enable "1" = Enabled, "0" = Disabled		
	D30	DATSIZ	Data size control "1" = Half-word, "0" = Byte		
	D29–28	SRINCC[1:0]	Source address control		
			SRINC1	SRINC0	Setting contents
1			1	Address incremented (In block transfer mode, the transfer address is updated without reset using the initial value.)	
1			0	Address incremented (In block transfer mode, the transfer address is updated with the initial value.)	
0	1	Address decremented (In block transfer mode, the transfer address is updated without reset using the initial value.)			
0	0	Address fixed			
D27–0	SRADDR[27:0]	Source address			
3rd	D31–30	DMOD[1:0]	Transfer mode (Do not set to "11".)		
			DMOD1	DMOD0	Setting contents
			1	0	Block transfer mode
			0	1	Successive transfer mode
0	0	Single transfer mode			
D29–28	DSINCC[1:0]	Destination address control			
		DSINC1	DSINC0	Setting contents	
		1	1	Address incremented (In block transfer mode, the transfer address is updated without reset using the initial value.)	
		1	0	Address incremented (In block transfer mode, the transfer address is updated with the initial value.)	
0	1	Address decremented (In block transfer mode, the transfer address is updated without reset using the initial value.)			
0	0	Address fixed			
D27–0	DSADDR[27:0]	Destination address			

LNKEN: IDMA link enable (D31/1st Word)

If this bit remains set (= "1"), the IDMA channel that is set in the IDMA link field is invoked after the completion of a DMA transfer in this channel. DMA transfers in multiple channels can be performed successively by merely triggering the first channel to be executed. There is no limit to the number of channels linked. Set this link in order of the IDMA channels you want to be executed.

If this bit is "0", IDMA is completed by merely executing a DMA transfer in this channel.

LNKCHN[6:0]: IDMA link field (D[30:24]/1st Word)

If you want IDMA to be linked, set the channel numbers (0 to 127) to be executed next.

The data in this field is valid only when LINKEN = "1".

TC[15:0]: Transfer counter (D[23:8]/1st Word)

In block transfer mode, a transfer count can be specified using up to 16 bits. Set this value here. In single transfer and successive transfer modes, a transfer count can be specified using up to 24 bits. Set a 16-bit high-order value here.

BLKLEN[7:0]: Block size/transfer counter (D[7:0]/1st Word)

In block transfer mode, set the size of a block that is transferred in one operation (in units of DATSIZ). In single transfer and successive transfer modes, set an 8-bit low-order value for the transfer count here.

Note: The transfer count and block size thus set are decremented according to the transfers performed. If the transfer count or block size is set to 0, it is decremented to all Fs by the first transfer performed. This means that you have set the maximum value that is determined by the number of bits available.

DINTEN: End-of-transfer interrupt enable (D31/2nd Word)

If this bit is left set (= "1"), when the transfer counter reaches 0, an interrupt request to the CPU is generated based on the interrupt factor flag by which IDMA has been invoked.

If this bit is "0", no interrupt request to the CPU is generated even when the transfer counter has reached 0.

DATSIZ: Data size control (D30/2nd Word)

Set the unit size of data to be transferred.

A half-word size (16 bits) is assumed if this bit is "1" and a byte size (8 bits) is assumed if this bit is "0".

SRINC[1:0]: Source address control (D[29:28]/2nd Word)

Set the source address updating format.

If the format is set for "address fixed" (00), the source address is not changed by a data transfer performed. Even when transferring multiple data, the transfer data is always read from the same address.

If the format is set for "address increment" (11 or 10) in single and successive transfer modes, the source address is incremented by an amount equal to the data size set by DATSIZ when one data transfer is completed. If the format is set for "address decrement" (01), the source address is decremented in the same way.

In block transfer mode too, the source address is incremented or decremented when one data unit is transferred. However, if the set format is "10", the source address that has been incremented during a block transfer recycles back to the initial value when the block transfer is completed.

SRADR[27:0]: Source address (D[27:0]/2nd Word)

Use these bits to set the starting address at the source of transfer. The content set here is updated according to the setting of SRINC.

DMOD[1:0]: Transfer mode (D[31:30]/3rd Word)

Use these bits to set the desired transfer mode.

The transfer modes are outlined below (to be detailed later):

- **Single transfer mode (00)**

In this mode, a transfer operation invoked by one trigger is completed after transferring one unit of data of the size set by DATSIZ. If data transfer need to be performed a number of times as set by the transfer counter, an equal number of triggers are required.

- **Successive transfer mode (01)**

In this mode, data transfer operations are performed by one trigger a number of times as set by the transfer counter. The transfer counter is decremented to 0 each time data is transferred.

- **Block transfer mode (10)**

In this mode, a transfer operation invoked by one trigger is completed after transferring one block of data of the size set by BLKLEN. If a block transfer need to be performed a number of times as set by the transfer counter, an equal number of triggers are required.

DSINC[1:0]: Destination address control (D[29:28]/3rd Word)

Set the destination address update format.

If the format is set for "address fixed" (00), the destination address is not changed by the performance of a data transfer operation. Even when transferring multiple data, the transfer data is always written to the same address.

If the format is set for "address increment" (11 or 10) in single and successive transfer modes, the destination address is incremented by an amount equal to the data size set by DATSIZ when one data transfer is completed. If the format is set for "address decrement" (01), the destination address is decremented in the same way.

In block transfer mode as well, the destination address is incremented or decremented when one data unit is transferred. However, if the set format is "10", the destination address that has been incremented during a block transfer recycles back to the initial value when the block transfer is completed.

DSADR[27:0]: Destination address (D[27:0]/3rd Word)

Use these bits to set the starting address at the destination of transfer. The content set here is updated according to the setting of DSINC.

Since the control information is placed in RAM, it can be rewritten. However, before rewriting the content of this information, make sure that no DMA transfer is generated in the channel whose information you are going to rewrite.

IDMA Invocation

The triggers by which IDMA is invoked have the following three causes:

1. Interrupt factor in an internal peripheral circuit
2. Trigger in the software application
3. Link setting

Enabling/disabling DMA transfer

The IDMA controller is enabled by writing "1" to the IDMA enable bit IDMAEN (D0) / IDMA enable register (0x48205), and is ready to accept the triggers described above. However, before enabling a DMA transfer, be sure to set the base address and the control information for the channel to be invoked correctly. If IDMAEN is set to "0", no IDMA invocation request is accepted.

IDMA invocation by an interrupt factor in internal peripheral circuits

Some internal peripheral circuits that have an interrupt generating function can invoke IDMA by an interrupt factor in that circuit. The IDMA channel numbers corresponding to such IDMA invocation are predetermined. The relationship between the interrupt factors that have this function and the IDMA channels is shown in Table V-3.2.

Table V-3.2 Interrupt Factors Used to Invoke IDMA

Peripheral circuit	Interrupt factor	IDMA Ch.	IDMA request bit	IDMA enable bit
Ports	Port input 0	1	RP0 (D0/0x40290)	DEP0 (D0/0x40294)
	Port input 1	2	RP1 (D1/0x40290)	DEP1 (D1/0x40294)
	Port input 2	3	RP2 (D2/0x40290)	DEP2 (D2/0x40294)
	Port input 3	4	RP3 (D3/0x40290)	DEP3 (D3/0x40294)
High-speed DMA	Ch.0, end of transfer	5	RHDM0 (D4/0x40290)	DEHDM0 (D4/0x40294)
	Ch.1, end of transfer	6	RHDM1 (D5/0x40290)	DEHDM1 (D5/0x40294)
16-bit programmable timer	Timer 0 comparison B	7	R16TU0 (D6/0x40290)	DE16TU0 (D6/0x40294)
	Timer 0 comparison A	8	R16TC0 (D7/0x40290)	DE16TC0 (D7/0x40294)
	Timer 1 comparison B	9	R16TU1 (D0/0x40291)	DE16TU1 (D0/0x40295)
	Timer 1 comparison A	10	R16TC1 (D1/0x40291)	DE16TC1 (D1/0x40295)
	Timer 2 comparison B	11	R16TU2 (D2/0x40291)	DE16TU2 (D2/0x40295)
	Timer 2 comparison A	12	R16TC2 (D3/0x40291)	DE16TC2 (D3/0x40295)
	Timer 3 comparison B	13	R16TU3 (D4/0x40291)	DE16TU3 (D4/0x40295)
	Timer 3 comparison A	14	R16TC3 (D5/0x40291)	DE16TC3 (D5/0x40295)
	Timer 4 comparison B	15	R16TU4 (D6/0x40291)	DE16TU4 (D6/0x40295)
	Timer 4 comparison A	16	R16TC4 (D7/0x40291)	DE16TC4 (D7/0x40295)
8-bit programmable timer	Timer 5 comparison B	17	R16TU5 (D0/0x40292)	DE16TU5 (D0/0x40296)
	Timer 5 comparison A	18	R16TC5 (D1/0x40292)	DE16TC5 (D1/0x40296)
	Timer 0 underflow	19	R8TU0 (D2/0x40292)	DE8TU0 (D2/0x40296)
	Timer 1 underflow	20	R8TU1 (D3/0x40292)	DE8TU1 (D3/0x40296)
	Timer 2 underflow	21	R8TU2 (D4/0x40292)	DE8TU2 (D4/0x40296)
Serial interface	Timer 3 underflow	22	R8TU3 (D5/0x40292)	DE8TU3 (D5/0x40296)
	Ch.0 receive buffer full	23	RSRX0 (D6/0x40292)	DESRX0 (D6/0x40296)
	Ch.0 transmit buffer empty	24	RSTX0 (D7/0x40292)	DESTX0 (D7/0x40296)
	Ch.1 receive buffer full	25	RSRX1 (D0/0x40293)	DESRX1 (D0/0x40297)
A/D converter	Ch.1 transmit buffer empty	26	RSTX1 (D1/0x40293)	DESTX1 (D1/0x40297)
	End of A/D conversion	27	RADE (D2/0x40293)	DEADE (D2/0x40297)
Ports	Port input 4	28	RP4 (D4/0x40293)	DEP4 (D4/0x40297)
	Port input 5	29	RP5 (D5/0x40293)	DEP5 (D5/0x40297)
	Port input 6	30	RP6 (D6/0x40293)	DEP6 (D6/0x40297)
	Port input 7	31	RP7 (D7/0x40293)	DEP7 (D7/0x40297)

These interrupt factors are used in common for interrupt requests and IDMA invocation requests.

To invoke IDMA upon the occurrence of an interrupt factor, set the corresponding bits of the IDMA request and IDMA enable registers shown in the table by writing "1". Then when an interrupt factor occurs, an interrupt request to the CPU is kept pending and the corresponding IDMA channel is invoked.

The interrupt factor flag that has been set to "1" remains set until the DMA transfer invoked by it is completed. If the following two conditions are met when one DMA transfer is completed, an interrupt request is generated without resetting the interrupt factor flag.

- The transfer counter has reached 0.
- DINTEN in control information is set to "1" (interrupt enabled).

In this case, the IDMA request register is cleared to "0". Therefore, if IDMA needs to be invoked when an interrupt factor occurs next time, this register must be set up again. To prevent unwanted IDMA requests from being generated, this setting must be performed before enabling interrupts and after resetting the interrupt factor flag. The IDMA enable bit is not cleared and remains set to "1".

If the transfer counter is not 0, the interrupt factor flag is reset when the DMA transfer is completed, so that no interrupt is generated. In this case, the IDMA request bit and IDMA enable bit are not cleared and remain set to "1".

When DINTEN in control information has been set to "0", the interrupt factor flag is reset even if the transfer counter reaches 0, so that no interrupt is generated. In this case, the IDMA request bit is not cleared but the IDMA enable bit is cleared.

If the IDMA request register bit is left reset to "0", the relevant interrupt factor generates an interrupt request and not a IDMA request.

The control registers (interrupt enable register and interrupt priority register) corresponding to the interrupt factor do not affect IDMA invocation. IDMA can be invoked even if the interrupt enable bit in ITC is set to "0" (interrupt disabled). However, these register must be set to enable the interrupt when generating the interrupt after completing the DMA transfer.

IDMA invocation by a trigger in the software application

All IDMA channels for which control information is set, including those corresponding to interrupt factors described above, can be invoked by a trigger in the software application.

The following bits are used for this control:

IDMA channel number set-up: DCHN[6:0] (D[6:0]) / IDMA start register (0x48204)

IDMA start control: DSTART (D7) / IDMA start register (0x48204)

When the IDMA channel number to be invoked (0 to 127) is written to DCHN and DSTART is set to "1", the specified IDMA channel starts a DMA transfer.

DSTART remains set (= "1") during a DMA transfer and is reset to "0" in hardware when one DMA transfer operation is completed.

Do not modify these bits during a DMA transfer.

If DINTEN is set to "1" (interrupt enabled), an interrupt factor for the completion of IDMA transfer is generated when one DMA transfer is completed.

IDMA invocation by link setting

If LNKEN in the control information is set to "1" (link enabled), the IDMA channel that is set in the IDMA link field "LNKCHN" is invoked successively after a DMA transfer in the link-enabled channel is completed. The interrupt request by the first channel is generated after transfers in all linked channels are completed if the interrupt conditions are met.

To generate an interrupt at the end of an IDMA transfer, the DINTEN (end-of-transfer interrupt enable) bits in the IDMA control information for the first IDMA channel to be invoked and all the channels to be linked must be set to "1".

IDMA invocation request during a DMA transfer

An IDMA invocation request to another channel that is generated during a DMA transfer is kept pending until the DMA transfer that was being executed at the time is completed. Since an invocation request is not cleared, new requests will be accepted when the DMA transfer under execution is completed.

An IDMA invocation request to the same channel cannot be accepted while the channel is executing a DMA transfer because the same interrupt factor is used. Therefore, an interval longer than the DMA transfer period is required when invoking the same channel.

IDMA invocation request when DMA transfer is disabled

An IDMA invocation request generated when IDMAEN is "0" (DMA transfer disabled) is kept pending until IDMAEN is set to "1". Since an invocation request is not cleared, it is accepted when DMA transfer is enabled.

Simultaneous generation of a software trigger and a hardware trigger

When a software trigger and the hardware trigger for the same channel are generated simultaneously, the software trigger starts IDMA transfer. The IDMA transfer by the hardware trigger is not executed since the interrupt factor is reset when the DMA transfer is completed. However, an operation like this cannot be recommended.

Operation of IDMA

IDMA has three transfer modes, in each of which data transfer operates differently. Furthermore, an interrupt factor is processed differently depending on the type of trigger. The following describes the operation of IDMA in each transfer mode and how an interrupt factor is processed for each type of trigger.

Single transfer mode

The channels for which DMOD in control information is set to "00" operate in single transfer mode. In this mode, a transfer operation invoked by one trigger is completed after transferring one data unit of the size set by DATSIZ. If a data transfer needs to be performed a number of times as set by the transfer counter, an equal number of triggers are required.

The operation of IDMA in single transfer mode is shown by the flow chart in Figure V-3.1.

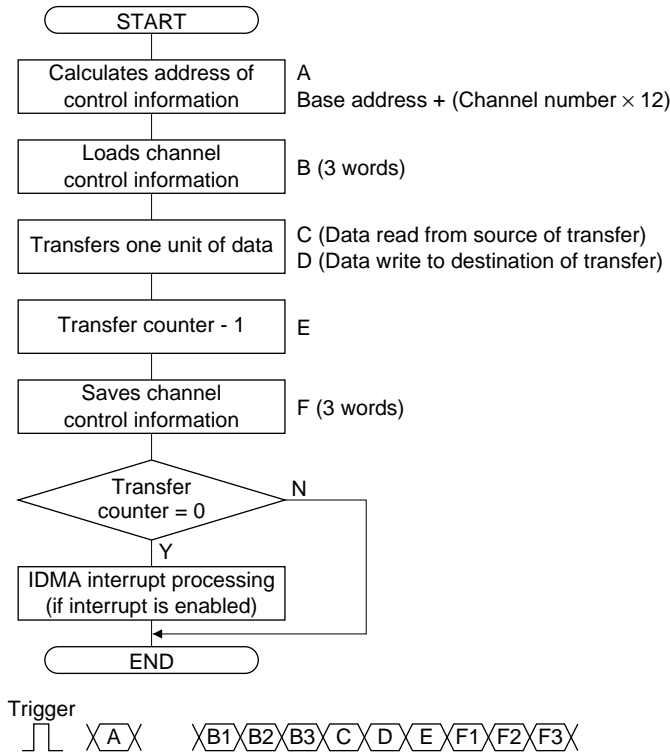


Figure V-3.1 Operation Flow in Single Transfer Mode

- (1) When a trigger is accepted, the address for control information is calculated from the base address and channel number.
- (2) Control information is read from the calculated address into the internal temporary register.
- (3) Data of the size set in the control information is read from the source address.
- (4) The read data is written to the destination address.
- (5) The address is incremented or decremented and the transfer counter is decremented.
- (6) The modified control information is written to RAM.
- (7) In the case of a hardware trigger, the interrupt control bits are processed before completing IDMA.

Condition	Interrupt factor flag	IDMA request bit	IDMA enable bit
Transfer counter ≠ "0":	Reset ("0")	Not changed ("1")	Not changed ("1")
Transfer counter = "0", DINTEN = "1":	Not changed ("1")	Reset ("0")	Not changed ("1")
Transfer counter = "0", DINTEN = "0":	Reset ("0")	Not changed ("1")	Reset ("0")

Successive transfer mode

The channels for which DMOD in control information is set to "01" operate in successive transfer mode. In this mode, a data transfer is performed by one trigger a number of times as set by the transfer counter. The transfer counter is decremented to "0" by one transfer executed.

The operation of IDMA in successive transfer mode is shown by the flow chart in Figure V-3.2.

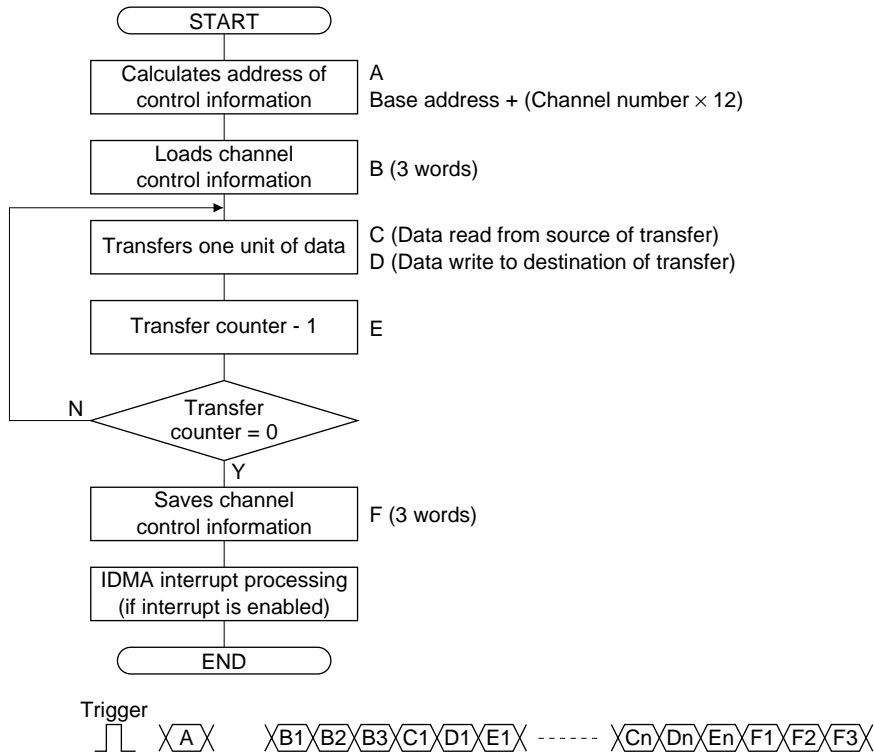


Figure V-3.2 Operation Flow in Successive Transfer Mode

- (1) When a trigger is accepted, the address for control information is calculated from the base address and channel number.
- (2) Control information is read from the calculated address into the internal temporary register.
- (3) Data of the size set in the control information is read from the source address.
- (4) The read data is written to the destination address.
- (5) The address is incremented or decremented and the transfer counter is decremented.
- (6) Steps (3) to (5) are repeated until the transfer counter reaches 0.
- (7) The modified control information is written to RAM.
- (8) In the case of a hardware trigger, the interrupt control bits are processed before completing IDMA.

Condition	Interrupt factor flag	IDMA request bit	IDMA enable bit
Transfer counter ≠ "0":	Reset ("0")	Not changed ("1")	Not changed ("1")
Transfer counter = "0", DINTEN = "1":	Not changed ("1")	Reset ("0")	Not changed ("1")
Transfer counter = "0", DINTEN = "0":	Reset ("0")	Not changed ("1")	Reset ("0")

Block transfer mode

The channels for which DMOD in control information is set to "10" operate in block transfer mode. In this mode, a transfer operation invoked by one trigger is completed after transferring one block of data of the size set by BLKLEN. If a block transfer needs to be performed a number of times as set by the transfer counter, an equal number of triggers are required.

The operation of IDMA in block transfer mode is shown by the flow chart in Figure V-3.3.

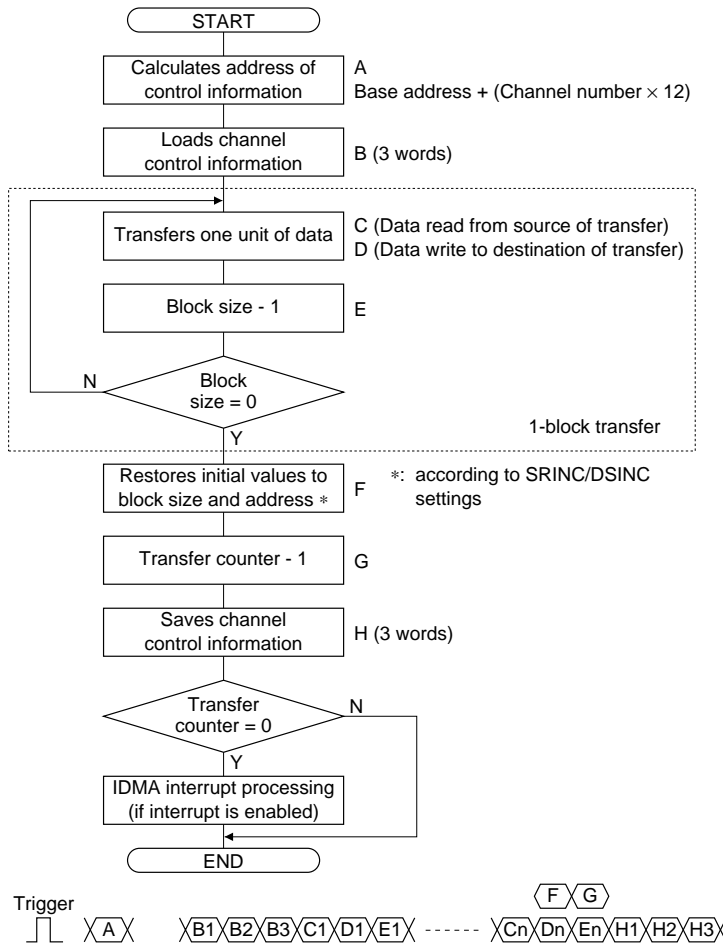


Figure V-3.3 Operation Flow in Block Transfer Mode

- (1) When a trigger is accepted, the address for control information is calculated from the base address and channel number.
- (2) Control information is read from the calculated address into the internal temporary register.
- (3) Data of the size set in the control information is read from the source address.
- (4) The read data is written to the destination address.
- (5) The address is incremented or decremented and BLKLEN is decremented.
- (6) Steps (3) to (5) are repeated until BLKLEN reaches 0.
- (7) If SRINC and DSINC are "10", the address is recycled to the initial value.
- (8) The transfer counter is decremented.
- (9) The modified control information is written to RAM.
- (10) In the case of a hardware trigger, the interrupt control bits are processed before completing IDMA.

Condition	Interrupt factor flag	IDMA request bit	IDMA enable bit
Transfer counter ≠ "0":	Reset ("0")	Not changed ("1")	Not changed ("1")
Transfer counter = "0", DINTEN = "1":	Not changed ("1")	Reset ("0")	Not changed ("1")
Transfer counter = "0", DINTEN = "0":	Reset ("0")	Not changed ("1")	Reset ("0")

Processing of interrupt factors by type of trigger

- **When invoked by an interrupt factor**

The interrupt factor flag by which IDMA has been invoked remains set even during a DMA transfer.

If the transfer counter is decremented to 0 and DINTEN = "1" (interrupt enabled) when one DMA transfer is completed, the interrupt factor that has invoked IDMA is not reset and an interrupt request is generated. At the same time, the IDMA request register is cleared to "0". The IDMA enable bit is not cleared and remains set to "1".

If the transfer counter is not 0, the interrupt factor flag is reset when the DMA transfer is completed, so that no interrupt is generated. In this case, the IDMA request bit and IDMA enable bit are not cleared and remain set to "1".

When DINTEN has been set to "0" (interrupt disabled), the interrupt factor flag is reset even if the transfer counter reaches 0, so that no interrupt is generated. In this case, the IDMA request bit is not cleared but the IDMA enable bit is cleared.

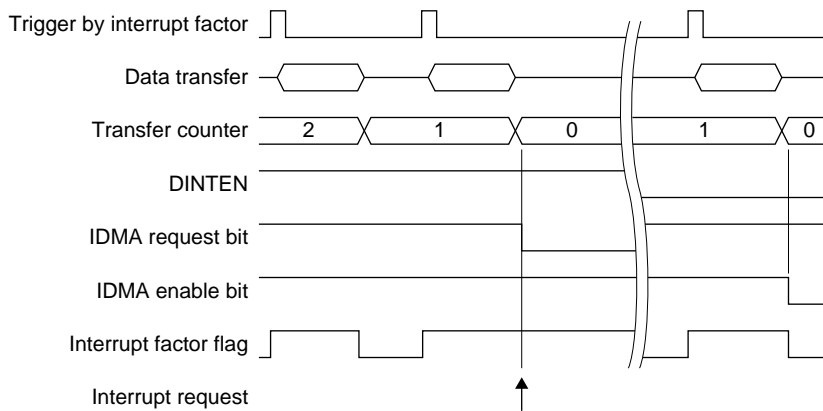


Figure V-3.4 Operation when Invoked by Interrupt Factor

When IDMA is invoked by the software trigger, the IDMA interrupt factor flag FIDMA (D4)/DMA interrupt factor flag register (0x40281) will not be set.

- **When invoked by a software trigger**

If the transfer counter is decremented to 0 and DINTEN = "1" (interrupt enabled) when one DMA transfer is completed, the IDMA interrupt factor flag FIDMA (D4)/DMA interrupt factor flag register (0x40281) is set, thereby generating an interrupt request.

If the transfer counter is not 0 or DINTEN = "0" (interrupt disabled), the FIDMA flag is not set.

If the interrupt factor flag for the same channel is set during a software-triggered transfer, the IDMA invocation request by that interrupt factor flag is kept pending. However, the interrupt factor flag will be reset when the current execution is completed, so there will be no DMA transfer by the interrupt factor flag.

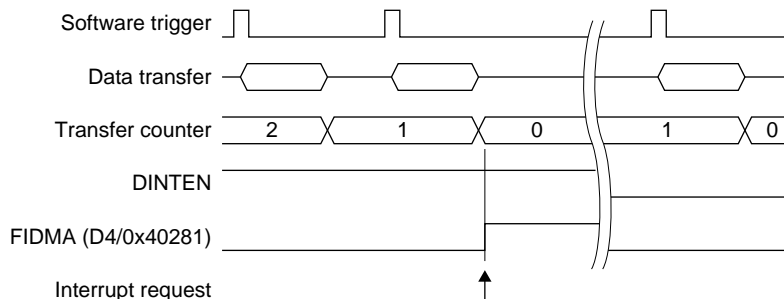


Figure V-3.5 Operation when Invoked by Software Trigger

Linking

If the IDMA channel number to be executed next is set in the IDMA link field "LNKCHN" of control information and LNKEN is set to "1" (link enabled), DMA successive transfer in that IDMA channel can be performed. An example of link setting is shown in Figure V-3.6.

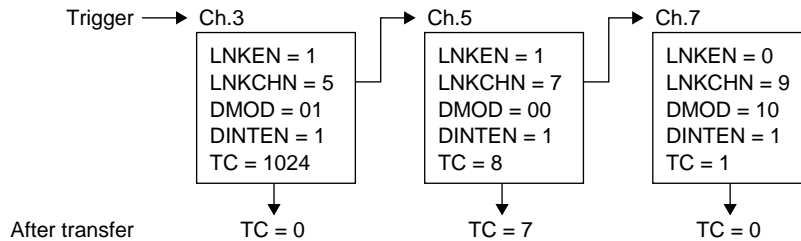


Figure V-3.6 Example of Link Setting

For the above example, IDMA operates as described below.

• For trigger in hardware

- (1) The IDMA channel 3 is invoked by an interrupt factor and the DMA transfer that is set is performed. Since the IDMA is operating in successive transfer mode and the transfer counter is decremented to 0 and DINTEN is set to "1", the interrupt factor flag by which the channel 3 has been invoked remains set.
- (2) Next, a DMA transfer is performed via the linked IDMA channel 5. Channel 5 is set for single transfer mode and the transfer counter in this transfer is decremented by 1.
- (3) Finally, a DMA transfer in IDMA channel 7 is performed. Although the channel 7 is set for block transfer mode, the transfer counter is decremented to 0 when the transfer is completed because the number of transfers to be performed is 1.
- (4) Since the interrupt factor flag that has invoked IDMA channel 3 in (1) remains set, an interrupt is generated when the IDMA transfer (channel 7) in (3) is completed. The transfer result does not affect the interrupt factor flag of channel 3.

To generate an interrupt at the end of an IDMA transfer, the DINTEN (end-of-transfer interrupt enable) bits in the IDMA control information for the first IDMA channel to be invoked and all the channels to be linked must be set to "1".

• For trigger in the software application

- (1) The IDMA channel 3 is invoked by a trigger in the software application and the DMA transfer that is set is performed. Since the IDMA is operating in successive transfer mode and the transfer counter is decremented to 0 and DINTEN is set to "1", the IDMA interrupt factor flag FIDMA (D4)/DMA interrupt factor flag register (0x40281) is set when the transfer is completed.
- (2) Next, a DMA transfer is performed in the linked IDMA channel 5. The channel 5 is set for the single transfer mode and the transfer counter in this transfer is decremented by 1.
- (3) Finally, a DMA transfer in IDMA channel 7 is performed. Although channel 7 is set for the block transfer mode, the transfer counter is decremented to 0 when the transfer is completed because the number of transfers to be performed is 1. The completion of this transfer also causes the FIDMA flag to be set to "1". However, the FIDMA flag has already been set when the transfer is completed in (1) above.
- (4) Since the FIDMA flag is set, an interrupt request is generated here. In cases when IDMA has been invoked by a trigger in the software application, if the transfer counter in any one of the linked channels is decremented to 0 and DINTEN for that channel is set to "1", an interrupt request for the completion of IDMA transfer is generated when a transfer operation in each of the linked channels is completed. The channel in which an interrupt request has been generated can be verified by reading out the transfer counter.

Transfer operations in each channel are performed as described earlier.

Interrupt Function of Intelligent DMA

IDMA can generate an interrupt that causes invocation of IDMA and an interrupt for the completion of IDMA transfer itself.

Interrupt when invoked by an interrupt factor

If the corresponding bits of the IDMA request and interrupt enable registers are left set (= "1"), assertion of an interrupt request is kept pending even when the enabled interrupt factor has occurred and the IDMA channel assigned to that interrupt factor is invoked.

If the transfer counter is decremented to 0 and DINTEN = "1" (interrupt enabled) when one DMA transfer is completed, the interrupt factor that has invoked IDMA is not reset and an interrupt request is generated. At the same time, the IDMA request register is cleared to "0". The IDMA enable bit is not cleared and remains set to "1".

If the transfer counter is not 0, the interrupt factor flag is reset when the DMA transfer is completed, so that no interrupt is generated. In this case, the IDMA request bit and IDMA enable bit are not cleared and remain set to "1".

When DINTEN has been set to "0" (interrupt disabled), the interrupt factor flag is reset even if the transfer counter reaches 0, so that no interrupt is generated. In this case, the IDMA request bit is not cleared but the IDMA enable bit is cleared.

When IDMA is invoked by the software trigger, the IDMA interrupt factor flag FIDMA (D4)/DMA interrupt factor flag register (0x40281) will not be set.

For details about the interrupt factors that can be used to invoke IDMA and the interrupt control registers, refer to the descriptions of the peripheral circuits in this manual.

Note that the priority levels of interrupt factors are set by the interrupt priority register. Refer to "ITC (Interrupt Controller)". However, when compared between IDMA and interrupt requests, IDMA is given higher priority over the other. Consequently, even when an interrupt factor occurring during an IDMA transfer has higher priority than the interrupt factor that invoked the IDMA transfer, an interrupt request for it or a new IDMA invocation request is not accepted until after the current IDMA transfer is completed.

Software-triggered interrupts

If the transfer counter is decremented to 0 and DINTEN = "1" (interrupt enabled) when one DMA transfer operation is completed, the IDMA interrupt factor flag FIDMA (D4)/DMA interrupt factor flag register (0x40281) is set, thereby generating an interrupt request. If the transfer counter is not 0 or DINTEN = "0" (interrupt disabled), the FIDMA flag is not set.

IDMA interrupt control register in the interrupt controller

The following registers are used to control an interrupt for the completion of IDMA transfer:

Interrupt factor flag: FIDMA (D4) / DMA interrupt factor flag register (0x40281)

Interrupt enable: EIDMA (D4) / DMA interrupt enable register (0x40271)

Interrupt level: PDM[2:0](D[2:0]) / IDMA interrupt priority register (0x40265)

When a DMA transfer in the IDMA channel invoked by a trigger in the software application or subsequent link is completed and the transfer counter is decremented to 0, the interrupt factor flag for the completion of IDMA transfer is set to "1". However, this requires as a precondition that interrupt be enabled (DINTEN = "1") in the control information for that channel. If the interrupt enable register bit remains set (= "1") when the flag is set, an interrupt request is generated. Interrupts can be disabled by leaving the interrupt enable register bit cleared (= "0"). Use the interrupt priority register to set interrupt priority levels (0 to 7). An interrupt request to the CPU is accepted on condition that no other interrupt request of higher priority is generated.

Furthermore, it is only when the PSR's IE bit = "1" (interrupt enabled) and the set value of IL is smaller than the IDMA interrupt level which is set by the interrupt priority register that the CPU actually accepts an IDMA interrupt request.

For details about these interrupt control registers, and for information on device operation when an interrupt occurs, refer to "ITC (Interrupt Controller)".

Trap vector

The trap vector address for an interrupt upon completion of IDMA transfer by default is set as follows:

When BTA3 = H (high), 0x0080068; when BTA3 = L (low), 0x0C00068

The trap table base address can be changed using the TTBR registers (0x48134 to 0x48137).

I/O Memory of Intelligent DMA

Table V-3.3 shows the control bits of IDMA.

Table V-3.3 Control Bits of IDMA

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks							
IDMA interrupt priority register	0040265 (B)	D7-3	–	reserved	–	–	–	0 when being read.							
		D2	PDM2	IDMA interrupt level	0 to 7	X	R/W								
		D1	PDM1			X	R/W								
		D0	PDM0			X	R/W								
DMA interrupt enable register	0040271 (B)	D7-5	–	reserved	–	–	–	0 when being read.							
		D4	EIDMA	IDMA	1 Enabled	0 Disabled	0	R/W							
		D3	EHDM3	High-speed DMA Ch.3			0	R/W							
		D2	EHDM2	High-speed DMA Ch.2	0	R/W									
		D1	EHDM1	High-speed DMA Ch.1	0	R/W									
		D0	EHDM0	High-speed DMA Ch.0	0	R/W									
DMA interrupt factor flag register	0040281 (B)	D7-5	–	reserved	–	–	–	0 when being read.							
		D4	FIDMA	IDMA	1 Factor is generated	0 No factor is generated	X	R/W							
		D3	FHDM3	High-speed DMA Ch.3			X	R/W							
		D2	FHDM2	High-speed DMA Ch.2	X	R/W									
		D1	FHDM1	High-speed DMA Ch.1	X	R/W									
		D0	FHDM0	High-speed DMA Ch.0	X	R/W									
IDMA base address low-order register	0048200 (HW)	DF	DBASEL15	IDMA base address			0	R/W							
		DE	DBASEL14	low-order 16 bits											
		DD	DBASEL13	(Initial value: 0x0C003A0)											
		DC	DBASEL12												
		DB	DBASEL11												
		DA	DBASEL10												
		D9	DBASEL9												
		D8	DBASEL8												
		D7	DBASEL7												
		D6	DBASEL6												
		D5	DBASEL5												
		D4	DBASEL4												
		D3	DBASEL3												
		D2	DBASEL2												
		D1	DBASEL1												
D0	DBASEL0														
IDMA base address high-order register	0048202 (HW)	DF-C	–	reserved	–	–	–	Undefined in read.							
		DB	DBASEH11	IDMA base address			0	R/W							
		DA	DBASEH10	high-order 12 bits											
		D9	DBASEH9	(Initial value: 0x0C003A0)											
		D8	DBASEH8												
		D7	DBASEH7												
		D6	DBASEH6												
		D5	DBASEH5												
		D4	DBASEH4												
		D3	DBASEH3												
		D2	DBASEH2												
		D1	DBASEH1												
		D0	DBASEH0												
		IDMA start register	0048204 (B)	D7			DSTART			IDMA start	1 IDMA start	0 Stop	0	R/W	
				D6-0			DCHN			IDMA channel number	0 to 127		0	R/W	
IDMA enable register	0048205 (B)	D7-1	–	reserved			–			–	–				
		D0	IDMAEN	IDMA enable	1 Enabled	0 Disabled	0	R/W							

DBASEL[15:0]: IDMA base address [15:0] (D[F:0]) / IDMA base address low-order register (0x48200)

DDBASEH[11:0]: IDMA base address [27:16] (D[B:0]) / IDMA base address high-order register (0x48202)

Specify the starting address of the control information to be placed in RAM.

Use DBASEL to set the 16 low-order bits of the address and DDBASEH to set the 12 high-order bits.

The address to be set in these registers must always be a word (32-bit) boundary address.

These registers cannot be read or written in bytes. The registers must be accessed in words for read/write operations to address 0x48200, and in half-words for read/write operations to addresses 0x48200 and 0x48202.

Write operations in half-words must be performed in order of 0x48200 and 0x48202. Read operations in half-words may be performed in any order.

Write operations to the IDMA base address registers during a DMA transfer are ignored. When the register is read during a DMA transfer, the read data is indeterminate.

At initial reset, the base address is set to 0xC003A0.

IDMAEN: DMA enable (D0) / DMA enable register (0x48205)

Enable a IDMA transfer.

Write "1": Enabled

Write "0": Disabled

Read: Valid

A data transfer operation by intelligent DMA is enabled by writing "1" to IDMAEN.

IDMA transfer is disabled by writing "0" to IDMAEN.

At initial reset, IDMAEN is set to "0" (disabled).

DCHN[6:0]: IDMA channel number (D[6:0]) / IDMA start register (0x48204)

Set the channel numbers (0 to 127) to be invoked by a trigger in the software application.

At initial reset, DCHN is set to "0".

DSTART: IDMA start (D7) / IDMA start register (0x48204)

Use this register for a trigger in the software application and for monitoring the operation of IDMA.

When written

Write "1": IDMA started

Write "0": Invalid

When read

Read "1": IDMA operating (only when invoked by software trigger)

Read "0": IDMA inactive

When DSTART is set to "1", it functions as a trigger in the software application, invoking the IDMA channel that is set in the DCHN register.

At initial reset, DSTART is set to "0".

PDM2–PDM0: DMA interrupt level (D[2:0]) / IDMA interrupt priority register (0x40265)

Set the priority level of the interrupt upon completion of IDMA transfer in the range of 0 to 7.

At initial reset, the contents of this register are indeterminate.

EIDMA: IDMA interrupt enable (D2) / DMA interrupt enable register (0x40271)

Enable or disable occurrence of an interrupt to the CPU.

Write "1": Interrupt enabled

Write "0": Interrupt disabled

Read: Valid

This bit controls the interrupt generated upon completion of IDMA transfer. The interrupt is enabled by setting this bit to "1" and disabled by setting this bit to "0".

At initial reset, EIDMA is set to "0" (interrupt disable).

FIDMA: IDMA interrupt factor flag (D2) / DMA interrupt factor flag register (0x40281)

Indicate the occurrence status of an IDMA interrupt request.

When read

Read "1": Interrupt factor occurred

Read "0": No interrupt factor occurred

When written using reset-only method (default)

Write "1": Interrupt factor flag is reset

Write "0": Invalid

When written using the read/write method

Write "1": Interrupt factor flag is set

Write "0": Interrupt factor flag is reset

This flag is set to "1" when one DMA transfer initiated by a software trigger or subsequent link is completed and the transfer counter is decremented to 0. However, this requires as a precondition that interrupts be enabled in control information (DINTEN = "1").

At this time, an interrupt to the CPU is generated if the following conditions are met:

1. The corresponding interrupt enable register bit is set to "1".
2. No interrupt request of higher priority is generated.
3. The IE bit of the PSR is set to "1" (interrupt enable).
4. The corresponding interrupt priority register is set to a level higher than the CPU's interrupt level (IL).

In order for the next interrupt to be accepted after interrupt generation, the interrupt factor flag must be reset and the PSR must be set up again (by setting the IL below the level indicated by the interrupt priority register and setting the IE bit to "1" or executing a reti instruction).

The interrupt factor flag can only be reset by a write instruction in the software application. If the PSR is set up again to accept interrupts (or the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt may occur again. Note also that the value to be written to reset the flag is "1" when using the reset-only method (RSTONLY = "1") and "0" when using the read/write method (RSTONLY = "0"). Be careful not to confuse these two cases.

This flag becomes indeterminate when initially reset, so be sure to reset it in the software application.

Programming Notes

- (1) Before setting the IDMA base address, be sure to disable DMA transfers (IDMAEN = "0"). Writing to the IDMA base address register is ignored when the DMA transfer is enabled (IDMAEN = "1"). Also, when the register is read during a DMA transfer, the data is indeterminate. When setting or rewriting control information for each channel, make sure that DMA transfers will not occur in any channel.
- (2) The address that is set in the IDMA base address register must always be a word (32-bit) boundary address.
- (3) After an initial reset, the interrupt factor flag (FIDMA) becomes indeterminate. To prevent unwanted interrupts from occurring, be sure to reset the flag in a program.
- (4) Once an interrupt occurs, be sure to reset the interrupt factor flag (FIDMA) before setting up the PSR again or executing the reti instruction. This ensures that an interrupt will not be generated for the same factor.
- (5) If all the following conditions are met, the transfer counter value becomes invalid during IDMA transfer so data cannot be transferred properly.
 1. The IDMA control information (source/destination addresses, transfer counter, etc.) is placed in the external EDO DRAM.
 2. The DRAM access timing condition is set to EDO mode by the BCU register.
 3. The bus clock is set to x2 speed mode (#X2SPD pin = "0").

When placing the control information in the EDO DRAM in x2 speed mode, the DRAM access timing condition must be set to high-speed page mode.

Or place the control information in the internal RAM. Using the internal RAM increases the performance because the overhead during IDMA transfer is decreased to 6 cycles on both load/store operations.

- (6) The current version of the DMA controller (C33 macro Model 2 rev. 2.2) does not set the IDMA interrupt factor flag FIDMA (D4)/DMA interrupt factor flag register (0x40281) even when an IDMA transfer that was started with a software trigger has completed (transfer counter = 0). Therefore, a transfer completion interrupt cannot be used in software trigger mode.

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E0C33 Block Technical Manual

Appendix I/O MAP

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
8-bit timer clock select register	0040146 (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	P8TPCK3	8-bit timer 3 clock selection	1 0/1	0	Divided clk.	0 R/W	θ: selected by
		D2	P8TPCK2	8-bit timer 2 clock selection	1 0/1	0	Divided clk.	0 R/W	Prescaler clock select
		D1	P8TPCK1	8-bit timer 1 clock selection	1 0/1	0	Divided clk.	0 R/W	register (0x40181)
		D0	P8TPCK0	8-bit timer 0 clock selection	1 0/1	0	Divided clk.	0 R/W	
16-bit timer 0 clock control register	0040147 (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	P16TON0	16-bit timer 0 clock control	1 On	0	Off	0 R/W	
		D2	P16TS02	16-bit timer 0	P16TS0[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS01	clock division ratio selection	1 1 1	θ/4096	0		Prescaler clock select
		D0	P16TS00		1 1 0	θ/1024	0		register (0x40181)
					1 0 1	θ/256			
					1 0 0	θ/64			
					0 1 1	θ/16			
		0 1 0	θ/4				16-bit timer 0 can be used as a watchdog timer.		
		0 0 1	θ/2						
		0 0 0	θ/1						
16-bit timer 1 clock control register	0040148 (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	P16TON1	16-bit timer 1 clock control	1 On	0	Off	0 R/W	
		D2	P16TS12	16-bit timer 1	P16TS1[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS11	clock division ratio selection	1 1 1	θ/4096	0		Prescaler clock select
		D0	P16TS10		1 1 0	θ/1024	0		register (0x40181)
					1 0 1	θ/256			
					1 0 0	θ/64			
					0 1 1	θ/16			
		0 1 0	θ/4						
		0 0 1	θ/2						
		0 0 0	θ/1						
16-bit timer 2 clock control register	0040149 (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	P16TON2	16-bit timer 2 clock control	1 On	0	Off	0 R/W	
		D2	P16TS22	16-bit timer 2	P16TS2[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS21	clock division ratio selection	1 1 1	θ/4096	0		Prescaler clock select
		D0	P16TS20		1 1 0	θ/1024	0		register (0x40181)
					1 0 1	θ/256			
					1 0 0	θ/64			
					0 1 1	θ/16			
		0 1 0	θ/4						
		0 0 1	θ/2						
		0 0 0	θ/1						
16-bit timer 3 clock control register	004014A (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	P16TON3	16-bit timer 3 clock control	1 On	0	Off	0 R/W	
		D2	P16TS32	16-bit timer 3	P16TS3[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS31	clock division ratio selection	1 1 1	θ/4096	0		Prescaler clock select
		D0	P16TS30		1 1 0	θ/1024	0		register (0x40181)
					1 0 1	θ/256			
					1 0 0	θ/64			
					0 1 1	θ/16			
		0 1 0	θ/4						
		0 0 1	θ/2						
		0 0 0	θ/1						
16-bit timer 4 clock control register	004014B (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	P16TON4	16-bit timer 4 clock control	1 On	0	Off	0 R/W	
		D2	P16TS42	16-bit timer 4	P16TS4[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS41	clock division ratio selection	1 1 1	θ/4096	0		Prescaler clock select
		D0	P16TS40		1 1 0	θ/1024	0		register (0x40181)
					1 0 1	θ/256			
					1 0 0	θ/64			
					0 1 1	θ/16			
		0 1 0	θ/4						
		0 0 1	θ/2						
		0 0 0	θ/1						

(B) in [Address] indicates an 8-bit register and (HW) indicates a 16-bit register.

The meaning of the symbols described in [Init.] are listed below:

0, 1: Initial values that are set at initial reset.

(However, the registers for the bus and input/output ports are not initialized at hot start.)

X: Not initialized at initial reset.

–: Not set in the circuit.

APPENDIX: I/O MAP

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
16-bit timer 5 clock control register	004014C (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	P16TON5	16-bit timer 5 clock control	1 On	0 Off	0	R/W	
		D2	P16TS52	16-bit timer 5	P16TS5[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D1	P16TS51	clock division ratio selection	1 1 1	θ/4096	0		
		D0	P16TS50	1 1 0	θ/1024	0			
				1 0 1	θ/256	0			
				1 0 0	θ/64	0			
				0 1 1	θ/16	0			
				0 1 0	θ/4	0			
				0 0 1	θ/2	0			
0 0 0	θ/1	0							
8-bit timer 0/1 clock control register	004014D (B)	D7	P8TON1	8-bit timer 1 clock control	1 On	0 Off	0	R/W	
		D6	P8TS12	8-bit timer 1	P8TS1[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D5	P8TS11	clock division ratio selection	1 1 1	θ/4096	0		
		D4	P8TS10	1 1 0	θ/2048	0			
				1 0 1	θ/1024	0			
				1 0 0	θ/512	0			
				0 1 1	θ/256	0			
				0 1 0	θ/128	0			
				0 0 1	θ/64	0			
		0 0 0	θ/32	0					
		D3	P8TON0	8-bit timer 0 clock control	1 On	0 Off	0	R/W	
		D2	P8TS02	8-bit timer 0	P8TS0[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D1	P8TS01	clock division ratio selection	1 1 1	θ/256	0		
		D0	P8TS00	1 1 0	θ/128	0			
1 0 1	θ/64			0					
1 0 0	θ/32			0					
0 1 1	θ/16			0					
0 1 0	θ/8	0							
0 0 1	θ/4	0							
0 0 0	θ/2	0							
8-bit timer 2/3 clock control register	004014E (B)	D7	P8TON3	8-bit timer 3 clock control	1 On	0 Off	0	R/W	
		D6	P8TS32	8-bit timer 3	P8TS3[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D5	P8TS31	clock division ratio selection	1 1 1	θ/256	0		
		D4	P8TS30	1 1 0	θ/128	0			
				1 0 1	θ/64	0			
				1 0 0	θ/32	0			
				0 1 1	θ/16	0			
				0 1 0	θ/8	0			
				0 0 1	θ/4	0			
		0 0 0	θ/2	0					
D3	P8TON2	8-bit timer 2 clock control	1 On	0 Off	0	R/W			
D2	P8TS22	8-bit timer 2	P8TS2[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181)		
D1	P8TS21	clock division ratio selection	1 1 1	θ/4096	0				
D0	P8TS20	1 1 0	θ/2048	0					
		1 0 1	θ/64	0					
		1 0 0	θ/32	0					
		0 1 1	θ/16	0					
0 1 0	θ/8	0							
0 0 1	θ/4	0							
0 0 0	θ/2	0							
A/D clock control register	004014F (B)	D7-4	–	reserved	–	–	–	0 when being read.	
		D3	PSONAD	A/D converter clock control	1 On	0 Off	0	R/W	
		D2	PSAD2	A/D converter clock division ratio	P8TS0[2:0] Division ratio		0	R/W	θ: selected by Prescaler clock select register (0x40181)
		D1	PSAD1	selection	1 1 1	θ/256	0		
		D0	PSAD0	1 1 0	θ/128	0			
				1 0 1	θ/64	0			
				1 0 0	θ/32	0			
				0 1 1	θ/16	0			
				0 1 0	θ/8	0			
				0 0 1	θ/4	0			
0 0 0	θ/2	0							

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Clock timer Run/Stop register	0040151 (B)	D7-2	–	reserved	–	–	–	0 when being read.	
		D1	TCRST	Clock timer reset	1 Reset	0 Invalid	X	W	0 when being read.
		D0	TCRUN	Clock timer Run/Stop control	1 Run	0 Stop	X	R/W	
Clock timer interrupt control register	0040152 (B)	D7	TCISE2	Clock timer interrupt factor selection	TCISE[2:0] Interrupt factor		X	R/W	
		D6	TCISE1		1 1 1	None	X		
		D5	TCISE0		1 1 0	Day	X		
					1 0 1	Hour			
					1 0 0	Minute			
				0 1 1	1 Hz				
				0 1 0	2 Hz				
				0 0 1	8 Hz				
				0 0 0	32 Hz				
				D4	TCASE2	Clock timer alarm factor selection	TCASE[2:0] Alarm factor		X
D3	TCASE1	1 X X	Day	X					
D2	TCASE0	X 1 X	Hour	X					
		X X 1	Minute						
				0 0 0	None				
		D1	TCIF	Interrupt factor generation flag	1 Generated	0 Not generated	X	R/W	Reset by writing 1.
		D0	TCAF	Alarm factor generation flag	1 Generated	0 Not generated	X	R/W	Reset by writing 1.
Clock timer divider register	0040153 (B)	D7	TCD7	Clock timer data 1 Hz	1 High	0 Low	X	R	
		D6	TCD6	Clock timer data 2 Hz	1 High	0 Low	X	R	
		D5	TCD5	Clock timer data 4 Hz	1 High	0 Low	X	R	
		D4	TCD4	Clock timer data 8 Hz	1 High	0 Low	X	R	
		D3	TCD3	Clock timer data 16 Hz	1 High	0 Low	X	R	
		D2	TCD2	Clock timer data 32 Hz	1 High	0 Low	X	R	
		D1	TCD1	Clock timer data 64 Hz	1 High	0 Low	X	R	
		D0	TCD0	Clock timer data 128 Hz	1 High	0 Low	X	R	
Clock timer second register	0040154 (B)	D7-6	–	reserved	–	–	–	–	0 when being read.
		D5	TCMD5	Clock timer second counter data TCMD5 = MSB TCMD0 = LSB	0 to 59 seconds		X	R	
		D4	TCMD4		X				
		D3	TCMD3		X				
		D2	TCMD2		X				
		D1	TCMD1		X				
		D0	TCMD0		X				
Clock timer minute register	0040155 (B)	D7-6	–	reserved	–	–	–	–	0 when being read.
		D5	TCHD5	Clock timer minute counter data TCHD5 = MSB TCHD0 = LSB	0 to 59 minutes		X	R/W	
		D4	TCHD4		X				
		D3	TCHD3		X				
		D2	TCHD2		X				
		D1	TCHD1		X				
		D0	TCHD0		X				
Clock timer hour register	0040156 (B)	D7-5	–	reserved	–	–	–	–	0 when being read.
		D4	TCDD4	Clock timer hour counter data TCDD4 = MSB TCDD0 = LSB	0 to 23 hours		X	R/W	
		D3	TCDD3		X				
		D2	TCDD2		X				
		D1	TCDD1		X				
		D0	TCDD0		X				
Clock timer day (low-order) register	0040157 (B)	D7	TCND7	Clock timer day counter data (low-order 8 bits) TCND0 = LSB	0 to 65535 days (low-order 8 bits)		X	R/W	
		D6	TCND6		X				
		D5	TCND5		X				
		D4	TCND4		X				
		D3	TCND3		X				
		D2	TCND2		X				
		D1	TCND1		X				
		D0	TCND0		X				
Clock timer day (high-order) register	0040158 (B)	D7	TCND15	Clock timer day counter data (high-order 8 bits) TCND15 = MSB	0 to 65535 days (high-order 8 bits)		X	R/W	
		D6	TCND14		X				
		D5	TCND13		X				
		D4	TCND12		X				
		D3	TCND11		X				
		D2	TCND10		X				
		D1	TCND9		X				
		D0	TCND8		X				
Clock timer minute comparison register	0040159 (B)	D7-6	–	reserved	–	–	–	–	0 when being read.
		D5	TCCH5	Clock timer minute comparison data TCCH5 = MSB TCCH0 = LSB	0 to 59 minutes (Note) Can be set within 0–63.		X	R/W	
		D4	TCCH4		X				
		D3	TCCH3		X				
		D2	TCCH2		X				
		D1	TCCH1		X				
		D0	TCCH0		X				

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
Clock timer hour comparison register	004015A (B)	D7-5	–	reserved	–	–	–	0 when being read.
		D4	TCCD4	Clock timer hour comparison data	0 to 23 hours	X	R/W	
		D3	TCCD3	TCCD4 = MSB	(Note) Can be set within 0–31.	X		
		D2	TCCD2	TCCD0 = LSB		X		
		D1	TCCD1			X		
		D0	TCCD0			X		
Clock timer day comparison register	004015B (B)	D7-5	–	reserved	–	–	–	0 when being read.
		D4	TCCN4	Clock timer day comparison data	0 to 31 days	X	R/W	Compared with TCND[4:0].
		D3	TCCN3	TCCN4 = MSB		X		
		D2	TCCN2	TCCN0 = LSB		X		
		D1	TCCN1			X		
		D0	TCCN0			X		

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
8-bit timer 0 control register	0040160 (B)	D7-3	–	reserved	–	–	–	0 when being read.
		D2	PTOUT0	8-bit timer 0 clock output control	1 On 0 Off	0	R/W	
		D1	PSET0	8-bit timer 0 preset	1 Preset 0 Invalid	–	W	0 when being read.
		D0	PTRUN0	8-bit timer 0 Run/Stop control	1 Run 0 Stop	0	R/W	
8-bit timer 0 reload data register	0040161 (B)	D7	RLD07	8-bit timer 0 reload data RLD07 = MSB RLD00 = LSB	0 to 255	X	R/W	
		D6	RLD06			X		
		D5	RLD05			X		
		D4	RLD04			X		
		D3	RLD03			X		
		D2	RLD02			X		
		D1	RLD01			X		
		D0	RLD00			X		
8-bit timer 0 counter data register	0040162 (B)	D7	PTD07	8-bit timer 0 counter data PTD07 = MSB PTD00 = LSB	0 to 255	X	R	
		D6	PTD06			X		
		D5	PTD05			X		
		D4	PTD04			X		
		D3	PTD03			X		
		D2	PTD02			X		
		D1	PTD01			X		
		D0	PTD00			X		
8-bit timer 1 control register	0040164 (B)	D7-3	–	reserved	–	–	–	0 when being read.
		D2	PTOUT1	8-bit timer 1 clock output control	1 On 0 Off	0	R/W	
		D1	PSET1	8-bit timer 1 preset	1 Preset 0 Invalid	–	W	0 when being read.
		D0	PTRUN1	8-bit timer 1 Run/Stop control	1 Run 0 Stop	0	R/W	
8-bit timer 1 reload data register	0040165 (B)	D7	RLD17	8-bit timer 1 reload data RLD17 = MSB RLD10 = LSB	0 to 255	X	R/W	
		D6	RLD16			X		
		D5	RLD15			X		
		D4	RLD14			X		
		D3	RLD13			X		
		D2	RLD12			X		
		D1	RLD11			X		
		D0	RLD10			X		
8-bit timer 1 counter data register	0040166 (B)	D7	PTD17	8-bit timer 1 counter data PTD17 = MSB PTD10 = LSB	0 to 255	X	R	
		D6	PTD16			X		
		D5	PTD15			X		
		D4	PTD14			X		
		D3	PTD13			X		
		D2	PTD12			X		
		D1	PTD11			X		
		D0	PTD10			X		
8-bit timer 2 control register	0040168 (B)	D7-3	–	reserved	–	–	–	0 when being read.
		D2	PTOUT2	8-bit timer 2 clock output control	1 On 0 Off	0	R/W	
		D1	PSET2	8-bit timer 2 preset	1 Preset 0 Invalid	–	W	0 when being read.
		D0	PTRUN2	8-bit timer 2 Run/Stop control	1 Run 0 Stop	0	R/W	
8-bit timer 2 reload data register	0040169 (B)	D7	RLD27	8-bit timer 2 reload data RLD27 = MSB RLD20 = LSB	0 to 255	X	R/W	
		D6	RLD26			X		
		D5	RLD25			X		
		D4	RLD24			X		
		D3	RLD23			X		
		D2	RLD22			X		
		D1	RLD21			X		
		D0	RLD20			X		
8-bit timer 2 counter data register	004016A (B)	D7	PTD27	8-bit timer 2 counter data PTD27 = MSB PTD20 = LSB	0 to 255	X	R	
		D6	PTD26			X		
		D5	PTD25			X		
		D4	PTD24			X		
		D3	PTD23			X		
		D2	PTD22			X		
		D1	PTD21			X		
		D0	PTD20			X		

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
8-bit timer 3 control register	004016C (B)	D7-3	–	reserved	–	–	–	0 when being read.	
		D2	PTOUT3	8-bit timer 3 clock output control	1 On	0 Off	0	R/W	
		D1	PSET3	8-bit timer 3 preset	1 Preset	0 Invalid	–	W	0 when being read.
		D0	PTRUN3	8-bit timer 3 Run/Stop control	1 Run	0 Stop	0	R/W	
8-bit timer 3 reload data register	004016D (B)	D7	RLD37	8-bit timer 3 reload data RLD37 = MSB RLD30 = LSB	0 to 255		X	R/W	
		D6	RLD36				X		
		D5	RLD35				X		
		D4	RLD34				X		
		D3	RLD33				X		
		D2	RLD32				X		
		D1	RLD31				X		
		D0	RLD30				X		
8-bit timer 3 counter data register	004016E (B)	D7	PTD37	8-bit timer 3 counter data PTD37 = MSB PTD30 = LSB	0 to 255		X	R	
		D6	PTD36				X		
		D5	PTD35				X		
		D4	PTD34				X		
		D3	PTD33				X		
		D2	PTD32				X		
		D1	PTD31				X		
		D0	PTD30				X		

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Watchdog timer write-protect register	0040170 (B)	D7	WRWD	EWD write protection	1 Write enabled 0 Write-protect	0	R/W		
		D6-0	–	–	–	–	–	–	0 when being read.
Watchdog timer enable register	0040171 (B)	D7-2	–	–	–	–	–	–	0 when being read.
		D1	EWD	Watchdog timer enable	1 NMI enabled 0 NMI disabled	0	R/W		
		D0	–	–	–	–	–	–	0 when being read.

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
Power control register	0040180 (B)	D7	CLKDT1	System clock division ratio selection	CLKDT[1:0]		0	R/W		
		D6	CLKDT0		1	1				1/8
					1	0				1/4
					0	1				1/2
					0	0				1/1
		D5	PSCON	Prescaler On/Off control	1	On	0	Off	1	R/W
		D4-3	–	reserved	–		0	–	Writing 1 not allowed.	
		D2	CLKCHG	CPU operating clock switch	1	OSC3	0	OSC1	1	R/W
		D1	SOSC3	High-speed (OSC3) oscillation On/Off	1	On	0	Off	1	R/W
		D0	SOSC1	Low-speed (OSC1) oscillation On/Off	1	On	0	Off	1	R/W
Prescaler clock select register	0040181 (B)	D7-1	–	reserved	–		0	–		
		D0	PSCDT0	Prescaler clock selection	1	OSC1	0	OSC3/PLL	0	R/W
Clock option register	0040190 (B)	D7-4	–	–	–		–	–	0 when being read.	
		D3	HLT2OP	HALT clock option	1	On	0	Off	0	R/W
		D2	8T1ON	OSC3-stabilize waiting function	1	Off	0	On	1	R/W
		D1	–	reserved	–		0	–	Do not write 1.	
		D0	PF1ON	OSC1 external output control	1	On	0	Off	0	R/W
Power control protect register	004019E (B)	D7	CLGP7	Power control register protect flag	Writing 10010110 (0x96)		0	R/W		
		D6	CLGP6		removes the write protection of		0			
		D5	CLGP5		the power control register		0			
		D4	CLGP4		(0x40180).		0			
		D3	CLGP3		Writing another value set the		0			
		D2	CLGP2		write protection.		0			
		D1	CLGP1				0			
		D0	CLGP0				0			

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Serial I/F Ch.0 transmit data register	00401E0 (B)	D7	TXD07	Serial I/F Ch.0 transmit data TXD07(06) = MSB TXD00 = LSB	0x0 to 0xFF(0x7F)		X	R/W	7-bit asynchronous mode does not use TXD07.		
		D6	TXD06				X				
		D5	TXD05				X				
		D4	TXD04				X				
		D3	TXD03				X				
		D2	TXD02				X				
		D1	TXD01				X				
		D0	TXD00				X				
Serial I/F Ch.0 receive data register	00401E1 (B)	D7	RXD07	Serial I/F Ch.0 receive data RXD07(06) = MSB RXD00 = LSB	0x0 to 0xFF(0x7F)		X	R	7-bit asynchronous mode does not use RXD07 (fixed at 0).		
		D6	RXD06				X				
		D5	RXD05				X				
		D4	RXD04				X				
		D3	RXD03				X				
		D2	RXD02				X				
		D1	RXD01				X				
		D0	RXD00				X				
Serial I/F Ch.0 status register	00401E2 (B)	D7-6	–	–	–		–	–	0 when being read.		
		D5	TEND0	Ch.0 transmit-completion flag	1	Transmitting	0	End	0	R	
		D4	FER0	Ch.0 framing error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D3	PER0	Ch.0 parity error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D2	OER0	Ch.0 overrun error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE0	Ch.0 transmit data buffer empty	1	Empty	0	Buffer full	1	R	
		D0	RDBF0	Ch.0 receive data buffer full	1	Buffer full	0	Empty	0	R	
Serial I/F Ch.0 control register	00401E3 (B)	D7	TXEN0	Ch.0 transmit enable	1	Enabled	0	Disabled	0	R/W	
		D6	RXEN0	Ch.0 receive enable	1	Enabled	0	Disabled	0	R/W	
		D5	EPR0	Ch.0 parity enable	1	With parity	0	No parity	X	R/W	Valid only in asynchronous mode.
		D4	PMD0	Ch.0 parity mode selection	1	Odd	0	Even	X	R/W	
		D3	STPB0	Ch.0 stop bit selection	1	2 bits	0	1 bit	X	R/W	
		D2	SSCK0	Ch.0 input clock selection	1	#SCLK0	0	Internal clock	X	R/W	
		D1	SMD01	Ch.0 transfer mode selection	SMD0[1:0]		Transfer mode		X	R/W	
		D0	SMD00		1	1	8-bit asynchronous	X			
					1	0	7-bit asynchronous				
0	1				Clock sync. Slave						
0	0	Clock sync. Master									
Serial I/F Ch.0 IrDA register	00401E4 (B)	D7-5	–	–	–		–	–	0 when being read.		
		D4	DIVMD0	Ch.0 async. clock division ratio	1	1/8	0	1/16	X	R/W	
		D3	IRTL0	Ch.0 IrDA I/F output logic inversion	1	Inverted	0	Direct	X	R/W	Valid only in asynchronous mode.
		D2	IRRL0	Ch.0 IrDA I/F input logic inversion	1	Inverted	0	Direct	X	R/W	
		D1	IRMD01	Ch.0 interface mode selection	IRMD0[1:0]		I/F mode		X	R/W	
		D0	IRMD00		1	1	reserved				
1	0				IrDA 1.0						
0	1				reserved						
0	0	General I/F									

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Serial I/F Ch.1 transmit data register	00401E5 (B)	D7	TXD17	Serial I/F Ch.1 transmit data	0x0 to 0xFF(0x7F)	X	R/W	7-bit asynchronous mode does not use TXD17.			
		D6	TXD16	TXD17(16) = MSB							
		D5	TXD15	TXD10 = LSB							
		D4	TXD14								
		D3	TXD13								
		D2	TXD12								
		D1	TXD11								
		D0	TXD10								
Serial I/F Ch.1 receive data register	00401E6 (B)	D7	RXD17	Serial I/F Ch.1 receive data	0x0 to 0xFF(0x7F)	X	R	7-bit asynchronous mode does not use RXD17 (fixed at 0).			
		D6	RXD16	RXD17(16) = MSB							
		D5	RXD15	RXD10 = LSB							
		D4	RXD14								
		D3	RXD13								
		D2	RXD12								
		D1	RXD11								
		D0	RXD10								
Serial I/F Ch.1 status register	00401E7 (B)	D7-6	-	-	-	-	-	0 when being read.			
		D5	TEND1	Ch.1 transmit-completion flag	1	Transmitting	0	End	0	R	
		D4	FER1	Ch.1 flaming error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D3	PER1	Ch.1 parity error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D2	OER1	Ch.1 overrun error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE1	Ch.1 transmit data buffer empty	1	Empty	0	Buffer full	1	R	
		D0	RDBF1	Ch.1 receive data buffer full	1	Buffer full	0	Empty	0	R	
		Serial I/F Ch.1 control register	00401E8 (B)	D7	TXEN1	Ch.1 transmit enable	1	Enabled	0	Disabled	0
D6	RXEN1			Ch.1 receive enable	1	Enabled	0	Disabled	0	R/W	
D5	EPR1			Ch.1 parity enable	1	With parity	0	No parity	X	R/W	Valid only in asynchronous mode.
D4	PMD1			Ch.1 parity mode selection	1	Odd	0	Even	X	R/W	
D3	STPB1			Ch.1 stop bit selection	1	2 bits	0	1 bit	X	R/W	
D2	SSCK1			Ch.1 input clock selection	1	#SCLK1	0	Internal clock	X	R/W	
D1	SMD11			Ch.1 transfer mode selection	SMD1[1:0]		Transfer mode		X	R/W	
D0	SMD10				1	1	8-bit asynchronous				
		1	0		7-bit asynchronous						
		0	1		Clock sync. Slave						
0	0	Clock sync. Master									
Serial I/F Ch.1 IrDA register	00401E9 (B)	D7-5	-	-	-	-	-	0 when being read.			
		D4	DIVMD1	Ch.1 async. clock division ratio	1	1/8	0	1/16	X	R/W	
		D3	IRTL1	Ch.1 IrDA I/F output logic inversion	1	Inverted	0	Direct	X	R/W	Valid only in asynchronous mode.
		D2	IRRL1	Ch.1 IrDA I/F input logic inversion	1	Inverted	0	Direct	X	R/W	
		D1	IRMD11	Ch.1 interface mode selection	IRMD1[1:0]		I/F mode		X	R/W	
		D0	IRMD10		1	1	reserved				
					1	0	IrDA 1.0				
0	1				reserved						
0	0	General I/F									

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
A/D conversion result (low-order) register	0040240 (B)	D7	ADD7	A/D converted data (low-order 8 bits) ADD0 = LSB	0x0 to 0x3FF (low-order 8 bits)		0	R			
		D6	ADD6				0				
		D5	ADD5				0				
		D4	ADD4				0				
		D3	ADD3				0				
		D2	ADD2				0				
		D1	ADD1				0				
		D0	ADD0				0				
A/D conversion result (high-order) register	0040241 (B)	D7-2	–	–	–		–	–	0 when being read.		
		D1	ADD9	A/D converted data (high-order 2 bits) ADD9 = MSB	0x0 to 0x3FF (high-order 2 bits)		0	R			
D0	ADD8	0									
A/D trigger register	0040242 (B)	D7-6	–	–	–		–	–	0 when being read.		
		D5	MS	A/D conversion mode selection	1	Continuous	0	Normal	0	R/W	
		D4	TS1	A/D conversion trigger selection	TS[1:0]		Trigger		0	R/W	
		D3	TS0		1	1	#ADTRG pin	0			
					1	0	8-bit timer 0	0			
					0	1	16-bit timer 0	0			
					0	0	Software				
		D2	CH2	A/D conversion channel status	CH[2:0]		Channel		0	R	
		D1	CH1		1	1	1	AD7	0		
		D0	CH0		1	1	0	AD6	0		
		1	0		1	AD5					
		1	0		0	AD4					
		0	1		1	AD3					
			0	1	0	AD2					
			0	0	1	AD1					
			0	0	0	AD0					
A/D channel register	0040243 (B)	D7-6	–	–	–		–	–	0 when being read.		
		D5	CE2	A/D converter end channel selection	CE[2:0]		End channel		0	R/W	
		D4	CE1		1	1	1	AD7	0		
		D3	CE0		1	1	0	AD6	0		
					1	0	1	AD5			
					1	0	0	AD4			
					0	1	1	AD3			
					0	1	0	AD2			
					0	0	1	AD1			
					0	0	0	AD0			
		D2	CS2	A/D converter start channel selection	CS[2:0]		Start channel		0	R/W	
D1	CS1	1	1		1	AD7	0				
D0	CS0	1	1		0	AD6	0				
		1	0		1	AD5					
		1	0		0	AD4					
			0		1	1	AD3				
			0	1	0	AD2					
			0	0	1	AD1					
			0	0	0	AD0					
A/D enable register	0040244 (B)	D7-4	–	–	–		–	–	0 when being read.		
		D3	ADF	Conversion-complete flag	1	Completed	0	Run/Standby	0	R	Reset when ADD is read.
		D2	ADE	A/D enable	1	Enabled	0	Disabled	0	R/W	
		D1	ADST	A/D conversion control/status	1	Start/Run	0	Stop	0	R/W	
D0	OWE	Overwrite error flag	1	Error	0	Normal	0	R/W	Reset by writing 0.		
A/D sampling register	0040245 (B)	D7-2	–	–	–		–	–	0 when being read.		
		D1	ST1	Input signal sampling time setup	ST[1:0]		Sampling time		1	R/W	Use with 9 clocks.
		D0	ST0		1	1	9 clocks	1			
					1	0	7 clocks				
		0	1		5 clocks						
			0	0	3 clocks						

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Port input 0/1 interrupt priority register	0040260 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PP1L2	Port input 1 interrupt level	0 to 7	X	R/W		
		D5	PP1L1						
		D4	PP1L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PP0L2	Port input 0 interrupt level	0 to 7	X	R/W		
D1	PP0L1								
D0	PP0L0								
Port input 2/3 interrupt priority register	0040261 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PP3L2	Port input 3 interrupt level	0 to 7	X	R/W		
		D5	PP3L1						
		D4	PP3L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PP2L2	Port input 2 interrupt level	0 to 7	X	R/W		
D1	PP2L1								
D0	PP2L0								
Key input interrupt priority register	0040262 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PK1L2	Key input 1 interrupt level	0 to 7	X	R/W		
		D5	PK1L1						
		D4	PK1L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PK0L2	Key input 0 interrupt level	0 to 7	X	R/W		
D1	PK0L1								
D0	PK0L0								
High-speed DMA Ch.0/1 interrupt priority register	0040263 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PHSD1L2	High-speed DMA Ch.1 interrupt level	0 to 7	X	R/W		
		D5	PHSD1L1						
		D4	PHSD1L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PHSD0L2	High-speed DMA Ch.0 interrupt level	0 to 7	X	R/W		
D1	PHSD0L1								
D0	PHSD0L0								
High-speed DMA Ch.2/3 interrupt priority register	0040264 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	PHSD3L2	High-speed DMA Ch.3 interrupt level	0 to 7	X	R/W		
		D5	PHSD3L1						
		D4	PHSD3L0						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	PHSD2L2	High-speed DMA Ch.2 interrupt level	0 to 7	X	R/W		
D1	PHSD2L1								
D0	PHSD2L0								
IDMA interrupt priority register	0040265 (B)	D7–3	–	reserved	–	–	–	0 when being read.	
		D2	PDM2	IDMA interrupt level	0 to 7	X	R/W		
		D1	PDM1						
		D0	PDM0						
16-bit timer 0/1 interrupt priority register	0040266 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T12	16-bit timer 1 interrupt level	0 to 7	X	R/W		
		D5	P16T11						
		D4	P16T10						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	P16T02	16-bit timer 0 interrupt level	0 to 7	X	R/W		
D1	P16T01								
D0	P16T00								
16-bit timer 2/3 interrupt priority register	0040267 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T32	16-bit timer 3 interrupt level	0 to 7	X	R/W		
		D5	P16T31						
		D4	P16T30						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	P16T22	16-bit timer 2 interrupt level	0 to 7	X	R/W		
D1	P16T21								
D0	P16T20								
16-bit timer 4/5 interrupt priority register	0040268 (B)	D7	–	reserved	–	–	–	0 when being read.	
		D6	P16T52	16-bit timer 5 interrupt level	0 to 7	X	R/W		
		D5	P16T51						
		D4	P16T50						
		D3	–	reserved	–	–	–	–	0 when being read.
		D2	P16T42	16-bit timer 4 interrupt level	0 to 7	X	R/W		
D1	P16T41								
D0	P16T40								

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
8-bit timer, serial I/F Ch.0 interrupt priority register	0040269 (B)	D7	–	reserved	–	–	–	0 when being read.
		D6	PSIO02	Serial interface Ch.0	0 to 7	X	R/W	
		D5	PSIO01	interrupt level		X		
		D4	PSIO00			X		
		D3	–	reserved	–	–	–	0 when being read.
		D2	P8TM2	8-bit timer 0–3 interrupt level	0 to 7	X	R/W	
		D1	P8TM1			X		
D0	P8TM0			X				
Serial I/F Ch.1, A/D interrupt priority register	004026A (B)	D7	–	reserved	–	–	–	0 when being read.
		D6	PAD2	A/D converter interrupt level	0 to 7	X	R/W	
		D5	PAD1			X		
		D4	PAD0			X		
		D3	–	reserved	–	–	–	0 when being read.
		D2	PSIO12	Serial interface Ch.1	0 to 7	X	R/W	
		D1	PSIO11	interrupt level		X		
D0	PSIO10			X				
Clock timer interrupt priority register	004026B (B)	D7–3	–	reserved	–	–	–	Writing 1 not allowed.
		D2	PCTM2	Clock timer interrupt level	0 to 7	X	R/W	
		D1	PCTM1			X		
		D0	PCTM0			X		
Port input 4/5 interrupt priority register	004026C (B)	D7	–	reserved	–	–	–	0 when being read.
		D6	PP5L2	Port input 5 interrupt level	0 to 7	X	R/W	
		D5	PP5L1			X		
		D4	PP5L0			X		
		D3	–	reserved	–	–	–	0 when being read.
		D2	PP4L2	Port input 4 interrupt level	0 to 7	X	R/W	
		D1	PP4L1			X		
D0	PP4L0			X				
Port input 6/7 interrupt priority register	004026D (B)	D7	–	reserved	–	–	–	0 when being read.
		D6	PP7L2	Port input 7 interrupt level	0 to 7	X	R/W	
		D5	PP7L1			X		
		D4	PP7L0			X		
		D3	–	reserved	–	–	–	0 when being read.
		D2	PP6L2	Port input 6 interrupt level	0 to 7	X	R/W	
		D1	PP6L1			X		
D0	PP6L0			X				

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Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks						
Key input, port input 0-3 interrupt enable register	0040270 (B)	D7-6	-	reserved	1	Enabled	0	Disabled	-	-	0 when being read.				
		D5	EK1	Key input 1					0	R/W					
		D4	EK0	Key input 0					0	R/W					
		D3	EP3	Port input 3					0	R/W					
		D2	EP2	Port input 2					0	R/W					
		D1	EP1	Port input 1					0	R/W					
		D0	EP0	Port input 0					0	R/W					
DMA interrupt enable register	0040271 (B)	D7-5	-	reserved	1	Enabled	0	Disabled	-	-	0 when being read.				
		D4	EIDMA	IDMA					0	R/W					
		D3	EHDM3	High-speed DMA Ch.3					0	R/W					
		D2	EHDM2	High-speed DMA Ch.2					0	R/W					
		D1	EHDM1	High-speed DMA Ch.1					0	R/W					
		D0	EHDM0	High-speed DMA Ch.0					0	R/W					
16-bit timer 0/1 interrupt enable register	0040272 (B)	D7	E16TC1	16-bit timer 1 comparison A	1	Enabled	0	Disabled	0	R/W	0 when being read.				
		D6	E16TU1	16-bit timer 1 comparison B					0	R/W					
		D5-4	-	reserved					-	-					
		D3	E16TC0	16-bit timer 0 comparison A					1	Enabled		0	Disabled	0	R/W
		D2	E16TU0	16-bit timer 0 comparison B					0	R/W					
		D1-0	-	reserved					-	-					
16-bit timer 2/3 interrupt enable register	0040273 (B)	D7	E16TC3	16-bit timer 3 comparison A	1	Enabled	0	Disabled	0	R/W	0 when being read.				
		D6	E16TU3	16-bit timer 3 comparison B					0	R/W					
		D5-4	-	reserved					-	-					
		D3	E16TC2	16-bit timer 2 comparison A					1	Enabled		0	Disabled	0	R/W
		D2	E16TU2	16-bit timer 2 comparison B					0	R/W					
		D1-0	-	reserved					-	-					
16-bit timer 4/5 interrupt enable register	0040274 (B)	D7	E16TC5	16-bit timer 5 comparison A	1	Enabled	0	Disabled	0	R/W	0 when being read.				
		D6	E16TU5	16-bit timer 5 comparison B					0	R/W					
		D5-4	-	reserved					-	-					
		D3	E16TC4	16-bit timer 4 comparison A					1	Enabled		0	Disabled	0	R/W
		D2	E16TU4	16-bit timer 4 comparison B					0	R/W					
		D1-0	-	reserved					-	-					
8-bit timer interrupt enable register	0040275 (B)	D7-4	-	reserved	1	Enabled	0	Disabled	-	-	0 when being read.				
		D3	E8TU3	8-bit timer 3 underflow					0	R/W					
		D2	E8TU2	8-bit timer 2 underflow					0	R/W					
		D1	E8TU1	8-bit timer 1 underflow					0	R/W					
		D0	E8TU0	8-bit timer 0 underflow					0	R/W					
Serial I/F interrupt enable register	0040276 (B)	D7-6	-	reserved	1	Enabled	0	Disabled	-	-	0 when being read.				
		D5	ESTX1	SIF Ch.1 transmit buffer empty					0	R/W					
		D4	ESRX1	SIF Ch.1 receive buffer full					0	R/W					
		D3	ESERR1	SIF Ch.1 receive error					0	R/W					
		D2	ESTX0	SIF Ch.0 transmit buffer empty					0	R/W					
		D1	ESRX0	SIF Ch.0 receive buffer full					0	R/W					
		D0	ESERR0	SIF Ch.0 receive error					0	R/W					
Port input 4-7, clock timer, A/D interrupt enable register	0040277 (B)	D7-6	-	reserved	1	Enabled	0	Disabled	-	-	0 when being read.				
		D5	EP7	Port input 7					0	R/W					
		D4	EP6	Port input 6					0	R/W					
		D3	EP5	Port input 5					0	R/W					
		D2	EP4	Port input 4					0	R/W					
		D1	ECTM	Clock timer					0	R/W					
		D0	EADE	A/D converter					0	R/W					

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks					
Key input, port input 0–3 interrupt factor flag register	0040280 (B)	D7–6	–	reserved			–	–	0 when being read.					
		D5	FK1	Key input 1	1	Factor is generated	0	No factor is generated	X	R/W				
		D4	FK0	Key input 0					X	R/W				
		D3	FP3	Port input 3					X	R/W				
		D2	FP2	Port input 2					X	R/W				
		D1	FP1	Port input 1					X	R/W				
		D0	FP0	Port input 0					X	R/W				
DMA interrupt factor flag register	0040281 (B)	D7–5	–	reserved							–	–	0 when being read.	
		D4	FIDMA	IDMA	1	Factor is generated	0	No factor is generated	X	R/W				
		D3	FHDM3	High-speed DMA Ch.3					X	R/W				
		D2	FHDM2	High-speed DMA Ch.2					X	R/W				
		D1	FHDM1	High-speed DMA Ch.1					X	R/W				
		D0	FHDM0	High-speed DMA Ch.0					X	R/W				
16-bit timer 0/1 interrupt factor flag register	0040282 (B)	D7	F16TC1	16-bit timer 1 comparison A					1	Factor is generated	0	No factor is generated	X	R/W
		D6	F16TU1	16-bit timer 1 comparison B	X	R/W								
		D5–4	–	reserved			–	–					0 when being read.	
		D3	F16TC0	16-bit timer 0 comparison A	1	Factor is generated	0	No factor is generated					X	R/W
		D2	F16TU0	16-bit timer 0 comparison B									X	R/W
		D1–0	–	reserved										
16-bit timer 2/3 interrupt factor flag register	0040283 (B)	D7	F16TC3	16-bit timer 3 comparison A	1	Factor is generated	0	No factor is generated	X	R/W				
		D6	F16TU3	16-bit timer 3 comparison B					X	R/W				
		D5–4	–	reserved							–	–	0 when being read.	
		D3	F16TC2	16-bit timer 2 comparison A					1	Factor is generated	0	No factor is generated	X	R/W
		D2	F16TU2	16-bit timer 2 comparison B									X	R/W
		D1–0	–	reserved										
16-bit timer 4/5 interrupt factor flag register	0040284 (B)	D7	F16TC5	16-bit timer 5 comparison A	1	Factor is generated	0	No factor is generated	X	R/W				
		D6	F16TU5	16-bit timer 5 comparison B					X	R/W				
		D5–4	–	reserved							–	–	0 when being read.	
		D3	F16TC4	16-bit timer 4 comparison A					1	Factor is generated	0	No factor is generated	X	R/W
		D2	F16TU4	16-bit timer 4 comparison B									X	R/W
D1–0	–	reserved			–	–	0 when being read.							
8-bit timer interrupt factor flag register	0040285 (B)	D7–4	–	reserved			–	–	0 when being read.					
		D3	F8TU3	8-bit timer 3 underflow	1	Factor is generated	0	No factor is generated	X	R/W				
		D2	F8TU2	8-bit timer 2 underflow					X	R/W				
		D1	F8TU1	8-bit timer 1 underflow					X	R/W				
		D0	F8TU0	8-bit timer 0 underflow					X	R/W				
Serial I/F interrupt factor flag register	0040286 (B)	D7–6	–	reserved			–	–	0 when being read.					
		D5	FSTX1	SIF Ch.1 transmit buffer empty	1	Factor is generated	0	No factor is generated	X	R/W				
		D4	FSRX1	SIF Ch.1 receive buffer full					X	R/W				
		D3	FSERR1	SIF Ch.1 receive error					X	R/W				
		D2	FSTX0	SIF Ch.0 transmit buffer empty					X	R/W				
		D1	FSRX0	SIF Ch.0 receive buffer full					X	R/W				
		D0	FSERR0	SIF Ch.0 receive error					X	R/W				
Port input 4–7, clock timer, A/D interrupt factor flag register	0040287 (B)	D7–6	–	reserved			–	–	0 when being read.					
		D5	FP7	Port input 7	1	Factor is generated	0	No factor is generated	X	R/W				
		D4	FP6	Port input 6					X	R/W				
		D3	FP5	Port input 5					X	R/W				
		D2	FP4	Port input 4					X	R/W				
		D1	FCTM	Clock timer					X	R/W				
		D0	FADE	A/D converter					X	R/W				

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA request register	0040290 (B)	D7	R16TC0	16-bit timer 0 comparison A	1 IDMA request	0	Interrupt request	0	R/W
		D6	R16TU0	16-bit timer 0 comparison B				0	R/W
		D5	RHDM1	High-speed DMA Ch.1				0	R/W
		D4	RHDM0	High-speed DMA Ch.0				0	R/W
		D3	RP3	Port input 3				0	R/W
		D2	RP2	Port input 2				0	R/W
		D1	RP1	Port input 1				0	R/W
		D0	RP0	Port input 0				0	R/W
16-bit timer 1–4 IDMA request register	0040291 (B)	D7	R16TC4	16-bit timer 4 comparison A	1 IDMA request	0	Interrupt request	0	R/W
		D6	R16TU4	16-bit timer 4 comparison B				0	R/W
		D5	R16TC3	16-bit timer 3 comparison A				0	R/W
		D4	R16TU3	16-bit timer 3 comparison B				0	R/W
		D3	R16TC2	16-bit timer 2 comparison A				0	R/W
		D2	R16TU2	16-bit timer 2 comparison B				0	R/W
		D1	R16TC1	16-bit timer 1 comparison A				0	R/W
		D0	R16TU1	16-bit timer 1 comparison B				0	R/W
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA request register	0040292 (B)	D7	RSTX0	SIF Ch.0 transmit buffer empty	1 IDMA request	0	Interrupt request	0	R/W
		D6	RSRX0	SIF Ch.0 receive buffer full				0	R/W
		D5	R8TU3	8-bit timer 3 underflow				0	R/W
		D4	R8TU2	8-bit timer 2 underflow				0	R/W
		D3	R8TU1	8-bit timer 1 underflow				0	R/W
		D2	R8TU0	8-bit timer 0 underflow				0	R/W
		D1	R16TC5	16-bit timer 5 comparison A				0	R/W
		D0	R16TU5	16-bit timer 5 comparison B				0	R/W
Serial I/F Ch.1, A/D, port input 4–7 IDMA request register	0040293 (B)	D7	RP7	Port input 7	1 IDMA request	0	Interrupt request	0	R/W
		D6	RP6	Port input 6				0	R/W
		D5	RP5	Port input 5				0	R/W
		D4	RP4	Port input 4				0	R/W
		D3	–	reserved	–	–	0 when being read.		
		D2	RADE	A/D converter	1 IDMA request	0	Interrupt request	0	R/W
		D1	RSTX1	SIF Ch.1 transmit buffer empty				0	R/W
		D0	RSRX1	SIF Ch.1 receive buffer full				0	R/W
Port input 0–3, high-speed DMA, 16-bit timer 0 IDMA enable register	0040294 (B)	D7	DE16TC0	16-bit timer 0 comparison A	1 IDMA enabled	0	IDMA disabled	0	R/W
		D6	DE16TU0	16-bit timer 0 comparison B				0	R/W
		D5	DEHDM1	High-speed DMA Ch.1				0	R/W
		D4	DEHDM0	High-speed DMA Ch.0				0	R/W
		D3	DEP3	Port input 3				0	R/W
		D2	DEP2	Port input 2				0	R/W
		D1	DEP1	Port input 1				0	R/W
		D0	DEP0	Port input 0				0	R/W
16-bit timer 1–4 IDMA enable register	0040295 (B)	D7	DE16TC4	16-bit timer 4 comparison A	1 IDMA enabled	0	IDMA disabled	0	R/W
		D6	DE16TU4	16-bit timer 4 comparison B				0	R/W
		D5	DE16TC3	16-bit timer 3 comparison A				0	R/W
		D4	DE16TU3	16-bit timer 3 comparison B				0	R/W
		D3	DE16TC2	16-bit timer 2 comparison A				0	R/W
		D2	DE16TU2	16-bit timer 2 comparison B				0	R/W
		D1	DE16TC1	16-bit timer 1 comparison A				0	R/W
		D0	DE16TU1	16-bit timer 1 comparison B				0	R/W
16-bit timer 5, 8-bit timer, serial I/F Ch.0 IDMA enable register	0040296 (B)	D7	DESTX0	SIF Ch.0 transmit buffer empty	1 IDMA enabled	0	IDMA disabled	0	R/W
		D6	DESRX0	SIF Ch.0 receive buffer full				0	R/W
		D5	DE8TU3	8-bit timer 3 underflow				0	R/W
		D4	DE8TU2	8-bit timer 2 underflow				0	R/W
		D3	DE8TU1	8-bit timer 1 underflow				0	R/W
		D2	DE8TU0	8-bit timer 0 underflow				0	R/W
		D1	DE16TC5	16-bit timer 5 comparison A				0	R/W
		D0	DE16TU5	16-bit timer 5 comparison B				0	R/W
Serial I/F Ch.1, A/D, port input 4–7 IDMA enable register	0040297 (B)	D7	DEP7	Port input 7	1 IDMA enabled	0	IDMA disabled	0	R/W
		D6	DEP6	Port input 6				0	R/W
		D5	DEP5	Port input 5				0	R/W
		D4	DEP4	Port input 4				0	R/W
		D3	–	reserved	–	–	0 when being read.		
		D2	DEADE	A/D converter	1 IDMA enabled	0	IDMA disabled	0	R/W
		D1	DESTX1	SIF Ch.1 transmit buffer empty				0	R/W
		D0	DESRX1	SIF Ch.1 receive buffer full				0	R/W

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
High-speed DMA Ch.0/1 trigger set-up register	0040298 (B)	D7	HSD1S3	High-speed DMA Ch.1 trigger set-up	0	Software trigger	0	R/W		
		D6	HSD1S2		1	K51 input (falling edge)	0			
D5	HSD1S1	2	K51 input (rising edge)		0					
D4	HSD1S0	3	Port 1 input		0					
					4	Port 5 input				
					5	8-bit timer Ch.1 underflow				
					6	16-bit timer Ch.1 compare B				
					7	16-bit timer Ch.1 compare A				
					8	16-bit timer Ch.5 compare B				
					9	16-bit timer Ch.5 compare A				
					A	SI/F Ch.1 Rx buffer full				
					B	SI/F Ch.1 Tx buffer empty				
					C	A/D conversion completion				
High-speed DMA Ch.2/3 trigger set-up register	0040299 (B)	D3	HSD0S3	High-speed DMA Ch.0 trigger set-up	0	Software trigger	0	R/W		
		D2	HSD0S2		1	K50 input (falling edge)	0			
D1	HSD0S1	2	K50 input (rising edge)		0					
D0	HSD0S0	3	Port 0 input		0					
					4	Port 4 input				
					5	8-bit timer Ch.0 underflow				
					6	16-bit timer Ch.0 compare B				
					7	16-bit timer Ch.0 compare A				
					8	16-bit timer Ch.4 compare B				
					9	16-bit timer Ch.4 compare A				
					A	SI/F Ch.0 Rx buffer full				
					B	SI/F Ch.0 Tx buffer empty				
					C	A/D conversion completion				
High-speed DMA Ch.2/3 trigger set-up register	004029A (B)	D7	HSD3S3	High-speed DMA Ch.3 trigger set-up	0	Software trigger	0	R/W		
		D6	HSD3S2		1	K54 input (falling edge)	0			
D5	HSD3S1	2	K54 input (rising edge)		0					
D4	HSD3S0	3	Port 3 input		0					
					4	Port 7 input				
					5	8-bit timer Ch.3 underflow				
					6	16-bit timer Ch.3 compare B				
					7	16-bit timer Ch.3 compare A				
					8	16-bit timer Ch.5 compare B				
					9	16-bit timer Ch.5 compare A				
					A	SI/F Ch.1 Rx buffer full				
					B	SI/F Ch.1 Tx buffer empty				
					C	A/D conversion completion				
High-speed DMA software trigger register	004029A (B)	D7-4	–	reserved	–	–	–	–	0 when being read.	
		D3	HST3	HSDMA Ch.3 software trigger	1	Trigger	0	Invalid	0	W
		D2	HST2	HSDMA Ch.2 software trigger				0	W	
		D1	HST1	HSDMA Ch.1 software trigger				0	W	
		D0	HST0	HSDMA Ch.0 software trigger				0	W	
Flag set/reset method select register	004029F (B)	D7-3	–	reserved	–	–	–	–		
		D2	DENONLY	IDMA enable register set method selection	1	Set only	0	RD/WR	1	R/W
		D1	IDMAONLY	IDMA request register set method selection	1	Set only	0	RD/WR	1	R/W
		D0	RSTONLY	Interrupt factor flag reset method selection	1	Reset only	0	RD/WR	1	R/W

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Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks		
K5 function select register	00402C0 (B)	D7-5	–	reserved	–		–	–	0 when being read.		
		D4	CFK54	K54 function selection	1	#DMAREQ3	0	K54		0	R/W
		D3	CFK53	K53 function selection	1	#DMAREQ2	0	K53		0	R/W
		D2	CFK52	K52 function selection	1	#ADTRG	0	K52		0	R/W
		D1	CFK51	K51 function selection	1	#DMAREQ1	0	K51		0	R/W
		D0	CFK50	K50 function selection	1	#DMAREQ0	0	K50		0	R/W
K5 input port data register	00402C1 (B)	D7-5	–	reserved	–		–	–	0 when being read.		
		D4	K54D	K54 input port data	1	High	0	Low		–	R
		D3	K53D	K53 input port data						–	R
		D2	K52D	K52 input port data						–	R
		D1	K51D	K51 input port data						–	R
		D0	K50D	K50 input port data						–	R
K6 function select register	00402C3 (B)	D7	CFK67	K67 function selection	1	AD7	0	K67	0	R/W	
		D6	CFK66	K66 function selection	1	AD6	0	K66	0	R/W	
		D5	CFK65	K65 function selection	1	AD5	0	K65	0	R/W	
		D4	CFK64	K64 function selection	1	AD4	0	K64	0	R/W	
		D3	CFK63	K63 function selection	1	AD3	0	K63	0	R/W	
		D2	CFK62	K62 function selection	1	AD2	0	K62	0	R/W	
		D1	CFK61	K61 function selection	1	AD1	0	K61	0	R/W	
		D0	CFK60	K60 function selection	1	AD0	0	K60	0	R/W	
K6 input port data register	00402C4 (B)	D7	K67D	K67 input port data	1	High	0	Low	–	R	
		D6	K66D	K66 input port data					–	R	
		D5	K65D	K65 input port data					–	R	
		D4	K64D	K64 input port data					–	R	
		D3	K63D	K63 input port data					–	R	
		D2	K62D	K62 input port data					–	R	
		D1	K61D	K61 input port data					–	R	
		D0	K60D	K60 input port data					–	R	

Register name	Address	Bit	Name	Function	Setting				Init.	R/W	Remarks
Port input interrupt select register 1	00402C6 (B)	D7	SPT31	FPT3 interrupt input port selection	11	10	01	00	0	R/W	
		D6	SPT30		P23	P03	K53	K63	0		
		D5	SPT21	FPT2 interrupt input port selection	11	10	01	00	0	R/W	
		D4	SPT20		P22	P02	K52	K62	0		
		D3	SPT11	FPT1 interrupt input port selection	11	10	01	00	0	R/W	
		D2	SPT10		P21	P01	K51	K61	0		
		D1	SPT01	FPT0 interrupt input port selection	11	10	01	00	0	R/W	
D0	SPT00		P20	P00	K50	K60	0				
Port input interrupt select register 2	00402C7 (B)	D7	SPT71	FPT7 interrupt input port selection	11	10	01	00	0	R/W	
		D6	SPT70		P27	P07	P33	K67	0		
		D5	SPT61	FPT6 interrupt input port selection	11	10	01	00	0	R/W	
		D4	SPT60		P26	P06	P32	K66	0		
		D3	SPT51	FPT5 interrupt input port selection	11	10	01	00	0	R/W	
		D2	SPT50		P25	P05	P31	K65	0		
		D1	SPT41	FPT4 interrupt input port selection	11	10	01	00	0	R/W	
D0	SPT40		P24	P04	K54	K64	0				
Port input interrupt input polarity select register	00402C8 (B)	D7	SPPT7	FPT7 input polarity selection	1	High level or Rising edge	0	Low level or Falling edge	1	R/W	
		D6	SPPT6	FPT6 input polarity selection					1	R/W	
		D5	SPPT5	FPT5 input polarity selection					1	R/W	
		D4	SPPT4	FPT4 input polarity selection					1	R/W	
		D3	SPPT3	FPT3 input polarity selection					1	R/W	
		D2	SPPT2	FPT2 input polarity selection					1	R/W	
		D1	SPPT1	FPT1 input polarity selection					1	R/W	
		D0	SPPT0	FPT0 input polarity selection					1	R/W	
Port input interrupt edge/level select register	00402C9 (B)	D7	SEPT7	FPT7 edge/level selection	1	Edge	0	Level	1	R/W	
		D6	SEPT6	FPT6 edge/level selection					1	R/W	
		D5	SEPT5	FPT5 edge/level selection					1	R/W	
		D4	SEPT4	FPT4 edge/level selection					1	R/W	
		D3	SEPT3	FPT3 edge/level selection					1	R/W	
		D2	SEPT2	FPT2 edge/level selection					1	R/W	
		D1	SEPT1	FPT1 edge/level selection					1	R/W	
		D0	SEPT0	FPT0 edge/level selection					1	R/W	
Key input interrupt select register	00402CA (B)	D7-4	-	reserved	-				-	-	0 when being read.
		D3	SPPK11	FPK1 interrupt input port selection	11	10	01	00	0	R/W	
		D2	SPPK10		P2[7:4]	P0[7:4]	K6[7:4]	K6[3:0]	0		
		D1	SPPK01	FPK0 interrupt input port selection	11	10	01	00	0	R/W	
		D0	SPPK00		P2[4:0]	P0[4:0]	K6[4:0]	K5[4:0]	0		
Key input interrupt (FPK0) input comparison register	00402CC (B)	D7-5	-	reserved	-				-	-	0 when being read.
		D4	SCPCK04	FPK04 input comparison	1	High	0	Low	0	R/W	
		D3	SCPCK03	FPK03 input comparison					0	R/W	
		D2	SCPCK02	FPK02 input comparison					0	R/W	
		D1	SCPCK01	FPK01 input comparison					0	R/W	
D0	SCPCK00	FPK00 input comparison	0	R/W							
Key input interrupt (FPK1) input comparison register	00402CD (B)	D7-4	-	reserved	-				-	-	0 when being read.
		D3	SCPCK13	FPK13 input comparison	1	High	0	Low	0	R/W	
		D2	SCPCK12	FPK12 input comparison					0	R/W	
		D1	SCPCK11	FPK11 input comparison					0	R/W	
D0	SCPCK10	FPK10 input comparison	0	R/W							
Key input interrupt (FPK0) input mask register	00402CE (B)	D7-5	-	reserved	-				-	-	0 when being read.
		D4	SMPK04	FPK04 input mask	1	Interrupt enabled	0	Interrupt disabled	0	R/W	
		D3	SMPK03	FPK03 input mask					0	R/W	
		D2	SMPK02	FPK02 input mask					0	R/W	
		D1	SMPK01	FPK01 input mask					0	R/W	
D0	SMPK00	FPK00 input mask	0	R/W							
Key input interrupt (FPK1) input mask register	00402CF (B)	D7-4	-	reserved	-				-	-	0 when being read.
		D3	SMPK13	FPK13 input mask	1	Interrupt enabled	0	Interrupt disabled	0	R/W	
		D2	SMPK12	FPK12 input mask					0	R/W	
		D1	SMPK11	FPK11 input mask					0	R/W	
D0	SMPK10	FPK10 input mask	0	R/W							

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
P0 function select register	00402D0 (B)	D7	CFP07	P07 function selection	1 #SRDY1	0 P07	0	R/W	Extended functions (0x402DF)	
		D6	CFP06	P06 function selection	1 #SCLK1	0 P06	0	R/W		
		D5	CFP05	P05 function selection	1 SOUT1	0 P05	0	R/W		
		D4	CFP04	P04 function selection	1 SIN1	0 P04	0	R/W		
		D3	CFP03	P03 function selection	1 #SRDY0	0 P03	0	R/W		
		D2	CFP02	P02 function selection	1 #SCLK0	0 P02	0	R/W		
		D1	CFP01	P01 function selection	1 SOUT0	0 P01	0	R/W		
		D0	CFP00	P00 function selection	1 SIN0	0 P00	0	R/W		
P0 I/O port data register	00402D1 (B)	D7	P07D	P07 I/O port data	1 High	0 Low	0	R/W		
		D6	P06D	P06 I/O port data			0	R/W		
		D5	P05D	P05 I/O port data			0	R/W		
		D4	P04D	P04 I/O port data			0	R/W		
		D3	P03D	P03 I/O port data			0	R/W		
		D2	P02D	P02 I/O port data			0	R/W		
		D1	P01D	P01 I/O port data			0	R/W		
		D0	P00D	P00 I/O port data			0	R/W		
P0 I/O control register	00402D2 (B)	D7	IOC07	P07 I/O control	1 Output	0 Input	0	R/W		
		D6	IOC06	P06 I/O control			0	R/W		
		D5	IOC05	P05 I/O control			0	R/W		
		D4	IOC04	P04 I/O control			0	R/W		
		D3	IOC03	P03 I/O control			0	R/W		
		D2	IOC02	P02 I/O control			0	R/W		
		D1	IOC01	P01 I/O control			0	R/W		
		D0	IOC00	P00 I/O control			0	R/W		
P1 function select register	00402D4 (B)	D7	–	reserved	–		–	–	0 when being read.	
		D6	CFP16	P16 function selection	1 EXCL5 #DMAEND1	0 P16	0	R/W	Extended functions (0x402DF)	
		D5	CFP15	P15 function selection	1 EXCL4 #DMAEND0	0 P15	0	R/W		
		D4	CFP14	P14 function selection	1 FOSC1	0 P14	0	R/W		
		D3	CFP13	P13 function selection	1 EXCL3 T8UF3	0 P13	0	R/W		
		D2	CFP12	P12 function selection	1 EXCL2 T8UF2	0 P12	0	R/W		
		D1	CFP11	P11 function selection	1 EXCL1 T8UF1	0 P11	0	R/W		
		D0	CFP10	P10 function selection	1 EXCL0 T8UF0	0 P10	0	R/W		
P1 I/O port data register	00402D5 (B)	D7	–	reserved	–		–	–	0 when being read.	
		D6	P16D	P16 I/O port data	1 High	0 Low	0	R/W		
		D5	P15D	P15 I/O port data			0	R/W		
		D4	P14D	P14 I/O port data			0	R/W		
		D3	P13D	P13 I/O port data			0	R/W		
		D2	P12D	P12 I/O port data			0	R/W		
		D1	P11D	P11 I/O port data			0	R/W		
		D0	P10D	P10 I/O port data			0	R/W		
P1 I/O control register	00402D6 (B)	D7	–	reserved			–			–
		D6	IOC16	P16 I/O control	1 Output	0 Input	0	R/W		
		D5	IOC15	P15 I/O control			0	R/W		
		D4	IOC14	P14 I/O control			0	R/W		
		D3	IOC13	P13 I/O control			0	R/W		
		D2	IOC12	P12 I/O control			0	R/W		
		D1	IOC11	P11 I/O control			0	R/W		
		D0	IOC10	P10 I/O control			0	R/W		
P2 function select register	00402D8 (B)	D7	CFP27	P27 function selection			1 TM5	0 P27		0
		D6	CFP26	P26 function selection	1 TM4	0 P26	0	R/W		
		D5	CFP25	P25 function selection	1 TM3	0 P25	0	R/W		
		D4	CFP24	P24 function selection	1 TM2	0 P24	0	R/W		
		D3	CFP23	P23 function selection	1 TM1	0 P23	0	R/W		
		D2	CFP22	P22 function selection	1 TM0	0 P22	0	R/W		
		D1	CFP21	P21 function selection	1 #DWE	0 P21	0	R/W	Ext. func.(0x402DF)	
		D0	CFP20	P20 function selection	1 #DRD	0 P20	0	R/W		
P2 I/O port data register	00402D9 (B)	D7	P27D	P27 I/O port data	1 High	0 Low	0	R/W		
		D6	P26D	P26 I/O port data			0	R/W		
		D5	P25D	P25 I/O port data			0	R/W		
		D4	P24D	P24 I/O port data			0	R/W		
		D3	P23D	P23 I/O port data			0	R/W		
		D2	P22D	P22 I/O port data			0	R/W		
		D1	P21D	P21 I/O port data			0	R/W		
		D0	P20D	P20 I/O port data			0	R/W		

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks			
P2 I/O control register	00402DA (B)	D7	IOC27	P27 I/O control	1	Output	0	Input	0	R/W		
		D6	IOC26	P26 I/O control					0	R/W		
		D5	IOC25	P25 I/O control					0	R/W		
		D4	IOC24	P24 I/O control					0	R/W		
		D3	IOC23	P23 I/O control					0	R/W		
		D2	IOC22	P22 I/O control					0	R/W		
		D1	IOC21	P21 I/O control					0	R/W		
		D0	IOC20	P20 I/O control					0	R/W		
P3 function select register	00402DC (B)	D7-6	-	reserved			-	-	0 when being read.			
		D5	CFP35	P35 function selection	1	#BUSACK	0	P35	0	R/W		
		D4	CFP34	P34 function selection	1	#BUSREQ #CE6	0	P34	0	R/W		
		D3	CFP33	P33 function selection	1	#DMAACK1	0	P33	0	R/W		
		D2	CFP32	P32 function selection	1	#DMAACK0	0	P32	0	R/W		
		D1	CFP31	P31 function selection	1	#BUSGET	0	P31	0	R/W		Ext. func.(0x402DF)
		D0	CFP30	P30 function selection	1	#WAIT #CE4/#CE5	0	P30	0	R/W		
P3 I/O port data register	00402DD (B)	D7-6	-	reserved			-	-	0 when being read.			
		D5	P35D	P35 I/O port data	1	High	0	Low	0	R/W		
		D4	P34D	P34 I/O port data					0	R/W		
		D3	P33D	P33 I/O port data					0	R/W		
		D2	P32D	P32 I/O port data					0	R/W		
		D1	P31D	P31 I/O port data					0	R/W		
		D0	P30D	P30 I/O port data					0	R/W		
P3 I/O control register	00402DE (B)	D7-6	-	reserved								-
		D5	IOC35	P35 I/O control	1	Output	0	Input	0	R/W		
		D4	IOC34	P34 I/O control					0	R/W		
		D3	IOC33	P33 I/O control					0	R/W		
		D2	IOC32	P32 I/O control					0	R/W		
		D1	IOC31	P31 I/O control					0	R/W		
		D0	IOC30	P30 I/O control					0	R/W		
Port function extension register	00402DF (B)	D7	CFEX7	P07 port extended function					1	#DMAEND3		0
		D6	CFEX6	P06 port extended function	1	#DMAACK3	0	P06, etc.	0	R/W		
		D5	CFEX5	P05 port extended function	1	#DMAEND2	0	P05, etc.	0	R/W		
		D4	CFEX4	P04 port extended function	1	#DMAACK2	0	P04, etc.	0	R/W		
		D3	CFEX3	P31 port extended function	1	#GARD	0	P31, etc.	0	R/W		
		D2	CFEX2	P21 port extended function	1	#GAAS	0	P21, etc.	0	R/W		
		D1	CFEX1	P10, P11, P13 port extended function	1	DST0 DST1 DPC0	0	P10, etc. P11, etc. P13, etc.	1	R/W		
		D0	CFEX0	P12, P14 port extended function	1	DST2 DCLK	0	P12, etc. P14, etc.	1	R/W		

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
Areas 18–15 set-up register	0048120 (HW)	DF	–	reserved	–	–	–	0 when being read.	
		DE	A18SZ	Areas 18–17 device size selection	1 8 bits 0 16 bits	0	R/W		
		DD	A18DF1	Areas 18–17 output disable delay time	A18DF[1:0] Number of cycles		1	R/W	
		DC	A18DF0		1 1 3.5				
					1 0 2.5				
					0 1 1.5				
						0 0 0.5			
		DB	–	reserved	–	–	–	–	0 when being read.
		DA	A18WT2	Areas 18–17 wait control	A18WT[2:0] Wait cycles		1	R/W	
		D9	A18WT1		1 1 1 7				
		D8	A18WT0		1 1 0 6				
					1 0 1 5				
					1 0 0 4				
					0 1 1 3				
		0 1 0 2							
		0 0 1 1							
			0 0 0 0						
D7	–	reserved	–	–	–	–	0 when being read.		
D6	A16SZ	Areas 16–15 device size selection	1 8 bits 0 16 bits	0	R/W				
D5	A16DF1	Areas 16–15 output disable delay time	A16DF[1:0] Number of cycles		1	R/W			
D4	A16DF0		1 1 3.5						
			1 0 2.5						
			0 1 1.5						
				0 0 0.5					
D3	–	reserved	–	–	–	–	0 when being read.		
D2	A16WT2	Areas 16–15 wait control	A16WT[2:0] Wait cycles		1	R/W			
D1	A16WT1		1 1 1 7						
D0	A16WT0		1 1 0 6						
			1 0 1 5						
			1 0 0 4						
			0 1 1 3						
			0 1 0 2						
			0 0 1 1						
			0 0 0 0						
Areas 14–13 set-up register	0048122 (HW)	DF–9	–	reserved	–	–	–	0 when being read.	
		D8	A14DRA	Area 14 DRAM selection	1 Used 0 Not used	0	R/W		
		D7	A13DRA	Area 13 DRAM selection	1 Used 0 Not used	0	R/W		
		D6	A14SZ	Areas 14–13 device size selection	1 8 bits 0 16 bits	0	R/W		
		D5	A14DF1	Areas 14–13 output disable delay time	A14DF[1:0] Number of cycles		1	R/W	
		D4	A14DF0		1 1 3.5				
					1 0 2.5				
					0 1 1.5				
				0 0 0.5					
D3	–	reserved	–	–	–	–	0 when being read.		
D2	A14WT2	Areas 14–13 wait control	A14WT[2:0] Wait cycles		1	R/W			
D1	A14WT1		1 1 1 7						
D0	A14WT0		1 1 0 6						
			1 0 1 5						
			1 0 0 4						
			0 1 1 3						
			0 1 0 2						
			0 0 1 1						
			0 0 0 0						
Areas 12–11 set-up register	0048124 (HW)	DF–7	–	reserved	–	–	–	0 when being read.	
		D6	A12SZ	Areas 12–11 device size selection	1 8 bits 0 16 bits	0	R/W		
		D5	A12DF1	Areas 12–11 output disable delay time	A12DF[1:0] Number of cycles		1	R/W	
		D4	A12DF0		1 1 3.5				
					1 0 2.5				
					0 1 1.5				
				0 0 0.5					
D3	–	reserved	–	–	–	–	0 when being read.		
D2	A12WT2	Areas 12–11 wait control	A12WT[2:0] Wait cycles		1	R/W			
D1	A12WT1		1 1 1 7						
D0	A12WT0		1 1 0 6						
			1 0 1 5						
			1 0 0 4						
			0 1 1 3						
		0 1 0 2							
		0 0 1 1							
			0 0 0 0						

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
Areas 10–9 set-up register	0048126 (HW)	DF	–	reserved	–	–	–	0 when being read.		
		DE	A10IR2	Area 10 internal ROM wait control	A10IR[2:0]	ROM size	1	R/W		
		DD	A10IR1	Area 10 internal ROM size	1 1 1	2MB	1			
		DC	A10IR0	selection	1 1 0	1MB	1			
		1 0 1	512KB							
		1 0 0	256KB							
		0 1 1	128KB							
		0 1 0	64KB							
		0 0 1	32KB							
		0 0 0	16KB							
		DB	–	reserved	–	–	–	–	0 when being read.	
		DA	A10BW1	Areas 10–9	A10BW[1:0]	Wait cycles	0	R/W		
		D9	A10BW0	burst ROM burst read cycle wait control	1 1	3	0			
		1 0	2							
		0 1	1							
		0 0	0							
		D8	A10DRA	Area 10 burst ROM selection	1	Used	0	Not used	0	R/W
D7	A9DRA	Area 9 burst ROM selection	1	Used	0	Not used	0	R/W		
D6	A10SZ	Areas 10–9 device size selection	1	8 bits	0	16 bits	0	R/W		
D5	A10DF1	Areas 10–9	A10DF[1:0]	Number of cycles	1	R/W				
D4	A10DF0	output disable delay time	1 1	3.5	1					
1 0	2.5									
0 1	1.5									
0 0	0.5									
D3	–	reserved	–	–	–	–	0 when being read.			
D2	A10WT2	Areas 10–9 wait control	A10WT[2:0]	Wait cycles	1	R/W				
D1	A10WT1		1 1 1	7	1					
D0	A10WT0		1 1 0	6	1					
1 0 1	5									
1 0 0	4									
0 1 1	3									
0 1 0	2									
0 0 1	1									
0 0 0	0									
Areas 8–7 set-up register	0048128 (HW)	DF–9	–	reserved	–	–	–	0 when being read.		
		D8	A8DRA	Area 8 DRAM selection	1	Used	0	Not used	0	R/W
		D7	A7DRA	Area 7 DRAM selection	1	Used	0	Not used	0	R/W
		D6	A8SZ	Areas 8–7 device size selection	1	8 bits	0	16 bits	0	R/W
		D5	A8DF1	Areas 8–7	A8DF[1:0]	Number of cycles	1	R/W		
		D4	A8DF0	output disable delay time	1 1	3.5	1			
		1 0	2.5							
		0 1	1.5							
		0 0	0.5							
		D3	–	reserved	–	–	–	–	0 when being read.	
D2	A8WT2	Areas 8–7 wait control	A8WT[2:0]	Wait cycles	1	R/W				
D1	A8WT1		1 1 1	7	1					
D0	A8WT0		1 1 0	6	1					
1 0 1	5									
1 0 0	4									
0 1 1	3									
0 1 0	2									
0 0 1	1									
0 0 0	0									

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks		
Areas 6-4 set-up register	004812A (HW)	DF-E	-	reserved		-	-	0 when being read.		
		DD	A6DF1	Area 6	A6DF[1:0]	Number of cycles	1	R/W		
		DC	A6DF0	output disable delay time	1 1	3.5	1			
					1 0	2.5				
					0 1	1.5				
					0 0	0.5				
		DB	-	reserved		-	-	-	0 when being read.	
		DA	A6WT2	Area 6 wait control	A6WT[2:0]	Wait cycles	1	R/W		
		D9	A6WT1		1 1 1	7	1			
		D8	A6WT0		1 1 0	6	1			
					1 0 1	5				
					1 0 0	4				
					0 1 1	3				
					0 1 0	2				
		0 0 1	1							
		0 0 0	0							
D7	-	reserved		-	-	-	0 when being read.			
D6	A5SZ	Areas 5-4 device size selection	1 8 bits	0 16 bits	0	R/W				
D5	A5DF1	Areas 5-4 output disable delay time	A5DF[1:0]	Number of cycles	1	R/W				
D4	A5DF0		1 1	3.5	1					
			1 0	2.5						
			0 1	1.5						
			0 0	0.5						
D3	-	reserved		-	-	-	0 when being read.			
D2	A5WT2	Areas 5-4 wait control	A5WT[2:0]	Wait cycles	1	R/W				
D1	A5WT1		1 1 1	7	1					
D0	A5WT0		1 1 0	6	1					
			1 0 1	5						
			1 0 0	4						
			0 1 1	3						
			0 1 0	2						
		0 0 1	1							
		0 0 0	0							
TTBR write protect register	004812D (B)	D7	TBRP7	TTBR register write protect	Writing 01011001(0x59) removes the TTBR (0x48134) write protection. Writing other data sets the write protection.	0	W	Undefined in read.		
		D6	TBRP6			0				
		D5	TBRP5			0				
		D4	TBRP4			0				
		D3	TBRP3			0				
		D2	TBRP2			0				
		D1	TBRP1			0				
		D0	TBRP0			0				
Bus control register	004812E (HW)	DF	RBCLK	BCLK output control	1 Fixed at H	0 Enabled	0	R/W		
		DE	-	reserved		-	-	0	-	Writing 1 not allowed.
		DD	RBST8	Burst ROM burst mode selection	1 8-successive	0 4-successive	0	R/W		
		DC	REDO	DRAM page mode selection	1 EDO	0 Fast page	0	R/W		
		DB	RCA1	Column address size selection	RCA[1:0]	Size	0	R/W		
		DA	RCA0		1 1	11	0			
					1 0	10				
					0 1	9				
					0 0	8				
		D9	RPC2	Refresh enable	1 Enabled	0 Disabled	0	R/W		
		D8	RPC1	Refresh method selection	1 Self-refresh	0 CBR-refresh	0	R/W		
		D7	RPC0	Refresh RPC delay setup	1 2.0	0 1.0	0	R/W		
		D6	RRA1	Refresh RAS pulse width selection	RRA[1:0]	Number of cycles	0	R/W		
		D5	RRA0		1 1	5	0			
					1 0	4				
		0 1	3							
			0 0	2						
D4	-	reserved		-	-	0	-	Writing 1 not allowed.		
D3	SBUSST	External interface method selection	1 #BSL	0 A0	0	R/W				
D2	SEMAS	External bus master setup	1 Existing	0 Nonexistent	0	R/W				
D1	SEPD	External power-down control	1 Enabled	0 Disabled	0	R/W				
D0	SWAITE	#WAIT enable	1 Enabled	0 Disabled	0	R/W				

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
DRAM timing set-up register	0048130 (HW)	DF-C	-	reserved		-	-	-	0 when being read.
		DB	A3EEN	Area 3 emulation	1 Internal ROM 0 Emulation	1	R/W		
		DA	CEFUNC1	#CE pin function selection	CFFUNC[1:0]	#CE output	0	R/W	
		D9	CEFUNC0				1 x #CE7/8..#CE17/18	0	
							0 1 #CE6..#CE17		
					0 0 #CE4..#CE10				
		D8	CRAS	Successive RAS mode setup	1 Successive 0 Normal	0	R/W		
		D7	RPRC1	DRAM RAS precharge cycles selection	RPRC[1:0]	Number of cycles	0	R/W	
		D6	RPRC0				1 1 4	0	
							1 0 3		
							0 1 2		
			0 0 1						
D5	-	reserved		-	-	-	0 when being read.		
D4	CASC1	DRAM CAS cycles selection	CASC[1:0]	Number of cycles	0	R/W			
D3	CASC0				1 1 4	0			
					1 0 3				
					0 1 2				
			0 0 1						
D2	-	reserved		-	-	-	0 when being read.		
D1	RASC1	DRAM RAS cycles selection	RASC[1:0]	Number of cycles	0	R/W			
D0	RASC0				1 1 4	0			
					1 0 3				
					0 1 2				
			0 0 1						
Access control register	0048132 (HW)	DF	A18IO	Area 18, 17 internal/external access	1 Internal access	0 External access	0	R/W	
		DE	A16IO	Area 16, 15 internal/external access			0	R/W	
		DD	A14IO	Area 14, 13 internal/external access			0	R/W	
		DC	A12IO	Area 12, 11 internal/external access			0	R/W	
		DB	-	reserved		-	0	-	0 when being read.
		DA	A8IO	Area 8, 7 internal/external access	1 Internal access	0 External access	0	R/W	
		D9	A6IO	Area 6 internal/external access			0	R/W	
		D8	A5IO	Area 5, 4 internal/external access			0	R/W	
		D7	A18EC	Area 18, 17 endian control	1 Big endian	0 Little endian	0	R/W	
		D6	A16EC	Area 16, 15 endian control			0	R/W	
		D5	A14EC	Area 14, 13 endian control			0	R/W	
		D4	A12EC	Area 12, 11 endian control			0	R/W	
		D3	A10EC	Area 10, 9 endian control			0	R/W	
		D2	A8EC	Area 8, 7 endian control			0	R/W	
		D1	A6EC	Area 6 endian control			0	R/W	
D0	A5EC	Area 5, 4 endian control			0	R/W			
TTBR low-order register	0048134 (HW)	DF	TTBR15	Trap table base address [15:10]			0	R/W	
		DE	TTBR14				0		
		DD	TTBR13				0		
		DC	TTBR12				0		
		DB	TTBR11				0		
		DA	TTBR10				0		
		D9	TTBR09	Trap table base address [9:0]	Fixed at 0		0	R	0 when being read. Writing 1 not allowed.
		D8	TTBR08				0		
		D7	TTBR07				0		
		D6	TTBR06				0		
		D5	TTBR05				0		
		D4	TTBR04				0		
		D3	TTBR03				0		
		D2	TTBR02				0		
		D1	TTBR01				0		
D0	TTBR00	0							
TTBR high-order register	0048136 (HW)	DF	TTBR33	Trap table base address [31:28]	Fixed at 0		0	R	0 when being read. Writing 1 not allowed.
		DE	TTBR32				0		
		DD	TTBR31				0		
		DC	TTBR30				0		
		DB	TTBR2B	Trap table base address [27:16]	The initial value is set according to the BTA3 pin status. BTA3 = "1": 0x008 BTA3 = "0": 0x0C0		←	R/W	
		DA	TTBR2A						
		D9	TTBR29						
		D8	TTBR28						
		D7	TTBR27						
		D6	TTBR26						
		D5	TTBR25						
		D4	TTBR24						
		D3	TTBR23						
		D2	TTBR22						
		D1	TTBR21						
D0	TTBR20								

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Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks		
G/A read signal control register	0048138 (HW)	DF	A18AS	Area 18, 17 address strobe signal	1	Enabled	0	Disabled	0	R/W	
		DE	A16AS	Area 16, 15 address strobe signal					0	R/W	
		DD	A14AS	Area 14, 13 address strobe signal					0	R/W	
		DC	A12AS	Area 12, 11 address strobe signal					0	R/W	
		DB	-	reserved	-		0	-	0 when being read.		
		DA	A8AS	Area 8, 7 address strobe signal	1	Enabled	0	Disabled	0	R/W	
		D9	A6AS	Area 6 address strobe signal					0	R/W	
		D8	A5AS	Area 5, 4 address strobe signal					0	R/W	
		D7	A18RD	Area 18, 17 read signal	1	Enabled	0	Disabled	0	R/W	
		D6	A16RD	Area 16, 15 read signal					0	R/W	
		D5	A14RD	Area 14, 13 read signal					0	R/W	
		D4	A12RD	Area 12, 11 read signal					0	R/W	
		D3	-	reserved					-		
		D2	A8RD	Area 8, 7 read signal	1	Enabled	0	Disabled	0	R/W	
		D1	A6RD	Area 6 read signal					0	R/W	
		D0	A5RD	Area 5, 4 read signal					0	R/W	
BCLK select register	004813A (B)	D7-4	-	reserved	-		0	-	0 when being read.		
		D3	A1X1MD	Area 1 access-speed	1	2 cycles	0	4 cycles	0	R/W	x2 speed mode only
		D2	-	reserved	-		0	-	0 when being read.		
		D1	BCLKSEL1	BCLK output clock selection	BCLKSEL[1:0]		BCLK	0	R/W		
		D0	BCLKSEL0		1	1	PLL_CLK	0			
			1	0	OSC3_CLK						
			0	1	BCU_CLK						
			0	0	CPU_CLK						

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
16-bit timer 0 comparison register A	0048180 (HW)	DF	CR0A15	16-bit timer 0 comparison data A CR0A15 = MSB CR0A0 = LSB	0 to 65535	X	R/W		
		DE	CR0A14						
		DD	CR0A13						
		DC	CR0A12						
		DB	CR0A11						
		DA	CR0A10						
		D9	CR0A9						
		D8	CR0A8						
		D7	CR0A7						
		D6	CR0A6						
		D5	CR0A5						
		D4	CR0A4						
		D3	CR0A3						
		D2	CR0A2						
		D1	CR0A1						
		D0	CR0A0						
16-bit timer 0 comparison register B	0048182 (HW)	DF	CR0B15	16-bit timer 0 comparison data B CR0B15 = MSB CR0B0 = LSB	0 to 65535	X	R/W		
		DE	CR0B14						
		DD	CR0B13						
		DC	CR0B12						
		DB	CR0B11						
		DA	CR0B10						
		D9	CR0B9						
		D8	CR0B8						
		D7	CR0B7						
		D6	CR0B6						
		D5	CR0B5						
		D4	CR0B4						
		D3	CR0B3						
		D2	CR0B2						
		D1	CR0B1						
		D0	CR0B0						
16-bit timer 0 counter data register	0048184 (HW)	DF	TC015	16-bit timer 0 counter data TC015 = MSB TC00 = LSB	0 to 65535	X	R		
		DE	TC014						
		DD	TC013						
		DC	TC012						
		DB	TC011						
		DA	TC010						
		D9	TC09						
		D8	TC08						
		D7	TC07						
		D6	TC06						
		D5	TC05						
		D4	TC04						
		D3	TC03						
		D2	TC02						
		D1	TC01						
		D0	TC00						
16-bit timer 0 control register	0048186 (B)	D7	–	reserved	–	0	–	0 when being read.	
		D6	SELFMO	16-bit timer 0 fine mode selection	1 Fine mode	0 Normal	0	R/W	
		D5	SELCRB0	16-bit timer 0 comparison buffer	1 Enabled	0 Disabled	0	R/W	
		D4	OUTINV0	16-bit timer 0 output inversion	1 Invert	0 Normal	0	R/W	
		D3	CKSL0	16-bit timer 0 input clock selection	1 External clock	0 Internal clock	0	R/W	
		D2	PTM0	16-bit timer 0 clock output control	1 On	0 Off	0	R/W	
		D1	PRESET0	16-bit timer 0 reset	1 Reset	0 Invalid	0	W	0 when being read.
		D0	PRUN0	16-bit timer 0 Run/Stop control	1 Run	0 Stop	0	R/W	

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
16-bit timer 1 comparison register A	0048188 (HW)	DF	CR1A15	16-bit timer 1 comparison data A CR1A15 = MSB CR1A0 = LSB	0 to 65535	X	R/W		
		DE	CR1A14						
		DD	CR1A13						
		DC	CR1A12						
		DB	CR1A11						
		DA	CR1A10						
		D9	CR1A9						
		D8	CR1A8						
		D7	CR1A7						
		D6	CR1A6						
		D5	CR1A5						
		D4	CR1A4						
		D3	CR1A3						
		D2	CR1A2						
		D1	CR1A1						
		D0	CR1A0						
		16-bit timer 1 comparison register B	004818A (HW)			DF			CR1B15
DE	CR1B14								
DD	CR1B13								
DC	CR1B12								
DB	CR1B11								
DA	CR1B10								
D9	CR1B9								
D8	CR1B8								
D7	CR1B7								
D6	CR1B6								
D5	CR1B5								
D4	CR1B4								
D3	CR1B3								
D2	CR1B2								
D1	CR1B1								
D0	CR1B0								
16-bit timer 1 counter data register	004818C (HW)			DF	TC115	16-bit timer 1 counter data TC115 = MSB TC10 = LSB	0 to 65535	X	R
		DE	TC114						
		DD	TC113						
		DC	TC112						
		DB	TC111						
		DA	TC110						
		D9	TC19						
		D8	TC18						
		D7	TC17						
		D6	TC16						
		D5	TC15						
		D4	TC14						
		D3	TC13						
		D2	TC12						
		D1	TC11						
		D0	TC10						
		16-bit timer 1 control register	004818E (B)	D7	–			reserved	
D6	SELFM1			16-bit timer 1 fine mode selection	1 Fine mode	0 Normal	0	R/W	
D5	SELCRB1			16-bit timer 1 comparison buffer	1 Enabled	0 Disabled	0	R/W	
D4	OUTINV1			16-bit timer 1 output inversion	1 Invert	0 Normal	0	R/W	
D3	CKSL1			16-bit timer 1 input clock selection	1 External clock	0 Internal clock	0	R/W	
D2	PTM1			16-bit timer 1 clock output control	1 On	0 Off	0	R/W	
D1	PRESET1			16-bit timer 1 reset	1 Reset	0 Invalid	0	W	0 when being read.
D0	PRUN1			16-bit timer 1 Run/Stop control	1 Run	0 Stop	0	R/W	

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
16-bit timer 2 comparison register A	0048190 (HW)	DF	CR2A15	16-bit timer 2 comparison data A CR2A15 = MSB CR2A0 = LSB	0 to 65535	X	R/W				
		DE	CR2A14								
		DD	CR2A13								
		DC	CR2A12								
		DB	CR2A11								
		DA	CR2A10								
		D9	CR2A9								
		D8	CR2A8								
		D7	CR2A7								
		D6	CR2A6								
		D5	CR2A5								
		D4	CR2A4								
		D3	CR2A3								
		D2	CR2A2								
		D1	CR2A1								
		D0	CR2A0								
16-bit timer 2 comparison register B	0048192 (HW)	DF	CR2B15	16-bit timer 2 comparison data B CR2B15 = MSB CR2B0 = LSB	0 to 65535	X	R/W				
		DE	CR2B14								
		DD	CR2B13								
		DC	CR2B12								
		DB	CR2B11								
		DA	CR2B10								
		D9	CR2B9								
		D8	CR2B8								
		D7	CR2B7								
		D6	CR2B6								
		D5	CR2B5								
		D4	CR2B4								
		D3	CR2B3								
		D2	CR2B2								
		D1	CR2B1								
		D0	CR2B0								
16-bit timer 2 counter data register	0048194 (HW)	DF	TC215	16-bit timer 2 counter data TC215 = MSB TC20 = LSB	0 to 65535	X	R				
		DE	TC214								
		DD	TC213								
		DC	TC212								
		DB	TC211								
		DA	TC210								
		D9	TC29								
		D8	TC28								
		D7	TC27								
		D6	TC26								
		D5	TC25								
		D4	TC24								
		D3	TC23								
		D2	TC22								
		D1	TC21								
		D0	TC20								
16-bit timer 2 control register	0048196 (B)	D7	–	reserved	–		0	–	0 when being read.		
		D6	SELF2	16-bit timer 2 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SEL2	16-bit timer 2 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUT2	16-bit timer 2 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CK2	16-bit timer 2 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM2	16-bit timer 2 clock output control	1	On	0	Off	0	R/W	
		D1	PRE2	16-bit timer 2 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN2	16-bit timer 2 Run/Stop control	1	Run	0	Stop	0	R/W	

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
16-bit timer 3 comparison register A	0048198 (HW)	DF	CR3A15	16-bit timer 3 comparison data A CR3A15 = MSB CR3A0 = LSB	0 to 65535		X	R/W			
		DE	CR3A14								
		DD	CR3A13								
		DC	CR3A12								
		DB	CR3A11								
		DA	CR3A10								
		D9	CR3A9								
		D8	CR3A8								
		D7	CR3A7								
		D6	CR3A6								
		D5	CR3A5								
		D4	CR3A4								
		D3	CR3A3								
		D2	CR3A2								
		D1	CR3A1								
		D0	CR3A0								
16-bit timer 3 comparison register B	004819A (HW)	DF	CR3B15	16-bit timer 3 comparison data B CR3B15 = MSB CR3B0 = LSB	0 to 65535		X	R/W			
		DE	CR3B14								
		DD	CR3B13								
		DC	CR3B12								
		DB	CR3B11								
		DA	CR3B10								
		D9	CR3B9								
		D8	CR3B8								
		D7	CR3B7								
		D6	CR3B6								
		D5	CR3B5								
		D4	CR3B4								
		D3	CR3B3								
		D2	CR3B2								
		D1	CR3B1								
		D0	CR3B0								
16-bit timer 3 counter data register	004819C (HW)	DF	TC315	16-bit timer 3 counter data TC315 = MSB TC30 = LSB	0 to 65535		X	R			
		DE	TC314								
		DD	TC313								
		DC	TC312								
		DB	TC311								
		DA	TC310								
		D9	TC39								
		D8	TC38								
		D7	TC37								
		D6	TC36								
		D5	TC35								
		D4	TC34								
		D3	TC33								
		D2	TC32								
		D1	TC31								
		D0	TC30								
16-bit timer 3 control register	004819E (B)	D7	–	reserved	–		0	–	0 when being read.		
		D6	SELFM3	16-bit timer 3 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB3	16-bit timer 3 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV3	16-bit timer 3 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL3	16-bit timer 3 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM3	16-bit timer 3 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET3	16-bit timer 3 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN3	16-bit timer 3 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks	
16-bit timer 4 comparison register A	00481A0 (HW)	DF	CR4A15	16-bit timer 4 comparison data A CR4A15 = MSB CR4A0 = LSB	0 to 65535	X	R/W		
		DE	CR4A14						
		DD	CR4A13						
		DC	CR4A12						
		DB	CR4A11						
		DA	CR4A10						
		D9	CR4A9						
		D8	CR4A8						
		D7	CR4A7						
		D6	CR4A6						
		D5	CR4A5						
		D4	CR4A4						
		D3	CR4A3						
		D2	CR4A2						
		D1	CR4A1						
		D0	CR4A0						
16-bit timer 4 comparison register B	00481A2 (HW)	DF	CR4B15	16-bit timer 4 comparison data B CR4B15 = MSB CR4B0 = LSB	0 to 65535	X	R/W		
		DE	CR4B14						
		DD	CR4B13						
		DC	CR4B12						
		DB	CR4B11						
		DA	CR4B10						
		D9	CR4B9						
		D8	CR4B8						
		D7	CR4B7						
		D6	CR4B6						
		D5	CR4B5						
		D4	CR4B4						
		D3	CR4B3						
		D2	CR4B2						
		D1	CR4B1						
		D0	CR4B0						
16-bit timer 4 counter data register	00481A4 (HW)	DF	TC415	16-bit timer 4 counter data TC415 = MSB TC40 = LSB	0 to 65535	X	R		
		DE	TC414						
		DD	TC413						
		DC	TC412						
		DB	TC411						
		DA	TC410						
		D9	TC49						
		D8	TC48						
		D7	TC47						
		D6	TC46						
		D5	TC45						
		D4	TC44						
		D3	TC43						
		D2	TC42						
		D1	TC41						
		D0	TC40						
16-bit timer 4 control register	00481A6 (B)	D7	–	reserved	–	0	–	0 when being read.	
		D6	SELF4	16-bit timer 4 fine mode selection	1 Fine mode	0 Normal	0	R/W	
		D5	SELCRB4	16-bit timer 4 comparison buffer	1 Enabled	0 Disabled	0	R/W	
		D4	OUTINV4	16-bit timer 4 output inversion	1 Invert	0 Normal	0	R/W	
		D3	CKSL4	16-bit timer 4 input clock selection	1 External clock	0 Internal clock	0	R/W	
		D2	PTM4	16-bit timer 4 clock output control	1 On	0 Off	0	R/W	
		D1	PRESET4	16-bit timer 4 reset	1 Reset	0 Invalid	0	W	0 when being read.
		D0	PRUN4	16-bit timer 4 Run/Stop control	1 Run	0 Stop	0	R/W	

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Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
16-bit timer 5 comparison register A	00481A8 (HW)	DF	CR5A15	16-bit timer 5 comparison data A CR5A15 = MSB CR5A0 = LSB	0 to 65535	X	R/W				
		DE	CR5A14								
		DD	CR5A13								
		DC	CR5A12								
		DB	CR5A11								
		DA	CR5A10								
		D9	CR5A9								
		D8	CR5A8								
		D7	CR5A7								
		D6	CR5A6								
		D5	CR5A5								
		D4	CR5A4								
		D3	CR5A3								
		D2	CR5A2								
		D1	CR5A1								
		D0	CR5A0								
16-bit timer 5 comparison register B	00481AA (HW)	DF	CR5B15	16-bit timer 5 comparison data B CR5B15 = MSB CR5B0 = LSB	0 to 65535	X	R/W				
		DE	CR5B14								
		DD	CR5B13								
		DC	CR5B12								
		DB	CR5B11								
		DA	CR5B10								
		D9	CR5B9								
		D8	CR5B8								
		D7	CR5B7								
		D6	CR5B6								
		D5	CR5B5								
		D4	CR5B4								
		D3	CR5B3								
		D2	CR5B2								
		D1	CR5B1								
		D0	CR5B0								
16-bit timer 5 counter data register	00481AC (HW)	DF	TC515	16-bit timer 5 counter data TC515 = MSB TC50 = LSB	0 to 65535	X	R				
		DE	TC514								
		DD	TC513								
		DC	TC512								
		DB	TC511								
		DA	TC510								
		D9	TC59								
		D8	TC58								
		D7	TC57								
		D6	TC56								
		D5	TC55								
		D4	TC54								
		D3	TC53								
		D2	TC52								
		D1	TC51								
		D0	TC50								
16-bit timer 5 control register	00481AE (B)	D7	–	reserved	–	0	–	0 when being read.			
		D6	SELFM5	16-bit timer 5 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB5	16-bit timer 5 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV5	16-bit timer 5 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL5	16-bit timer 5 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM5	16-bit timer 5 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET5	16-bit timer 5 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN5	16-bit timer 5 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
IDMA base address low-order register	0048200 (HW)	DF	DBASEL15	IDMA base address		0	R/W	
		DE	DBASEL14	low-order 16 bits		0		
		DD	DBASEL13	(Initial value: 0x0C003A0)		0		
		DC	DBASEL12			0		
		DB	DBASEL11			0		
		DA	DBASEL10			0		
		D9	DBASEL9			1		
		D8	DBASEL8			1		
		D7	DBASEL7			1		
		D6	DBASEL6			0		
		D5	DBASEL5			1		
		D4	DBASEL4			0		
		D3	DBASEL3			0		
		D2	DBASEL2			0		
		D1	DBASEL1			0		
		D0	DBASEL0			0		
		IDMA base address high-order register	0048202 (HW)	DF-C	-	reserved	-	-
DB	DBASEH11			IDMA base address		0	R/W	
DA	DBASEH10			high-order 12 bits		0		
D9	DBASEH9			(Initial value: 0x0C003A0)		0		
D8	DBASEH8					0		
D7	DBASEH7					1		
D6	DBASEH6					1		
D5	DBASEH5					0		
D4	DBASEH4					0		
D3	DBASEH3					0		
D2	DBASEH2					0		
D1	DBASEH1					0		
D0	DBASEH0			0				
IDMA start register	0048204 (B)	D7	DSTART	IDMA start	1 IDMA start 0 Stop	0	R/W	
		D6-0	DCHN	IDMA channel number	0 to 127	0	R/W	
IDMA enable register	0048205 (B)	D7-1	-	reserved	-	-	-	
		D0	IDMAEN	IDMA enable	1 Enabled 0 Disabled	0	R/W	

APPENDIX: I/O MAP

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks									
High-speed DMA Ch.0 transfer counter register	0048220 (HW)	DF	TC0_L7	Ch.0 transfer counter[7:0] (block transfer mode)													
		DE	TC0_L6														
		DD	TC0_L5														
		DC	TC0_L4														
		DB	TC0_L3														
		DA	TC0_L2														
		D9	TC0_L1														
		D8	TC0_L0														
		D7	BLKLEN07	Ch.0 block length (block transfer mode)													
		D6	BLKLEN06														
		D5	BLKLEN05														
		D4	BLKLEN04														
		D3	BLKLEN03														
		D2	BLKLEN02														
		D1	BLKLEN01														
		D0	BLKLEN00														
High-speed DMA Ch.0 control register	0048222 (HW)	DF	DUALM0	Ch.0 address mode selection	1	Dual addr	0	Single addr						0	R/W		
		DE	DODIR	D) Invalid													
				S) Ch.0 transfer direction control	1	Memory WR	0	Memory RD						0	R/W		
		DD-8	-	reserved													Undefined in read.
		D7	TC0_H7	Ch.0 transfer counter[15:8] (block transfer mode)													
		D6	TC0_H6														
		D5	TC0_H5														
		D4	TC0_H4														
		D3	TC0_H3														
		D2	TC0_H2														
		D1	TC0_H1														
		D0	TC0_H0														
High-speed DMA Ch.0 low-order source address set-up register	0048224 (HW)	DF	S0ADRL15	D) Ch.0 source address[15:0]													
		DE	S0ADRL14														
		DD	S0ADRL13														
		DC	S0ADRL12														
		DB	S0ADRL11														
		DA	S0ADRL10														
		D9	S0ADRL9														
		A8	S0ADRL8														
		D7	S0ADRL7														
		D6	S0ADRL6														
		D5	S0ADRL5														
		D4	S0ADRL4														
		D3	S0ADRL3														
		D2	S0ADRL2														
		D1	S0ADRL1														
		D0	S0ADRL0														
High-speed DMA Ch.0 high-order source address set-up register	0048226 (HW)	DF	DINTENO	Ch.0 interrupt enable	1	Enabled	0	Disabled	0	R/W							
		DE	DATSIZE0	Ch.0 transfer data size	1	Half word	0	Byte	0	R/W							
		DD	S0IN1	D) Ch.0 source address control	S0IN[1:0]		Inc/dec		0	R/W							
		DC	S0IN0	S) Ch.0 memory address control	1	1	Inc.(no init)		0								
					1	0	Inc.(init)										
					0	1	Dec.(no init)										
					0	0	Fixed										
		D7	S0ADRH11	D) Ch.0 source address[27:16]													
		DA	S0ADRH10														
		D9	S0ADRH9														
		A8	S0ADRH8														
		D7	S0ADRH7														
		D6	S0ADRH6														
		D5	S0ADRH5														
		D4	S0ADRH4														
		D3	S0ADRH3														
D2	S0ADRH2																
D1	S0ADRH1																
D0	S0ADRH0																

APPENDIX: I/O MAP

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks							
High-speed DMA Ch.1 transfer counter register	0048230 (HW)	DF	TC1_L7	Ch.1 transfer counter[7:0] (block transfer mode)			X	R/W							
		DE	TC1_L6												
		DD	TC1_L5												
		DC	TC1_L4												
		DB	TC1_L3												
		DA	TC1_L2												
		D9	TC1_L1												
		D8	TC1_L0												
		D7	BLKLEN17							Ch.1 block length (block transfer mode)			X	R/W	
		D6	BLKLEN16												
	D5	BLKLEN15													
	D4	BLKLEN14													
	D3	BLKLEN13													
	D2	BLKLEN12													
	D1	BLKLEN11													
	D0	BLKLEN10													
High-speed DMA Ch.1 control register	0048232 (HW)	DF	DUALM1	Ch.1 address mode selection	1	Dual addr	0	Single addr	0	R/W					
		DE	D1DIR	D) Invalid											
				S) Ch.1 transfer direction control	1	Memory WR	0	Memory RD	0	R/W					
		DD-8	-	reserved							-	Undefined in read.			
	Note: D) Dual address mode S) Single address mode		D7	TC1_H7	Ch.1 transfer counter[15:8] (block transfer mode)			X	R/W						
		D6	TC1_H6												
		D5	TC1_H5												
		D4	TC1_H4												
		D3	TC1_H3												
		D2	TC1_H2												
D1		TC1_H1													
D0	TC1_H0														
High-speed DMA Ch.1 low-order source address set-up register	0048234 (HW)	DF	S1ADRL15	D) Ch.1 source address[15:0] S) Ch.1 memory address[15:0]			X	R/W							
		DE	S1ADRL14												
		DD	S1ADRL13												
		DC	S1ADRL12												
		DB	S1ADRL11												
		DA	S1ADRL10												
		D9	S1ADRL9												
		A8	S1ADRL8												
		D7	S1ADRL7												
		D6	S1ADRL6												
		D5	S1ADRL5												
D4	S1ADRL4														
D3	S1ADRL3														
D2	S1ADRL2														
D1	S1ADRL1														
D0	S1ADRL0														
High-speed DMA Ch.1 high-order source address set-up register	0048236 (HW)	DF	DINTEN1	Ch.1 interrupt enable	1	Enabled	0	Disabled	0	R/W					
		DE	DATSIZE1	Ch.1 transfer data size	1	Half word	0	Byte	0	R/W					
		DD	S1IN1	D) Ch.1 source address control S) Ch.1 memory address control		1	1	Inc.(no init)	0	R/W					
		DC	S1IN0												
		Note: D) Dual address mode S) Single address mode		DB	S1ADRH11	D) Ch.1 source address[27:16] S) Ch.1 memory address[27:16]			X	R/W					
			DA	S1ADRH10											
			D9	S1ADRH9											
			A8	S1ADRH8											
			D7	S1ADRH7											
			D6	S1ADRH6											
			D5	S1ADRH5											
D4	S1ADRH4														
D3	S1ADRH3														
D2	S1ADRH2														
D1	S1ADRH1														
D0	S1ADRH0														

APPENDIX: I/O MAP

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
High-speed DMA Ch.2 transfer counter register	0048240 (HW)	DF	TC2_L7	Ch.2 transfer counter[7:0] (block transfer mode)			X	R/W			
		DE	TC2_L6								
		DD	TC2_L5								
		DC	TC2_L4								
		DB	TC2_L3								
		DA	TC2_L2								
		D9	TC2_L1								
		D8	TC2_L0								
		D7	BLKLEN27	Ch.2 block length (block transfer mode)			X				
		D6	BLKLEN26								
		D5	BLKLEN25								
		D4	BLKLEN24								
		D3	BLKLEN23								
		D2	BLKLEN22								
		D1	BLKLEN21								
		D0	BLKLEN20								
High-speed DMA Ch.2 control register	0048242 (HW)	DF	DUALM2	Ch.2 address mode selection	1	Dual addr	0	Single addr	0	R/W	
		DE	D2DIR	D) Invalid							
				S) Ch.2 transfer direction control	1	Memory WR	0	Memory RD	0	R/W	
		DD-8	-	reserved						-	Undefined in read.
		D7	TC2_H7	Ch.2 transfer counter[15:8] (block transfer mode)	X						
		D6	TC2_H6								
		D5	TC2_H5								
		D4	TC2_H4								
		D3	TC2_H3								
		D2	TC2_H2								
		D1	TC2_H1								
D0	TC2_H0										
High-speed DMA Ch.2 low-order source address set-up register	0048244 (HW)	DF	S2ADRL15	D) Ch.2 source address[15:0]			X	R/W			
		DE	S2ADRL14								
		DD	S2ADRL13								
		DC	S2ADRL12								
		DB	S2ADRL11								
		DA	S2ADRL10								
		D9	S2ADRL9								
		A8	S2ADRL8								
		D7	S2ADRL7								
		D6	S2ADRL6								
		D5	S2ADRL5								
		D4	S2ADRL4								
		D3	S2ADRL3								
D2	S2ADRL2										
D1	S2ADRL1										
D0	S2ADRL0										
High-speed DMA Ch.2 high-order source address set-up register	0048246 (HW)	DF	DINTEN2	Ch.2 interrupt enable	1	Enabled	0	Disabled	0	R/W	
		DE	DATSIZE2	Ch.2 transfer data size	1	Half word	0	Byte	0	R/W	
		DD	S2IN1	D) Ch.2 source address control	S2IN[1:0]		Inc/dec		0	R/W	
		DC	S2IN0	S) Ch.2 memory address control	1	1	Inc.(no init)		0		
					1	0	Inc.(init)				
					0	1	Dec.(no init)				
					0	0	Fixed				
		D7	S2ADRH11	D) Ch.2 source address[27:16]	X						
		DA	S2ADRH10								
		D9	S2ADRH9								
		A8	S2ADRH8								
		D7	S2ADRH7								
		D6	S2ADRH6								
D5	S2ADRH5										
D4	S2ADRH4										
D3	S2ADRH3										
D2	S2ADRH2										
D1	S2ADRH1										
D0	S2ADRH0										

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks				
High-speed DMA Ch.2 low-order destination address set-up register Note: D) Dual address mode S) Single address mode	0048248 (HW)	DF	D2ADRL15	D) Ch.2 destination address[15:0] S) Invalid			X	R/W				
		DE	D2ADRL14									
		DD	D2ADRL13									
		DC	D2ADRL12									
		DB	D2ADRL11									
		DA	D2ADRL10									
		D9	D2ADRL9									
		A8	D2ADRL8									
		D7	D2ADRL7									
		D6	D2ADRL6									
		D5	D2ADRL5									
		D4	D2ADRL4									
		D3	D2ADRL3									
		D2	D2ADRL2									
		D1	D2ADRL1									
		D0	D2ADRL0									
		High-speed DMA Ch.2 high-order destination address set-up register Note: D) Dual address mode S) Single address mode	004824A (HW)				DF			D2MOD1	Ch.2 transfer mode	D2MOD[1:0]
DE	D2MOD0											
					1	1	Invalid	0				
					1	0	Block	0				
					0	1	Successive	0				
					0	0	Single	0				
					D2IN[1:0]		Inc/dec	0				
					1	1	Inc.(no init)	0				
					1	0	Inc.(init)	0				
					0	1	Dec.(no init)	0				
					0	0	Fixed	0				
High-speed DMA Ch.2 enable register	004824C (HW)			DF-1	-	reserved	-		-	-	Undefined in read.	
		D0	HS2_EN	Ch.2 enable	1	Enable	0	Disable	0	R/W		
		High-speed DMA Ch.2 trigger flag register	004824E (HW)	DF-1	-	reserved	-		-	-	Undefined in read.	
				D0	HS2_TF	Ch.2 trigger flag clear (writing)	1	Clear	0	No operation	0	R/W
						Ch.2 trigger flag status (reading)	1	Set	0	Cleared		

APPENDIX: I/O MAP

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks												
High-speed DMA Ch.3 transfer counter register	0048250 (HW)	DF	TC3_L7	Ch.3 transfer counter[7:0] (block transfer mode)																
		DE	TC3_L6																	
		DD	TC3_L5																	
		DC	TC3_L4																	
		DB	TC3_L3																	
		DA	TC3_L2																	
		D9	TC3_L1	Ch.3 transfer counter[15:8] (single/successive transfer mode)																
		D8	TC3_L0																	
		D7	BLKLEN37																	
		D6	BLKLEN36						Ch.3 block length (block transfer mode)											
		D5	BLKLEN35																	
		D4	BLKLEN34																	
		D3	BLKLEN33	Ch.3 transfer counter[7:0] (single/successive transfer mode)																
		D2	BLKLEN32																	
		D1	BLKLEN31																	
		D0	BLKLEN30																	
High-speed DMA Ch.3 control register	0048252 (HW)	DF	DUALM3		Ch.3 address mode selection	1	Dual addr	0	Single addr	0	R/W									
		DE	D3DIR		D) Invalid															
				S) Ch.3 transfer direction control	1	Memory WR	0	Memory RD	0	R/W										
		DD-8	-	reserved								Undefined in read.								
		D7	TC3_H7	Ch.3 transfer counter[15:8] (block transfer mode)																
		D6	TC3_H6																	
		D5	TC3_H5																	
		D4	TC3_H4																	
		D3	TC3_H3																	
		D2	TC3_H2																	
		D1	TC3_H1	Ch.3 transfer counter[23:16] (single/successive transfer mode)																
		D0	TC3_H0																	
High-speed DMA Ch.3 low-order source address set-up register	0048254 (HW)	DF	S3ADRL15										D) Ch.3 source address[15:0]							
		DE	S3ADRL14																	
		DD	S3ADRL13																	
		DC	S3ADRL12																	
		DB	S3ADRL11																	
		DA	S3ADRL10																	
		D9	S3ADRL9																	
		A8	S3ADRL8																	
		D7	S3ADRL7																	
		D6	S3ADRL6																	
		D5	S3ADRL5																	
		D4	S3ADRL4																	
		D3	S3ADRL3																	
		D2	S3ADRL2																	
		D1	S3ADRL1																	
		D0	S3ADRL0																	
High-speed DMA Ch.3 high-order source address set-up register	0048256 (HW)	DF	DINTEN3	Ch.3 interrupt enable	1	Enabled	0	Disabled	0	R/W										
		DE	DATSIZE3	Ch.3 transfer data size	1	Half word	0	Byte	0	R/W										
		DD	S3IN1	D) Ch.3 source address control	S3IN[1:0]		Inc/dec		0	R/W										
		DC	S3IN0	S) Ch.3 memory address control	1	1	Inc.(no init)		0											
					1	0	Inc.(init)													
					0	1	Dec.(no init)													
					0	0	Fixed													
		D7	S3ADRH11	D) Ch.3 source address[27:16]																
		DA	S3ADRH10																	
		D9	S3ADRH9																	
		A8	S3ADRH8																	
		D7	S3ADRH7																	
		D6	S3ADRH6																	
		D5	S3ADRH5																	
		D4	S3ADRH4																	
		D3	S3ADRH3																	
D2	S3ADRH2																			
D1	S3ADRH1																			
D0	S3ADRH0																			

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks																		
High-speed DMA Ch.3 low-order destination address set-up register Note: D) Dual address mode S) Single address mode	0048258 (HW)	DF	D3ADRL15	D) Ch.3 destination address[15:0] S) Invalid			X	R/W																		
		DE	D3ADRL14																							
		DD	D3ADRL13																							
		DC	D3ADRL12																							
		DB	D3ADRL11																							
		DA	D3ADRL10																							
		D9	D3ADRL9																							
		A8	D3ADRL8																							
		D7	D3ADRL7																							
		D6	D3ADRL6																							
		D5	D3ADRL5																							
		D4	D3ADRL4																							
		D3	D3ADRL3																							
		D2	D3ADRL2																							
		D1	D3ADRL1																							
		D0	D3ADRL0																							
High-speed DMA Ch.3 high-order destination address set-up register Note: D) Dual address mode S) Single address mode	004825A (HW)	DF	D3MOD1	Ch.3 transfer mode		D3MOD[1:0]	Mode	0	R/W																	
		DE	D3MOD0																							
											1	1	Invalid													
											1	0	Block													
											0	1	Successive													
											0	0	Single													
											DD	D3IN1	D) Ch.3 destination address control S) Invalid		D3IN[1:0]	Inc/dec	0	R/W								
											DC	D3IN0														
																				1	1	Inc.(no init)				
																				1	0	Inc.(init)				
																				0	1	Dec.(no init)				
																				0	0	Fixed				
											DB	D3ADRH11								D) Ch.3 destination address[27:16] S) Invalid				X	R/W	
											DA	D3ADRH10														
											D9	D3ADRH9														
											A8	D3ADRH8														
		D7	D3ADRH7																							
		D6	D3ADRH6																							
		D5	D3ADRH5																							
		D4	D3ADRH4																							
		D3	D3ADRH3																							
		D2	D3ADRH2																							
		D1	D3ADRH1																							
		D0	D3ADRH0																							
High-speed DMA Ch.3 enable register	004825C (HW)	DF-1	–	reserved		–		–	–	Undefined in read.																
		D0	HS_EN	Ch.3 enable	1	Enable	0	Disable	0	R/W																
High-speed DMA Ch.3 trigger flag register	004825E (HW)	DF-1	–	reserved		–		–	–	Undefined in read.																
		D0	HS_TF	Ch.3 trigger flag clear (writing) Ch.3 trigger flag status (reading)	1	Clear	0	No operation	0	R/W																
					1	Set	0	Cleared																		

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SED1375 Block LCD Controller

Hardware Functional Specification

1 INTRODUCTION

1.1 Scope

This document gives the hardware functional specifications for the C332L01's LCD controller block, consisting of an SED1375 and 40K byte VRAM. This document contains timing diagrams, AC and DC characteristics, register descriptions, and power management descriptions. This document is intended for two audiences: Video Subsystem Designers and Software Developers.

1.2 Overview Description

The LCD controller block consists of an SED1375 color/monochrome LCD graphics controller and 40K byte SRAM used as a display buffer. The high integration of the SED1375 block provides a low cost, low power, single chip solution to meet the requirements of embedded markets such as Office Automation equipment, Mobile Communications devices, and Hand-Held PCs where board size and battery life are major concerns.

Products requiring a "Portrait" display can take advantage of the Hardware Portrait Mode feature of the SED1375 block. Virtual and Split Screen are just some of the display modes supported. The above features, combined with the Operating System independence of the SED1375 block, make it the ideal solution for a wide variety of applications.

2 FEATURES

2.1 *Integrated Frame Buffer*

- Embedded 40K byte SRAM display buffer.

2.2 *C33 Core CPU Interface*

- Registers are mapped into addresses 0x039FFE0 to 0x039FFFF of the C332L01 memory map.
- Single level CPU write buffer.
- The complete 40K byte display buffer is mapped into addresses 0x0380000 to 0x0389FFF of the C332L01 memory map.

2.3 *Display Support*

- 4/8-bit monochrome LCD interface.
- 4/8-bit color LCD interface.
- Single-panel, single-drive passive displays.
- Dual-panel, dual-drive passive displays.
- Active Matrix TFT / D-TFD interface
- Register level support for EL panels.
- Example resolutions:
 - 640 × 480 at a color depth of 1 bpp
 - 640 × 240 at a color depth of 2 bpp
 - 320 × 240 at a color depth of 4 bpp
 - 240 × 160 at a color depth of 8 bpp

2.4 *Display Modes*

- Hardware Portrait Mode: direct 90° hardware rotation of display image for portrait mode display
- 1/2/4 bit-per-pixel (bpp), 2/4/16-level grayscale display.
- 1/2/4/8 bit-per-pixel, 2/4/16/256-level color display.
- Up to 16 shades of gray by FRM on monochrome passive LCD panels; a 256 × 4 Look-Up Table is used to map 1/2/4 bpp modes into these shades.
- 256 simultaneous of 4096 colors on color passive and active matrix LCD panels; three 256 × 4 Look-Up Tables are used to map 1/2/4/8 bpp modes into these colors.
- Split screen display for all landscape panel modes allows two different images to be simultaneously displayed.
- Virtual display support (displays images larger than the panel size through the use of panning).

2.5 Clock Source

- Maximum operating clock (CLK) frequency of 25MHz.
- Operating clock (CLK) is derived from CLKI input.
CLK = CLKI
or
CLK = CLKI/2
- Pixel Clock (PCLK) and Memory Clock (MCLK) are derived from CLK.

2.6 Miscellaneous

- Hardware/Software Video Invert.
- Software Power Save mode.
- Hardware Power Save mode.
- LCD power-down sequencing.
- 5 General Purpose Input/Output pins are available.

GPIO0 is available if Hardware Power Save is not required.

GPIO[4:1] are available if upper LCD data pins (FPDAT[11:8]) are not required for TFT/D-TFD support or hardware inverse video.

3 FUNCTIONAL BLOCK DIAGRAM

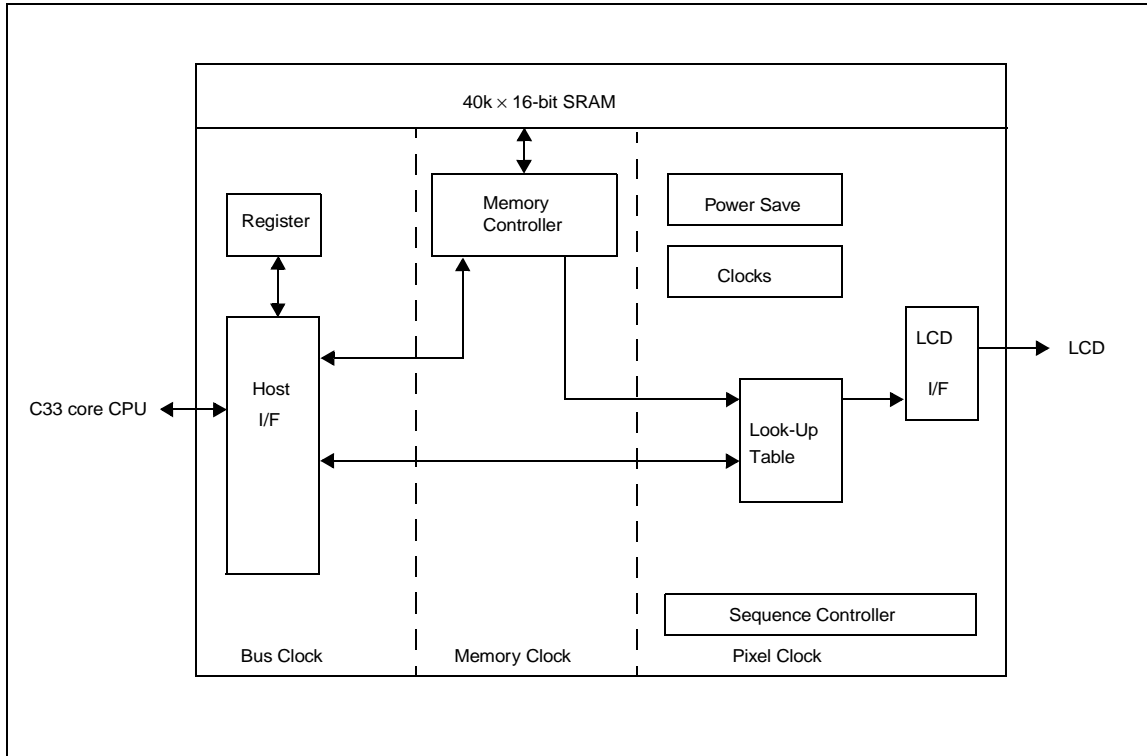


Figure 3-1 System Block Diagram Showing Data Paths

3.1 Functional Block Descriptions

Host Interface

The Host Interface block allows the C33 core CPU to communicate with the internal registers, display buffer, and other LCD controller block components.

Memory Controller

The Memory Controller arbitrates between CPU accesses and display refresh accesses. It also generates the necessary signals to control the SRAM frame buffer.

Sequence Controller

The Sequence Controller controls data flow from the Memory Controller through the Look-Up Table and to the LCD Interface. It also generates memory addresses for display refresh accesses.

Look-Up Table

The Look-Up Table contains three 256×4 Look-Up Tables or palettes, one for each primary color. In monochrome mode only the green Look-Up Table is used.

LCD Interface

The LCD Interface performs frame rate modulation for passive LCD panels. It also generates the correct data format and timing control signals for various LCD and TFT/D-TFD panels.

Power Save

Power Save contains the power save mode circuitry.

4 PINS

4.1 Pin Description

Key:

I	=	Input
O	=	Output
IO	=	Bi-Directional (Input/Output)
C	=	CMOS level input
CS	=	CMOS level Schmitt input
COx	=	CMOS output driver, x denotes driver type (1=3/-1.5mA, 2=6/-3mA, 3=12/-6mA)
TSx	=	Tri-state CMOS output driver, x denotes driver type (1=3/-1.5mA, 2=6/-3mA, 3=12/-6mA)
TSxD	=	Tri-state CMOS output driver with pull down resistor (typical values of 120K Ω /200K Ω at 5V/3.3V respectively), x denotes driver type (1=3/-1.5mA, 2=6/-3mA, 3=12/-6mA)
CNx	=	CMOS low-noise output driver, x denotes driver type (1=3/-1.5mA, 2=6/-3mA, 3=12/-6mA)

LCD Interface

Table 4-1 LCD Interface Pin Descriptions

Pin Name	Type	Pin #	Cell	RESET# State	Description
FPDAT[7:0]	O	98, 99, 100, 102, 103, 104, 105, 107	CN3	0	Panel Data
FPDAT[10:8]	O, IO	93, 94, 96	CN3	Input	These pins have multiple functions. <ul style="list-style-type: none"> Panel Data bits [10:8] for TFT/D-TFD panels. General Purpose Input/Output pins GPIO[3:1]. These pins should be connected to V _{DDE2} when unused. See Table 4-5, "LCD Interface Pin Mapping," on page C-1-8 for summary.
FPDAT11	O, IO	92	CN3	Input	This pin has multiple functions. <ul style="list-style-type: none"> Panel Data bit 11 for TFT/D-TFD panels. General Purpose Input/Output pin GPIO4. Inverse Video select pin. This pin should be connected to V _{DDE2} when unused. See Table 4-5, "LCD Interface Pin Mapping," on page C-1-8 for summary.
FPFRAME	O	109	CN3	0	Frame Pulse
FPLINE	O	108	CN3	0	Line Pulse
FPSHIFT	O	97	CN3	0	Shift Clock
LCDPWR	O	112	CO1	0	Active high LCD Power Control
DRDY	O	110	CN3	0	This pin has multiple functions. <ul style="list-style-type: none"> TFT/D-TFD Display Enable (DRDY). LCD Backplane Bias (MOD). Second Shift Clock (FPSHIFT2). See Table 4-5, "LCD Interface Pin Mapping," on page C-1-8 for summary.

Clock Input

Table 4-2 Clock Input Pin Description

Pin Name	Type	Pin #	Driver	Description
CLKI	I	161	C	External Input Clock

Miscellaneous

Table 4-3 Miscellaneous Pin Descriptions

Pin Name	Type	Pin #	Cell	RESET# State	Description																																				
CKSEL[2:0]	I	157, 158, 159	C	As set by hardware	<p>These inputs configure such SED1375 block parameters as clock. See Table 4-4, "Summary of Power On/Reset Options," on page C-1-7. Note that these pins must be connected directly to V_{SS} or V_{DDE1}.</p> <p>Clock source selection</p> <table border="1"> <thead> <tr> <th>CKSEL2</th> <th>CKSEL1</th> <th>CKSEL0</th> <th>Clock source</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>1</td> <td>1</td> <td>reserved</td> </tr> <tr> <td>1</td> <td>1</td> <td>0</td> <td>SED1375 block disable mode</td> </tr> <tr> <td>1</td> <td>0</td> <td>1</td> <td>External input clock from the CLKI pin</td> </tr> <tr> <td>1</td> <td>0</td> <td>0</td> <td>OSC3 oscillation clock × 1/4</td> </tr> <tr> <td>0</td> <td>1</td> <td>1</td> <td>OSC3 oscillation clock × 1/3</td> </tr> <tr> <td>0</td> <td>1</td> <td>0</td> <td>OSC3 oscillation clock × 1/2</td> </tr> <tr> <td>0</td> <td>0</td> <td>1</td> <td>OSC3 oscillation clock</td> </tr> <tr> <td>0</td> <td>0</td> <td>0</td> <td>PLL output clock</td> </tr> </tbody> </table>	CKSEL2	CKSEL1	CKSEL0	Clock source	1	1	1	reserved	1	1	0	SED1375 block disable mode	1	0	1	External input clock from the CLKI pin	1	0	0	OSC3 oscillation clock × 1/4	0	1	1	OSC3 oscillation clock × 1/3	0	1	0	OSC3 oscillation clock × 1/2	0	0	1	OSC3 oscillation clock	0	0	0	PLL output clock
CKSEL2	CKSEL1	CKSEL0	Clock source																																						
1	1	1	reserved																																						
1	1	0	SED1375 block disable mode																																						
1	0	1	External input clock from the CLKI pin																																						
1	0	0	OSC3 oscillation clock × 1/4																																						
0	1	1	OSC3 oscillation clock × 1/3																																						
0	1	0	OSC3 oscillation clock × 1/2																																						
0	0	1	OSC3 oscillation clock																																						
0	0	0	PLL output clock																																						
CNF3	I	156	C	As set by hardware	<p>These inputs configure such SED1375 block parameters as clock. See Table 4-4, "Summary of Power On/Reset Options," on page C-1-7. Note that these pins must be connected directly to V_{SS} or V_{DDE1}.</p> <p>Access method (endian) selection 1: Big endian, 0: Little endian</p>																																				
GPIO0	IO, I	91	CS/TS1	Input	<p>This pin has multiple functions - see REG[03h] bit 2.</p> <p>General Purpose Input/Output pin.</p> <p>Hardware Power Save.</p>																																				

4.2 Summary of Configuration Options

Table 4-4 Summary of Power On/Reset Options

Configuration Pin	Power On/Reset State			
	1		0	
CNF3	Big Endian		Little Endian	
CKSEL[2:0]	Clock source selection			
	CKSEL2	CKSEL1	CKSEL0	Clock source
	1	1	1	reserved
	1	1	0	SED1375 block disable mode
	1	0	1	External input clock from the CLKI pin
	1	0	0	OSC3 oscillation clock × 1/4
	0	1	1	OSC3 oscillation clock × 1/3
	0	1	0	OSC3 oscillation clock × 1/2
	0	0	1	OSC3 oscillation clock
	0	0	0	PLL output clock

4.3 LCD Interface Pin Mapping

Table 4-5 LCD Interface Pin Mapping

SED1375 block Pin Name	Monochrome Passive Panel			Color Passive Panel				Color TFT/D-TFD		
	4-bit Single	8-bit Single	8-bit Dual	4-bit Single	8-bit Single Format 1	8-bit Single Format 2	8-bit Dual	9-bit	12-bit	
FPFRAME	FPFRAME									
FPLINE	FPLINE									
FPSHIFT	FPSHIFT									
DRDY	MOD	MOD	MOD	MOD	FPSHIFT2	MOD	MOD	DRDY		
FPDAT0	driven 0	D0	LD0	driven 0	D0	D0	LD0	R2	R3	
FPDAT1	driven 0	D1	LD1	driven 0	D1	D1	LD1	R1	R2	
FPDAT2	driven 0	D2	LD2	driven 0	D2	D2	LD2	R0	R1	
FPDAT3	driven 0	D3	LD3	driven 0	D3	D3	LD3	G2	G3	
FPDAT4	D0	D4	UD0	D0	D4	D4	UD0	G1	G2	
FPDAT5	D1	D5	UD1	D1	D5	D5	UD1	G0	G1	
FPDAT6	D2	D6	UD2	D2	D6	D6	UD2	B2	B3	
FPDAT7	D3	D7	UD3	D3	D7	D7	UD3	B1	B2	
FPDAT8	GPIO1	GPIO1	GPIO1	GPIO1	GPIO1	GPIO1	GPIO1	B0	B1	
FPDAT9	GPIO2	GPIO2	GPIO2	GPIO2	GPIO2	GPIO2	GPIO2	GPIO2	R0	
FPDAT10	GPIO3	GPIO3	GPIO3	GPIO3	GPIO3	GPIO3	GPIO3	GPIO3	G0	
FPDAT11	GPIO4/ Hardware Video Invert	GPIO4/ Hardware Video Invert	GPIO4/ Hardware Video Invert	GPIO4/ Hardware Video Invert	GPIO4/ Hardware Video Invert	GPIO4/ Hardware Video Invert	GPIO4/ Hardware Video Invert	GPIO4/ Hardware Video Invert	GPIO4	B0

- Note:** 1. Unused GPIO pins must be connected to IO V_{DDE2} .
2. Hardware Video Invert is enabled on FPDAT11 by REG[02h] bit 1.

5 REGISTERS

5.1 Register Mapping

The C332L01 maps the SED1375 block registers to the 32 bytes from 0x039FFE0 through 0x039FFFF.

5.2 Register Descriptions

Unless specified otherwise, all register bits are reset to 0 during power up. All bits marked n/a should be programmed 0.

REG[00h] Revision Code Register							Read Only.	
Address = 0x039FFE0								
Product Code Bit 5	Product Code Bit 4	Product Code Bit 3	Product Code Bit 2	Product Code Bit 1	Product Code Bit 0	Revision Code Bit 1	Revision Code Bit 0	

bits 7-2 Product Code
This is a read-only register that indicates the product code of the chip. The product code is 001001.

bits 1-0 Revision Code
This is a read-only register that indicates the revision code of the chip. The revision code is 01.

REG[01h] Mode Register 0							Read/Write.	
Address = 0x039FFE1								
TFT/STN	Dual/Single	Color/Mono	FPLINE Polarity	FPFRAME Polarity	Mask FPSHIFT	Data Width Bit 1	Data Width Bit 0	

bit 7 TFT/STN
When this bit = 0, STN (passive) panel mode is selected. When this bit = 1, TFT/D-TFD panel mode is selected. If TFT/D-TFD panel mode is selected, Dual/Single (REG[01h] bit 6) and Color/Mono (REG[01h] bit 5) are ignored. See Table 5-1 for a comprehensive description of panel selection.

bit 6 Dual/Single
When this bit = 0, Single LCD panel drive is selected. When this bit = 1, Dual LCD panel drive is selected. See Table 5-1 for a comprehensive description of panel selection.

bit 5 Color/Mono
When this bit = 0, Monochrome LCD panel drive is selected. When this bit = 1, Color LCD panel drive is selected. See Table 5-1 for a comprehensive description of panel selection.

bit 4 FPLINE Polarity
This bit controls the polarity of FPLINE in TFT/D-TFD mode (no effect in passive panel mode). When this bit = 0, FPLINE is active low. When this bit = 1, FPLINE is active high.

bit 3 FPFRAME Polarity
This bit controls the polarity of FPFRAME in TFT/D-TFD mode (no effect in passive panel mode). When this bit = 0, FPFRAME is active low. When this bit = 1, FPFRAME is active high.

5 REGISTERS

bit 2 Mask FPSHIFT
FPSHIFT is masked during non-display periods if either of the following two criteria is met:

1. Color passive panel is selected (REG[01h] bit 5 = 1)
2. This bit (REG[01h] bit 2) = 1

bits 1-0 Data Width Bits [1:0]
These bits select the display data format. See Table 5-1 below for a comprehensive description of panel selection.

Table 5-1 Panel Data Format

TFT/STN REG[01h] bit 7	Color/Mono REG[01h] bit 5	Dual/Single REG[01h] bit 6	Data Width Bit 1 REG[01h] bit 1	Data Width Bit 0 REG[01h] bit 0	Function
0	0	0	0	0	Mono Single 4-bit passive LCD
				1	Mono Single 8-bit passive LCD
			1	0	reserved
		1		reserved	
		1	0	0	reserved
				1	Mono Dual 8-bit passive LCD
	1		0	reserved	
		1	reserved		
	1	0	0	0	Color Single 4-bit passive LCD
				1	Color Single 8-bit passive LCD format 1
			1	0	reserved
				1	Color Single 8-bit passive LCD format 2
		1	0	0	reserved
				1	Color Dual 8-bit passive LCD
1			0	reserved	
			1	reserved	
1	X (don't care)		0	9-bit TFT/D-TFD panel	
	X (don't care)		1	12-bit TFT/D-TFD panel	

REG[02h] Mode Register 1							Read/Write.
Address = 0x039FFE2							
Bit-Per-Pixel Bit 1	Bit-Per-Pixel Bit 0	High Performance	Input Clock divide (CLKI/2)	Display Blank	Frame Repeat	Hardware Video Invert Enable	Software Video Invert

bits 7-6 Bit-Per-Pixel Bits [1:0]
These bits select the color or gray-scale depth (Display Mode).

Table 5-2 Gray Scale/Color Mode Selection

Color/Mono REG[01h] bit 6	Bit-Per-Pixel Bit 1 REG[02h] bit 7	Bit-Per-Pixel Bit 0 REG[02h] bit 6	Display Mode	
0	0	0	2 Gray scale	1 bit-per-pixel
		1	4 Gray scale	2 bit-per-pixel
	1	0	16 Gray scale	4 bit-per-pixel
		1	reserved	
1	0	0	2 Colors	1 bit-per-pixel
		1	4 Colors	2 bit-per-pixel
	1	0	16 Colors	4 bit-per-pixel
		1	256 Colors	8 bit-per-pixel

- bit 5 High Performance (Landscape Modes Only)
When this bit = 0, the internal Memory Clock (MCLK) is a divided-down version of the Pixel Clock (PCLK). The denominator is dependent on the bit-per-pixel mode - see the table below.

Table 5-3 High Performance Selection

High Performance	BPP Bit 1	BPP Bit 0	Display Modes	
0	0	0	MClk = PClk/8	1 bit-per-pixel
		1	MClk = PClk/4	2 bit-per-pixel
	1	0	MClk = PClk/2	4 bit-per-pixel
		1	MClk = PClk	8 bit-per-pixel
1	X	X	MClk = PClk	

When this bit = 1, MCLK is fixed to the same frequency as PCLK for all bit-per-pixel modes. This provides a faster screen update performance in 1/2/4 bit-per-pixel modes, but also increases power consumption. This bit can be set to 1 just before a major screen update, then set back to 0 to save power after the update. This bit has no effect in portrait mode. Refer to “*REG[1Bh] Portrait Mode Register*” on page C-1-19 for portrait mode clock selection.

- bit 4 Input Clock Divide
When this bit = 0, the Operating Clock (CLK) is the same as the Input Clock (CLKI).
When this bit = 1, CLK = CLKI/2.

In landscape mode PCLK=CLK and MCLK is selected as per Table 5-3 .

In portrait mode, MCLK and PCLK are derived from CLK as shown in Table 5-8, “*Selection of PCLK and MCLK in Portrait Mode,*” on page C-1-19.

- bit 3 Display Blank
This bit blanks the display image. When this bit = 1, the display is blanked (FPDAT lines to the panel are driven low). When this bit = 0, the display is enabled.
- bit 2 Frame Repeat (EL support)
This feature is used to improve Frame Rate Modulation of EL panels. When this bit = 1, an internal frame counter runs from 0 to 3FFFFh. When the frame counter rolls over, the modulated image pattern is repeated (every 1 hour when the frame rate is 72Hz). When this bit = 0, the modulated image pattern is never repeated.
- bit 1 Hardware Video Invert Enable
In passive panel modes (REG[01h] bit 7 = 0) FPDAT11 is available as either GPIO4 or hardware video invert. When this bit = 1, Hardware Video Invert is enabled via the FPDAT11 pin. When this bit = 0, FPDAT11 operates as GPIO4. See Table 5-4 below.
- Note:** Video data is inverted after the Look-Up Table.
- bit 0 Software Video Invert
When this bit = 1, Inverse Video Mode is selected. When this bit = 0, Standard Video Mode is selected. See Table 5-4 below.

Note: Video data is inverted after the Look-Up Table.

Table 5-4 Inverse Video Mode Select Options

Hardware Video Invert Enable	Software Video Invert (Passive and Active Panels)	FPDAT11 (Passive Panels Only)	Video Data
0	0	X	Normal
0	1	X	Inverse
1	X	0	Normal
1	X	1	Inverse

REG[03h] Mode Register 2							Read/Write
Address = 0x039FFE3							
n/a	n/a	n/a	n/a	LCDPWR Override	Hardware Power Save Enable	Software Power Save Bit 1	Software Power Save Bit 0

bit 3 LCDPWR Override
 When this bit = 1, LCDPWR is forced inactive, by-passing the LCD power sequencing. The 127 frame delay between Hardware Power Save and the LCD panel control signals is reduced to a single line. When this bit = 0, LCDPWR is controlled by the power sequencing logic within the SED1375 block.

bit 2 Hardware Power Save Enable
 When this bit = 1 GPIO0 is used as the Hardware Power Save input pin. When this bit = 0, GPIO0 operates normally.

Table 5-5 Hardware Power Save/GPIO0 Operation

RESET# State	Hardware Power Save Enable REG[03h] bit 2	GPIO0 Config REG[18h] bit 0	GPIO0 Status/Control REG[19h] bit 0	GPIO0 Operation
0	X	X	X	
1	0	0	reads pin status	GPIO0 Input (high impedance)
1	0	1	0	GPIO0 Output = 0
1	0	1	1	GPIO0 Output = 1
1	1	X	X	Hardware Power Save Input (active high)

bits 1-0 Software Power Save Bits [1: 0]
 These bits select the Power Save Mode as shown in the following table.

Table 5-6 Software Power Save Mode Selection

Bit 1	Bit 0	Mode
0	0	Software Power Save
0	1	reserved
1	0	reserved
1	1	Normal Operation

Refer to Section 10 “POWER SAVE MODES” on page C-1-34 for a complete description of the power save modes.

REG[04h] Horizontal Panel Size Register							Read/Write
Address = 0x039FFE4							
n/a	Horizontal Panel Size Bit 6	Horizontal Panel Size Bit 5	Horizontal Panel Size Bit 4	Horizontal Panel Size Bit 3	Horizontal Panel Size Bit 2	Horizontal Panel Size Bit 1	Horizontal Panel Size Bit 0

bits 6-0 Horizontal Panel Size Bits [6:0]
 This register determines the horizontal resolution of the panel. This register must be programmed with a value calculated as follows:

$$\text{Horizontal Panel Size Register} = \left(\frac{\text{Horizontal Panel Resolution (pixels)}}{8} \right) - 1$$

Note: This register must not be set to a value less than 03h.

REG[05h] Vertical Panel Size Register (LSB)							
Address = 0x039FFE5							Read/Write
Vertical Panel Size Bit 7	Vertical Panel Size Bit 6	Vertical Panel Size Bit 5	Vertical Panel Size Bit 4	Vertical Panel Size Bit 3	Vertical Panel Size Bit 2	Vertical Panel Size Bit 1	Vertical Panel Size Bit 0

REG[06h] Vertical Panel Size Register (MSB)							
Address = 0x039FFE6							Read/Write
n/a	n/a	n/a	n/a	n/a	n/a	Vertical Panel Size Bit 9	Vertical Panel Size Bit 8

REG[05h] bits 7-0 Vertical Panel Size Bits [9:0]

REG[06h] bits 1-0 This 10-bit register determines the vertical resolution of the panel. This register must be programmed with a value calculated as follows.:

$$\text{Vertical Panel Size Register} = \text{Vertical Panel Resolution (lines)} - 1$$

3FFh is the maximum value of this register for a vertical resolution of 1024 lines.

REG[07h] FPLINE Start Position							
Address = 0x039FFE7							Read/Write
n/a	n/a	n/a	FPLINE Start Position Bit 4	FPLINE Start Position Bit 3	FPLINE Start Position Bit 2	FPLINE Start Position Bit 1	FPLINE Start Position Bit 0

bits 4-0 FPLINE Start Position

These bits are used in TFT/D-TFD mode to specify the position of the FPLINE pulse. These bits specify the delay, in 8-pixel resolution, from the end of a line of display data (FPDAT) to the leading edge of FPLINE. This register is effective in TFT/D-TFD mode only (REG[01h] bit 7 = 1). This register is programmed as follows:

$$\text{FPLINEposition(pixels)} = (\text{REG}[07\text{h}] + 2) \times 8$$

The following constraint must be satisfied:

$$\text{REG}[07\text{h}] \leq \text{REG}[08\text{h}]$$

REG[08h] Horizontal Non-Display Period							
Address = 0x039FFE8							Read/Write
n/a	n/a	n/a	Horizontal Non-Display Period Bit 4	Horizontal Non-Display Period Bit 3	Horizontal Non-Display Period Bit 2	Horizontal Non-Display Period Bit 1	Horizontal Non-Display Period Bit 0

bits 4-0 Horizontal Non-Display Period

These bits specify the horizontal non-display period in 8-pixel resolution.

$$\text{Horizontal Non-Display Period (pixels)} = (\text{REG}[08\text{h}] + 4) \times 8$$

REG[09h] FPFRAME Start Position								Read/Write
Address = 0x039FFE9								
n/a	n/a	FPFRAME Start Position Bit 5	FPFRAME Start Position Bit 4	FPFRAME Start Position Bit 3	FPFRAME Start Position Bit 2	FPFRAME Start Position Bit 1	FPFRAME Start Position Bit 0	

bits 5-0 FPFRAME Start Position

These bits are used in TFT/D-TFD mode to specify the position of the FPFRAME pulse. These bits specify the number of lines between the last line of display data (FPDAT) and the leading edge of FPFRAME. This register is effective in TFT/D-TFD mode only (REG[01h] bit 7 = 1). This register is programmed as follows:

$$\text{FPFRAMEposition(lines)} = \text{REG}[09\text{h}]$$

The contents of this register must be greater than zero and less than or equal to the Vertical Non-Display Period Register, i.e.

$$1 \leq \text{REG}[09\text{h}] \leq \text{REG}[0\text{Ah}]$$

REG[0Ah] Vertical Non-Display Period								Read/Write
Address = 0x039FFE9								
Vertical Non-Display Status	n/a	Vertical Non-Display Period Bit 5	Vertical Non-Display Period Bit 4	Vertical Non-Display Period Bit 3	Vertical Non-Display Period Bit 2	Vertical Non-Display Period Bit 1	Vertical Non-Display Period Bit 0	

bit 7 Vertical Non-Display Status

This bit =1 during the Vertical Non-Display period.

bits 5-0 Vertical Non-Display Period

These bits specify the vertical non-display period. This register is programmed as follows:

$$\text{Vertical Non-Display Period (lines)} = \text{REG}[0\text{Ah}] \text{ bits } [5:0]$$

Note: This register should be set only once, on power-up during initialization.

REG[0Bh] MOD Rate Register								Read/Write
Address = 0x039FFEB								
n/a	n/a	MOD Rate Bit 5	MOD Rate Bit 4	MOD Rate Bit 3	MOD Rate Bit 2	MOD Rate Bit 1	MOD Rate Bit 0	

bits 5-0 MOD Rate Bits [5:0]

When the value of this register is 0, the MOD output signal toggles every FPFRAME. For a non-zero value, the value in this register + 1 specifies the number of FPLINEs between toggles of the MOD output signal. These bits are for passive LCD panels only.

REG[0Ch] Screen 1 Start Address Register (LSB)							Read/Write
Address = 0x039FFEC							
Screen 1 Start Address Bit 7	Screen 1 Start Address Bit 6	Screen 1 Start Address Bit 5	Screen 1 Start Address Bit 4	Screen 1 Start Address Bit 3	Screen 1 Start Address Bit 2	Screen 1 Start Address Bit 1	Screen 1 Start Address Bit 0

REG[0Dh] Screen 1 Start Address Register (MSB)							Read/Write
Address = 0x039FFED							
Screen 1 Start Address Bit 15	Screen 1 Start Address Bit 14	Screen 1 Start Address Bit 13	Screen 1 Start Address Bit 12	Screen 1 Start Address Bit 11	Screen 1 Start Address Bit 10	Screen 1 Start Address Bit 9	Screen 1 Start Address Bit 8

REG[0Dh] bits 7-0 Screen 1 Start Address Bits [15:0]

REG[0Ch] bits 7-0 These bits determine the **word address** of the start of Screen 1 in Landscape modes or the **byte address** of the start of Screen 1 in Portrait modes.

Note: For Portrait mode the most significant bit (bit 16) is located in REG[10h].

REG[0Eh] Screen 2 Start Address Register (LSB)							Read/Write
Address = 0x039FFEE							
Screen 2 Start Address Bit 7	Screen 2 Start Address Bit 6	Screen 2 Start Address Bit 5	Screen 2 Start Address Bit 4	Screen 2 Start Address Bit 3	Screen 2 Start Address Bit 2	Screen 2 Start Address Bit 1	Screen 2 Start Address Bit 0

REG[0Fh] bits 7-0 Screen 2 Start Address Bits [15:0]

REG[0Eh] bits 7-0 These bits determine the **word address** of the start of Screen 2 in Landscape modes only and has no effect in Portrait modes.

REG[10h] Screen Start Address Overflow Register							Read/Write
Address = 0x039FFF0							
n/a	n/a	n/a	n/a	n/a	n/a	n/a	Screen 1 Start Address Bit 16

bit 0 Screen 1 Start Address Bit 16

This bit is the most significant bit of Screen 1 Start Address for Portrait mode. This bit has no effect in Landscape mode.

REG[11h] Memory Address Offset Register							
Address = 0x039FFF1							Read/Write
Memory Address Offset Bit 7	Memory Address Offset Bit 6	Memory Address Offset Bit 5	Memory Address Offset Bit 4	Memory Address Offset Bit 3	Memory Address Offset Bit 2	Memory Address Offset Bit 1	Memory Address Offset Bit 0

bits 7-0 Memory Address Offset Bits [7:0] (Landscape Modes Only)

This register is used to create a virtual image by setting a word offset between the last address of one line and the first address of the following line. If this register is not equal to zero, then a virtual image is formed. The displayed image is a window into the larger virtual image. See Figure 5-1, “*Screen-Register Relationship*,” on page C-1-17.

This register has no effect in portrait modes. See “*REG[1Ch] Line Byte Count Register for Portrait Mode*” on page C-1-20.

REG[12h] Screen 1 Vertical Size Register (LSB)							
Address = 0x039FFF2							Read/Write
Screen 1 Vertical Size Bit 7	Screen 1 Vertical Size Bit 6	Screen 1 Vertical Size Bit 5	Screen 1 Vertical Size Bit 4	Screen 1 Vertical Size Bit 3	Screen 1 Vertical Size Bit 2	Screen 1 Vertical Size Bit 1	Screen 1 Vertical Size Bit 0

REG[13h] Screen 1 Vertical Size Register (MSB)							
Address = 0x039FFF3							Read/Write
n/a	n/a	n/a	n/a	n/a	n/a	Screen 1 Vertical Size Bit 9	Screen 1 Vertical Size Bit 8

REG[13h] bits 1-0 Screen 1 Vertical Size Bits [9:0]

REG[12h] bits 7-0 These bits determine the height (in lines) of Screen 1.

In landscape modes, if this register is programmed with a value, n, where n is less than the Vertical Panel Size (REG[06h], REG[05h]), then lines 0 to n of the panel contain Screen 1 and lines n+1 to REG[06h], REG[05h] of the panel contain Screen 2. See Figure 5-1, “*Screen-Register Relationship*,” on page C-1-17.

In portrait modes this register must be programmed greater than, or equal to the Vertical Panel Size, REG[06h] and REG[05h]. See “*9 PORTRAIT MODE*” on page C-1-29.

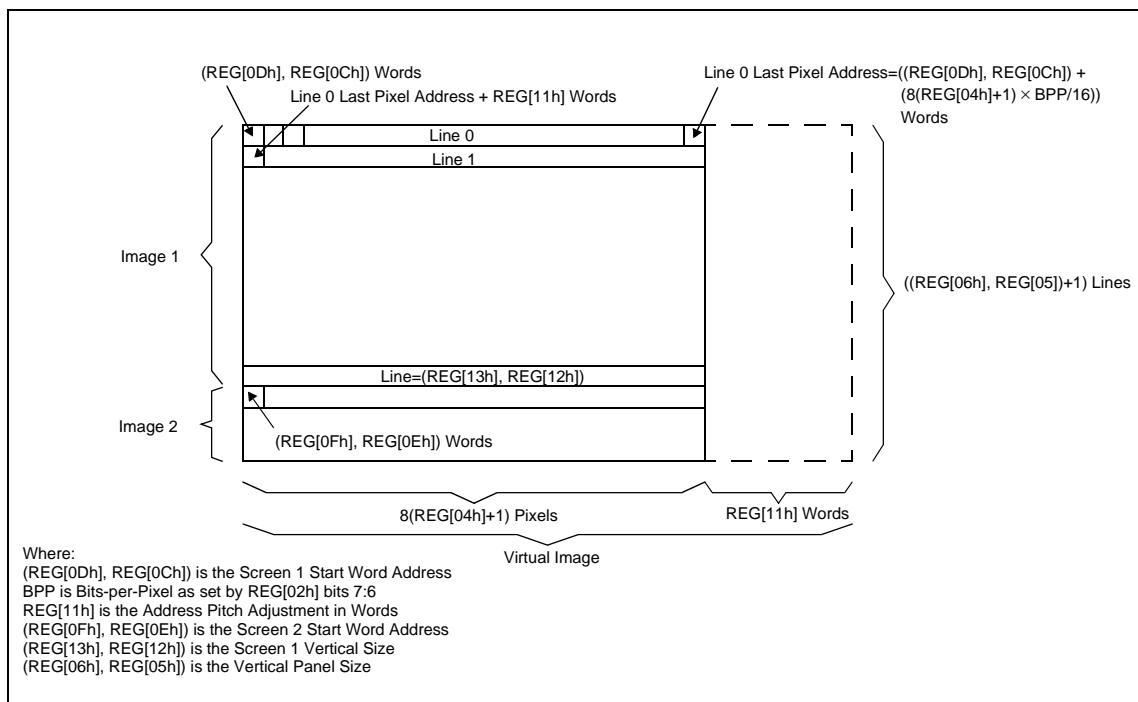


Figure 5-1 Screen-Register Relationship

Consider an example where REG[13h], REG[12] = 0CEh for a 320×240 display system. The upper 207 lines (CEh + 1) of the panel show an image from the Screen 1 Start Word Address. The remaining 33 lines show an image from the Screen 2 Start Word Address.

REG[15h] Look-Up Table Address Register							Read/Write
Address = 0x039FFF5							
LUT Address Bit 7	LUT Address Bit 6	LUT Address Bit 5	LUT Address Bit 4	LUT Address Bit 3	LUT Address Bit 2	LUT Address Bit 1	LUT Address Bit 0

bits 7-0 LUT Address Bits [7:0]

These 8 bits control a pointer into the Look-Up Tables (LUT). The SED1375 block has three 256-position, 4-bit wide LUTs, one for each of red, green, and blue – refer to Section 8 “LOOK-UP TABLE ARCHITECTURE” on page C-1-23 for details.

This register selects which LUT entry is read/write accessible through the LUT Data Register (REG[17h]). Writing the LUT Address Register automatically sets the pointer to the Red LUT. Accesses to the LUT Data Register automatically increment the pointer.

For example, writing a value 03h into the LUT Address Register sets the pointer to R[3]. A subsequent access to the LUT Data Register accesses R[3] and moves the pointer onto G[3]. Subsequent accesses to the LUT Data Register move the pointer onto B[3], R[4], G[4], B[4], R[5], etc.

Note: The RGB data is inserted into the LUT after the Blue data is written, i.e. all three colors must be written before the LUT is updated.

REG[17h] Look-Up Table Data Register							Read/Write
Address = 0x039FFF7							
LUT Data Bit 3	LUT Data Bit 2	LUT Data Bit 1	LUT Data Bit 0	n/a	n/a	n/a	n/a

bits 7-4 LUT Data Bits [3:0]

This register is used to read/write the RGB Look-Up Tables. This register accesses the entry at the pointer controlled by the Look-Up Table Address Register (REG[15h]).

Accesses to the Look-Up Table Data Register automatically increment the pointer.

Note: The RGB data is inserted into the LUT after the Blue data is written, i.e. all three colors must be written before the LUT is updated.

REG[18h] GPIO Configuration Control Register							Read/Write
Address = 0x039FFF8							
n/a	n/a	n/a	GPIO4 Pin IO Configuration	GPIO3 Pin IO Configuration	GPIO2 Pin IO Configuration	GPIO1 Pin IO Configuration	GPIO0 Pin IO Configuration

bits 4-0 GPIO[4:0] Pin IO Configuration

These bits determine the direction of the GPIO[4:0] pins.

When the GPIO Pin IO Configuration bit = 0, the corresponding GPIO pin is configured as an input. The input can be read at the GPIO Status/Control Register bit. See “REG[19h] GPIO Status/Control Register”.

When the GPIO Pin IO Configuration bit = 1, the corresponding GPIO pin is configured as an output. The output can be controlled by writing the GPIO Status/Control Register bit.

Note: These bits have no effect when the GPIO pin is configured for a specific function (i.e. as FPDAT[11:8] for TFT/D-TFD operation).

REG[19h] GPIO Status/Control Register							Read/Write
Address = 0x039FFF9							
n/a	n/a	n/a	GPIO4 Pin IO Status	GPIO3 Pin IO Status	GPIO2 Pin IO Status	GPIO1 Pin IO Status	GPIO0 Pin IO Status

bits 4-0 GPIO[4:0] Status

When the GPIO pin is configured as an input, the corresponding GPIO Status bit is used to read the pin input. See REG[18h] above.

When the GPIO pin is configured as an output, the corresponding GPIO Status bit is used to control the pin output.

REG[1Ah] Scratch Pad Register							Read/Write
Address = 0x039FFFA							
Scratch bit 7	Scratch bit 6	Scratch bit 5	Scratch bit 4	Scratch bit 3	Scratch bit 2	Scratch bit 1	Scratch bit 0

bits 7-0 Scratch Pad Register

This register contains general use read/write bits. These bits have no effect on hardware.

REG[1Bh] Portrait Mode Register							Read/Write	
Address = 0x039FFB								
Portrait Mode Enable	Portrait Mode Select	n/a	n/a	n/a	reserved	Portrait Mode Pixel Clock Select Bit 1	Portrait Mode Pixel Clock Select Bit 0	

- bit 7 Portrait Mode Enable
When this bit = 1, Portrait Mode is enabled. When this bit = 0, Landscape Mode is enabled.
- bit 6 Portrait Mode Select
When this bit = 0, Default Portrait Mode is selected. When this bit = 1, Alternate Portrait Mode is selected. See Section 9 “PORTRAIT MODE” on page C-1-29 for further information on Portrait Mode.

The following table shows the selection of Portrait Mode.

Table 5-7 Selection of Portrait Mode

Portrait Mode Enable (REG[1Bh] bit 7)	Portrait Mode Select (REG[1Bh] bit 6)	Mode
0	X	Landscape
1	0	Default Portrait
1	1	Alternate Portrait

- bit 2 reserved
reserved bits must be set to 0.
- bits 1-0 Portrait Mode Pixel Clock Select Bits [1:0]
These two bits select the Pixel Clock (PCLK) source in Portrait Mode - these bits have no effect in Landscape Mode. The following table shows the selection of PCLK and MCLK in Portrait Mode - see Section 9 “PORTRAIT MODE” on page C-1-29 for details.

Table 5-8 Selection of PCLK and MCLK in Portrait Mode

Portrait Mode Enable (REG[1Bh] bit 7)	Portrait Mode Select (REG[1Bh] bit 6)	Pixel Clock (PCLK) Select (REG[1Bh] bits [1:0])		PCLK =	MCLK =
		Bit 1	Bit 0		
0	X	X	X	CLK	See Reg[02h] bit 5
1	0	0	0	CLK	CLK
1	0	0	1	CLK/2	CLK/2
1	0	1	0	CLK/4	CLK/4
1	0	1	1	CLK/8	CLK/8
1	1	0	0	CLK/2	CLK
1	1	0	1	CLK/2	CLK
1	1	1	0	CLK/4	CLK/2
1	1	1	1	CLK/8	CLK/4

Where CLK is CLKI (REG[02h] bit 4 = 0) or CLKI/2 (REG[02h] bit 4 = 1)

REG[1Ch] Line Byte Count Register for Portrait Mode							Read/Write
Address = 0x039FFFC							
Line Byte Count bit 7	Line Byte Count bit 6	Line Byte Count bit 5	Line Byte Count bit 4	Line Byte Count bit 3	Line Byte Count bit 2	Line Byte Count bit 1	Line Byte Count bit 0

bits 7-0 Line Byte Count Bits [7:0]

This register is the byte count from the beginning of one line to the beginning of the next consecutive line (commonly called “stride” by programmers). This register may be used to create a virtual image in portrait mode.

When this register = 00 the “stride” = 256 bytes. This value is used for 240×320 8 bpp default portrait mode

When the Line Byte Count Register = n, where $1 \leq n \leq FFh$, the “stride” = n bytes.

REG[1Eh] and REG[1Fh] (Address = 0x039FFFE to 0x039FFF)

REG[1Eh] and REG[1Fh] are reserved for factory SED1375 block testing and should not be written. Any value written to these registers may result in damage to the SED1375 block and/or any panel connected to the SED1375 block.

6 FRAME RATE CALCULATION

The following formulae are used to calculate the display frame rate.

TFT/D-TFD and Passive Single-Panel modes

$$\text{FrameRate} = \frac{f_{\text{PCLK}}}{(\text{HDP} + \text{HNDP}) \times (\text{VDP} + \text{VNDP})}$$

Where: f_{PCLK} = PCLK frequency (Hz)

HDP = Horizontal Display Period = ((REG[04h] bits 6-0) + 1) × 8 Pixels

HNDP = Horizontal Non-Display Period = ((REG[08h] bits 4-0) + 4) × 8 Pixels

VDP = Vertical Display Period = ((REG[06h] bits 1-0, REG[05h] bits 7-0) + 1) Lines

VNDP = Vertical Non-Display Period = (REG[0Ah] bits 5-0) Lines

Passive Dual-Panel mode

$$\text{FrameRate} = \frac{f_{\text{PCLK}}}{2 \times (\text{HDP} + \text{HNDP}) \times \left(\frac{\text{VDP}}{2} + \text{VNDP} \right)}$$

Where: f_{PCLK} = PCLK frequency (Hz)

HDP = Horizontal Display Period = ((REG[04h] bits 6-0) + 1) × 8 Pixels

HNDP = Horizontal Non-Display Period = ((REG[08h] bits 4-0) + 4) × 8 Pixels

VDP = Vertical Display Period = ((REG[06h] bits 1-0, REG[05h] bits 7-0) + 1) Lines

VNDP = Vertical Non-Display Period = (REG[0Ah] bits 5-0) Lines

7 DISPLAY DATA FORMATS

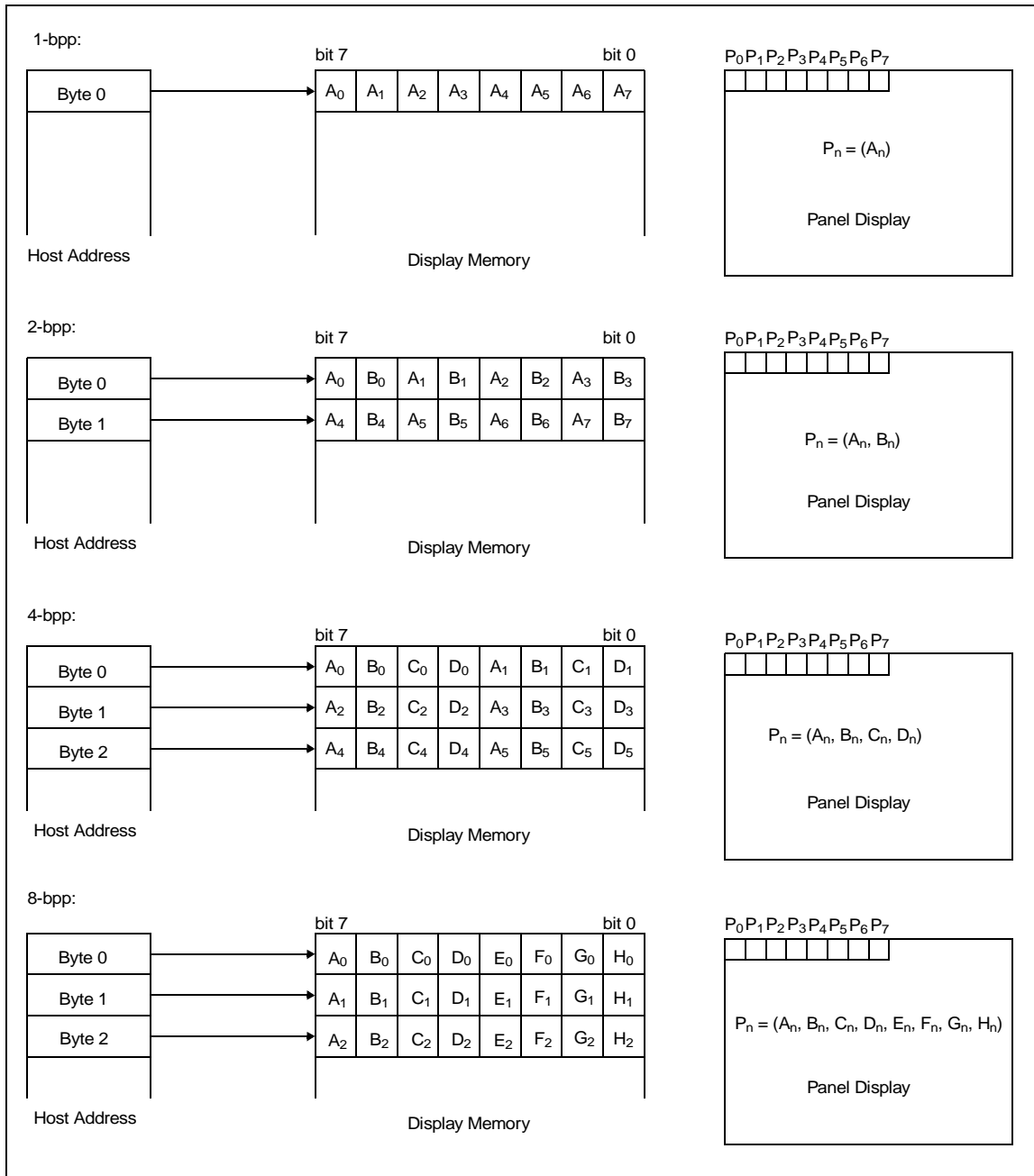


Figure 7-1 1/2/4/8 Bit-Per-Pixel Display Data Memory Organization

8 LOOK-UP TABLE ARCHITECTURE

The following figures are intended to show the display data output path only.

Note: When Video Data Invert is enabled the video data is inverted after the Look-Up Table.

8.1 Monochrome Modes

The green Look-Up Table (LUT) is used for all monochrome modes.

1 Bit-per-pixel Monochrome Mode

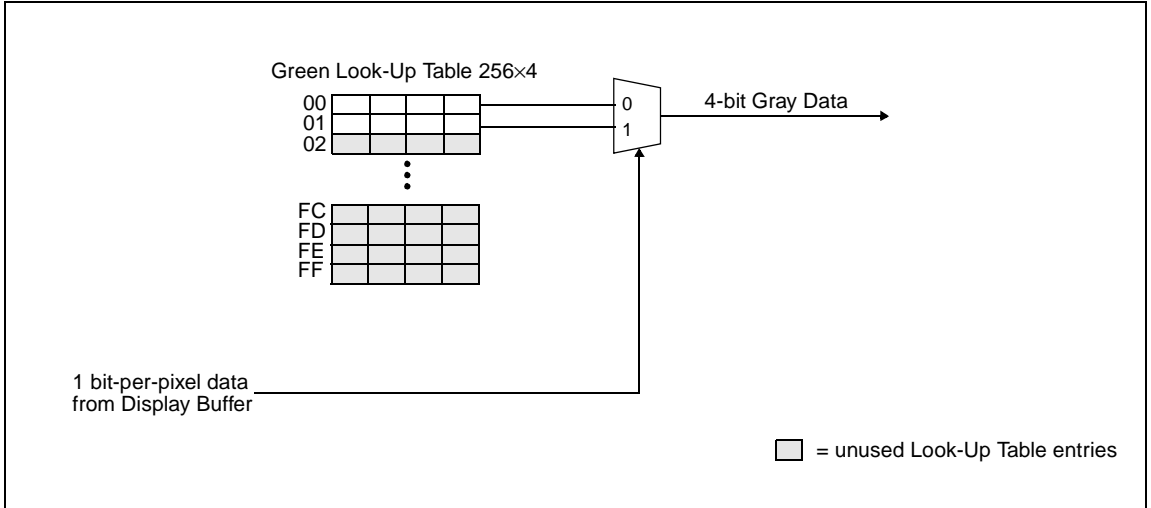


Figure 8-1 1 Bit-per-pixel Monochrome Mode Data Output Path

2 Bit-per-pixel Monochrome Mode

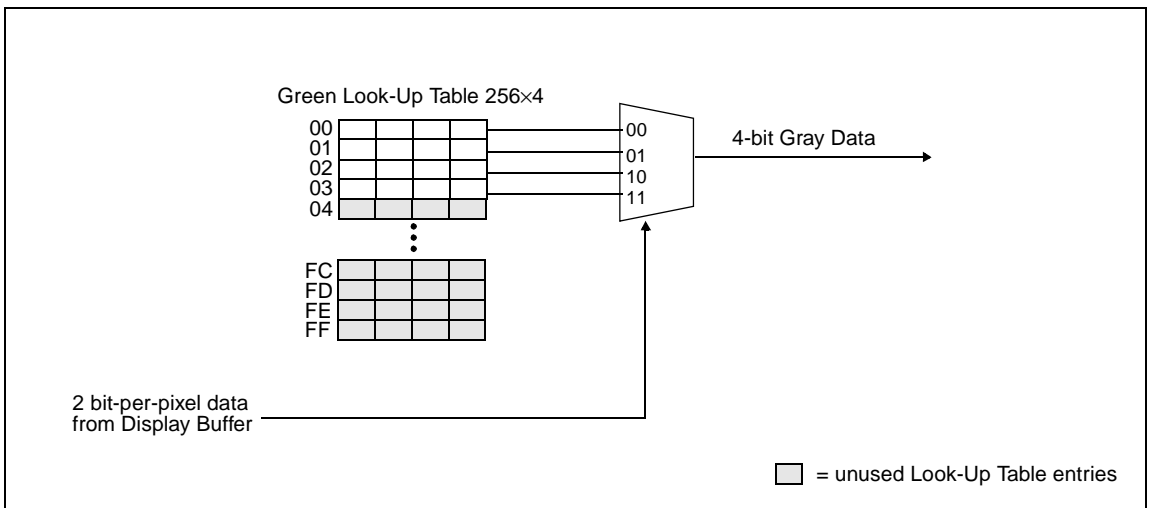


Figure 8-2 2 Bit-per-pixel Monochrome Mode Data Output Path

4 Bit-per-pixel Monochrome Mode

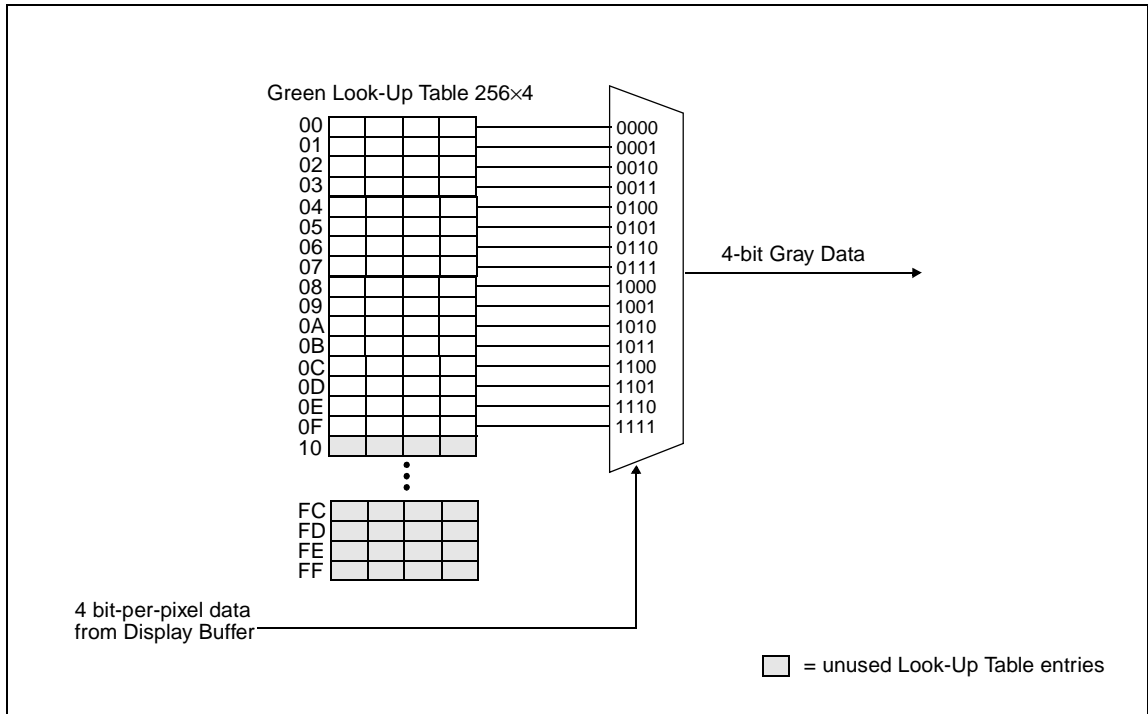


Figure 8-3 4 Bit-per-pixel Monochrome Mode Data Output Path

8.2 Color Modes

1 Bit-per-pixel Color Mode

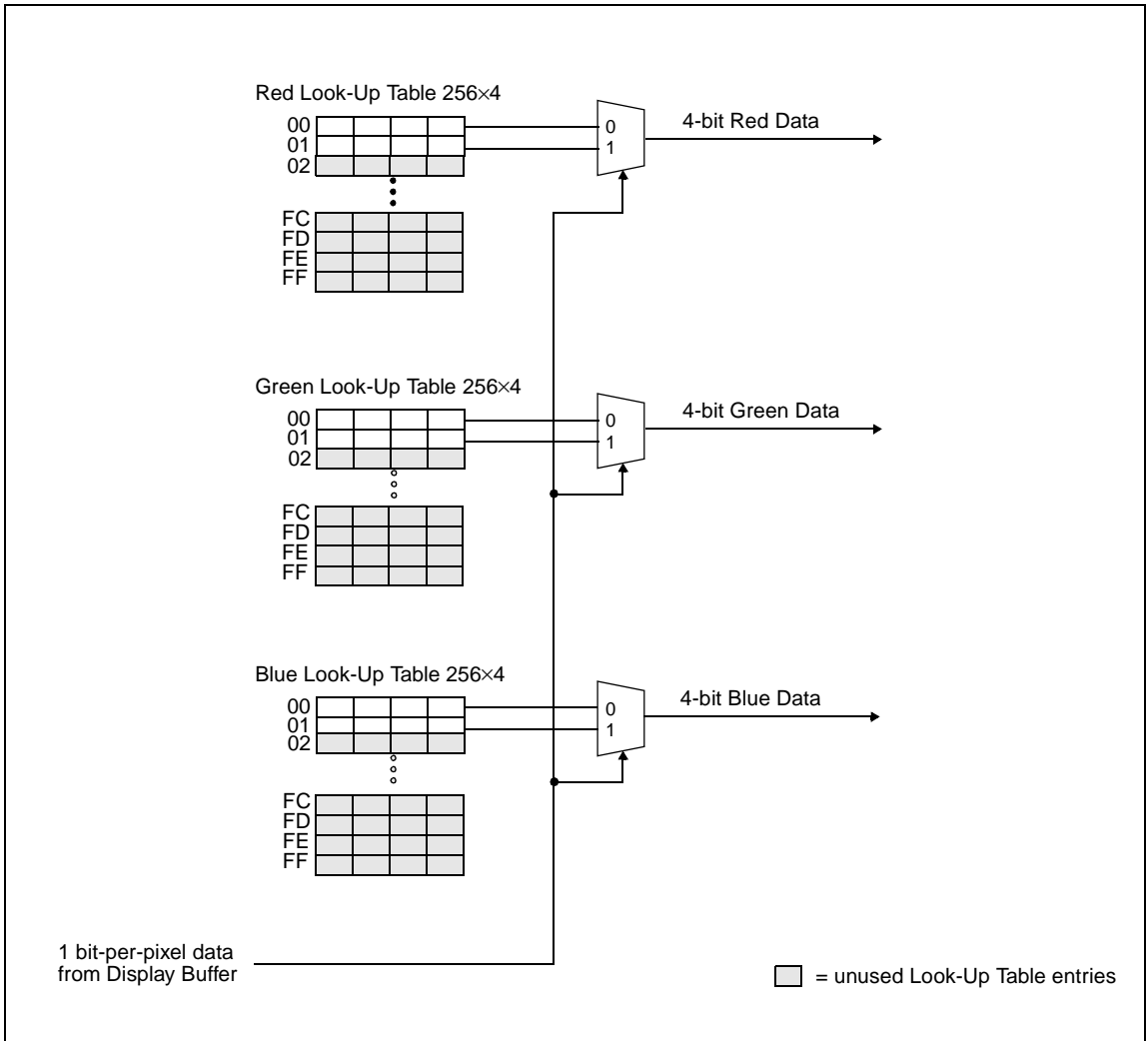


Figure 8-4 1 Bit-per-pixel Color Mode Data Output Path

2 Bit-per-pixel Color Mode

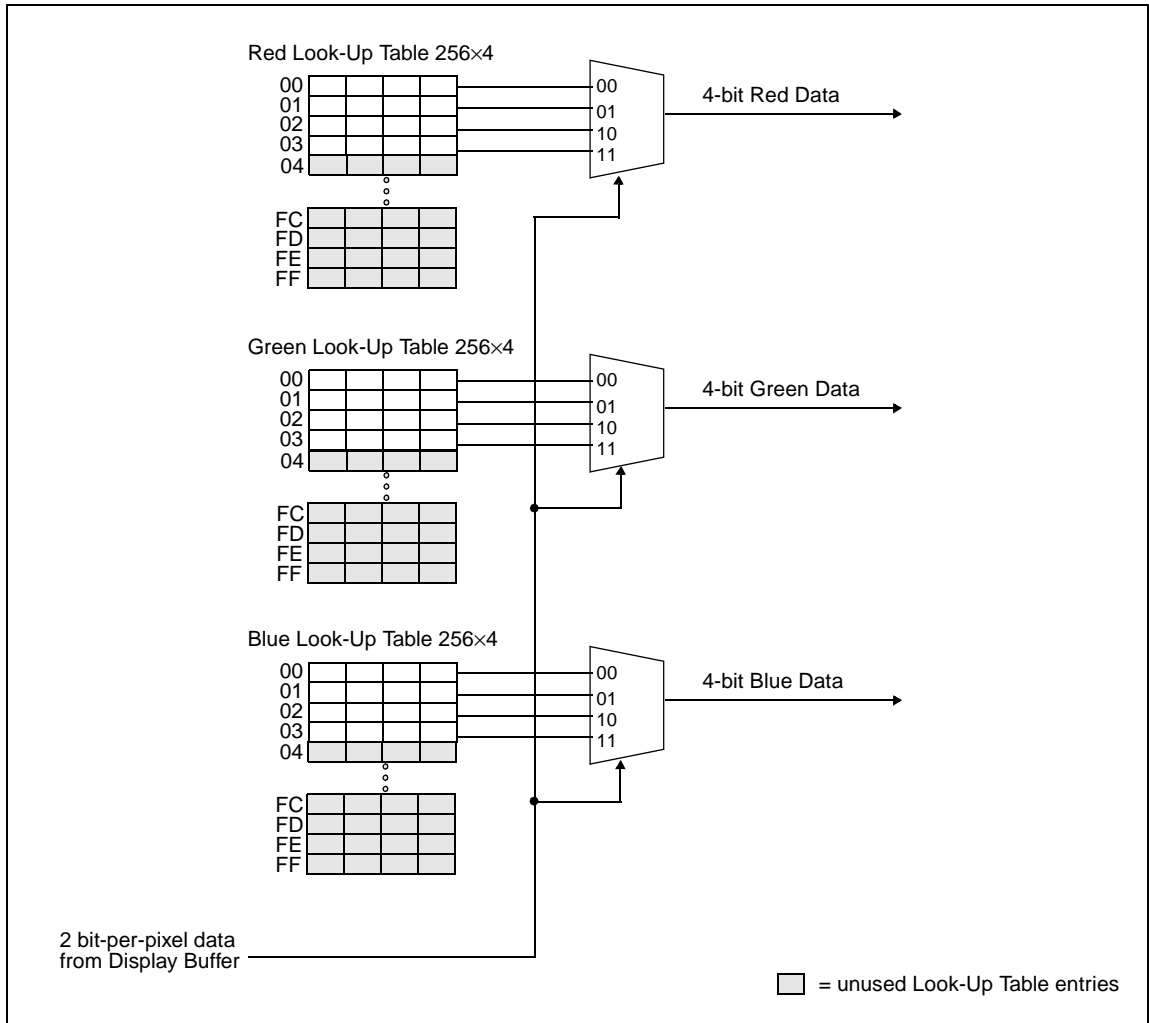


Figure 8-5 2 Bit-per-pixel Color Mode Data Output Path

4 Bit-per-pixel Color Mode

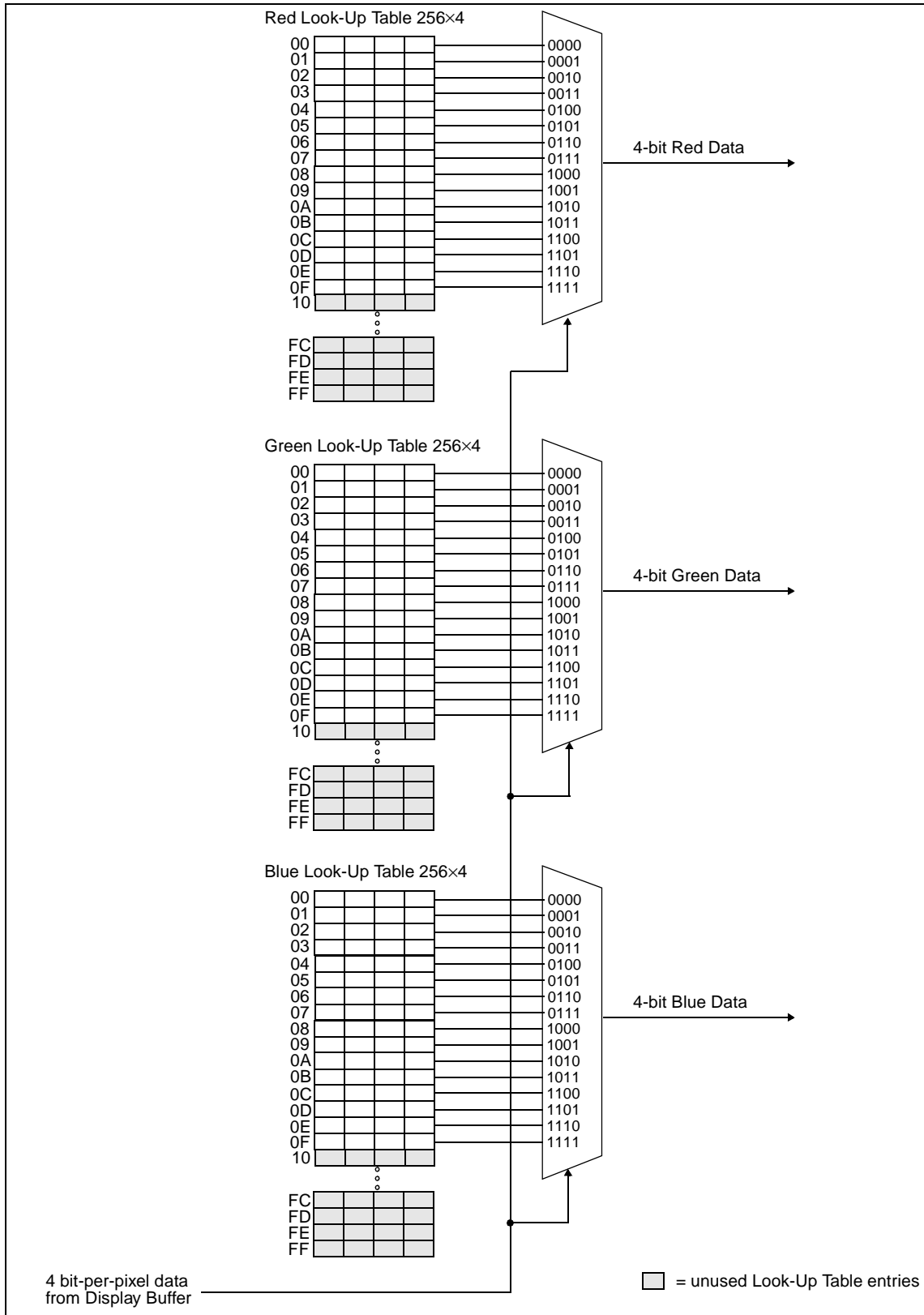


Figure 8-6 4 Bit-per-pixel Color Mode Data Output Path

8 Bit-per-pixel Color Mode

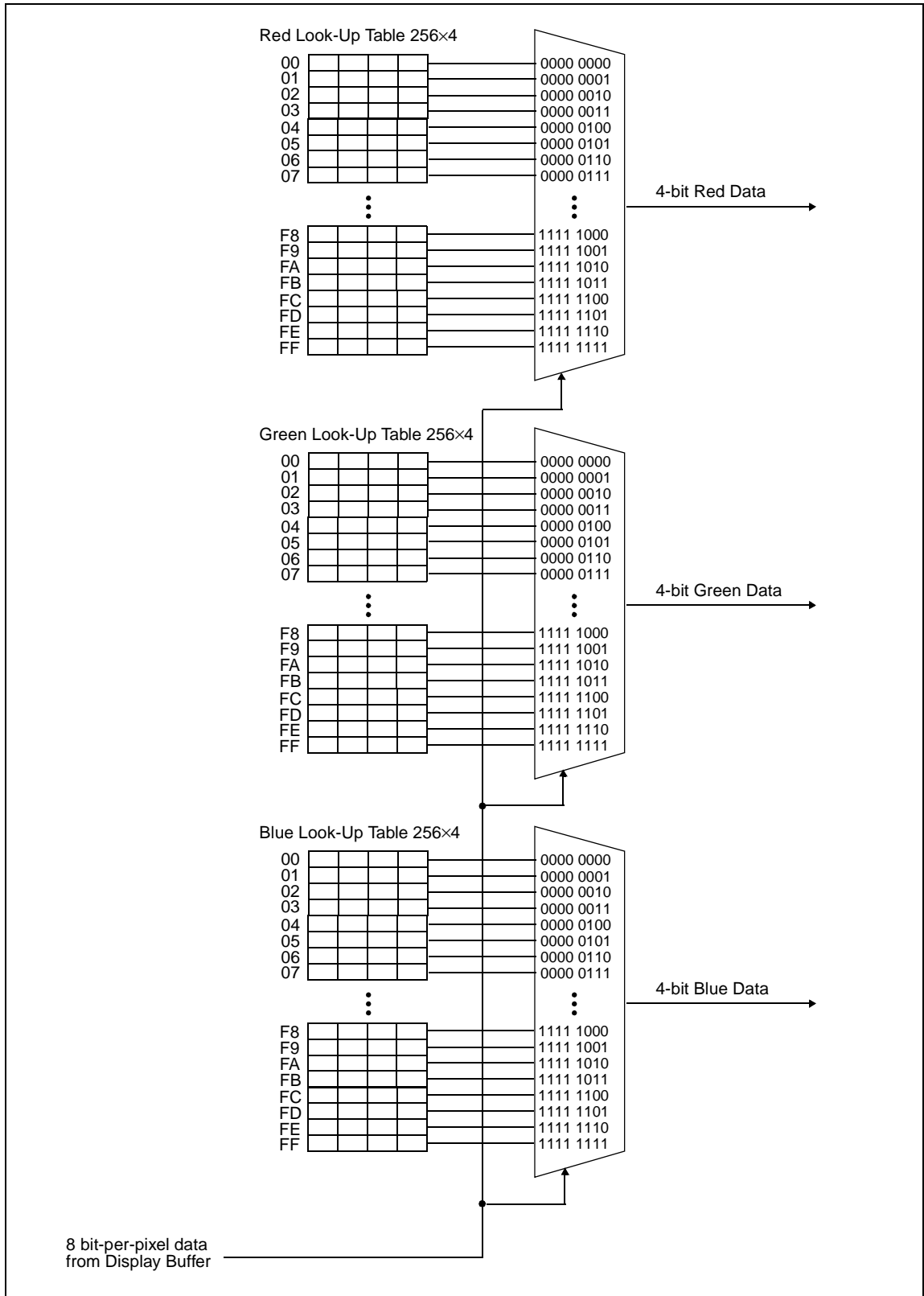


Figure 8-7 8 Bit-per-pixel Color Mode Data Output Path

9 PORTRAIT MODE

Many of today's applications use the LCD panel in a portrait orientation. In this case it becomes necessary to "rotate" the displayed image by 90°. This rotation can be done by software at the expense of performance or, it can be done by the SED1375 block hardware with no CPU penalty.

There are two portrait modes: Default Portrait Mode and Alternate Portrait Mode.

9.1 Default Portrait Mode

Default Portrait Mode requires the portrait image width be a power of two, e.g. a 240-line panel requires a minimum virtual image width of 256. This mode should be used whenever the required virtual image can be contained within the integrated display buffer (i.e. virtual image size \leq 40K bytes), as it consumes less power than the Alternate Portrait Mode.

The virtual image size for a 320×240 panel, for example, is 320×256 . The virtual image size is 320×256 which can be contained within the 40K Byte display buffer.

Default Portrait Mode also requires Memory Clock (MCLK) \geq Pixel Clock (PCLK).

The following figure shows how the programmer sees a 240×320 image and how the image is displayed. The application image is written to the SED1375 block in the following sense: A-B-C-D. The display is refreshed by the SED1375 block in the following sense: B-D-A-C.

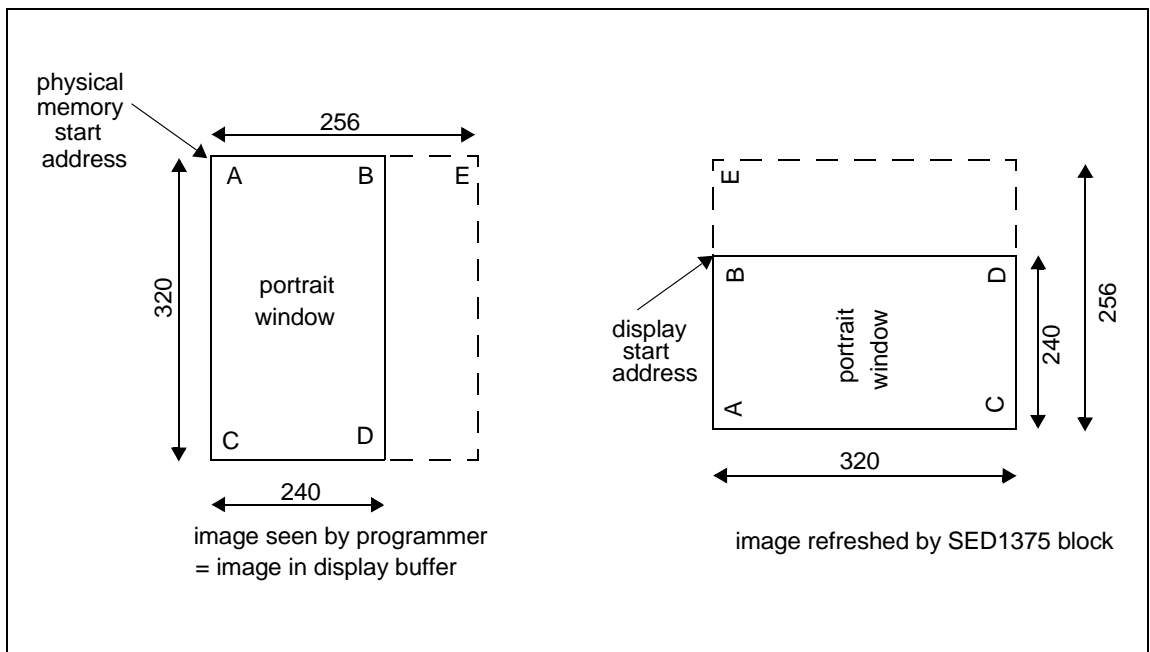


Figure 9-1 Relationship Between The Screen Image and the Image Refreshed by SED1375 block in Default Mode

How to Set Up Default Portrait Mode

The following describes the register settings needed to set up Default Portrait Mode for a 240×320×2 bpp image:

- Select Default Portrait Mode: REG[1Bh] bit 7 = 1 and bit 6 = 0
- The display refresh circuitry starts at pixel “B”, therefore the Screen 1 Start Address register must be programmed with the address of pixel “B”, i.e.

$$\begin{aligned} \text{REG}[10\text{Eh}], \text{REG}[0\text{Dh}], \text{REG}[0\text{Ch}] &= \text{AddressOfPixelB} \\ &= (\text{AddressOfPixelA} + \text{ByteOffset}) \\ &= \text{AddressOfPixelA} + \left(\frac{240 \text{ pixels} \times 2\text{bpp}}{8\text{bpb}} \right) - 1 \\ &= \text{AddressOfPixelA} + 3\text{Bh} \end{aligned}$$

Where bpb is bits-per-pixel and bpb is bits-per-byte.

- The Line Byte Count Register for Portrait Mode must be set to the virtual-image width in bytes, i.e.

$$\text{REG}[1\text{Ch}] = \frac{256}{(8\text{bpb}) \div (2\text{bpp})} = \frac{256}{4} = 64 = 40\text{h}$$

Where bpb is bits-per-byte and bpp is bits-per-pixel.

- Panning is achieved by changing the Screen 1 Start Address register:
- Increment the register by 1 to pan horizontally by one byte, e.g. four pixels in 2 bpp mode
- Increment the register by twice the effective value of the Line Byte Count register to pan vertically by two lines, e.g. add 800h to pan by two lines in the example above.

Note: Vertical panning by a single line is not supported in Default Portrait Mode.

9.2 Alternate Portrait Mode

Alternate Portrait Mode may be used when the virtual image size of Default Portrait Mode cannot be contained in the 40K byte integrated frame buffer. For example, the panel size is 480×320 and the display mode is 2 bit-per-pixel. The minimum virtual image size for Default Portrait Mode would be 480×512 which requires 61,440 bytes. Alternate Portrait Mode requires a panel size of only 480×320 which needs only 38,400 bytes.

Alternate Portrait Mode requires the Memory Clock (MCLK) to be at least twice the frequency of the Pixel Clock (PCLK), i.e. $MCLK \geq 2 \times PCLK$. This makes the power consumption in Alternate Portrait Mode higher than in Default Portrait Mode.

The following figure shows how the programmer sees a 480×320 image and how the image is being displayed. The application image is written to the SED1375 block in the following sense: A–B–C–D. The display is refreshed by the SED1375 block in the following sense: B–D–A–C.

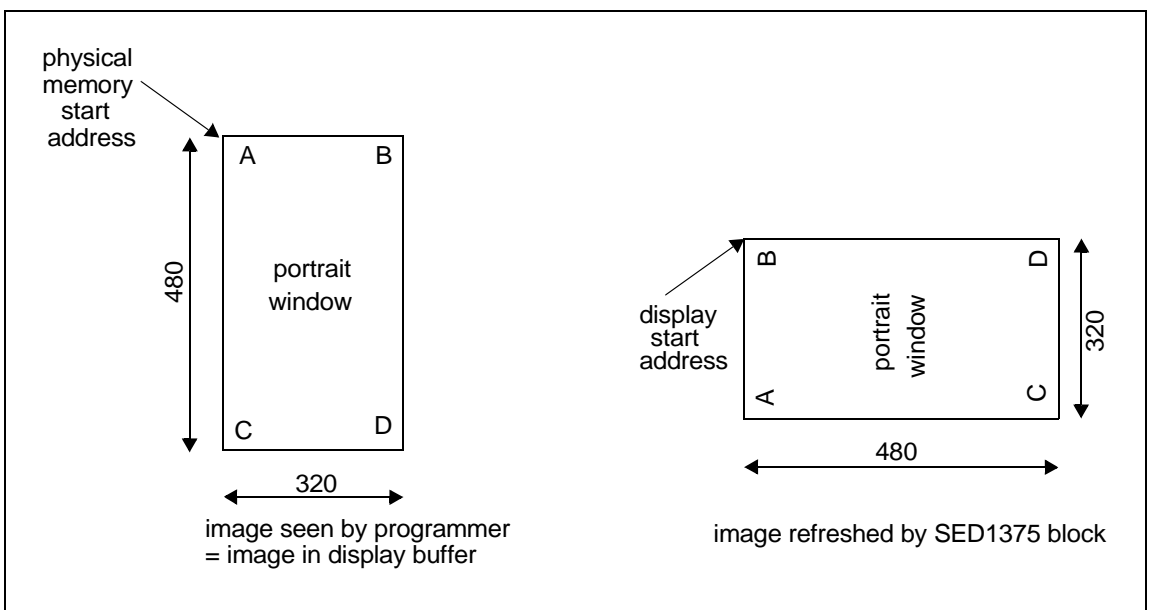


Figure 9-2 Relationship Between The Screen Image and the Image Refreshed by SED1375 block in Alternate Mode

How to Set Up Alternate Portrait Mode

The following describes the register settings needed to set up Alternate Portrait Mode for a 320×240×4 bpp image.

- Select Alternate Portrait Mode:
REG[1Bh] bit 7 = 1 and bit 6 = 1
- The display refresh circuitry starts at pixel “B”, therefore the Screen 1 Start Address register must be programmed with the address of pixel “B”, or

$$\begin{aligned}
 \text{REG}[10\text{Eh}], \text{REG}[0\text{Dh}], \text{REG}[0\text{Ch}] &= \text{Address Of Pixel B} \\
 &= (\text{Address Of Pixel A} + \text{Byte Offset}) \\
 &= \text{Address Of Pixel A} + \left(\frac{320 \text{ pixels} \times 4 \text{ bpp}}{8 \text{ bpb}} \right) - 1 \\
 &= \text{Address Of Pixel A} + 9\text{Fh}
 \end{aligned}$$

Where bpb is bits-per-pixel and bpb is bits-per-byte.

- The Line Byte Count Register for Portrait Mode must be set to the image width in bytes, i.e.

$$\text{REG}[1\text{Ch}] = \frac{320}{(8\text{bpb}) \div (4\text{bpp})} = \frac{320}{2} = 160 = \text{A0h}$$

Where bpb is bits-per-byte and bpp is bits-per-pixel.

- Panning is achieved by changing the Screen 1 Start Address register:
- Increment the register by 1 to pan horizontally by one byte, e.g. two pixels in 4 bpp mode
- Increment the register by the value in the Line Byte Count register to pan vertically by one line, e.g. add A0h to pan by one line in the example above

9.3 Comparison Between Default and Alternate Portrait Modes

Table 9-1 Default and Alternate Portrait Mode Comparison

Item	Default Portrait Mode	Alternate Portrait Mode
Memory Requirements	The width of the rotated image must be a power of 2. In most cases, a virtual image is required where the right-hand side of the virtual image is unused and memory is wasted. For example, a $320 \times 240 \times 4\text{bpp}$ image would normally require only 38,400 bytes - possible within the 40K byte address space, but the virtual image is $512 \times 240 \times 4\text{bpp}$ which needs 61,440 bytes - not possible.	Does not require a virtual image.
Clock Requirements	CLK need only be as fast as the required PCLK.	MCLK, and hence CLK, need to be $2 \times \text{PCLK}$. For example, if the panel requires a 3MHz PCLK, then CLK must be 6MHz. Note that 25MHz is the maximum CLK, so PCLK cannot be higher than 12.5MHz in this mode.
Power Consumption	Lowest power consumption.	Higher than Default Mode.
Panning	Vertical panning in 2 line increments.	Vertical panning in 1 line increments.
Performance	Nominal performance.	Higher performance than Default Mode.

9.4 Portrait Mode Limitations

The only limitation to using portrait mode on the SED1375 block is that split screen operation is not supported.

10 POWER SAVE MODES

Two Power Save Modes have been incorporated into the SED1375 block to accommodate the need for power reduction in the hand-held devices market. These modes are enabled as follows:

Table 10-1 Power Save Mode Selection

Hardware Power Save	Software Power Save Bit 1	Software Power Save Bit 0	Mode
Not Configured or 0	0	0	Software Power Save Mode
Not Configured or 0	0	1	reserved
Not Configured or 0	1	0	reserved
Not Configured or 0	1	1	Normal Operation
Configured and 1	X	X	Hardware Power Save Mode

10.1 Software Power Save Mode

Software Power Save Mode saves power by powering down the panel and stopping display refresh accesses to the display buffer.

Table 10-2 Software Power Save Mode Summary

• Registers read/write accessible
• Memory read/write accessible
• Look-Up Table registers not accessible
• LCD outputs are forced low

10.2 Hardware Power Save Mode

Hardware Power Save Mode saves power by powering down the panel, stopping accesses to the display buffer and registers, and disabling the Host Bus Interface.

Table 10-3 Hardware Power Save Mode Summary

• Host Interface not accessible
• Memory read/write not accessible
• Look-Up Table registers not accessible
• LCD outputs are forced low

10.3 Power Save Mode Function Summary

Table 10-4 Power Save Mode Function Summary

	Hardware Power Save	Software Power Save	Normal
IO Access Possible?	No	Yes	Yes
Memory Access Possible?	No	Yes	Yes
Look-Up Table Registers Access Possible?	No	No	Yes
Sequence Controller Running?	No	No	Yes
Display Active?	No	No	Yes
LCDPWR	Inactive	Inactive	Active
FPDAT[11:0], FPSHIFT (see note)	Forced Low	Forced Low	Active
FPLINE, FPFRAME, DRDY	Forced Low	Forced Low	Active

Note: When FPDAT[11:8] are designated as GPIO these pins are not forced low. Unused GPIO pins must be tied to V_{DDE2} - see Table 4-5, "LCD Interface Pin Mapping," on page C-1-8.

10.4 Panel Power Up/Down Sequence

After chip reset or when entering/exiting a power save mode, the Panel Interface signals follow a power on/off sequence shown below. This sequence is essential to prevent damage to the LCD panel.

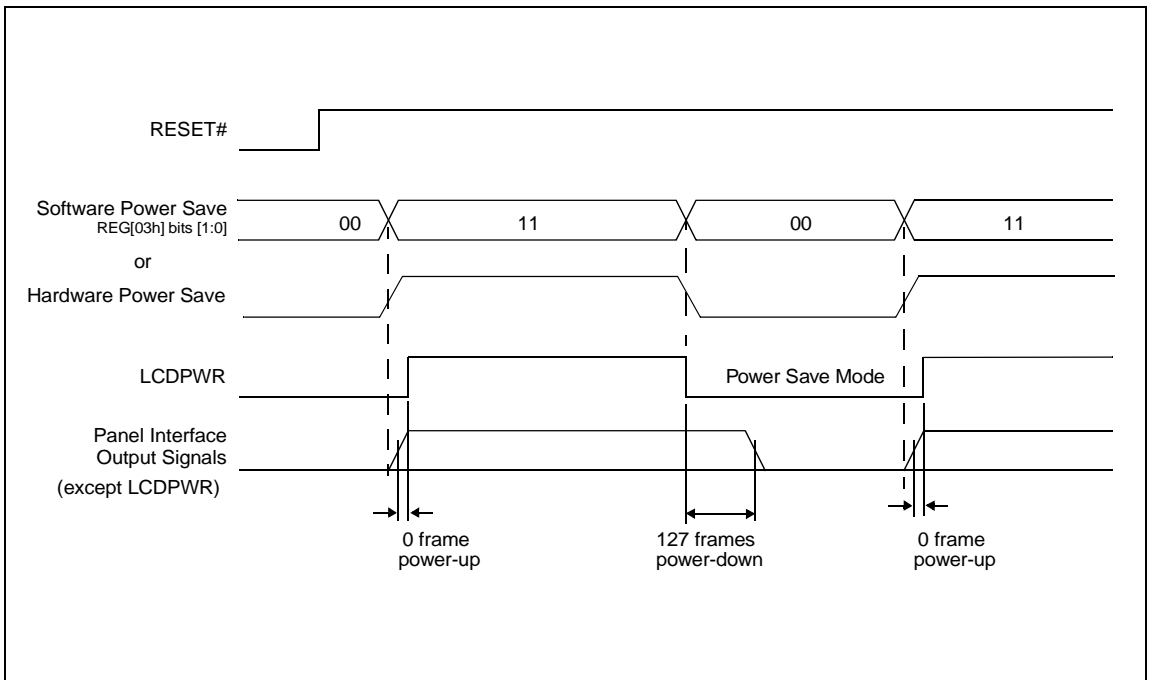


Figure 10-1 Panel On/Off Sequence

After chip reset, LCDPWR is inactive and the rest of the panel interface output signals are held “low”. Software initializes the chip (i.e. programs all registers except the Look-Up Table registers) and then programs REG[03h] bits [1:0] to 11b. This starts the power-up sequence as shown. The power-up/power-down sequence delay is 127 frames. The Look-Up Table registers may be programmed any time after REG[03h] bits[1:0] = 11b.

The power-up/power-down sequence also occurs when exiting/entering Software Power Save Mode.

10.5 Clock Requirements

The following table shows what clock is required for which function in the SED1375 block.

Table 10-5 SED1375 block Internal Clock Requirements

Function	BCLK	CLKI
Register Read/Write	Required	Not Required
Memory Read/Write	Required	Required
Look-Up Table Register Read/Write	Required	Not Required
Software Power Save	Required	Can be stopped after 128 frames from entering Software Power Save, i.e. after REG[03h] bits 1-0 = 11.
Hardware Power Save	Not Required	Can be stopped after 128 frames from entering Hardware Power Save.

SED1375 Block LCD Controller

Programming Notes and Examples

1 INTRODUCTION

This guide demonstrates how to program the SED1375 block Embedded Memory Color LCD Controller. The guide presents the basic concepts of the LCD controller and provides methods to directly program the registers. It explains some of the advanced techniques used and the special features of the SED1375 block.

The guide also introduces the Hardware Abstraction Layer (HAL), which is designed to make programming the SED1375 block as easy as possible. Future SED1375 block products will support the HAL allowing OEMs the ability to upgrade to future chips with relative ease.

2 INITIALIZATION

Prior to doing anything else with the SED1375 block the controller must be initialized. Initialization is the process of setting up the control registers to a known state in order to generate proper display signals.

2.1 Register Values

This section describes the register settings and sequence of setting the registers. In addition to these setting the Look-Up Table must be programmed with appropriate colors. Look-Up Table setup is not covered here. See “Section” 4 on page C-2-7 of this manual for Look-Up Table programming details.

The following initialization, presented in table form, shows the sequences and values to set the registers. The notes column comments the reason for the particular value being written.

This example writes to all the necessary registers. Initially, when the SED1375 block is powered up, all registers, unless noted otherwise in the specification, are set to zero. This example programs these registers to zero to establish a known state. In practice, it may be possible to write to only a subset of the registers.

The example initializes a SED1375 block to control a panel with the following specifications:

- 320 × 240 color single passive LCD panel at 70Hz.
- Color Format 2, 8-bit data interface.
- 4 bit-per-pixel.
- 6 MHz input clock (CLKI).

Table 2-1 SED1375 block Initialization Sequence

Register	Value (hex)	Notes	See Also
[01]	0010 0011 (23)	Select a passive, Single, Color panel with an 8-bit data width	
[02]	1000 0000 (80)	Select 4-bit per pixel color depth	
[03]	0000 0011 (03)	Select normal power operation	
[04]	0010 0111 (27)	Horizontal display size = (Reg[04]+1)*8 = (39+1) * 8 = 320 pixels	
[05]	1110 1111 (EF)	Vertical display size = Reg[06][05] + 1	
[06]	0000 0000 (00)	= 0000 0000 1110 1111 + 1 = 239 + 1 = 240 lines	
[07]	0000 0000 (00)	FPLINE start position (only required for TFT configuration)	
[08]	0000 0000 (00)	Horizontal non-display period = (Reg[08] + 4) * 8 = 4 * 8 = 32 pixels	Frame Rate Calculation
[09]	0000 0000 (00)	FPFRAME start position (only required for TFT configuration)	
[0A]	0000 0011 (03)	Vertical non-display period = REG[0A] = 3 lines	Frame Rate Calculation
[0B]	0000 0000 (00)	MOD rate is only required by some monochrome panels	
[0C]	0000 0000 (00)	Screen 1 Start Address - set to 0 for initialization	"5.3 Split Screen" on page C-2-20
[0D]	0000 0000 (00)		
[0E]	0000 0000 (00)	Screen 2 Start Address - set to 0 for initialization	"5.3 Split Screen" on page C-2-20
[0F]	0000 0000 (00)		
[10]	0000 0000 (00)	Screen 1 / Screen 2 Start Address MSB - set to 0	
[11]	0000 0000 (00)	Memory Address offset - not virtual setup - so set to 0	"5.1 Virtual Display" on page C-2-15
[12]	1111 1111 (FF)	Set the vertical size to the maximum value.	"5.3 Split Screen" on page C-2-20
[13]	0000 0011 (03)		
[15]		Leave the LUT alone for now	"4 LOOK-UP TABLE (LUT)" on page C-2-7
[17]			
[18]	0000 0000 (00)	GPIO control and status registers - set to "0".	
[19]	0000 0000 (00)		
[1A]	0000 0000 (00)	Set the scratch pad bits to "0".	
[1B]	0000 0000 (00)	This is not portrait mode so set this register to "0".	"7.1 Introduction To Hardware Rotation" on page C-2-25
[1C]	0000 0000 (00)	Line Byte Count is only required for portrait mode.	

2.2 Frame Rate Calculation

Frame rate specifies the number of complete frame which are drawn on the display in one second. Configuring a frame rate that is too high or too low adversely effects the quality of the displayed image.

System configuration imposes certain non-variable limitations. For instance the width and height of the display panel are fixed as is, typically, the input clock to the SED1375 block. From the following formula it is evident that the two variables the programmer can use to adjust frame rate are horizontal and vertical non-display periods.

2 INITIALIZATION

The following are the formulae for determining the frame rate of a panel. The formula for a single passive or TFT panel is calculated as follows:

$$\text{FrameRate} = \frac{\text{PCLK}}{(\text{HDP} + \text{HNDP}) \times (\text{VDP} + \text{VNDP})}$$

for a dual passive panel the formula is:

$$\text{FrameRate} = \frac{\text{PCLK}}{2 \times (\text{HDP} + \text{HNDP}) \times \left(\frac{\text{VDP}}{2} + \text{VNDP}\right)}$$

where :

PCLK	=	Pixel clock (in Hz)
HDP	=	Horizontal Display Period (in pixels)
HNDP	=	Horizontal Non-Display Period (in pixels)
VDP	=	Vertical Display Period (in lines)
VNDP	=	Vertical Non-Display Period (in lines)

In addition to varying the HNDP and VNDP times we can also select divider values which will reduce CLK_i to one half, one quarter up to one eighth of the CLK_i value. The example below is a portion of a 'C' routine to calculate HNDP and VNDP from a desired frame rate.

```
for (int loop = 0; loop < 2; loop++)
{
    for (VNDP = 2; VNDP < 0x3F; VNDP += 3)
    {
        // Solve for HNDP
        HNDP = (PCLK / (FrameRate * (VDP + VNDP))) - HDP;
        if ((HNDP >= 32) && (HNDP <= 280))
        {
            // Solve for VNDP.
            VNDP = (PCLK / (FrameRate * (HDP + HNDP))) - VDP;
            // If we have satisfied VNDP then we're done.
            if ((VNDP >= 0) && (VNDP <= 0x3F))
                goto DoneCalc;
        }
    }
    // Divide ClkI and try again.
    // (Reg[02] allows us to dived CLKI by 2)
    PCLK /= 2;
}
// If we still can't hit the frame rate - throw an error.
if ((VNDP < 0) || (VNDP > 0x3F) || (HNDP < 32) || (HNDP > 280))
{
    sprintf("ERROR: Unable to set the desired frame rate.\n");
    exit(1);
}
```

This routine first performs a formula rearrangement so that HNDP or VNDP can be solved. Start with VNDP set to a small value. Loop increasing VNDP and solving the equation for HNDP until satisfactory HNDP and VNDP values are found. If no satisfactory values are found then divide CLK_i and repeat the process. If a satisfactory frame rate still can't be reached - return an error.

Note: Most passive (STN) panels are tolerant of nearly any combination of HNDP and VNDP values, however panel specifications generally specify only a few lines of vertical non-display period. The SED1375 block is capable of generating a vertical non-display period of up to sixty-three lines. This amount of VNDP is far too great a non-display period and will likely degrade display quality. Similarly, setting a large HNDP value may cause a degrade in image quality.

If possible the system should be designed such that VNDP values of 7 or less lines and HNDP values of 20 or less characters can be selected.

3 MEMORY MODELS

The SED1375 block is capable of operating at four different color depths. For each color depth the data format is packed pixel. SED1375 block packed pixel modes can range from one byte containing eight adjacent pixels (1-bpp) to one byte containing just one pixel (8-bpp).

Packed pixel data may be envisioned as a stream of pixels. In this stream, pixels are packed in adjacent to each other. If a pixel requires four bits then it will be located in the four most significant bits of a byte. The pixel to the immediate right on the display will occupy the lower four bits of the same byte. The next two pixels to the immediate right are located in the following byte, etc.

3.1 1 Bit-Per-Pixel (2 Colors/Gray Shades)

1-bit pixels support two color/gray shades. In this memory format each byte of display buffer contains eight adjacent pixels. Setting or resetting any pixel requires reading the entire byte, masking out appropriate bits and, if necessary, setting bits to “1”.

When using a color panel the two colors are derived by indexing into positions 0 and 1 of the Look-Up Table. If the first two LUT elements are set to black (RGB = 0 0 0) and white (RGB = F F F) then each “0” bit of display memory will display as a black pixel and each “1” bit will display as a white pixel. The two LUT entries can be set to any desired colors, for instance red and green or cyan and yellow.

For monochrome panels the two displayed gray shades are generated by indexing into the first two elements of the green component of the Look-Up Table (LUT). Thus, by manipulating the green LUT components we can set either of the two gray shades to any of sixteen possible levels.

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Pixel 0	Pixel 1	Pixel 2	Pixel 3	Pixel 4	Pixel 5	Pixel 6	Pixel 7

Figure 3-1 Pixel Storage for 1 Bpp (2 Colors/Gray Shades) in One Byte of Display Buffer

3.2 2 Bit-Per-Pixel (4 Colors/Gray Shades)

2-bit pixels support four color/gray shades. In this memory format each byte of display buffer contains four adjacent pixels. Setting or resetting any pixel requires reading the entire byte, masking out the appropriate bits and, if necessary, setting bits to “1”.

Color panels derive their four colors by indexing into positions 0 through 3 of the Look-Up Table. These four LUT entries can be set to any of the 4096 possible color combinations.

Monochrome panels derive four gray shades by indexing into the first four elements of the green component of the Look-Up Table. Any of the four LUT entries can be set to any of the sixteen possible gray shades.

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Pixel 0 Bit 1	Pixel 0 Bit 0	Pixel 1 Bit 1	Pixel 1 Bit 0	Pixel 2 Bit 1	Pixel 2 Bit 0	Pixel 3 Bit 1	Pixel 3 Bit 0

Figure 3-2 Pixel Storage for 2 Bpp (4 Colors/Gray Shades) in One Byte of Display Buffer

3.3 4 Bit-Per-Pixel (16 Colors/Gray Shades)

Four bit pixels support 16 color/gray shades. In this memory format each byte of display buffer contains two adjacent pixels. Setting or resetting any pixel requires reading the entire byte, masking out the upper or lower nibble (4 bits) and setting the appropriate bits to “1”.

Color panels can display up to sixteen colors simultaneously. These sixteen colors are derived by indexing into the first sixteen elements of the Look-Up Table. Each of these colors may be selected from the 4096 possible available colors.

On a monochrome panel the gray shades are generated by indexing into the first sixteen green components of the LUT. Each of these sixteen possible gray shades can be adjusted to any of the sixteen possible gray shades. For instance, one could program the first eight green LUT entries to be 0 and the second green LUT entries to be FFh. This would result in nibble values of 0 through 7 displaying as black and nibble values 8 through 0Fh displaying as white.

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Pixel 0 Bit 3	Pixel 0 Bit 2	Pixel 0 Bit 1	Pixel 0 Bit 0	Pixel 1 Bit 3	Pixel 1 Bit 2	Pixel 1 Bit 1	Pixel 1 Bit 0

Figure 3-3 Pixel Storage for 4 Bpp (16 Colors/Gray Shades) in One Byte of Display Buffer

3.4 Eight Bit-Per-Pixel (256 Colors)

In eight bit-per-pixel mode one byte of display buffer represents one pixel on the display. At this color depth the read-modify-write cycles, required by the lessor pixel depths, are eliminated.

When using a color panel, each byte of display memory acts as an index to one element of the LUT. The displayed color is arrived at by taking the display memory value as an index into the LUT.

Eight bit per pixel is not supported for monochrome display modes. The reason is that each element of the LUT supports a 4-bit (sixteen value) level for red, green and blue. In monochrome display modes on the green value is used to set the gray intensity. Thus we have sixteen possible grey values but, because of the color.

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Red bit 2	Red bit 1	Red bit 0	Green bit 2	Green bit 1	Green bit 0	Blue bit 1	Blue bit 0

Figure 3-4 Pixel Storage for 8 Bpp (256 Colors) in One Byte of Display Buffer

4 LOOK-UP TABLE (LUT)

This section is supplemental to the description of the Look-Up Table architecture found in the SED1375 Hardware Functional Specification. Covered here is a review of the LUT registers, recommendations for the color and gray shade LUT values, and additional programming considerations for the LUT. Refer to the “SED1375 Hardware Functional Specification”, document number X27A-A-001-01 for more detail.

The SED1375 block Look-Up Table consists of 256 indexed red/green/blue entries. Each entry is 4 bits wide. Two registers, REG[15h] and REG[17h], control access to the LUT.

Each Look-Up Table entry consists of a red, green, and blue component. Each component consisting of four bits, or sixteen intensity levels. Any Look-Up Table element can be selected from a palette of 4096 (16×16×16) colors.

In color display modes, pixel values are used as an index to an RGB value stored in the Look-Up Table. In monochrome modes, pixel values still index into the LUT, but only the green component is used to determine display intensity.

The selected color depth determines how many index positions are used for image display. For example at one bit-per-pixel (bpp) only index positions 0 and 1 of the Look-Up Table are used. At 4-bpp the first 16 index positions of the Look-Up Table are used and at 8-bpp all 256 Look-Up Table index positions are used.

The Look-Up Table mechanism itself consists of an index register and a data register. The index, or address, register determines which element of the Look-Up Table will be accessed. After setting the index the LUT may be read or written through the data register. The first data element read or written is the red component of the entry. Subsequent read/write operations access the green and then the blue elements of the Look-Up Table. The SED1375 block LUT architecture is designed to provide a high degree of similarity in operation to a standard VGA RAMDAC. However, there are two considerations which must be kept in mind.

- The SED1375 block Look-Up Table has four bits (16 levels) of intensity per primary color. The standard VGA RAMDAC has six bits (64 levels). This four to one difference must be taken into consideration when converting from a VGA palette to a LUT palette. One suggestion is to divide the VGA intensity level by four to arrive at the LUT intensity.

However, most applications specify the red, green and blue components as eight bit intensities. To determine the appropriate SED1375 block Look-Up Table value we recommend using the four most significant bits.

4.1 Look-Up Table Registers

REG[15h] Look-Up Table Address Register							Read/Write
LUT Address Bit 7	LUT Address Bit 6	LUT Address Bit 5	LUT Address Bit 4	LUT Address Bit 3	LUT Address Bit 2	LUT Address Bit 1	LUT Address Bit 0

LUT Address

The LUT address register selects which of the 256 LUT entries will be accessed. After three successive reads/writes to the data register this register is automatically incremented to point to the next address.

REG[17h] Look-Up Table Data Register							Read/Write
LUT Data Bit 3	LUT Data Bit 2	LUT Data Bit 1	LUT Data Bit 0	n/a	n/a	n/a	n/a

LUT Data

This register is where the 4-bit red/green/blue data value is written/read. Immediately after setting the LUT index with register [15h] this register accesses the red element of the Look-Up Table. With each successive write/read the internal bank select is incremented. Thus the second access is from the green element and the third is from the blue element.

After the third access the LUT Address is incremented by one, then next access to this register will be the red element of the next Look-Up Table index.

4.2 Look-Up Table Organization

Color Modes

1 bpp color

When the SED1375 block is configured for 1 bpp color mode, the LUT is limited to selecting colors from the first two entries. The two LUT entries can be any two RGB values but are typically set to black-and-white.

Each byte in the display buffer contains eight adjacent pixels. If a bit has a value of “0” then the color in LUT 0 index is displayed. A bit value of “1” results in the color in LUT 1 index being displayed.

The following table shows the recommended values for obtaining a black-and-white mode while in 1 bpp on a color panel.

Table 4-1 Recommended LUT Values for 1 Bpp Color Mode

Index	Red	Green	Blue
00	00	00	00
01	F0	F0	F0
02	00	00	00
...	00	00	00
FF	00	00	00

 unused entries

2 bpp color


When the SED1375 block is configured for 2 bpp color mode, the displayed colors are selected from the first four entries of the Look-Up Table. The LUT entries may be set to any of the 4096 possible colors.

Each byte in the display buffer contains four adjacent pixels. If a bit combination has a value of “00” then the color in LUT index 0 is displayed. A bit value of “01” results in the color in LUT index 1 being displayed. Likewise the bit combination of “10” displays from the third LUT entry and “11” displays a color from the fourth LUT entry.

The following table shows the example values for 2 bit-per-pixel display mode.

Table 4-2 Example LUT Values for 2 Bpp Color Mode

Index	Red	Green	Blue
00	00	00	00
01	70	70	70
02	A0	A0	A0
03	F0	F0	F0
04	00	00	00
...	00	00	00
FF	00	00	00

 indicates unused entries

4 LOOK-UP TABLE (LUT)

4 bpp color


When the SED1375 block is configured for 4 bpp color mode, the displayed colors are selected from the first sixteen entries of the Look-Up Table. The LUT entries may be set to any of the 4096 possible colors.

Each byte in the display buffer contains two adjacent pixels. If a nibble has a value of “0000” then the color in LUT index 0 is displayed. A nibble value of “0001” results in the color in LUT index 1 being displayed. The pattern continues to the nibble pattern of “1111” which results in the sixteenth color of the Look-Up Table being displayed.

The following table shows the example values for 4 bit-per-pixel display mode. These colors simulate the colors used by the sixteen color modes of a VGA.

Table 4-3 Suggested LUT Values to Simulate VGA Default 16 Color Palette

Index	Red	Green	Blue
00	00	00	00
01	00	00	A0
02	00	A0	00
03	00	A0	A0
04	A0	00	00
05	A0	00	A0
06	A0	A0	00
07	A0	A0	A0
08	00	00	00
09	00	00	F0
0A	00	F0	00
0B	00	F0	F0
0C	F0	00	00
0D	F0	00	F0
0E	F0	F0	00
0F	F0	F0	F0
10	00	00	00
...	00	00	00
FF	00	00	00

 indicates unused entries

8 bpp color

When the SED1375 block is configured for 8 bpp color mode the entire Look-Up Table is used to display images. Each of the LUT entries may be set to any of the 4096 possible colors.

Each byte in the display buffer represents one pixels. The byte value is used directly as an index into one of the 256 LUT entries. A display memory byte with a value of 00h will display the color contained in the first Look-Up Table entry while a display memory byte of FFh will display a color formed by the two hundred and fifty sixth Look-Up Table entry.

The following table depicts LUT values which approximate the VGA default 256 color palette.

Table 4-4 Suggested LUT Values to Simulate VGA Default 256 Color Palette

Index	R	G	B	Index	R	G	B	Index	R	G	B	Index	R	G	B
00	00	00	00	40	F0	70	70	80	30	30	70	C0	00	40	00
01	00	00	A0	41	F0	90	70	81	40	30	70	C1	00	40	10
02	00	A0	00	42	F0	B0	70	82	50	30	70	C2	00	40	20
03	00	A0	A0	43	F0	D0	70	83	60	30	70	C3	00	40	30
04	A0	00	00	44	F0	F0	70	84	70	30	70	C4	00	40	40
05	A0	00	A0	45	D0	F0	70	85	70	30	60	C5	00	30	40
06	A0	50	00	46	B0	F0	70	86	70	30	50	C6	00	20	40
07	A0	A0	A0	47	90	F0	70	87	70	30	40	C7	00	10	40
08	50	50	50	48	70	F0	70	88	70	30	30	C8	20	20	40
09	50	50	F0	49	70	F0	90	89	70	40	30	C9	20	20	40
0A	50	F0	50	4A	70	F0	B0	8A	70	50	30	CA	30	20	40
0B	50	F0	F0	4B	70	F0	D0	8B	70	60	30	CB	30	20	40
0C	F0	50	50	4C	70	F0	F0	8C	70	70	30	CC	40	20	40
0D	F0	50	F0	4D	70	D0	F0	8D	60	70	30	CD	40	20	30
0E	F0	F0	50	4E	70	B0	F0	8E	50	70	30	CE	40	20	30
0F	F0	F0	F0	4F	70	90	F0	8F	40	70	30	CF	40	20	20
10	00	00	00	50	B0	B0	F0	90	30	70	30	D0	40	20	20
11	10	10	10	51	C0	B0	F0	91	30	70	40	D1	40	20	20
12	20	20	20	52	D0	B0	F0	92	30	70	50	D2	40	30	20
13	20	20	20	53	E0	B0	F0	93	30	70	60	D3	40	30	20
14	30	30	30	54	F0	B0	F0	94	30	70	70	D4	40	40	20
15	40	40	40	55	F0	B0	E0	95	30	60	70	D5	30	40	20
16	50	50	50	56	F0	B0	D0	96	30	50	70	D6	30	40	20
17	60	60	60	57	F0	B0	C0	97	30	40	70	D7	20	40	20
18	70	70	70	58	F0	B0	B0	98	50	50	70	D8	20	40	20
19	80	80	80	59	F0	C0	B0	99	50	50	70	D9	20	40	20
1A	90	90	90	5A	F0	D0	B0	9A	60	50	70	DA	20	40	30
1B	A0	A0	A0	5B	F0	E0	B0	9B	60	50	70	DB	20	40	30
1C	B0	B0	B0	5C	F0	F0	B0	9C	70	50	70	DC	20	40	40
1D	C0	C0	C0	5D	E0	F0	B0	9D	70	50	60	DD	20	30	40
1E	E0	E0	E0	5E	D0	F0	B0	9E	70	50	60	DE	20	30	40
1F	F0	F0	F0	5F	C0	F0	B0	9F	70	50	50	DF	20	20	40
20	00	00	F0	60	B0	F0	B0	A0	70	50	50	E0	20	20	40
21	40	00	F0	61	B0	F0	C0	A1	70	50	50	E1	30	20	40
22	70	00	F0	62	B0	F0	D0	A2	70	60	50	E2	30	20	40
23	B0	00	F0	63	B0	F0	E0	A3	70	60	50	E3	30	20	40
24	F0	00	F0	64	B0	F0	F0	A4	70	70	50	E4	40	20	40
25	F0	00	B0	65	B0	E0	F0	A5	60	70	50	E5	40	20	30
26	F0	00	70	66	B0	D0	F0	A6	60	70	50	E6	40	20	30
27	F0	00	40	67	B0	C0	F0	A7	50	70	50	E7	40	20	30
28	F0	00	00	68	00	00	70	A8	50	70	50	E8	40	20	20
29	F0	40	00	69	10	00	70	A9	50	70	50	E9	40	30	20
2A	F0	70	00	6A	30	00	70	AA	50	70	60	EA	40	30	20
2B	F0	B0	00	6B	50	00	70	AB	50	70	60	EB	40	30	20
2C	F0	F0	00	6C	70	00	70	AC	50	70	70	EC	40	40	20

4 LOOK-UP TABLE (LUT)

Table 4-4 Suggested LUT Values to Simulate VGA Default 256 Color Palette (Continued)

2D	B0	F0	00	6D	70	00	50	AD	50	60	70	ED	30	40	20
2E	70	F0	00	6E	70	00	30	AE	50	60	70	EE	30	40	20
2F	40	F0	00	6F	70	00	10	AF	50	50	70	EF	30	40	20
30	00	F0	00	70	70	00	00	B0	00	00	40	F0	20	40	20
31	00	F0	40	71	70	10	00	B1	10	00	40	F1	20	40	30
32	00	F0	70	72	70	30	00	B2	20	00	40	F2	20	40	30
33	00	F0	B0	73	70	50	00	B3	30	00	40	F3	20	40	30
34	00	F0	F0	74	70	70	00	B4	40	00	40	F4	20	40	40
35	00	B0	F0	75	50	70	00	B5	40	00	30	F5	20	30	40
36	00	70	F0	76	30	70	00	B6	40	00	20	F6	20	30	40
37	00	40	F0	77	10	70	00	B7	40	00	10	F7	20	30	40
38	70	70	F0	78	00	70	00	B8	40	00	00	F8	00	00	00
39	90	70	F0	79	00	70	10	B9	40	10	00	F9	00	00	00
3A	B0	70	F0	7A	00	70	30	BA	40	20	00	FA	00	00	00
3B	D0	70	F0	7B	00	70	50	BB	40	30	00	FB	00	00	00
3C	F0	70	F0	7C	00	70	70	BC	40	40	00	FC	00	00	00
3D	F0	70	D0	7D	00	50	70	BD	30	40	00	FD	00	00	00
3E	F0	70	B0	7E	00	30	70	BE	20	40	00	FE	00	00	00
3F	F0	70	90	7F	00	10	70	BF	10	40	00	FF	00	00	00

Gray Shade Modes

Gray shade modes are monochrome display modes. Monochrome display modes use the Look-Up Table in a very similar fashion to the color modes. This most significant difference is that the monochrome display modes use only the intensity of the green element of the Look-Up Table to form the gray level.

One side effect of using only green for intensity selection is that in gray shade modes there are only sixteen possible intensities. 8 bit-per-pixel is not supported for gray shade modes.

1 bpp gray shade

When the SED1375 block is configured for 1 bpp gray shade mode, the LUT is limited to selecting colors from the first two green entries. The two LUT entries can be set to any of sixteen possible intensities. Typically they would be set to 0h (black) and Fh (white).

Each byte in the display buffer contains eight adjacent pixels. If a bit has a value of “0” then the color in the green LUT 0 index is displayed. A bit value of “1” results in the color in green LUT 1 index being displayed.

The following table shows the recommended values 1 bpp gray shade display mode

Table 4-5 Recommended LUT Values for 1 Bpp Gray Shade

Address	Red	Green	Blue
00	00	00	00
01	00	F0	00
02	00	00	00
...	00	00	00
FF	00	00	00

 unused entries

2 bpp gray shade


When the SED1375 block is configured for 2 bpp gray shade, the displayed colors are selected from the first four green entries in the Look-Up Table. The remaining entries of the LUT are unused. Each of the four entries can be set to any of the sixteen possible colors.

Each byte in the display buffer contains four adjacent pixels. If a bit combination has a value of “00” then the intensity in the green LUT index 0 is displayed. A bit value of “01” results in the intensity represented by the green in LUT index 1 being displayed. Likewise the bit combination of “10” displays from the third LUT entry and “11” displays a from the fourth LUT entry.

The following table shows the example values for 2 bit-per-pixel display mode.

Table 4-6 Suggested Values for 2 Bpp Gray Shade

Index	Red	Green	Blue
0	00	00	00
1	00	50	00
2	00	A0	00
3	00	F0	00
4	00	00	00
...	00	00	00
FF	00	00	00

 indicates unused entries

4 LOOK-UP TABLE (LUT)

4 bpp gray shade


When the SED1375 block is configured for 4 bpp gray shade mode the displayed colors are selected from the green values of the first sixteen entries of the Look-Up Table. Each of the sixteen entries can be set to any of the sixteen possible intensity levels.

Each byte in the display buffer contains two adjacent pixels. If a nibble pattern is “0000” then the green intensity of LUT index 0 is displayed. A nibble value of “0001” results in the green intensity in LUT index 1 being displayed. The pattern continues to the nibble pattern of “1111” which results in the sixteenth intensity of Look-Up Table being displayed.

The following table shows the example values for 4 bit-per-pixel display mode.

Table 4-7 Suggested LUT Values for 4 Bpp Gray Shade

Index	Red	Green	Blue
00	00	00	00
01	00	10	00
02	00	20	00
03	00	30	00
04	00	40	00
05	00	50	00
06	00	60	00
07	00	70	00
08	00	80	00
09	00	90	00
0A	00	A0	00
0B	00	B0	00
0C	00	C0	00
0D	00	D0	00
0E	00	E0	00
0F	00	F0	00
10	00	00	00
...	00	00	00
FF	00	00	00

 indicates unused entries

5 ADVANCED TECHNIQUES

This section contains programming suggestions for the following:

- virtual display
- panning and scrolling
- split screen display

5.1 Virtual Display

Virtual display refers to the situation where the image to be viewed is larger than the physical display. The difference can be in the horizontal, vertical or both dimensions. To view the image, the display is used as a window into the display buffer. At any given time only a portion of the image is visible. Panning and scrolling are used to view the full image.

The Memory Address Offset register determines the number of horizontal pixels in the virtual image. The offset register can be used to specify from 0 to 255 additional words for each scan line. At 1 bpp, 255 words span an additional 4,080 pixels. At 8 bpp, 255 words span an additional 510 pixels.

The maximum vertical size of the virtual image is the result of dividing 40,960 bytes of display memory by the number of bytes on each line (i.e. at 1 bpp with a 320×240 panel set for a virtual width of 640×480 there is enough memory for 512 lines).

Figure 5-1 “Viewport Inside a Virtual Display,” depicts a typical use of a virtual display. The display panel is 320×240 pixels, an image of 640×480 pixels can be viewed by navigating a 320×240 pixel viewport around the image using panning and scrolling.

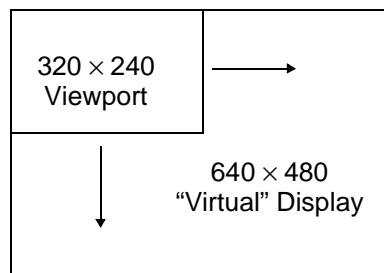


Figure 5-1 Viewport Inside a Virtual Display

Registers

REG[11h] Memory Address Offset Register							
Memory Address Offset Bit 7	Memory Address Offset Bit 6	Memory Address Offset Bit 5	Memory Address Offset Bit 4	Memory Address Offset Bit 3	Memory Address Offset Bit 2	Memory Address Offset Bit 1	Memory Address Offset Bit 0

Memory Address Offset Register

REG[11h] forms an 8-bit value called the Memory Address Offset. This offset is the number of additional words on each line of the display. If the offset is set to zero there is no virtual width.

This value does not represent the number of words to be shown on the display. The display width is set in the Horizontal Display Width register.

Note: This value does not represent the number of words to be shown on the display. The display width is set in the Horizontal Display Width register.

Examples

Example 1

In this example we go through the calculations to display a 640 × 480 image on a 320 × 240 panel at 1 bpp.

Step 1: Calculate the number of pixels per word for this color depth.

At 1 bpp each byte is comprised of 8 pixels, therefore each word contains 16 pixels.

$$\text{pixels_per_word} = 16 / \text{bpp} = 16 / 1 = 16$$

Step 2: Calculate the Memory Address Offset register value

We require a total of 640 pixels. The horizontal display register will account for 320 pixels, this leaves 320 pixels for the Memory Address Offset register to account for.

$$\text{offset} = \text{pixels} / \text{pixels_per_word} = 320 / 16 = 20 = 14\text{h}$$

The Memory Address Offset register, REG[11h], will have to be set to 28h to satisfy the above condition.

Example 2

From the above, what is the maximum number of lines our image can contain?

Step 1: Calculate the number of bytes on each line.

$$\text{bytes_per_line} = \text{pixels_per_line} / \text{pixels_per_byte} = 640 / 8 = 80$$

Each line of the display requires 80 bytes.

Step 2: Calculate the number of lines the SED1375 block is capable of.

$$\text{total_lines} = \text{memory} / \text{bytes_per_line} = 40960 / 80 = 512$$

We can display a maximum of 512 lines. Our example image requires 480 lines so this example can be done.

5.2 Panning and Scrolling

Panning and scrolling describe the operation of moving a physical display viewport about a virtual image in order to view the entire image a portion at time. For example, after setting up the previous example (virtual display) and drawing an image into it we would only be able to view one quarter of the image. Panning and scrolling are used to reveal the rest of the image.

Panning describes the horizontal (side to side) motion of the viewport. When panning to the right the image in the viewport appears to slide to the left. When panning to the left the image to appears to slide to the right. Scrolling describes the vertical (up and down) motion of the viewport. Scrolling down causes the image to appear to slide up and scrolling up causes the image to appear to slide down.

Both panning and scrolling are performed by modifying the start address register. The start address registers in the SED1375 block are a word offset to the data to be displayed in the top left corner of a frame. Changing the start address by one means a change on the display of the number of pixels in one word. The number of pixels in word varies according to the color depth. At 1 bit-per-pixel a word contains sixteen pixels. At 2 bit-per-pixel there are eight pixels, at 4 bit-per-pixel there are four pixels and at 8 bit-per-pixel there is two pixels in each word. The number of pixels in each word represent the finest step we can pan to the left or right.

When portrait mode (see “7 HARDWARE ROTATION” on page C-2-25) is enabled the start address registers become offsets to bytes. In this mode the step rate for the start address registers if halved making for smoother panning.

Registers

REG[0Ch] Screen 1 Display Start Address 0 (LSB)							
Start Addr Bit 7	Start Addr Bit 6	Start Addr Bit 5	Start Addr Bit 4	Start Addr Bit 3	Start Addr Bit 2	Start Addr Bit 1	Start Addr Bit 0

REG[0Dh] Screen 1 Display Start Address 1 (MSB)							
Start Addr Bit 15	Start Addr Bit 14	Start Addr Bit 13	Start Addr Bit 12	Start Addr Bit 11	Start Addr Bit 10	Start Addr Bit 9	Start Addr Bit 8

REG[10h] Screen 1 Display Start Address 2 (MSB)							
n/a	n/a	n/a	n/a	n/a	n/a	n/a	Start Addr Bit 16

Screen 1 Start Address Registers

These three registers form the seventeen bit screen 1 start address. Screen 1 is displayed starting at the top left corner of the display.

In landscape mode these registers form the word offset to the first byte in display memory to be displayed in the upper left corner of the screen. Changing these registers by one will shift the display image 2 to 16 pixels, depending on the current color depth.

In portrait mode these registers form the offset to the display memory byte where screen 1 will start displaying. Changing these registers in portrait mode will result in a shift of 1 to 8 pixels depending on the color depth.

Refer to Table 5-1 to see the minimum number of pixels affected by a change of one to these registers

Table 5-1 Number of Pixels Panned Using Start Address

Color Depth (bpp)	Pixels per Word	Landscape Mode Number of Pixels Panned	Pixels Per Byte	Portrait Mode Number of Pixels Panned
1	16	16	8	8
2	8	8	4	4
4	4	4	2	2
8	2	2	1	1

Examples

For the following examples we base our calculations on a 4 bit-per-pixel image displayed on a 256w × 64h panel. We have set up a virtual size of 320w × 240h. Width is greater than height so we are in landscape display mode. Refer to Section 2, “*INITIALIZATION*” on page C-2-2 and Section 5.1, “*Virtual Display*” on page C-2-15 for assistance with these settings.

These examples are shown using a C-like syntax.

Example 3 **Panning (Right and Left)**

To pan to the right increase the start address value by one. To pan to the left decrease the start address value. Keep in mind that, with the exception of 8 bit-per-pixel portrait display mode, the display will jump by more than one pixel as a result of changing the start address registers.

Panning to the right.

```
StartWord = GetStartAddress();
StartWord ++;
SetStartAddress (StartWord);
```

Panning to the left.

```
StartWord = GetStartAddress();
StartWord --;
if (StartWord < 0)
    StartWord = 0;
SetStartAddress (StartWord);
```

The routine `GetStartAddress()` is one which will read the start address registers and return the start address as a long value. It would be written similar to:

```
long GetStartAddress()
{
    return ((REG[10] & 1) * 65536) + (REG[0D] * 256) + (REG[0C]);
}
```

The routine `SetStartAddress()` break up its long integer argument into three register values and store the values.

```
void SetStartAddress(long SA)
{
    REG[0C] = SA        & 0xFF;
    REG[0D] = (SA >>  8) & 0xFF;
    Reg[10] = (SA >> 16) & 0xFF;
}
```

Example 4

Scrolling (Up and Down)

To scroll down, increase the value in the Screen 1 Display Start Address Register by the number of words in one *virtual* scan line. To scroll up, decrease the value in the Screen 1 Display Start Address Register by the number of words in one *virtual* scan line. A virtual scan line includes both the number of bytes required by the physical display and any extra bytes that may be being used for creating a virtual width on the display.

The previous dimensions are still in effect for this example (i.e. 320w × 240h virtual size, 256h × 64w physical size at 4 bpp)

Step 1: Determine the number of words in one virtual scanline.

$$\text{bytes_per_line} = \text{pixels_per_line} / \text{pixels_per_byte} = 320 / 2 = 160$$

$$\text{words_per_line} = \text{bytes_per_line} / 2 = 160 / 2 = 80$$

Step 2: Scroll up or down

To scroll up.

```
StartWord = GetStartAddress();
StartWord -= words_per_line;
if (StartWord < 0)
StartWord = 0;
SetStartAddress(StartWord);
```

To scroll down.

```
StartWord = GetStartAddress();
StartWord += words_per_line;
SetStartAddress(StartWord);

}
```

5.3 Split Screen

Occasionally the need arises to display two different but related images. Take, for example, a game where the main play area requires rapid updates and game status, displayed at the bottom of the screen, requires infrequent updates.

The Split Screen feature of the SED1375 block allows a programmer to setup a display in such a manor. When correctly configured the programmer has only to update the main area on a regular basis. Occasionally, as the need arises, the secondary area is updated.

The figure below illustrates how a 320×240 panel may be configured to have one image displaying from scan line 0 to scan line 199 and image 2 displaying from scan line 200 to scan line 239. Although this example picks specific values, the split between image 1 and image 2 may occur at any line of the display.



Screen 1 Vertical Size Registers = 199 lines

Figure 5-2 320×240 Single Panel For Split Screen

In split screen operation “Image 1” is taken from the display memory location pointed to by the Screen 1 Start Address registers and is always located at the top of the screen. “Image 2” is taken from the display memory location pointed to by the Screen 2 Start Address registers. The line where “Image 1” end and “Image 2” begins is determined by the Screen 1 Vertical Size register.

Registers

Split screen operation is performed primarily by manipulating three register sets. Screen 1 Start Address and Screen 2 Start Address determine from where in display memory the first and second images will be taken from. The Vertical Size registers determine how many lines Screen 1 will use. The following is a description of the registers used to do split screen.

REG[13] Screen 1 Vertical Size (LSB)							
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
REG[14] Screen 1 Vertical Size (MSB)							
n/a	n/a	n/a	n/a	n/a	n/a	Bit 9	Bit 8

Screen 1 Vertical Size

These two registers form a ten bit value which determines the size of screen 1. When the vertical size is equal to or greater than the physical number of lines being displayed there is no visible effect on the display. When the vertical size value is less than the number of physical display lines, operation is like this:

1. From the beginning of a frame to the number of lines indicated by vertical size the display data will come from the memory area pointed to by the Screen 1 Display Start Address.

2. After *vertical size* lines have been displayed the system will begin displaying data from the memory area pointed to by Screen 2 Display Start Address.

On thing that must be pointed out here is that Screen 1 memory is **always** displayed at the top of the screen followed by screen 2 memory. This relationship holds true regardless of where in display memory Screen 1 Start Address and Screen 2 Start Address are pointing. For instance, Screen 2 Start Address may point to offset zero of display memory while Screen 1 Start Address points to a location several thousand bytes higher. Screen 1 will still be shown first on the display. While not particularly useful, it is even possible to set screen 1 and screen 2 to the same address.

REG[0Eh] Screen 2 Display Start Address 0 (LSB)							
Start Addr Bit 7	Start Addr Bit 6	Start Addr Bit 5	Start Addr Bit 4	Start Addr Bit 3	Start Addr Bit 2	Start Addr Bit 1	Start Addr Bit 0

REG[0Fh] Screen 2 Display Start Address 1 (MSB)							
Start Addr Bit 15	Start Addr Bit 14	Start Addr Bit 13	Start Addr Bit 12	Start Addr Bit 11	Start Addr Bit 10	Start Addr Bit 9	Start Addr Bit 8

Screen 2 Start Address Registers

These two registers form the sixteen bit Screen 2 Start Address. Screen 2 is always displayed immediately following the screen 1 data and will begin at the left-most pixel on a line. Keep in mind that if the Screen 1 Vertical Size is equal to or greater than the physical display then Screen 2 will not be shown.

In landscape mode these registers form the word offset to the first byte in display memory to be displayed. Changing these registers by one will shift the display image 2 to 16 pixels, depending on the current color depth.

The SED1375 block does not support split screen operation in portrait mode. Screen 2 will never be used if portrait mode is selected.

Refer to Table 5-1 to see the minimum number of pixels affected by a change of one to these registers

Screen 1 Start Address registers, REG[0C], REG[0D] and REG[10] are discussed in “Section” on page C-2-17.

Examples

Example 5

Display 200 scanlines of image 1 and 40 scanlines of image 2. Image 2 is located first (offset 0) in the display buffer followed immediately by image 1. Assume a 320 × 240 display and a color depth of 4 bpp.

1. Calculate the Screen 1 Vertical Size register values.

$\text{vertical_size} = 200 = \text{C8h}$

Write the Vertical Size LSB, REG[13h], with C8h and Vertical Size MSB, REG[14h], with a 00h.

2. Calculate the Screen 1 Start Word Address register values.

Screen 2 is located first in display memory, therefore we must calculate the number of bytes taken up by the screen 2 data.

$\text{bytes_per_line} = \text{pixels_per_line} / \text{pixels_per_byte} = 320 / 2 = 160$

$\text{total bytes} = \text{bytes_per_line} \times \text{lines} = 160 \times 40 = 6400.$

Screen 2 requires 6400 bytes (0 to 6399) therefore the start address offset for screen 1 must be 6400 bytes. (6400 bytes = 3200 words = C80h words)

Set the Screen 1 Start Word Address MSB, REG[0Dh], to 0Ch and the Screen 1 Start Word Address LSB, REG[0Ch], to 80h.

3. Calculate the Screen 2 Start Word Address register values.

Screen 2 display data is coming from the very beginning of the display buffer. All there is to do here is ensure that both the LSB and MSB of the Screen 2 Start Word Address registers are set to zero.

6 LCD POWER SEQUENCING AND POWER SAVE MODES

6.1 LCD Power Sequencing

Correct power sequencing is required to prevent long term damage to LCD panels and to avoid unsightly "lines" during power-up and power-down. Power Sequencing allows the LCD power supply to discharge prior to shutting down the LCD logic signals.

Proper LCD power sequencing dictates there must be a time delay between the LCD power being disabled and the LCD signals being shut down. During power-up the LCD signals must be active prior to or when power is applied to the LCD. The time intervals vary depending on the power supply design.

The SED1375 block performs automatic power sequencing in response to both software power save (REG[03h]) or in response to a hardware power save. One frame after a power save mode is set, the SED1375 block disables LCD power, and the LCD logic signals continue for one hundred and twenty seven frames allowing the LCD power supply to completely discharge. For most applications the internal power sequencing is the appropriate choice.

There may be situations where the internal time delay is insufficient to discharge the LCD power supply before the LCD signals are shut down, or the delay is too long and the designer wishes to shorten it. This section details the sequences to manually power-up and power-down the LCD interface.

6.2 Registers

REG[03h] Mode Register 2							
				LCDPWR Override	Hardware Power Save Enable	Software Power Save bit 1	Software Power Save bit 0

The LCD Power (LCDPWR) Override bit forces LCD power inactive one frame after being toggled. As long as this bit is "1" LCD power will be disabled.

The Hardware Power Save Enable bit must be set in order to activate hardware power save through GPIO0.

The Software Power Save bits set and reset the software power save mode. These bits are set to "11" for normal operation and set to "00" for power save mode.

LCD logic signals to the display panel are active for 128 frames after setting either hardware or software power save modes. Power sequencing override is performed by setting the LCDPWR Override bit some time before setting a power save mode for power off sequences. During power on sequences the power save mode is reset some time before the LCDPWR Override is reset resulting in the LCD logic signals being active before power is applied to the panel.

6.3 LCD Enable/Disable

The descriptions below cover manually powering the LCD panel up and down. Use the sequences described in this section if the power supply connected to the panel requires more than 127 frames to discharge on power-down, or if the panel requires starting the LCD logic well in advance of enabling LCD power. Currently there are no known circumstances where the LCD logic must be active well in advance of LCD power.

Note: If 127 frame period is too long, blank the display, then reprogram the Horizontal and Vertical sizes to produce a shorter frame period before using these methods.

Power On/Enable Sequence

The following is a sequence for manually powering-up an LCD panel if LCD power had to be applied later than LCD logic.

1. Set REG[03h] bit 3 (LCDPWR Override) to "1". This ensures that LCD power will be held disabled.
2. Enable LCD logic. This is done by either setting the GPIO0 pin low to disable hardware power save mode and/or by setting REG[03h] bits 1-0 to "11" to disable software power save.
3. Count "x" Vertical Non-Display Periods (OPTIONAL).
"x" corresponds to the length of time LCD logic must be enabled before LCD power-up, converted to the equivalent vertical non-display periods. For example, at 72 HZ counting 36 non-display periods results in a one half second delay.
4. Set REG[03h] bit 3 to "0" to enable LCD Power.

Power Off/Disable Sequence

The following is a sequence for manually powering-down an LCD panel. These steps would be used if the power supply discharge requirements are larger than the default 127 frames.

1. Set REG[03h] bit 3 (LCDPWR Override) to "1" which will disable LCD Power.
2. Count "x" Vertical Non-Display Periods.
"x" corresponds to the power supply discharge time converted to the equivalent vertical non-display periods. (see the previous example)
3. Disable the LCD logic by setting the software power save in REG[03h] or setting hardware power save via GPIO0. Keep in mind that after setting the power save mode there will be 127 frames before the LCD logic signals are disabled.

7 HARDWARE ROTATION

7.1 Introduction To Hardware Rotation

Many of today's applications use the LCD panel in a portrait orientation (typically LCD panels are landscape oriented). In this case it becomes necessary to "rotate" the displayed image. This rotation can be done by software at the expense of performance or, as with the SED1375 block, it can be done by hardware with no performance penalty.

This discussion of display rotation is intended to augment the excellent description of the hardware functionality found in the Hardware Functional Specification.

The SED1375 block supports two portrait modes: Default Portrait Mode and Alternate Portrait Mode.

7.2 Default Portrait Mode

Default portrait mode was designed to reduce power consumption for portrait mode use. The reduced power consumption comes with certain trade offs.

The most obvious difference between the two modes is that Default Portrait Mode requires the portrait width be a power of two, e.g. a 240-line panel, used in portrait mode, requires setting a virtual width of 256 pixels. Also default portrait mode is only capable of scrolling the display in two line increments.

The benefits to using default portrait mode lies in the ability to use a slower input clock and in reduced power consumption.

The following figure depicts the ways to envision memory layouts for the SED1375 block in default portrait mode. This example uses a 320×240 panel.

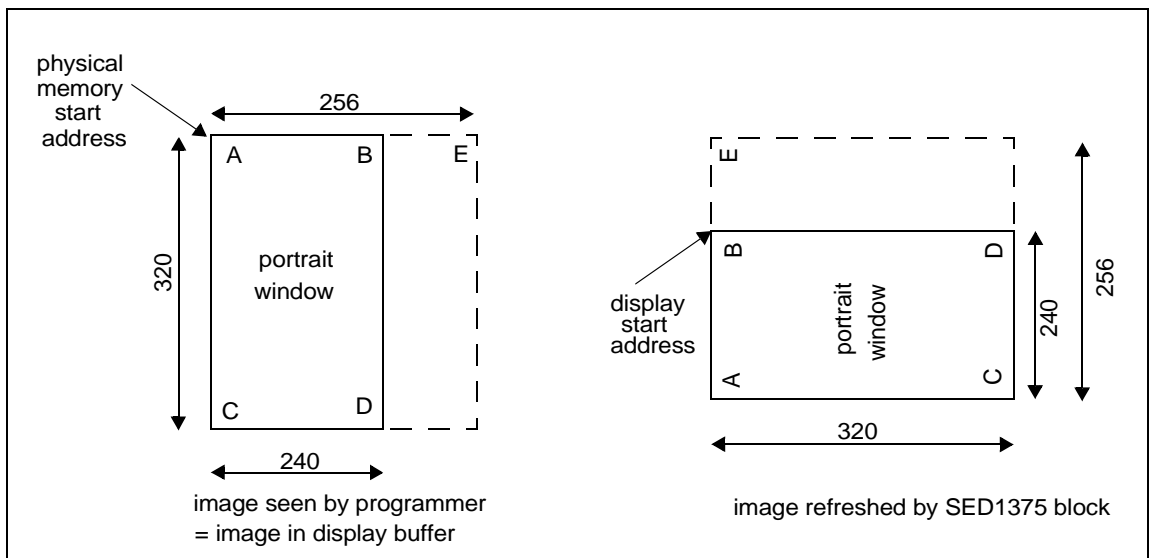


Figure 7-1 Relationship Between the Default Mode Screen Image and the Image Refreshed by SED1375 block

From the programmer's perspective the memory is laid out as shown on the left. The programmer accesses memory exactly as for a panel of with the dimensions of 240×320 setup to have a 256 pixel horizontal stride. The programmer sees memory addresses increasing from A->B and from C->D.

From a hardware perspective the SED1375 block always refreshes the LCD panel in the order B->D and down to do A->C.

7.3 Alternate Portrait Mode

Alternate portrait mode does not impose the power of two line width. To rotated the image on 240 line panel requires a portrait stride of 240 pixels. Alternate portrait mode is capable of scrolling by one line at a time in response to changes to the Start Address Registers. However, to achieve the same frame rate requires a 2 x faster input clock, therefore using more power.

The following figure depicts the ways to envision memory layouts for the SED1375 block in alternate portrait mode. This example also uses a 480 x 320 panel. Notice that in alternate portrait mode the stride may be as little as 240 pixels.

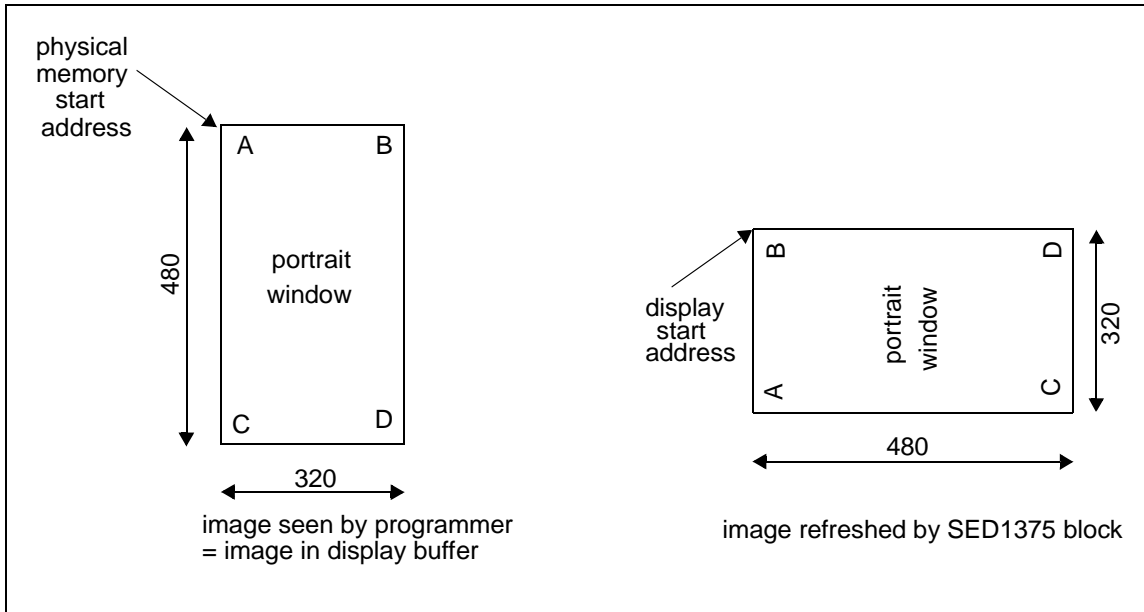


Figure 7-2 Relationship Between the Alternate Mode Screen Image and the Image Refreshed by SED1375 block

From the programmers perspective the memory is laid out as shown on the left. The programmer accesses memory exactly as for a panel of with the dimensions of 480 x 320. The programmer sees memory addresses increasing from A->B and from C->D.

From a hardware perspective the SED1375 block always refreshes the LCD panel in the order B->D and down to do A->C

The greatest factor in selecting alternate portrait mode over default portrait mode would be for the ability to obtain an area of contiguous off screen memory. For example: A 640 x 480 panel in default portrait mode at one bit-per-pixel requires 40960 bytes (40 Kb). There is unused memory but it is not contiguous. The same situation using alternate portrait mode requires 38400 bytes leaving 2560 bytes of contiguous memory available to the application. In fact the change in memory usage may make the difference between being able to run certain panels in portrait mode or not being able to do so.

7.4 Registers

This section describes the registers used to set portrait mode operation.

REG[0Ch] Screen 1 Start Word Address LSB							
bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0

REG[0Dh] Screen 1 Start Word Address MSB							
bit 15	bit 14	bit 13	bit 12	bit 11	bit 10	bit 9	bit 8

REG[0Eh] Screen 1 Start Word Address MSB							
n/a	n/a	n/a	n/a	n/a	n/a	n/a	bit 16

The Screen 1 Start Address registers must be set correctly for portrait mode. In portrait mode the Start Address registers form a byte offset, as opposed to a word offset, into display memory.

The initial required offset is the portrait mode stride (in bytes) less one.

REG[1Ch] Line Byte Count Register							
bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0

The line byte count register informs the SED1375 block of the stride, in bytes, between two consecutive lines of display in portrait mode. The Line Byte Count register only affects portrait mode operation and are ignored when the SED1375 block is in landscape display mode.

REG[1Bh] Portrait Mode Register							
Portrait Mode Enable	Portrait Mode Select	n/a	n/a	n/a	Portrait Mode Memory Clock Select	Portrait Mode Pixel Clock Select Bit 1	Portrait Mode Pixel Clock Select Bit 0

The portrait mode register contains several items for portrait mode support.

The first is the Portrait Mode Enable bit. When this bit is “0” the SED1375 block is in landscape mode and the remainder of the settings in this register as well as the Line Byte Count in REG[1Ch] are ignored. Set this bit to “1” to enable portrait mode.

The portrait mode select bit selects between the “Default Mode” and the “Alternate Mode”. Setting this bit to “0” selects the default portrait mode while setting this bit to “1” enables the alternate portrait mode.

Portrait Mode Memory Clock Select is another power saving measure which can be enabled if the final MCLK value is less than or equal to 25 MHz. Memory Clock Select results in the SED1375 block temporarily increasing the memory clock circuitry on CPU access and resuming the slower speed when the access is complete. This results in better performance while using the least power.

In portrait display mode the CLKI (input clock) is routed to the portrait section of the SED1375 block as CLK. From the CLK signal the MCLK value can be determined from table 8-8 of the Hardware Functional Specification, document number X27A-A-001-xx. If MCLK is determined to be less than or equal to 25 MHz then Portrait Mode Memory Clock Select may be enabled.

7.5 Limitations

The only limitation to using portrait mode on the SED1375 block is that split screen operation is not supported.

A comparison of the two portrait modes is as follows:

Table 7-1 Default and Alternate Portrait Mode Comparison

Item	Default Portrait Mode	Alternate Portrait Mode
Memory Requirements	The width of the rotated image must be a power of 2. In most cases, a virtual image is required where the right-hand side of the virtual image is unused and memory is wasted. For example, a $320 \times 240 \times 4\text{bpp}$ image would normally require only 38,400 bytes - possible within the 40K byte address space, but the virtual image is $512 \times 240 \times 4\text{bpp}$ which needs 61,440 bytes - not possible.	Does not require a virtual image.
Clock Requirements	CLK need only be as fast as the required PCLK.	MCLK, and hence CLK, need to be 2x PCLK. For example, if the panel requires a 3MHz PCLK, then CLK must be 6MHz. Note that 25MHz is the maximum CLK, so PCLK cannot be higher than 12.5MHz in this mode.
Power Consumption	Lowest power consumption.	Higher than Default Mode.
Panning	Vertical panning in 2 line increments.	Vertical panning in 1 line increments.
Performance	Nominal performance. Note that performance can be increased by increasing CLK and setting $\text{MCLK} = \text{CLK} (\text{REG}[1\text{Bh}] \text{ bit } 2 = 1)$.	Higher performance than Default Mode. Note that performance can be increased by increasing CLK and setting $\text{MCLK} = \text{CLK} (\text{REG}[1\text{Bh}] \text{ bit } 2 = 1)$.

7.6 Examples

Example 6

Enable default portrait mode for a 320×240 panel at 2 bpp.

Before switching to portrait mode from landscape mode, display memory should be cleared to make the user perceived transition smoother. Images in display memory are not rotated automatically by hardware and a garbled image would be visible for a short period of time if video memory is not cleared.

If alternate portrait is used then the CLK signal is divided in half to get the PCLK signal. If the Input Clock Divide bit, in register[02] is set we can simply reset the divider. The result of this is a PCLK of exactly the same frequency as we used for landscape mode and we can use the current horizontal and vertical non-display periods. If the Input Clock Divide bit is not set then we must recalculate the frame rate based on the a PCLK value. In this example we will bypass recalculation of the horizontal and vertical non-display times (frame rate) by selecting the default portrait mode scheme.

1. Calculate and set the Screen 1 Start Word Address register.

$$\text{OffsetBytes} = (\text{Width} \times \text{BitsPerPixel} / 8) - 1 = (256 \times 2 / 8) - 1 = 63 = 003\text{Fh}$$

(“Width” is the width of the portrait mode display - in this case the next power of two greater than 240 pixels or 256.)

Set Screen1 Display Start Word Address LSB (REG [0Ch]) to 3Fh and Screen1 Display Start Word Address MSB (REG[0Dh]) to 00h.

2. Calculate the Line Byte Count

The Line Byte Count also must be based on the power of two width.

$$\text{LineByteCount} = \text{Width} \times \text{BitsPerPixel} / 8 = 256 \times 2 / 8 = 64 = 40\text{h.}$$

Set the Line Byte Count (REG[1C]) to 40h.

3. Enable portrait mode.

This example uses the default portrait mode scheme. If we do not change the Portrait Mode Pixel Clock Select bits then we will not have to recalculate the non-display timings to correct the frame rate.

Write 40h to the Portrait Mode Register (REG[1Bh]).

The display is now configured for portrait mode use. Offset zero into display memory will correspond to the upper left corner of the display. The only item to keep in mind is that the count from the first pixel of one line to the first pixel of the next line (referred to as the “stride”) is 64 bytes.

Example 7**Enable alternate portrait mode for a 320x240 panel at 2 bpp.**

Note: As we have to perform a frame rate calculation for this mode we need to know the following panel characteristics: 320 × 240 8-bit color to be run at 80 Hz with a 16 MHz input clock.

As in the previous example, before switching to portrait mode, display memory should be cleared. Images in display memory are not rotated automatically by hardware and the garbled image would be visible for a short period of time if video memory is not cleared.

1. Calculate and set the Screen 1 Start Word Address register.

$$\text{OffsetBytes} = (\text{Width} \times \text{BitsPerPixel} / 8) - 1 = (240 \times 2 / 8) - 1 = 59 = 003\text{Bh}$$

Set Screen1 Display Start Word Address LSB (REG [0Ch]) to 3Bh and Screen1 Display Start Word Address MSB (REG[0Dh]) to 00h.

2. Calculate the Line Byte Count.

$$\text{LineByteCount} = \text{Width} \times \text{BitsPerPixel} / 8 = 240 \times 2 / 8 = 60 = 3\text{Ch.}$$

Set the Line Byte Count (REG[1C]) to 3Ch.

3. Enable portrait mode.

This example uses the alternate portrait mode scheme. We will not change the MCLK Autoswitch or Pixel Clock Select settings.

Write C0h to the Portrait Mode register (REG[1Bh])

4. Recalculate the frame rate dependents.

This example assumes the alternate portrait mode scheme. In this scheme, without touching the Pixel Clock Select bits the PCLK value will be equal to CLK/2.

These examples don't use the Pixel Clock Select bits. The ability to divide the PCLK value down further than the default values was added to the SED1375 block to support hardware portrait mode on very small panels.

The Pixel Clock value has changed so we must calculate horizontal and vertical non-display times to reach the desired frame rate. Rather than perform the frame rate calculations here I will refer the reader to the frame rate calculations in “2.2 Frame Rate Calculation” on page C-2-3 and simply “arrive” at the following:

$$\text{Horizontal Non-Display Period} = 88\text{h}$$

$$\text{Vertical Non-Display Period} = 03\text{h}$$

7 HARDWARE ROTATION

Plugging the values into the frame rate calculations yields:

$$\text{FrameRate} = \frac{\text{PCLK}}{(\text{HDP} + \text{HNDP}) \times (\text{VDP} + \text{VNDP})}$$

$$\text{FrameRate} = \frac{\frac{16,000,000}{2}}{(320 + 88) \times (240 + 3)} = 80.69$$

For this example the Horizontal Non-Display register [REG[08h]] needs to be set to 07h and the Vertical Non-Display register (REG[0Ah]) needs to be set to 03h.

The 16,000,000/2 in the formula above represents the input clock being divided by two when this alternate portrait mode is selected. With the values given for this example we must ensure the Input Clock Divide bit (REG[02h] b4) is reset (with the given values it was likely set as a result of the frame rate calculations for landscape display mode).

No other registers need to be altered.

The display is now configured for portrait mode use. Offset zero of display memory corresponds to the upper left corner of the display. Display memory is accessed exactly as it was for landscape mode.

As this is the alternate portrait mode the power of two stride issue encountered with the default portrait mode is no longer an issue. The stride is the same as the portrait mode width. In this case 60 bytes.

Example 8

Pan the above portrait mode image to the right by 4 pixels then scroll it up by 6 pixels.

To pan by four pixels the start address needs to be advanced.

1. Calculate the number of bytes to change start address by.

$$\text{Bytes} = \text{Pixels} \times \text{BitsPerPixel} / 8 = 4 \times 2 / 8 = 1 \text{ bytes}$$

2. Increment the start address registers by the just calculated value.

In this case the value write to the start address register will be 80h (7Fh + 1 = 80h)

To scroll by 4 lines we have to change the start address by the offset of four lines of display.

1. Calculate the number of bytes to change start address by.

$$\text{BytesPerLine} = \text{LineByteCount} = 64$$

$$\text{Bytes} = \text{Lines} \times \text{BytesPerLine} = 4 \times 64 = 256 = 100h$$

2. Increment the start address registers by the just calculated value

In this case 181h (81h + 100h) will be written to the Screen 1 Start Address register set.

Set Screen1 Display Start Word Address LSB (REG[0Ch]) to 81h and Screen1 Display Start Word Address MSB (REG[0Dh]) to 01h.

EPSON International Sales Operations

AMERICA

EPSON ELECTRONICS AMERICA, INC.

- HEADQUARTERS -

1960 E. Grand Avenue
El Segundo, CA 90245, U.S.A.
Phone: +1-310-955-5300 Fax: +1-310-955-5400

- SALES OFFICES -

West

150 River Oaks Parkway
San Jose, CA 95134, U.S.A.
Phone: +1-408-922-0200 Fax: +1-408-922-0238

Central

101 Virginia Street, Suite 290
Crystal Lake, IL 60014, U.S.A.
Phone: +1-815-455-7630 Fax: +1-815-455-7633

Northeast

301 Edgewater Place, Suite 120
Wakefield, MA 01880, U.S.A.
Phone: +1-781-246-3600 Fax: +1-781-246-5443

Southeast

3010 Royal Blvd. South, Suite 170
Alpharetta, GA 30005, U.S.A.
Phone: +1-877-EEA-0020 Fax: +1-770-777-2637

EUROPE

EPSON EUROPE ELECTRONICS GmbH

- HEADQUARTERS -

Riesstrasse 15
80992 Munich, GERMANY
Phone: +49-(0)89-14005-0 Fax: +49-(0)89-14005-110

SALES OFFICE

Allstadtstrasse 176
51379 Leverkusen, GERMANY
Phone: +49-(0)2171-5045-0 Fax: +49-(0)2171-5045-10

UK BRANCH OFFICE

Unit 2.4, Doncastle House, Doncastle Road
Bracknell, Berkshire RG12 8PE, ENGLAND
Phone: +44-(0)1344-381700 Fax: +44-(0)1344-381701

FRENCH BRANCH OFFICE

1 Avenue de l'Atlantique, LP 915 Les Conquerants
Z.A. de Courtaboeuf 2, F-91976 Les Ulis Cedex, FRANCE
Phone: +33-(0)1-64862350 Fax: +33-(0)1-64862355

ASIA

EPSON (CHINA) CO., LTD.

28F, Beijing Silver Tower 2# North RD DongSanHuan
ChaoYang District, Beijing, CHINA
Phone: 64106655 Fax: 64107319

SHANGHAI BRANCH

4F, Bldg., 27, No. 69, Gui Jing Road
Caohejing, Shanghai, CHINA
Phone: 21-6485-5552 Fax: 21-6485-0775

EPSON HONG KONG LTD.

20/F., Harbour Centre, 25 Harbour Road
Wanchai, Hong Kong
Phone: +852-2585-4600 Fax: +852-2827-4346
Telex: 65542 EPSCO HX

EPSON TAIWAN TECHNOLOGY & TRADING LTD.

10F, No. 287, Nanking East Road, Sec. 3
Taipei
Phone: 02-2717-7360 Fax: 02-2712-9164
Telex: 24444 EPSONTB

HSINCHU OFFICE

13F-3, No. 295, Kuang-Fu Road, Sec. 2
HsinChu 300
Phone: 03-573-9900 Fax: 03-573-9169

EPSON SINGAPORE PTE., LTD.

No. 1 Temasek Avenue, #36-00
Millenia Tower, SINGAPORE 039192
Phone: +65-337-7911 Fax: +65-334-2716

SEIKO EPSON CORPORATION KOREA OFFICE

50F, KLI 63 Bldg., 60 Yoido-dong
Youngdeungpo-Ku, Seoul, 150-763, KOREA
Phone: 02-784-6027 Fax: 02-767-3677

SEIKO EPSON CORPORATION

ELECTRONIC DEVICES MARKETING DIVISION

Electronic Device Marketing Department

IC Marketing & Engineering Group

421-8, Hino, Hino-shi, Tokyo 191-8501, JAPAN
Phone: +81-(0)42-587-5816 Fax: +81-(0)42-587-5624

ED International Marketing Department Europe & U.S.A.

421-8, Hino, Hino-shi, Tokyo 191-8501, JAPAN
Phone: +81-(0)42-587-5812 Fax: +81-(0)42-587-5564

ED International Marketing Department Asia

421-8, Hino, Hino-shi, Tokyo 191-8501, JAPAN
Phone: +81-(0)42-587-5814 Fax: +81-(0)42-587-5110



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